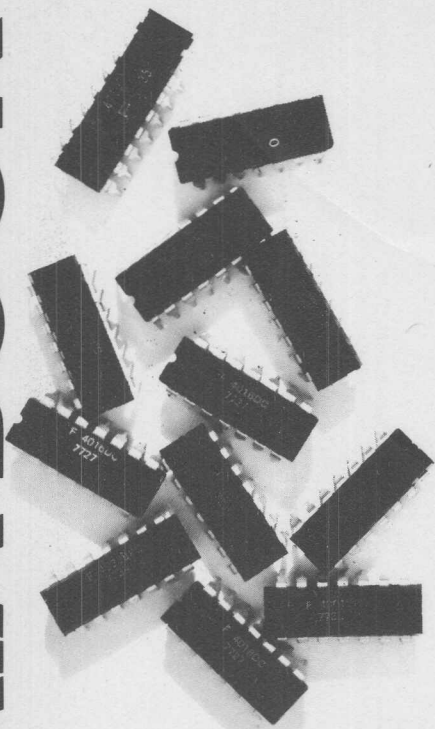


CMOS DATA BOOK



FAIRCHILD

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464 Ellis Street, Mountain View, California 94042

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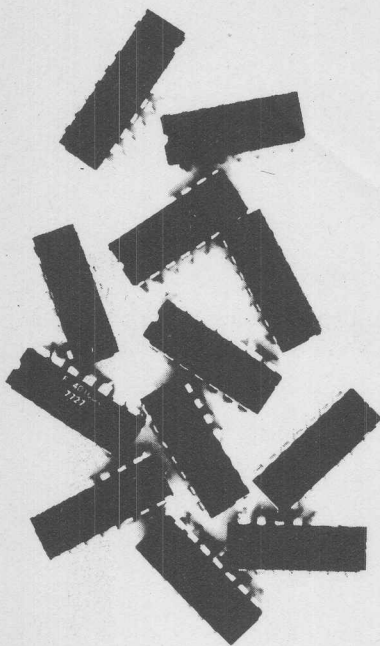
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The data sheets listed below contain preliminary product specifications. For additional data, consult your local Fairchild Sales Office or Fairchild CMOS Product Marketing.

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INTRODUCTION

This data book provides complete technical information on Fairchild's 4000B Series Isoplanar CMOS family. The family encompasses a wide range of SSI, MSI and LSI devices offering the designer a complete spectrum of various circuit complexities all at highest performance. For easy reference to this broad range of devices, a number of indices, selection guides and cross references can be found in Sections 2 and 3.

Since the first introduction of CMOS in the early 1970s, and as each new generation of designs was developed, a large variety of functional and performance parameters were generated by the industry creating a great deal of customer confusion.

In late 1976, under the auspices of EIA/JEDEC, the CMOS vendor community accepted the formidable task of clearing this confusion via industry-wide standardization. The result, as found in Section 6 of this book, is the new "JeDEC Industry Standard 'B' Series CMOS Specification." Fairchild lauds EIA/JEDEC and the industry in total for such a cooperative and valuable effort and encourages continuation of this trend.

It should be noted that all Fairchild CMOS products have always, since first introduction in early 1974, complied with today's JEDEC CMOS specifications. Furthermore, it should be noted that Fairchild offers the only CMOS family which meets or exceeds all functional and performance parameters of all CMOS devices and generations of devices introduced to date. Fairchild continues to provide leadership in technology.

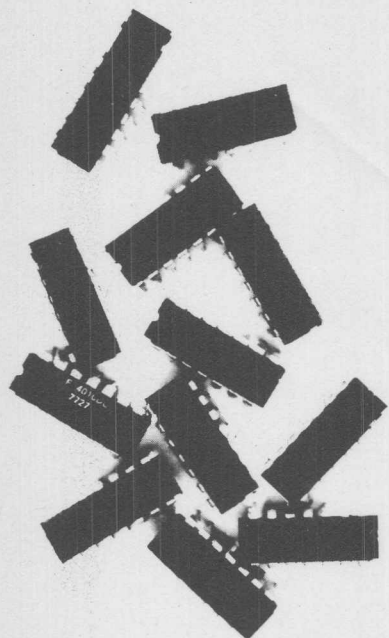
INTRODUCTION

This book provides complete technical information on Fairchild's 4000 Series CMOS family. The family encompasses a wide range of 251, 401 and 402 devices offering the designer a complete spectrum of various circuit complexities at the highest performance. For easy reference, the broad range of devices is numbered in order of increasing complexity and cost in Sections 2 and 3.

Since the first introduction of CMOS in the early 1970's, and as each new generation of designs was developed, a large variety of functional and technological parameters were generated by the industry, creating a great deal of customer confusion.

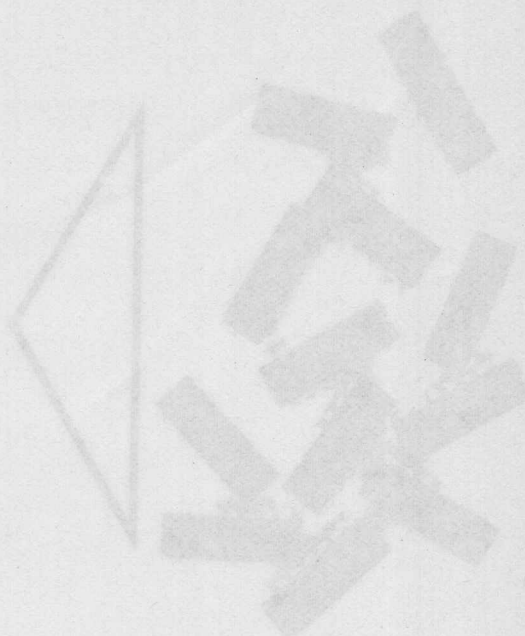
In late 1978, under the auspices of EIA/JEDEC, the CMOS vendor community accepted the formidable task of clearing the confusion via industry-wide standardization. The result, set forth in Section 4 of this book, is the new "Logic Technology Standard," Series CMOS 2. Fairchild joins EIA/JEDEC and the industry in support of such a cooperative and valuable effort and encourages continuation of the trend.

It should be noted that all Fairchild CMOS products have always since their introduction in early 1974, complied with today's JEDEC CMOS specifications. Furthermore, it should be noted that Fairchild offers the only CMOS family which meets or exceeds all functional and performance parameters of all CMOS devices and generations of devices introduced to date. Fairchild continues to provide leadership in technology.



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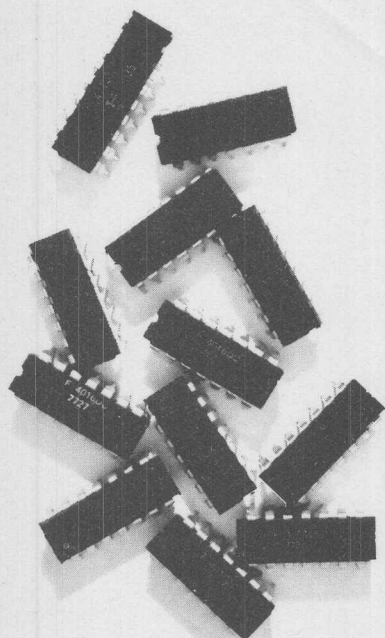
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4047B	Low-Power Monostable/Astable Multivibrator	7-98
4528B	Dual Retriggerable Resettable Monostable Multivibrator	7-188
4538B	Dual Precision Monostable Multivibrator	7-200
4722B	Programmable Counter/Timer	7-298

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Fairchild	RCA	Motorola	National	Solid State Scientific	Texas Instruments
4001B	CD4001A/B	MC14001A/B	CD4001A/B	SCL4001A/B	TP4001A/B
4002B	CD4002A/B	MC14002A/B	CD4002A/B	SCL4002A/B	TP4002A/B
4006B	CD4006A/B	MC14006A/B	CD4006A/B	SCL4006A/B	
4007UB	CD4007A/UB	MC14007A/UB	CD4007A/UB	SCL4007A/UB	TP4007A/UB
4008B	CD4008A/B	MC14008A/B	CD4008A/B	SCL4008A/B	TP4008A/B
4011B	CD4011A/B	MC14011A/B	CD4011A/B	SCL4011A/B	TP4011A/B
4012B	CD4012A/B	MC14012A/B	CD4012A/B	SCL4012A/B	TP4012A/B
4013B	CD4013A/B	MC14013A/B	CD4013A/B	SCL4013A/B	TP4013A/B
4014B	CD4014A/B	MC14014A/B	CD4014A/B	SCL4014A/B	TP4014A/B
4015B	CD4015A/B	MC14015A/B	CD4015A/B	SCL4015A/B	TP4015A/B
4016B	CD4016A/B	MC14016A/B	CD4016A/B	SCL4016A/B	TP4016A/B
4017B	CD4017A/B	MC14017A/B	CD4017A/B	SCL4017A/B	TP4017A/B
4018B	CD4018A/B	MC14018A/B	CD4018A/B	SCL4018A/B	TP4018A/B
4019B	CD4019A/B		CD4019A/B	SCL4019A/B	TP4019A/B
4020B	CD4020A/B	MC14020A/B	CD4020A/B	SCL4020A/B	TP4020A/B
4021B	CD4021A/B	MC14021A/B	CD4021A/B	SCL4021A/B	TP4021A/B
4022B	CD4022A/B	MC14022A/B	CD4022A/B	SCL4022A/B	TP4022A/B
4023B	CD4023A/B	MC14023A/B	CD4023A/B	SCL4023A/B	TP4023A/B
4024B	CD4024A/B	MC14024A/B	CD4024A/B	SCL4024A/B	TP4024A/B
4025B	CD4025A/B	MC14025A/B	CD4025A/B	SCL4025A/B	TP4025A/B
4027B	CD4027A/B	MC14027A/B	CD4027A/B	SCL4027A/B	TP4027A/B
4028B	CD4028A/B	MC14028A/B	CD4028A/B	SCL4028A/B	TP4028A/B
4029B	CD4029A/B		CD4029A/B	SCL4029A/B	TP4029A/B
4030B	CD4030A/B		CD4030A/B	SCL4030A/B	TP4030A/B
4031B	CD4031A/B		CD4031A/B		
4034B	CD4034A/B	MC14034A/B	CD4034A/B	SCL4034A/B	
4035B	CD4035A/B	MC14035A/B	CD4035A/B	SCL4035A/B	TP4035A/B
4040B	CD4040A/B	MC14040A/B	CD4040A/B	SCL4040A/B	TP4040A/B
4041B	CD4041A/B		CD4041A/B	SCL4041A/B	TP4041A/B
4042B	CD4042A/B	MC14042A/B	CD4042A/B	SCL4042A/B	TP4042A/B
4043B	CD4043A/B	MC14043A/B	CD4043A/B	SCL4043A/B	TP4043A/B
4044B	CD4044A/B	MC14044A/B	CD4044A/B	SCL4044A/B	TP4044A/B
4045B	CD4045A/B				
4046B	CD4046A/B	MC14046A/B	CD4046A/B	SCL4046A/B	
4047B	CD4047A/B		CD4047A/B		TP4047A/B
4049B	CD4049A/UB	MC14049A/UB	CD4049A/UB	SCL4049A/UB	TP4049A/UB
4050B	CD4050A/B	MC14050A/B	CD4050A/B	SCL4050A/B	TP4050A/B
4051B	CD4051A/B	MC14051A/B	CD4051A/B	SCL4051A/B	TP4051A/B
4052B	CD4052A/B	MC14052A/B	CD4052A/B	SCL4052A/B	TP4052A/B
4053B	CD4053A/B	MC14053A/B	CD4053A/B	SCL4053A/B	TP4053A/B
4066B	CD4066A/B	MC14066A/B	CD4066A/B	SCL4066A/B	TP4066A/B
4067B	CD4067B				
4068B	CD4068B	MC14068B		SCL4068B	TP4068B
4069UB	CD4069UB	MC14069UB	CD4069UB	SCL4069UB	TP4069UB
4070B	CD4070B	MC14070B	CD4070B	SCL4070B	
4071B	CD4071B	MC14071B	CD4071B	SCL4071B	TP4071B
4072B	CD4072B	MC14072B		SCL4072B	TP4072B
4073B	CD4073B	MC14073B	CD4073B	SCL4073B	TP4073B
4075B	CD4075B	MC14075B	CD4075B	SCL4075B	TP4075B
4076B	CD4076B	MC14076B	CD4076B	SCL4076B	

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Fairchild	RCA	Motorola	National	Solid State Scientific	Texas Instruments
4077B	CD4077B	MC14077B		SCL4077B	
4078B	CD4078B	MC14078B		SCL4078B	TP4078B
4081B	CD4081B	MC14081B	CD4081B	SCL4081B	TP4081B
4082B	CD4082B	MC14082B		SCL4082B	TP4082B
4085B	CD4085B				
4086B	CD4086B				
4093B	CD4093B	MC14093B	CD4093B	SCL4093B	
4104B					
4510B	CD4510B	MC14510B	CD4510B	SCL14510B	
4511B	CD4511B	MC14511B	CD4511B	SCL14511B	TP4511B
4512B		MC14512B		SCL14512B	TP4512A/B
4514B	CD4514B	MC14514B		SCL14514B	
4515B	CD4515B	MC14515B		SCL14515B	
4516B	CD4516B	MC14516B	CD4516B	SCL14516B	
4518B	CD4518B	MC14518B	CD4518B	SCL14518B	TP4518A/B
4519B		MC14519B	CD4519B		TP4519A/B
4520B	CD4520B	MC14520B	CD4520B	SCL14520B	TP4520A/B
4521B		MC14521B			
4522B		MC14522B		SCL4522B	TP4522A/B
4526B		MC14526B		SCL14526B	TP4526A/B
4527B	CD4527B	MC14527B	CD4527B	SCL14527B	
4528B	CD4098B	MC14528B		SCL14528B	
4531B		MC14531B		SCL14531B	TP4531A/B
4532B	CD4532B	MC14532B			
4534B		MC14534B			
4538B		MC14538B			
4539B		MC14539B			TP4539A/B
4543B		MC14543B			
4553B		MC14553B			
4555B	CD4555B	MC14555B		SCL14555B	
4556B	CD4556B	MC14556B		SCL14556B	
4557B		MC14557B			
4560B		MC14560B			
4561B		MC14561B			
4566B		MC14566B			
4581B	CD40181B	MC14581B		SCL14581B	TP4581A/B
4582B	CD40182B	MC14582B		SCL14582B	TP4582A/B
4583B		MC14583B			
4702B					
4703B					
4704B					
4705B					
4706B					
4707B					
4708B					
4710B					
4720B	**CD4061A				
4721B	CDP1822		MM74C920		
4722B					
4723B			CD4723B		

*This device is a functional equivalent only.

**This device is a pin-for-pin compatible if leads 4 and 8 are tied together.

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Fairchild	RCA	Motorola	National	Solid State Scientific	Texas Instruments
4724B	CD4099B*		CD4724B MM74C89		
4725B					
4727B					
4731B					
4734B	CDP1821	MC14513B	MM74C929		
4735B					
4736B					
4737B					
4741B	CD40106B	MC14584B	MM74C14	*SCL14585B	
40014B					
40085B					
40097B					
40098B					
40160B					
40161B					
40162B					
40163B					
40174B					
40175B					
40192B					
40193B	CD40192B	MC14160B MC14161B	MM74C160 MM74C161	SCL4160B SCL4161B	TP4360B TP4361B
40193B	CD40193B				
40194B	CC40194B				
40195B					
40193B	CD40193B	MC14162B MC14163B MC14174B MC14175B	MM74C162 MM74C163 MM74C174 MM74C175	SCL4162B SCL4163B	TP4362B TP4363B
40194B					
40195B					
40193B	CD40193B	MC14194B	MM74C193		
40194B					
40195B					

* This device is a functional equivalent only.

** This device is a pin-for-pin compatible if leads 4 and 8 are tied together.

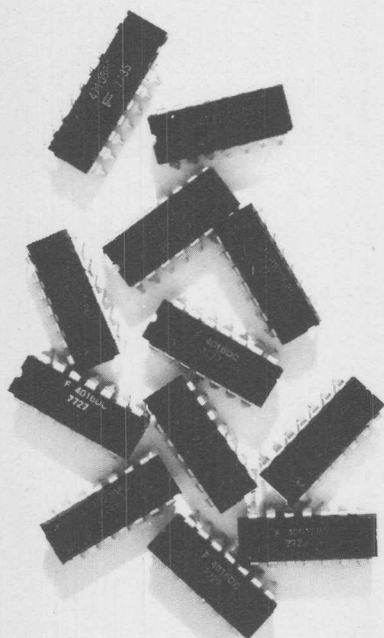
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PACKAGE CODE CROSS REFERENCE

Package	Fairchild	RCA	Motorola	National	Solid State Scientific	Texas Instruments
Plastic DIP	P	E	.P	N	E	N
Ceramic DIP	D	D or F	L	D	D	J
Ceramic Flatpak	F	K	—	F	F	—

TEMPERATURE CODE CROSS REFERENCE

Temperature Range	Fairchild	RCA	Motorola	National	Solid State Scientific	Texas Instruments
Military (-55°C to +125°C)	M	D, K, F Packages Only	A	54CXX 70CXX M	D, F Packages Only	TF
Commercial (-40°C to +85°C)	C	E Package Only	C	C	E Package Only	TP
Commercial (0°C to +70°C)	—	—	—	74CXX 80CXX	—	TL



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FAIRCHILD 4000 SERIES CMOS

GENERAL DESCRIPTION – Fairchild CMOS logic combines popular 4000 series functions with the advanced Isoplanar C process. The result is a logic family with a superior combination of noise immunity and standardized drive characteristics. Under static conditions, these devices dissipate very low power, typically 10 nW per gate. The low power combined with the wide (3 to 15 V) recommended operating supply voltage requirement greatly minimizes power supply costs. The CMOS family is designed with standardized output drive characteristics which, combined with relative insensitivity to output capacitance loading, simplify system design.

- **LOW POWER** – TYPICALLY 10 nW PER GATE STATIC
- **WIDE OPERATING SUPPLY VOLTAGE RANGE** –
3 TO 15 V RECOMMENDED
18 V ABSOLUTE MAXIMUM
- **HIGH NOISE IMMUNITY**
- **BUFFERED OUTPUTS STANDARDIZE OUTPUT DRIVE AND REDUCE VARIATION OF PROPAGATION DELAY WITH OUTPUT CAPACITANCE**
- **WIDE OPERATING TEMPERATURE RANGE**
COMMERCIAL -40°C TO $+85^{\circ}\text{C}$
MILITARY -55°C TO $+125^{\circ}\text{C}$
- **HIGH DC FAN OUT** – GREATER THAN 50

ISOPLANAR C

The Fairchild CMOS logic family uses Isoplanar C for high performance. This technology combines local oxidation isolation techniques with silicon gate technology to achieve an approximate 35% to 100% savings in area as shown in Figure 4-1a. Operating speeds are increased due to the self-alignment of the silicon gate and reduced side-wall capacitance.

Conventional CMOS circuits are fabricated on an n-type substrate as shown in Figure 4-1b. The p-type substrate required for complementary n-channel MOS is obtained by diffusing a lightly doped p-region into the n-type substrate. Conventional CMOS fabrication requires more chip area and has slower circuit speeds than Isoplanar C CMOS. This is a result of the n+ or p+ channel stop which surrounds the p- or n-channels respectively in conventional metal gate CMOS. Silicon gate CMOS (Figure 4-1c) has a negligible reduction in area, though transient performance is improved.

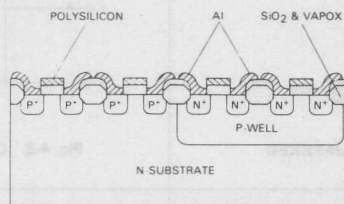


Fig. 4-1a. ISOPLANAR C CMOS STRUCTURE
REDUCES AREA 35%

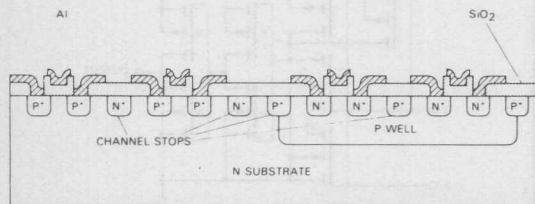


Fig. 4-1b. CONVENTIONAL METAL GATE CMOS STRUCTURE

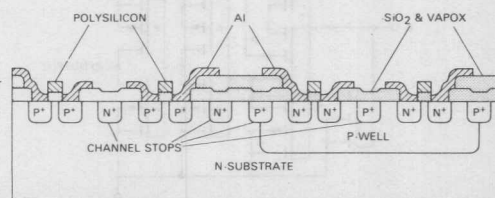


Fig. 4-1c. CONVENTIONAL SILICON GATE CMOS STRUCTURE
REDUCES AREA 8%

FULLY BUFFERED CONFIGURATION DESCRIPTION

Fairchild CMOS logic is designed with the system user in mind. Output buffering is used on all devices to achieve high performance, standardized output drive, highest noise immunity and decreased ac sensitivity to output loading. Figure 4-2 illustrates a conventional unbuffered 2-Input NOR Gate. Either n-channel transistor connected to V_{SS} (ground) conducts when either input is HIGH, causing the output to go LOW through the ON resistance of the device. If both inputs are HIGH, both n-channel devices are on; effectively halving the ON resistance, thereby making the output impedance (and hence fall time) a function of input variables. Similarly the p-channel devices are switched on by LOW signals; i.e., when both inputs are LOW, conduction from V_{DD} to the output will occur.

Since the p-channel devices are in series, their ON resistance must be decreased (larger chip area) to hold output HIGH impedance within specification. As the number of gate inputs increases, even larger p-channel devices are required, and the output impedance to V_{SS} becomes even more pattern sensitive.

A conventional unbuffered CMOS 2-Input NAND Gate interchanges the parallel and serial transistor gating to achieve the NAND function (Figure 4-3). The changes in output resistance then move to the p-channel transistors connected to V_{DD} , while the n-channel devices must be increased in size due to their serial connection.

Fairchild CMOS uses small geometry logic transistors to generate the required function which drive standard low impedance output buffers (Figures 4-4 and 5). This technique reduces chip size, since only two large output transistors are required and rise and fall times are independent of input pattern. Buffered outputs also increase system speeds and make propagation delay less sensitive to output capacitance. Figure 4-6 illustrates typical propagation delay vs. output capacitance for conventional and buffered CMOS Gates.

Another advantage of the Fairchild approach is improved noise immunity. Because of the increased voltage gain, nearly ideal transfer characteristics are realized as shown in Figure 4-7. The high gain (greater than 10,000) also provides significant pulse shaping; the waveforms of Figures 4-8 and 9 compare the output waveforms of conventional and buffered CMOS gates. For input transition times of 100 ns or less, the outputs of both gate types are similar. When the input transitions are stretched to one microsecond, the conventional gate exhibits increased transition times while the buffered gate has unchanged output transition times. This feature eliminates progressive deterioration of pulse characteristics in a system. The combination of Isoplanar C and buffered outputs results in new standards of CMOS logic performance.

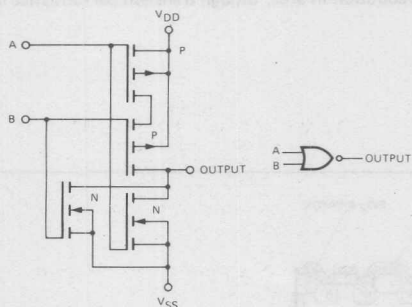


Fig. 4-2. CONVENTIONAL NON-BUFFERED 2-INPUT NOR GATE

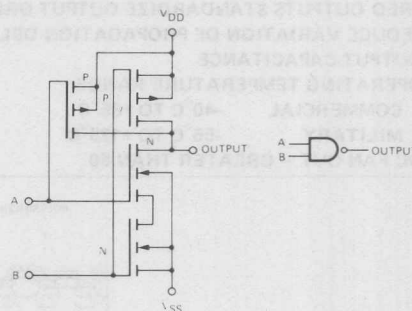


Fig. 4-3. CONVENTIONAL NON-BUFFERED 2-INPUT NAND GATE

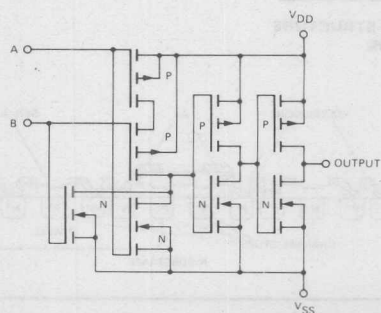


Fig. 4-4. FAIRCHILD 4001B FULLY BUFFERED NOR GATE

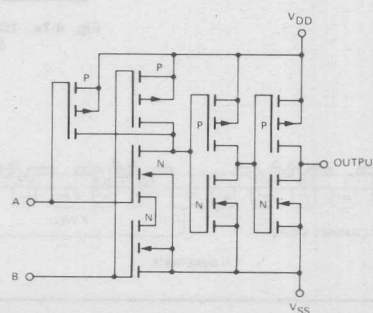


Fig. 4-5. FAIRCHILD 4011B FULLY BUFFERED NAND GATE

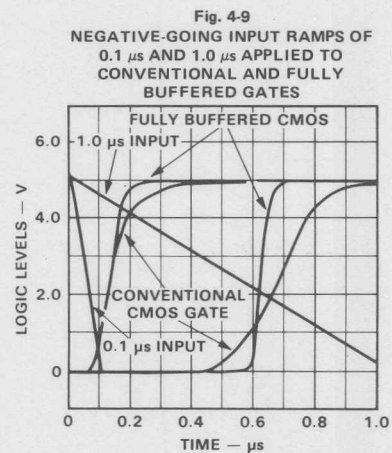
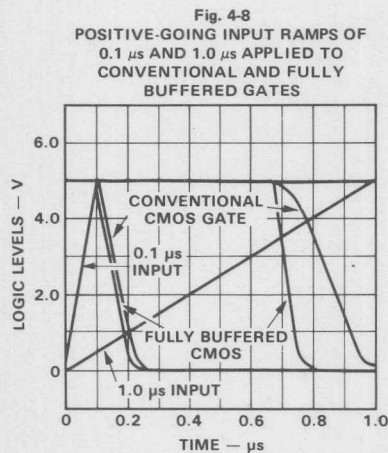
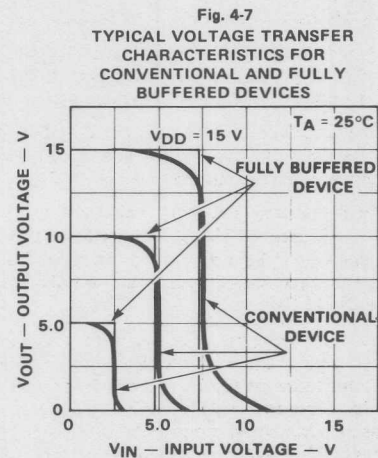
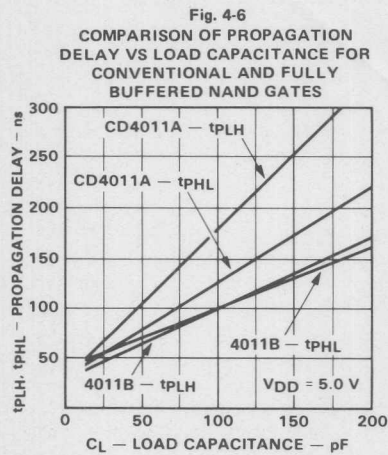


FIG. 48
SWITCHING DELAY FOR PROPAGATION
DELAY OF LOAD CAPACITANCE FOR
CONVENTIONAL AND FULLY
SUFFICIENT BIAS

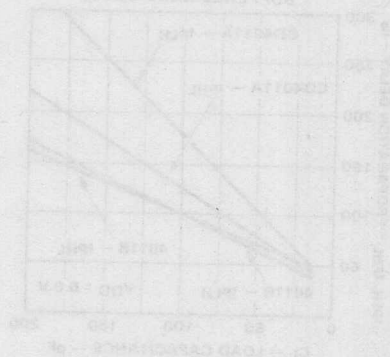


FIG. 49
TYPICAL VOLTAGE TRANSFER
CHARACTERISTICS FOR
CONVENTIONAL AND FULLY
SUFFICIENT BIAS

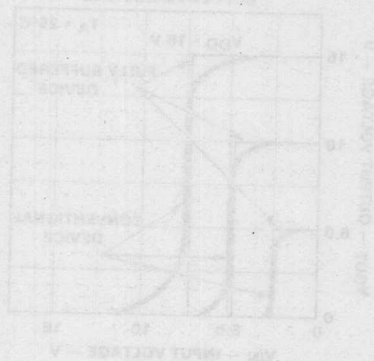


FIG. 50
SIGNAL-TO-NOISE RATIO FOR
A 10% DUTY CYCLE INPUT SIGNAL TO
CONVENTIONAL AND FULLY
SUFFICIENT BIAS

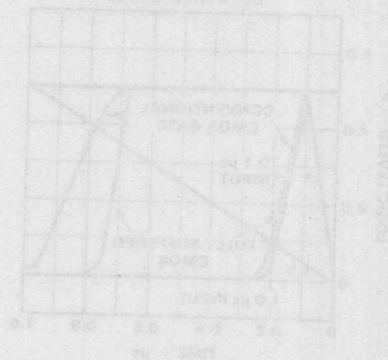
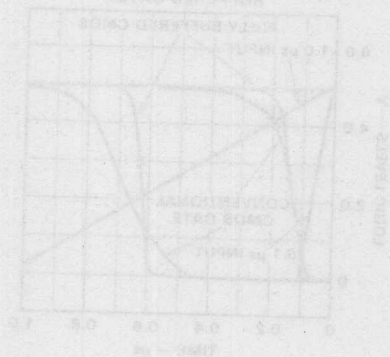
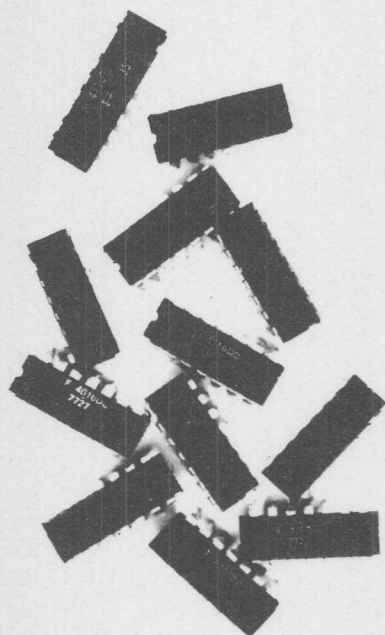


FIG. 51
NEGATIVE-TO-POSITIVE INPUT RATIO OF
A 10% DUTY CYCLE INPUT SIGNAL TO
CONVENTIONAL AND FULLY
SUFFICIENT BIAS





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DESIGN CONSIDERATIONS WITH FAIRCHILD 4000B SERIES CMOS

INTRODUCTION

Complementary MOS digital logic building blocks of SSI and MSI complexity have been hailed as the ideal logic family. They are rapidly gaining popularity as more and more manufacturers introduce increasing numbers of parts at reasonable prices.

Originally designed for aerospace applications, CMOS now finds its way into portable instruments, industrial and medical electronics, automotive applications and computer peripherals, besides dominating the electronic watch market.

In late 1973, Fairchild introduced the Fairchild 4000B CMOS family, using Isoplanar technology to achieve superior electrical performance. Most of these devices are functional equivalents and pin-for-pin replacements of the well-known 4000 series; some are equivalent to TTL circuits and some are proprietary logic designs.

A few CMOS devices, such as bidirectional analog switches, exploit the unique features of CMOS technology; some take advantage of the smaller device size and higher potential packing density to achieve true LSI complexity; but most of the available CMOS elements today are of SSI and MSI complexity and perform logic functions that have been available in DTL or TTL for many years. Therefore, it is both helpful and practical to compare the performance of CMOS with that of

the more familiar DTL/TTL (*Figure 5-1*). The TTL to CMOS Comparison Guide in Section 3 lists numerous CMOS circuits that are pinout identical to their TTL counterparts, others that are functionally identical only, still others that are similar and, in most cases, offer added features.

CMOS speed is comparable to 74L-TTL and DTL, and about three to six times slower than TTL or Low Power Schottky (LS-TTL). Voltage noise immunity and fan out are almost ideal, supply voltage is noncritical, and the quiescent power consumption is close to zero-several orders of magnitude lower than for any competing technology.

POWER CONSUMPTION

Under static conditions, the p-channel (top) and the n-channel (bottom) transistors are not conducting simultaneously, thus only leakage current flows from the positive (V_{DD}) to the negative (V_{SS}) supply connection. This leakage current is typically 0.5 nA per gate, resulting in very attractive low power consumption of 2.5 nW per gate (at 5 V).

Whenever a CMOS circuit is exercised, when data or clock inputs change, additional power is consumed to charge and discharge capacitances (on-chip parasitic capacitances as well as load capacitances). Moreover, there is a short time during the transition when both the top and the bottom transistors are partially conducting. This dynamic power consumption is

PARAMETER	STANDARD TTL	74L	DTL	LOW POWER SCHOTTKY	FAIRCHILD 4000B CMOS 5 V SUPPLY	FAIRCHILD 4000B CMOS 10 V SUPPLY
PROPAGATION DELAY (GATE)	10 ns	33 ns	30 ns	5 ns	40 ns	20 ns
FLIP-FLOP TOGGLE FREQUENCY	35 MHz	3 MHz	5 MHz	45 MHz	8 MHz	16 MHz
QUIESCENT POWER (GATE)	10 mW	1 mW	8.5 mW	2 mW	10 nW	10 nW
NOISE IMMUNITY	1 V	1 V	1 V	0.8 V	2 V	4 V
FAN OUT	10	10	8	20	50*	50*

*OR AS DETERMINED BY ALLOWABLE PROPAGATION DELAY

Fig. 5-1 CMOS COMPARED TO OTHER LOGIC FAMILIES

obviously proportional to the frequency at which the circuit is exercised, to the load capacitance and to the square of the supply voltage. As shown in Figure 5-2, the power consumption of a CMOS gate exceeds that of a Low Power Schottky gate somewhere between 500 kHz and 2 MHz of actual output frequency.

At 100 transitions per second, the dynamic power consumption is far greater than the static dissipation; at one million transitions per second, it exceeds the power consumption of LS-TTL. Comparing the power consumption of more complex devices (MSI) in various technologies may show a different result. In any complex design, only a small fraction of the gates actually switch at the full clock frequency, most gates operate at a much lower average rate and consume, therefore, much less power.

A realistic comparison of power consumption between different technologies involves a thorough analysis of the average switching speed of each gate in the circuit. The small static supply current, I_{DD} is specified on individual data sheets for 5, 10 and 15 V. The dynamic power dissipation for 5, 10 and 15 V, 15 and 50 pF may be found in graph form for frequencies of 100 Hz to 10 MHz. The total power may be calculated, $P_T = (I_{DD} \times V_{DD}) + \text{dynamic power dissipation}$.

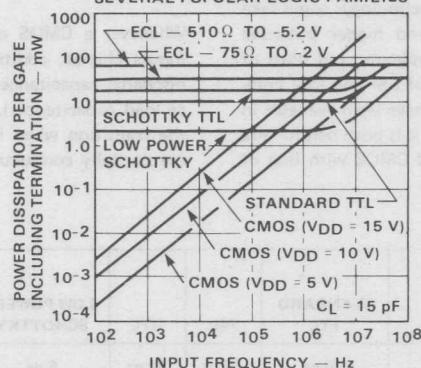
SUPPLY VOLTAGE RANGE

CMOS is guaranteed to function over the unprecedented range of 3 to 15 V supply voltage. Characteristics are guaranteed for 5, 10 and 15 V operation and can be extrapolated for any voltage in between. Operation below 4.5 V is not very meaningful because of the increase in delay (loss of speed), the increase in output impedance and the loss of noise immunity. Operation above 15 V is not recommended because of high dynamic power consumption and risk of noise spikes on the power supply exceeding the breakdown voltage (typ >20 V), causing SCR-latch-up and destroying the device unless the current is externally limited.

The lower limit of power supply voltage, including ripple, is determined by the required noise immunity, propagation delay or interface to TTL. The upper limit of supply voltage, including ripple and transients, is determined by power dissipation or direct interface to TTL. The 4049B, 4050B, 4104B, 40097B and 40098B provide level translation between TTL and CMOS when CMOS supply voltages over 5 V are used. While devices are usable to 18 V, operation above 12 V is discouraged for reasons of power dissipation.

Low static power consumption combined with wide supply voltage range make CMOS the ideal logic family for battery operated equipment.

Fig. 5-2
TYPICAL POWER DISSIPATION
VERSUS INPUT FREQUENCY FOR
SEVERAL POPULAR LOGIC FAMILIES

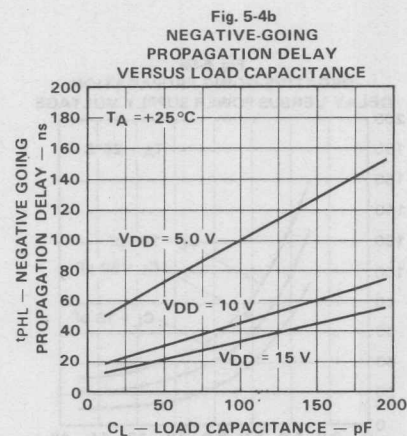
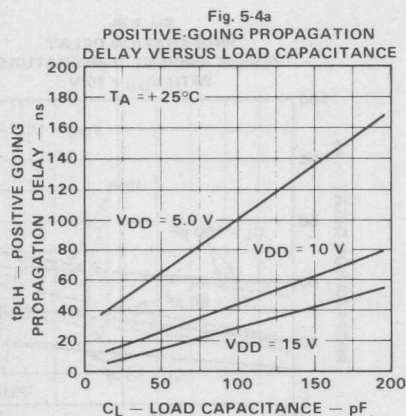
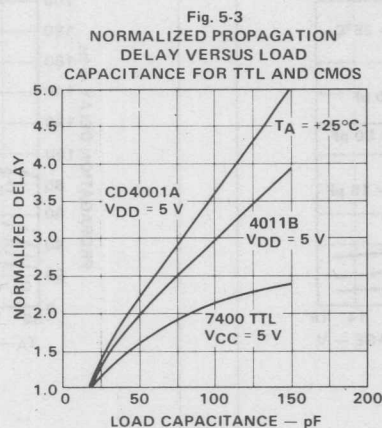


very sensitive to capacitive loading. See *Figure 5-3*. The Fairchild 4000B family uses both advanced processing (isoplanar) and improved circuit design (buffered gates) to achieve propagation delays and output rise times that are superior to any other junction-isolated CMOS design. (Silicon-on-sapphire, SOS, can achieve similar performance but at a substantial cost penalty).

Isoplanar processing achieves lower parasitic capacitances which reduce the on-chip delay and increase the maximum toggle frequency of flip-flops, registers and counters. Buffering all outputs, even on gates, results in lower output impedance and thus reduces the effect of capacitive loading.

Propagation delay is affected by three parameters: capacitive loading, supply voltage, and temperature.

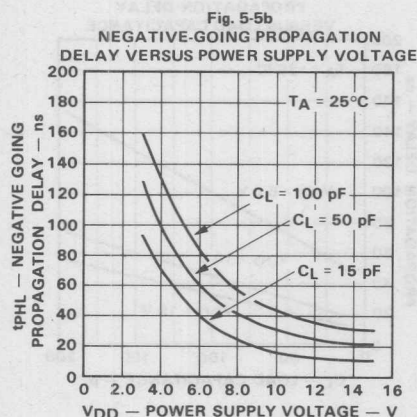
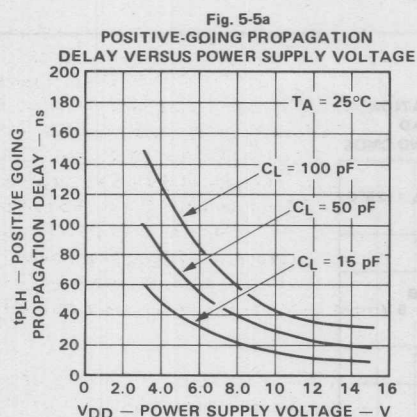
Historically, semiconductor manufacturers have always specified the propagation delay at an output load of 15 pF, not because anybody considers this a representative systems environment, but rather because it was the lowest practical test-jig capacitance. It also generated the most impressive specifications. TTL with an output impedance less than 100 Ω is little affected by an increase in capacitive loading; a 100 pF load increases the delay by only about 4 ns. CMOS, however, with an output impedance of 1 k Ω (worst case at 5 V) is 10 times more sensitive to capacitive loading. *Figure 5-4* shows the positive- and negative-going delays as a function of load capacitance. It should be noted that the older, unbuffered gates have an even higher output impedance, a larger dependence on output loading, and do not show the same symmetry.



Supply Voltage Effect

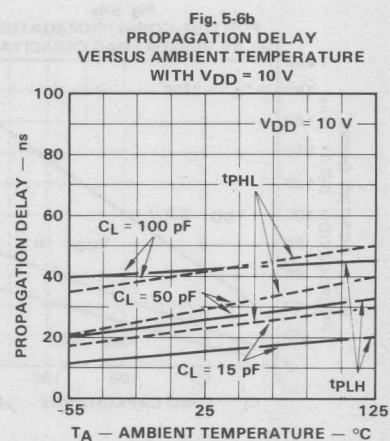
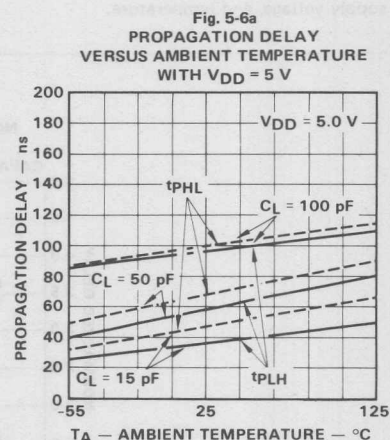
Figure 5-5 shows propagation delay as a function of supply voltage and again indicates the symmetry of the positive- and negative-going delays. Increasing the supply voltage from 5 to 10 V more than doubles the speed of CMOS gates. Increasing the supply voltage to 15 V almost doubles the speed again, but, as mentioned before, results in a significant increase in dynamic power dissipation.

The best choice for slow applications is 5 V. For reasonably fast systems, choose 10 or 12 V. Any application requiring 15 V to achieve short delays and fast operation should be investigated for excessive power dissipation and should be weighed against an LS-TTL approach.



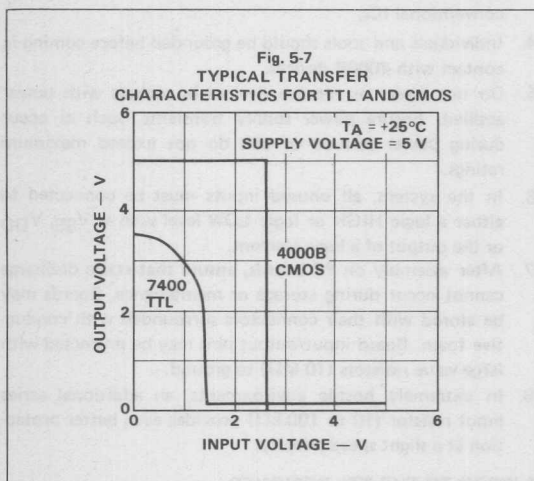
Temperature Effect

Figure 5-6 shows propagation delay as a function of ambient temperature. The temperature dependence of CMOS is much simpler than with TTL, where three factors contribute— increase of beta with temperature, increase of resistor value with temperature, and decrease of junction forward voltage drop with increasing temperature. In CMOS, essentially only the carrier mobility changes, thus increasing the impedance and hence the delay with temperature. For 4000B devices, this temperature dependence is less than 0.3% per $^\circ\text{C}$, practically linear over the full temperature range. Note that the commercial temperature range is -40 to $+85^\circ\text{C}$ rather than the usual 0 to $+75^\circ\text{C}$.



CMOS delays increase with temperature. They are very sensitive to capacitive loading but can be reduced by increasing the supply voltage to 10 or even 15 V.

To determine propagation delays, the effects of capacitive loading, supply voltage, manufacturing tolerances and ambient temperature must be considered. Start with the values of t_{PLH} (propagation delay, a LOW-to-HIGH output transition) and t_{PHL} (propagation delay, a HIGH-to-LOW output transition) given in the individual data sheets. Delay values for V_{DD} at 5, 10 and 15 V and output capacity of 50 pF is provided. Manufacturing tolerances account for the differences between MIN, TYP and MAX. Starting with the nearest applicable delay value, correct for effects of capacitive loading, ambient temperature and supply voltage using the general family characteristics of Section 7.



NOISE IMMUNITY

One of the most advertised and also misunderstood CMOS features is noise immunity. The input threshold of a CMOS gate is approximately 50% of the supply voltage and the voltage transfer curve is almost ideal. As a result, CMOS can claim very good voltage noise immunity, typically 45% of the supply voltage, *i.e.*, 2.25 V in a 5 V system, 4.5 V in a 10 V system. Compare this with the TTL transfer curve in Figure 5-5 and its resultant 1 V noise immunity in a lightly loaded system and only 0.4 V worst case.

Since CMOS output impedance, output voltage and input threshold are symmetrical with respect to the supply voltage, the LOW and HIGH level noise immunities are practically equal. Therefore, a CMOS system can tolerate ground or V_{DD} drops and noise on these supply lines of more than 1 V, even in a 5 V system. Moreover, the inherent CMOS delays act as a noise filter; 10 ns spikes tend to disappear in a chain of CMOS gates, but are amplified in a chain of TTL gates. Because of these features, CMOS is very popular with designers of industrial control equipment that must operate in an electrically and electromagnetically "polluted" environment.

Unfortunately these impressive noise margin specifications disregard one important fact: the output impedance of CMOS is 10 to 100 times higher than that of TTL. CMOS interconnections are therefore less "stiff" and much more susceptible to capacitively coupled noise. In terms of such current injected crosstalk from high noise voltages through small coupling capacitances, CMOS has about six times less noise margin than TTL. It takes more than 20 mA to pull a TTL output into the threshold region, but it takes only 3 mA to pull a CMOS output into the threshold of a 5 V system.

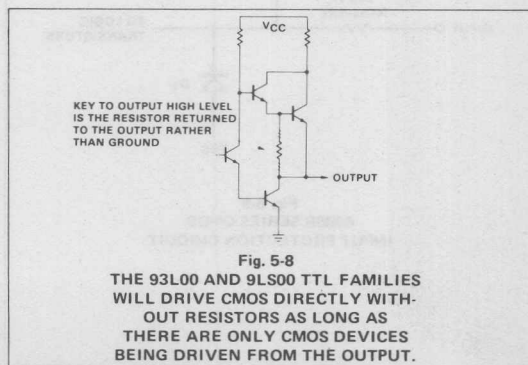
The nearly ideal transfer characteristic and the slow response of CMOS circuits make them insensitive to low voltage, magnetically coupled noise. The high output impedance, however, results in a poor rejection of capacitively coupled noise.

INTERFACE TO TTL

When CMOS is operated with a 5 V power supply, interface to TTL is straightforward. The input impedance of CMOS is very high, so that any form of TTL will drive CMOS without loss of fan out in the LOW state. Unfortunately, most TTL has insufficient HIGH state voltage (typically 3.5 V) to drive CMOS reliably. A pull up resistor (1 k Ω to 10 k Ω) from the output of the TTL device to the 5 V power supply will effectively pull the HIGH state level to 4.5 V or above. Alternately, DTL Hex inverters may be used between the TTL and CMOS. 9LS Low Power Schottky and 93L00 Low Power TTL/MSI utilize the unique output configuration shown in Figure 5-8 to pull its output to $V_{CC}-V_{BC}$ or approximately 4.3 V when lightly loaded.

All Fairchild 4000B logic elements will drive a single 9LS Low Power Schottky input fan in directly. A 9LS Hex inverter such as the 9LS04 makes an excellent low cost TTL buffer with a fan out of 20 into 9LS or 5 into standard TTL. Alternately, the 4049B and 4050B Hex buffers may be used to drive a fan out of 8 into 9LS or 2 into standard TTL.

When operating CMOS at voltage higher than 5 V direct interface to TTL cannot be used. The 4104B Quad Level Translator converts TTL levels to high voltage CMOS up to 15 V. The 4049B and 4050B Hex Buffers will accept high voltage CMOS levels up to 15 V and drive 2 standard TTL loads.



INPUT/OUTPUT CAPACITY

CMOS devices exhibit input capacities in the 1.5 to 5 pF range and output capacity in the 3 to 7 pF range.

OUTPUT IMPEDANCE

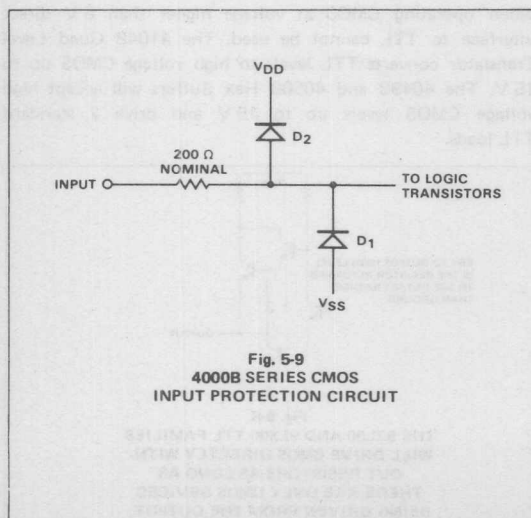
All Fairchild 4000B logic devices employ standardized output buffers. Section 7 details output characteristics. It should be noted that these impedances do not change with input pattern as do conventional CMOS gates. Buffers, analog switches and analog multiplexers employ special output configurations which are detailed in individual data sheets.

INPUT PROTECTION

The gate input to any MOS transistor appears like a small (<1 pF) very low leakage ($<10^{-12}$ A) capacitor. Without special precautions, these inputs could be electrostatically charged to a high voltage, causing a destructive breakdown of the dielectric and permanently damaging the device. Therefore, all CMOS inputs are protected by a combination of series resistor and shunt diodes. Various manufacturers have used different approaches; some use a single diode, others use two diodes, and some use a resistor with a parasitic substrate diode.

Each member of the Fairchild 4000B family utilizes a series resistor, nominally $200\ \Omega$, and two diodes, one to V_{DD} , and the other to V_{SS} (Figure 5-9). The resistor is a poly-silicon "true resistor" without a parasitic substrate diode. This ensures that the input impedance is always at least $200\ \Omega$ under all biasing conditions, even when V_{DD} is short circuited to V_{SS} . A parasitic substrate diode would represent a poorly defined shunt to V_{SS} in this particular case.

The diodes exhibit typical forward voltage drops of 0.9 V at 1 mA and reverse breakdowns of 20 V for D1 and 20 V for D2. For certain special applications such as oscillators, the diodes actually conduct during normal operation. However, currents must be limited to 10 mA.



HANDLING PRECAUTIONS

All MOS devices are subject to damage by large electrostatic charges. All Fairchild 4000B devices employ the input protection described in Figure 5-9, however, electrostatic damage can still occur. The following handling precautions should be observed.

1. All Fairchild 4000B devices are shipped in conducting foam or antistatic tubes. They should be removed for inspection or assembly using proper precautions.
2. Ionized air blowers are recommended when automatic incoming inspection is performed.
3. Fairchild 4000B devices, after removal from their shipping material, should be placed leads down on a grounded surface. Conventional cookie tins work well. Under no circumstances should they be placed in polystyrene foam or plastic trays used for shipment and handling of conventional ICs.
4. Individuals and tools should be grounded before coming in contact with 4000B devices.
5. Do not insert or remove devices in sockets with power applied. Ensure power supply transients, such as occur during power turn-on or off; do not exceed maximum ratings.
6. In the system, all unused inputs must be connected to either a logic HIGH or logic LOW level such as V_{SS} , V_{DD} or the output of a logic element.
7. After assembly on PC boards, ensure that static discharge cannot occur during storage or maintenance. Boards may be stored with their connectors surrounded with conductive foam. Board input/output pins may be protected with large value resistors ($10\ M\Omega$) to ground.
8. In extremely hostile environments, an additional series input resistor (10 to $100\ k\Omega$) provides even better protection at a slight speed penalty.

A WORD TO THE TTL DESIGNER

Designing with CMOS is generally an easy transition and allows the designer to discard many of the old design inhibitions for new found freedoms. A few of these are:

Fan out—It is practically unlimited from a dc point of view and is restricted only by delay and rise time considerations.

Power Supply Regulation—Anything between 3 V and 15 V goes, as long as all communicating circuits are fed from the same voltage.

Ground and V_{CC} Line Drops—The currents are normally so small that there is no need for heavy supply line bussing.

V_{CC} Decoupling—It can be reduced to a few capacitors per board.

Heat Problems—They do not exist, unless an attempt is made to run CMOS very fast and from more than 10 V.

It should also be noted that there are a few warnings called for when designing with CMOS and that many of the hard-earned good engineering basics cannot be forgotten. A few of the new design challenges include:

Unused Inputs—They must be connected to V_{SS} or V_{DD} (V_{CC} or ground) lest they generate a logical "maybe". The bad TTL habit of leaving unused inputs open is definitely out.

Oscillations—Slowly rising or falling input signals can lead to oscillations and multiple triggering. A poorly regulated and decoupled power supply magnifies this problem since the CMOS input threshold varies with the supply voltage.

Timing Details—Even slow systems require a careful analysis of worst case timing delays, derated for maximum temperature, minimum supply voltage and maximum capacitive loading. Many CMOS flip-flops, registers and latches have a real hold time requirement, *i.e.*, inputs must remain stable even after the active clock edge; some require a minimum clock rise time. This hasn't been a problem with TTL. CMOS systems, even slow ones, are prone to unsuspected clock skew problems, especially since a heavily loaded clock generator can have a poor rise time.

Compatibility—The TTL designer knows that devices sold by different manufacturers under the same generic part number are electrically almost identical. Many semiconductor houses manufacture 4000-type devices with wide variations in output drive capability and speed. Sometimes even the functions are different and incompatible; two cases in point are the 1-of-10 decoder (CD4028A and MC14028) and the magnitude comparator (MC14585 and MM74C85).

Data Sheet Format—The original CMOS data sheets may appear confusing to the TTL user because a range of input voltage requirements is not specified. Rather, this information is contained in a "noise immunity" specification and is not immediately obvious.

Both TTL and CMOS tolerate deviations from the ideal LOW and HIGH input voltages. TTL is therefore specified as follows:

	MIN	MAX	
V_{IH}	2.0		V
V_{IL}		0.8	V

Any voltage below 0.8 V is considered LOW; any voltage above +2.0 V is considered HIGH. The actual threshold is somewhere in between these values, depending on manufacturing tolerances, supply voltage, and temperature.

Fairchild's 4000B CMOS is specified in a similar way. For $V_{DD} = 5$ V;

	MIN	MAX	
V_{IH}	3.5		V
V_{IL}		1.5	V

The CD4000 data sheets, on the other hand, do not call out V_{IH} and V_{IL} but specify a "noise immunity" which is somewhat arbitrarily defined relative to the appropriate supply voltage.

$$V_{NL} = V_{IL}$$

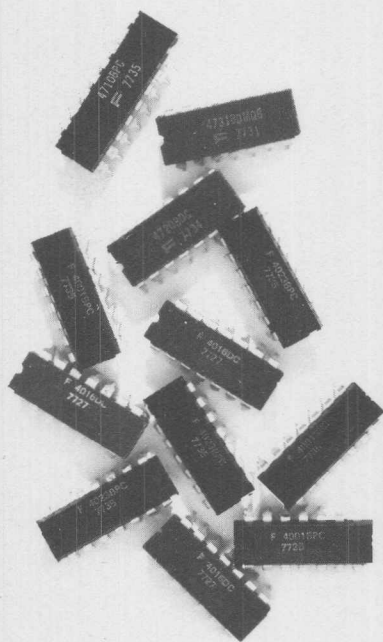
$$V_{NH} = V_{DD} - V_{IH}$$

For $V_{DD} = 5$ V, therefore

$V_{NL} = 1.5$ V min is equivalent to $V_{IL} = 1.5$ V max

$V_{NH} = 1.4$ V min is equivalent to $V_{IH} = 3.6$ V min, etc.

Systems Oriented MSI—Available CMOS circuits, especially the original 4000 series, are not as well suited for synchronous systems as are the 9300/7400 TTL families. Control polarities are inconsistent; many circuits cannot be cascaded or extended synchronously without additional gates, etc. This will improve as more good synchronous building blocks, like the 40160B are introduced.



FAIRCHILD FIELD SALES OFFICES,
SALES REPRESENTATIVES AND
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JEDEC Industry Standard "B" Series CMOS

Throughout first half of 1976 the CMOS vendor industry, in total, was invited to participate in the generation of a new JEDEC Industry Standard CMOS "B" Series specification. Unanimous agreement was reached and confirmed by industrywide ballot in late 1976.

This section is meant to extend knowledge of the new Industry Standard "B" Series CMOS specification to the customer and ensure that all Fairchild CMOS products meet or exceed all specifications of the new JEDEC standard.

In fact, since first introduction of the Isoplanar CMOS Family in 1973, all Fairchild CMOS products have been designed and tested to meet or exceed the more recently announced JEDEC specifications. The following is a compilation of the definitions and parametric specifications as listed in the JEDEC "Standard Specifications for description of 'B' Series CMOS devices".

ABSOLUTE MAXIMUM RATINGS

V _{DD}	-0.5 to +18	V _{DD}	DC Supply Voltage
V _{IN}	-0.5 to V _{DD} + 0.5	V _{IN}	Input Voltage
I _{IN}	±10	I _{IN}	DC Input Current
T _S	-55 to +150	T _S	Storage Temperature Range

RECOMMENDED OPERATING CONDITIONS

V _{DD}	+3 to +18	V _{DD}	DC Supply Voltage
T _A	-55 to +125	T _A	Operating Temperature Range
T _S	-55 to +150	T _S	Storage Temperature Range

(Formulated under the cognizance of the JEDEC JC-40.2 Committee on CMOS Standardization)

1. PURPOSE AND SCOPE

1. Purpose

To develop a standard of "B" Series CMOS Specifications to provide for uniformity, multiplicity of sources, elimination of confusion, and ease of device specification and system design by users.

1.2 Scope

This Tentative Standard covers standard specifications for description of "B" Series CMOS devices.

2. DEFINITIONS

2.1 "B" Series

"B" Series CMOS includes both buffered and unbuffered devices.

2.2 "Buffered"

A buffered output is one that has the characteristic that the output "on" impedance is independent of any and all valid input logic conditions, both preceding and present.

3. STANDARD SPECIFICATIONS

3.1 Listing of Standard DC Specifications. Table 6-2 lists the standard dc specifications for "B" Series CMOS devices.

3.2 Absolute Maximum Ratings. In the maximum ratings listed below voltages are referenced to V_{SS} .

ABSOLUTE MAXIMUM RATINGS

DC Supply Voltage	V_{DD}	-0.5 to +18	Vdc
Input Voltage	V_{IN}	-0.5 to $V_{DD} + 0.5$	Vdc
DC Input Current (any one input)	I_{IN}	± 10	mAdc
Storage Temperature Range	T_S	-65 to +150	°C

3.3 Recommended Operating Conditions. Recommended operating conditions are listed below.

RECOMMENDED OPERATING CONDITIONS

DC Supply Voltage	V_{DD}	+3 to +15	Vdc
Operating Temperature Range	T_A		
Military-Range Devices		-55 to +125	°C
Commercial-Range Devices		-40 to +85	°C

3.4 Designation of "B" Series CMOS Devices

Those parts which have analog inputs and/or outputs shall be included in the "B" Series providing those parts' maximum ratings and logical input and output parameters conform to the "B" Series, such as (including, but not limited to):

Schmitt Triggers
 Analog Switches and Multiplexers
 One Shot Multivibrators and Oscillators
 4511B BCD to 7-Segment Latch/Decoder/Driver
 4046B Micropower Phase Lock Loop

Products that meet "B" Series specifications except that the logical outputs are not buffered and the V_{IL} and V_{IH} specifications differ from "B" series as shown in Table 6-1 shall be marked with the UB designation, such as (including, but not limited to):

4007UB
 4069UB

Table 6-1. INPUT VOLTAGE LEVELS FOR "UB" PRODUCTS

PARAMETER	TEMP RANGE	V_{DD} (Vdc)	CONDITIONS	LIMITS			UNITS
				T_{LOW}	$25^{\circ}C$	T_{HIGH}	
V_{IL} (max)	Input LOW Voltage	All	$V_O =$ 5 0.5 V or 4.5 V	1	1	1	V
			10 1.0 V or 9.0 V	2	2	2	
			15 1.5 V or 13.5 V $ I_O \leq 1 \mu A$	2.5	2.5	2.5	
V_{IH} (min)	Input HIGH Voltage	All	$V_O =$ 5 0.5 V or 4.5 V	4	4	4	V
			10 1.0 V or 9.0 V	8	8	8	
			15 1.5 V or 13.5 V $ I_O \leq 1 \mu A$	12.5	12.5	12.5	

Table 6-2. STANDARDIZED "B" SERIES CMOS SPECIFICATIONS

SYMBOL	PARAMETER	TEMP. RANGE	V _{DD} (Vdc)	CONDITIONS	LIMITS						UNITS
					T _{LOW} *		+25°C		T _{HIGH} **		
					MIN	MAX	MIN	MAX	MIN	MAX	
I _{DD}	Quiescent Device Current	Mil	5	V _{IN} = V _{SS} or V _{DD}		0.25		0.25		7.5	μAdc
			10			0.5		0.5		15	
			15			1		1		30	
	GATES	Comm	5	All valid input combinations		1		1		7.5	μAdc
			10			2		2		15	
			15			4		4		30	
	BUFFERS, FLIP-FLOPS	Mil	5	V _{IN} = V _{SS} or V _{DD}		1		1		30	μAdc
			10			2		2		60	
			15			4		4		120	
		Comm	5	All valid input combinations		4		4		30	μAdc
			10			8		8		60	
			15			16		16		120	
	MSI	Mil	5	V _{IN} = V _{SS} or V _{DD}		5		5		150	μAdc
			10			10		10		300	
			15			20		20		600	
		Comm	5	All valid input combinations		20		20		150	μAdc
			10			40		40		300	
			15			80		80		600	
V _{OL}	LOW-Level Output Voltage	All	5	V _{IN} = V _{SS} or V _{DD} I _O < 1 μA		0.05		0.05		0.05	Vdc
			10			0.05		0.05		0.05	
			15			0.05		0.05		0.05	
V _{OH}	HIGH-Level Output Voltage	All	5	V _{IN} = V _{SS} or V _{DD} I _O < 1 μA	4.95		4.35		4.95		Vdc
			10		9.95		9.95		9.95		
			15		14.95		14.95		14.95		
V _{IL} ***	Input LOW Voltage	All	5	V _O = 0.5 V or 4.5 V V _O = 1 V or 9 V V _O = 1.5 V or 13.5 V I _O < 1 μA		1.5		1.5		1.5	Vdc
			10			3		3		3	
			15			4		4		4	
V _{IH} ***	Input HIGH Voltage	All	5	V _O = 0.5 V or 4.5 V V _O = 1 V or 9 V V _O = 1.5 V or 13.5 V I _O < 1 μA	3.5		3.5		3.5		Vdc
			10		7		7		7		
			15		11		11		11		
I _{OL}	Output LOW (Sink) Current	Mil	5	V _O = 0.4 V, V _{IN} = 0 or 5 V V _O = 0.5 V, V _{IN} = 0 or 10 V V _O = 1.5 V, V _{IN} = 0 or 15 V	0.64		0.51		0.36		mAdc
			10		1.6		1.3		0.9		
			15		4.2		3.4		2.4		
		Comm	5	V _O = 0.4 V, V _{IN} = 0 or 5 V V _O = 0.5 V, V _{IN} = 0 or 10 V V _O = 1.5 V, V _{IN} = 0 or 15 V	0.52		0.44		0.36		mAdc
			10		1.3		1.1		0.9		
			15		3.6		3		2.4		
I _{OH}	Output HIGH (Source) Current	Mil	5	V _O = 4.6 V, V _{IN} = 0 or 5 V V _O = 9.5 V, V _{IN} = 0 or 10 V V _O = 13.5 V, V _{IN} = 0 or 15 V	-0.25		-0.2		-0.14		mAdc
			10		-0.62		-0.5		-0.35		
			15		-1.8		-1.5		-1.1		
		Comm	5	V _O = 4.6 V, V _{IN} = 0 or 5 V V _O = 9.5 V, V _{IN} = 0 or 10 V V _O = 13.5 V, V _{IN} = 0 or 15 V	-0.2		-0.16		-0.12		mAdc
			10		-0.5		-0.4		-0.3		
			15		-1.4		-1.2		-1		
I _{IN}	Input Current	Mil	15	V _{IN} = 0 or 15 V		±0.1		±0.1		±1	μAdc
		Comm	15	V _{IN} = 0 or 15 V		±0.3		±0.3		±1	
I _{OZ}	3-State Output Leakage Current	Mil	15	V _O = 0 V or 15 V		±0.4		±0.4		±12	μAdc
		Comm	15	V _O = 0 V or 15 V		±1.6		±1.6		±12	
C _{IN}	Input Capacitance per Unit Load	All	—	Any input				7.5			pF

*T_{LOW} = -55°C for Military Temp. Range device, -40°C for Commercial Temp. Range device**T_{HIGH} = +125°C for Military Temp. Range device, +85°C for Commercial Temp. Range device***V_{IL} and V_{IH} specifications apply to worst case input combinations.

Figure 6-1 shows the standard AC (Dynamic) test configuration and conditions. Dynamic electrical symbols and parametric definitions are listed in Table 6-3. Figures 6-2 through 6-5 show standard AC characteristic test waveforms.

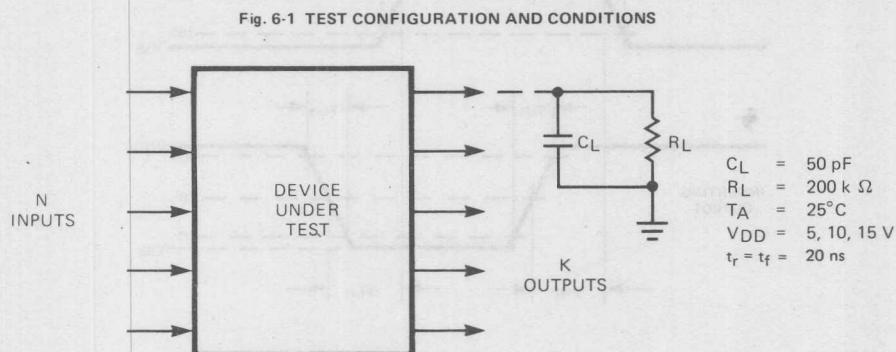


Table 6-3. DYNAMIC ELECTRICAL SYMBOLS AND DEFINITIONS

CHARACTERISTIC	SYMBOL	LIMITS		NOTES
		MAX.	MIN.	
PROPAGATION DELAY:				
Outputs going HIGH-to-LOW	t_{PHL}	X		
Outputs going LOW-to-HIGH	t_{PLH}	X		
OUTPUT TRANSITION TIME:				
Outputs going HIGH-to-LOW	t_{THL}	X		
Outputs going LOW-to-HIGH	t_{TLH}	X		
PULSE WIDTH — Set, Reset, Preset, Enable, Disable, Strobe, Clock	t_{WL} or t_{WH}		X	1
CLOCK INPUT FREQUENCY	F_{CL}		X	1, 2
CLOCK INPUT RISE & FALL TIME	t_{rCL}, t_{fCL}	X		
SET-UP TIME	t_{SU}		X	1
HOLD-TIME	t_H		X	1
REMOVAL TIME — Set, Reset, Preset, Enable	t_{REM}		X	1
THREE STATE DELAY TIMES:				
HIGH level-to-high impedance	t_{PHZ}	X		
High impedance-to-LOW level	t_{PZL}	X		
LOW level-to-high impedance	t_{PLZ}	X		
High impedance-to-HIGH level	t_{PZH}	X		

NOTES:

- 1) By placing a defining min or max in front of definition, the limits can change from min to max, or vice versa.
- 2) Clock input waveform should have a 50% duty cycle and be such as to cause the outputs to be switching from 10% V_{DD} to 90% V_{DD} in accordance with the device truth table.

Fig. 6-2 TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATIONAL LOGIC

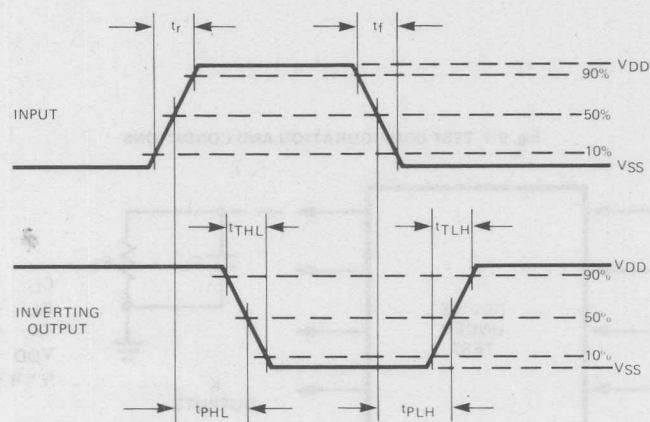
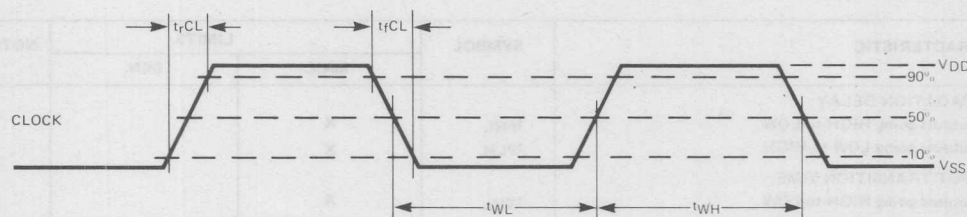


Fig. 6-3 CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH*



*Outputs should be switching from 10% V_{DD} to 90% V_{DD} in accordance with device truth table.

Fig. 6-4 SETUP TIMES, HOLD-TIMES, REMOVAL TIME, AND PROPAGATION DELAY TIMES FOR POSITIVE EDGE-TRIGGERED SEQUENTIAL LOGIC CIRCUITS.

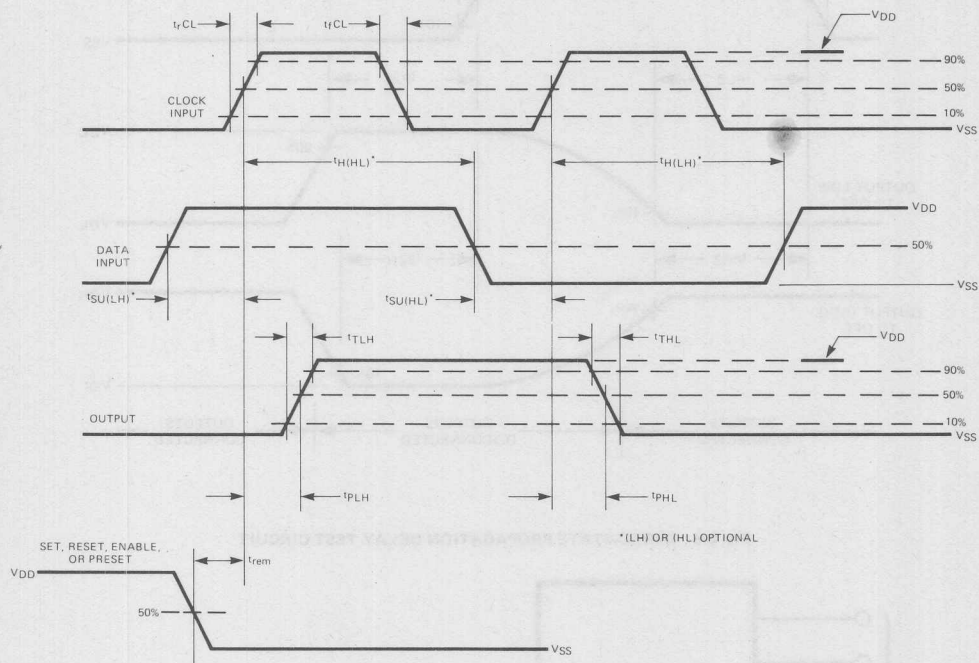


Fig. 6-5 3-STATE PROPAGATION DELAY WAVEFORMS

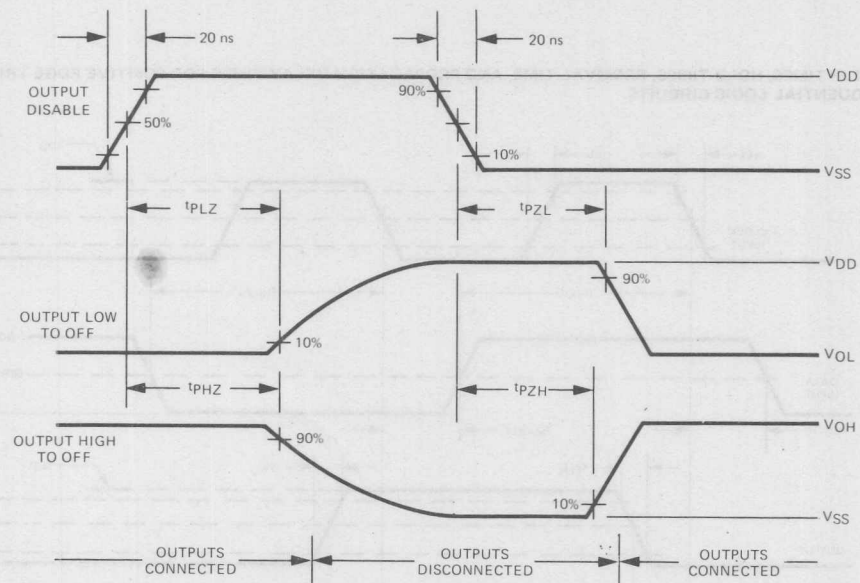
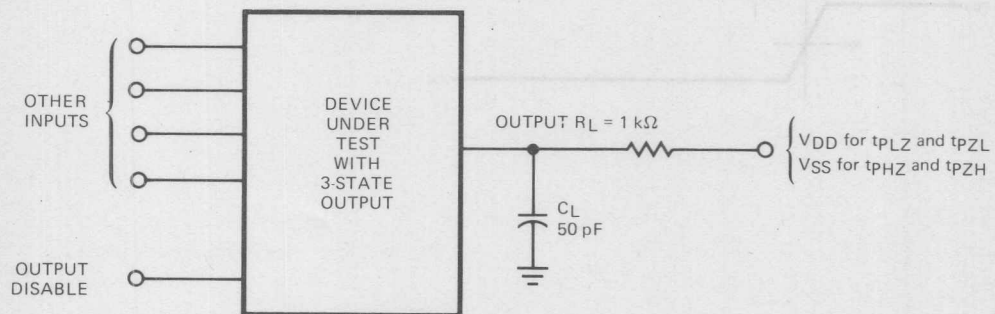


Fig. 6-6 THREE-STATE PROPAGATION DELAY TEST CIRCUIT



As defined by the above Industry Standard Specification, Fairchild offers the following devices:

4001B	4024B	4070B	4543B	40160B
4002B	4025B	4071B	4553B	40161B
4006B	4027B	4072B	4555B	40162B
4007UB	4028B	4073B	4557B	40163B
4008B	4029B	4075B	4560B	40174B
4011B	4030B	4076B	4561B	40175B
4012B	4031B	4077B	4566B	40192B
4013B	4034B	4078B	4581B	40193B
4014B	4035B	4081B	4582B	40194B
4015B	4040B	4082B	4583B	40195B
4016B	4041B	4085B	4702B	
4017B	4042B	4086B	4703B	
4018B	4043B	4093B	4704B	
4019B	4044B	4104B	4705B	
4020B	4045B	4510B	4706B	
4021B	4046B	4511B	4707B	
4022B	4047B	4512B	4708B	
4023B	4049B	4514B	4710B	
	4050B	4515B	4720B	
	4051B	4516B	4721B	
	4052B	4518B	4722B	
	4053B	4519B	4723B	
	4066B	4520B	4724B	
	4067B	4521B	4725B	
	4068B	4522B	4727B	
	4069UB	4526B	4731B	
		4527B	4734B	
		4528B	4735B	
		4531B	4736B	
		4532B	4737B	
		4534B	4741B	
		4538B	40085B	
		4539B	40097B	
			40098B	

To order Fairchild Industry Standard "B" Series CMOS . . .

ORDER AND PACKAGE INFORMATION

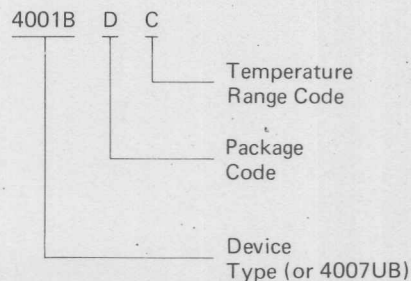
Fairchild integrated circuits may be ordered using a simplified purchasing code where the package style and temperature range are defined as follows:

PACKAGE CODE

- D = Dual In-line — Ceramic (hermetic)
- P = Dual In-line — Plastic
- F = Flatpak

TEMPERATURE RANGE CODE

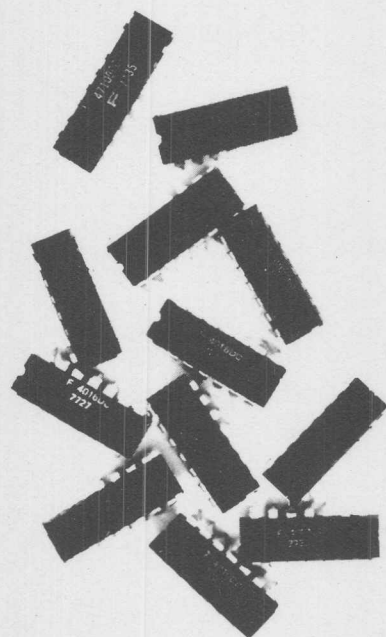
- C = Commercial
-40°C to +85°C
- M = Military
-55°C to +125°C



As defined by the above industry standard, the following table lists the part numbers for the various packages and temperatures.

40100	40101	40102	40103	40104	40105
40106	40107	40108	40109	40110	40111
40112	40113	40114	40115	40116	40117
40118	40119	40120	40121	40122	40123
40124	40125	40126	40127	40128	40129
40130	40131	40132	40133	40134	40135
40136	40137	40138	40139	40140	40141
40142	40143	40144	40145	40146	40147
40148	40149	40150	40151	40152	40153
40154	40155	40156	40157	40158	40159
40160	40161	40162	40163	40164	40165
40166	40167	40168	40169	40170	40171
40172	40173	40174	40175	40176	40177
40178	40179	40180	40181	40182	40183
40184	40185	40186	40187	40188	40189
40190	40191	40192	40193	40194	40195
40196	40197	40198	40199	40200	40201
40202	40203	40204	40205	40206	40207
40208	40209	40210	40211	40212	40213
40214	40215	40216	40217	40218	40219
40220	40221	40222	40223	40224	40225
40226	40227	40228	40229	40230	40231
40232	40233	40234	40235	40236	40237
40238	40239	40240	40241	40242	40243
40244	40245	40246	40247	40248	40249
40250	40251	40252	40253	40254	40255
40256	40257	40258	40259	40260	40261
40262	40263	40264	40265	40266	40267
40268	40269	40270	40271	40272	40273
40274	40275	40276	40277	40278	40279
40280	40281	40282	40283	40284	40285
40286	40287	40288	40289	40290	40291
40292	40293	40294	40295	40296	40297
40298	40299	40300	40301	40302	40303
40304	40305	40306	40307	40308	40309
40310	40311	40312	40313	40314	40315
40316	40317	40318	40319	40320	40321
40322	40323	40324	40325	40326	40327
40328	40329	40330	40331	40332	40333
40334	40335	40336	40337	40338	40339
40340	40341	40342	40343	40344	40345
40346	40347	40348	40349	40350	40351
40352	40353	40354	40355	40356	40357
40358	40359	40360	40361	40362	40363
40364	40365	40366	40367	40368	40369
40370	40371	40372	40373	40374	40375
40376	40377	40378	40379	40380	40381
40382	40383	40384	40385	40386	40387
40388	40389	40390	40391	40392	40393
40394	40395	40396	40397	40398	40399
40400	40401	40402	40403	40404	40405
40406	40407	40408	40409	40410	40411
40412	40413	40414	40415	40416	40417
40418	40419	40420	40421	40422	40423
40424	40425	40426	40427	40428	40429
40430	40431	40432	40433	40434	40435
40436	40437	40438	40439	40440	40441
40442	40443	40444	40445	40446	40447
40448	40449	40450	40451	40452	40453
40454	40455	40456	40457	40458	40459
40460	40461	40462	40463	40464	40465
40466	40467	40468	40469	40470	40471
40472	40473	40474	40475	40476	40477
40478	40479	40480	40481	40482	40483
40484	40485	40486	40487	40488	40489
40490	40491	40492	40493	40494	40495
40496	40497	40498	40499	40500	40501
40502	40503	40504	40505	40506	40507
40508	40509	40510	40511	40512	40513
40514	40515	40516	40517	40518	40519
40520	40521	40522	40523	40524	40525
40526	40527	40528	40529	40530	40531
40532	40533	40534	40535	40536	40537
40538	40539	40540	40541	40542	40543
40544	40545	40546	40547	40548	40549
40550	40551	40552	40553	40554	40555
40556	40557	40558	40559	40560	40561
40562	40563	40564	40565	40566	40567
40568	40569	40570	40571	40572	40573
40574	40575	40576	40577	40578	40579
40580	40581	40582	40583	40584	40585
40586	40587	40588	40589	40590	40591
40592	40593	40594	40595	40596	40597
40598	40599	40600	40601	40602	40603
40604	40605	40606	40607	40608	40609
40610	40611	40612	40613	40614	40615
40616	40617	40618	40619	40620	40621
40622	40623	40624	40625	40626	40627
40628	40629	40630	40631	40632	40633
40634	40635	40636	40637	40638	40639
40640	40641	40642	40643	40644	40645
40646	40647	40648	40649	40650	40651
40652	40653	40654	40655	40656	40657
40658	40659	40660	40661	40662	40663
40664	40665	40666	40667	40668	40669
40670	40671	40672	40673	40674	40675
40676	40677	40678	40679	40680	40681
40682	40683	40684	40685	40686	40687
40688	40689	40690	40691	40692	40693
40694	40695	40696	40697	40698	40699
40700	40701	40702	40703	40704	40705
40706	40707	40708	40709	40710	40711
40712	40713	40714	40715	40716	40717
40718	40719	40720	40721	40722	40723
40724	40725	40726	40727	40728	40729
40730	40731	40732	40733	40734	40735
40736	40737	40738	40739	40740	40741
40742	40743	40744	40745	40746	40747
40748	40749	40750	40751	40752	40753
40754	40755	40756	40757	40758	40759
40760	40761	40762	40763	40764	40765
40766	40767	40768	40769	40770	40771
40772	40773	40774	40775	40776	40777
40778	40779	40780	40781	40782	40783
40784	40785	40786	40787	40788	40789
40790	40791	40792	40793	40794	40795
40796	40797	40798	40799	40800	40801
40802	40803	40804	40805	40806	40807
40808	40809	40810	40811	40812	40813
40814	40815	40816	40817	40818	40819
40820	40821	40822	40823	40824	40825
40826	40827	40828	40829	40830	40831
40832	40833	40834	40835	40836	40837
40838	40839	40840	40841	40842	40843
40844	40845	40846	40847	40848	40849
40850	40851	40852	40853	40854	40855
40856	40857	40858	40859	40860	40861
40862	40863	40864	40865	40866	40867
40868	40869	40870	40871	40872	40873
40874	40875	40876	40877	40878	40879
40880	40881	40882	40883	40884	40885
40886	40887	40888	40889	40890	40891
40892	40893	40894	40895	40896	40897
40898	40899	40900	40901	40902	40903
40904	40905	40906	40907	40908	40909
40910	40911	40912	40913	40914	40915
40916	40917	40918	40919	40920	40921
40922	40923	40924	40925	40926	40927
40928	40929	40930	40931	40932	40933
40934	40935	40936	40937	40938	40939
40940	40941	40942	40943	40944	40945
40946	40947	40948	40949	40950	40951
40952	40953	40954	40955	40956	40957
40958	40959	40960	40961	40962	40963
40964	40965	40966	40967	40968	40969
40970	40971	40972	40973	40974	40975
40976	40977	40978	40979	40980	40981
40982	40983	40984	40985	40986	40987
40988	40989	40990	40991	40992	40993
40994	40995	40996	40997	40998	40999

1 - Over 100000 units/year, 2 - 10000 to 100000 units/year, 3 - 1000 to 10000 units/year, 4 - 100 to 1000 units/year, 5 - 10 to 100 units/year, 6 - 1 to 10 units/year, 7 - 0.1 to 1 units/year, 8 - 0.01 to 0.1 units/year, 9 - 0.001 to 0.01 units/year, 10 - 0.0001 to 0.001 units/year, 11 - 0.00001 to 0.0001 units/year, 12 - 0.000001 to 0.00001 units/year, 13 - 0.0000001 to 0.000001 units/year, 14 - 0.00000001 to 0.0000001 units/year, 15 - 0.000000001 to 0.00000001 units/year, 16 - 0.0000000001 to 0.000000001 units/year, 17 - 0.00000000001 to 0.0000000001 units/year, 18 - 0.000000000001 to 0.00000000001 units/year, 19 - 0.0000000000001 to 0.000000000001 units/year, 20 - 0.00000000000001 to 0.0000000000001 units/year, 21 - 0.000000000000001 to 0.00000000000001 units/year, 22 - 0.0000000000000001 to 0.000000000000001 units/year, 23 - 0.00000000000000001 to 0.0000000000000001 units/year, 24 - 0.000000000000000001 to 0.00000000000000001 units/year, 25 - 0.0000000000000000001 to 0.000000000000000001 units/year, 26 - 0.00000000000000000001 to 0.0000000000000000001 units/year, 27 - 0.000000000000000000001 to 0.00000000000000000001 units/year, 28 - 0.0000000000000000000001 to 0.000000000000000000001 units/year, 29 - 0.00000000000000000000001 to 0.0000000000000000000001 units/year, 30 - 0.000000000000000000000001 to 0.00000000000000000000001 units/year, 31 - 0.0000000000000000000000001 to 0.000000000000000000000001 units/year, 32 - 0.00000000000000000000000001 to 0.0000000000000000000000001 units/year, 33 - 0.000000000000000000000000001 to 0.00000000000000000000000001 units/year, 34 - 0.0000000000000000000000000001 to 0.00000000000000000000000001 units/year, 35 - 0.00000000000000000000000000001 to 0.000000000000000000000000001 units/year, 36 - 0.000000000000000000000000000001 to 0.00000000000000000000000000001 units/year, 37 - 0.0000000000000000000000000000001 to 0.000000000000000000000000000001 units/year, 38 - 0.00000000000000000000000000000001 to 0.0000000000000000000000000000001 units/year, 39 - 0.000000000000000000000000000000001 to 0.00000000000000000000000000000001 units/year, 40 - 0.0000000000000000000000000000000001 to 0.000000000000000000000000000000001 units/year, 41 - 0.00000000000000000000000000000000001 to 0.000000000000000000000000000000001 units/year, 42 - 0.000000000000000000000000000000000001 to 0.0000000000000000000000000000000001 units/year, 43 - 0.0000000000000000000000000000000000001 to 0.0000000000000000000000000000000001 units/year, 44 - 0.00000000000000000000000000000000000001 to 0.0000000000000000000000000000000001 units/year, 45 - 0.000000000000000000000000000000000000001 to 0.0000000000000000000000000000000001 units/year, 46 - 0.0000000000000000000000000000000000000001 to 0.0000000000000000000000000000000001 units/year, 47 - 0.001 to 0.0000000000000000000000000000000001 units/year, 48 - 0.0001 to 0.0000000000000000000000000000000001 units/year, 49 - 0.001 to 0.0000000000000000000000000000000001 units/year, 50 - 0.00



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FAIRCHILD 4000B SERIES

CMOS FAMILY CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS (Non-operating) above which useful life may be impaired. All voltages are referenced to V_{SS} .

Supply Voltage V_{DD}	−0.5 to 18 V
Voltage on any Input	−0.5 to $V_{DD} + 0.5$ V
Current into any Input	±10 mA
Maximum Power Dissipation	400 mW
Storage Temperature	−65° C to 150° C
Lead Temperature (Soldering, 10 s)	300° C

RECOMMENDED OPERATING CONDITIONS

Fairchild CMOS will operate over a recommended V_{DD} power supply range of 3 to 15 V, as referenced to V_{SS} (usually ground). Parametric limits are guaranteed for V_{DD} equal to 5, 10 and 15 V. Where low power dissipation is required, the lowest power supply voltage, consistent with required speed, should be used. For larger noise immunity, higher power supply voltages should be specified. Because of its wide operating range, power supply regulation and filtering are less critical than with other types of logic. The lower limit of supply regulation is 3 V, or as determined by required system speed and/or noise immunity or interface to other logic. The recommended upper limit is 15 V or as determined by power dissipation constraints or interface to other logic.

Unused inputs must be connected to V_{DD} , V_{SS} or another input.

Care should be used in handling CMOS devices; large static charges may damage the device.

Operating temperature ranges are −40° C to +85° C for Commercial and −55° C to +125° C for Military.

PARAMETER	4000BXC			4000BXM			UNITS
	MIN	TYP	MAX	MIN	TYP	MAX	
Supply Voltage, V_{DD}	3		15	3		15	V
Operating Free Air Temperature Range	−40	+25	+85	−55	+25	+125	°C

X - Package Type; F for Flatpak, D for Ceramic DIP, P for Plastic DIP. See Ordering Information section.

FAIRCHILD 4000B SERIES CMOS FAMILY CHARACTERISTICS


DC CHARACTERISTICS FOR THE 4000B SERIES CMOS FAMILY — Parametric Limits listed below are guaranteed for the entire Fairchild CMOS Family unless otherwise specified on the individual data sheets.

DC CHARACTERISTICS: $V_{DD} = 5\text{ V}$, $V_{SS} = 0\text{ V}$

SYMBOL	PARAMETER		LIMITS			UNITS	TEMP	TEST CONDITIONS		
			MIN	TYP	MAX					
V _{IH}	Input HIGH Voltage		3.5			V	All	Guaranteed Input HIGH Voltage		
V _{IL}	Input LOW Voltage				1.5	V	All	Guaranteed Input Low Voltage		
V _{OH}	Output HIGH Voltage		4.95			V	Min, 25° C	I _{OH} < 1 μA, Inputs at 0 or 5 V per the Logic Function or Truth Table		
			4.95			V	MAX			
			4.5			V	All	I _{OH} < 1 μA, Inputs at 1.5 or 3.5 V		
V _{OL}	Output LOW Voltage				0.05	V	MIN, 25° C	I _{OL} < 1 μA, Inputs at 0 or 5 V per the Logic Function or Truth Table		
					0.05	V	MAX			
					0.5	V	All	I _{OL} < 1 μA, Inputs at 1.5 or 3.5 V		
I _{OH}	Output HIGH Current		-0.63			mA	MIN, 25° C	V _{OUT} =	Inputs at 0 or 5 V per the Logic Function or Truth Table	
			-0.36				MAX	4.6 V		
I _{OL}	Output LOW Current		1			mA	MIN, 25° C	V _{OUT} =		
			0.8				MAX	0.4 V		
			0.4				MAX			
C _{IN}	Input Capacitance Per Unit Load				7.5	pF	25° C	Any Input		
I _{DD}	Quiescent Power Supply Current	Gates	XC		1	μA	MIN, 25° C	All Inputs at 0 V or V _{DD} for all Valid Input Combinations		
					7.5		MAX			
			XM		0.25	μA	MIN, 25° C			
					7.5		MAX			
		Buffers and Flip-Flops	XC		4	μA	MIN, 25° C			
					30		MAX			
			XM		1	μA	MIN, 25° C			
					30		MAX			
		MSI	XC		20	μA	MIN, 25° C			
					150		MAX			
			XM		5	μA	MIN, 25° C			
					150		MAX			

FAIRCHILD 4000B SERIES CMOS FAMILY CHARACTERISTICS

DC CHARACTERISTICS: $V_{DD} = 10\text{ V}$, $V_{SS} = 0\text{ V}$

SYMBOL	PARAMETER			LIMITS		UNITS	TEMP	TEST CONDITIONS		
				MIN	TYP					MAX
V _{IH}	Input HIGH Voltage			7			V	All	Guaranteed Input HIGH Voltage	
V _{IL}	Input LOW Voltage					3	V	All	Guaranteed Input LOW Voltage	
V _{OH}	Output HIGH Voltage			9.95			V	MIN, 25°C	I _{OH} < 1 μA, Inputs at 0 V or 10 V per the Logic Function or Truth Table	
				9.95			V	MAX		
V _{OL}	Output LOW Voltage			9			V	All	I _{OL} < 1 μA, Inputs at 3 or 7 V	
						0.05	V	MIN, 25°C		
						0.05	V	MAX		
						1	V	All	I _{OL} < 1 μA, Inputs at 3 or 7 V	
I _{OH}	Output HIGH Current			-1.4			mA	MIN, 25°C	V _{OUT} = 9.5 V	Inputs at 0 or 10 V per the Logic Function or Truth Table
				-0.8				MAX		
I _{OL}	Output LOW Current			2.6			mA	MIN,	V _{OUT} = 0.5 V	
				2				25°C		
				1.2				MAX		
C _{IN}	Input Capacitance Per Unit Load					7.5	pF	25°C	Any Input	
I _{DD}	Quiescent Power Supply Current	Gates			2	μA	MIN, 25°C	All Inputs at 0 V or V _{DD} for All Valid Input Combinations		
					15		MAX			
			XM		0.5	μA	MIN, 25°C			
					15		MAX			
		Buffers, Flip-Flops	XC		8	μA	MIN, 25°C			
					60		MAX			
			XM		2	μA	MIN, 25°C			
					60		MAX			
		MSI	XC		40	μA	MIN, 25°C			
					300		MAX			
			XM		10	μA	MIN, 25°C			
					300		MAX			

SYMBOL	PARAMETER		LIMITS			UNITS	TEMP	TEST CONDITIONS	
			MIN	TYP	MAX				
V _{IH}	Input HIGH Voltage		11			V	All	Guaranteed Input HIGH Voltage	
V _{IL}	Input LOW Voltage				4	V	All	Guaranteed Input LOW Voltage	
V _{OH}	Output HIGH Voltage		14.95			V	MIN, 25°C	I _{OH} < 1 μA, Inputs at 0 or 15 V per the Logic Function or Truth Table	
			14.95				MAX		
			13.5			V	All	I _{OH} < 1 μA, Inputs at 4 or 11 V	
V _{OL}	Output LOW Voltage				0.05	V	MIN, 25°C	I _{OL} < 1 μA, Inputs at 0 or 15 V per the Logic Function or Truth Table	
					0.05		MAX		
					1.5	V	All	I _{OL} < 1 μA, Inputs at 4 or 11 V	
I _{IN}	Input Current	XC			0.3 1	μA	MIN, 25°C MAX	Lead under test at 0 or 15 V	
		XM			0.1 1	μA	MIN, 25°C MAX	All other Inputs Simultaneously at 0 or 15 V	
I _{OH}	Output HIGH Current		-4.5 -2.7			mA	MIN, 25°C MAX	V _{OUT} = 13.5 V	Inputs at 0 or 15 V per the Logic Function or Truth Table
I _{OL}	Output LOW Current		7.5 4.5			mA	MIN, 25°C MAX	V _{OUT} = 1.5 V	
C _{IN}	Input Capacitance Per Unit Load				7.5	pF	25°C	Any Input	
I _{DD}	Quiescent Power Supply Current	Gates	XC		4	μA	MIN, 25°C	All Inputs at 0 V or V _{DD} for all Valid Input Conditions	
					30		MAX		
			XM		1	μA	MIN, 25°C		
					30		MAX		
		Buffers, Flip-Flops	XC		16	μA	MIN, 25°C		
					120		MAX		
			XM		4	μA	MIN, 25°C		
					120		MAX		
		MSI	XC		80	μA	MIN, 25°C		
					600		MAX		
			XM		20	μA	MIN, 25°C		
					600		MAX		

TYPICAL FAIRCHILD 4000B SERIES CHARACTERISTICS

Fig. 7-1
POSITIVE-GOING
PROPAGATION DELAY
VERSUS SUPPLY VOLTAGE

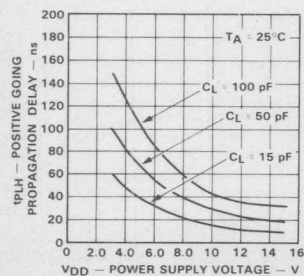


Fig. 7-2
NEGATIVE-GOING
PROPAGATION DELAY
VERSUS SUPPLY VOLTAGE

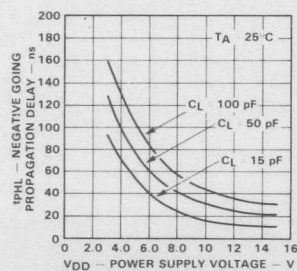
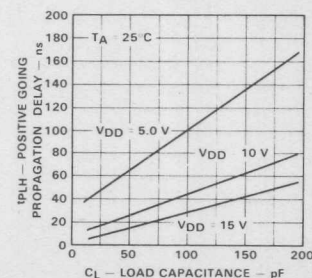


Fig. 7-3
POSITIVE-GOING
PROPAGATION DELAY
VERSUS LOAD CAPACITANCE



FAIRCHILD 4000B SERIES CMOS FAMILY CHARACTERISTICS

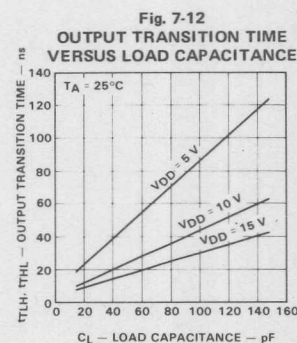
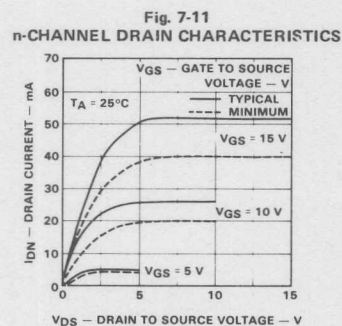
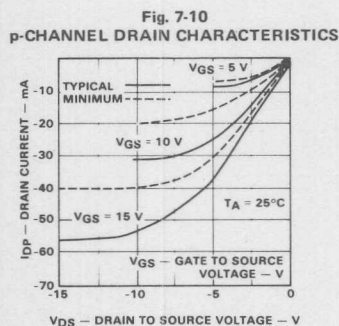
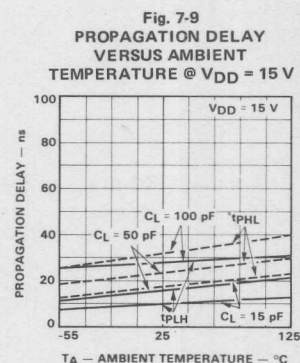
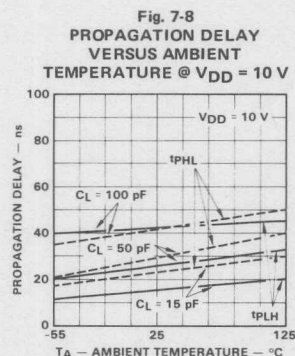
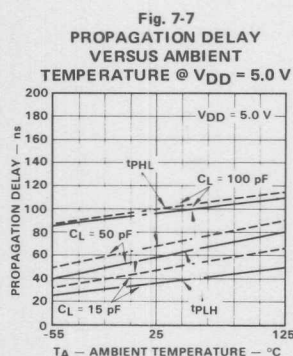
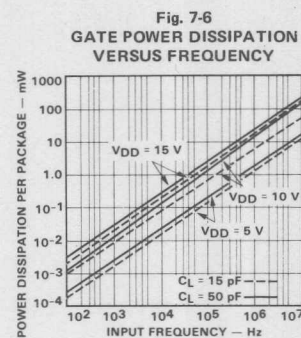
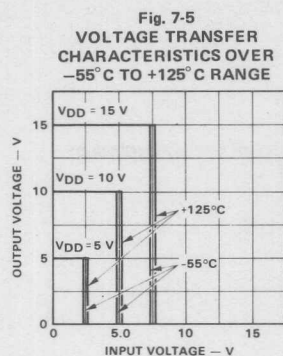
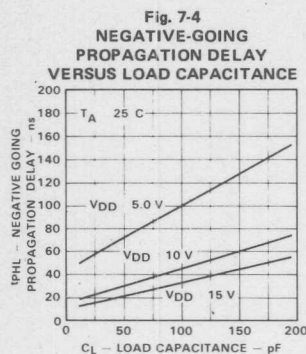
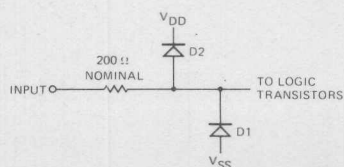


Fig. 7-13
INPUT PROTECTION CIRCUIT



INPUT CIRCUITRY

All inputs are protected by the network of Figure 7-13; a series input resistor plus diodes D1 and D2 clamp input voltages between V_{SS} and V_{DD} . Forward conduction of these diodes is typically 0.9 V at 1 mA. When V_{SS} or V_{DD} is not connected, avalanche breakdown of the diodes limit input voltage; D1 typically breaks down at 20 V, D2 at 20 V. In normal logic operation the diodes never conduct, but for certain special applications such as oscillators, circuit operation may actually depend on diode conduction. Operation in this mode is permissible so long as input currents do not exceed 10 mA.

Input capacitance is typically 5 pF across temperature for any input.

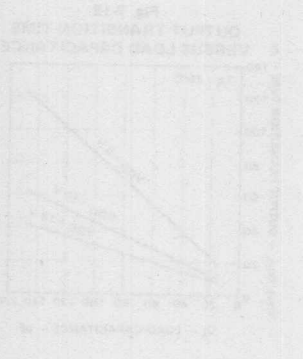
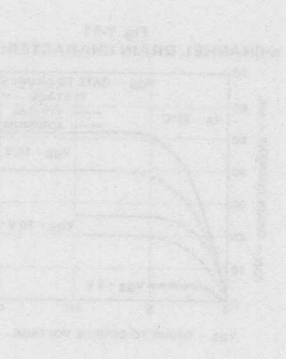
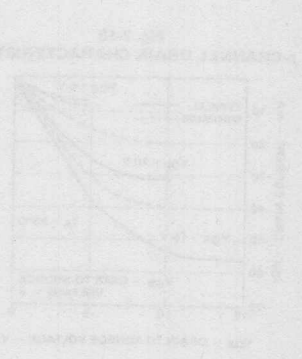
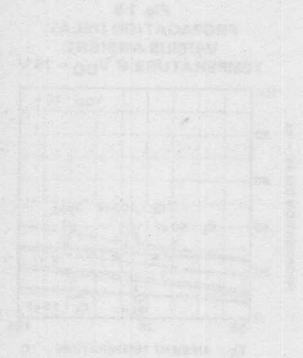
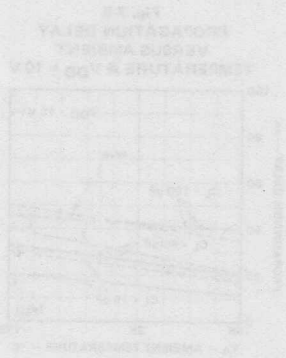
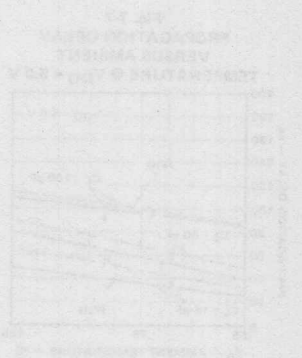
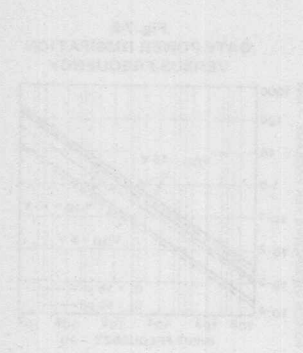
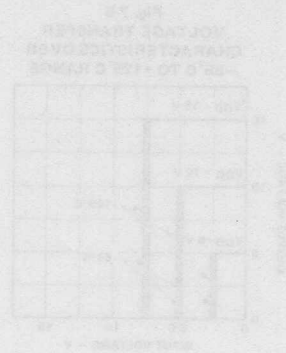


FIG. 7-10
INPUT PROTECTION CIRCUIT



INPUT PROTECTION
All inputs are protected by the network of diodes shown in Figure 7-10. A series resistor is connected to the input terminal. The diodes are connected to V_{DD} and ground. The resistors are connected to the input terminal. The network provides protection against electrostatic discharge (ESD) and other input damage.

DEFINITION OF SYMBOLS AND TERMS

CURRENTS — Positive current is defined as conventional current flow into a device. Negative current is defined as conventional current flow out of a device.

I_{IN} — (Input Current) — The current flowing into a device at specified input voltage and V_{DD} .

I_{OH} — (Output HIGH Current) — The drive current flowing out of the device at specified HIGH output voltage and V_{DD} .

I_{OL} — (Output LOW Current) — The drive current flowing into the device at specified LOW output voltage and V_{DD} .

I_{DD} — (Quiescent Power Supply Current) — The current flowing into the V_{DD} lead at specified input and V_{DD} conditions.

I_{OZH} — (Output OFF Current HIGH) — The leakage current flowing into the output of a 3-state device in the "OFF" state at a specified HIGH output voltage and V_{DD} .

I_{OZL} — (Output OFF Current LOW) — The leakage current flowing out of a 3-state device in the "OFF" state at a specified HIGH output voltage and V_{DD} .

I_{IL} — (Input Current LOW) — The current flowing into a device at a specified LOW level input voltage and a specified V_{DD} .

I_{IH} — (Input Current HIGH) — The current flowing into a device at a specified HIGH level input voltage and a specified V_{DD} .

I_{DDL} — (Quiescent Power Supply Current LOW) — The current flowing into the V_{DD} lead with a specified LOW level input voltage on all inputs and specified V_{DD} conditions.

I_{DDH} — (Quiescent Power Supply Current HIGH) — The current flowing into the V_{DD} lead with a specified HIGH level input voltage on all inputs and specified V_{DD} conditions.

I_Z — (OFF State Leakage Current) — The leakage current flowing into the output of a 3-state device in the "OFF" state at a specified output voltage and V_{DD} .

VOLTAGES — All voltages are referenced to V_{SS} (or V_{EE}) which is the most negative potential applied to the device.

V_{DD} — (Drain Voltage) — The most positive potential on the device.

V_{IH} — (Input HIGH Voltage) — The range of input voltages that represents a logic HIGH level in the system.

V_{IL} — (Input LOW Voltage) — The range of input voltages that represents a logic LOW level in the system.

$V_{IH}(\min)$ — (Minimum Input HIGH Voltage) — The minimum allowed input HIGH level in a logic system.

$V_{IL}(\max)$ — (Maximum Input LOW Voltage) — The maximum allowed input LOW level in a system.

V_{OH} — (Output HIGH Voltage) — The range of voltages at an output terminal with specified output loading and supply voltage. Device inputs are conditioned to establish a HIGH level at the output.

V_{OL} — (Output LOW Voltage) — The range of voltages at an output terminal with specified output loading and supply voltage. Device inputs are conditioned to establish a LOW level at the output.

V_{SS} — (Source Voltage) — For a device with a single negative power supply, the most negative power supply, used as the reference level for other voltages. Typically ground.

V_{EE} — (Source Voltage) — One of two (V_{SS} and V_{EE}) negative power supplies. For a device with dual negative power supplies, the most negative power supply used as a reference level for other voltages.

ANALOG TERMS

R_{ON} — (ON Resistance) — The effective "ON" state resistance of an analog transmission gate, at specified input voltage, output load and V_{DD} .

ΔR_{ON} — ("Δ" ON Resistance) — The difference in effective "ON" resistance between any two transmission gates of an analog device at specified input voltage, output load and V_{DD} .

tial circuit with the output of the circuit changing between 10% of V_{DD} and 90% of V_{DD} . Above this frequency the device may cease to function. See Figure 7-15.

t_{PLH} — (Propagation Delay Time) — The time between the specified reference points, normally 50% points on the input and output voltage waveforms, with the output changing from the defined LOW level to the defined HIGH level. See Figure 7-14.

t_{PHL} — (Propagation Delay Time) — The time between the specified reference points, normally 50% points on the input and output voltage waveforms, with the output changing from the defined HIGH level to the defined LOW level. See Figure 7-14.

t_{TLH} — (Transition Time, LOW to HIGH) — The time between two specified reference points on a waveform, normally 10% to 90% of V_{DD} , which is changing from LOW to HIGH. See Figure 7-14.

t_{THL} — (Transition Time, HIGH to LOW) — The time between two specified reference points on a waveform, normally 90% to 10% of V_{DD} , which is changing from HIGH to LOW. See Figure 7-14.

t_w — (Pulse Width) — The time between 50% amplitude points on the leading and trailing edges of pulse.

t_h — (Hold Time) — The interval immediately following the active transition of the timing pulse (usually the clock pulse) or following the transition of the control input to its latching level, during which interval the data to be recognized must be maintained at the input to ensure its continued recognition. A negative hold time indicates that the correct logic level may be released prior to the active transition of the timing pulse and still be recognized.

t_s — (Set-up Time) — The interval immediately preceding the active transition of the timing pulse (usually the clock pulse) or preceding the transition of the control input to its latching level, during which interval the data to be recognized must be maintained at the input to ensure its recognition. A negative set-up time indicates that the correct logic level may be initiated sometime after the active transition of the timing pulse and still be recognized.

t_{PHZ} — (3-State Output Disable Time, HIGH to Z) — The time between the specified reference points, normally the 50% point on the Output Enable input voltage waveform and a point representing a 0.1 V_{DD} drop on the Output voltage waveform of a 3-state device, with the output changing from the defined HIGH level to a high impedance OFF state.

t_{PLZ} — (3-State Output Disable Time, LOW to Z) — The time between the specified reference points, normally the 50% point on the Output Enable input voltage waveform and a point representing a 0.1 V_{DD} rise on the Output voltage waveform of a 3-state device, with the output changing from the defined LOW level to a high impedance OFF state.

t_{PZH} — (3-State Output Enable Time, Z to HIGH) — The time between the specified reference points, normally the 50% point on the Output Enable input voltage waveform and a point representing 0.5 V_{DD} on the Output voltage waveform of a 3-state device, with the output changing from a high impedance OFF state to the defined HIGH level.

t_{PZL} — (3-State Output Enable Time, Z to LOW) — The time between the specified reference points, normally the 50% point on the Output Enable input voltage waveform and a point representing 0.5 V_{DD} on the Output voltage waveform of a 3-state device, with the output changing from a high impedance OFF state to the defined LOW level.

t_{rec} — (Recovery Time) — The time between the end of an overriding asynchronous input, typically a Clear or Reset input, and the earliest allowable beginning of a synchronous control input, typically a Clock input, normally measured at 50% points on both input voltage waveforms.

t_{CW} (Clock Period) — The time between 50% amplitude points on the leading edges of a clock pulse.

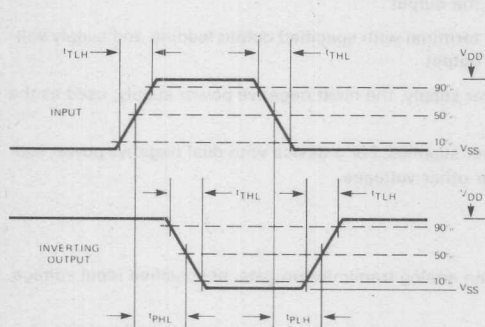


Fig. 7-14. Propagation Delay, Transition Time

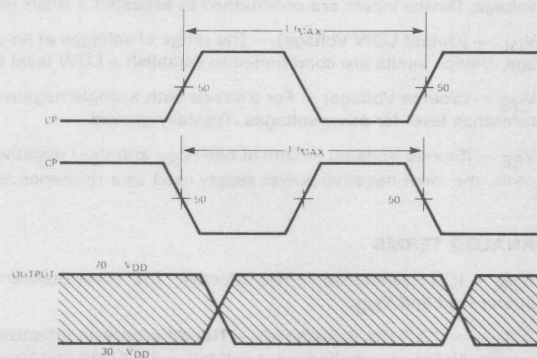


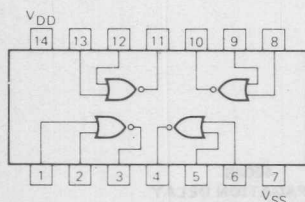
Fig. 7-15. Maximum Operating Frequency

4001B 4002B

QUAD 2-INPUT NOR GATE • DUAL 4-INPUT NOR GATE

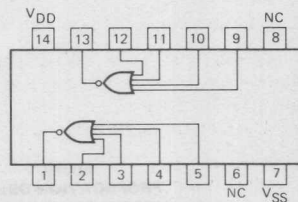
DESCRIPTION – These CMOS logic elements provide the positive input NOR function. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

4001B
LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak versions have the same pinouts (Connection Diagram) as the Dual In-line Package.

4002B
LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C, 4001B only (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS See Note 2
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		60	110		25	60		20	48	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			60	110		25	60		20	48	ns	
t _{TLH}	Output Transition Time		60	135		30	70		20	45	ns	Input Transition Times ≤ 20 ns
t _{THL}			60	135		30	70		20	45	ns	

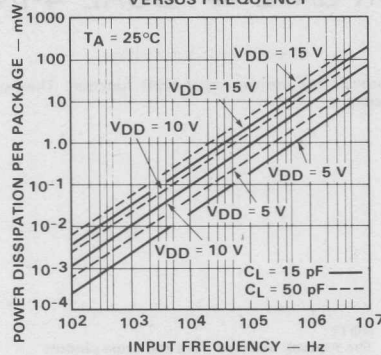
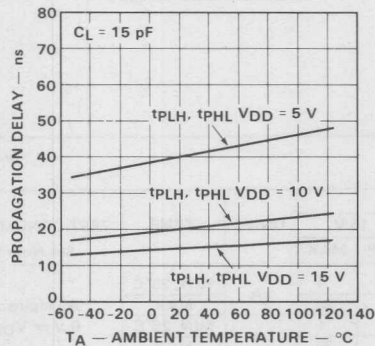
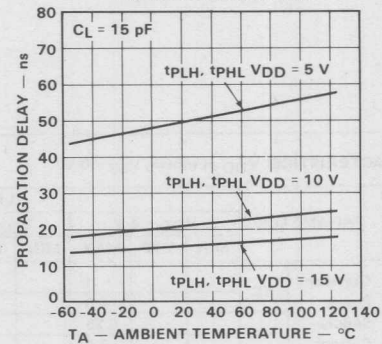
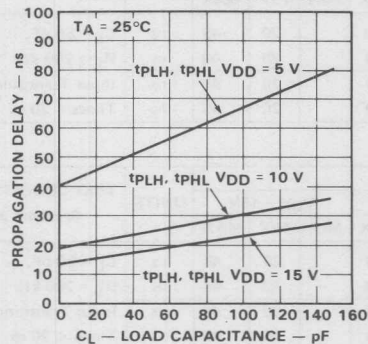
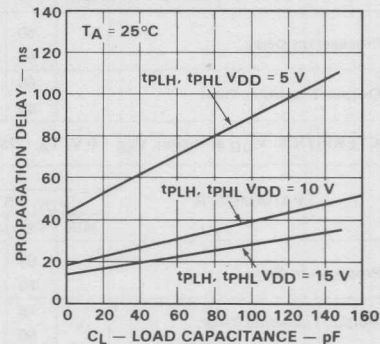
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C, 4002B only

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS See Note 2
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		65	110		30	60		20	48	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			70	110		30	60		23	48	ns	
t _{TLH}	Output Transition Time		75	135		40	70		30	45	ns	Input Transition Times ≤ 20 ns
t _{THL}			60	135		23	70		15	45	ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS

4001B AND 4002B
POWER DISSIPATION
VERSUS FREQUENCY4001B
PROPAGATION DELAY
VERSUS TEMPERATURE4002B
PROPAGATION DELAY
VERSUS TEMPERATURE4001B
PROPAGATION DELAY
VERSUS LOAD CAPACITANCE4002B
PROPAGATION DELAY
VERSUS LOAD CAPACITANCE

4006B

18-STAGE STATIC SHIFT REGISTER

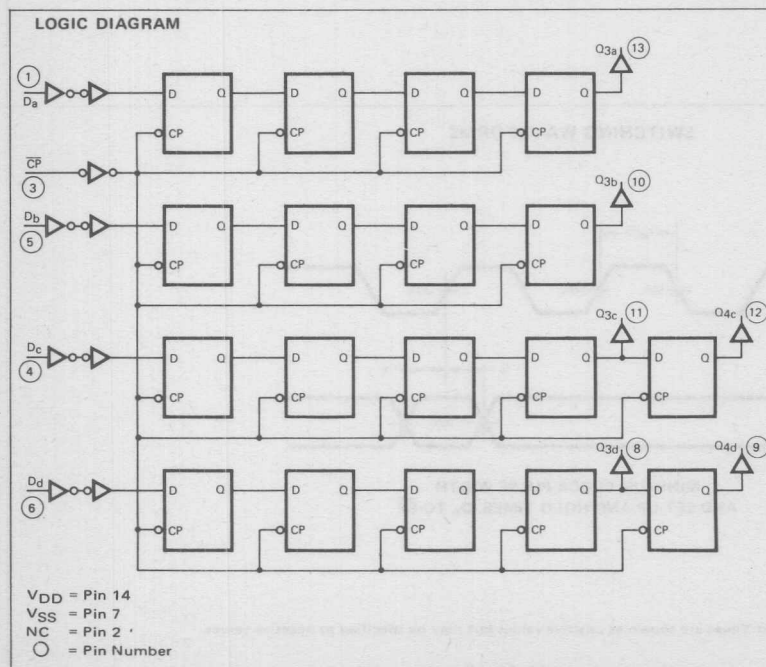
DESCRIPTION — The 4006B is an 18-stage Shift Register arranged as two 4-stage and two 5-stage shift registers with a common Clock Input (CP). The two 4-stage shift registers, each have a Data Input (D_a, D_b) and a Data Output (Q_{3a}, Q_{3b}); the two 5-stage shift registers each have a Data Input (D_c, D_d) and Data Outputs from the fourth and fifth stages ($Q_{3c}, Q_{4c}, Q_{3d}, Q_{4d}$).

The registers can be operated in parallel or interconnected to form a single shift register of up to 18 bits. Data is shifted into the first register position of each register from the Data Inputs (D_a, D_b, D_c, D_d) and all the data in each register is shifted one position to the right on the HIGH-to-LOW transition of the Clock Input (CP).

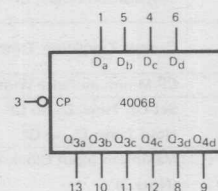
- CLOCK EDGE-TRIGGERED ON A HIGH-TO-LOW TRANSITION
- CASCADABLE
- SERIAL-TO-SERIAL DATA TRANSFER

PIN NAMES

D_a, D_b, D_c, D_d Data Inputs
 CP Clock Input (H→L Edge-Triggered)
 $Q_{3a}, Q_{3b}, Q_{3c}, Q_{3d}, Q_{4c}, Q_{4d}$ Data Outputs

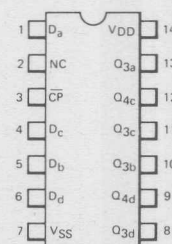


LOGIC SYMBOL



V_{DD} = Pin 14
 V_{SS} = Pin 7
 NC = Pin 2

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

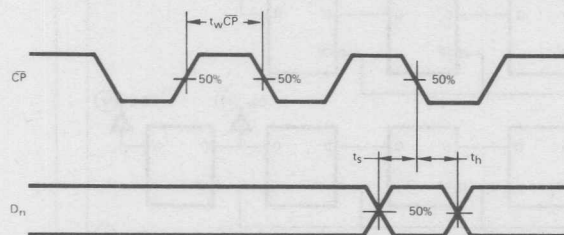
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, \overline{CP} to any Q _n		90	200		39	100		30	80	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			90	200		35	100		25	80		
t _{TLH}	Output Transition Time		60	135		30	75		20	45	ns	
t _{THL}			60	135		30	75		20	45		
t _{wCP}	\overline{CP} Minimum Pulse Width	100	50		50	20		40	13		ns	
t _s	Set-Up Time, D _n to \overline{CP}	30	12		15	5		15	5		ns	
t _h	Hold Time, D _n to \overline{CP}	10	1		10	4		10	4			
f _{MAX}	Maximum Input Clock Frequency (Note 3)	8	19		15	30		18	36		MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μs at $V_{DD} = 5\text{ V}$, 4 μs at $V_{DD} = 10\text{ V}$, and 3 μs at $V_{DD} = 15\text{ V}$.

SWITCHING WAVEFORMS



MINIMUM CLOCK PULSE WIDTH
AND SET-UP AND HOLD TIMES, D_n TO \overline{CP}

NOTE: Set-up and Hold Times are shown as positive values but may be specified as negative values.

4007UB

DUAL COMPLEMENTARY PAIR PLUS INVERTER

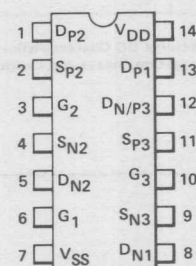
DESCRIPTION — The 4007UB is a Dual Complementary Pair and an Inverter with access to each device. It has three n-channel and three p-channel enhancement mode MOS transistors. For proper operation $V_{SS} \leq V_1 \leq V_{DD}$.

- INPUT DIODE PROTECTION ON ALL INPUTS
- DRAINS AND SOURCES TO N- AND P-CHANNEL TRANSISTORS AVAILABLE

PIN NAMES

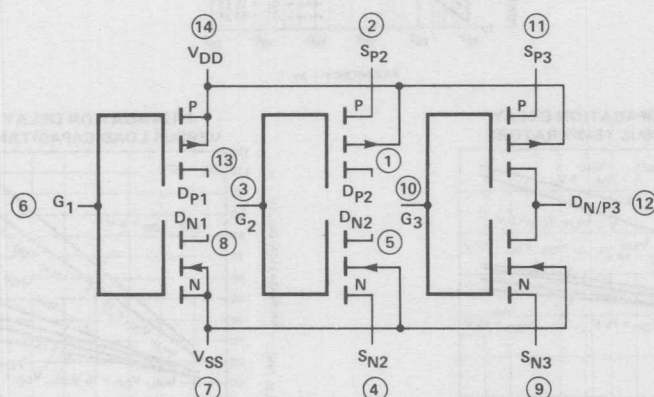
SP2, SP3 Source Connection to Second and Third p-channel Transistors
 DP1, DP2 Drain Connection from the First and Second p-channel Transistors
 DN1, DN2 Drain Connection from the First and Second n-channel Transistors
 SN2, SN3 Source Connection to the Second and Third n-channel Transistors
 DN/P3 Common Connection to the Third p-channel and n-channel Transistor Drains
 G1-G3 Gate Connection to n- and p-channel Transistors 1, 2 and 3

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

LOGIC SYMBOL



FAIRCHILD CMOS • 4007UB

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

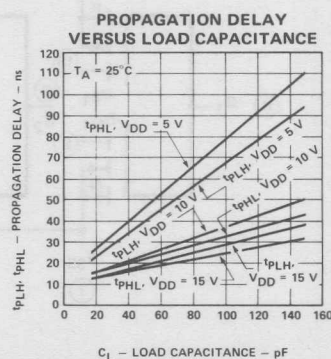
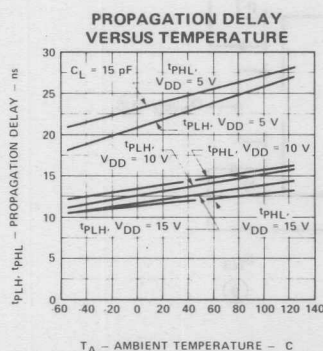
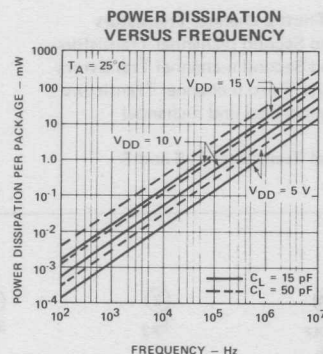
SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power Supply Current	XC			1 7.5			2 15			4 30	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
		XM			0.25 7.5			0.5 15			1 30	μA	MIN, 25°C MAX	

AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		42	85		23	40		18	32	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			42	85		23	40		18	32	ns	
t _{TLH}	Output Transition Time		65	135		30	70		25	45	ns	Input Transition Times ≤ 20 ns
t _{THL}			65	135		30	70		25	45	ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.



4008B

4-BIT BINARY FULL ADDER

DESCRIPTION — The 4008B is a 4-Bit Binary Full Adder with two 4-bit Data Inputs (A_0 – A_3 , B_0 – B_3); a Carry Input (C_0), four Sum Outputs (S_0 – S_3) and a Carry Output (C_4).

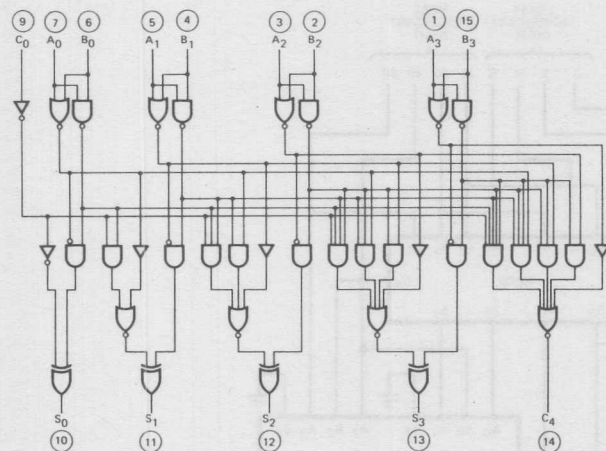
The 4008B uses full lookahead across 4-bits to generate the Carry Output (C_4). This minimizes the necessity for extensive "lookahead" and carry-cascading circuits.

- CARRY LOOKAHEAD BUFFERED OUTPUT
- EASILY CASCADED

PIN NAMES

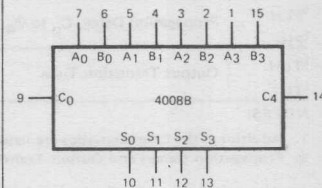
A_0 – A_3 , B_0 – B_3	Data Inputs
C_0	Carry Input
S_0 – S_3	Sum Outputs
C_4	Carry Output

LOGIC DIAGRAM



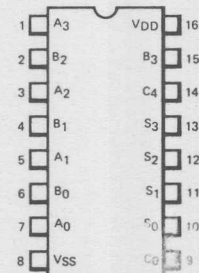
V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Number

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP(TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					100			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, V_{SS} = 0 V, T_A = 25°C (see Note 2)

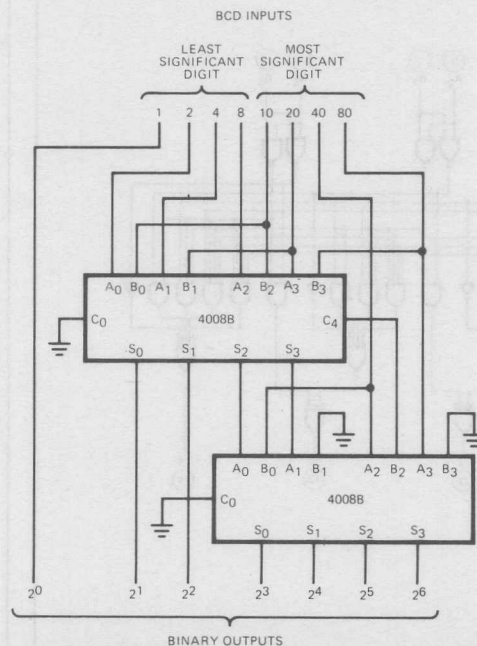
SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, A _n , B _n to S _n		150	300		60	140		50	110	ns	C _L = 50 pF, R _L = 200 kΩ, Input Transition Times ≤ 20 ns
t _{PHL}			150	300		60	140		50	110	ns	
t _{PLH}	Propagation Delay, A _n , B _n to C ₄		138	275		63	130		50	100	ns	
t _{PHL}			138	275		63	130		50	100	ns	
t _{PLH}	Propagation Delay, C _O to S _n		115	250		69	115		52	90	ns	
t _{PHL}			123	250		69	115		52	90	ns	
t _{PLH}	Propagation Delay, C _O to C ₄		72	200		28	95		23	75	ns	
t _{PHL}			95	200		28	95		23	75	ns	
t _{TLH}	Output Transition Time		60	135		30	75		20	45	ns	
t _{THL}				60	135		30	75		20	45	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

APPLICATION

A 2-DIGIT BCD TO 7-BIT BINARY DECODER USING THE 4008B

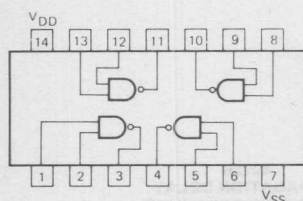


4011B • 4012B

4011B QUAD 2-INPUT NAND GATE

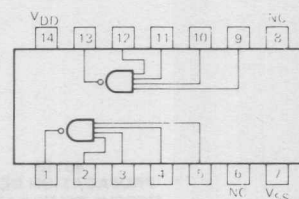
4012B DUAL 4-INPUT NAND GATE

4011B
LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak versions have the same pinouts
(Connection Diagram) as the Dual In-line
Package.

4012B
LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$, 4011B only (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS See Note 2
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		60	110		25	60		20	48	ns	C _L = 50 pF,
t _{PHL}			60	110		25	60		20	48	ns	R _L = 200 kΩ
t _{TLH}	Output Transition Time		60	135		30	70		20	45	ns	Input Transition
t _{THL}			60	135		30	70		20	45	ns	Times ≤ 20 ns

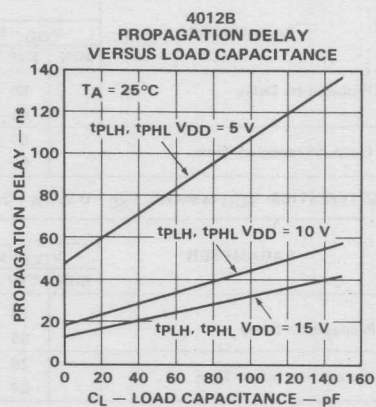
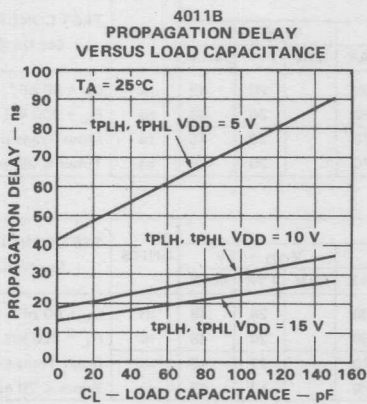
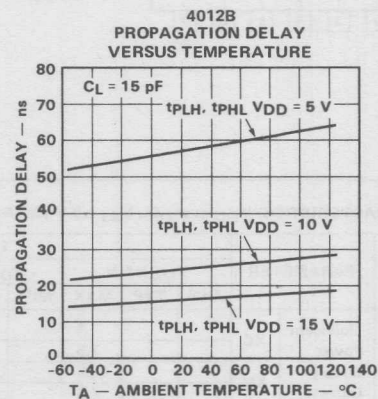
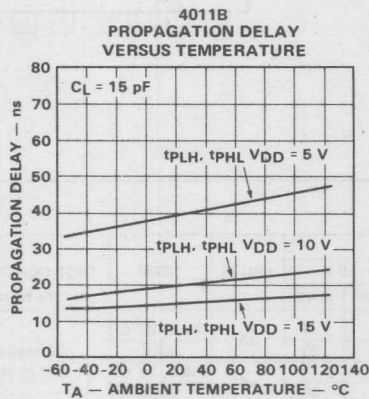
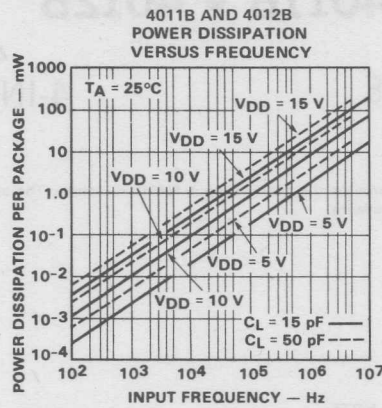
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$, 4012B only

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS See Note 2
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		73	110		33	60		24	48	ns	C _L = 50 pF,
t _{PHL}			85	110		31	60		20	48	ns	R _L = 200 kΩ
t _{TLH}	Output Transition Time		76	135		37	70		27	45	ns	Input Transition
t _{THL}			67	135		25	70		17	45	ns	Times ≤ 20 ns

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS



4013B DUAL D FLIP-FLOP

DESCRIPTION — The 4013B is a CMOS Dual D Flip-Flop which is edge-triggered and features independent Set Direct, Clear Direct, and Clock inputs. Data is accepted when the Clock is LOW and transferred to the output on the positive-going edge of the Clock. The active HIGH asynchronous Clear Direct (C_D) and Set Direct (S_D) are independent and override the D or Clock inputs. The outputs are buffered for best system performance.

PIN NAMES

D	Data Input
CP	Clock Input (L→H Edge-Triggered)
S_D	Asynchronous Set Direct Input (Active HIGH)
C_D	Asynchronous Clear Direct Input (Active HIGH)
Q	True Output
\bar{Q}	Complement Output

4013B TRUTH TABLES

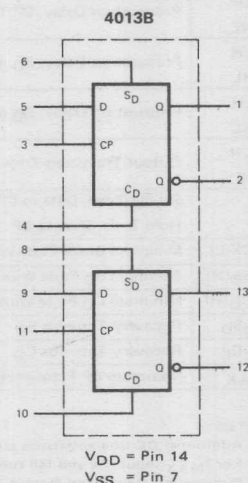
ASYNCHRONOUS INPUTS		OUTPUTS	
S_D	C_D	Q	\bar{Q}
L	H	L	H
H	L	H	L
H	H	H	H

L = LOW Level
H = HIGH Level
┐ = Positive-Going Transition
 Q_{n+1} = State After Clock Positive Transition

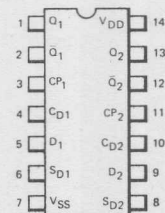
SYNCHRONOUS INPUTS		OUTPUTS	
CP	D	Q_{n+1}	\bar{Q}_{n+1}
┐	L	L	H
┐	H	H	L

Conditions: $S_D = C_D = \text{LOW}$

LOGIC SYMBOL



CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

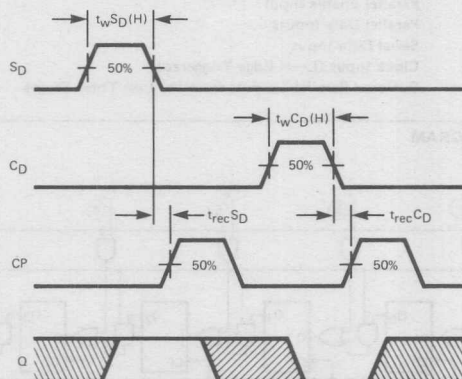
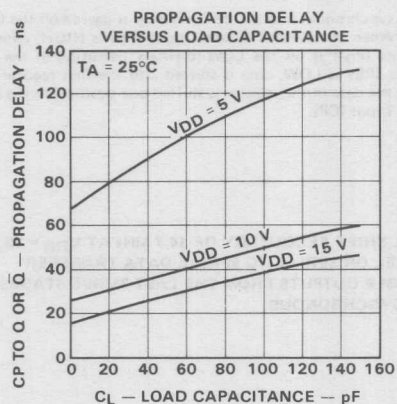
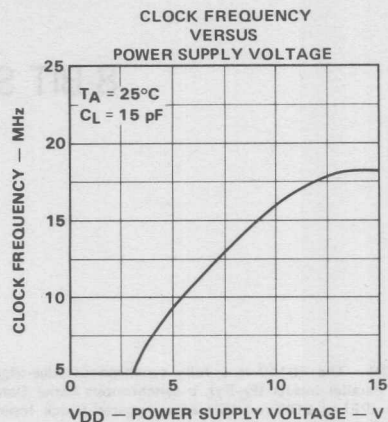
SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			4			8			16	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					30			60			120		MAX	
	Supply Current	XM			1			2			4	μA	MIN, 25°C	
					30			60			120		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP TO Q, \bar{Q}		95	200		38	90		29	72	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			95	200		38	90		29	72	ns	
t _{PLH}	Propagation Delay, S _D or C _D to \bar{Q}		130	225		45	110		32	88	ns	
t _{PHL}			75	225		35	110		20	88	ns	
t _{PLH}	Propagation Delay, S _D or C _D to Q		115	225		50	110		35	88	ns	
t _{PHL}			115	225		50	110		35	88	ns	
t _{TLH}	Output Transition Time		60	135		30	70		20	45	ns	
t _{THL}			60	135		30	70		20	45	ns	
t _s	Set-Up Time, Data to CP	60	30		30	15		24	8		ns	
t _h	Hold Time, Data to CP	0	-25		0	-12		0	-6		ns	
t _{wCP(L)}	Minimum Clock Pulse Width	100	55		55	30		44	18		ns	
t _{wS_D(H)}	Minimum S _D Pulse Width	60	30		30	15		24	10		ns	
t _{wC_D(H)}	Minimum C _D Pulse Width	60	30		30	15		24	10		ns	
t _{recS_D}	Recovery Time for S _D	20	8		10	2		8	2		ns	
t _{recC_D}	Recovery Time for C _D	30	15		15	7		12	6		ns	
f _{MAX}	Maximum CP Frequency (Note 2)	5	8		8	16		9	19		MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. For t_{MAX} input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
3. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.



RECOVERY TIME FOR S_D , RECOVERY TIME FOR C_D ,
MINIMUM S_D PULSE WIDTH, AND MINIMUM C_D PULSE WIDTH

7-23

4014B

8-BIT SHIFT REGISTER

DESCRIPTION — The 4014B is a fully synchronous edge-triggered 8-Bit Shift Register with eight synchronous Parallel Inputs (P_0 - P_7), a synchronous Serial Data Input (D_S), a synchronous Parallel Enable Input (PE), a LOW-to-HIGH edge-triggered Clock Input (CP) and Buffered Parallel Outputs from the last three stages (Q_5 - Q_7).

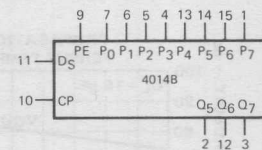
Operation is synchronous and the device is edge-triggered on the LOW-to-HIGH transition of the Clock Input (CP). When the Parallel Enable Input (PE) is HIGH, data is loaded into the register from the Parallel Inputs (P_0 - P_7) on the LOW-to-HIGH transition of the Clock Input (CP). When the Parallel Enable Input (PE) is LOW, data is shifted into the first register position from the Serial Data Input (D_S) and all the data in the register is shifted one position to the right on the LOW-to-HIGH transition of the Clock Input (CP).

- TYPICAL SHIFT FREQUENCY OF 14.7 MHz AT $V_{DD} = 10$ V
- PARALLEL OR SERIAL TO SERIAL DATA TRANSFER
- AVAILABLE OUTPUTS FROM THE LAST THREE STAGES
- FULLY SYNCHRONOUS

PIN NAMES

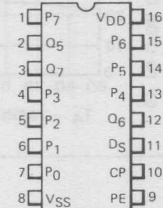
PE	Parallel Enable Input
P_0 - P_7	Parallel Data Inputs
D_S	Serial Data Input
CP	Clock Input (L→H Edge-Triggered)
Q_5 , Q_6 , Q_7	Buffered Parallel Outputs from the Last Three Stages

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

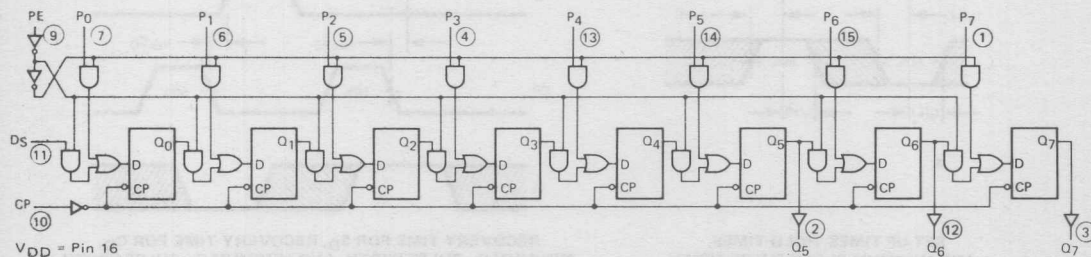
CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
○ = Pin Number

FAIRCHILD CMOS • 4014B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power Supply Current	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	XM			5			10			20	μA	MIN, 25°C		
				150			300			600		MAX		

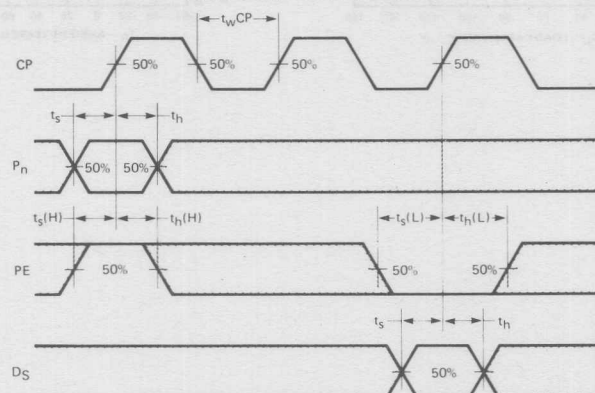
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to any Q		129	275		57	120		41	96	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			165	350		68	120		47	96	ns	
t _{TLH}	Output Transition Time		70	135		37	75		21	45	ns	
t _{THL}			77	135		34	75		21	45	ns	
t _{wCP}	CP Minimum Pulse Width	200	93		100	33		80	22		ns	
t _s	Set-Up Time PE to CP	300	118		80	44		64	29		ns	
t _h	Hold Time PE to CP	25	15		5	3		4	2		ns	
t _s	Set-Up Time D _S to CP	200	80		50	28		40	17		ns	
t _h	Hold Time D _S to CP	10	5		0	-1		0	-1		ns	
t _s	Set-Up Time P _n to CP	250	108		100	37		80	23		ns	
t _h	Hold Time P _n to CP	20	10		5	3		4	2		ns	
f _{MAX}	Max. Input Clock Frequency (Note 3)	2	5.8		5	14.7		6	17		MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

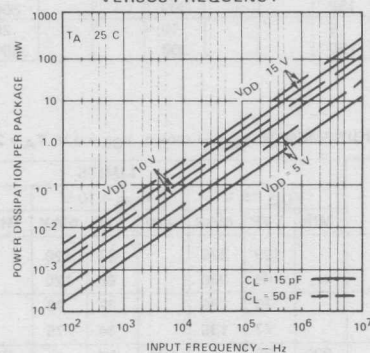
SWITCHING WAVEFORMS



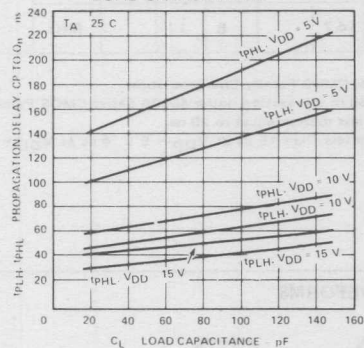
**MINIMUM CLOCK PULSE WIDTH
AND SET-UP AND HOLD TIMES, PE TO CP, D_S TO CP, AND P_n TO CP**

NOTE: Set-up and Hold Times are shown as positive values but may be specified as negative values.

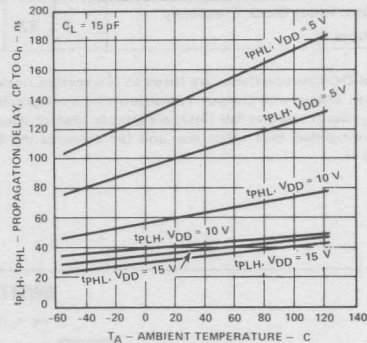
POWER DISSIPATION VERSUS FREQUENCY



PROPAGATION DELAY, CP TO Q_n VERSUS LOAD CAPACITANCE



PROPAGATION DELAY, CP TO Q_n VERSUS TEMPERATURE



4015B

DUAL 4-BIT STATIC SHIFT REGISTER

DESCRIPTION — The 4015B is a Dual Edge-Triggered 4-Bit Static Shift Register (Serial-to-Parallel Converter). Each Shift Register has a Serial Data Input (D), a Clock Input (CP), four fully buffered parallel Outputs (Q_0 – Q_3) and an overriding asynchronous Master Reset Input (MR).

Information present on the serial Data Input (D) is shifted into the first register position, and all the data in the register is shifted one position to the right on the LOW-to-HIGH transition of the Clock Input (CP).

A HIGH on the Master Reset Input (MR) clears the register and forces the Outputs (Q_0 – Q_3) LOW, independent of the Clock and Data Inputs (CP and D).

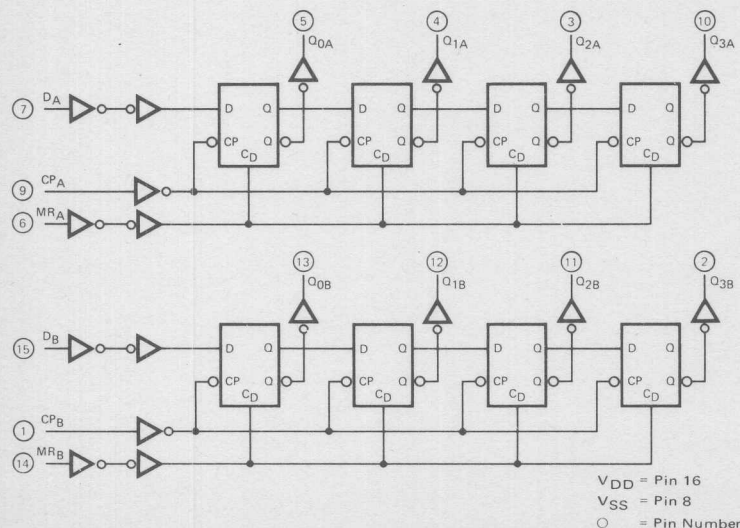
- TYPICAL SHIFT FREQUENCY OF 14 MHz AT $V_{DD} = 10\text{ V}$
- ASYNCHRONOUS MASTER RESET
- SERIAL-TO-PARALLEL DATA TRANSFER
- FULLY BUFFERED OUTPUTS FROM EACH STAGE

PIN NAMES

D_A, D_B
 MR_A, MR_B
 CP_A, CP_B
 $Q_{0A}, Q_{1A}, Q_{2A}, Q_{3A}$
 $Q_{0B}, Q_{1B}, Q_{2B}, Q_{3B}$

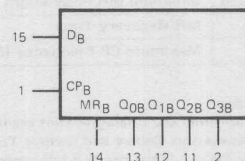
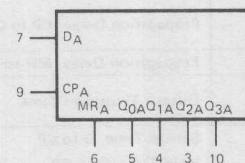
Serial Data Input
 Master Reset Input (Active HIGH)
 Clock Input (L→H Edge-Triggered)
 Parallel Outputs
 Parallel Outputs

LOGIC DIAGRAM



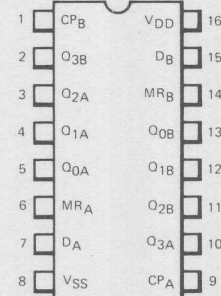
LOGIC SYMBOL

4015B



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4015B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

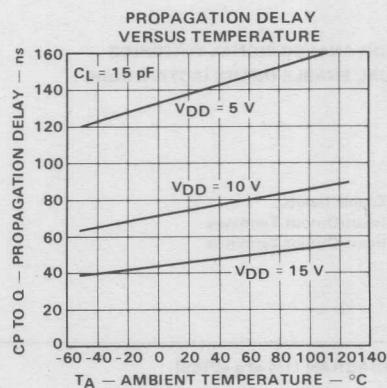
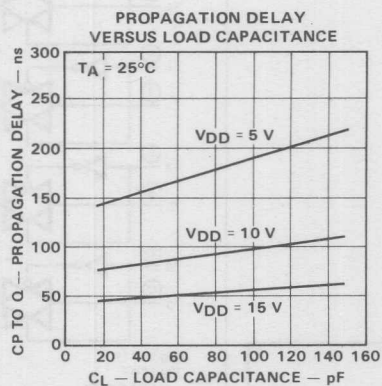
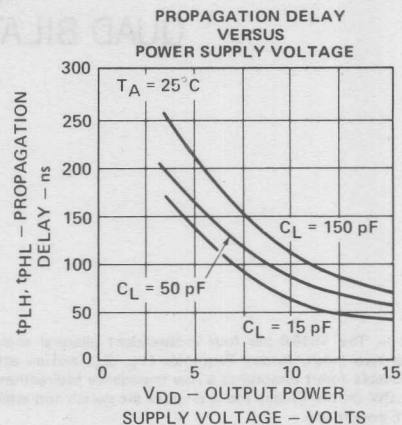
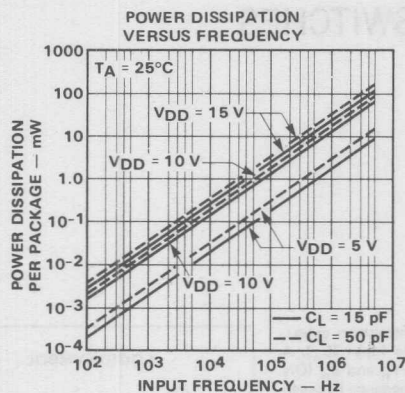
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q		165	300		85	150		50	120	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			165	300		85	150		50	120	ns	
t _{PHL}	Propagation Delay, MR to Q		180	325		90	160		60	128	ns	
t _{TLH}	Output Transition Time		85	150		45	85		30	50	ns	
t _{THL}			85	150		45	85		30	50	ns	
t _s	Set-Up Time, D to CP	150	70		50	30		40	25		ns	
t _h	Hold Time, D to CP	0	-5		0	-20		0	-10		ns	
t _{wCP(L)}	Minimum Clock Pulse Width	120	60		70	35		56	25		ns	
t _{wMR(H)}	Minimum MR Pulse Width	75	40		45	25		36	20		ns	
t _{rec}	MR Recovery Time	300	160		120	60		96	45		ns	
f _{MAX}	Maximum CP Frequency (Note 3)	4	8		7	14		8	16		MHz	

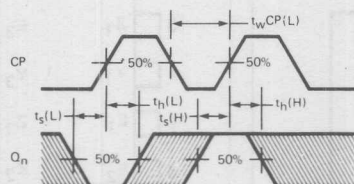
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

TYPICAL ELECTRICAL CHARACTERISTICS



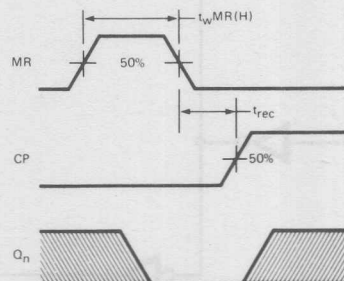
SWITCHING WAVEFORMS



SET-UP TIMES, HOLD TIMES AND MINIMUM CLOCK PULSE WIDTH

NOTE:

t_s and t_h are shown as positive values but may be specified as negative values.



RECOVERY TIME FOR MR AND MINIMUM MR PULSE WIDTH

4010B QUAD BILATERAL SWITCHES

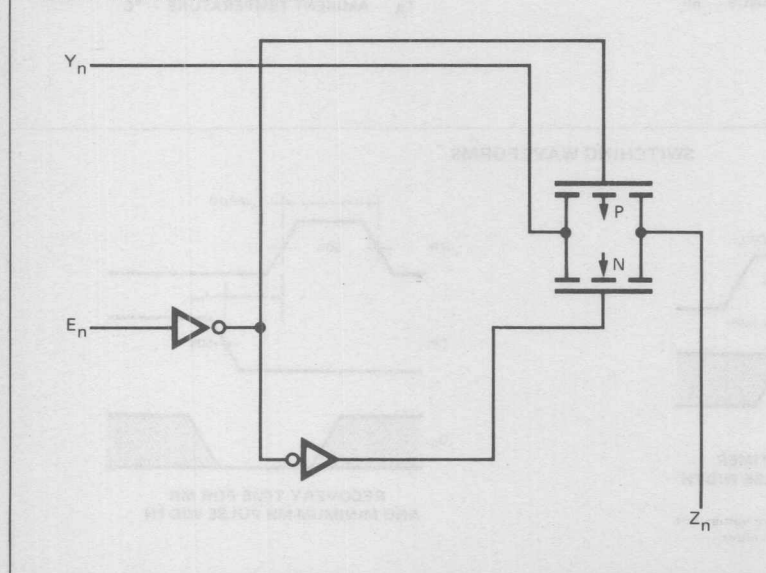
DESCRIPTION — The 4010B has four independent bilateral analog switches (transmission gates). Each switch has two Input/Output Terminals (Y_n , Z_n) and an active HIGH Enable Input (E_n). A HIGH on the Enable Input establishes a low impedance bidirectional path between Y_n and Z_n (ON condition). A LOW on the Enable Input disables the switch and establishes a high impedance between Y_n and Z_n (OFF condition).

- DIGITAL OR ANALOG SIGNAL SWITCHING
- INDIVIDUAL ENABLE INPUTS (ACTIVE HIGH)

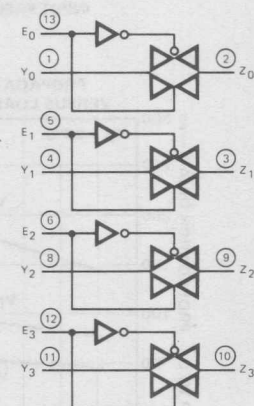
PIN NAMES

$E_0 - E_3$ Enable Inputs
 $Y_0 - Y_3$ Input/Output Terminals
 $Z_0 - Z_3$ Input/Output Terminals

LOGIC DIAGRAM (1/4 of a 4010B)

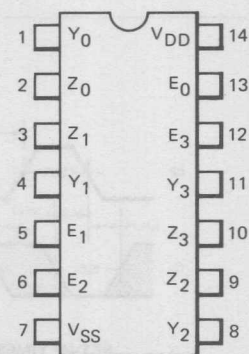


LOGIC SYMBOL



V_{DD} = Pin 14
 V_{SS} = Pin 7
 ○ = Pin Numbers

CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4016B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS		
			$V_{DD} = 5\text{ V}$			$V_{DD} = 10\text{ V}$			$V_{DD} = 15\text{ V}$							
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX					
R_{ON}	ON Resistance	XC						610			370	Ω	MIN	$V_{IS} = V_{DD}$ or V_{SS}	$R_L = 10\text{ k}\Omega$ to $V_{DD}/2$ $E_n = V_{DD}$	
								660			400		Ω			MIN
								840			520					25°C
		XM						1900			790	Ω	MIN	$V_{IS} = V_{DD}/2$ $\pm 0.25\text{ V}$	$R_L = 10\text{ k}\Omega$ to $V_{DD}/2$ $E_n = V_{DD}$	
								2000			850		25°C			
								2380			1080		MAX			
ΔR_{ON}	ON Resistance Between Any Two Switches	XC						600			360	Ω	MIN	$V_{IS} = V_{DD}$ or V_{SS}	$R_L = 10\text{ k}\Omega$ to $V_{DD}/2$ $E_n = V_{DD}$	
								660			400		Ω			MIN
								960			600					25°C
		XM						1870			775	Ω	MIN	$V_{IS} = V_{DD}/2$ $\pm 0.25\text{ V}$	$R_L = 10\text{ k}\Omega$ to $V_{DD}/2$ $E_n = V_{DD}$	
								2000			850		25°C			
								2600			1230		MAX			
I_Z	OFF State Leakage Current, Any Y to Z	XC										μA	MIN, 25°C	$V_{IS} = V_{DD}$ or V_{SS} $E_n = V_{SS}$ $V_{OS} = V_{SS}$ or V_{DD}		
												MAX				
I_{DD}	Quiescent Power Supply Current	XC			1		2			4	μA	MIN, 25°C	All inputs at V_{DD} or V_{SS}			
					7.5		15		30	MAX						
		XM			0.25		0.5		1	μA	MIN, 25°C					
					7.5		15		30		MAX					

Notes on following page.

FAIRCHILD CMOS • 4016B

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH} t _{PHL}	Propagation Delay, Y _n to Z _n or Z _n to Y _n		17 15	35 31		14 10	28 20		13 4	27 9	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns E _n = V _{DD} V _{is} = V _{DD} (square wave)
t _{PZL} t _{PZH}	Output Enable Time		42 45	84 90		20 22	40 44		14 18	28 35	ns	C _L = 50 pF, R _L = 1 kΩ to V _{SS} or V _{DD} E _n = V _{DD} (square wave)
t _{PLZ} t _{PHZ}	Output Disable Time		80 74	160 150		78 70	157 140		76 62	155 125	ns	Input Transition Times ≤ 20 ns V _{is} = V _{DD} or V _{SS}
	Distortion, Sine Wave Response					0.4					%	R _L = 10 kΩ Input Frequency = 1 kHz E _n = V _{DD} V _{is} = V _{DD} /2 (sine wave) p-p
	Crosstalk Between Any Two Switches					0.9					MHz	R _L = 1 kΩ E _A = V _{DD} , E _B = V _{SS} V _{is} = V _{DD} /2 (sine wave) p-p 20 Log ₁₀ [V _{os} (B)/V _{is} (A)] = -50 dB
	Crosstalk, Enable Input to Output					50					mV	Input Transition Times ≤ 20 ns R _L (OUT) = 1 kΩ R _L (IN) = 50 Ω E _n = V _{DD} (square wave)
	OFF State Feedthrough					1.25					MHz	R _L = 1 kΩ, E _n = V _{SS} V _{is} = V _{DD} /2 (sine wave) p-p 20 Log ₁₀ (V _{os} /V _{is}) = -50 dB
	ON State Frequency Response					40					MHz	R _L = 1 kΩ V _{is} = V _{DD} /2 (sine wave) p-p E _n = V _{DD} , 20 Log ₁₀ (V _{os} /V _{os} @ 1 kHz) = -3 dB
f _{MAX}	Enable Input Frequency (Note 4)					10					MHz	C _L = 50 pF, R _L = 1 kΩ Input Transition Times ≤ 20 ns E _n = V _{DD} (square wave) V _{os} = V _{os} /2 at DC V _{is} = V _{DD}
C _{is}	Input Switch Capacitance					4					pF	V _{DD} = 10 V E _n = V _{SS}
C _{os}	Output Switch Capacitance					4					pF	V _{is} = Open 100 kHz or
C _{ios}	Feedthrough Switch Capacitance					0.2					pF	1 MHz Bridge

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. V_{is}/V_{os} is the voltage signal at an Input/Output Terminal (Y_n/Z_n).
3. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
4. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
5. In certain applications, the current through the external load resistor (R_L) may include both V_{DD} and signal line components. To avoid drawing V_{DD} current when switch current flows into terminals 1, 4, 8, or 11 the voltage drop across the bidirectional switch must not exceed 0.5 V at $T_A \leq 25^\circ\text{C}$, or 0.3 V at $T_A > 25^\circ\text{C}$. No V_{DD} current will flow through R_L if the switch current flows into terminals 2, 3, 9, or 10.

4017B

5-STAGE JOHNSON COUNTER

DESCRIPTION — The 4017B is a 5-Stage Johnson Decade Counter with ten glitch free decoded active HIGH Outputs (O_0 - O_9), an active LOW Output from the most significant flip-flop (\overline{Q}_{5-9}), active HIGH and active LOW Clock Inputs (CP_0 , \overline{CP}_1) and an overriding asynchronous Master Reset Input (MR).

The counter is advanced by either a LOW-to-HIGH transition at CP_0 while \overline{CP}_1 is LOW or a HIGH-to-LOW transition at \overline{CP}_1 while CP_0 is HIGH (see Functional Truth Table). When cascading 4017B counters, the \overline{Q}_{5-9} output, which is LOW while the counter is in states 5, 6, 7, 8 and 9, can be used to drive the CP_0 input of the next 4017B.

A HIGH on the Master Reset Input (MR) resets the counter to zero ($O_0 = \overline{Q}_{5-9} = \text{HIGH}$, O_1 - $O_9 = \text{LOW}$) independent of the Clock Inputs (CP_0 , \overline{CP}_1).

- TYPICAL COUNT FREQUENCY OF 13.8 MHz AT $V_{DD} = 10\text{ V}$
- ACTIVE HIGH DECODED OUTPUTS
- TRIGGERS ON EITHER A HIGH-TO-LOW OR LOW-TO-HIGH TRANSITION
- CASCADABLE

PIN NAMES

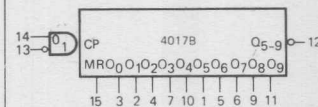
CP_0	Clock Input (L→H Triggered)
\overline{CP}_1	Clock Input (H→L Triggered)
MR	Master Reset Input
O_0 - O_9	Decoded Outputs
\overline{Q}_{5-9}	Carry Output (Active LOW)

FUNCTIONAL TRUTH TABLE

MR	CP_0	\overline{CP}_1	OPERATION
H	X	X	$O_0 = \overline{Q}_{5-9} = \text{H}$; O_1 - $O_9 = \text{L}$
L	H	H→L	Counter Advances
L	L→H	L	Counter Advances
L	L	X	No Change
L	X	H	No Change
L	H	L→H	No Change
L	H→L	L	No Change

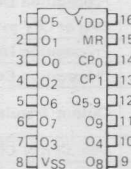
H = HIGH Level
L = LOW Level
L→H = LOW-to-HIGH Transition
H→L = HIGH-to-LOW Transition
X = Don't Care

LOGIC SYMBOL



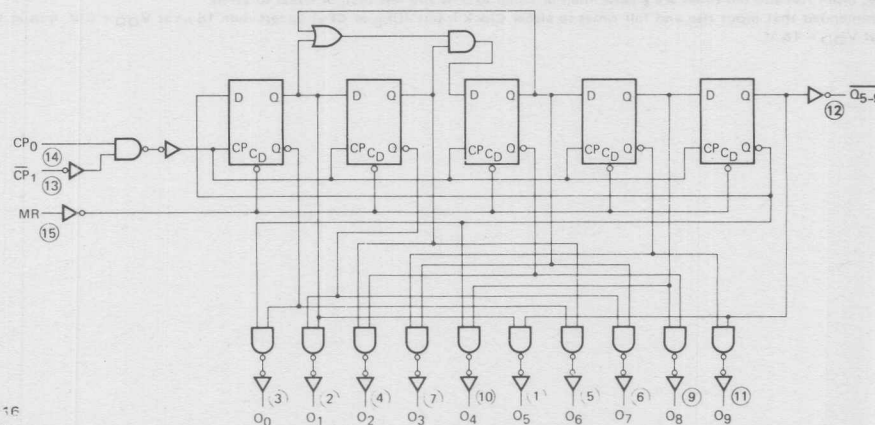
V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
○ = Pin Number

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

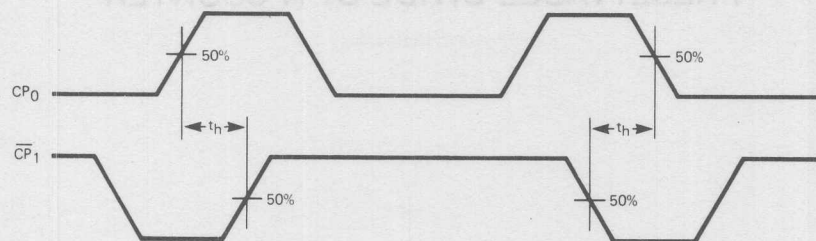
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP ₀ or CP ₁ to O _n		278	700		114	285		82	228	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	CP ₀ or CP ₁ to O _n		226	550		94	240		67	192	ns	
t _{PLH}	Propagation Delay, CP ₀ or CP ₁ to Q _{5.9}		205	525		87	225		63	180	ns	
t _{PHL}	CP ₀ or CP ₁ to Q _{5.9}		261	650		105	250		73	200	ns	
t _{PHL}	Propagation Delay, MR to O _n		170	430		80	175		52	140	ns	
t _{PLH}	Propagation Delay, MR to Q _{5.9}		125	300		65	130		40	104	ns	
t _{TLH}	Output Transition Time		59	135		31	70		23	45	ns	
t _{THL}			63	135		26	70		19	45	ns	
t _{wCP}	Min. CP ₀ or CP ₁ Pulse Width	200	85		70	37		56	28		ns	
t _{wMR}	Minimum MR Pulse Width	130	52		55	22		44	18		ns	
t _{rec}	MR Recovery Time	50	16		25	6		20	3		ns	
t _h	Hold Time, CP ₀ to CP ₁	200	90		90	39		72	26		ns	
t _h	Hold Time, CP ₁ to CP ₀	200	89		90	39		72	22		ns	
f _{MAX}	Input Count Frequency (Note 3)	2.5	5.8		7	13.8		8	16		MHz	

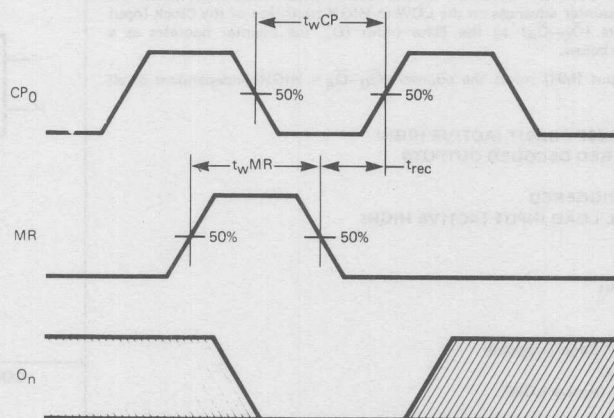
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to either Clock Input (CP_0 or CP_1) be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

SWITCHING WAVEFORMS

HOLD TIMES, CP_0 TO \overline{CP}_1 AND \overline{CP}_1 TO CP_0

Hold Times are shown as positive values, but may be specified as negative values.

MINIMUM PULSE WIDTHS FOR
CP AND MR AND RECOVERY TIME FOR MR

CONDITIONS: $\overline{CP}_1 = \text{LOW}$ while CP_0 is triggered on a LOW-to-HIGH transition. t_{wCP} and t_{rec} also apply when $CP_0 = \text{HIGH}$ and \overline{CP}_1 is triggered on a HIGH-to-LOW transition.

4018B

PRESETTABLE DIVIDE-BY-N COUNTER

DESCRIPTION — The 4018B is a 5-Stage Johnson Counter with a Clock Input (CP), a Data Input (D), an asynchronous Parallel Load Input (PL), five Parallel Inputs (P_0 – P_4), five active LOW buffered Outputs (\bar{Q}_0 – \bar{Q}_4) and an overriding asynchronous Master Reset Input (MR).

Information on the Parallel Inputs (P_0 – P_4) is asynchronously loaded into the counter while the Parallel Load Input (PL) is HIGH, independent of the Clock (CP) and Data (D) Inputs. Data present in the counter is stored on the HIGH-to-LOW transition of the Parallel Load Input (PL). When the Parallel Load Input is LOW, the counter advances on the LOW-to-HIGH transition of the Clock Input (CP). By connecting the Outputs (\bar{Q}_0 – \bar{Q}_4) to the Data Input (D), the counter operates as a divide-by-n counter ($2 \leq n \leq 10$); see below.

A HIGH on the Master Reset Input (MR) resets the counter (\bar{Q}_0 – \bar{Q}_4 = HIGH) independent of all other inputs.

- ASYNCHRONOUS MASTER RESET INPUT (ACTIVE HIGH)
- ACTIVE LOW FULLY BUFFERED DECODED OUTPUTS
- DIVIDE-BY-N WITH $2 \leq n \leq 10$
- CLOCK INPUT L→H EDGE-TRIGGERED
- ASYNCHRONOUS PARALLEL LOAD INPUT (ACTIVE HIGH)

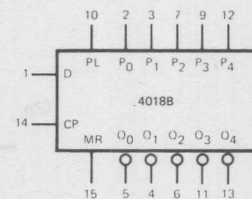
PIN NAMES

PL	Parallel Load Input
P_0 – P_4	Parallel Inputs
D	Data Input
CP	Clock Input (L→H Edge-Triggered)
MR	Master Reset Input
\bar{Q}_0 – \bar{Q}_4	Buffered Outputs (Active LOW)

DIVIDE-BY-N MODE SELECTION

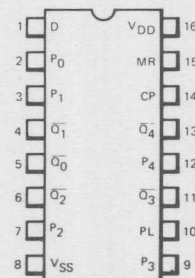
DIVIDE BY	D INPUT
2	\bar{Q}_0
3	$\bar{Q}_0 \cdot \bar{Q}_1$
4	\bar{Q}_1
5	$\bar{Q}_1 \cdot \bar{Q}_2$
6	\bar{Q}_2
7	$\bar{Q}_2 \cdot \bar{Q}_3$
8	\bar{Q}_3
9	$\bar{Q}_3 \cdot \bar{Q}_4$
10	\bar{Q}_4

LOGIC SYMBOL

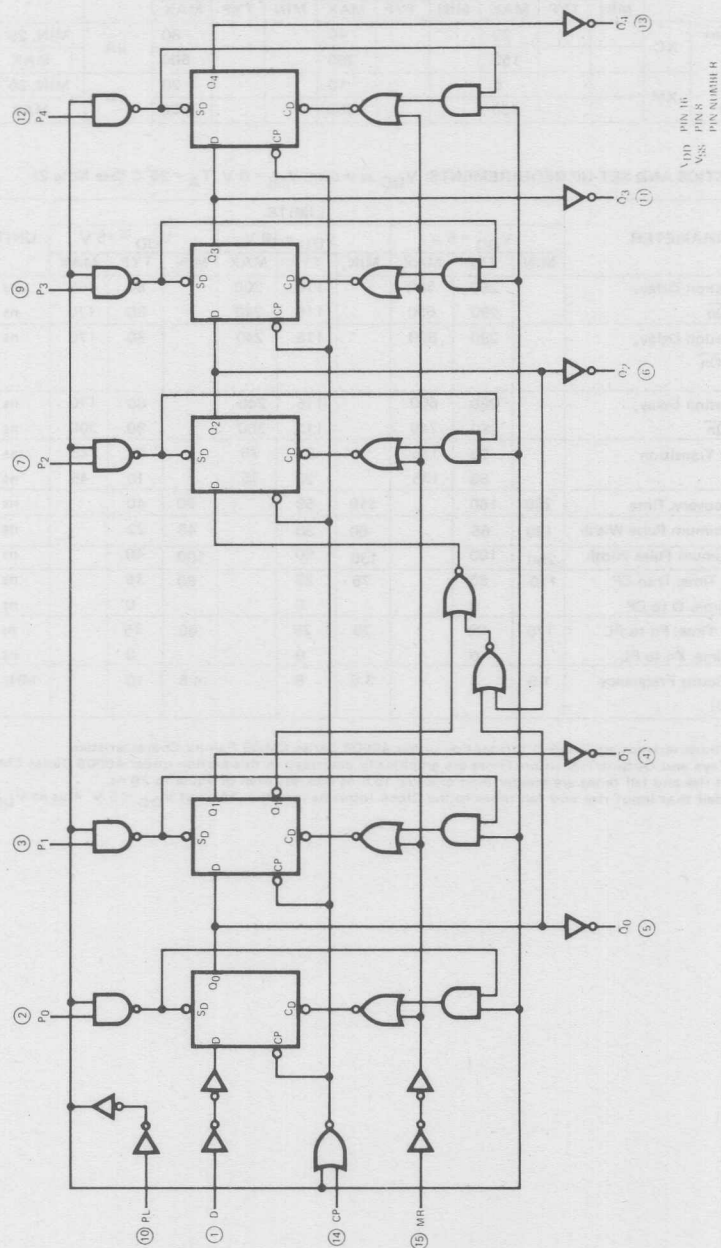


V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.



SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent	XC			20			40			80	μA	MIN. 25°C	All inputs at 0 V or V _{DD}
	Power				150			300			600		MAX	
	Supply	XM			5			10			20	μA	MIN. 25°C	
	Current				150			300			600		MAX	

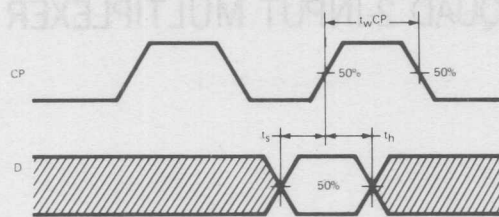
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to $\overline{Q_n}$		280	500		115	200		80	160	ns	C _L = 50 pF, R _L = 200 kΩ, Input Tran- sition Times ≤ 20 ns
t _{PHL}	CP to $\overline{Q_n}$		280	600		115	240		80	170	ns	
t _{PLH}	Propagation Delay, MR to $\overline{Q_n}$		280	600		115	240		80	170	ns	
t _{PLH}	Propagation Delay, PL to $\overline{Q_n}$		280	600		115	240		80	170	ns	
t _{PHL}	PL to $\overline{Q_n}$		280	740		115	300		80	200	ns	
t _{TLH}	Output Transition		59	135		31	75		23	45	ns	
t _{THL}	Time		63	135		26	75		19	45	ns	
t _{rec}	MR Recovery Time	250	150		110	50		90	40		ns	
t _{wMR}	MR Minimum Pulse Width	130	65		60	30		48	22		ns	
t _{wCP}	CP Minimum Pulse Width	260	100		130	50		100	40		ns	
t _s	Set-Up Time, D to CP	175	85		75	25		60	35		ns	
t _h	Hold Time, D to CP		0			0			0		ns	
t _s	Set-Up Time, Pn to PL	175	85		75	25		60	35		ns	
t _h	Hold Time, Pn to PL		0			0			0		ns	
f _{MAX}	Input Count Frequency (Note 3)	1.5	3		3.5	8		4.5	10		MHz	

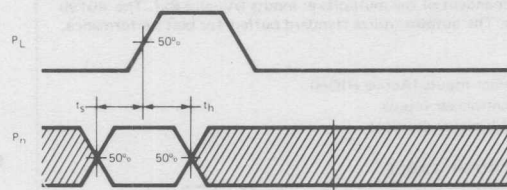
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μs at $V_{DD} = 5\text{ V}$, 4 μs at $V_{DD} = 10\text{ V}$, and 3 μs at $V_{DD} = 15\text{ V}$.

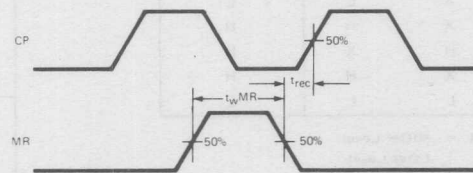
SWITCHING WAVEFORMS



MINIMUM CLOCK PULSE WIDTH AND SET-UP AND HOLD TIMES, D TO CP



SET-UP AND HOLD TIMES, P_n to P_L



MR RECOVERY TIME AND MINIMUM MR PULSE WIDTH

Note: Set-up and Hold Times are shown as positive values but may be specified as negative values.

4019B

QUAD 2-INPUT MULTIPLEXER

DESCRIPTION — The 4019B provides four multiplexing circuits with common selection inputs; each circuit contains two inputs and one output. It may be used to select four bits of information from one of two sources. The A inputs are selected when S_A is HIGH, the B inputs when S_B is HIGH. When S_A and S_B are HIGH, output (Z_n) is the logical OR of the A_n and B_n inputs ($Z_n = A_n + B_n$). When S_A and S_B are LOW, output (Z_n) is LOW independent of the multiplexer inputs (A_n and B_n). The 4019B cannot be used to multiplex analog signals. The outputs utilize standard buffers for best performance.

PIN NAMES

S_A, S_B
 $A_0 - A_3, B_0 - B_3$
 $Z_0 - Z_3$

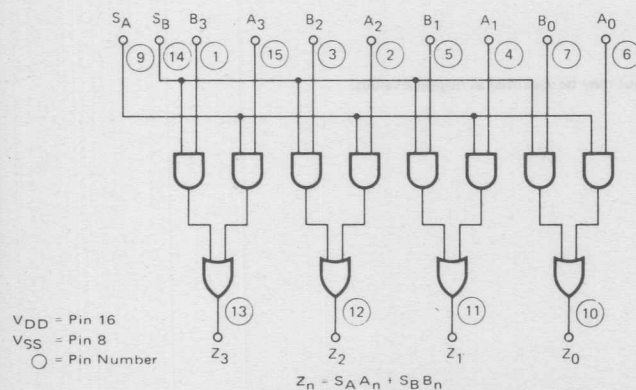
Select Inputs (Active HIGH)
 Multiplexer Inputs
 Multiplexer Outputs

TRUTH TABLE

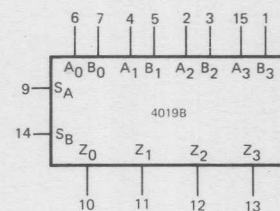
SELECT		INPUTS		OUTPUT
S_A	S_B	A_n	B_n	Z_n
L	L	X	X	L
H	L	L	X	L
H	L	H	X	H
L	H	X	L	L
L	H	X	H	H
H	H	H	X	H
H	H	X	H	H
H	H	L	L	L

H = HIGH Level
 L = LOW Level
 X = Don't Care

LOGIC DIAGRAM

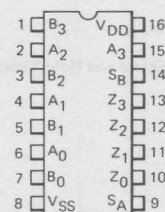


LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM
 DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4019B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power Supply Current	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600			
		XM			5			10			20	μA	MIN, 25°C	
					150			300			600			

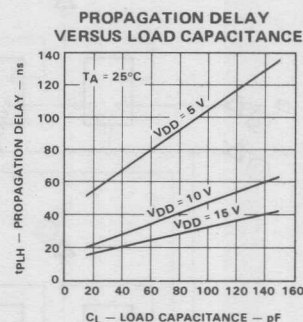
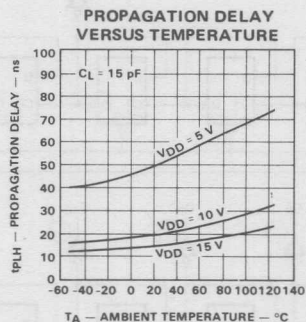
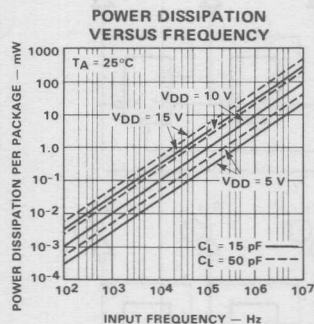
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, S _A , S _B , A _n or B _n to Z _n		75	150		35	70		24	56	ns	C _L = 50 pF
t _{PHL}			85	160		37	75		29	60	ns	R _L = 200 kΩ
t _{TLH}	Output Transition Time		80	135		42	70		32	45	ns	Input Transition
t _{THL}			90	135		40	70		30	45	ns	Times ≤ 20 ns

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS



4020B

14-STAGE BINARY COUNTER

DESCRIPTION – The 4020B is a 14-Stage Binary Ripple Counter with a Clock Input (\overline{CP}), an overriding asynchronous Master Reset Input (MR) and twelve fully buffered Outputs (Q_0, Q_3-Q_{13}). The counter advances on the HIGH-to-LOW transition of the Clock Input (\overline{CP}). A HIGH on the Master Reset Input (MR) clears all counter stages and forces all Outputs (Q_0, Q_3-Q_{13}) LOW, independent of the Clock Input (\overline{CP}).

- 25 MHz TYPICAL COUNT FREQUENCY AT $V_{DD} = 10\text{ V}$
- COMMON ASYNCHRONOUS MASTER RESET
- FULLY BUFFERED OUTPUTS FROM THE FIRST STAGE AND THE LAST ELEVEN STAGES

PIN NAMES

\overline{CP}

MR

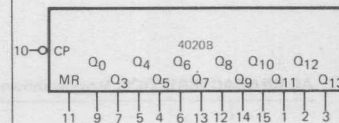
Q_0, Q_3-Q_{13}

Clock Input (H→L Triggered)

Master Reset Input (Active HIGH)

Parallel Outputs

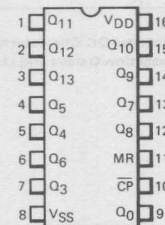
LOGIC SYMBOL



V_{DD} = Pin 16

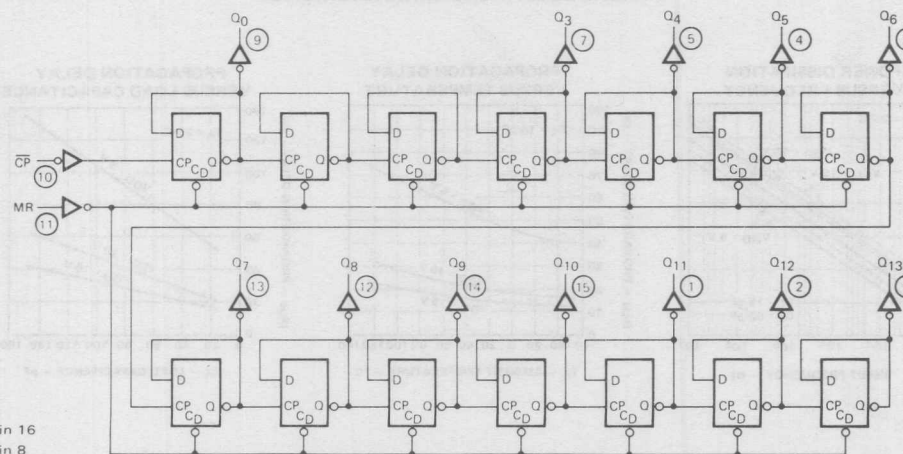
V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 16

V_{SS} = Pin 8

○ = Pin Number

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power Supply Current	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					150			300			600			
		XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

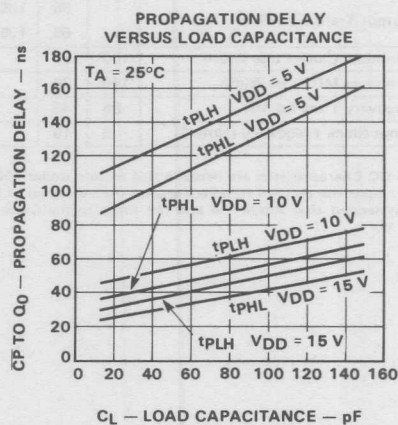
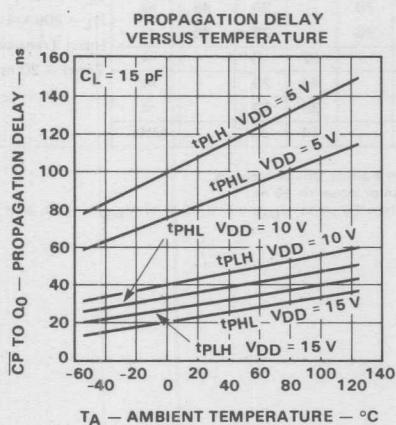
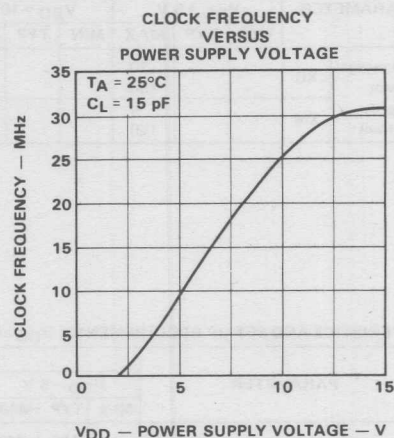
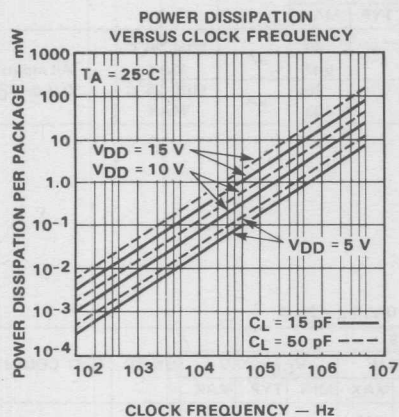
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, \overline{CP} to Q ₀		130	260		55	110		37	88	ns	C _L = 50 pF, R _L = 200 k Ω Input Transition Times \leq 20 ns
t _{PHL}			110	220		45	90		33	72	ns	
t _{PHL}	Propagation Delay, MR to Q _n		180	360		75	150		50	120	ns	
t _{TLH}	Output Transition Time		65	135		35	70		25	45	ns	
t _{THL}			65	135		35	70		25	45	ns	
t _{wCP(H)}	Minimum Clock Pulse Width	100	50		40	20		32	16		ns	
t _{wMR(H)}	Minimum MR Pulse Width	140	70		55	27		44	20		ns	
t _{rec}	Recovery Time for MR	85	43		35	17		28	12		ns	
f _{MAX}	Input Clock Frequency (Note 2)	5	10		12	25		14	30		MHz	

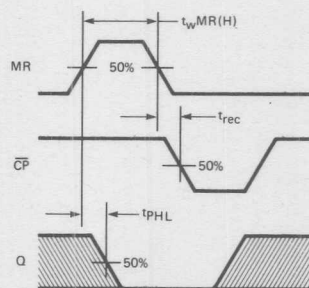
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
3. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

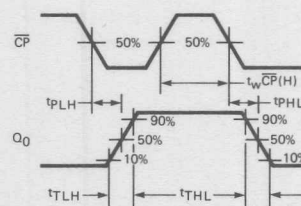
TYPICAL ELECTRICAL CHARACTERISTICS



SWITCHING WAVEFORMS



PROPAGATION DELAY MASTER
RESET TO OUTPUT, MINIMUM MASTER RESET
PULSE WIDTH AND RECOVERY TIME FOR MASTER RESET



PROPAGATION DELAY CLOCK TO
OUTPUT Q_0 , OUTPUT TRANSITION
TIMES AND MINIMUM CLOCK PULSE WIDTH

4021B

8-BIT SHIFT REGISTER

DESCRIPTION — The 4021B is an Edge-Triggered 8-Bit Shift Register (Parallel-to-Serial Converter) with a synchronous Serial Data Input (D_S), a Clock Input (CP), an asynchronous active HIGH Parallel Load Input (PL), eight asynchronous Parallel Data Inputs (P_0 - P_7) and Buffered Parallel Outputs from the last three stages (Q_5 - Q_7).

Information on the Parallel Data Inputs (P_0 - P_7) is asynchronously loaded into the register while the Parallel Load Input (PL) is HIGH, independent of the Clock (CP) and Serial Data (D_S) inputs. Data present in the register is stored on the HIGH-to-LOW transition of the Parallel Load Input (PL).

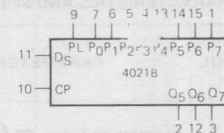
When the Parallel Load Input is LOW, data on the Serial Data Input (D_S) is shifted into the first register position and all the data in the register is shifted one position to the right on the LOW-to-HIGH transition of the Clock Input (CP).

- TYPICAL SHIFT FREQUENCY OF 18.1 MHz AT $V_{DD} = 10$ V
- PARALLEL-TO-SERIAL DATA TRANSFER
- BUFFERED OUTPUTS AVAILABLE LAST THREE STAGES
- CLOCK INPUT IS L \rightarrow H EDGE-TRIGGERED

PIN NAMES

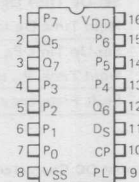
PL	Parallel Load Input
P_0 - P_7	Parallel Data Inputs
D_S	Serial Data Input
CP	Clock Input (L \rightarrow H Edge-Triggered)
Q_5 - Q_7	Buffered Parallel Outputs from the Last Three Stages

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

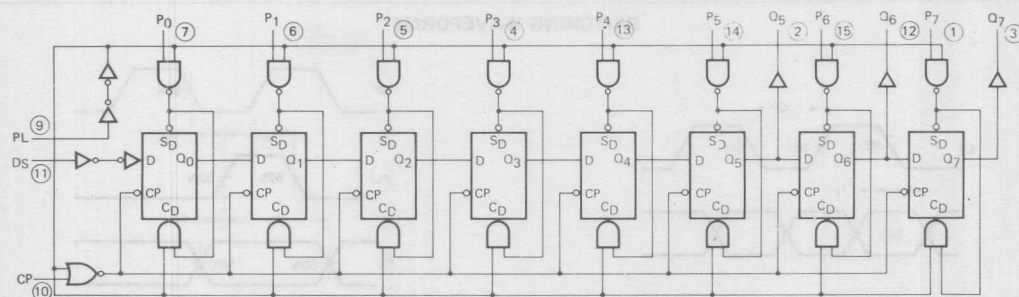
CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Number

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

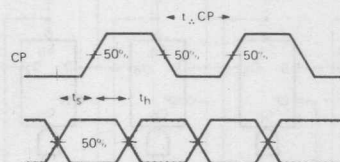
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, V_{SS} = 0 V, T_A = 25°C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q _n		134			59			40		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			184			74			49		ns	
t _{PLH}	Propagation Delay, PL to Q _n		188			78			54		ns	
t _{PHL}			274			105			72		ns	
t _{TLH}	Output Transition Time		58			31			22		ns	
t _{THL}			69			27			22		ns	
t _{wCP}	CP Minimum Pulse Width		61			21			14		ns	
t _{wPL}	PL Minimum Pulse Width		67			24			16		ns	
t _{rec}	PL Recovery Time		71			28			21		ns	
t _s	Set-Up Time D _S to CP		51			16			12		ns	
t _h	Hold Time D _S to CP		49			15			11		ns	
t _s	Set-Up Time P _n to PL		78			28			18		ns	
t _h	Hold Time, P _n to PL		72			26			16		ns	
f _{MAX}	Shift Frequency (Note 3)		7.8			18.1			21		MHz	

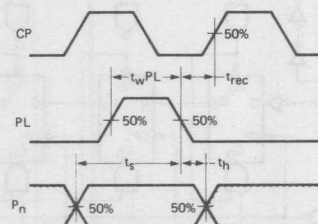
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX}, input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μs at V_{DD} = 5 V, 4 μs at V_{DD} = 10 V, and 3 μs at V_{DD} = 15 V.

SWITCHING WAVEFORMS



**MINIMUM CLOCK PULSE WIDTH
AND SET-UP AND HOLD TIMES, D_S TO CP**



**MINIMUM PL PULSE WIDTH, RECOVERY
TIME FOR PL, AND SET-UP AND HOLD TIMES, P_n TO PL**

NOTE: Set-up and Hold Times are shown as positive values but may be specified as negative values.

4022B

4-STAGE DIVIDE-BY-8 JOHNSON COUNTER

DESCRIPTION — The 4022B is a 4-Stage Divide-by-8 Johnson Counter with eight glitch free active HIGH Decoded Outputs (O_0 – O_7), an active LOW Output from the most significant flip-flop (\bar{Q}_4 – 7), an active HIGH and an active LOW Clock Input (CP_0 , CP_1) and an overriding asynchronous Master Reset Input (MR).

The counter is advanced by either a LOW-to-HIGH transition at CP_0 while \bar{CP}_1 is LOW or a HIGH-to-LOW transition at \bar{CP}_1 while CP_0 is HIGH (see Functional Truth Table). When cascading the counters, the \bar{Q}_4 – 7 Output (which is LOW while the counter is in states 4, 5, 6 and 7) can be used to drive the CP_0 Input of the next 4022B. A HIGH on the Master Reset Input (MR) resets the counter to Zero ($O_0 = \bar{Q}_4$ – $7 = \text{HIGH}$, O_1 – $O_7 = \text{LOW}$) independent of the Clock Inputs (CP_0 , CP_1).

- CLOCK EDGE-TRIGGERED ON EITHER A LOW-TO-HIGH TRANSITION OR A HIGH-TO-LOW TRANSITION
- BUFFERED CARRY OUTPUT (\bar{Q}_4 – 7) AVAILABLE FOR CASCADING
- BUFFERED FULLY DECODED OUTPUTS

PIN NAMES

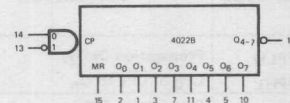
CP_0	Clock Input (L→H Edge-Triggered)
CP_1	Clock Input (H→L Edge-Triggered)
MR	Master Reset Input
O_0 – O_7	Decoded Outputs
\bar{Q}_4 – 7	Carry (Active LOW) Output

FUNCTIONAL TRUTH TABLE

MR	CP_0	\bar{CP}_1	OPERATION
H	X	X	$O_0 = \bar{Q}_4$ – $7 = \text{H}$; O_1 – $O_7 = \text{L}$
L	H	H→L	Counter Advances
L	L→H	L	Counter Advances
L	L	X	No Change
L	X	H	No Change
L	H	L→H	No Change
L	L→L	L	No Change

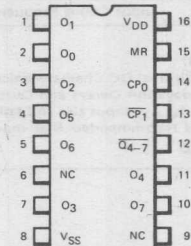
H = HIGH Level
 L = LOW Level
 L→H = LOW-to-HIGH Transition
 H→L = HIGH-to-LOW Transition
 X = Don't Care

LOGIC SYMBOL



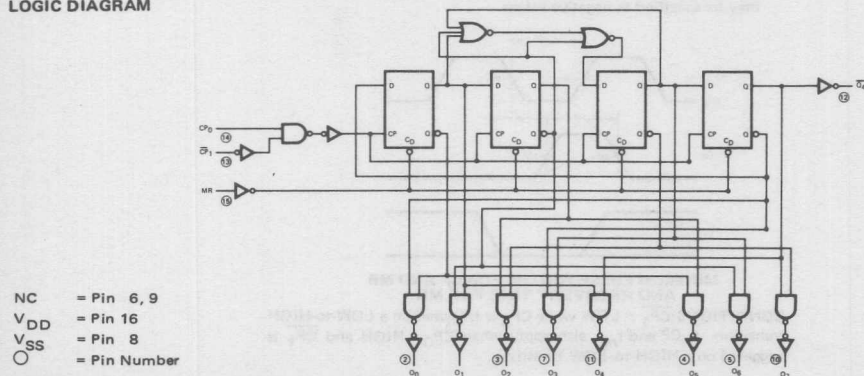
V_{DD} = Pin 16
 V_{SS} = Pin 8
 NC = Pin 6, 9

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (connection Diagram) as the Dual In-line package

LOGIC DIAGRAM



NC = Pin 6, 9
 V_{DD} = Pin 16
 V_{SS} = Pin 8
 O = Pin Number

FAIRCHILD CMOS • 4022B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

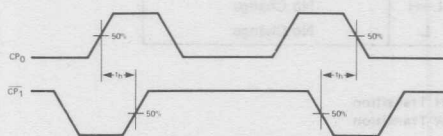
SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP ₀ or $\overline{CP_1}$ to O _n		245			95			60		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	CP ₀ or CP ₁ to O _n		195			75			50		ns	
t _{PLH}	Propagation Delay, CP ₀ or CP ₁ to Q ₄₋₇		190			75			50		ns	
t _{PHL}	CP ₀ or CP ₁ to Q ₄₋₇		245			90			60		ns	
t _{PLH}	Propagation Delay, MR to O _n		130			55			40		ns	
t _{PLH}	Propagation Delay, MR to Q ₄₋₇		110			45			35		ns	
t _{TLH}	Output Transition Time		70			35			25		ns	
t _{THL}			70			35			25		ns	
t _{wCP}	Min. CP ₀ or CP ₁ Pulse Width		35			15			10		ns	
t _{wMR}	Minimum MR Pulse Width		35			15			10		ns	
t _{rec}	MR Recovery Time		10			5			5		ns	
t _h	Hold Time, CP ₀ to CP ₁		70			25			15		ns	
t _h	Hold Time, CP ₁ to CP ₀		85			30			20		ns	
f _{MAX}	Input Count Frequency (Note 3)		6			16			24		MHz	

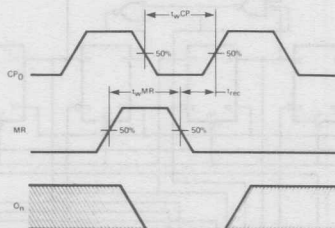
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.



HOLD TIMES, CP_0 TO CP_1 AND CP_1 TO CP_0

NOTE: Note: Hold Times are shown as positive values, but may be specified as negative values.



MINIMUM PULSE WIDTHS FOR CP AND MR AND RECOVERY TIME FOR MR

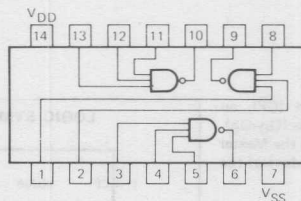
CONDITIONS: $CP_1 = \text{LOW}$ while CP_0 is triggered on a LOW-to-HIGH transition. t_{wCP} and t_{rec} also apply when $CP_0 = \text{HIGH}$ and CP_1 is triggered on a HIGH-to-LOW transition.

4023B

TRIPLE 3-INPUT NAND GATE

DESCRIPTION — This CMOS logic element provides a 3-input positive NAND function. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts
(Connection Diagram) as the Dual In-line
Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

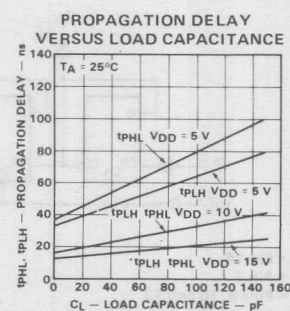
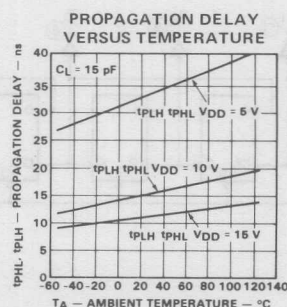
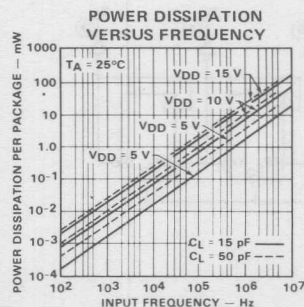
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		45	110		25	60		19	48	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			51	110		25	60		12	48	ns	
t _{TLH}	Output Transition Time		45	135		18	70		17	45	ns	Input Transition
t _{THL}			45	135		18	70		12	45	ns	Times ≤ 20 ns

NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS



4024B

7-STAGE BINARY COUNTER

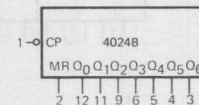
DESCRIPTION — The 4024B is a 7-Stage Binary Ripple Counter with a Clock Input (\overline{CP}), an overriding asynchronous Master Reset Input (MR) and seven fully Buffered Parallel Outputs (Q_0 – Q_6). The counter advances on the HIGH-to-LOW transition of the Clock Input (\overline{CP}). A HIGH on the Master Reset Input (MR) clears all counter stages and forces all Outputs (Q_0 – Q_6) LOW, independent of the Clock Input (\overline{CP}).

- TYPICAL COUNT FREQUENCY OF 30 MHz AT $V_{DD} = 10$ V
- CLOCK TRIGGERED ON THE HIGH-TO-LOW TRANSITION
- ASYNCHRONOUS ACTIVE HIGH MASTER RESET
- OUTPUTS AVAILABLE FROM ALL SEVEN STAGES

PIN NAMES

\overline{CP} Clock Input (H→L Triggered)
MR Master Reset Input
 Q_0 – Q_6 Buffered Parallel Outputs

LOGIC SYMBOL

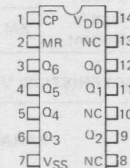


V_{DD} = Pin 14

V_{SS} = Pin 7

NC = Pins 8, 10 and 13

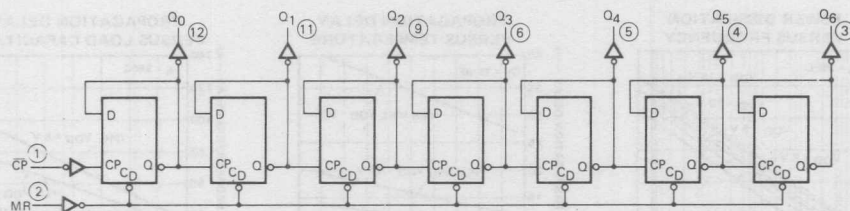
CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 14

V_{SS} = Pin 7

NC = Pins 8, 10 and 13

○ = Pin Number

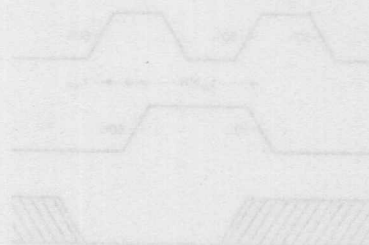
SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (See Note 2)

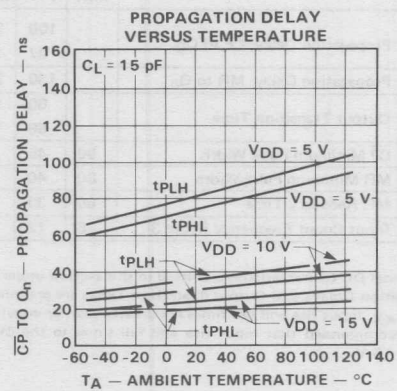
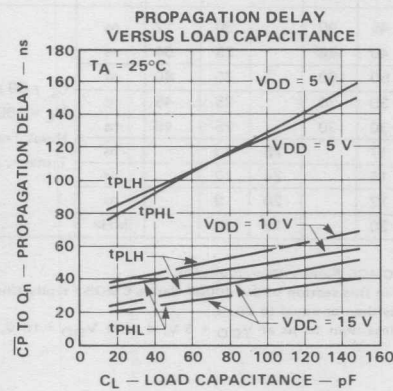
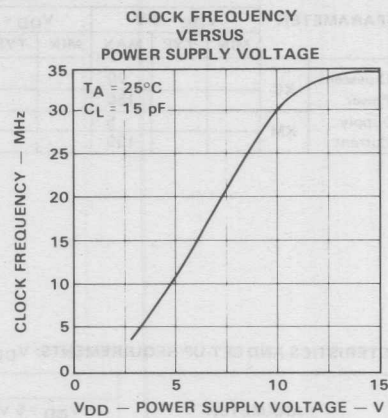
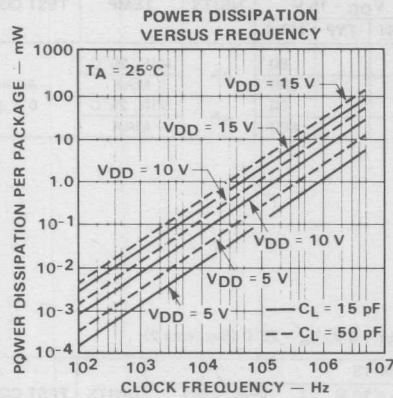
SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, \overline{CP} to Q ₀		100	200		45	90		30	72	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			97	195		40	80		25	64	ns	
t _{PHL}	Propagation Delay, MR to Q _n		130	260		50	100		35	80	ns	
t _{TLH}	Output Transition Time		60	130		30	70		25	45	ns	
t _{THL}			60	130		30	70		25	45	ns	
t _{wCP}	\overline{CP} Minimum Pulse Width:	90	45		35	17		28	13		ns	
t _{wMR}	MR Minimum Pulse Width	80	40		30	15		24	12		ns	
t _{rec}	MR Recovery Time	60	30		25	12		20	9		ns	
f _{MAX}	Input Count Frequency (Note 3)	6	12		15	30		18	36		MHz	

NOTES:

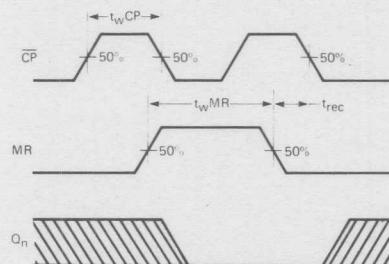
1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μs at $V_{DD} = 5\text{ V}$, 4 μs at $V_{DD} = 10\text{ V}$, and 3 μs at $V_{DD} = 15\text{ V}$.



TYPICAL ELECTRICAL CHARACTERISTICS



SWITCHING WAVEFORMS



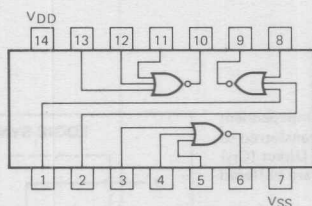
MINIMUM PULSE WIDTH
FOR CP AND MR AND MR RECOVERY TIME

4025B

TRIPLE 3-INPUT NOR GATE

DESCRIPTION — This CMOS logic element provides a 3-input positive NOR function. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts
(Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

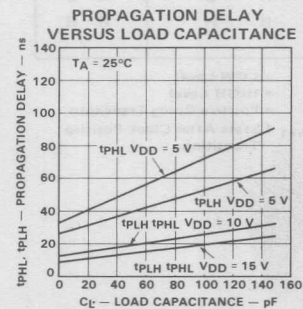
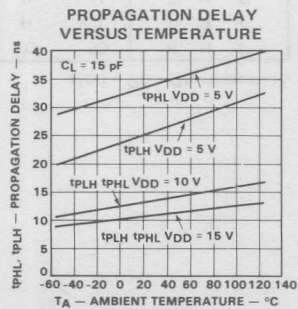
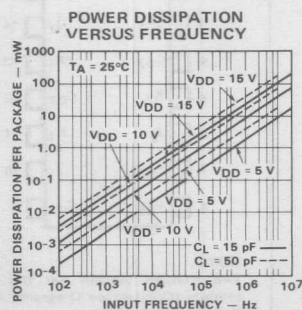
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		45	110		20	60		15	48	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			47	110		25	60		21	48	ns	
t _{TLH}	Output Transistion Time		38	135		20	70		15	45	ns	Input Transition Times ≤ 20 ns
t _{THL}			38	135		15	70		11	45	ns	

NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS



4027B

DUAL JK FLIP-FLOP

DESCRIPTION — The 4027B is a Dual JK Flip-Flop which is edge-triggered and features independent Direct Set, Direct Clear, and Clock inputs. Data is accepted when the Clock is LOW and transferred to the output on the positive-going edge of the Clock. The active HIGH asynchronous Clear Direct (C_D) and Set Direct (S_D) are independent and override the J, K, or Clock inputs. The outputs are buffered for best system performance.

PIN NAMES

J, K	Synchronous Inputs
CP	Clock Input (L \rightarrow H Edge-Triggered)
S_D	Asynchronous Direct Set Input (Active HIGH)
C_D	Asynchronous Direct Clear Input (Active HIGH)
Q	True Output
\bar{Q}	Complement Output

TRUTH TABLES

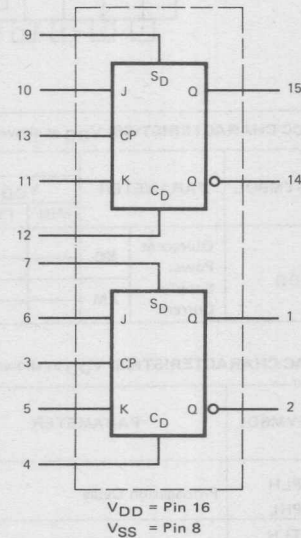
ASYNCHRONOUS INPUTS		OUTPUTS	
S_D	C_D	Q	\bar{Q}
L	H	L	H
H	L	H	L
H	H	H	H

L = LOW Level
H = HIGH Level
↗ = Positive-Going Transition
 Q_{n+1} = State After Clock Positive Transition

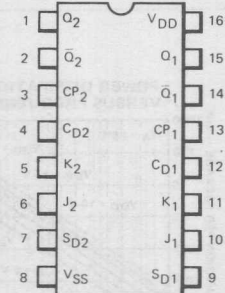
SYNCHRONOUS INPUTS			OUTPUTS	
CP	J	K	Q_{n+1}	\bar{Q}_{n+1}
↗	L	L	NO CHANGE	
↗	H	L	H	L
↗	L	H	L	H
↗	H	H	\bar{Q}_n	Q_n

Conditions: $S_D = C_D = \text{LOW}$

LOGIC SYMBOL



CONNECTION DIAGRAMS DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4027B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power Supply Current	XC			4			8			16	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					30			60			120		MAX	
	XM			1			2			4	μA	MIN, 25°C		
				30			60			120		MAX		

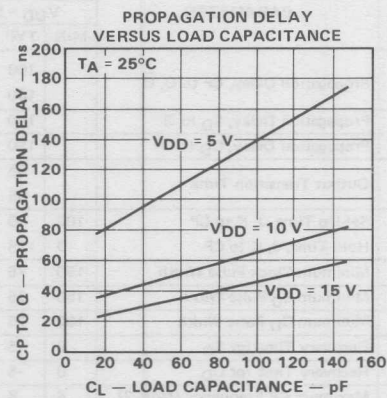
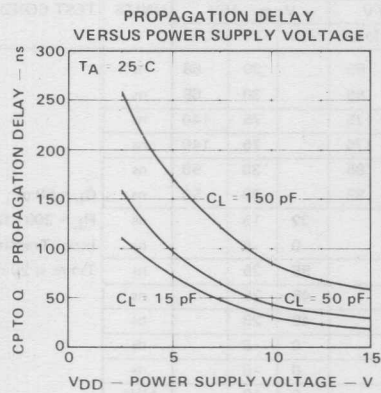
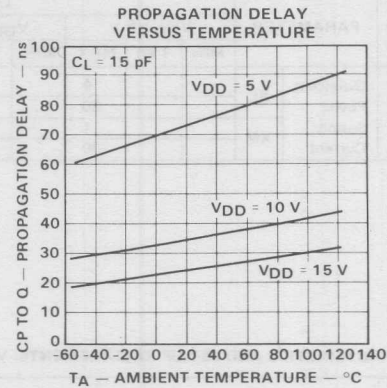
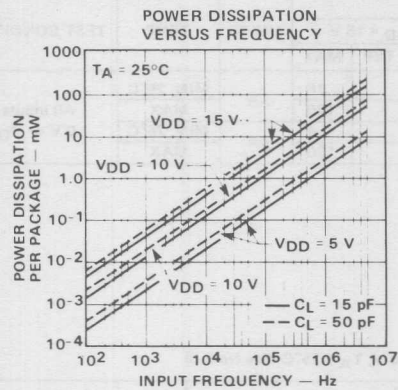
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q, \bar{Q}		100	200		45	85		30	68	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	Propagation Delay, S _D to Q		100	200		45	85		30	68	ns	
t _{PLH}	Propagation Delay, S _D to Q		180	350		90	175		75	140	ns	
t _{PHL}	Propagation Delay, C _D to Q		180	350		90	175		75	140	ns	
t _{TLH}	Output Transition Time		85	150		45	85		30	50	ns	
t _{THL}	Output Transition Time		85	150		45	85		30	50	ns	
t _s	Set-Up Time, J, K to CP	100	45		40	20		32	15		ns	
t _h	Hold Time, J, K to CP	0	-25		0	-10		0	-5		ns	
t _{wCP(L)}	Minimum Clock Pulse Width	150	75		70	35		56	25		ns	
t _{wSD(H)}	Minimum S _D Pulse Width	150	75		60	30		48	25		ns	
t _{wCD(H)}	Minimum C _D Pulse Width	150	75		60	30		48	25		ns	
t _{recSD}	Recovery Time for S _D	0	-5		0	-4		0	-3		ns	
t _{recCD}	Recovery Time for C _D	0	-5		0	-4		0	-3		ns	
f _{MAX}	Maximum CP Frequency (Note 2)	4	8		8	16		9	19		MHz	

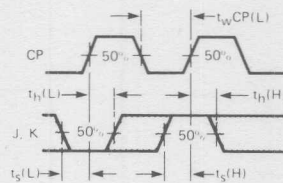
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. For f_{MAX} input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
3. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

TYPICAL ELECTRICAL CHARACTERISTICS

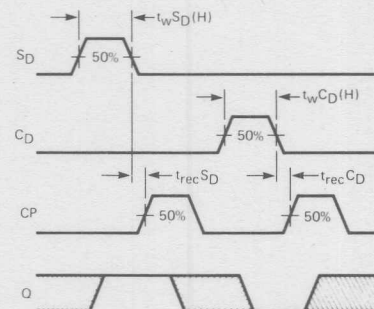


SWITCHING WAVEFORMS



NOTE:
 t_s & t_h are shown as positive values but may be specified as negative values.

SET-UP TIMES, HOLD TIMES,
AND MINIMUM CLOCK PULSE WIDTH



RECOVERY TIME FOR SD, RECOVERY TIME FOR CD,
MINIMUM SD PULSE WIDTH, AND MINIMUM CD PULSE WIDTH

4028B

1-OF-10 DECODER

DESCRIPTION — The 4028B is a CMOS 4 Bit BCD to 1-of-10 active HIGH decoder. A 1-2-4-8 BCD code applied to inputs A_0 through A_3 causes the selected output to be HIGH, the other nine will be LOW. If desired, the 4028B may be used as a 1-of-8 decoder with enable; 3-bit octal inputs are applied to inputs A_0 , A_1 , and A_2 selecting an output 0 through 7. Input A_3 then becomes an active LOW enable, forcing the selected output LOW when A_3 is HIGH. The 4028B may also be used as an 8-input demultiplexer with an active LOW data input. The outputs are fully buffered for best performance.

- BCD TO 1-OF-10 DECODER
- 1-OF-8 DECODER WITH ACTIVE LOW ENABLE
- 8-INPUT DEMULTIPLEXER WITH ACTIVE LOW DATA INPUT

PIN NAMES

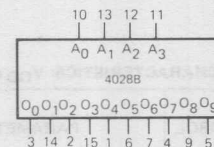
$A_0 - A_3$ Address Inputs, 1-2-4-8 BCD
 $O_0 - O_9$ Outputs (Active HIGH)

TRUTH TABLE

INPUTS				OUTPUTS									
A_3	A_2	A_1	A_0	O_0	O_1	O_2	O_3	O_4	O_5	O_6	O_7	O_8	O_9
L	L	L	L	H	L	L	L	L	L	L	L	L	L
L	L	L	H	L	H	L	L	L	L	L	L	L	L
L	L	H	L	L	L	H	L	L	L	L	L	L	L
L	L	H	H	L	L	L	H	L	L	L	L	L	L
L	H	L	L	L	L	L	H	L	L	L	L	L	L
L	H	L	H	L	L	L	L	H	L	L	L	L	L
L	H	H	L	L	L	L	L	L	H	L	L	L	L
L	H	H	H	L	L	L	L	L	L	H	L	L	L
H	L	L	L	L	L	L	L	L	L	L	H	L	L
H	L	L	H	L	L	L	L	L	L	L	L	H	L
H	L	H	L	L	L	L	L	L	L	L	L	H	L
H	L	H	H	L	L	L	L	L	L	L	L	L	H
H	H	L	L	L	L	L	L	L	L	L	H	L	L
H	H	L	H	L	L	L	L	L	L	L	L	H	L
H	H	H	L	L	L	L	L	L	L	L	L	H	L
H	H	H	H	L	L	L	L	L	L	L	L	L	H

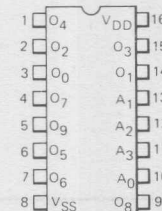
H = HIGH Level
 L = LOW Level

LOGIC SYMBOL



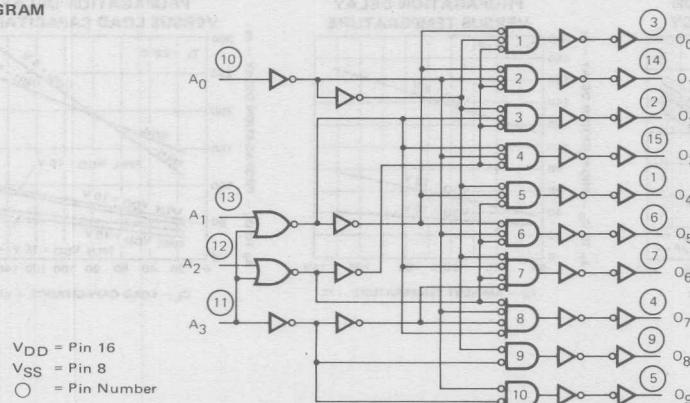
V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Number

SYMBOL	PARAMETER		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V			UNITS	TEMP	TEST CONDITIONS
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power Supply Current	XC			20 150			40 300			80 600	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
		XM			5 150			10 300			20 600	μA	MIN, 25°C MAX	

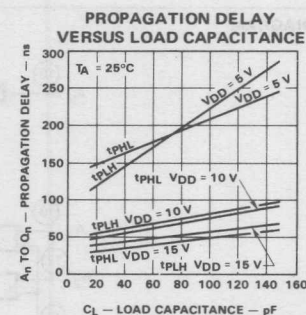
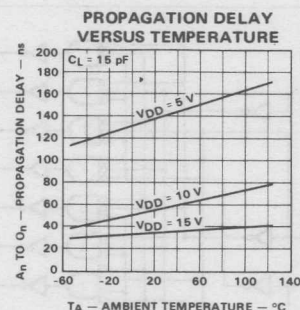
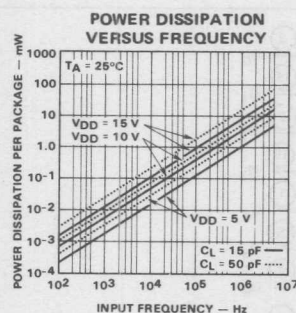
AC CHARACTERISTICS: V_{DD} as shown, V_{SS} = 0 V, T_A = 25°C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, A _n to O _n		167	325		66	145		45	53	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			157	325		57	145		40	46	ns	
t _{TLH}	Output Transition Time		85	200		40	100		31	70	ns	Input Transition Times ≤ 20 ns
t _{THL}			110	200		37	100		25	70	ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS



4029B

SYNCHRONOUS UP/DOWN COUNTER

DESCRIPTION — The 4029B is a Synchronous Edge-Triggered Up/Down 4-Bit Binary/BCD Decade Counter with a Clock Input (CP), an active LOW Count Enable Input (\overline{CE}), an Up/Down Control Input (UP/DN), a Binary/Decade Control Input (BIN/DEC), an overriding asynchronous active HIGH Parallel Load Input (PL), four Parallel Data Inputs (P₀-P₃), four Parallel Buffered Outputs (Q₀-Q₃) and an active LOW Terminal Count Output (TC).

Information on the Parallel Inputs (P₀-P₃) is loaded into the counter while the Parallel Load Input (PL) is HIGH, independent of all other input conditions. With the Parallel Load Input (PL) LOW, operation is synchronous and is edge-triggered on the LOW-to-HIGH transition of the Clock Input (CP). Operation is determined by the three synchronous Mode Control Inputs; UP/DN, BIN/DEC and \overline{CE} (see the Mode Selection Table). These inputs must be stable only during the set-up time prior to the LOW-to-HIGH transition of the Clock Input (CP) and the hold time after this clock transition. The Terminal Count Output (TC) is LOW when the counter is at its terminal count, as determined by the counting mode, and the Count Enable Input (\overline{CE}) is LOW (see Logic Equation for TC).

- BINARY OR DECADE UP/DOWN COUNTER
- ASYNCHRONOUS PARALLEL LOAD
- ACTIVE LOW COUNT ENABLE
- CLOCK EDGE-TRIGGERED ON THE LOW-TO-HIGH TRANSITION
- ACTIVE LOW TERMINAL COUNT FOR CASCADING
- TYPICAL COUNT FREQUENCY OF 12 MHz AT V_{DD} = 10 V

PIN NAMES

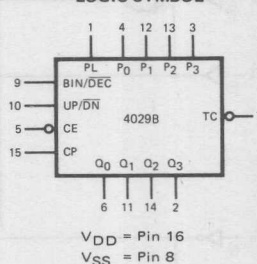
PL	Parallel Load Input
P ₀ -P ₃	Parallel Data Inputs
BIN/DEC	Binary/Decade Control Input
UP/DN	Up/Down Control Input
\overline{CE}	Count Enable Input (Active LOW)
CP	Clock Input (L→H Edge-Triggered)
Q ₀ -Q ₃	Buffered Parallel Outputs
TC	Terminal Count Output (Active LOW)

MODE SELECTION TABLE

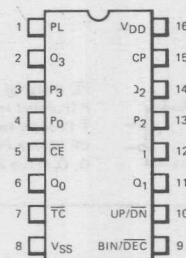
PL	BIN/DEC	UP/DN	\overline{CE}	CP	MODE
H	X	X	X	X	Parallel Load (P _n → Q _n)
L	X	X	H	X	No Change
L	L	L	L	↗	Count Down, Decade
L	L	H	L	↗	Count Up, Decade
L	H	L	L	↗	Count Down, Binary
L	H	H	L	↗	Count Up, Binary

H = HIGH Level
L = LOW Level
X = Don't Care
↗ = Positive-Going Transition

LOGIC SYMBOL

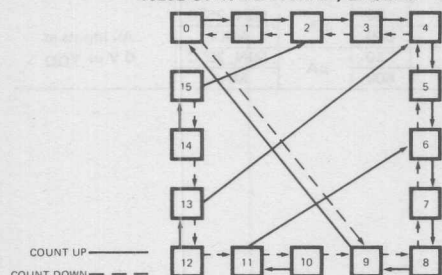


CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

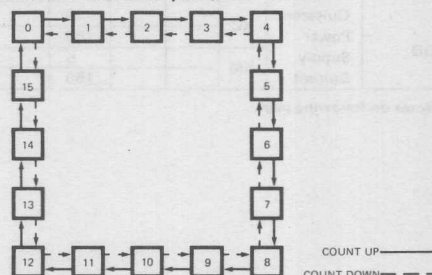
4029B STATE DIAGRAM, BIN/DEC = LOW



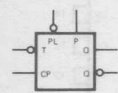
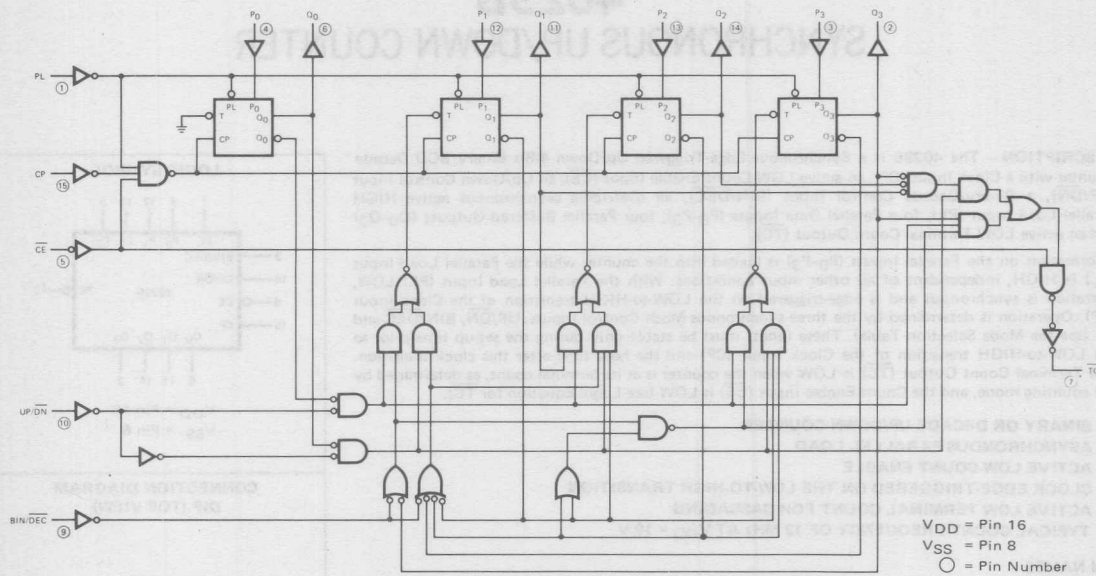
LOGIC EQUATION FOR TERMINAL COUNT

$$TC = CE \cdot [UP \cdot Q_0 \cdot Q_3 \cdot (\overline{BIN} + (Q_1 \cdot Q_2)) + (\overline{UP} \cdot Q_0 \cdot Q_1 \cdot Q_2 \cdot Q_3)]$$

4029B STATE DIAGRAM, BIN/DEC = HIGH



LOGIC DIAGRAM



\overline{PL} (Parallel Load Input) — Asynchronously Loads P into Q, Overriding all Other Inputs
 P (Parallel Input) — Data on this Pin is Asynchronously Loaded into Q, when \overline{PL} is LOW Overriding all Other Inputs
 \overline{T} (Toggle Input) — Forces the Q Output to Synchronously Toggle when a LOW is Placed on this Input.
 CP (Clock Pulse Input)
 Q, \overline{Q} (True and Complimentary Outputs)

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC		20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}	
				150			300			600		MAX		
	Supply Current	XM		5			10			20	μA	MIN, 25°C		
				150			300			600		MAX		

Notes on following page.

FAIRCHILD CMOS • 4029B

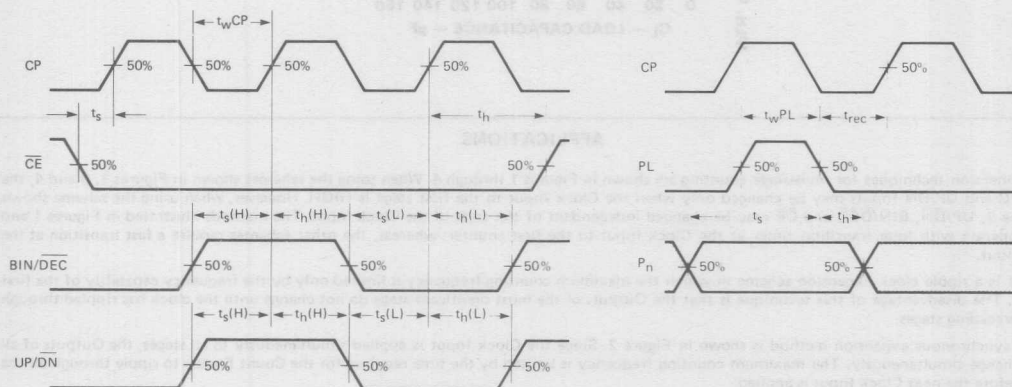
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q _n		150	350		62	160		41	128	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			150	350		59	160		39	128	ns	
t _{PLH}	Propagation Delay, CP to \overline{TC}		167	450		71	180		48	144	ns	
t _{PHL}			252	650		100	245		66	196	ns	
t _{PLH}	Propagation Delay, PL to Q _n		170	325		70	150		45	120	ns	
t _{PHL}			220	450		90	195		62	156	ns	
t _{TLH}	Output Transition Time		60	135		31	75		23	45	ns	
t _{THL}			65	135		25	75		18	45	ns	
t _{WCP}	CP Minimum Pulse Width	125	50		60	21		48	14		ns	
t _{WPL}	PL Minimum Pulse Width	150	60		55	21		44	16		ns	
t _{rec}	PL Recovery Time	150	62		60	24		48	17		ns	
t _s	Set-Up Time, BIN/DEC to CP	250	106		100	41		80	29		ns	
t _h	Hold Time, BIN/DEC to CP	0	-90		0	-35		0	-25		ns	
t _s	Set-Up Time, UP/DN to CP	325	145		130	55		104	38		ns	
t _h	Hold Time, UP/DN to CP	0	-90		0	-35		0	-25		ns	
t _s	Set-Up Time, \overline{CE} to CP	275	118		120	49		96	23		ns	
t _h	Hold Time, \overline{CE} to CP	0	-40		0	-15		0	-10		ns	
t _s	Set-Up Time, P _n to PL	70	29		30	11		24	8		ns	
t _h	Hold Time, P _n to PL	0	-40		0	-20		0	-20		ns	
f _{MAX}	Input Clock Frequency (Note 2)	2	5		5	12		6	14		MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. For f_{MAX} input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
3. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

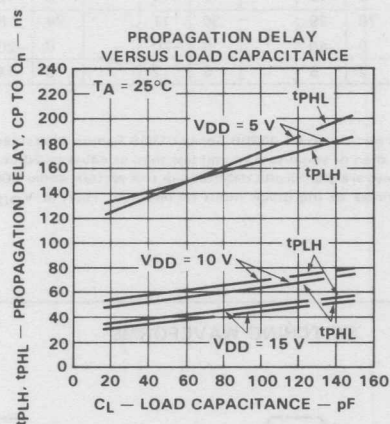
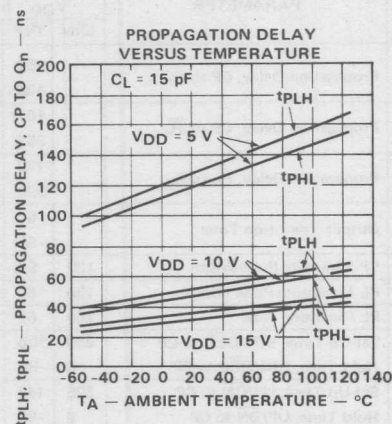
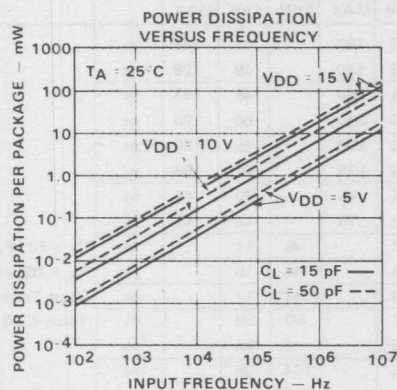
SWITCHING WAVEFORMS



MINIMUM CP WIDTH, SET-UP AND HOLD TIMES, \overline{CE} to CP, BIN/DEC to CP AND UP/DN to CP

MINIMUM PL PULSE WIDTH, RECOVERY TIME FOR PL, AND SET-UP AND HOLD TIMES, P_n to PL

NOTE: Set-up and Hold Times are shown as positive values but may be specified as negative values.



APPLICATIONS

Interconnection techniques for multistage counting are shown in Figures 1 through 4. When using the schemes shown in Figures 1, 3 and 4, the $\overline{\text{BIN}}/\overline{\text{DEC}}$ and $\overline{\text{UP}}/\overline{\text{DN}}$ Inputs may be changed only when the Clock Input to the first stage is HIGH. However, when using the scheme shown in Figure 2, $\overline{\text{UP}}/\overline{\text{DN}}$, $\overline{\text{BIN}}/\overline{\text{DEC}}$ and $\overline{\text{CE}}$ may be changed independent of the state of the Clock Input. The methods illustrated in Figures 1 and 3 will operate with long transition times at the Clock Input to the first counter; whereas, the other schemes require a fast transition at the Clock Input.

Figure 1 is a ripple clock expansion scheme in which the maximum counting frequency is limited only by the frequency capability of the first counter. The disadvantage of this technique is that the Outputs of the most significant stage do not change until the clock has rippled through all the preceding stages.

A fully synchronous expansion method is shown in Figure 2. Since the Clock Input is applied simultaneously to all stages, the Outputs of all stages change simultaneously. The maximum counting frequency is limited by the time required for the Count Enable to ripple through all the stages before the next Clock Input is applied.

The semi-synchronous technique illustrated in Figure 3 allows a higher counting frequency than the method shown in Figure 2 by allowing $\overline{\text{TC}}$ to take either 10 or 16 clock periods to ripple from the second stage to the most significant stage (10 clock periods when $\overline{\text{BIN}}/\overline{\text{DEC}} = \text{L}$, 16 clock periods when $\overline{\text{BIN}}/\overline{\text{DEC}} = \text{H}$). The Outputs of all stages, except the first, change simultaneously. The Outputs of the first stage change before the other stages.

The speed advantage of this scheme is lost if the count direction or count modulus is rapidly changed.

The method shown in Figure 4 is the same as in Figure 3 except an external gate is added to reduce the delay between the Clock Input to the first stage and the Clock Input to the following stages.

APPLICATIONS (Cont'd)

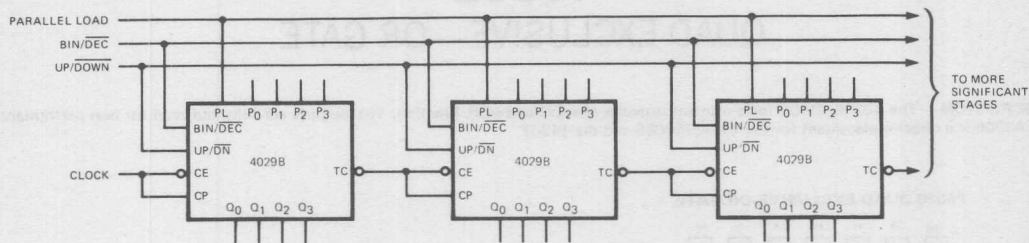


Fig. 1 RIPPLE CLOCK EXPANSION

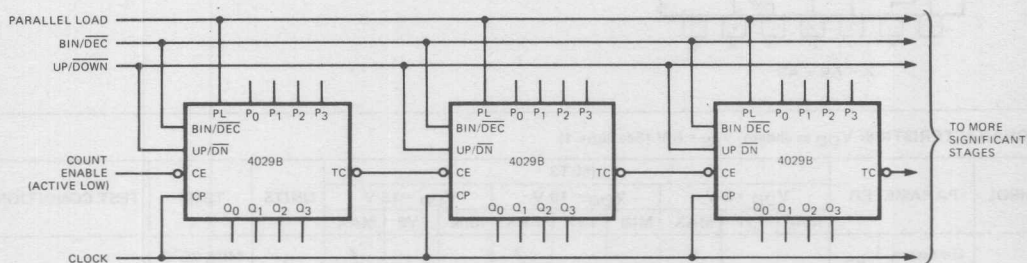


Fig. 2 PARALLEL CLOCK EXPANSION (FULLY SYNCHRONOUS)

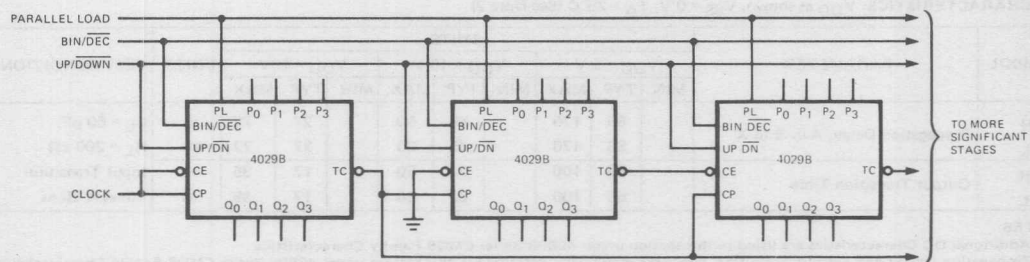


Fig. 3 SEMI-SYNCHRONOUS EXPANSION

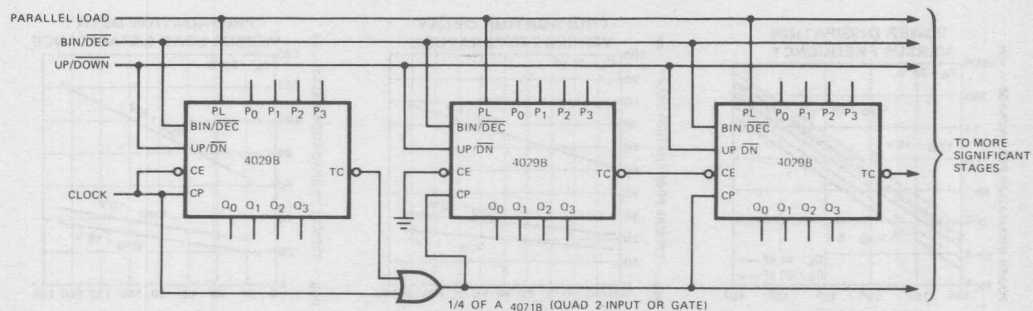


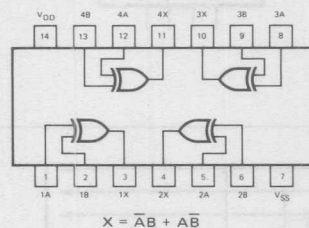
Fig. 4 HIGH SPEED SEMI-SYNCHRONOUS EXPANSION

4030B

QUAD EXCLUSIVE—OR GATE

DESCRIPTION — The 4030B CMOS logic element provides the Exclusive-OR function. The outputs are fully buffered for best performance. The 4030B is a direct replacement for the 74C86/54C86 and the 14507.

F4030 QUAD EXCLUSIVE-OR GATE



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

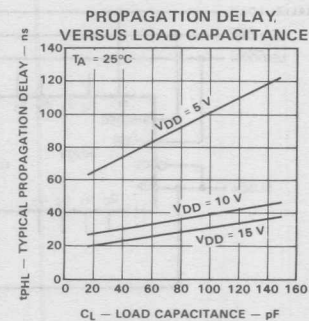
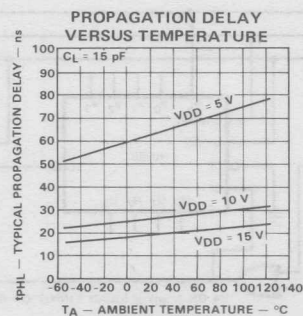
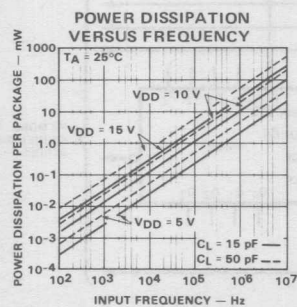
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ C$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, A or B to X		85	170		45	90		27	72	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			85	170		45	90		27	72	ns	
t _{TLH}	Output Transition Time		50	100		23	50		17	35	ns	Input Transition Times ≤ 20 ns
t _{THL}			50	100		23	50		17	35	ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS



4031B

64-STAGE STATIC SHIFT REGISTER

DESCRIPTION — The 4031B is an edge-triggered 64-Stage Static Shift Register with two Serial Data Inputs (D_0 , D_1), a Data Select Input (S), a Clock Input (CP), a buffered Clock Output (CO) and buffered Outputs from the 64th bit position (Q_{63} , \overline{Q}_{63}).

Data from the selected Data Inputs (D_0 or D_1), as determined by the state of the Select Input (S), is shifted into the first shift register position and all the data in the register is shifted one position to the right on the LOW-to-HIGH transition of the Clock Input (CP). D_0 is selected by a LOW on the Select Input (S) and D_1 is selected by a HIGH on the Select Input (S).

Registers can be cascaded by connecting all the Clock Inputs (CP) together or by driving the Clock Input (CP) of the right-most register with the system clock and connecting the Clock Output (CO) to the Clock Input (CP) of the preceding register. When the second technique is used in the recirculating mode, a flip-flop must be used to store the Output (Q_{63}) of the right-most register until the left-most register is clocked.

- CLOCK INPUT IS L-H EDGE-TRIGGERED
- DATA SELECT INPUT (S) ALLOWS DATA INPUT AT EITHER D_0 OR D_1 INPUTS
- EASILY CASCADED
- TRUE AND COMPLEMENTARY BUFFERED OUTPUTS AVAILABLE FROM 64TH STAGE

PIN NAMES

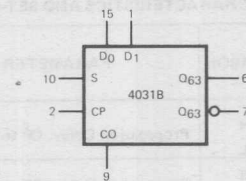
D_0 , D_1	Data Inputs
S	Data Select Input
CP	Clock Input (L-H Edge-Triggered)
CO	Buffered Clock Output
Q_{63}	Buffered Output from the 64th Stage
\overline{Q}_{63}	Complementary Buffered Output from the 64th Stage

TRUTH TABLE

S	D_0	D_1	Data Into Flip-Flop 1
L	L	X	L
L	H	X	H
H	X	L	L
H	X	H	H

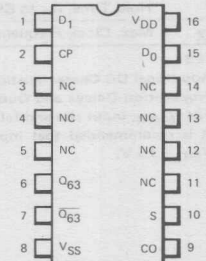
L = Low Level
H = High Level
X = Don't Care

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8
NC = Pins 3, 4, 5, 11, 12, 13, 14

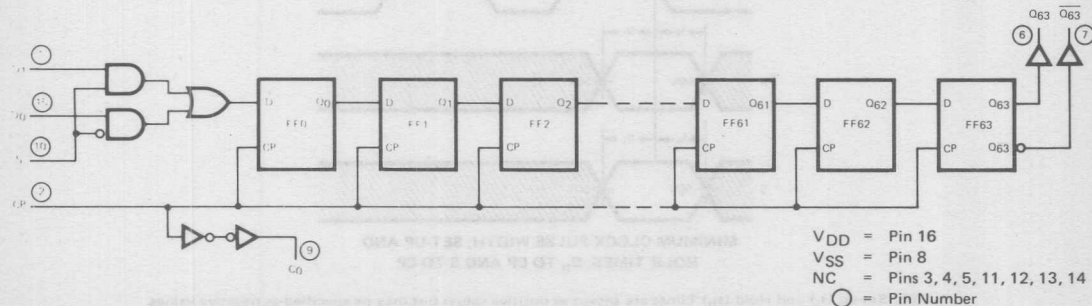
CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpack version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
NC = Pins 3, 4, 5, 11, 12, 13, 14
○ = Pin Number

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

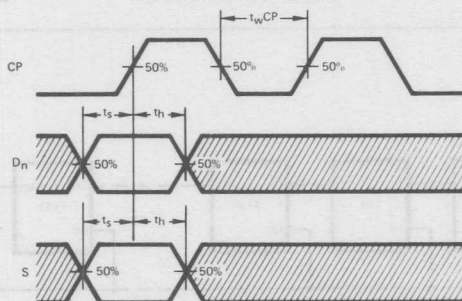
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, V_{SS} = 0 V, T_A = 25°C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q ₆₃ , \bar{Q}_{63}		120		60			40			ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			120		60			40			ns	
t _{PLH}	Propagation Delay, CP to CO		45		25			20			ns	
t _{PHL}			45		25			20			ns	
t _{TLH}	Output Transition Time		65		35			15			ns	
t _{THL}			65		35			15			ns	
t _{wCP(L)}	Minimum Clock Pulse Width		25		10			8			ns	
t _s	Set-Up Time, S to CP		75		40			30			ns	
t _h	Hold Time, S to CP		40		20			15			ns	
t _s	Set-Up Time D _n to CP		75		40			30			ns	
t _h	Hold Time, D _n to CP		40		20			15			ns	
f _{MAX}	Max. Clock Frequency (Note 3)		4		8			9			MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX}, input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at V_{DD} = 5 V, 4 μ s at V_{DD} = 10 V, and 3 μ s at V_{DD} = 15 V.

SWITCHING WAVEFORMS



MINIMUM CLOCK PULSE WIDTH, SET-UP AND HOLD TIMES, D_n TO CP AND S TO CP

NOTE: Set-up (t_s) and Hold (t_h) Times are shown as positive values but may be specified as negative values.

4034B

8-BIT UNIVERSAL BUS REGISTER

GENERAL DESCRIPTION — The 4034B is an 8 Bit Bi-directional Parallel/Serial Input/Output Bus Register with a Serial Data Input (D_S), a Clock Input (CP), an active HIGH asynchronous or synchronous Parallel Load/Parallel Enable Input (PL/PE), two mode control inputs, Asynchronous/Synchronous (A/\bar{S}) and Data Transfer (P/Q), two sets of eight bi-directional Parallel Data Inputs/Outputs (P_0 - P_7 and Q_0 - Q_7), and an active HIGH Output Enable Input (EOp) controlling the P_0 - P_7 Parallel Data Inputs/Outputs.

The Data Transfer Mode Control Input (P/Q) determines the direction of data flow. When P/Q is HIGH P_0 - P_7 act as a parallel data inputs and Q_0 - Q_7 act as parallel data outputs. When P/Q is LOW, Q_0 - Q_7 act as parallel data inputs and P_0 - P_7 act as parallel data outputs. A LOW on the Output Enable Input (EOp) forces the P_0 - P_7 Input/Outputs to assume a high impedance "OFF" state, regardless of other input conditions.

An Asynchronous/Synchronous (A/\bar{S}) Mode Control Input allows either asynchronous or synchronous data transfer. With the A/\bar{S} input HIGH, parallel data may be transferred asynchronously, independent of the Clock Input (CP), at the P_0 - P_7 or Q_0 - Q_7 Parallel Data Inputs/Outputs with the direction of data transfer dependent upon the state of the P/Q input. Asynchronous parallel data transfer at either P_0 - P_7 or Q_0 - Q_7 occurs when both the Asynchronous/Synchronous (A/\bar{S}) and the Parallel Load/Parallel Enable (PL/PE) Inputs are HIGH. With the A/\bar{S} input LOW parallel or serial data may be transferred synchronously. Synchronous serial data transfer on the Serial Data Inputs (D_S) occurs on the LOW-to-HIGH transition at the Clock Input (CP) when both PL/PE and A/\bar{S} inputs are LOW. With A/\bar{S} LOW and PL/PE HIGH, synchronous parallel data transfer on either P_0 - P_7 or Q_0 - Q_7 occurs on the LOW-to-HIGH transition at the Clock Input (CP). The direction of data transfer is dependent upon the state of the P/Q input.

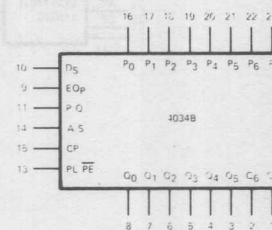
The 4034B is useful in applications requiring bi-directional transfer of parallel data between two data buses, conversion of serial data to parallel form and transfer of the parallel data to either of two data buses, recirculation of parallel data, or acceptance of parallel data from either of two buses for conversion to serial form.

- BI-DIRECTIONAL DATA TRANSFER
- ASYNCHRONOUS OR SYNCHRONOUS PARALLEL OPERATION
- SYNCHRONOUS SERIAL OPERATION
- 3-STATE OUTPUT ENABLE
- SERIAL-TO-PARALLEL OR PARALLEL-TO-SERIAL DATA TRANSFER
- PARALLEL LOAD OR PARALLEL ENABLE

PIN NAMES

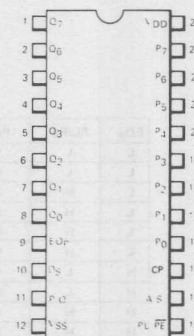
D_S	Serial Data Input
P_0 - P_7	Parallel Data Inputs/Outputs
Q_0 - Q_7	Parallel Data Inputs/Outputs
PL/PE	Parallel Load/Parallel Enable Input
CP	Clock Input
A/\bar{S}	Asynchronous/Synchronous Mode Control Input
P/Q	Data Transfer Mode Control Input
EOp	Output Enable Input for P_n Parallel Data Inputs/Outputs

LOGIC SYMBOL



V_{DD} = Pin 24
 V_{SS} = Pin 12

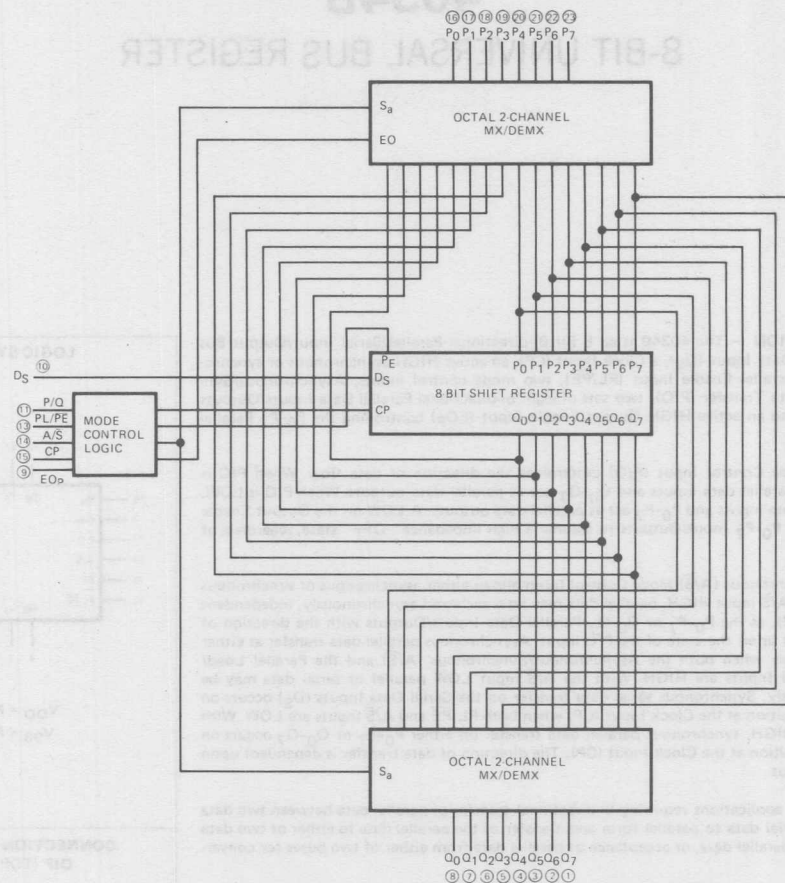
CONNECTION DIAGRAMS DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4034B

BLOCK DIAGRAM



VDD = Pin 24
VSS = Pin 12
○ = Pin Number

MODE SELECTION TABLE

EOp	PL/PE	P/Q	A/S	MODE	OPERATION
L	L	L	X	Serial	Synchronous Serial data input, P and Q parallel data outputs disabled.
L	L	H	X	Serial	Synchronous Serial data input, Q Parallel data output.
L	H	L	L	Parallel	Q Synchronous Parallel data inputs, P Parallel data outputs disabled.
L	H	L	H	Parallel	Q Asynchronous Parallel data inputs, P Parallel data outputs disabled.
L	H	H	L	Parallel	P Parallel data inputs disabled, Q Parallel data outputs, synchronous data recirculation.
L	H	H	H	Parallel	P Parallel data inputs disabled, Q Parallel data outputs, asynchronous data recirculation.
H	L	L	X	Serial	Synchronous serial data input, P Parallel data output.
H	L	H	X	Serial	Synchronous serial data input, Q Parallel data output.
H	H	L	L	Parallel	Q Synchronous Parallel data input, P Parallel data output.
H	H	L	H	Parallel	Q Asynchronous Parallel data input, P Parallel data output.
H	H	H	L	Parallel	P Synchronous Parallel data input, Q Parallel data output.
H	H	H	H	Parallel	P Asynchronous Parallel data input, Q Parallel data output.

X = Don't Care, H = HIGH Level, L = LOW Level

Note:

Outputs change at positive transition of clock in the serial mode and when the A/S input is LOW in the parallel mode. During transfer from parallel to serial operation, A/S should remain LOW in order to prevent D_S transfer into flip-flops.

FAIRCHILD CMOS • 4034B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF Current HIGH	XC									1.6 12	μA	MIN, 25°C MAX	Output Returned to V _{DD} , EO _P = V _{SS}
		XM									0.4 12		MIN, 25°C MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6 -12	μA	MIN, 25°C MAX	Output Returned to V _{SS} , EO _P = V _{SS}
		XM									-0.4 -12		MIN, 25°C MAX	
I _{DD}	Quiescent Power Supply Current	XC			20 150			40 300			80 600	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
		XM			5 150			10 300			20 600		MIN, 25°C MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

A SYNCHRONOUS MODE ONLY

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5V			V _{DD} = 10V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{pLH}	Propagation Delay, PL/ \overline{PE} to Qn or Pn		300			160			120		ns	C _L = 50 pF, R _L = 200 Ω Input Transition Times ≤ 20 ns
t _{pHL}			300			160			120		ns	
t _{pLH}	Propagation Delay, A/ \overline{S} to Pn or Qn		285			150			115		ns	
t _{pHL}			285			150			115		ns	
t _{wA/\overline{S}(H)}	A/ \overline{S} Minimum Pulse Width (HIGH)		150			75			55		ns	
t _{wPL/\overline{PE}(H)}	PL/ \overline{PE} Minimum Pulse Width(HIGH)		150			75			55		ns	
t _{wP/Q}	P/Q Minimum Pulse Width		150			75			55		ns	
t _s	Set-Up Time, Pn or Qn to PL/ \overline{PE}		35			15			12		ns	
t _h	Hold-Time, Pn or Qn to PL/ \overline{PE}		-10			-5			-2		ns	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYNCHRONOUS MODE ONLY

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q _n or P _n		300			155			120		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			300			155			120		ns	
t _{WCP}	CP Minimum Pulse Width		100			50			40		ns	
t _s	Set-Up Time, PL/PE to CP		35			15			12		ns	
t _h	Hold Time, PL/PE to CP		-10			-5			-2		ns	
t _s	Set-Up Time, D _S to CP		35			15			12		ns	
t _h	Hold Time, D _S to CP		-10			-5			-2		ns	
t _s	Set-Up Time, A/ \overline{S} to CP		35			15			12		ns	
t _h	Hold Time, A/ \overline{S} to CP		-10			-5			-2		ns	
t _s	Set-Up Time, P/Q to CP		35			15			12		ns	
t _h	Hold Time, P/Q to CP		-10			-5			-2		ns	
f _{MAX}	Input Count Frequency (Note 3)		4			8			9		MHz	

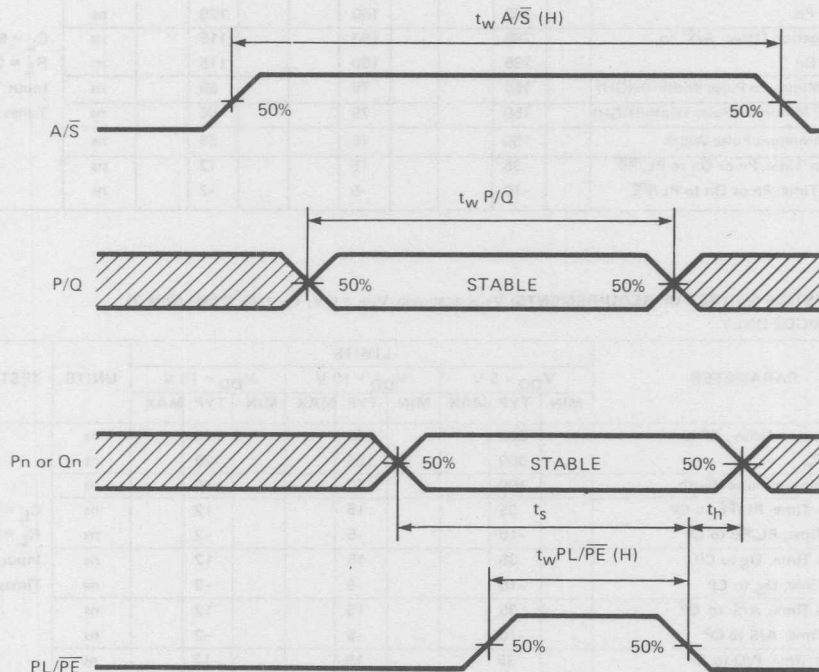
Notes are on the following page.

SYMBOL	PARAMETER	$V_{DD} = 5V$			$V_{DD} = 10V$			$V_{DD} = 15V$			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t_{PLH}	Propagation Delay, P/Q to Qn or Pn		300			160			120		ns	$C_L = 50 \text{ pF}$, $R_L = 200 \text{ k}\Omega$ Input Transition Times $\leq 20 \text{ ns}$
t_{PHL}			300			160			120		ns	
t_{PZH}	Output Enable Time (Note 5)		60			37			25		ns	
t_{PZL}			60			37			25		ns	
t_{PHZ}	Output Disable Time (Note 5)		60			37			25		ns	
t_{PLZ}			60			37			25		ns	
t_{TLH}	Output Transition Time		85			45			30		ns	
t_{THL}			85			45			30		ns	
$t_{WEOP(H)}$	EOp Minimum Pulse Width (HIGH)		150			75			55		ns	

Notes:

1. Additional dc characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For t_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μs at $V_{DD} = 5V$, 4 μs at $V_{DD} = 10V$, and 3 μs at $V_{DD} = 15V$.
5. For t_{PZH} and t_{PHZ} , $R_L = 1 \text{ k}\Omega$ to V_{SS} . For t_{PZL} and t_{PLZ} , $R_L = 1 \text{ k}\Omega$ to V_{DD} .

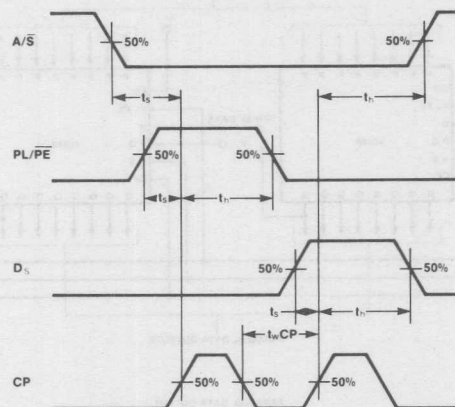
AC WAVEFORMS
ASYNCHRONOUS MODE ONLY



Minimum Pulse Widths for A/\bar{S} ,
 P/Q and $PL/\bar{P}E$ and Set-Up and
Hold Times $Pn \text{ or } Qn$ to $PL/\bar{P}E$

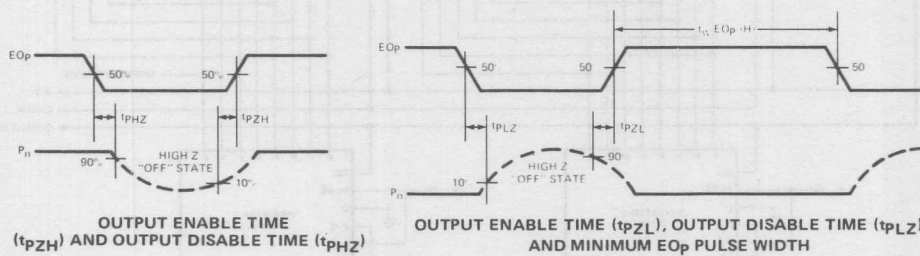
AC WAVEFORMS (Cont'd)

SYNCHRONOUS MODE ONLY



SET-UP AND HOLD-TIMES A/\bar{S} TO CP , PL/\bar{PE} TO CP AND D_S TO CP AND MINIMUM CLOCK PULSE WIDTH

ALL MODES OF OPERATION



NOTE:

Set-up and Hold Times are shown as positive values but may be specified as negative values.



A "HIGH" ("LOW") on the Shift Left/Shift Right Input allows serial data on the Shift Left Input (Shift Right Input) to enter the register on the positive transition of the clock signal. A "HIGH" on the Output Enable Input disables the "P" Parallel Data lines on registers 1 and 2 and enables the "P" data lines on registers 3 and 4 and allows parallel data into registers 1 and 2. Other logic schemes may be used in place of registers 3 and 4 for parallel loading.

When parallel inputs are not used registers 3 and 4 and associated logic are not required.

The shift left input must be disabled during parallel entry.

4035B

4-BIT UNIVERSAL SHIFT REGISTER

DESCRIPTION — The 4035B is a fully synchronous edge-triggered 4-Bit Shift Register with a Clock Input (CP), four synchronous Parallel Data Inputs (P_0 – P_3), two synchronous Serial Data Inputs (J, K), a synchronous Parallel Enable Input (PE), Buffered Parallel Outputs from all 4-bit positions (Q_0 – Q_3), a True/Complement Input (T/\bar{C}) and an overriding asynchronous Master Reset Input (MR).

Operation is synchronous (except for Master Reset) and is edge-triggered on the LOW-to-HIGH transition of the Clock Input (CP). When the Parallel Enable Input (PE) is HIGH, data is loaded into the register from Parallel Inputs (P_0 – P_3) on the LOW-to-HIGH transition of the Clock Input (CP). When the Parallel Enable Input (PE) is LOW, data is shifted into the first register position from the Serial Data Inputs (J, K) and all the data in the register is shifted one position to the right on the LOW-to-HIGH transition of the Clock Input (CP). D-type entry is obtained by tying the two Serial Data Inputs (J, K) together.

The Outputs (Q_0 – Q_3) are either inverting or non-inverting, depending on the True/Complement Input (T/\bar{C}). With the T/\bar{C} Input HIGH, the Outputs (Q_0 – Q_3) are non-inverting (Active HIGH). With the T/\bar{C} Input LOW, the Outputs (Q_0 – Q_3) are inverting (Active LOW).

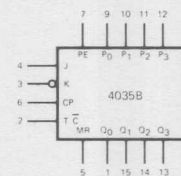
A HIGH on the Master Reset Input (MR) resets all four bit positions (Q_0 – Q_3 = LOW if T/\bar{C} = HIGH, Q_0 – Q_3 = HIGH if T/\bar{C} = LOW) independent of all other input conditions.

- TYPICAL SHIFT FREQUENCY OF 17 MHz AT V_{DD} = 10 V
- J, \bar{K} INPUTS TO THE FIRST STAGE
- T/\bar{C} INPUT FOR TRUE OR COMPLEMENTARY OUTPUTS
- SYNCHRONOUS PARALLEL ENABLE
- CLOCK EDGE-TRIGGERED ON LOW-TO-HIGH TRANSITION
- ASYNCHRONOUS MASTER RESET

PIN NAMES

PE	Parallel Enable Input
P_0 – P_3	Parallel Data Inputs
J	First Stage J Input (Active HIGH)
\bar{K}	First Stage K Input (Active LOW)
CP	Clock Input (L→H Edge-Triggered)
T/\bar{C}	True/Complement Input
MR	Master Reset Input
Q_0 – Q_3	Buffered Parallel Outputs

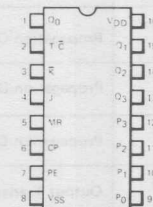
LOGIC SYMBOL



V_{DD} = Pin 16

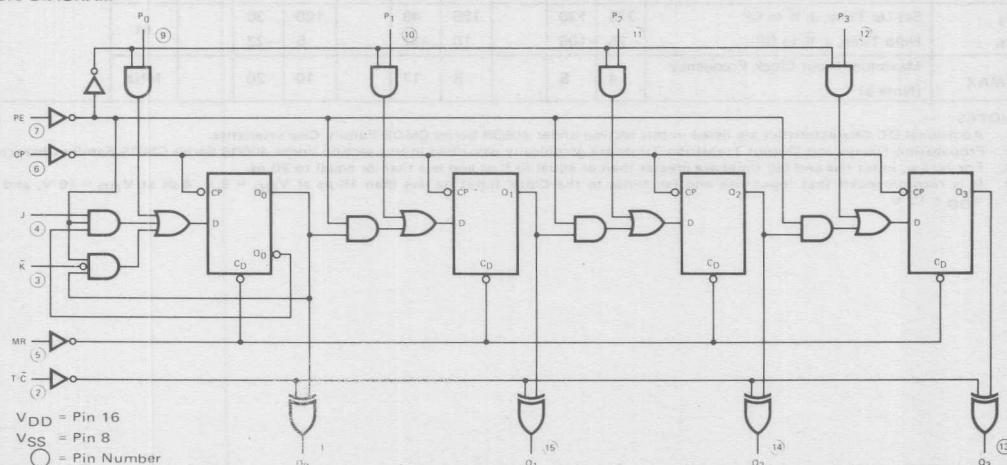
V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



FAIRCHILD CMOS • 4035B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

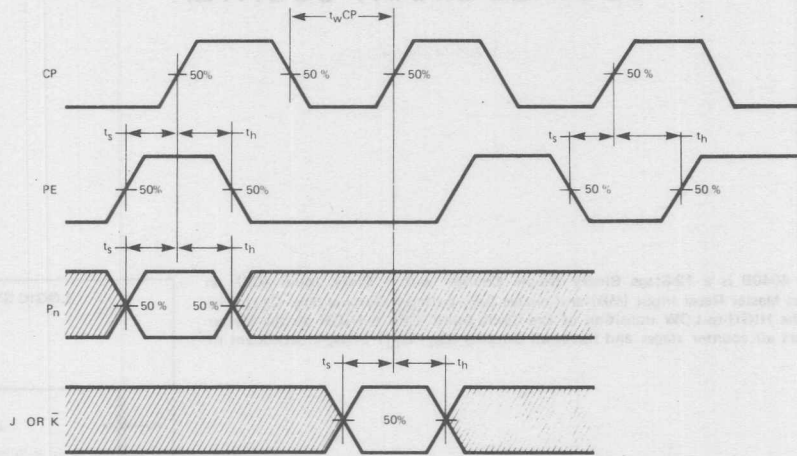
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q _N		200	400		90	180		60	140	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	Propagation Delay, MR to Q _N		200	400		90	180		60	140	ns	
t _{PLH}	Propagation Delay, T/C to Q _N		250	500		120	230		75	180	ns	
t _{PHL}	Propagation Delay, T/C to Q _N		250	500		120	230		75	180	ns	
t _{PLH}	Propagation Delay, T/C to Q _N		125	250		55	120		40	95	ns	
t _{PHL}	Propagation Delay, T/C to Q _N		125	250		55	120		40	95	ns	
t _{TLH}	Output Transition Time		85	135		45	75		30	45	ns	
t _{THL}	Output Transition Time		85	135		45	75		30	45	ns	
t _{wCP}	CP Minimum Pulse Width	125	50		55	20		44	14		ns	
t _{wMR}	MR Minimum Pulse Width	150	60		70	25		56	20		ns	
t _{rec}	MR Recovery Time	120	60		54	30		43	22		ns	
t _s	Set-Up Time, P _N to CP	250	100		110	46		88	32		ns	
t _h	Hold Time, P _N to CP	10	-90		5	-32		0	-22		ns	
t _s	Set-Up Time, PE to CP	250	100		110	46		88	32		ns	
t _h	Hold Time, PE to CP	10	-90		5	-32		0	-22		ns	
t _s	Set-Up Time, J, K̄ to CP	275	130		125	48		100	30		ns	
t _h	Hold Time, J, K̄ to CP	25	-100		10	-37		5	-23		ns	
f _{MAX}	Maximum Input Clock Frequency (Note 3)	4	8		8	17		10	20		MHz	

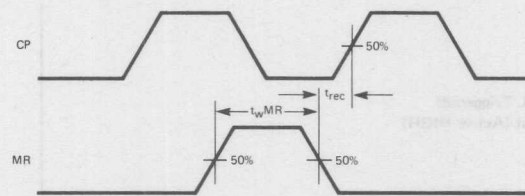
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

SWITCHING WAVEFORMS



MINIMUM CP PULSE WIDTH AND SET-UP
AND HOLD TIMES, PE TO CP, P_n TO CP, AND J OR K TO CP



MR RECOVERY TIME AND MINIMUM MR PULSE WIDTH

NOTE: Set-up and Hold Times are shown as positive values but may be specified as negative values.

4040B

12-STAGE BINARY COUNTER

DESCRIPTION — The 4040B is a 12-Stage Binary Ripple Counter with a Clock Input (\overline{CP}), an overriding asynchronous Master Reset Input (MR) and twelve fully buffered Outputs (Q_0 - Q_{11}). The counter advances on the HIGH-to-LOW transition of the Clock Input (\overline{CP}). A HIGH on the Master Reset Input (MR) clears all counter stages and forces all Outputs (Q_0 - Q_{11}) LOW, independent of the Clock Input (\overline{CP}).

- 25 MHz TYPICAL COUNT FREQUENCY AT $V_{DD} = 10\text{ V}$
- CLOCK IS H \rightarrow L TRIGGERED
- COMMON ASYNCHRONOUS MASTER RESET
- FULLY BUFFERED OUTPUTS FROM ALL 12 STAGES

PIN NAMES

\overline{CP}

MR

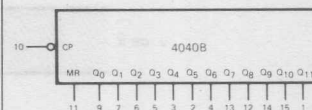
Q_0 - Q_{11}

Clock Input (H \rightarrow L Triggered)

Master Reset Input (Active HIGH)

Parallel Outputs

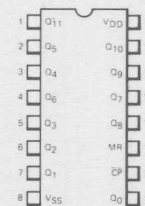
LOGIC SYMBOL



V_{DD} = Pin 16

V_{SS} = Pin 8

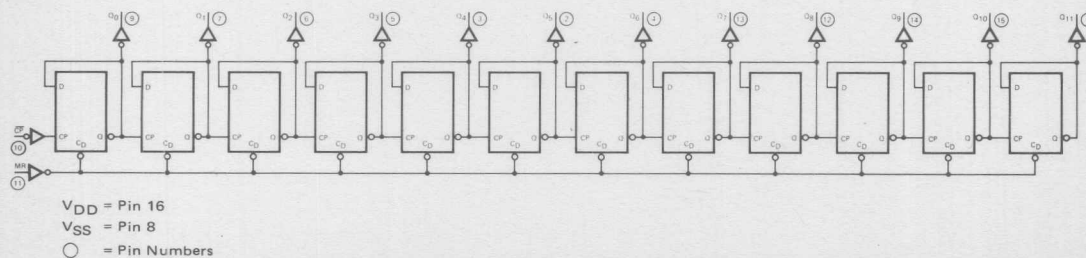
CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



FAIRCHILD CMOS • 4040B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

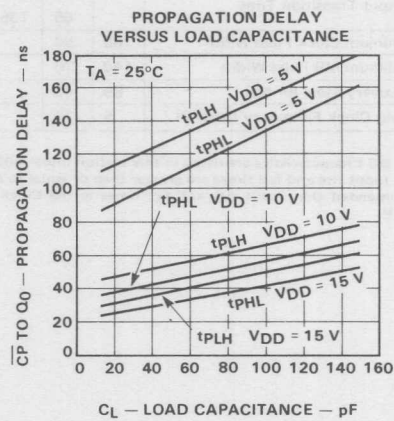
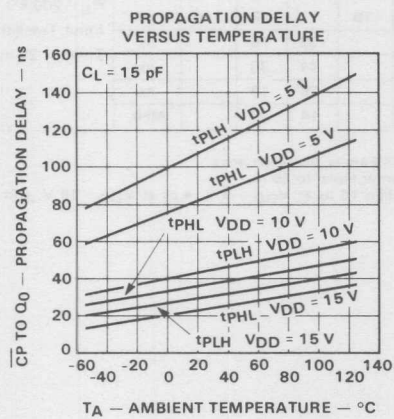
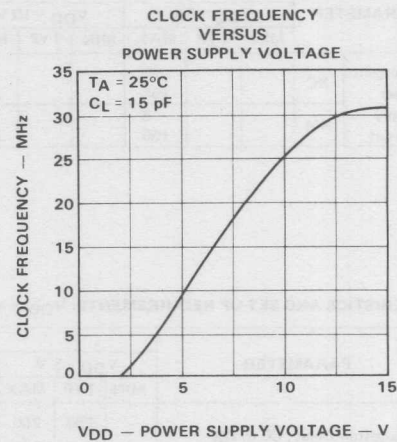
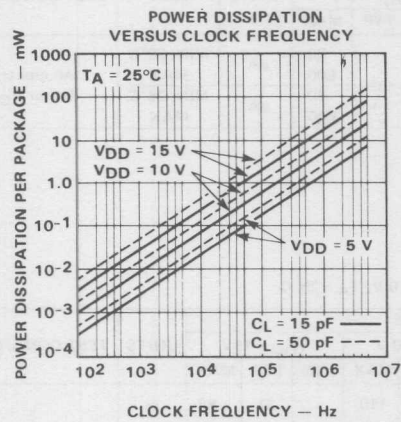
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, \overline{CP} to Q ₀		130	260		55	110		37	88	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			110	220		45	90		33	72	ns	
t _{PHL}	Propagation Delay, MR to Q _n		180	360		75	150		50	120	ns	
t _{TLH}	Output Transition Time		65	135		35	70		25	45	ns	
t _{THL}			65	135		35	70		25	45	ns	
t _{wCP(H)}	Minimum Clock Pulse Width	100	50		40	20		32	16		ns	
t _{wMR(H)}	Minimum MR Pulse Width	140	70		55	27		44	20		ns	
t _{rec}	Recovery Time for MR	85	43		35	17		28	12		ns	
f _{MAX}	Input Clock Frequency (Note 2)	5	10		12	25		14	30		MHz	

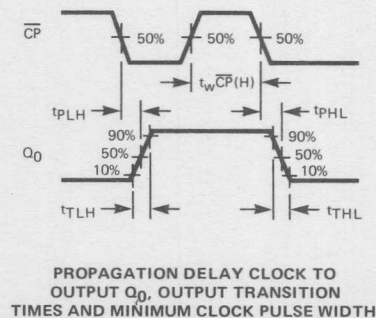
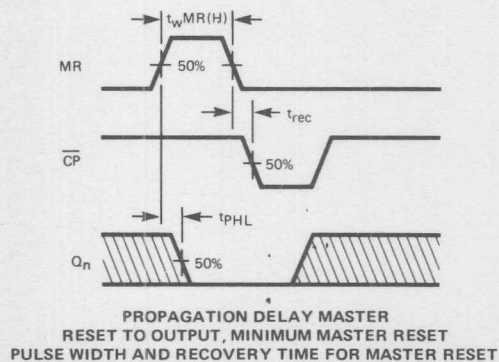
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
3. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

TYPICAL ELECTRICAL CHARACTERISTICS



SWITCHING WAVEFORMS

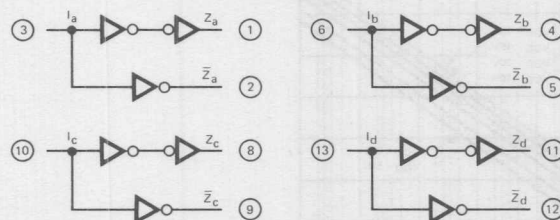


4041B

QUAD TRUE/COMPLEMENT BUFFER

GENERAL DESCRIPTION — The 4041B is a Quad True/Complement Buffer which provides both an inverted active LOW Output (\bar{Z}) and a non-inverted active HIGH Output (Z) for each Input (I).

LOGIC DIAGRAM

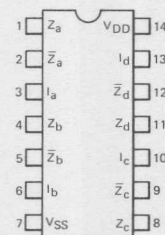


V_{DD} = Pin 14
 V_{SS} = Pin 7
 = Pin Number

PIN NAMES

I_a, I_b, I_c, I_d Buffer Input
 Z_a, Z_b, Z_c, Z_d Buffered True Output
 $\bar{Z}_a, \bar{Z}_b, \bar{Z}_c, \bar{Z}_d$ Buffered Complementary Output

**CONNECTION DIAGRAM
DIP (TOP VIEW)**



NOTE:

The flatpak version has the same pinouts (Connection Diagram) as the Dual In-Line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

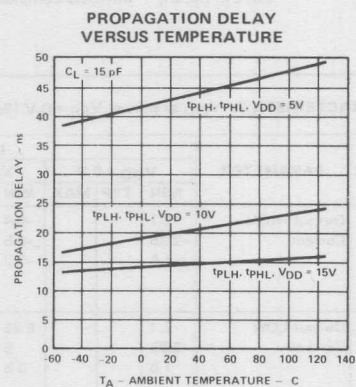
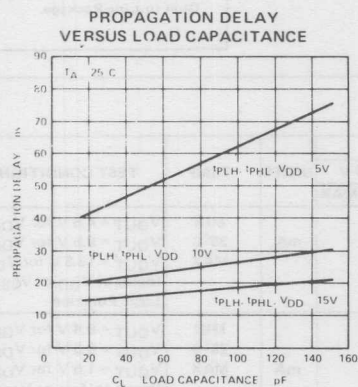
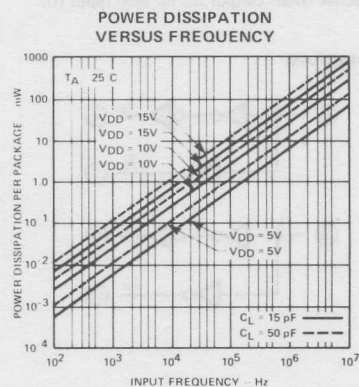
SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OH}	Output HIGH Current	-2.7			-5.4			-15.5			mA	MIN 25°C MAX	V _{OUT} = 4.6 V for V _{DD} = 5 V V _{OUT} = 9.5 V for V _{DD} = 10 V V _{OUT} = 13.5 V for V _{DD} = 15 V Inputs at V _{DD} or V _{SS} per Logic Function	
		-2.25			-4.5			-13						
		-1.6			-3.2			-8.7						
I _{OL}	Output LOW Current	2.7			6.25			18			mA	MIN 25°C MAX	V _{OUT} = 0.4 V for V _{DD} = 5 V V _{OUT} = 0.5 V for V _{DD} = 10 V V _{OUT} = 1.5 V for V _{DD} = 15 V Inputs at V _{DD} or V _{SS} per Logic Function	
		2.25			5			15						
		1.6			3.5			10						
I _{DD}	Quiescent Power Supply Current	XC			4			8			16	μA	MIN 25°C MAX	All inputs at 0 V or V _{DD}
			XM			1			2			4	μA	
					30			60			120			
					30			60			120			

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		$V_{DD} = 5V$			$V_{DD} = 10V$			$V_{DD} = 15V$				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t_{PLH}	Propagation Delay		60	125		25	60		20	48	ns	$C_L = 50 \text{ pF}$, $R_L = 200 \text{ k}\Omega$ Input Transition Times $\leq 20 \text{ ns}$
t_{PHL}			60	125		25	60		20	48	ns	
t_{TLH}	Output Transition Time		30	75		15	40		12	30	ns	
t_{THL}			30	75		15	40		12	30	ns	

NOTES

1. Additional dc characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation delays and output transition times are graphically described in this section under 4000 B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS



4042B

QUAD D LATCH

DESCRIPTION – The 4042B is a 4-Bit Latch with four Data Inputs (D_0 – D_3), four buffered Latch Outputs (Q_0 – Q_3), four buffered Complementary Latch Outputs (\bar{Q}_0 – \bar{Q}_3) and two Common Enable Inputs (E_0 and E_1). Information on the Data Inputs (D_0 – D_3) is transferred to the Outputs (Q_0 – Q_3) while both Enable Inputs (E_0 , E_1) are in the same state, either HIGH or LOW. The Outputs (Q_0 – Q_3) follow the Data Inputs (D_0 – D_3) as long as both Enable Inputs (E_0 , E_1) remain in the same state. When the two Enable Inputs (E_0 , E_1) are different, the Data Inputs (D_0 – D_3) do not affect the Outputs (Q_0 – Q_3) and the information in the latch is stored. The \bar{Q}_0 – \bar{Q}_3 Outputs are always the complement of the Q_0 – Q_3 Outputs. The Exclusive-OR input structure allows the choice of either polarity for the Enable Input. With one Enable Input HIGH, the other Enable Input is active HIGH; with one Enable Input LOW, the other Enable Input is active LOW.

The last moment prior to the trailing end of the enable condition that the Latch Outputs can still be affected by the inputs is specified as a set-up time. A negative set-up time, as typically exhibited by this device, means that the latches respond to input changes after the end of the enable condition. Following established industry practice, a hold time is specified, defining the time after the end of the enable condition, that the inputs must be held stable, so that they do not affect the state of the latches. It follows from this definition, that the hold time is identical with the negative set-up time. Set-up and hold times have a tolerance, due to manufacturing process variations, temperature and supply voltage changes. For predictable operation the data input levels must be held stable over the full spread of this timing window starting with the earliest set-up time (largest positive or smallest negative value) to the latest hold time.

- ACTIVE HIGH OR ACTIVE LOW ENABLE
- TRUE AND COMPLEMENTARY OUTPUTS (Q & \bar{Q})

PIN NAMES

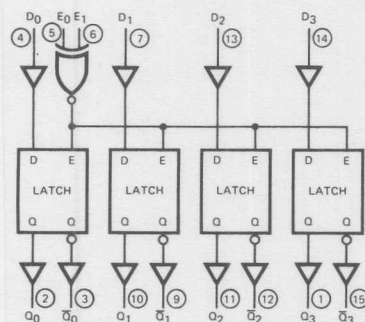
D_0 – D_3 Data Inputs
 E_0 , E_1 Enable Inputs
 Q_0 – Q_3 Parallel Latch Outputs
 \bar{Q}_0 – \bar{Q}_3 Complementary Parallel Latch Outputs

TRUTH TABLE

E_0	E_1	LATCH CONDITION
L	L	Enabled
L	H	Not Enabled
H	L	Not Enabled
H	H	Enabled

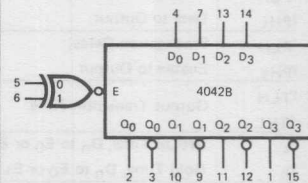
L = LOW Level
H = HIGH Level

LOGIC DIAGRAM



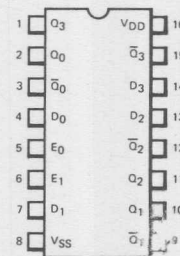
V_{DD} = Pin 16
 V_{SS} = Pin 8
○ = Pin Numbers

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4042B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20 150			40 300			80 600	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
	Supply Current	XM			5 150			10 300			20 600	μA	MIN, 25°C MAX	

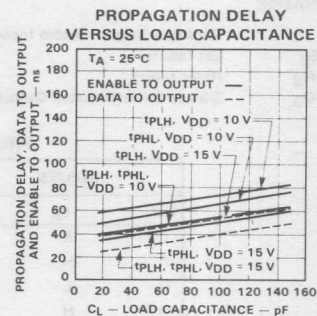
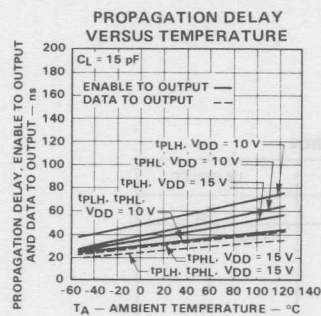
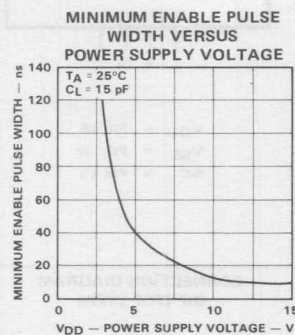
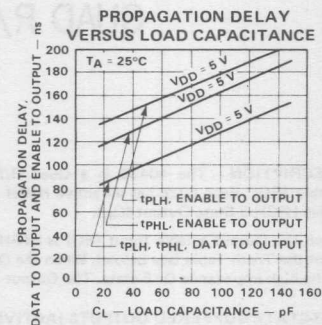
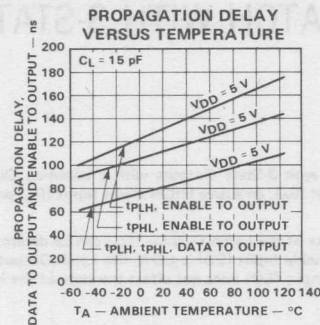
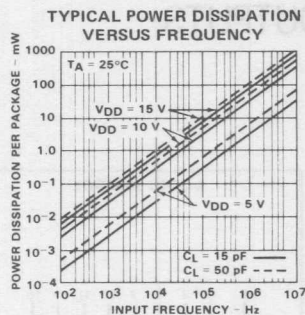
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Data to Output		101	200		45	90		33	72	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			99	200		44	88		33	70	ns	
t _{PLH}	Propagation Delay, Enable to Output		156	310		66	132		47	106	ns	
t _{PHL}			137	275		58	116		41	93	ns	
t _{TLH}	Output Transition Time		65	135		31	70		25	45	ns	
t _{THL}			60	135		26	70		20	45	ns	
t _s	Set-Up Time, D _n to E ₀ or E ₁	10	-12		10	-6		8	-4		ns	
t _h	Hold Time, D _n to E ₀ or E ₁	50	25		25	13		20	7		ns	
t _{wE_n}	Minimum Enable Pulse Width	80	40		32	16		25	12		ns	

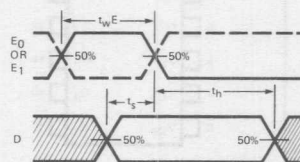
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS

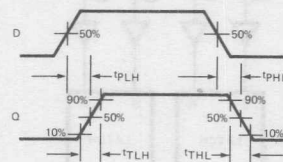


SWITCHING WAVEFORMS

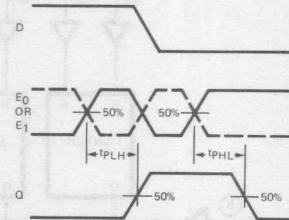


SET-UP AND HOLD TIMES, MINIMUM ENABLE PULSE WIDTH

NOTE:
Either E0 or E1 is held HIGH or LOW while the other Enable Input is pulsed as per the Truth Table. ts and th are shown as positive values but may be specified as negative values.



PROPAGATION DELAY DATA TO OUTPUT AND TRANSITION TIMES, WITH LATCH ENABLED



PROPAGATION DELAY ENABLE TO OUTPUT

NOTE:
Either E0 or E1 is held HIGH or LOW while the other Enable Input is pulsed as per the Truth Table.

4043B

QUAD R/S LATCH WITH 3-STATE OUTPUTS

DESCRIPTION — The 4043B is a Quad R/S Latch with 3-State Outputs with a common Output Enable (EO). Each latch has an active HIGH Set Input (S_n), an active HIGH Reset Input (R_n) and an active HIGH 3-State Output (Q_n).

When the Output Enable Input (EO) is HIGH, the state of the Latch Outputs (Q_n) can be determined from the Truth Table (see below). When the Output Enable Input (EO) is LOW, the Latch Outputs are in the high impedance OFF state. The Output Enable Input (EO) does not affect the state of the latch.

- 3-STATE BUFFERED OUTPUTS (ACTIVE HIGH)
- COMMON OUTPUT ENABLE
- SET INPUTS TO EACH LATCH (ACTIVE HIGH)
- RESET INPUTS TO EACH LATCH (ACTIVE HIGH)

PIN NAMES

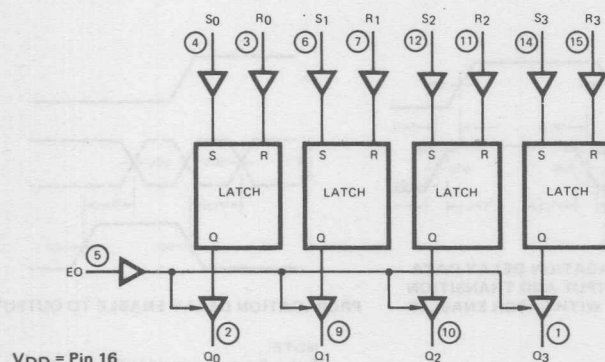
EO Common Output Enable Input
 S_0 – S_3 Set Inputs
 R_0 – R_3 Reset Inputs
 Q_0 – Q_3 3-State Buffered Latch Outputs

TRUTH TABLE

INPUTS			OUTPUT
EO	S_n	R_n	Q_n
L	X	X	High Impedance
H	H	L	H
H	L	H	L
H	H	H	H
H	L	L	No Change

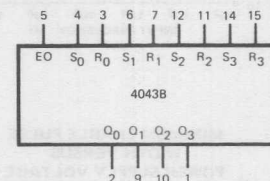
H = HIGH Level
 L = LOW Level
 X = Don't Care

LOGIC DIAGRAM



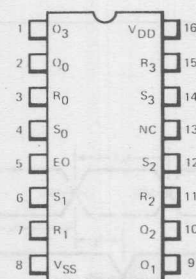
V_{DD} = Pin 16
 V_{SS} = Pin 8
 NC = Pin 13
 ○ = Pin Number

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8
 NC = Pin 13

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpack version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4043B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF Current HIGH	XC									1.6 12	μA	MIN, 25°C MAX	Output Returned to V _{DD} , EO = V _{SS}
		XM									0.4 12		MIN, 25°C MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6 -12	μA	MIN, 25°C MAX	Output Returned to V _{SS} EO = V _{SS}
		XM									-0.4 -12		MIN, 25°C MAX	
I _{DD}	Quiescent Power Supply Current	XC			20 150			40 300			80 600	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
		XM			5 150			10 300			20 600		MIN, 25°C MAX	

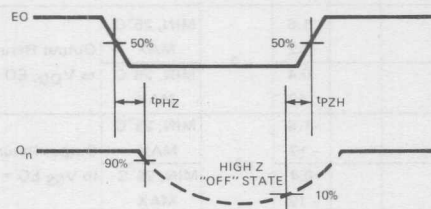
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, S _n to Q _n		80	145		30	70		24	56	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns (R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD}) (R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PHL}	Propagation Delay, R _n to Q _n		75	135		25	60		20	48	ns	
t _{PZH}	Output Enable Time		30	55		20	40		15	32	ns	
t _{PZL}			40	75		20	40		15	32	ns	
t _{PHZ}	Output Disable Time		20	45		20	40		18	32	ns	
t _{PLZ}			30	55		20	40		15	32	ns	
t _{TLH}	Output Transition Time		60	135		30	75		20	45	ns	
t _{THL}			60	135		30	75		20	45	ns	
t _W S _n	Minimum S _n Pulse Width	60	32		30	13		24	15		ns	
t _W R _n	Minimum R _n Pulse Width	60	32		30	13		24	15		ns	

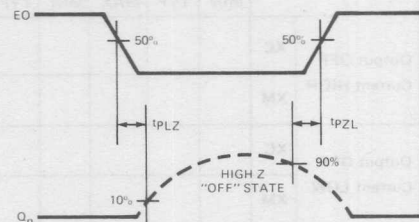
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

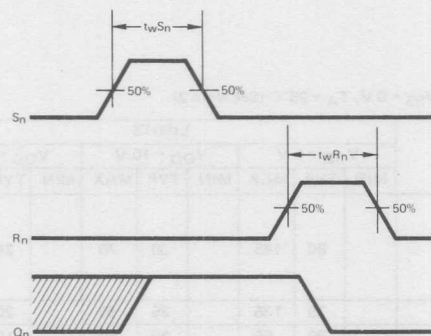
SWITCHING WAVEFORMS



OUTPUT ENABLE TIME (t_{pZH}) AND OUTPUT DISABLE TIME (t_{pHZ})

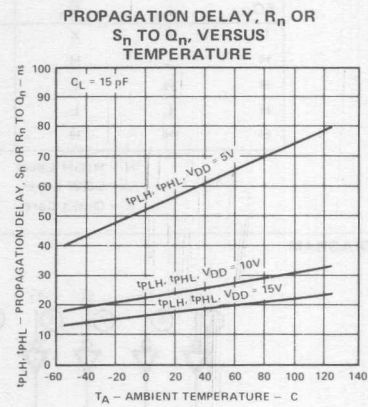
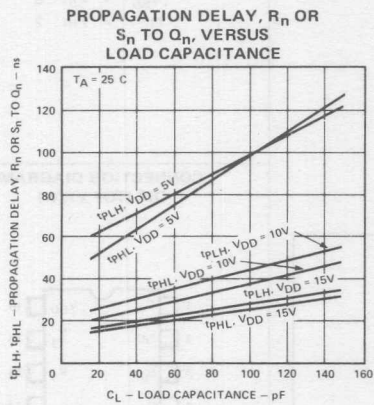
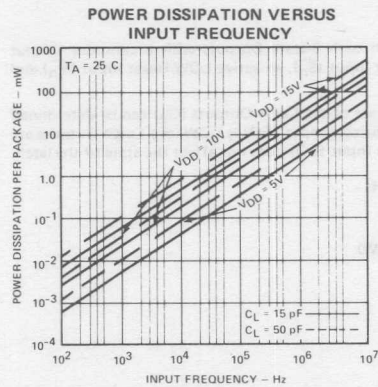


OUTPUT ENABLE TIME (t_{pZL}) AND OUTPUT DISABLE TIME (t_{pLZ})



MINIMUM R_N AND S_N PULSE WIDTHS AND RECOVERY TIMES FOR R_N AND S_N

TYPICAL ELECTRICAL CHARACTERISTICS



4044B

QUAD R/S LATCH WITH 3-STATE OUTPUTS

DESCRIPTION — The 4044B is a Quad R/S Latch with 3-state Outputs with a common Output Enable Input (EO). Each latch has an active LOW Set Input (\bar{S}_n), an active LOW Reset Input (\bar{R}_n) and an active HIGH 3-State Output (Q_n).

When the Output Enable Input (EO), is HIGH, the state of the Latch Outputs (Q_n) can be determined from the Truth Table (see below). When the Output Enable Input (EO) is LOW, the Latch Outputs are in the high impedance OFF state. The Output Enable Input (EO) does not affect the state of the latch.

- 3-STATE BUFFERED OUTPUTS (ACTIVE HIGH)
- COMMON OUTPUT ENABLE
- SET INPUTS TO EACH LATCH (ACTIVE LOW)
- RESET INPUTS TO EACH LATCH (ACTIVE LOW)

PIN NAMES

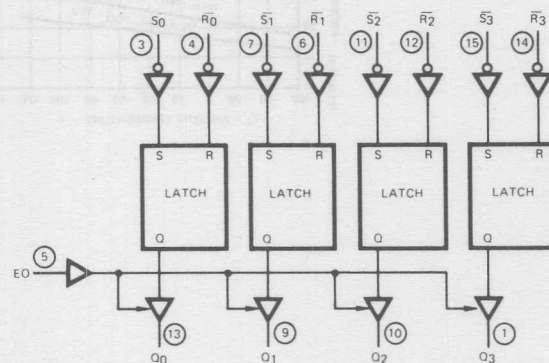
EO	Output Enable Input
\bar{S}_0 – \bar{S}_3	Set Inputs (Active LOW)
\bar{R}_0 – \bar{R}_3	Reset Inputs (Active LOW)
Q_0 – Q_3	3-State Buffered Latch Outputs

TRUTH TABLE

INPUTS			OUTPUT
EO	\bar{S}_n	\bar{R}_n	Q_n
L	X	X	High Impedance
H	L	H	H
H	H	L	L
H	L	L	L
H	H	H	No Change

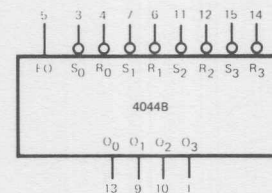
H = HIGH Level
L = LOW Level
X = Don't Care

LOGIC DIAGRAM



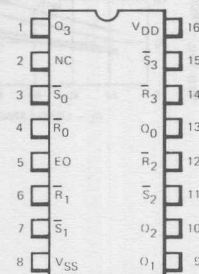
V_{DD} = Pin 16
 V_{SS} = Pin 8
NC = Pin 2
○ = Pin Numbers

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8
NC = Pin 2

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpack version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4044B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF Current HIGH	XC									1.6 12	μA	MIN, 25°C MAX	Output Returned to V _{DD} , EO = V _{SS}
		XM									0.4 12		MIN, 25°C MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6 -12	μA	MIN, 25°C MAX	Output Returned to V _{SS} , EO = V _{SS}
		XM									-0.4 -12		MIN, 25°C MAX	
I _{DD}	Quiescent Power Supply Current	XC			20 150			40 300			80 600	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
		XM			5 150			10 300			20 600		MIN, 25°C MAX	

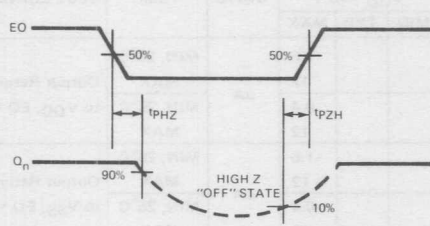
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ C$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, \bar{S}_n to Q _n		70	135		30	65		24	52	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns (R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD}) (R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PHL}	Propagation Delay, \bar{R}_n to Q _n		70	135		30	65		20	52	ns	
t _{PZH}	Output Enable Time		30	70		15	40		12	32	ns	
t _{PZL}			42	90		20	50		15	40	ns	
t _{PHZ}	Output Disable Time		22	55		20	50		15	40	ns	
t _{PLZ}			30	70		20	50		15	40	ns	
t _{TLH}	Output Transition Time		60	135		30	75		20	45	ns	
t _{THL}			60	135		30	75		20	45	ns	
t _{w\bar{S}_n}	Minimum \bar{S}_n Pulse Width	55	27		25	14		20	10		ns	
t _{w\bar{R}_n}	Minimum \bar{R}_n Pulse Width	55	27		25	14		20	10		ns	

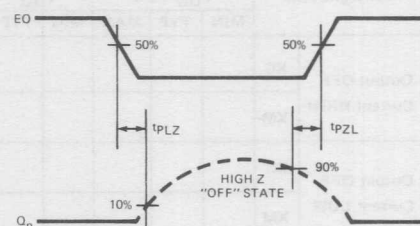
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

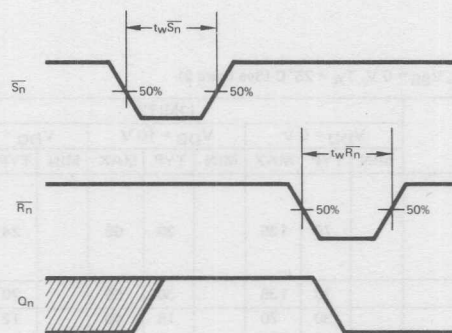
SWITCHING WAVEFORMS



OUTPUT ENABLE TIME
(t_{pZH}) AND OUTPUT DISABLE TIME (t_{pHZ})



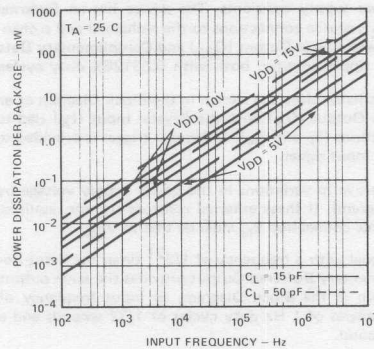
OUTPUT ENABLE TIME
(t_{pZL}) AND OUTPUT DISABLE TIME (t_{pLZ})



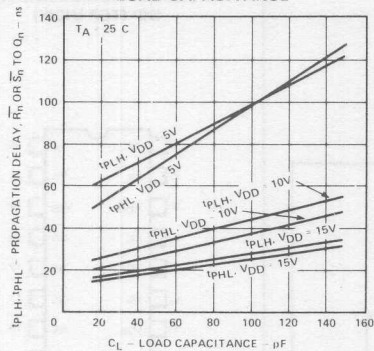
MINIMUM \overline{S}_n AND \overline{R}_n PULSE WIDTHS

TYPICAL ELECTRICAL CHARACTERISTICS

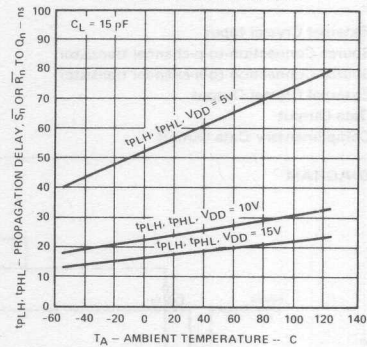
POWER DISSIPATION
VERSUS FREQUENCY



PROPAGATION DELAY,
Rn OR Sn TO Qn VERSUS
LOAD CAPACITANCE



PROPAGATION DELAY
Sn OR Rn TO Qn
VERSUS TEMPERATURE



4045B

21-STAGE BINARY COUNTER

GENERAL DESCRIPTION — The 4045B is a timing circuit consisting of an on-chip crystal oscillator circuit, a 21-stage binary ripple counter, two output pulse shaping circuits, two output buffers and one 20V Zener diode for protection against power supply transients. The device has an External Crystal Input (I_X), an External Crystal Output (O_X), source connections to the n-channel and p-channel transistors of the oscillator circuit (S_N and S_P), and a Data Output (Q_{20}) and Complimentary Data Output (\overline{Q}_{20}) from the 21st stage of the binary ripple counter, both with 0.03125% duty cycles.

The 4045B may be used with an external crystal oscillator circuit as shown in the Block Diagram or an external clock pulse may be applied to the Crystal Output (O_X) with the Crystal Input (I_X) tied to the Crystal Output (O_X) and to the source connections (S_P and S_N). A Schmitt trigger is provided to allow slow rise and fall times on the External Clock Input signal.

The crystal oscillator circuit can be made less sensitive to variations in the power supply voltage by adding external resistors R_1 and R_2 (see block diagram). If these external resistors are not required, source connection S_P must be tied to V_{DD} and source connection S_N must be tied to V_{SS} .

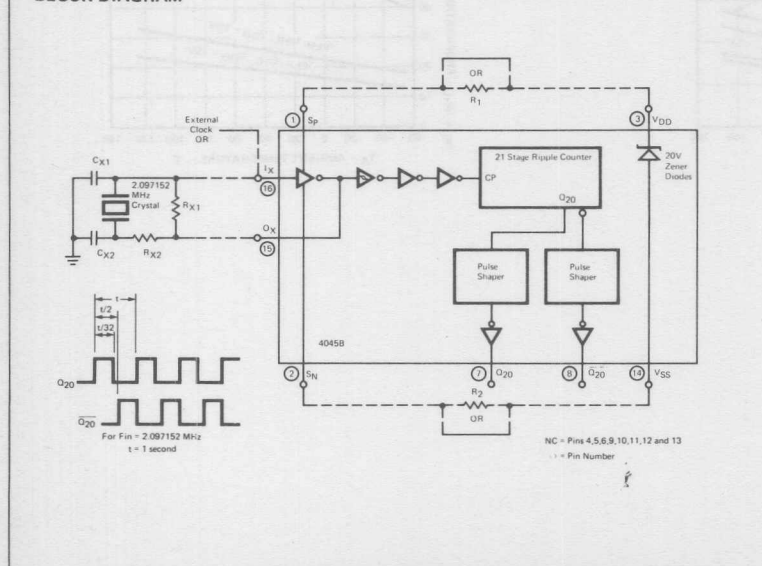
The Buffered Output (Q_{20}) provides an Output signal with a frequency of $1/2^{21}$ times the input frequency and a duty cycle of 0.03125%. The Complimentary Buffered Output provides the same output signal with a 180° phase shift from Q_{20} . As shown in the Block Diagram, an input frequency of 2.097152 MHz will yield output signals with frequencies of 1 Hz duty cycles of 1/32 seconds and a phase shift (between Q_{20} and \overline{Q}_{20}) of a one-half second.

- ON-CHIP CRYSTAL OSCILLATOR OR EXTERNAL CLOCK INPUT
- HIGH OUTPUT DRIVE CAPABILITY
- EXTERNAL SOURCE CONNECTIONS FOR IMPROVED TIMING STABILITY
- ON-CHIP ZENER DIODES FOR SUPPLY REGULATION

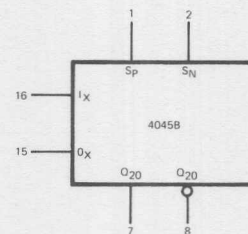
PIN NAMES

I_X	External Crystal Input
S_P	Source Connection-to-p-channel transistor
S_N	Source Connection-to-n-channel transistor
O_X	External Crystal Output
Q_{20}	Data Output
\overline{Q}_{20}	Complimentary Data Output

BLOCK DIAGRAM

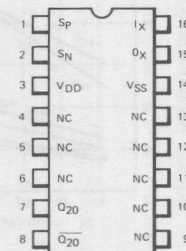


LOGIC SYMBOL



$V_{DD} = \text{PIN } 3$
 $V_{SS} = \text{PIN } 14$
 NC = PINS 4, 5, 6, 9, 10, 11, 12 AND 13

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-Line Package.

4046B

MICROPOWER PHASE-LOCKED LOOP

DESCRIPTION — The 4046B is a Micropower Phase-Locked Loop consisting of a low power linear Voltage-Controlled Oscillator, a Source Follower Circuit, two different Phase Comparators, and a Zener diode. The Voltage-Controlled Oscillator has two External Capacitor connections (C_{exta} , C_{extb}), two External Resistor connections (R_{exta} , R_{extb}), a Voltage-Controlled Oscillator Input (I_{VCO}) and a Voltage-Controlled Oscillator Output (O_{VCO}). The Source Follower Circuit provides a Demodulated Output (O_D) from the Voltage-Controlled Oscillator. An active LOW Enable Input (\bar{E}) common to both the Voltage-Controlled Oscillator and the Source Follower Circuit is also provided. Phase Comparator I and Phase Comparator II have common Signal (I_S) and Comparator (I_C) Inputs and separate outputs; Phase Comparator I Output (O_{PCI}), Phase Comparator II Output (O_{PCII}), and Phase Pulse Output (O_{PII}). An input to the Zener diode (I_Z) is also provided.

The Voltage-Controlled Oscillator requires one external capacitor (C_1) and one external resistor (R_1) to determine operational frequency range. A second external resistor (R_2) may be used to allow frequency offset. External resistor R_3 and external capacitor C_2 combined serve as a low pass filter to the Voltage-Controlled Oscillator Input (I_{VCO}). Output O_D is provided to avoid loading the low pass filter. External resistor R_4 is required if this output is utilized. O_D must be left open when not utilized. The output from the Voltage-Controlled Oscillator (O_{VCO}) may be connected directly or indirectly through CMOS frequency dividers (i.e., the 4018B, 4020B, 4022B, 4024B, 4029B, 4040B, 4518B, 4520B, 40160B, 40161B, 40162B, 40163B, 40192B or 40193B) to the Comparator Input (I_C). With the Enable Input (\bar{E}) HIGH both the Voltage-Controlled Oscillator and the Source Follower Circuit are OFF to minimize power consumption. With \bar{E} LOW, both are enabled.

For direct-coupling between O_{VCO} and I_C , the voltage swing at the Voltage-Controlled Oscillator Output (O_{VCO}) must be within standard CMOS logic levels ($V_{OH} > 0.7 \times V_{DD}$ and $V_{OL} < 0.3 \times V_{DD}$); otherwise the signal from O_{VCO} must be capacitively coupled to the Signal Input (I_S).

Phase Comparator I is an Exclusive OR circuit ($I_C \oplus I_S$). I_C and I_S must have 50% duty cycles to maximize lock range. When the Output of Phase Comparator I (O_{PCI}) is connected back to the Voltage-Controlled Oscillator through the low pass filter network, an averaged voltage to I_{VCO} forces oscillation at a center frequency.

Phase Comparator II is an edge-triggered digital memory network with four flip-flop stages, associated control circuitry and a 3-state output. Phase Comparator II triggers on LOW-to-HIGH transitions at the Signal (I_S) and Comparator (I_C) Inputs and is independent of duty cycle at these inputs. The Output of Phase Comparator II (O_{PCII}) provides voltage levels and duty cycles corresponding to frequency and phase differentials between I_C and I_S . When O_{PCII} is connected to the Voltage-Controlled Oscillator Input (I_{VCO}) through the low pass filter network, a corresponding voltage across capacitor C_2 is adjusted until the Signal (I_S) and Comparator (I_C) Inputs are equal in both frequency and phase. At this point Phase Comparator II maintains a constant voltage across Capacitor C_2 . When this stability has been established, the Phase Pulse Output (O_{PII}) is HIGH indicating a locked condition. Power dissipation in the low pass filter is reduced when Phase Comparator II is used.

A zener diode is provided for regulating the power supply voltage, if necessary.

- VERY LOW POWER CONSUMPTION
- HIGH VCO LINEARITY, 1% TYPICAL
- CHOICE OF 2-PHASE COMPARATORS
- ENABLE INPUT (ACTIVE LOW) FOR LOW POWER DISSIPATION IN STANDBY MODE
- ON-CHIP ZENER DIODE FOR SUPPLY REGULATION
- VCO FREQUENCY DRIFT WITH TEMPERATURE = $0.04\% / ^\circ\text{C}$ TYPICAL AT $V_{DD} = 10\text{ V}$

PIN NAMES

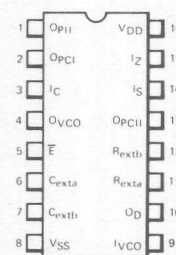
I_Z	Zener Diode Input
I_S	Signal Input
I_C	Comparator Input
I_{VCO}	Voltage-Controlled Oscillator Input
\bar{E}	Enable Input (Active LOW)
C_{exta} , C_{extb}	External Capacitor Connections
R_{exta} , R_{extb}	External Resistor Connections
O_{PCI}	Phase Comparator I Output
O_{PCII}	Phase Comparator II Output
O_{PII}	Phase Pulse Output
O_D	Demodulator Output
O_{VCO}	Voltage-Controlled Oscillator Output

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

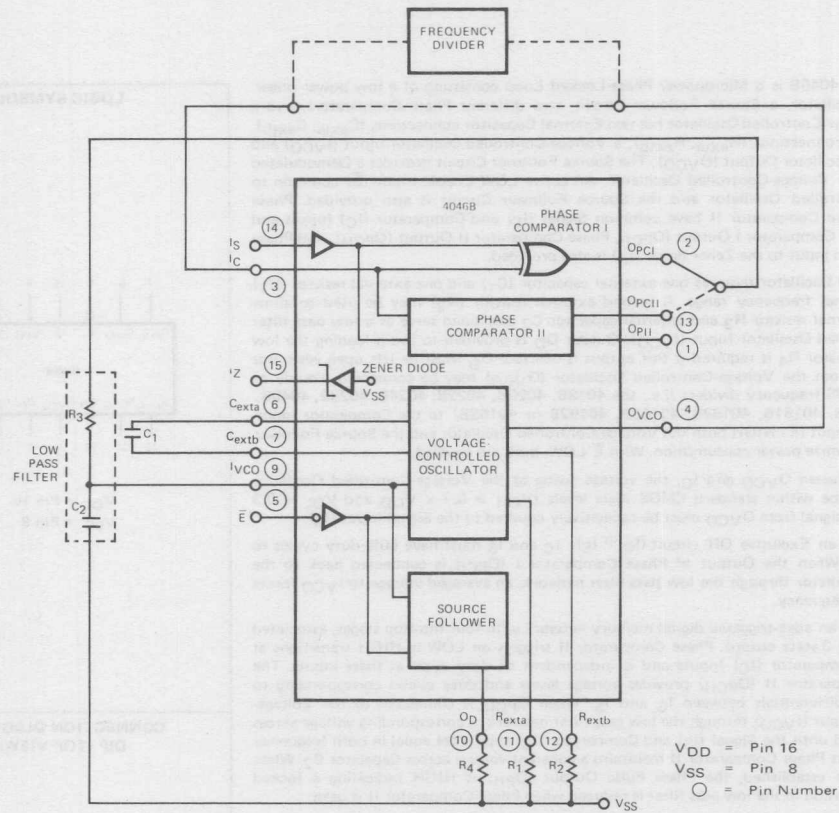
CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-Line Package.

FAIRCHILD CMOS • 4046B

BLOCK DIAGRAM



$10\text{ k}\Omega \leq R_1 \leq 1\text{ M}\Omega$
 $10\text{ k}\Omega \leq R_2 \leq 1\text{ M}\Omega$
 $10\text{ k}\Omega \leq R_4 \leq 1\text{ M}\Omega$
 $C_1 \geq 100\text{ pF at } V_{DD} = 5\text{ V}$
 $C_1 \geq 50\text{ pF at } V_{DD} = 10\text{ V}$

FUNCTIONAL DESCRIPTION — The 4046B, Micropower Phase-Locked Loop consists of a low power linear Voltage-Controlled Oscillator (VCO), a Source Follower circuit (SF), two Phase Comparators (PCI and PCII) and a Zener diode.

VOLTAGE-CONTROLLED OSCILLATOR

The VCO requires one external capacitor (C_1) and one external resistor (R_1) to determine operational frequency range. External resistor R_2 is used to allow for frequency offset, if required. It is recommended that R_1 and R_2 have a value between 10 k Ω and 1 M Ω . At $V_{DD} = 5$ V, C_1 should be greater than or equal to 100 pF, and at $V_{DD} = 10$ V, C_1 should be greater than or equal to 50 pF.

External resistor R_3 and external capacitor C_2 combined serve as a low-pass filter to the Voltage-Controlled Oscillator Input (I_{VCO}). The user is allowed a wide range of resistor-to-capacitor ratios for R_3 and C_2 because of the high input impedance at I_{VCO} (approximately $10^{12} \Omega$).

To avoid loading of the low-pass filter, the Demodulator Output (O_D) should be connected through external resistor R_4 as shown in the Block Diagram. It is recommended that R_4 have a value between 10 k Ω and 1 M Ω . If the O_D output is not utilized it must be left open.

The Voltage-Controlled Oscillator Output (O_{VCO}) provides a 0.3 V_{DD} to 0.7 V_{DD} output voltage swing and may be connected to the Comparator Input (I_C). O_{VCO} may, also be connected indirectly to I_C via CMOS frequency dividers (i.e., the 4018B, 4022B, 4029B, 4040B, 4518B, 4520B, 40160B, 40161B, 40162B, 40163B, 40192B, and 40193B.)

An Enable Input (\bar{E}) to the VCO and SF is provided for minimum stand-by power dissipation. With the \bar{E} Input HIGH both the VCO and the SF are OFF. With \bar{E} LOW, both are enabled.

PHASE COMPARATORS

For direct-coupling between O_{VCO} and I_C , the voltage swing at O_{VCO} must be within standard CMOS logic levels ($V_{OH} \geq 0.7 V_{DD}$ and $V_{OL} \leq 0.3 V_{DD}$); otherwise the signal from O_{VCO} must be capacitively coupled to the self-biasing amplifier at the I_S Input.

Phase Comparator I is an Exclusive OR circuit ($I_C \oplus I_S$). For maximum lock range, inputs to I_C and I_S must have 50% duty cycles. (Lock range, $2f_L$, is defined as that frequency range of input signals upon which the 4046B will stay locked from an initial locked condition). With no signal or noise input, Phase Comparator I provides an average output voltage equal to $V_{DD}/2$ at the O_{PCI} Output. This average output voltage is supplied to the I_{VCO} Input through the low-pass filter, which in turn forces the VCO to oscillate at a center frequency (f_0).

Capture range $2f_C$, is defined as that frequency range of input signals upon which the 4046B will lock from an initial unlocked condition. Capture range for PCI is directly dependent upon the characteristics of the low-pass filter network and may be as great as the lock range. Thus, PCI allows the user a phase-locked loop system which will remain in a locked condition despite high amounts of noise in the input signal.

It should be noted that with the use of PCI the system may lock onto input signals with frequencies that are near harmonics to the center frequency of the VCO. It should further be noted that the phase angle between the I_C and I_S Inputs will vary between 0° and 180° . At the center frequency the phase angle is 90° . Figure 2 illustrates a typical Phase Angle versus Average Output Voltage response characteristic for PCI. Figure 3 illustrates the typical waveforms for a phase-locked loop system employing PCI and locked at a center frequency.

Phase Comparator II is edge-triggered digital memory network with four flip-flop stages, associated control circuitry and a 3-state output, controlled internally. PCII triggers on LOW-to-HIGH transitions at the Signal (I_S) and Comparator (I_C) Inputs and is independent of duty cycle at these inputs. If the input frequency at I_S is higher than the input frequency at I_C , the p-channel output transistor at O_{PCII} is turned "ON" continuously, pulling the output (O_{PCII}) toward V_{DD} . If the input frequency at I_C is higher than the input frequency at I_S , the n-channel output transistor at O_{PCII} is turned "ON" continuously, pulling the output toward V_{SS} . If the input frequencies at I_S and I_C are equal, but I_S lags I_C in phase, the n-channel output transistor is turned "ON" for a period of time corresponding to the phase difference. If the input frequencies at I_S and I_C are equal, but I_C lags I_S in phase, the p-channel output transistor is turned "ON" for a period of time corresponding to the phase difference. Thus, over a period of time the voltage at capacitor C_2 is adjusted until the I_C and I_S input signals are of the same frequency and phase. Once this stability is reached, both p- and n-channel output transistors at O_{PCII} are "OFF". O_{PCII} becomes an open circuit holding the voltage across C_2 constant.

Once this stability is attained, the Phase Pulse Output (O_{PII}) is HIGH indicating a locked condition.

With PCII no phase difference is present between I_C and I_S over the entire VCO frequency range. Furthermore, since the 3-state Phase Comparator II Output (O_{PCII}) is mostly in the "OFF" condition, power dissipation through the low-pass filter is minimized. It should also be noted that $2f_C = 2f_L$ independent of the filter network in a phase-locked loop utilizing PCII. Figure 4 shows typical waveforms for a phase-locked loop system employing Phase Comparator II and locked at a center frequency.

Fig. 2 CHARACTERISTICS OF PHASE COMPARATOR I AT THE LOW PASS FILTER OUTPUT.

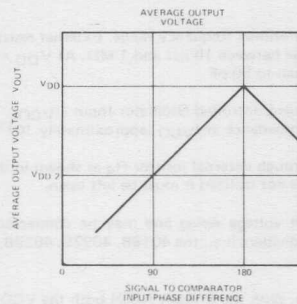


Fig. 3 A PLL SYSTEM USING PHASE COMPARATOR I.

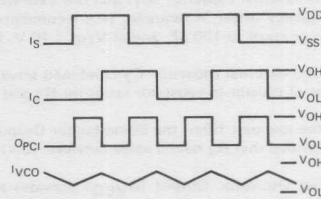


Fig. 4 A PLL SYSTEM USING PHASE COMPARATOR II

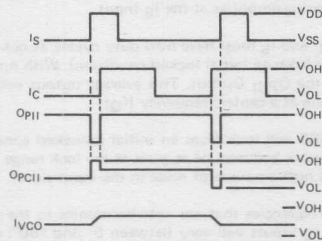


Fig. 5 TYPICAL LOW-PASS FILTERS.

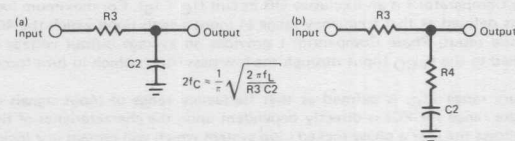
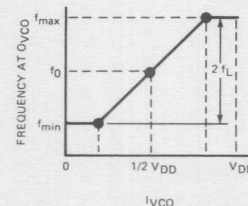


Fig. 6 DESIGN INFORMATION.

Characteristic	Using Phase Comparator 1	Using Phase Comparator 2
No signal on input I_S	VCO in PLL system adjusts to center frequency (f_0).	VCO in PLL system adjusts to minimum frequency (f_{min}).
Phase angle between I_S and I_C	90° at center frequency (f_0), approaching 0° and 180° at ends of lock range ($2f_L$).	Always 0° in lock (positive rising edges).
Locks on harmonics of center frequency.	Yes	No
Signal input noise rejection.	HIGH	LOW
Lock frequency range ($2f_L$).	The frequency range of the input signal on which the loop will stay locked if it was initially in lock. $2f_L = \text{full VCO frequency range} = f_{max} - f_{min}$.	
Capture frequency range ($2f_C$).	The frequency range of the input signal on which the loop will lock if it was initially out of lock.	
	Depends on low-pass filter characteristics (Figure 5) $f_C \leq f_L$	$f_C = f_L$
Center frequency (f_0).	The frequency of O_{VCO} when $I_{VCO} = 1/2 V_{DD}$	
O_{VCO} frequency (f).	$f \approx \frac{K \left[\frac{I_{VCO} - 1.65}{R_1} + \frac{V_{DD} - 1.35}{R_2} \right]}{(C_1 + 32)(V_{DD} + 1.6)} \text{ MHz (at } 25^\circ\text{C)}$ <p>where:</p> <p>V_{DD} in V; $5 \text{ V} < V_{DD} \leq 15 \text{ V}$ I_{VCO} in V; $1.65 \text{ V} \leq I_{VCO} \leq (V_{DD} - 1.35 \text{ V})$ R_1 and R_2 in $M\Omega$; $R_1, R_2 \geq 0.005 \text{ M}\Omega$ C_1 in pF; $C_1 \geq 50 \text{ pF}$ $K = 0.95 @ V_{DD} = 5 \text{ V}$ $= 0.95 @ V_{DD} = 10 \text{ V}$ $= 1.08 @ V_{DD} = 15 \text{ V}$</p>	

NOTE: The information presented here is meant only as a design guide.



FAIRCHILD CMOS • 4046B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (Note 1)

SYMBOL	PARAMETER	LIMITS									UNITS	TEMP	TEST CONDITIONS	
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V						
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX				
I _{DD}	Quiescent	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
	Power				150			300			600		MAX	
	Supply	XM			5			10			20	μA	MIN, 25°C	
	Current				150			300			600		MAX	

ELECTRICAL CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{TLH}	Propagation Delay,		72			48			38		ns	C _L = 50 pF
t _{THL}	Output Transition		72			48			38			R _L = 200 kΩ
	Time											Input Transition
												Times ≤ 20 ns

PHASE COMPARATORS

R _{IN}	Input Resistance	I _S I _C		200 10 ⁶		400 10 ⁶		700 10 ⁶		MΩ	
	AC Coupled Input Sensitivity for I _S			200		400		700		mV p-p	
V _{IN}	DC Coupled Input Sensitivity for I _S , I _C		See Note 1 for V _{IH} and V _{IL} Characteristics								

VOLTAGE CONTROLLED OSCILLATER

	Temperature- Frequency Stability		0.12		0.04		0.015		%/ $^\circ\text{C}$	No Frequency Offset, $f_{min} = 0$ See Note 3
			0.24		0.08		0.03			
			0.06		0.05		0.03			Frequency Offset, $f_{min} \neq 0$ See Note 4
			0.12		0.10		0.06			
	Linearity		1		1		1		%	See Note 2
	Output Duty Cycle		50		50		50		%	O_{VCO} tied to I_C
R_{IN}	Input Resistance to I_{VCO}		10^6		10^6		10^6		$M\Omega$	
f_{max}	Maximum Operating Frequency		0.9		1.7		2.3		MHz	See Note 6

SOURCE FOLLOWER

V_D	Offset Voltage at O_D		1.65		1.65		1.65		V	$R_4 > 10$ k Ω
	Linearity		0.1		0.6		0.8		%	See Note 5

ZENER DIODE

V_Z	Zener Voltage		7		7		7		V	$I_Z = 50$ μ A
R_Z	Zener Dynamic Resistance		100		100		100		Ω	$I_Z = 1$ mA

Notes:

- Additional dc characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- $I_{VCO} = 2.5$ V \pm 0.3 V, $R_1 > 10$ k Ω for $V_{DD} = 5$ V, $I_{VCO} = 5$ V \pm 2.5 V, $R_1 > 400$ k Ω for $V_{DD} = 10$ V, $I_{VCO} = 7.5$ V \pm 5 V, $R_1 > 1$ M Ω for $V_{DD} = 15$ V.
- $R_2 = \infty$, %/ $^\circ\text{C} \propto 1/(f - V_{DD})$.
- %/ $^\circ\text{C} \propto 1/(f - V_{DD})$.
- $R_4 > 50$ k Ω , $I_{VCO} = 2.5$ V \pm 0.3 V for $V_{DD} = 5$ V, $I_{VCO} = 5$ V \pm 2.5 V for $V_{DD} = 10$ V, $I_{VCO} = 7.5$ V \pm 5 V for $V_{DD} = 15$ V.
- $R_1 = 5$ k Ω , $R_2 = \infty$, $I_{VCO} = V_{DD}$, $C_1 = 50$ pF.

4047B

MONOSTABLE/ASTABLE MULTIVIBRATOR

DESCRIPTION — The 4047B is a Monostable/Astable Multivibrator capable of operating in either the monostable or astable mode. Operation in either mode requires an external capacitor (C_x) between pins 1 and 3 ($C_{ext}, R_{ext}/C_{ext}$) and an external resistor (R_x) between pins 2 and 3 ($R_{ext}, R_{ext}/C_{ext}$). These external timing components (R_x, C_x) determine the output pulse width in the monostable mode and the output frequency in the astable mode. The 4047B also has active HIGH and active LOW astable mode Enable Inputs (E_{A0}, E_{A1}), active HIGH and active LOW Trigger Inputs (T_0, T_1) for operation in the monostable mode, a Retrigger Input (I_{RT}), an Oscillator Output (O), active HIGH and active LOW flip-flop Outputs (Q, \bar{Q}) and an overriding asynchronous Master Reset Input (MR).

ASTABLE OPERATION. Astable operation is obtained by either a HIGH on the E_{A0} input or a LOW on the \bar{E}_{A1} input. The frequency of the 50% duty cycle output at the Q and \bar{Q} outputs is determined by the external timing components (R_x, C_x). A frequency twice that of the Q and \bar{Q} outputs is available at the Oscillator Output (O). However, a 50% duty cycle is not guaranteed. The 4047B can be used as a gated oscillator by controlling the E_{A0} and \bar{E}_{A1} inputs.

MONOSTABLE OPERATION. Monostable operation is obtained by connecting the E_{A0} input LOW and the \bar{E}_{A1} input HIGH. The device can be triggered by either a LOW-to-HIGH transition at the T_0 input while the \bar{T}_1 input is LOW or a HIGH-to-LOW transition at the \bar{T}_1 input while the T_0 is HIGH. The output pulse width at Q and \bar{Q} is determined by the external timing components (R_x, C_x). The device can be retrIGGERED by applying a simultaneous LOW-to-HIGH transition to both the Retrigger Input (I_{RT}) and the T_0 input while the \bar{T}_1 input is LOW.

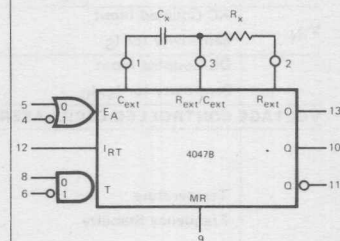
A HIGH on the Master Reset Input (MR) resets the output flip-flop ($Q = \text{LOW}$, $\bar{Q} = \text{HIGH}$ independent of all other input conditions).

- MONOSTABLE OR ASTABLE OPERATION
- TRUE AND COMPLEMENTARY BUFFERED OUTPUTS
- ENABLED WITH EITHER A LOW OR A HIGH LEVEL IN THE ASTABLE MODE
- TRIGGERED ON EITHER A LOW-TO-HIGH OR A HIGH-TO-LOW TRANSITION IN THE MONOSTABLE MODE
- ASYNCHRONOUS MASTER RESET
- IN THE MONOSTABLE MODE, OUTPUT PULSE WIDTH IS INDEPENDENT OF THE TRIGGER PULSE
- RETRIGGERABLE OPTION AVAILABLE FOR PULSE WIDTH EXPANSION
- IN THE ASTABLE MODE, MAY BE UTILIZED AS EITHER A FREE RUNNING OR GATED OSCILLATOR WITH A 50% OUTPUT DUTY CYCLE

PIN NAMES

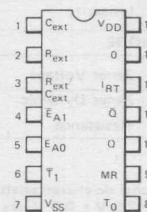
C_{ext}	External Capacitor Connection
R_{ext}	External Resistor Connection
R_{ext}/C_{ext}	Common External Capacitor and Resistor Connection
I_{RT}	Retrigger Input
T_0	Trigger Input (L \rightarrow H Triggered)
\bar{T}_1	Trigger Input (H \rightarrow L Triggered)
E_{A0}	Enable Input (Active HIGH)
\bar{E}_{A1}	Enable Input (Active LOW)
MR	Master Reset
O	Oscillator Output
Q, \bar{Q}	True and Complementary Buffered Outputs

LOGIC SYMBOL



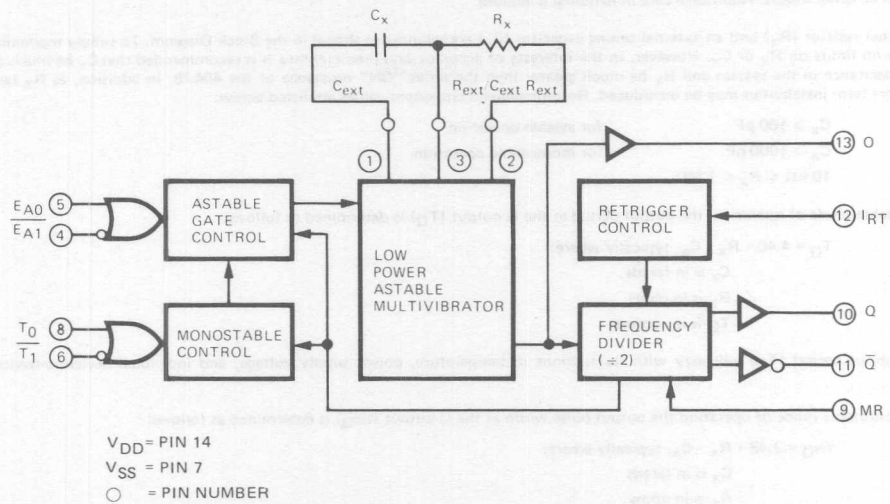
$V_{DD} = \text{Pin 14}$
 $V_{SS} = \text{Pin 7}$

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

BLOCK DIAGRAM



MODE SELECTION

INPUTS						FUNCTION
E_{A0}	$\overline{E_{A1}}$	T_0	$\overline{T_1}$	I_{RT}	MR	
H	X	L	H	L	L	Astable Multivibrator (Free Running)
X	L	L	H	L	L	Astable Multivibrator (Free Running)
\neg	H	L	H	L	L	Astable Multivibrator (True Gating)
L	\neg	L	H	L	L	Astable Multivibrator (Complement Gating)
L	H	\neg	L	L	L	Monostable Multivibrator (Positive-Edge Triggering)
L	H	H	\neg	L	L	Monostable Multivibrator (Negative-Edge Triggering)
L	H	\neg	L	\neg	L	Monostable Multivibrator (Retriggering)
X	X	X	X	X	H	Reset

H = HIGH LEVEL
 L = LOW LEVEL
 \neg = POSITIVE PULSE
 \neg = NEGATIVE PULSE
 \neg = POSITIVE-GOING TRANSITION
 \neg = NEGATIVE-GOING TRANSITION
 X = DON'T CARE

OPERATION RULES

- Under normal operating conditions of the 4047B, signals at the Common External Capacitor and Resistor Connection (R_{ext}/C_{ext}) may go above V_{DD} or below V_{SS} . A different input protection circuit has been utilized that is not as effective as the standard input protection circuit on all other inputs. Additional care in handling is advised.
- An external resistor (R_X) and an external timing capacitor (C_X) are required as shown in the Block Diagram. To simply maintain oscillation there are no limits on R_X or C_X . However, in the interests of accuracy and predictability it is recommended that C_X be much greater than stray capacitance in the system and R_X be much greater than the series "ON" resistance of the 4047B. In addition, as R_X becomes very large, short-term instabilities may be introduced. Recommended component values are listed below:

$$\begin{array}{ll} C_X \geq 100 \text{ pF} & \text{for astable operation} \\ C_X \geq 1000 \text{ pF} & \text{for monostable operation} \\ 10 \text{ k}\Omega \leq R_X \leq 1 \text{ M}\Omega & \end{array}$$

- In the astable mode of operation, the output period at the Q output (T_Q) is determined as follows:

$$T_Q = 4.40 \cdot R_X \cdot C_X, \text{ typically where:}$$

C_X is in farads
 R_X is in ohms
 T_Q is in seconds

Actual output period (T_Q) will vary with fluctuations in temperature, power supply voltage, and individual device-to-device threshold voltages.

- In the monostable mode of operation the output pulse width at the Q output (tw_Q) is determined as follows:

$$tw_Q = 2.48 \cdot R_X \cdot C_X, \text{ typically where:}$$

C_X is in farads
 R_X is in ohms
 tw_Q is in seconds

Actual output pulse width (tw_Q) will vary with fluctuations in temperature, power supply voltage, and individual device-to-device threshold voltages.

- It should be noted that in the astable mode of operation, the first positive half cycle will have a duration equal to $tw_Q = 2.48 \cdot R_X \cdot C_X$. Succeeding positive half cycles will have a duration of $T_Q = 4.40 \cdot R_X \cdot C_X$.
- Under all operating conditions, C_X and R_X must be kept as close to the circuit as possible to minimize stray capacitance and reduce noise pickup.
- V_{DD} and ground wiring should conform to good high frequency standards so that switching transients on V_{DD} and ground leads do not cause interaction between devices. Use of a 0.01 to 0.1 μF bypass capacitor between V_{DD} and ground located near the 4047B is recommended.
- In the retriggering mode of operation extended output pulse width at the Q or \bar{Q} outputs may be obtained by applying more than one input pulse to the T_Q and I_{RT} inputs simultaneously.
- An overriding active HIGH, Master Reset Input (MR) is provided on the 4047B device. By applying a HIGH to the Master Reset Input, any timing cycle can be terminated or any new cycle inhibited until the HIGH Master Reset signal is removed. Trigger inputs will not produce spikes in the output when Master Reset is HIGH.

FAIRCHILD CMOS • 4047B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

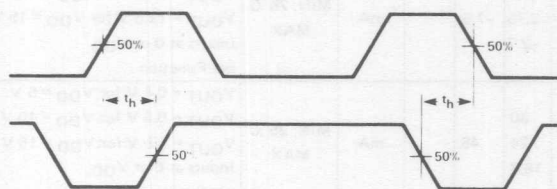
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ C$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, E _{A0} OR		100			50	125		38	100	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	E _{A1} to 0		100			50	125		38	100	ns	
t _{PLH}	Propagation Delay, E _{A0} OR		160			74	185		56	148	ns	
t _{PHL}	E _{A1} to Q or Q̄		160			74	185		56	148	ns	
t _{PLH}	Propagation Delay, T ₀ OR		210			94	235		68	108	ns	
t _{PHL}	T ₁ to Q or Q̄		210			94	235		68	108	ns	
t _{PLH}	Propagation Delay, T ₀ , I _{RT}		116			60	130		46	104	ns	
t _{PHL}	to Q or Q̄		116			60	130		46	104	ns	
t _{PLH}	Propagation Delay, MR to		100			44	125		28	100	ns	
t _{PHL}	Q or Q̄		100			44	125		28	100	ns	
t _{TLH}	Output Transition		65	135		31	75		24	45	ns	
t _{THL}	Time		60	135		25	75		20	45	ns	
t _w	Minimum Pulse Width (Any Input)	400	160		170	68		136	44		ns	
t _{rec}	MR Recovery Time	0	-30		0	-15		0	-10		ns	
t _h	Hold Time, T ₀ to T ₁	64	32		32	16		26	13		ns	
t _h	Hold Time, T ₁ to T ₀	64	32		32	16		26	13		ns	

Notes:

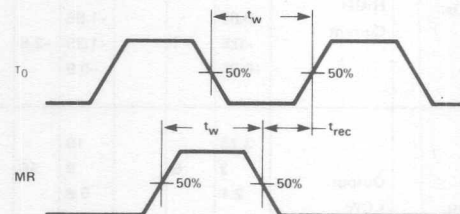
1. Additional dc characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. It is recommended that input rise and fall times to the T_0 , T_1 , or I_{RT} inputs be less than 15 μs at $V_{DD} = 5$ V, 4 μs at $V_{DD} = 10$ V and 3 μs at $V_{DD} = 15$ V. Also input rise and fall times to E_{A0} and E_{A1} should be less than 500 ns at any V_{DD} voltage.

SWITCHING WAVEFORMS



HOLD TIMES, T_0 TO T_1 AND T_1 TO T_0

Hold Times are shown as positive values, but may be specified as negative values.



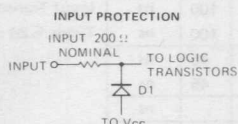
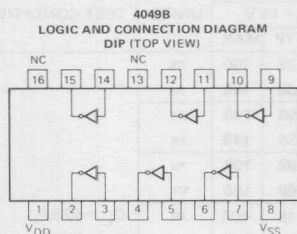
MINIMUM PULSE WIDTHS
AND RECOVERY TIME FOR MR

CONDITIONS: $T_1 = \text{LOW}$ while T_0 is triggered on a LOW-to-HIGH transition. t_W and t_{rec} also apply when $T_0 = \text{HIGH}$ and T_1 is triggered on a HIGH-to-LOW transition.

4049B • 4050B

4049B HEX INVERTING BUFFER • 4050B HEX NON-INVERTING BUFFER

DESCRIPTION — These CMOS buffers provide high current output capability suitable for driving TTL or high capacitance loads. Since input voltages in excess of the buffers' supply voltage are permitted, these buffers may also be used to convert logic levels of up to 15 V to standard TTL levels. The 4049B provides six inverting buffers, the 4050B six non-inverting buffers. Their guaranteed fan out into common bipolar logic elements is shown in Table 1.



NOTE: Typical Breakdown Voltage of Diode D1 is 20 V.

NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual in-line Package.

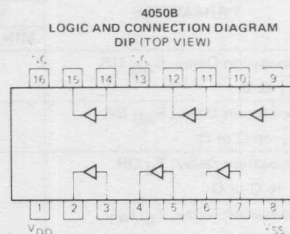


TABLE 1
Guaranteed fan out of 4049B, 4050B into common logic families

DRIVEN ELEMENT	GUARANTEED FAN OUT
Standard TTL, DTL	2
9LS, 93L, 74LS	9
74L	16

Conditions: $V_{DD} = V_{CC} = 5.0 \pm 0.25$ V
 $V_{OL} = 0.5$ V, $T_A = 0$ to 75° C

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, 4049BXM and 4050BXM (See Note 1)

SYMBOL	PARAMETER	LIMITS									UNITS	TEMP	TEST CONDITIONS			
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V								
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX						
I _{OH}	Output HIGH Current	-1.85 -1.25 -0.9	-2.5								mA	MIN, 25°C MAX	V _{OUT} = 2.5 V for V _{DD} = 5 V Inputs at 0 or V _{DD} per Function			
		-0.62 -0.5 -0.35	-1		-1.85 -1.25 -0.9	-2.5		-5.5 -3.75 -2.7	-7.5				mA	MIN, 25°C MAX	V _{OUT} = 4.5 V for V _{DD} = 5 V V _{OUT} = 9.5 V for V _{DD} = 10 V V _{OUT} = 13.5 V for V _{DD} = 15 V Inputs at 0 or V _{DD} per Function	
I _{OL}	Output LOW Current	3.75 3 2.1	6		10 8 5.6	16		30 24 16.8	48		mA	MIN, 25°C MAX			V _{OUT} = 0.4 V for V _{DD} = 5 V V _{OUT} = 0.5 V for V _{DD} = 10 V V _{OUT} = 1.5 V for V _{DD} = 15 V Inputs at 0 or V _{DD} per Function	
		3.3 2.6 1.8	5.2											mA	MIN, 25°C MAX	V _{OUT} = 0.4 V for V _{DD} = 4.5 V Inputs at 0 V or V _{DD} per Function
I _{DD}	Quiescent Power Supply Current			1 30			2 60			4 120	μA	MIN, 25°C MAX	All Inputs at 0 V or V _{DD}			

Notes on the following page.

FAIRCHILD CMOS • 4049B • 4050B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, 4049BXC and 4050BXC (Cont'd) (See Note 1)

SYMBOL	PARAM- ETER	LIMITS									UNITS	TEMP	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OH}	Output HIGH Current	-1.5 -1.25 -1.0	-2.5								mA mA mA	MIN 25°C MAX	V _{OUT} = 2.5 V for V _{DD} = 5 V Inputs at 0 or V _{DD} per Function
		-0.6 -0.5 -0.4	-1		-1.5 -1.25 -1.0	-2.5		-4.5 -3.75 -3	-7.5		mA mA mA	MIN 25°C MAX	V _{OUT} = 4.5 V for V _{DD} = 5 V V _{OUT} = 9.5 V for V _{DD} = 10 V V _{OUT} = 13.5 V for V _{DD} = 15 V Inputs at 0 or V _{DD} per Function
I _{OL}	Output LOW Current	3.6 3.0 2.5	6		9.6 8 6.6	16		28 24 19	48		mA mA mA	MIN 25°C MAX	V _{OUT} = 0.4 V for V _{DD} = 5 V V _{OUT} = 0.5 V for V _{DD} = 10 V V _{OUT} = 1.5 V for V _{DD} = 15 V Inputs at 0 or V _{DD} per Function
		3.1 2.6 2.1	5.2								mA mA mA	MIN 25°C MAX	V _{OUT} = 0.4 V for V _{DD} = 4.5 V Inputs at 0 V or V _{DD} per Function
I _{DD}	Quiescent Power Supply Current			4 30			8 60			16 120	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$, 4049B only (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		65	130		30	65		29	52	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			50	105		25	50		17	40		
t _{TLH}	Output Transition Time		73	145		40	80		30	60	ns	Input Transition Times ≤ 20 ns
t _{THL}			33	65		13	25		9	20		

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

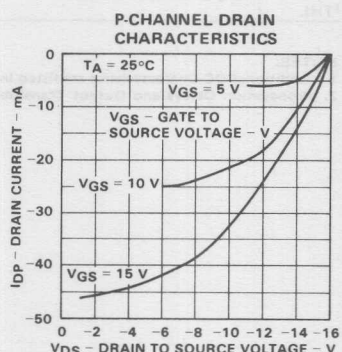
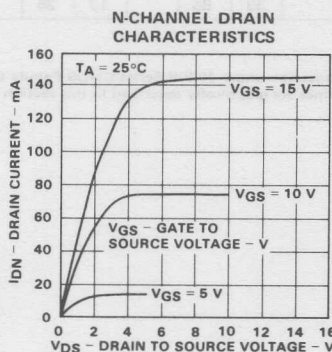
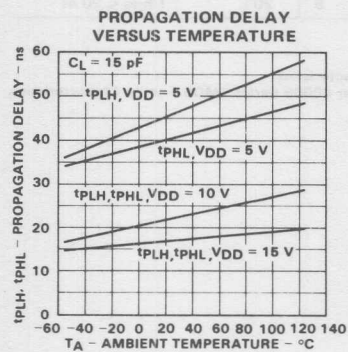
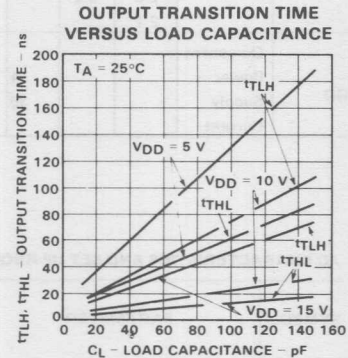
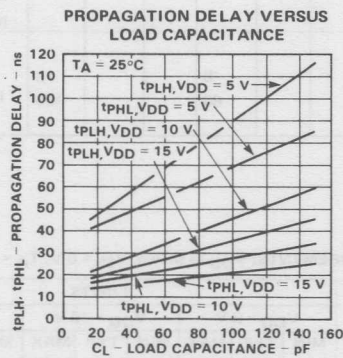
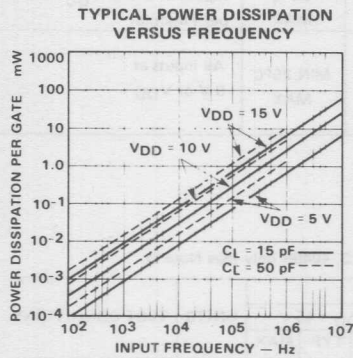
FAIRCHILD CMOS • 4049B • 4050B

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$, 4050B only (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		65	130		30	65		24	52	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			43	95		23	45		17	36		
t _{TLH}	Output Transition Time		73	145		90	80		30	60	ns	Input Transition Times ≤ 20 ns
t _{THL}			33	65		13	25		9	20		

Notes on preceding page.

TYPICAL ELECTRICAL CHARACTERISTICS



4051B

8-CHANNEL ANALOG MULTIPLEXER/DEMULPLEXER

DESCRIPTION — The 4051B is an 8-Channel Analog Multiplexer/Demultiplexer with three Address Inputs (A_0 – A_2), an active LOW Enable Input (\bar{E}), eight Independent Inputs/Outputs (Y_0 – Y_7) and a Common Input/Output (Z).

The 4051B contains eight bidirectional analog switches, each with one side connected to an Independent Input/Output (Y_0 – Y_7) and the other side connected to a Common Input/Output (Z). With the Enable Input (\bar{E}) LOW, one of the eight switches is selected (low impedance, ON state) by the three Address Inputs (A_0 – A_2). With the Enable Input (\bar{E}) HIGH, all switches are in the high impedance OFF state, independent of the Address Inputs.

V_{DD} and V_{SS} are the two supply voltage connections for the digital control inputs (A_0 – A_2 , \bar{E}). Their voltage limits are the same as for all other digital CMOS. The analog inputs/outputs (Y_0 – Y_7 , Z) can swing between V_{DD} as a positive limit and V_{EE} as a negative limit. V_{DD} – V_{EE} may not exceed 15 V. For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to V_{SS} (typically ground).

- ANALOG OR DIGITAL MULTIPLEXER/DEMULPLEXER
- COMMON ENABLE INPUT (ACTIVE LOW)

PIN NAMES

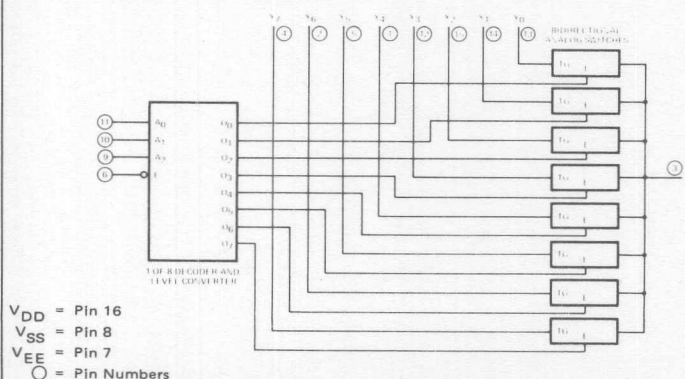
Y_0 – Y_7	Independent Inputs/Outputs
A_0 – A_2	Address Inputs
\bar{E}	Enable Input (Active LOW)
Z	Common Input/Output

TRUTH TABLE

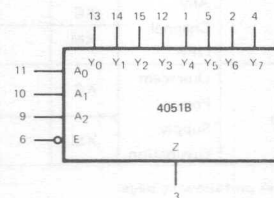
INPUTS				CHANNELS							
\bar{E}	A_2	A_1	A_0	Y_0 – Z	Y_1 – Z	Y_2 – Z	Y_3 – Z	Y_4 – Z	Y_5 – Z	Y_6 – Z	Y_7 – Z
L	L	L	L	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF
L	L	L	H	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF
L	L	H	L	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF
L	L	H	H	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF
L	H	L	L	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF
L	H	L	H	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF
L	H	H	L	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF
L	H	H	H	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON
H	X	X	X	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF

L = LOW Level
H = HIGH Level
X = Don't Care

4051B FUNCTIONAL LOGIC DIAGRAM

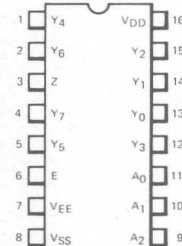


LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8
 V_{EE} = Pin 7

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram as the Dual In-Line Package).

FAIRCHILD CMOS • 4051B

DC CHARACTERISTICS: V_{DD} as shown, $V_{EE} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
R _{ON}	ON Resistance	XC		95	900		55	380		35	210	Ω	MIN	V _{is} = V _{DD} to V _{EE} Note 2
				100	1000		65	500		40	280		25°C	
				125	1100		100	600		65	340		MAX	
		XM		90	850		50	340		30	190	Ω	MIN	
	100		1000		65	500		40	280	25°C				
	150		1150		110	660		70	370	MAX				
ΔR _{ON}	“Δ” ON Resistance Between Any Two Channels			25			10			5		Ω	25°C	Note 2
I _Z	OFF State Leakage Current, All Channels OFF	XC						800				nA	25°C	$\bar{E} = V_{DD}$ V _{SS} = V _{DD} /2 V _{is} = V _{DD} or V _{EE} V _{os} = V _{EE} or V _{DD} $\bar{E} = V_{SS} = V_{DD}/2$ V _{is} = V _{DD} or V _{EE} V _{os} = V _{EE} or V _{DD}
		XM						80						
	Any Channel OFF	XC						100						
		XM						10						
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	V _{SS} = V _{EE} All inputs at V _{DD} or V _{EE}
	Supply Dissipation	XM			150			300			600		MAX	

Notes on following page.

2.1 EXAMINE								2.2 CHECK			
1-1	2-2	3-3	4-4	5-5	6-6	7-7	8-8	9-9	10-10	11-11	12-12
140	140	140	140	140	140	140	140	140	140	140	140
140	140	140	140	140	140	140	140	140	140	140	140
140	140	140	140	140	140	140	140	140	140	140	140
140	140	140	140	140	140	140	140	140	140	140	140
140	140	140	140	140	140	140	140	140	140	140	140
140	140	140	140	140	140	140	140	140	140	140	140
140	140	140	140	140	140	140	140	140	140	140	140
140	140	140	140	140	140	140	140	140	140	140	140
140	140	140	140	140	140	140	140	140	140	140	140

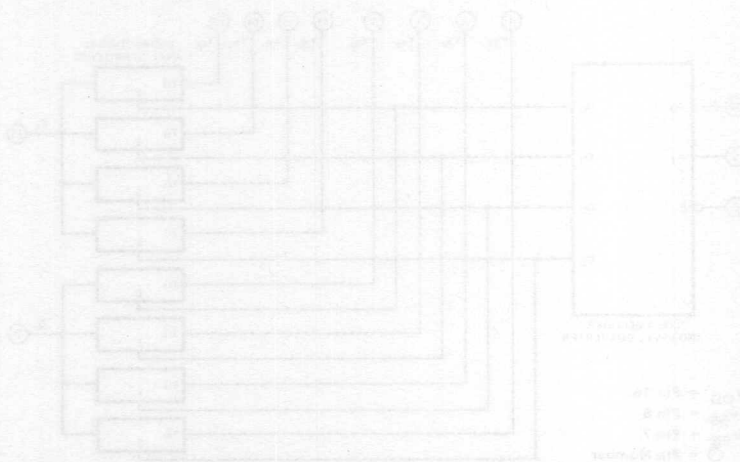
FAIRCHILD CMOS • 4051B

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{EE} = 0$ V, $T_A = 25$ °C (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Input to Output		25			10			6		ns	C _L = 50 pF, R _L = 200 kΩ E̅ = V _{SS} = V _{EE} .
t _{PHL}	Propagation Delay, Address to Output		10			6			4		ns	A _n or V _{is} = V _{DD} or V _{EE} Note 5
t _{PLH}	Propagation Delay, Input to Output		170			95			80		ns	C _L = 50 pF, R _L = 1 kΩ E or A _n = V _{SS} = V _{EE}
t _{PHL}	Propagation Delay, Address to Output		210			125			95		ns	V _{is} = V _{DD} or V _{EE} Note 5
t _{PZL}	Output Enable Time		185			95			75		ns	C _L = 50 pF, R _L = 1 kΩ E or A _n = V _{SS} = V _{EE}
t _{PZH}	Output Enable Time		205			105			85		ns	V _{is} = V _{DD} or V _{EE} Note 5
t _{PLZ}	Output Disable Time		1250			1130			1080		ns	
t _{PHZ}	Output Disable Time		1240			1120			1070		ns	
	Distortion, Sine Wave Response		0.2			0.2			0.2		%	R _L = 10 kΩ V _{SS} = V _{DD} /2, E̅ = V _{EE} , V _{is} = V _{DD} /2 (sine wave) p-p f _{is} = 1 kHz
	Crosstalk Between Any Two Channels					1					MHz	R _L = 1 kΩ, E̅ = V _{EE} V _{is} = V _{DD} /2 (sine wave) p-p at -40 dB V _{SS} = V _{DD} /2, 20 Log ₁₀ (V _{os} /V _{is}) = -40 dB
	OFF State Feedthrough					1					MHz	R _L = 1 kΩ, V _{SS} = V _{DD} /2 E̅ = V _{DD} V _{is} = V _{DD} /2 (sine wave) p-p 20 Log ₁₀ (V _{os} /V _{is}) = -40 dB
f _{MAX}	ON State Frequency Response		13			40			70		MHz	R _L = 1 kΩ, E̅ = V _{SS} V _{is} = V _{DD} /2 (sine wave) p-p V _{SS} = V _{DD} /2 20 Log ₁₀ (V _{os} /V _{os} @ 1 kHz) = -3 dB

NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- $\bar{E} = V_{SS}$, $R_L = 10$ k Ω , any channel selected and $V_{SS} = V_{EE}$ or $V_{DD}/2$.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
- V_{is}/V_{os} is the voltage signal at an Input/Output terminal (Y_n/Z_n).
- $V_{in} = V_{DD}$ (Square Wave), Input transition times = 20 ns, $R_L = 10$ k Ω .
- In certain applications, the current through the external load resistor (R_L) may include both V_{DD} and signal line components. To avoid drawing V_{DD} current when switch current flows into terminals 1, 2, 4, 5, 12, 13, 14, or 15 the voltage drop across the bidirectional switch must not exceed 0.5 V at $T_A = 25$ °C, or 0.3 V at $T_A = 25$ °C. No V_{DD} current will flow through R_L if the switch current flows into terminal 3.



4052B

DUAL 4-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

DESCRIPTION — The 4052B is a Dual 4-Channel Analog Multiplexer/Demultiplexer with common channel select logic. Each Multiplexer/Demultiplexer has four independent Inputs/Outputs (Y_0 – Y_3) and a Common Input/Output (Z). The common channel select logic includes two Address Inputs (A_0 , A_1) and an active LOW Enable Input (\bar{E}).

Both multiplexer/demultiplexers contain four bidirectional analog switches, each with one side connected to an Independent Input/Output (Y_0 – Y_3) and the other side connected to a Common Input/Output (Z). With the Enable Input LOW, one of the four switches is selected (low impedance, ON state) by the two Address Inputs. With the Enable Input HIGH, all switches are in the high impedance OFF state, independent of the Address Inputs.

V_{DD} and V_{SS} are the two supply voltage connections for the digital control inputs (A_0 , A_1 , \bar{E}). Their voltage limits are the same as for all other digital CMOS. The analog inputs/outputs (Y_0 – Y_3 , Z) can swing between V_{DD} as a positive limit and V_{EE} as a negative limit. V_{DD} – V_{EE} may not exceed 15 V. For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to V_{SS} (typically ground).

- DIGITAL OR ANALOG MULTIPLEXER/DEMULTIPLEXER
- COMMON ENABLE INPUT (ACTIVE LOW)

PIN NAMES

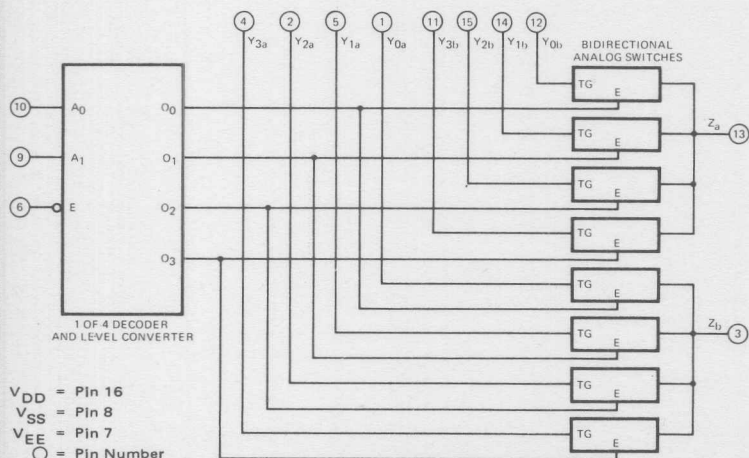
Y_{0a} – Y_{3a}	Independent Inputs/Outputs
Y_{0b} – Y_{3b}	Independent Inputs/Outputs
A_0 , A_1	Address Inputs
\bar{E}	Enable Input (Active LOW)
Z_a , Z_b	Common Input/Output

TRUTH TABLE

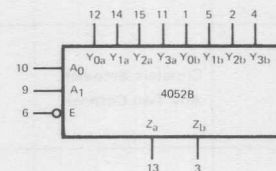
INPUTS			CHANNELS			
\bar{E}	A_1	A_0	Y_0 – Z	Y_1 – Z	Y_2 – Z	Y_3 – Z
L	L	L	ON	OFF	OFF	OFF
L	L	H	OFF	ON	OFF	OFF
L	H	L	OFF	OFF	ON	OFF
L	H	H	OFF	OFF	OFF	ON
H	X	X	OFF	OFF	OFF	OFF

L = LOW Level, H = HIGH Level, X = Don't care

4052B FUNCTIONAL LOGIC DIAGRAM

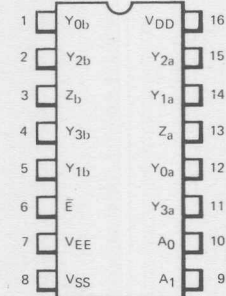


LOGIC SYMBOL



V_{DD} = PIN 16
 V_{SS} = PIN 8
 V_{EE} = PIN 7

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4052B

DC CHARACTERISTICS: V_{DD} as shown, $V_{EE} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			$V_{DD} = 5\text{ V}$			$V_{DD} = 10\text{ V}$			$V_{DD} = 15\text{ V}$					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
R_{ON}	ON Resistance	XC		95	900		55	380		35	210	Ω	MIN	$V_{IS} = V_{DD}$ to V_{EE} Note 2
				100	1000		65	500		40	280		25° C	
				125	1100		100	600		65	340		MAX	
		XM		90	850		50	340		30	190	Ω	MIN	
				100	1000		65	500		40	280		25° C	
				150	1150		110	660		70	370		MAX	
ΔR_{ON}	“Δ” ON Resistance Between Any Two Channels			25			10			5	Ω	25° C	Note 2	
I_Z	OFF State Leakage Current, All Channels OFF	XC						800				nA	25° C	$\bar{E} = V_{DD}$, $V_{SS} = V_{DD}/2$ $V_{IS} = V_{DD}$ or V_{EE} $V_{OS} = V_{EE}$ or V_{DD}
		XM						80						
	Any Channel OFF	XC						100						
		XM						10						
I_{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25° C	$V_{SS} = V_{EE}$ All inputs at V_{DD} or V_{EE}
					150			300			600		MAX	
	Supply	XM			5			10			20	μA	MIN, 25° C	
	Dissipation				150			300			600		MAX	

Notes on following page.

FAIRCHILD CMOS • 4052B

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{EE} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Input to Output		25			10			6		ns	C _L = 50 pF, R _L = 200 kΩ E̅ = V _{SS} = V _{EE} .
t _{PHL}	Propagation Delay, Address to Output		170			95			80		ns	A _n or V _{is} = V _{DD} or V _{EE} Note 5
t _{PZL}	Output Enable Time		185			95			75		ns	C _L = 50 pF, R _L = 1 kΩ E̅ or A _n = V _{SS} = V _{EE}
t _{PZH}	Output Disable Time		205			105			85		ns	V _{is} = V _{DD} or V _{EE} Note 5
t _{PLZ}	Distortion, Sine Wave Response		1250			1130			1080		%	R _L = 10 kΩ V _{SS} = V _{DD} /2, E̅ = V _{EE} . V _{is} = V _{DD} /2 (sine wave) p-p f _{is} = 1 kHz
t _{PHZ}	Crosstalk Between Any Two Channels		1240			1120			1070		MHz	R _L = 1 kΩ, E̅ = V _{EE} V _{is} = V _{DD} /2 (sine wave) p-p at -40 dB V _{SS} = V _{DD} /2, 20 Log ₁₀ (V _{os} /V _{is}) = -40 dB
	OFF State Feedthrough					1					MHz	R _L = 1 kΩ, V _{SS} = V _{DD} /2 E̅ = V _{DD} V _{is} = V _{DD} /2 (sine wave) p-p 20 Log ₁₀ (V _{os} /V _{is}) = -40 dB
f _{MAX}	ON State Frequency Response		13			40			70		MHz	R _L = 1 kΩ, E̅ = V _{SS} V _{is} = V _{DD} /2 (sine wave) p-p V _{SS} = V _{DD} /2 20 Log ₁₀ (V _{os} /V _{os} @ 1 kHz = -3 dB

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. $\bar{E} = V_{SS}$, $R_L = 10$ k Ω , any channel selected and $V_{SS} = V_{EE}$ or $V_{DD}/2$.
3. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
4. V_{is}/V_{os} is the voltage signal at an Input/Output terminal (Y_n/Z_n).
5. $V_{IN} = V_{DD}$ (Square Wave), Input transition times ≤ 20 ns
6. In certain applications, the current through the external load resistor (R_L) may include both V_{DD} and signal line components. To avoid drawing V_{DD} current when switch current flows into terminals 1, 2, 4, 5, 11, 12, 14, or 15 the voltage drop across the bidirectional switch must not exceed 0.5 V at $T_A \leq 25^\circ\text{C}$, or 0.3 V at $T_A > 25^\circ\text{C}$. No V_{DD} current will flow through R_L if the switch current flows into terminals 3 or 13.

4053B

TRIPLE 2-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

DESCRIPTION — The 4053B is a Triple 2-Channel Analog Multiplexer/Demultiplexer with a common Enable Input (\bar{E}). Each Multiplexer/Demultiplexer has two Independent Inputs/Outputs (Y_0, Y_1), a Common Input/Output (Z), and a Select Input (S). Each multiplexer/demultiplexer contains two bidirectional analog switches, each with one side connected to an Independent Input/Output (Y_0, Y_1) and the other side connected to a Common Input/Output (Z). With the Enable Input (\bar{E}) LOW, one of the two switches is selected (low impedance, ON state) by the Select Input (S). With the Enable Input (\bar{E}) HIGH, all switches are in the high impedance OFF state, independent of the Select Inputs (S_a, S_b, S_c).

V_{DD} and V_{SS} are the two supply voltage connections for the Digital Control Inputs (S_a, S_b, S_c, \bar{E}). Their voltage limits are the same as for all other digital CMOS. The analog Inputs/Outputs (Y_0, Y_1, Z) can swing between V_{DD} as a positive limit and V_{EE} as a negative limit. $V_{DD} - V_{EE}$ may not exceed 15 V. For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to V_{SS} (typically ground).

- ANALOG OR DIGITAL MULTIPLEXER/DEMULTIPLEXER
- COMMON ENABLE INPUT (ACTIVE LOW)

PIN NAMES

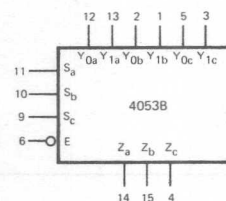
$Y_0, Y_1, Y_2, Y_3, Y_4, Y_5, Y_6, Y_7$	Independent Input/Outputs
S_a, S_b, S_c	Select Inputs
\bar{E}	Enable Input (Active LOW)
Z_a, Z_b, Z_c	Common Input/Outputs

TRUTH TABLE

INPUTS		CHANNELS	
\bar{E}	S	Y_0-Z	Y_1-Z
L	L	ON	OFF
L	H	OFF	ON
H	X	OFF	OFF

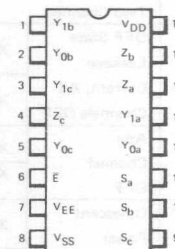
H = HIGH Level
L = LOW Level
X = Don't Care

LOGIC SYMBOL



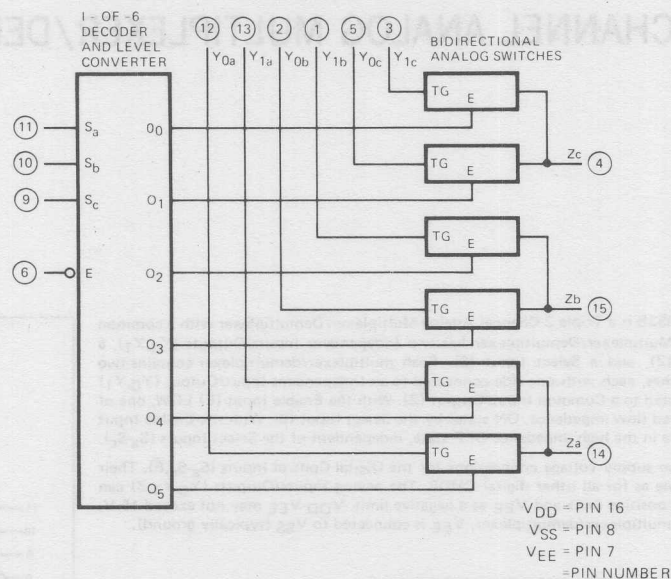
V_{DD} = Pin 16
 V_{SS} = Pin 8
 V_{EE} = Pin 7

CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FUNCTIONAL LOGIC DIAGRAM

DC CHARACTERISTICS: V_{DD} as shown, $V_{EE} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS		
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V							
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX					
R _{ON}	ON Resistance	XC		95	900		55	380		35	210	Ω	MIN 25°C MAX	V _{IS} = V _{DD} to V _{EE} Note 2		
				100	1000		65	500		40	280					
				125	1100		100	600		65	340					
		XM		90	850		50	340		30	190	Ω	MIN 25°C MAX			
				100	1000		65	500		40	280					
				150	1150		110	660		70	370					
ΔR _{ON}	“Δ” ON Resistance Between Any Two Channels			25		10			5		Ω	25°C	Note 2			
I _Z	OFF State Leakage Current, All Channels OFF	XC					800				nA	25°C	E̅ = V _{DD} , V _{SS} = V _{DD} /2 V _{IS} = V _{DD} or V _{EE} V _{OS} = V _{EE} or V _{DD}			
		XM					80									
	Any Channel OFF	XC					100									E̅ = V _{SS} = V _{DD} /2 V _{IS} = V _{DD} or V _{EE} V _{OS} = V _{EE} or V _{DD}
		XM					10									
I _{DD}	Quiescent Power	XC			20		40			80	μA	MIN, 25°C MAX	V _{SS} = V _{EE} All inputs at 0 V or V _{DD}			
					150		300			600						
	Supply Dissipation	XC			5		10			20		MIN, 25°C MAX				
		XM			150		300			600						

Notes are on the following page.

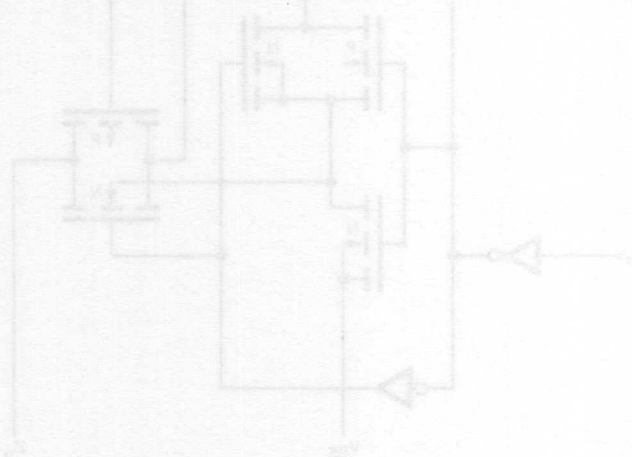
FAIRCHILD CMOS • 4053B

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{EE} = 0$ V, $T_A = 25^\circ$ C (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Input to Output		25			10			6		ns	C _L = 50 pF, R _L = 200 kΩ E̅ = V _{SS} = V _{EE} .
t _{PLH}	Propagation Delay, Select to Output		10			6			4		ns	S _n or V _{is} = V _{DD} or V _{EE} Note 5
t _{PZL}	Output Enable Time		185			95			75		ns	C _L = 50 pF, R _L = 1 kΩ E̅ or S _n = V _{SS} = V _{EE}
t _{PZH}	Output Disable Time		205			105			85		ns	V _{is} = V _{DD} or V _{EE} Note 5
t _{PLZ}	Output Disable Time		1250			1130			1080		ns	
t _{PHZ}	Output Disable Time		1240			1120			1070		ns	
	Distortion, Sine Wave Response		0.2			0.2			0.2		%	R _L = 10 kΩ V _{SS} = V _{DD} /2, E̅ = V _{EE} , V _{is} = V _{DD} /2 (sine wave) p-p f _{is} = 1 kHz
	Crosstalk Between Any Two Channels					1					MHz	R _L = 1 kΩ, E̅ = V _{EE} V _{is} = V _{DD} /2 (sine wave) p-p at -40 dB V _{SS} = V _{DD} /2, 20 Log ₁₀ (V _{os} /V _{is}) = -40 dB
	OFF State Feedthrough					1					MHz	R _L = 1 kΩ, V _{SS} = V _{DD} /2 E̅ = V _{DD} V _{is} = V _{DD} /2 (sine wave) p-p 20 Log ₁₀ (V _{os} /V _{is}) = -40 dB
f _{MAX}	ON State Frequency Response		13			40			70		MHz	R _L = 1 kΩ, E̅ = V _{SS} V _{is} = V _{DD} /2 (sine wave) p-p V _{SS} = V _{DD} /2 20 Log ₁₀ (V _{os} /V _{os} @ 1 kHz) = -3 dB

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. $\bar{E} = V_{SS}$, $R_L = 10$ k Ω , any channel selected and $V_{SS} = V_{EE}$ or $V_{DD}/2$.
3. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
4. V_{is}/V_{os} is the voltage signal at an Input/Output terminal (Y_n/Z_n).
5. $V_{IN} = V_{DD}$ (Square Wave), Input transition times ≤ 20 ns.
6. In certain applications, the current through the external load resistor (R_L) may include both V_{DD} and signal line components. To avoid drawing V_{DD} current when switch current flows into terminals 1, 2, 3, 5, 12, or 13 the voltage drop across the bidirectional switch must not exceed 0.5 V at $T_A \leq 25^\circ$ C, or 0.3 V at $T_A > 25^\circ$ C. No V_{DD} current will flow through R_L if the switch current flows into terminals 4, 14, or 15.



4066B

QUAD BILATERAL SWITCHES

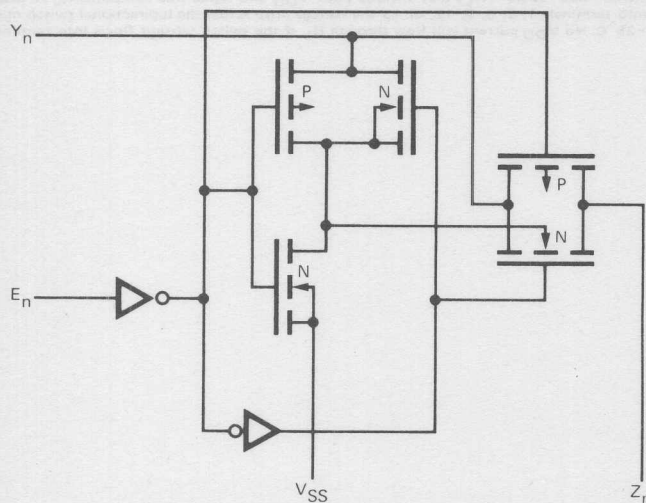
DESCRIPTION — The 4066B has four independent bilateral analog switches (transmission gates). Each switch has two Input/Output Terminals (Y_n , Z_n) and an active HIGH Enable Input (E_n). A HIGH on the Enable Input establishes a low impedance bidirectional path between Y_n and Z_n (ON condition). A LOW on the Enable Input disables the switch; high impedance between Y_n and Z_n (OFF condition).

- DIGITAL OR ANALOG SIGNAL SWITCHING
- INDIVIDUAL ENABLE INPUTS (ACTIVE HIGH)

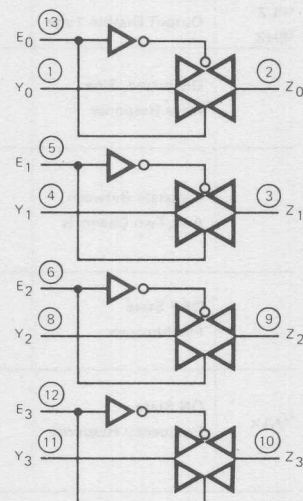
PIN NAMES

E_0 – E_3 Enable Inputs
 Y_0 – Y_3 Input/Output Terminals
 Z_0 – Z_3 Input/Output Terminals

LOGIC DIAGRAM (1/4 OF A 4066B)

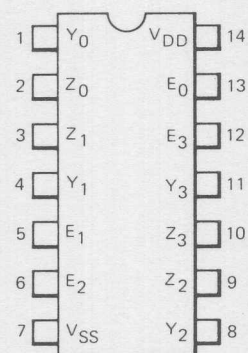


LOGIC SYMBOL



V_{DD} = Pin 14
 V_{SS} = Pin 7
 ○ = Pin Numbers

CONNECTION DIAGRAM
 DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
R _{ON}	ON Resistance	XC		190	900		100	450		80	250	Ω	MIN	E _n = V _{DD} R _L = 10 kΩ to V _{DD} /2 V _{is} = V _{DD} to V _{SS}
				270	1000		120	500		80	280		25° C	
				330	1090		170	520		130	300		MAX	
		XM		160	850		85	400		60	220	Ω	MIN.	
				270	1000		120	500		80	280		25° C	
				360	1150		190	550		145	320		MAX	
ΔR _{ON}	“Δ” ON Resistance Between Any Two Channels			25			10			5		Ω	25° C	E _n = V _{DD} R _L = 10 kΩ to V _{DD} /2 V _{is} = V _{DD} or V _{SS}
I _Z	OFF State Leakage Current	XC									±300	nA	MIN, 25° C	E _n = V _{SS} V _{is} = V _{DD} or V _{SS} V _{os} = V _{SS} or V _{DD}
											±1000		MAX	
		XM									±100		MIN, 25° C	
											±1000		MAX	
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25° C	All inputs at V _{DD} or V _{SS}
					7.5			15			30		MAX	
	Supply Dissipation	XM			0.25			0.5			1	μA	MIN, 25° C	
					7.5			15			30		MAX	

Notes on following page.

FAIRCHILD CMOS • 4066B

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Y _n to Z _n or Z _n to Y _n		8	45		3	30		2	20	ns	C _L = 50 pF, R _L = 200 Ω to V _{SS} Input Transition Times < 20 ns E _n = V _{DD} V _{is} = V _{DD} (square wave)
t _{PHL}			8	45		4	30		2	20		
t _{PZL}	Output Enable Time		32	125		16	60		13	50	ns	C _L = 50 pF, R _L = 1 kΩ to V _{SS} or V _{DD} E _n = V _{DD} (square wave)
t _{PZH}			32	125		16	60		13	50		E _n = V _{DD} (square wave) Input Transition Times < 20 ns V _{is} = V _{DD} or V _{SS}
t _{PLZ}	Output Disable Time		380			380			400		ns	
t _{PHZ}			380			380			400			
	Distortion, Sine Wave Response		0.4			0.4			0.4		%	R _L = 10 kΩ Input Frequency = 1 kHz E _n = V _{DD} V _{is} = V _{DD} /2 (sine wave) p-p
	Crosstalk Between Any Two Switches					0.9					MHz	R _L = 1 kΩ E _A = V _{DD} , E _B = V _{SS} V _{is} = V _{DD} /2 (sine wave) p-p 20 Log ₁₀ [V _{OS} (B)/V _{is} (A)] = -50 dB
	Crosstalk, Enable Input to Output					50					mV	Input Transition Times < 20 ns R _L (OUT) = 1 kΩ R _L (IN) = 50 Ω E _n = V _{DD} (square wave)
	OFF State Feedthrough					1.25					MHz	R _L = 1 kΩ, E _n = V _{SS} V _{is} = V _{DD} /2 (sine wave) p-p 20 Log ₁₀ (V _{OS} /V _{is}) = -50 dB
	ON State Frequency Response					40					MHz	R _L = 1 kΩ V _{is} = V _{DD} /2 (sine wave) p-p E _n = V _{DD} , 20 Log ₁₀ (V _{OS} /V _{OS} @ 1 kHz) = -3 dB
f _{MAX}	Enable Input Frequency (Note 4)					10					MHz	C _L = 50 pF, R _L = 1 kΩ Input Transition Times < 20 ns E _n = V _{DD} (square wave) V _{OS} = V _{is} /2 at DC V _{is} = V _{DD}
C _{is}	Input Switch Capacitance					4					pF	V _{DD} = 10 V E _n = V _{SS}
C _{os}	Output Switch Capacitance					4					pF	V _{is} = Open 100 kHz or
C _{ios}	Feedthrough Switch Capacitance					0.2					pF	1 MHz Bridge

NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- V_{is}/V_{OS} is the voltage signal at an Input/Output Terminal (Y_n/Z_n).
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
- For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
- In certain applications, the current through the external load resistor (R_L) may include both V_{DD} and signal line components. To avoid drawing V_{DD} current when switch current flows into terminals 1, 4, 8, or 11 the voltage drop across the bidirectional switch must not exceed 0.5 V at $T_A \leq 25^\circ\text{C}$, or 0.3 V at $T_A > 25^\circ\text{C}$. No V_{DD} current will flow through R_L if the switch current flows into terminals 2, 3, 9, or 10.

4067B

16-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

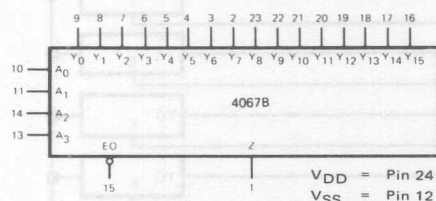
DESCRIPTION — The 4067B is a 16-Channel Analog Multiplexer/Demultiplexer with four Address Inputs (A_0 - A_3), 16 Independent Inputs/Outputs (Y_0 - Y_{15}), an active LOW Output Enable input (\overline{EO}), and a Common Input/Output (Z). The 4067B contains 16 bidirectional analog switches, each with one side connected to an Independent Input/Output (Y_0 - Y_{15}) and the other side connected to a Common Input/Output (Z). One of the 16 switches is selected (low impedance, ON state) by the four Address Inputs (A_0 - A_3) when the Output Enable input (\overline{EO}) is LOW. All unselected switches are in the high impedance OFF state. With the Output Enable input (\overline{EO}) HIGH, all 16 switches are in the high impedance OFF state. The Analog Input/Outputs (Y_0 - Y_{15} , Z) can swing between V_{DD} and V_{SS} . V_{DD} - V_{SS} may not exceed 15 V.

- ANALOG OR DIGITAL MULTIPLEXER/DEMULTIPLEXER
- 24-PIN PACKAGE
- SINGLE POWER SUPPLY

PIN NAMES

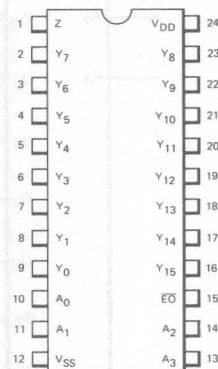
Y_0 - Y_{15} Independent Inputs/Outputs
 A_0 - A_3 Address Inputs
 Z Common Input/Output
 \overline{EO} Output Enable Input (Active LOW)

LOGIC SYMBOL



V_{DD} = Pin 24
 V_{SS} = Pin 12

CONNECTION DIAGRAM DIP (TOP VIEW)



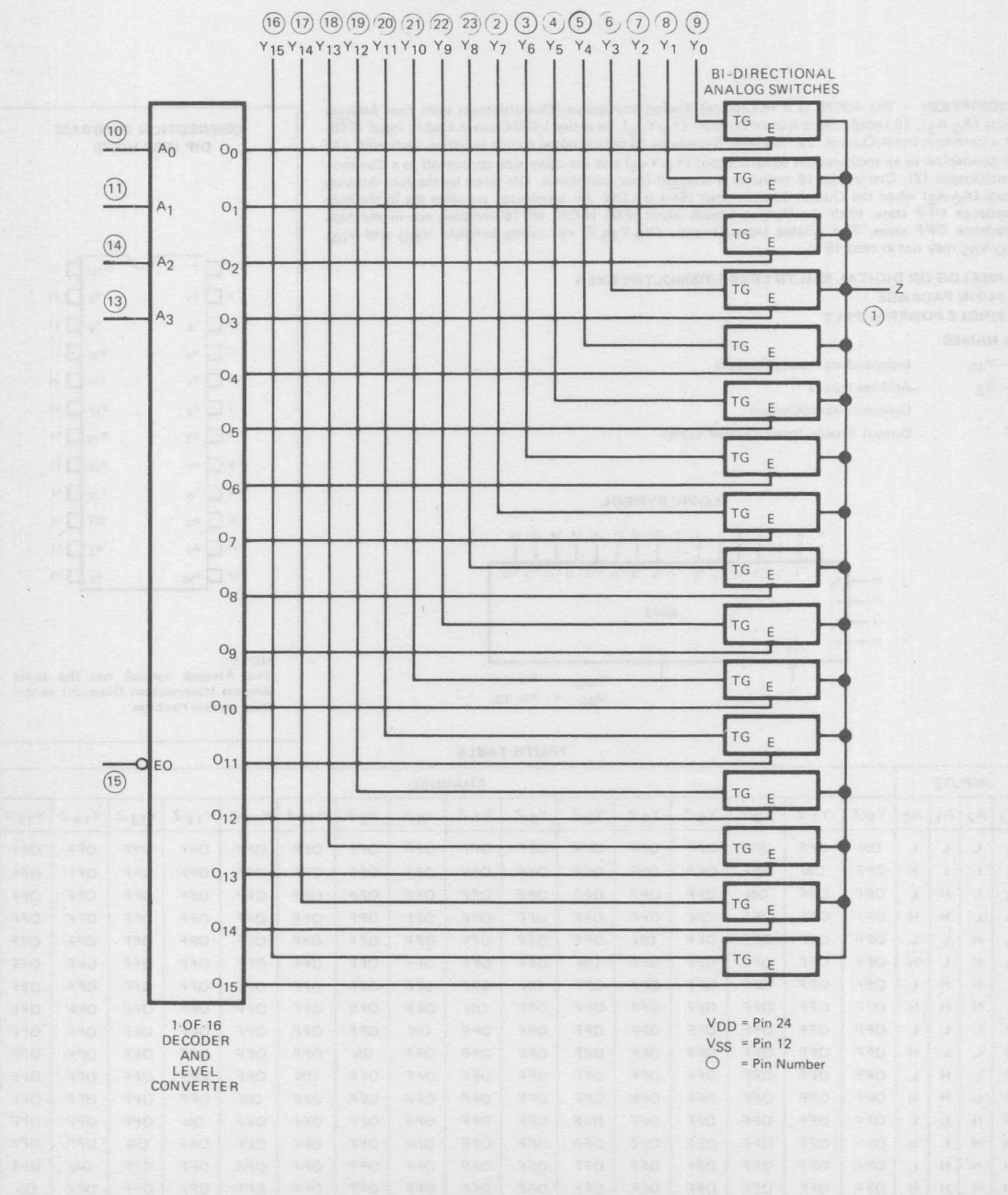
NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

TRUTH TABLE

INPUTS				CHANNEL															
A_3	A_2	A_1	A_0	Y_0 -Z	Y_1 -Z	Y_2 -Z	Y_3 -Z	Y_4 -Z	Y_5 -Z	Y_6 -Z	Y_7 -Z	Y_8 -Z	Y_9 -Z	Y_{10} -Z	Y_{11} -Z	Y_{12} -Z	Y_{13} -Z	Y_{14} -Z	Y_{15} -Z
L	L	L	L	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
L	L	L	H	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
L	L	H	L	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
L	L	H	H	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
L	H	L	L	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
L	H	L	H	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
L	H	H	L	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
L	H	H	H	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
H	L	L	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF
H	L	L	H	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF
H	L	H	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF
H	L	H	H	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF
H	H	L	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF
H	H	L	H	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF
H	H	H	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF
H	H	H	H	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON

L = LOW Level H = HIGH Level \overline{EO} = LOW Level

FUNCTIONAL LOGIC DIAGRAM



DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
R _{ON}	ON Resistance	XC		95	900		55	380		35	210	Ω	MIN	V _{is} = V _{DD} to V _{SS} Note 2
				100	1000		65	500		40	280		25° C	
				125	1100		100	600		65	340		MAX	
		XM		90	850		50	340		30	190	Ω	MIN	
				100	1000		65	500		40	280		25° C	
				150	1150		110	660		70	370		MAX	
ΔR _{ON}	“Δ” ON Resistance Between Any Two Channels			25			10			5		Ω	25° C	Note 2
I _Z	OFF State Leakage Current, All Channels OFF	XC						800				nA	25° C	$\overline{EO} = V_{DD}$ V _{is} = V _{DD} or V _{SS} V _{os} = V _{SS} or V _{DD} $\overline{EO} = V_{SS}$ V _{is} = V _{DD} or V _{SS} V _{os} = V _{SS} or V _{DD}
		XM						80						
	Any Channel OFF	XC						100						
		XM						10						
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25° C	All Inputs at 0 V or V _{DD}
				150			300			600	MAX			
	Supply Dissipation	XC			5			10			20	μA	MIN, 25° C	
		XM			150			300			600		MAX	

Notes on following page.

FAIRCHILD CMOS • 4067B

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Input to Output		25			10			6		ns	C _L = 50 pF, R _L = 200 kΩ E _O = V _{SS}
t _{PHL}	Propagation Delay, Address to Output		10			6			4		ns	A _n or V _{is} = V _{DD} or V _{SS} Note 5
t _{PZH}	Output Enable Time		185			95			75		ns	C _L = 50 pF, R _L @ 1 kΩ E _O or A _n = V _{SS}
t _{PLZ}	Output Disable Time		1250			1130			1080		ns	V _{is} = V _{DD} or V _{SS} Note 5
t _{PHZ}	Output Disable Time		1240			1120			1070		ns	
	Distortion, Sine Wave Response		0.2			0.2			0.2		%	R _L = 10 kΩ, E _O = V _{SS} V _{is} = V _{DD} /2 (sine wave) p-p f _{is} = 1 kHz
	Crosstalk Between Any Two Channels					1					MHz	R _L = 1 kΩ, E _O = V _{SS} V _{is} = V _{DD} /2 (sine wave) p-p at -40 dB 20 Log ₁₀ (V _{os} /V _{is}) = -40 dB
	OFF State Feedthrough					1					MHz	R _L = 1 kΩ, E _O = V _{DD} V _{is} = V _{DD} /2 (sine wave) p-p 20 Log ₁₀ (V _{os} /V _{is}) = -40 dB
f _{MAX}	ON State Frequency Response		13			40			70		MHz	R _L = 1 kΩ, E _O = V _{SS} V _{is} = V _{DD} /2 (sine wave) p-p 20 Log ₁₀ (V _{os} /V _{os} @ 1 kHz) = -3 dB

NOTES:

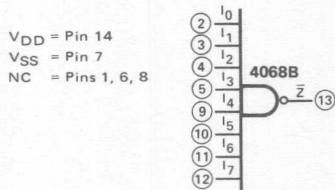
1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. $\overline{EO} = V_{SS}$, $R_L = 10$ k Ω , any channel selected.
3. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
4. V_{is}/V_{os} is the voltage signal at an Input/Output terminal (Y_n/Z_n).
5. $V_{IN} = V_{DD}$ (Square Wave), Input transition times ≤ 20 ns.
6. In certain applications, the current through the external load resistor (R_L) may include both V_{DD} and signal line components. To avoid drawing V_{DD} current when switch current flows into terminals 2, 3, 4, 5, 6, 7, 8, 9, 16, 17, 18, 19, 20, 21, 22, or 23 the voltage drop across the bidirectional switch must not exceed 0.5 V at $T_A \leq 25^\circ\text{C}$, or 0.3 V at $T_A > 25^\circ\text{C}$. No V_{DD} current will flow through R_L if the switch current flows into terminal 1.

4068B

8-INPUT NAND GATE

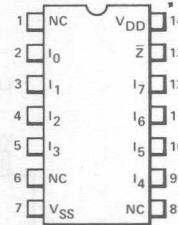
DESCRIPTION — This CMOS logic element provides the positive 8-Input NAND function. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

4068B LOGIC SYMBOL



PIN NAMES
I₀-I₇ NAND Gate Inputs
Z Output (Active LOW)

CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, V_{SS} = 0 V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					7.5			15			30			
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C MAX	
					7.5			15			30			

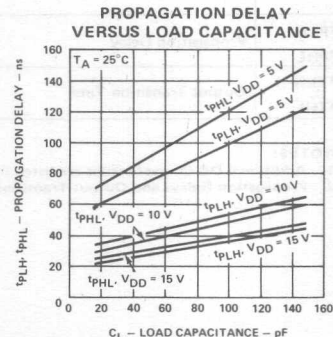
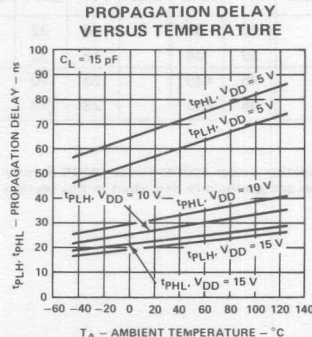
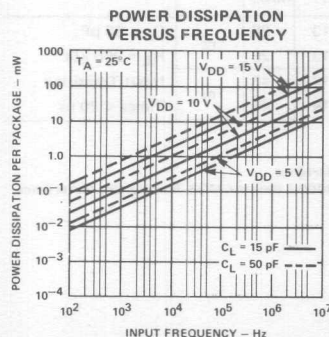
AC CHARACTERISTICS: V_{DD} as shown, V_{SS} = 0 V, T_A = 25°C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		82	200		40	85		29	68	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			88	200		40	85		28	68	ns	
t _{TLH}	Output Transition Time		64	135		32	70		24	45	ns	
t _{THL}			55	135		23	70		16	45		

NOTE:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS

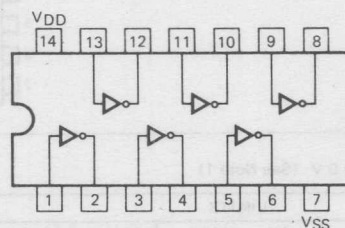


4069UB/74C04/54C04

HEX INVERTER

DESCRIPTION — The 4069UB is a general purpose Hex Inverter which has standard Fairchild input and output characteristics. A single-stage design has been used since the output impedance of a single-input gate is not pattern sensitive. The 4096UB is a Direct Replacement for the 74C04/54C04.

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

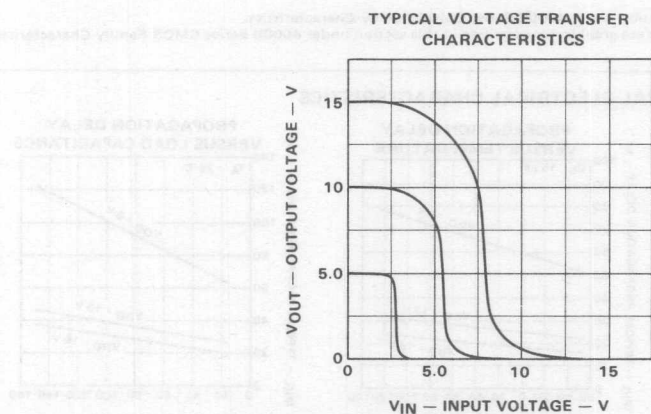
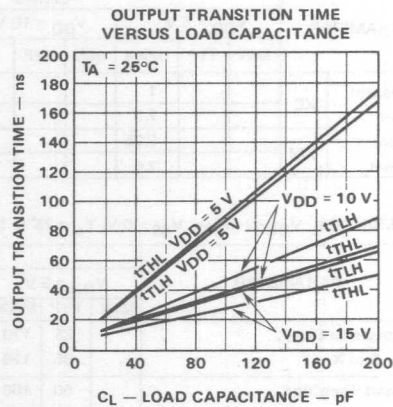
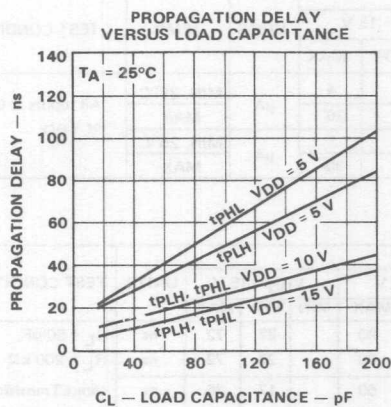
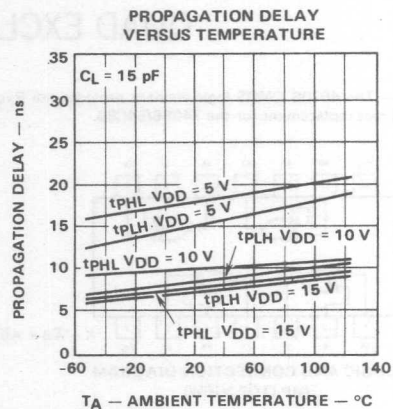
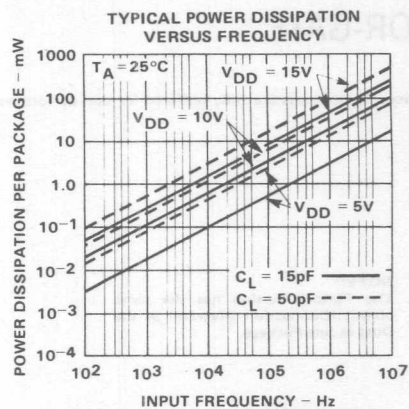
SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		32	64		16	32		13	26	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			32	64		16	32		13	26		
t _{TLH}	Output Transition Time		45	135		23	70		18	45	ns	Input Transition Times ≤ 20 ns
t _{THL}			45	135		23	70		18	45		

NOTES:

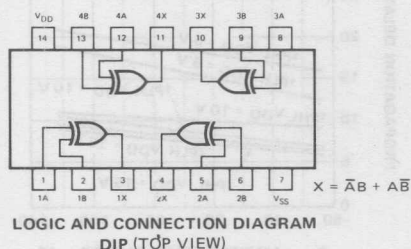
1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.



4070B/74C86/54C86

QUAD EXCLUSIVE-OR-GATE

DESCRIPTION — The 4070B CMOS logic element provides the Exclusive-OR function. The outputs are fully buffered for best performance. The 4070B is a direct replacement for the 74C86/54C86.



NOTE:
The Flatpak version has the same pinout (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

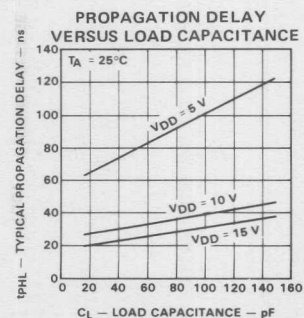
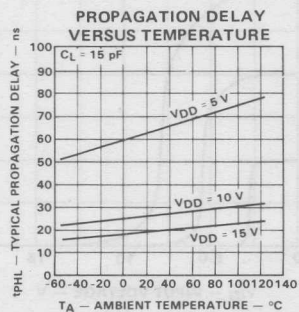
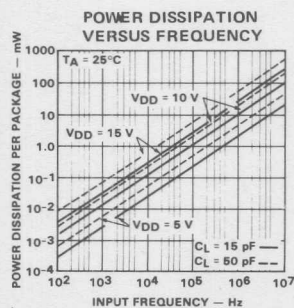
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, A or B to X		85	170		45	90		27	72	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			85	170		45	90		27	72	ns	
t _{TLH}	Output Transition Time		50	100		23	50		17	35	ns	Input Transition Times ≤ 20 ns
t _{THL}			50	100		23	50		17	35	ns	

NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS

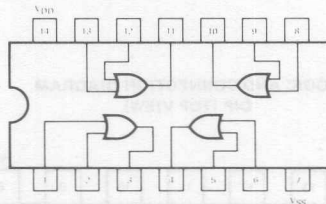


4071B

QUAD 2-INPUT OR GATE

DESCRIPTION — The 4071B is a positive logic Quad 2-Input OR Gate. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			$V_{DD} = 5\text{ V}$			$V_{DD} = 10\text{ V}$			$V_{DD} = 15\text{ V}$					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I_{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V_{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

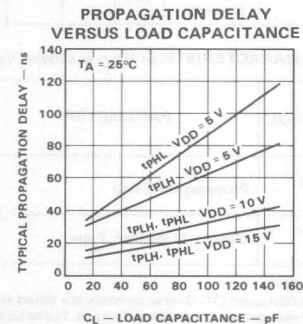
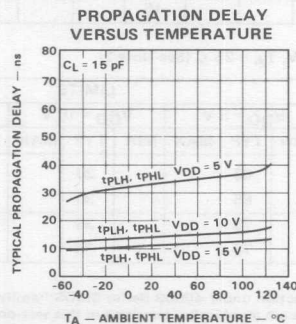
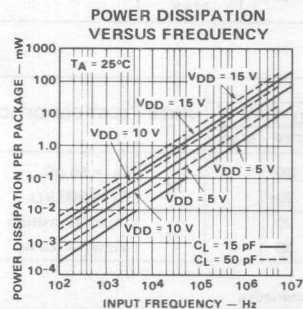
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		43	85		22	40		17	32	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			52	100		23	40		15	32	ns	
t _{TLH}	Output Transition Time		45	135		24	70		18	45	ns	Input Transition Times ≤ 20 ns
t _{THL}			54	135		21	70		15	45	ns	

NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS

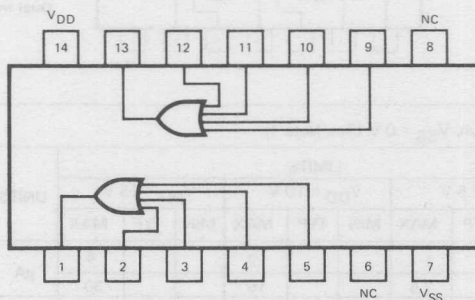


4072B

DUAL 4-INPUT OR GATE

DESCRIPTION — This CMOS logic element provides the positive Dual 4-Input OR function. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE: The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		65			30			20		ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			65			30			20			
t _{TLH}	Output Transition Time		70			35			30		ns	Input Transition Times ≤ 20 ns
t _{THL}			70			35			30			

NOTES:

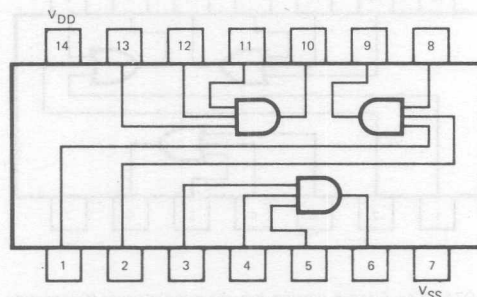
1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

4073B

TRIPLE 3-INPUT AND GATE

DESCRIPTION — This CMOS logic element provides the positive Triple 3-Input AND function. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE: The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		40	110		19	55		14	44	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			44	110		26	55		21	44		
t _{TLH}	Output Transition Time		70	135		35	75		25	45	ns	Input Transition Times ≤ 20 ns
t _{THL}			70	135		35	75		25	45		

NOTES:

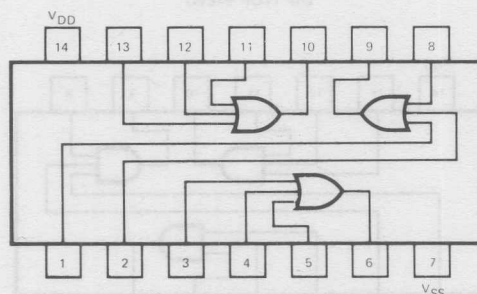
1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

4075B

TRIPLE 3-INPUT OR GATE

DESCRIPTION — This CMOS logic element provides the positive Triple 3-Input OR function. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE: The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		59	130		34	65		28	50	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			62	130		30	65		24	50		
t _{TLH}	Output Transition Time		70	135		35	75		25	35	ns	Input Transition Times ≤ 20 ns
t _{THL}			70	135		35	75		25	35		

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

4076B/74C173/54C173

QUAD D FLIP-FLOP WITH 3-STATE OUTPUTS

DESCRIPTION — The 4076B is a Quad Edge-Triggered D Flip-Flop with four Data Inputs (D_0 - D_3), two active LOW Data Enable Inputs (\overline{ED}_0 - \overline{ED}_1), an edge-triggered Clock Input (CP), four 3-State Outputs (Q_0 - Q_3), two active LOW Output Enable inputs (\overline{EO}_0 , \overline{EO}_1), and an overriding asynchronous Master Reset Input (MR).

Information on the Data Inputs (D_0 - D_3) is stored in the four flip-flops on the LOW-to-HIGH transition of the Clock Input (CP) if both Data Enable Inputs (\overline{ED}_0 - \overline{ED}_1) are LOW. A HIGH on either Data Enable Input (\overline{ED}_0 - \overline{ED}_1) prevents the flip-flops from changing on the LOW-to-HIGH transition of the Clock Input (CP), independent of the information on the Data Inputs (D_0 - D_3).

When both Output Enable inputs (\overline{EO}_0 - \overline{EO}_1) are LOW, the contents of the four flip-flops are available at the outputs (Q_0 - Q_3). A HIGH on either Output Enable input (\overline{EO}_0 , \overline{EO}_1) forces the outputs (Q_0 - Q_3) into the high impedance OFF state.

A HIGH on the overriding asynchronous Master Reset Input (MR) resets all four flip-flops, independent of all other input conditions.

The 4076B is a direct replacement for the 54C173/74C173.

- FULLY INDEPENDENT CLOCK
- 3-STATE OUTPUTS
- CLOCK IS L \rightarrow H EDGE-TRIGGERED
- ACTIVE LOW DATA ENABLE INPUTS
- ACTIVE LOW OUTPUT ENABLE INPUTS
- ASYNCHRONOUS MASTER RESET

PIN NAMES

D_0 - D_3	Data Inputs
\overline{ED}_0 - \overline{ED}_1	Data Enable Inputs (Active LOW)
\overline{EO}_0 , \overline{EO}_1	Output Enable Inputs (Active LOW)
CP	Clock Input (L \rightarrow H Edge-Triggered)
MR	Master Reset Input
Q_0 - Q_3	Data Outputs

TRUTH TABLE

INPUTS			OUTPUTS
\overline{ED}_0	\overline{ED}_1	D_n	Q_{n+1}
H	X	X	Q_n
X	H	X	Q_n
L	L	L	L
L	L	H	H

CONDITIONS:

MR = \overline{EO}_0 = \overline{EO}_1 = LOW

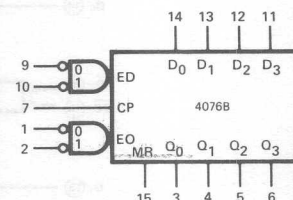
L = LOW Level

H = HIGH Level

X = Don't Care

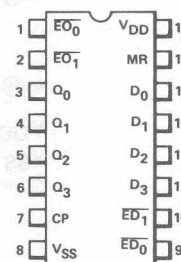
Q_{n+1} = State After Positive Clock Transition

LOGIC SYMBOL



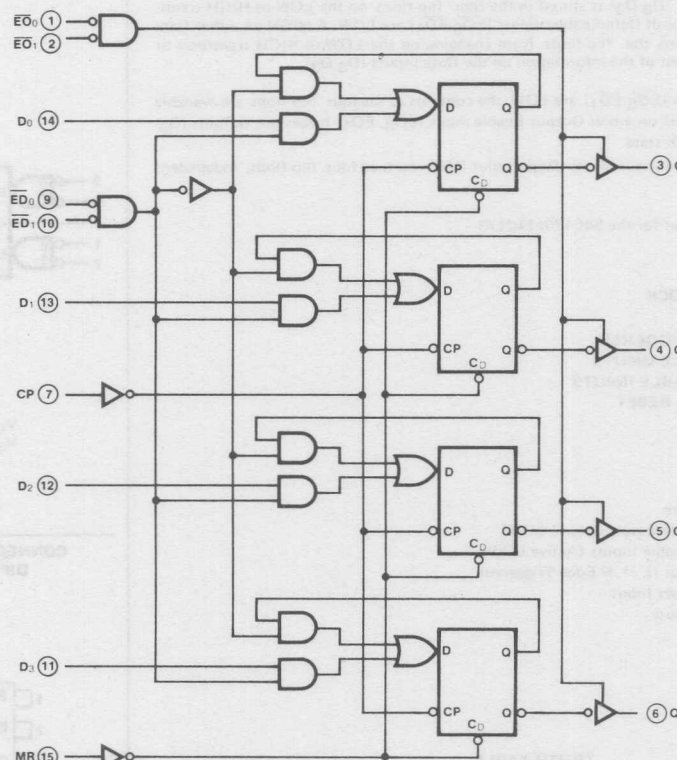
V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

QUAD D FLIP-FLOP WITH 3-STATE OUTPUTS



VDD = Pin 16
VSS = Pin 8
○ = Pin Number

INPUTS	Q	Q	Q	Q
D ₀	D ₁	D ₂	D ₃	
0	0	0	0	0
0	0	0	1	0
0	0	1	0	0
0	0	1	1	0
0	1	0	0	0
0	1	0	1	0
0	1	1	0	0
0	1	1	1	0
1	0	0	0	0
1	0	0	1	0
1	0	1	0	0
1	0	1	1	0
1	1	0	0	0
1	1	0	1	0
1	1	1	0	0
1	1	1	1	0

FAIRCHILD CMOS • 4076B/74C173/54C173

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF Current High	XC									1.6	μA	MIN, 25°C	Output returned to V _{DD} . EO ₁ = EO ₀ = V _{DD}
											12		MAX	
		XM									0.4		MIN, 25°C	
											12		MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6	μA	MIN, 25°C	Output returned to V _{SS} . EO ₁ = EO ₀ = V _{DD}
											-12		MAX	
		XM									-0.4		MIN, 25°C	
											-12		MAX	
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
				150			300			600	MAX			
	Supply Current	XC			5			10			10	μA	MIN, 25°C	
		XM			150			300			600		MAX	

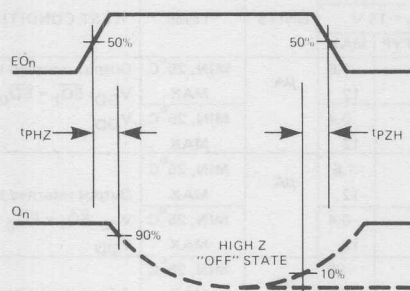
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ C$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to O _n		70			35			25		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns (R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD}) (R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PHL}	Propagation Delay MR to O _n		70			35			25		ns	
t _{PHL}	Propagation Delay MR to O _n		80			40			25		ns	
t _{PZH}	Output Enable		95			50			35		ns	
t _{PZL}	Time		95			50			35		ns	
t _{PHZ}	Output Disable		95			50			35		ns	
t _{PLZ}	Time		95			50			35		ns	
t _{TLH}	Output Transition		65			70			15		ns	
t _{THL}	Time		65			70			15		ns	
t _{wCP(L)}	Minimum Clock Pulse Width		25			10			8		ns	
t _{wMR(H)}	Minimum MR Pulse Width		35			20			15		ns	
t _{rec}	MR Recovery Time		6			5			2		ns	
t _s	Set-Up Time, D _n to CP		1			1			0		ns	
t _h	Hold-Time, D _n to CP		10			2			2		ns	
t _s	Set-Up Time, \overline{ED}_n to CP		50			20			15		ns	
t _h	Hold-Time, \overline{ED}_n to CP		2			1			1		ns	
f _{MAX}	Maximum Clock Frequency (Note 3)		9			16			19		MHz	

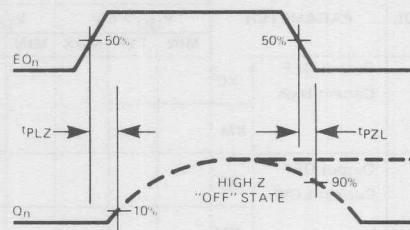
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μs at $V_{DD} = 5$ V, 4 μs at $V_{DD} = 20$ V, and 3 μs at $V_{DD} = 15$ V.

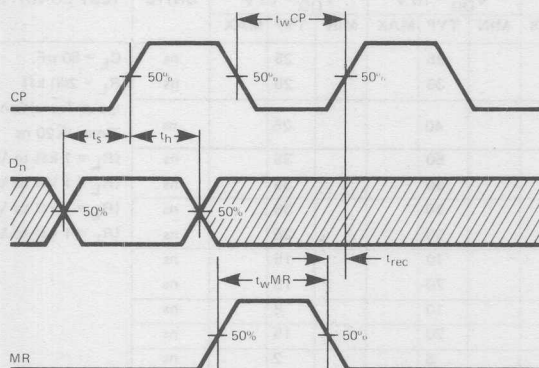
SWITCHING WAVEFORMS



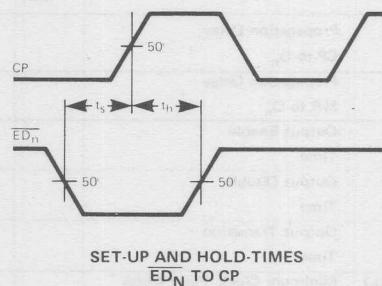
OUTPUT ENABLE TIME
(t_{PHZ}) AND OUTPUT DISABLE TIME (t_{PHZ})



OUTPUT ENABLE TIME
(t_{PLZ}) AND OUTPUT DISABLE TIME (t_{PLZ})



MINIMUM PULSE WIDTHS FOR CP AND MR ,
 MR RECOVERY TIME, AND SET-UP AND HOLD-TIMES, D_n TO CP



SET-UP AND HOLD-TIMES
 D_n TO CP

NOTE:

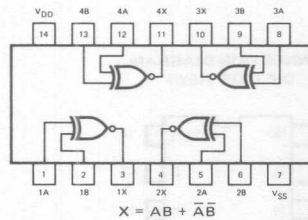
Set-up and Hold Times are shown as positive values but may be specified as negative values.

4077B

QUAD EXCLUSIVE-NOR GATE

DESCRIPTION — The 4077B CMOS logic element provides the Exclusive-NOR function. The outputs are fully buffered for best performance. The 4077B may be used interchangeably for the 4811.

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

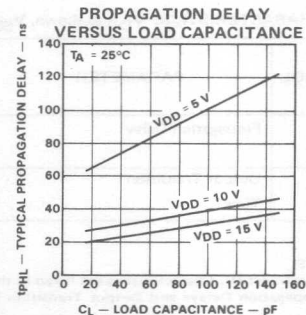
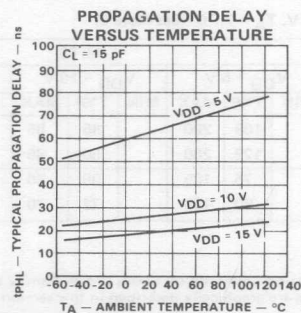
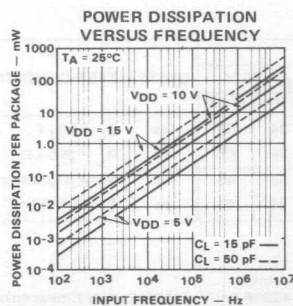
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		$V_{DD} = 5V$			$V_{DD} = 10V$			$V_{DD} = 15V$				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t_{PLH}	Propagation Delay, A or B to X		55	110		27	55		17	44	ns	$C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$
t_{PHL}			65	130		27	55		20	44	ns	
t_{TLH}	Output Transition Time		53	100		20	50		15	35	ns	Input Transition Times $\leq 20\text{ ns}$
t_{THL}			53	100		20	50		15	35	ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS

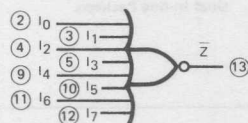


4078B

8-INPUT NOR GATE

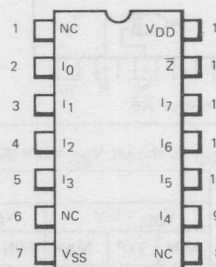
DESCRIPTION — This CMOS logic element provides the positive 8-Input NOR function. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

4078B LOGIC SYMBOL



V_{DD} = Pin 14
 V_{SS} = Pin 7
 NC = Pins 1, 6, 8

**CONNECTION DIAGRAM
DIP (TOP VIEW)**



PIN NAMES

I_0 – I_7 NOR Gate Inputs
 Z Output (Active LOW)

NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

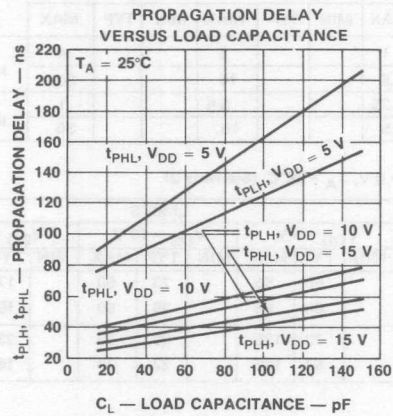
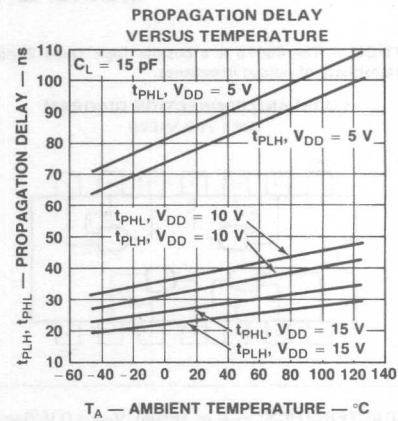
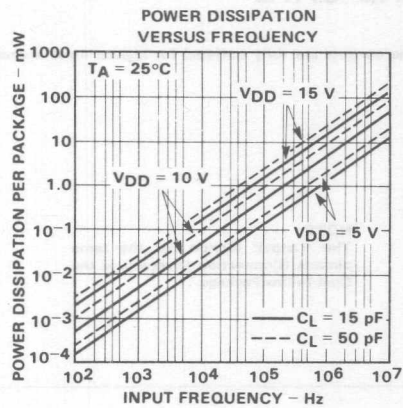
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		108	200		46	85		34	68	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			129	200		50	85		35	68	ns	
t _{TLH}	Output Transition Time		76	135		39	70		30	45	ns	Input Transition Times ≤ 20 ns
t _{THL}			80	135		32	70		24	45	ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS

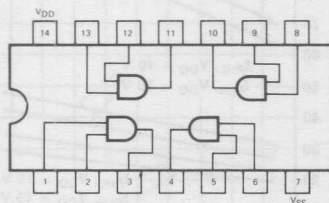


4081B

QUAD 2-INPUT AND GATE

DESCRIPTION — The 4081B is a positive logic Quad 2-Input AND Gate. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

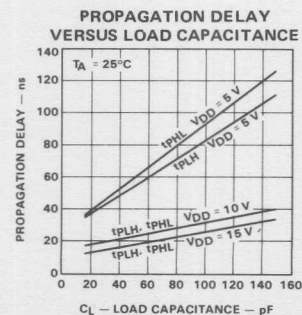
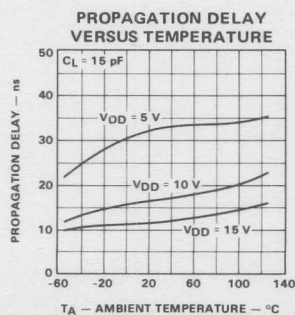
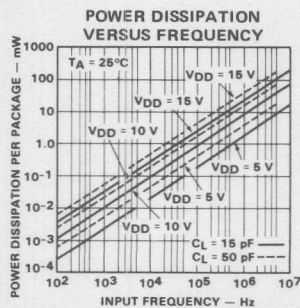
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		55	95		23	50		17	40	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			60	95		25	50		19	40	ns	
t _{TLH}	Output Transition		70	135		30	70		23	45	ns	Input Transition
t _{THL}	Time		57	135		23	70		16	45	ns	Times ≤ 20 ns

NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS

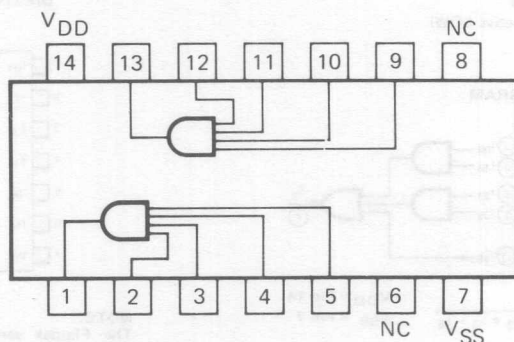


4082B

DUAL 4-INPUT AND GATE

DESCRIPTION — This CMOS logic element provides the positive Dual 4-Input AND function. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE: The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

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DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		45			25			20		ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			45			25			20			
t _{TLH}	Output Transition Time		45			20			15		ns	Input Transition Times ≤ 20 ns
t _{THL}			45			20			15			

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

4085B

DUAL 2-WIDE 2-INPUT AND-OR-INVERT GATE

DESCRIPTION — The 4085B is a Dual 2-Wide 2-Input AND-OR-Invert (AOI) Gate, each with an additional input (I_{4A} or I_{4B}) which can be used as either an Expander Input or an Inhibit Input by connecting it to any standard CMOS output. A HIGH on this Input (I_4) forces the Output (\bar{F}) LOW independent of the other four inputs (I_0 - I_3). The Outputs (\bar{F}_A and \bar{F}_B) are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

PIN NAMES

I_{0A} - I_{4A} , I_{0B} - I_{4B}
 \bar{F}_A , \bar{F}_B

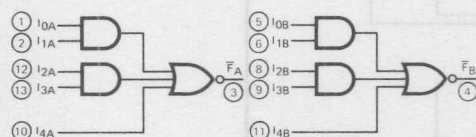
Gate Inputs

Outputs (Active LOW)

CONNECTION DIAGRAM

DIP (TOP VIEW)

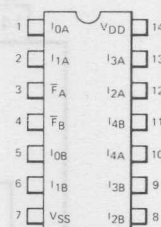
LOGIC DIAGRAM



$$\bar{F} = I_0 \cdot I_1 + I_2 \cdot I_3 + I_4$$

V_{DD} = Pin 14

V_{SS} = Pin 7



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

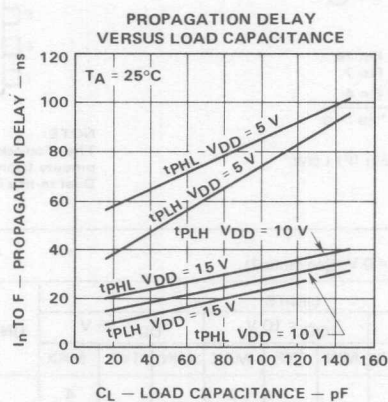
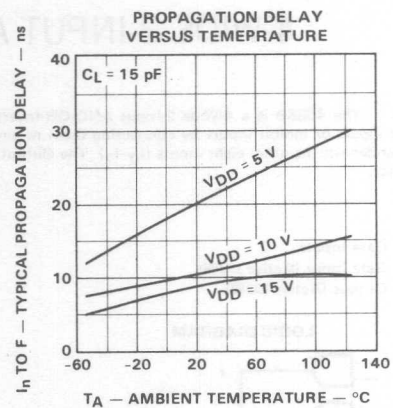
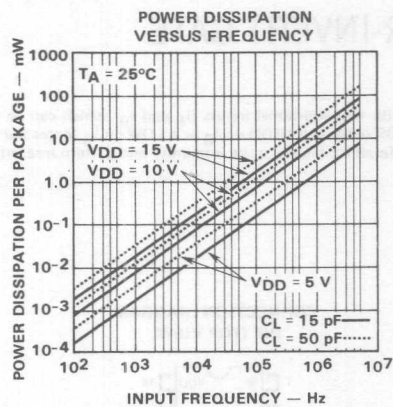
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Any 1 to \bar{F}		56	115		25	55		17	44	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			74	135		30	65		20	52	ns	
t _{TLH}	Output Transition		45	100		22	50		15	35	ns	Input Transition
t _{THL}	Time		45	100		22	50		15	35	ns	Times ≤ 20 ns

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS



4086B

DESCRIPTION — The 4086B is a 4-Wide 2-Input AND-OR-Invert (AOI) Gate with two additional inputs (I_8 and I_9) which can be used as either expander inputs or inhibit inputs by connecting them to any standard CMOS output. A HIGH on I_8 or a LOW on I_9 forces the Output (F) LOW independent of the other eight inputs (I_0 – I_7). The Output (F) is fully buffered for highest noise immunity and pattern insensitivity of output impedance.

10-18

10-18

19

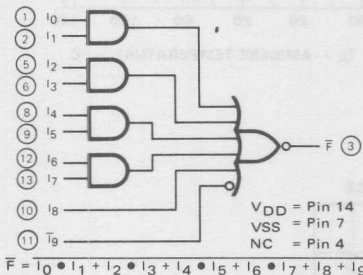
F.

Gate Inputs

Gate Input (Active LOW)

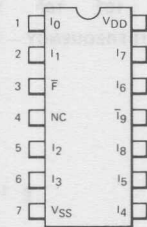
Output (Active LOW)

LOG'IC DIAGRAM



NOTE:
A HIGH on I_g or a LOW on \bar{I}_g forces the output (\bar{F}) LOW.

**CONNECTION DIAGRAM
DIP (TOP VIEW)**



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

[illegible]

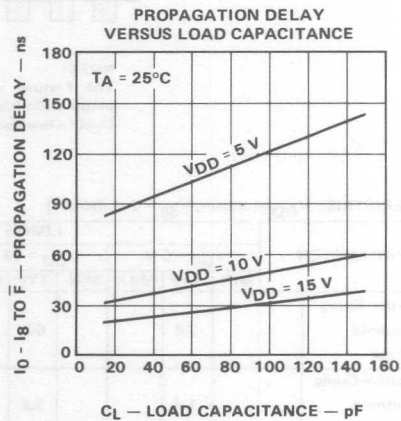
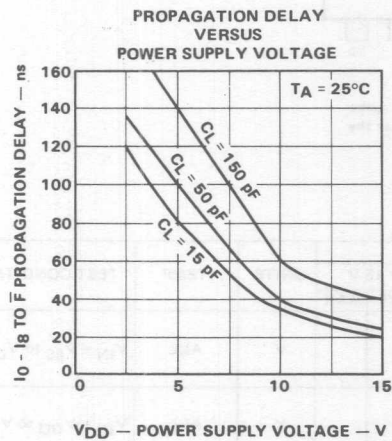
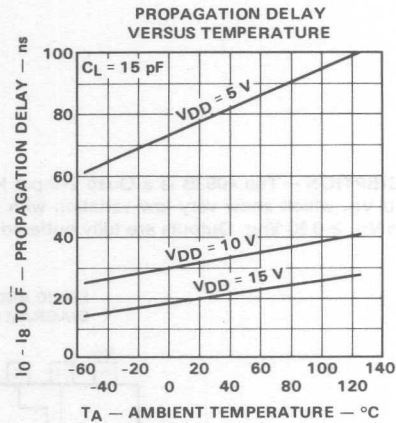
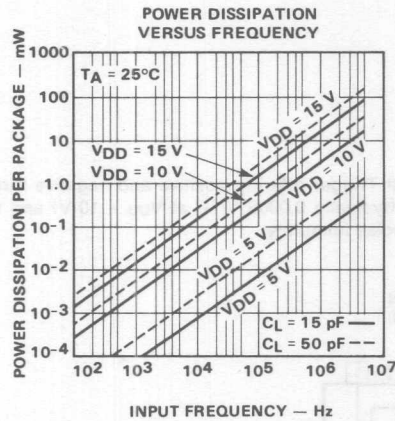
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, I _O through I ₈ to \bar{F}		100	180		40	80		25	64	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			100	180		40	80		25	64	ns	
t _{PLH}	Propagation Delay, \bar{I}_9 to \bar{F}		65	100		35	50		20	40	ns	
t _{PHL}			65	100		35	50		20	40	ns	
t _{TLH}	Output Transition Time		55	100		25	50		18	35	ns	
t _{THL}			55	100		25	50		18	35	ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS

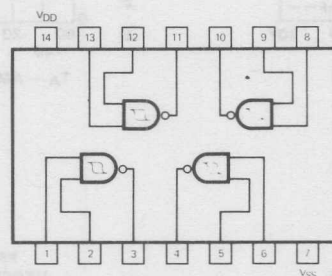


4093B

QUAD 2-INPUT NAND SCHMITT TRIGGER

GENERAL DESCRIPTION — The 4093B is a Quad 2-Input NAND Schmitt Trigger offering positive and negative threshold voltages, V_{T+} and V_{T-} which show very low variation with temperature (typically $0.0005 \text{ V/}^{\circ}\text{C}$ at $V_{DD} = 10 \text{ V}$) and typical hysteresis, V_{T+} to $V_{T-} \geq 0.33 V_{DD}$. Outputs are fully buffered for highest noise immunity.

**LOGIC AND CONNECTION
DIAGRAM DIP (TOP VIEW)**



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0 \text{ V}$ (Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
V _{T+}	Positive-Going Threshold Voltage			3.6			6.8			10		V	ALL	V _{IN} = V _{SS} to V _{DD}
V _{T-}	Negative-Going Threshold Voltage			1.4			3.2			5		V	ALL	V _{IN} = V _{DD} to V _{SS}
V _{T+} to V _{T-}	Hysteresis			2.2			3.6			5		V	ALL	Guaranteed Hysteresis = V _{T+} Minus V _{T-}
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All Inputs at OV or V _{DD}
					7.5			15			30		MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15			30		MAX	

NOTES:

1. Additional dc characteristics are listed in this section under Fairchild 4000B series CMOS family characteristics.

4104B

QUAD LOW VOLTAGE TO HIGH VOLTAGE TRANSLATER WITH 3-STATE OUTPUTS

DESCRIPTION — The 4104B Quad Low Voltage to High Voltage Translator with 3-State Outputs provides the capability of interfacing low voltage circuits to high voltage circuits, such as low voltage CMOS and TTL to high voltage CMOS. It has four Data Inputs (I_0 - I_3), an active HIGH Output Enable input (EO), four Data Outputs (Z_0 - Z_3) and their Complements (\bar{Z}_0 - \bar{Z}_3). With the Output Enable input HIGH, the Outputs (Z_0 - Z_3 , \bar{Z}_0 - \bar{Z}_3) are in the low impedance "ON" state, either HIGH or LOW as determined by the Data Inputs; with the Output Enable input LOW, the Outputs are in the high impedance "OFF" state. The voltage level on the Output Enable input may swing between V_{DDI} and V_{SS} .

The device uses a common negative supply (V_{SS}) and separate positive supplies for inputs (V_{DDI}) and outputs (V_{DDO}). V_{DDI} must always be less than or equal to V_{DDO} , even during power turn-on and turn-off. For the allowable operating range of V_{DDI} and V_{DDO} see Figure 1. Each input protection circuit is terminated between V_{DDO} and V_{SS} . This allows the input signals to be driven from any potential between V_{DDO} and V_{SS} , without regard to current limiting. When driving from potentials greater than V_{DDO} or less than V_{SS} , the current at each input must be limited to 10 mA.

When used in a bus organized system, all 4104B devices on the same bus line should be connected to the same V_{DDO} and V_{SS} supplies. Otherwise, parasitic diodes from the output to V_{DDO} and V_{SS} can become forward biased, even while the device is in the OFF state, causing catastrophic failure if the current is not limited to 10 mA.

- 3-STATE FULLY BUFFERED OUTPUTS
- OUTPUT ENABLE INPUT (ACTIVE HIGH)
- DUAL POWER SUPPLY

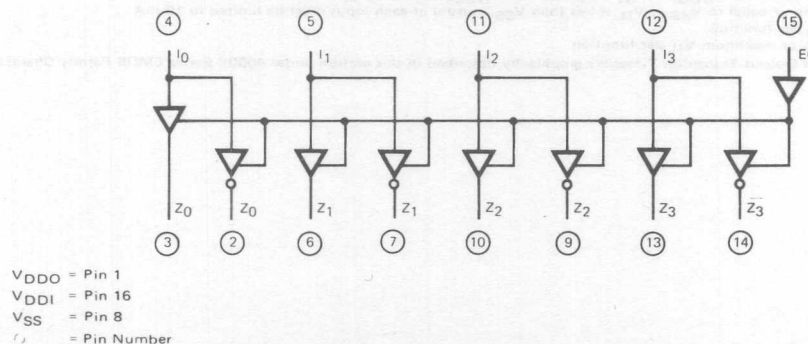
PIN NAMES	FUNCTION
I_0 - I_3	Data Inputs
EO	Output Enable Input
Z_0 - Z_3	Data Outputs
\bar{Z}_0 - \bar{Z}_3	Complimentary Data Outputs

**CONNECTION DIAGRAM
DIP (TOP VIEW)**



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC SYMBOL



FAIRCHILD CMOS • 4104B

DC CHARACTERISTICS: $V_{DDO} = V_{DDI}$ as shown, $V_{SS} = 0$ V

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DDO/I} = 5 V			V _{DDO/I} = 10 V			V _{DDO/I} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
V _{IH}	Input HIGH Voltage		3.5		Note 1	7		Note 1	11		Note 1	V	All	Guaranteed Input HIGH Voltage
V _{IL}	Input LOW Voltage		Note 2		1.5	Note 2		3	Note 2		4	V	All	Guaranteed Input LOW Voltage
V _{OH}	Output HIGH Voltage		4.95			9.95			14.95			V	MIN, 25°C	I _{OH} < 1 μA Note 3
			4.95			9.95			14.95				MAX	
			4.5			9.0			13.5				All	
V _{OL}	Output LOW Voltage				0.05			0.05			0.05	V	MIN, 25°C	I _{OL} < 1 μA Note 3
					0.05			0.05			0.05		MAX	
					0.5			1.0			1.5		All	
I _{IN}	Input Current	XC									0.3	μA	MIN, 25°C	Lead Under Test at 0 V or V _{DDO} . All Other Inputs Simultaneously at 0 V or V _{DDO}
											1.0		MAX	
		XM									0.1	μA	MIN, 25°C	
											1.0		MAX	
I _{OH}	Output HIGH Current		-1.5									mA	MIN, 25°C	V _{OUT} = 2.5 V for V _{DDO} = 5 V Note 3
			-1.0										MAX	
			-0.7			-1.4			-2.2				MIN, 25°C	
			-0.4			-0.8			-1.4				MAX	
I _{OL}	Output LOW Current		1.0			2.6			3.6			mA	MIN, 25°C	V _{OUT} = 0.4 V for V _{DDO} = 5 V V _{OUT} = 0.5 V for V _{DDO} = 10 V V _{OUT} = 0.5 V for V _{DDO} = 15 V Note 3
			0.8			2.0			3.6				MAX	
			0.4			1.2			2.0					
I _{OZH}	Output OFF Current HIGH	XC									1.6	μA	MIN, 25°C	Output Returned to V _{DDO} , EO = V _{SS}
											12		MAX	
		XM									0.4	μA	MIN, 25°C	
											12		MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6	μA	MIN, 25°C	Output Returned to V _{SS} , EO = V _{SS}
											-12		MAX	
		XM									-0.4	μA	MIN, 25°C	
											-12		MAX	
I _{DD}	Quiescent Power Supply Current	XC			20			40			80	μA	MIN, 25°C	All Inputs at 0 V or V _{DDI} = V _{DDO}
					150			300			600		MAX	
		XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

NOTES:

- V_{IH} must be less than or equal to V_{DDO} . If V_{IH} is greater than V_{DDO} , current at each input must be limited to 10 mA.
- V_{IL} must be greater than or equal to V_{SS} . If V_{IL} is less than V_{SS} , current at each input must be limited to 10 mA.
- Inputs at 0 V or V_{DDO} per function.
- Inputs at minimum V_{IH} or maximum V_{IL} per function.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

FAIRCHILD CMOS • 4104B

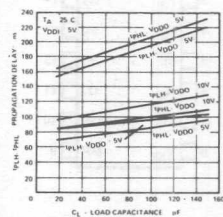
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $V_{DDI} = 5\text{ V}$, V_{DDO} as shown, $V_{SS} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (See Note 5)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DDO} = 5 V			V _{DDO} = 10 V			V _{DDO} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, I _n to Z _n or \bar{Z}_n		160	375		85	180		75	144	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			160	375		85	180		75	144		
t _{PZH}	Output Enable Time		200	450		80	110		70	88	ns	(R _L = 1 kΩ to V _{SS})
t _{PZL}			200	450		100	170		80	136		(R _L = 1 kΩ to V _{DDO})
t _{PHZ}	Output Disable Time		75	165		90	170		75	136	ns	(R _L = 1 kΩ to V _{SS})
t _{PLZ}			50	115		80	110		70	88		(R _L = 1 kΩ to V _{DDO})
t _{TLH}	Output Transition Time		60	135		30	70		25	45	ns	Input Transition
t _{THL}			60	135		30	70		25	45		Times < 20 ns

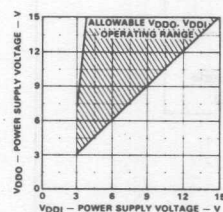
Notes on previous page.

Fig. 1 TYPICAL ELECTRICAL CHARACTERISTICS

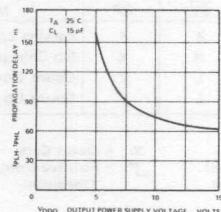
PROPAGATION DELAY
VERSUS C_L



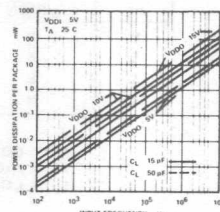
V_{DDO} VERSUS V_{DDI}



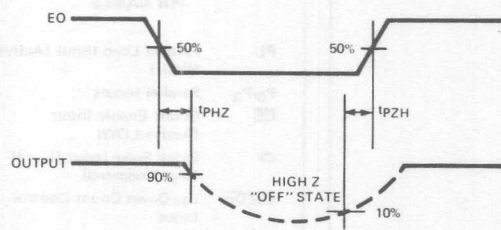
PROPAGATION DELAY
VERSUS V_{DDO}



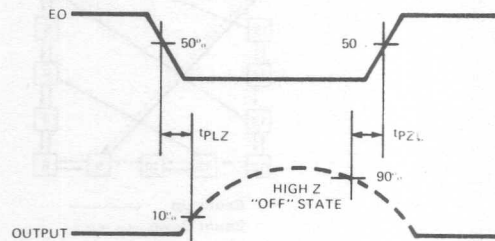
POWER DISSIPATION
VERSUS FREQUENCY



SWITCHING WAVEFORMS



OUTPUT ENABLE TIME
(t_{pZH}) AND OUTPUT DISABLE TIME (t_{pHZ})



OUTPUT ENABLE TIME
(t_{pZL}) AND OUTPUT DISABLE TIME (t_{pLZ})

4510B

UP/DOWN DECADE COUNTER

DESCRIPTION — The 4510B is an Edge-Triggered Synchronous Up/Down BCD Counter with a Clock Input (CP), an active HIGH Up/Down Count Control Input (Up/Dn), an active LOW Count Enable Input (CE), an asynchronous active HIGH Parallel Load Input (PL), four Parallel Inputs (P₀-P₃), four Parallel Outputs (Q₀-Q₃), an active LOW Terminal Count Output (TC) and an overriding asynchronous Master Reset Input (MR).

Information on the Parallel Inputs (P₀-P₃) is loaded into the counter while the Parallel Load Input (PL) is HIGH, independent of all other input conditions except the Master Reset Input (MR) which must be LOW. With the Parallel Load Input (PL) LOW, the counter changes on the LOW-to-HIGH transition of the Clock Input (CP) if the Count Enable Input (CE) is LOW. The Up/Down Count Control Input (Up/Dn) determines the direction of the count, HIGH for counting up, LOW for counting down. When counting up, the Terminal Count Output (TC) is LOW when the Parallel Outputs Q₀-Q₃ are HIGH and the Count Enable (CE) is LOW. When counting down, the Terminal Count Output (TC) is LOW when all the Parallel Outputs (Q₀-Q₃) and the Count Enable Input (CE) are LOW. A HIGH on the Master Reset Input resets the counter (Q₀-Q₃ = LOW) independent of all other input conditions.

- UP/DOWN COUNT CONTROL
- SINGLE CLOCK INPUT (L-H EDGE-TRIGGERED)
- ASYNCHRONOUS PARALLEL LOAD INPUT
- ASYNCHRONOUS MASTER RESET
- EASILY CASCADABLE

MODE SELECTION TABLE

PL	UP/DN	CE	CP	MODE
H	X	X	X	Parallel Load (P _n → Q _n)
L	X	H	X	No Change
L	L	L	↘	Count Down, Decade
L	H	L	↗	Count Up, Decade

MR = LOW

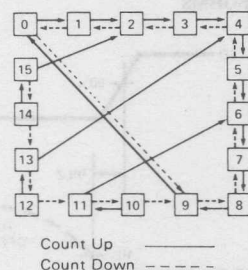
H = HIGH Level

L = LOW Level

X = Don't Care

↗ = Positive-Going Transition

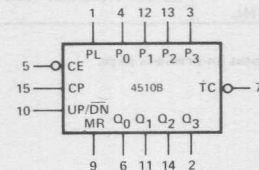
4510B STATE DIAGRAM



LOGIC EQUATION FOR TERMINAL COUNT

$$TC = CE \cdot [(UP \cdot Q_0 \cdot Q_3) + (\bar{UP} \cdot \bar{Q}_0 \cdot \bar{Q}_1 \cdot \bar{Q}_2 \cdot \bar{Q}_3)]$$

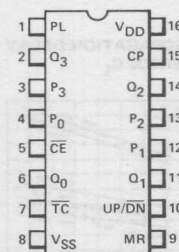
LOGIC SYMBOL



V_{DD} = Pin 16

V_{SS} = Pin 8

CONNECTION DIAGRAM
DIP (TOP VIEW)



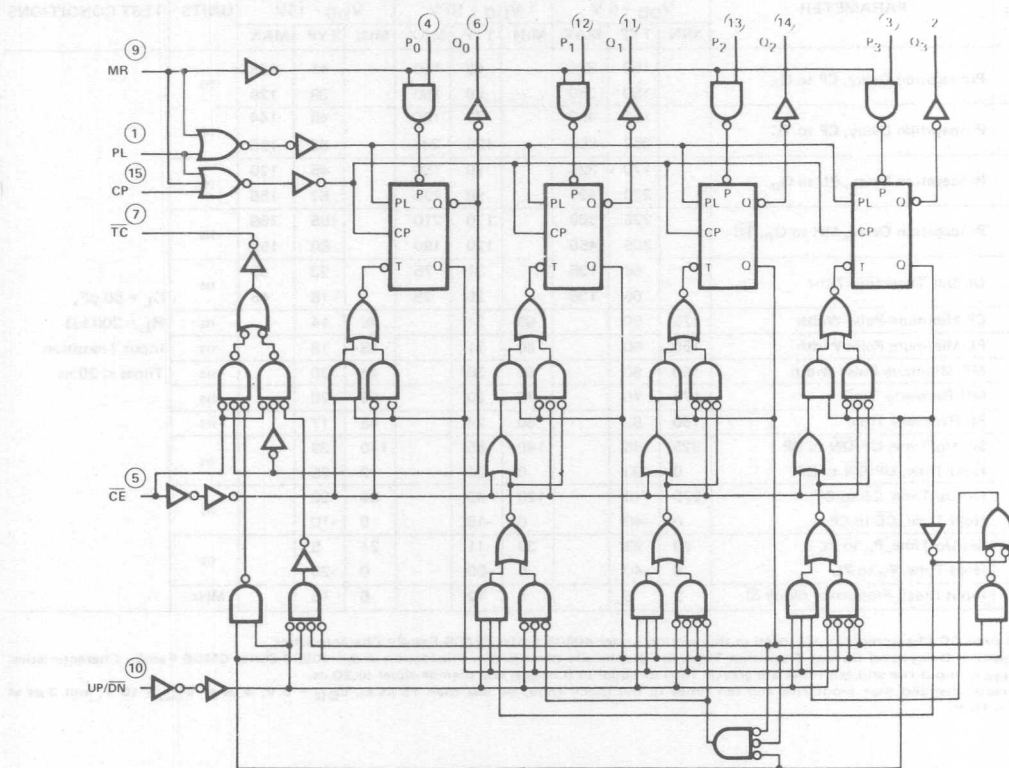
NOTE:

The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

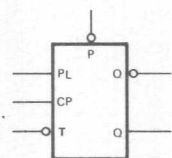
PIN NAMES

PL	Parallel Load Input (Active HIGH)
P ₀ -P ₃	Parallel Inputs
CE	Count Enable Input (Active LOW)
CP	Clock Pulse Input (L → H Edge-Triggered)
Up/Dn	Up/Down Count Control Input
MR	Master Reset Input
TC	Terminal Count Output (Active LOW)
Q ₀ -Q ₃	Parallel Outputs

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Number



PL (Parallel Load Input) — Asynchronously Loads P into Q, Overriding all Other Inputs
 P (Parallel Input) — Data on this Pin is Asynchronously Loaded into Q, when PL is HIGH Overriding all Other Inputs
 CP (Clock Pulse Input)
 Q, Q̄ (True and Complimentary Outputs)
 T (Toggle Input) — Forces the Q output to synchronously toggle when a HIGH is placed on this input.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

Notes on following page.

FAIRCHILD CMOS • 4510B

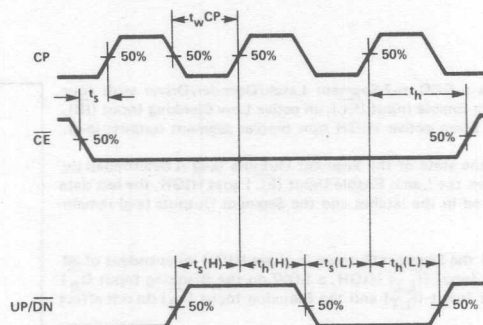
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q _n		150	350		62	160		41	128	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			150	350		59	160		39	128	ns	
t _{PLH}	Propagation Delay, CP to TC		167	450		71	180		48	144	ns	
t _{PHL}			252	650		100	245		66	196	ns	
t _{PLH}	Propagation Delay, PL to Q _n		170	325		70	150		45	120	ns	
t _{PHL}			220	425		90	195		62	156	ns	
t _{PLH}	Propagation Delay, MR to Q _n , TC		225	500		170	210		105	168	ns	
t _{PHL}			205	450		120	190		80	152	ns	
t _{TLH}	Output Transition Time		60	135		31	75		23	45	ns	
t _{THL}			65	135		25	75		18	45	ns	
t _{wCP}	CP Minimum Pulse Width	125	50		60	21		48	14		ns	
t _{wPL}	PL Minimum Pulse Width	150	60		60	21		48	16		ns	
t _{wMR}	MR Minimum Pulse Width	150	60		60	30		48	20		ns	
t _{rec}	MR Recovery Time	175	75		70	30		56	20		ns	
t _{rec}	PL Recovery Time	150	62		60	24		48	17		ns	
t _s	Set-Up Time, UP/DN to CP	325	145		140	55		110	38		ns	
t _h	Hold Time, UP/DN to CP	0	-90		0	-35		0	-25		ns	
t _s	Set-Up Time, CE to CP	275	118		120	49		96	33		ns	
t _h	Hold Time, CE to CP	0	-40		0	-15		0	-10		ns	
t _s	Set-Up Time, P _n to PL	70	29		30	11		24	8		ns	
t _h	Hold Time, P _n to PL	0	-40		0	-20		0	-20		ns	
f _{MAX}	Input Clock Frequency (Note 3)	2	5		5	12		6	15		MHz	

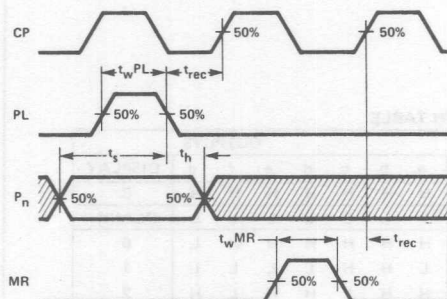
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

SWITCHING WAVEFORMS



MINIMUM CP WIDTH, SET-UP AND HOLD TIMES, \overline{CE} TO CP AND UP/DN TO CP



MINIMUM PL AND MR PULSE WIDTH, RECOVERY TIME FOR PL AND MR, AND SET-UP AND HOLD TIMES, P_n TO PL

NOTE:

Set-up and Hold Times are shown as positive values but may be specified as negative values.

4511B

BCD-TO-7 SEGMENT LATCH/DECODER/DRIVER

GENERAL DESCRIPTION — The 4511B is a BCD-to-7-Segment Latch/Decoder/Driver with four Address Inputs (A_0 - A_3), an active LOW Latch Enable Input (\overline{EL}), an active Low Blanking Input ($\overline{I_B}$), an active LOW Lamp Test Input ($\overline{I_{LT}}$) and seven active HIGH npn bipolar segment outputs (a-g).

When the Latch Enable Input (\overline{EL}) is LOW, the state of the Segment Outputs (a-g) is determined by the data on the Address Inputs (A_0 - A_3). When the Latch Enable Input (\overline{EL}) goes HIGH, the last data present at the Address Inputs (A_0 - A_3) is stored in the latches and the Segment Outputs (a-g) remain stable.

When the Lamp Test Input ($\overline{I_{LT}}$) is LOW, all the Segment Outputs (a-g) are HIGH independent of all other input conditions. With the Lamp Test Input ($\overline{I_{LT}}$) HIGH, a LOW on the Blanking Input ($\overline{I_B}$) forces all Outputs (a-g) LOW. The Lamp Test Input ($\overline{I_{LT}}$) and the Blanking Input ($\overline{I_B}$) do not affect the latch circuit.

- HIGH CURRENT SOURCING OUTPUTS (UP TO 25 mA)
- BLANKING INPUT (ACTIVE LOW)
- LAMP TEST INPUT (ACTIVE LOW)
- LAMP INTENSITY MODULATION CAPABILITY
- MULTIPLEXING CAPABILITY
- LOW POWER DISSIPATION

PIN NAMES

A_0 - A_3 Address (Data) Inputs
 \overline{EL} Latch Enable (Active LOW) Input
 $\overline{I_B}$ Blanking (Active LOW) Input
 $\overline{I_{LT}}$ Lamp Test (Active LOW) Input
a-g Segment Outputs

TRUTH TABLE

INPUTS							OUTPUTS							DISPLAY
\overline{EL}	$\overline{I_B}$	$\overline{I_{LT}}$	A_3	A_2	A_1	A_0	a	b	c	d	e	f	g	
X	X	L	X	X	X	X	H	H	H	H	H	H	H	8
X	L	H	X	X	X	X	L	L	L	L	L	L	L	BLANK
L	H	H	L	L	L	L	H	H	H	H	H	H	L	0
L	H	H	L	L	L	H	L	H	H	L	L	L	L	1
L	H	H	L	L	H	L	H	H	L	H	H	L	H	2
L	H	H	L	L	H	H	H	H	H	H	L	L	H	3
L	H	H	L	H	L	L	L	H	H	L	L	H	H	4
L	H	H	L	H	L	H	H	L	H	H	L	H	H	5
L	H	H	L	H	H	L	L	L	H	H	H	H	H	6
L	H	H	L	H	H	H	H	H	H	L	L	L	L	7
L	H	H	H	L	L	L	H	H	H	H	H	H	H	8
L	H	H	H	L	L	H	H	H	H	L	L	H	H	9
L	H	H	H	L	H	L	L	L	L	L	L	L	L	BLANK
L	H	H	H	L	H	H	L	L	L	L	L	L	L	BLANK
L	H	H	H	H	L	L	L	L	L	L	L	L	L	BLANK
L	H	H	H	H	H	L	L	L	L	L	L	L	L	BLANK
H	H	H	X	X	X	X								

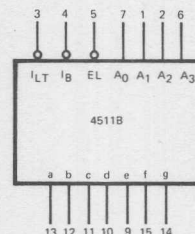
H = HIGH Level

L = LOW Level

X = Don't Care

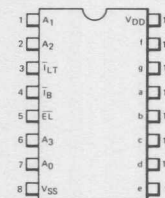
• = Depends upon the BCD code applied during the LOW-to-HIGH transition of \overline{EL}

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

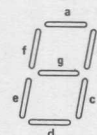
CONNECTION DIAGRAM DIP (TOP VIEW)



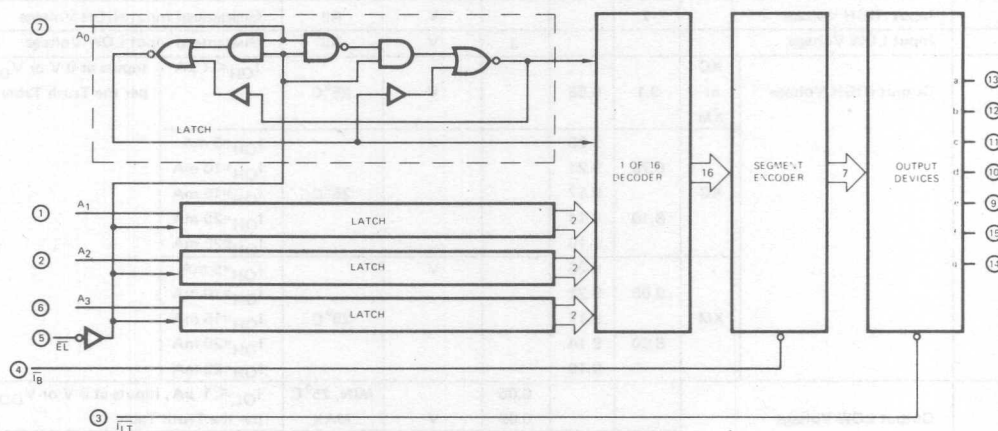
NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Packages.

NUMERICAL DESIGNATIONS



BLOCK DIAGRAM



V_{DD} = PIN 16
 V_{SS} = PIN 8
 ○ = PIN NUMBER

 DC CHARACTERISTICS: $V_{DD} = 5\text{ V}$, $V_{SS} = 0\text{ V}$ (Note 1)

SYMBOL	PARAMETER		LIMITS			UNITS	TEMP	TEST CONDITIONS		
			MIN	TYP	MAX					
V _{IH}	Input HIGH Voltage		3.5			V	All	Guaranteed Input HIGH Voltage		
V _{IL}	Input LOW Voltage				1.5	V	All	Guaranteed Input LOW Voltage		
V _{OH}	Output HIGH Voltage	XC or XM	4.1	4.57		V	25° C	I _{OH} < 1 μA	Inputs at 0 V or V _{DD} per the Truth Table	
	XC		4.24	V	25° C	I _{OH} = 5 mA				
		3.60	4.22			I _{OH} = 10 mA				
			4.16			I _{OH} = 15 mA				
		2.80	4.12			I _{OH} = 20 mA				
			4.05			I _{OH} = 25 mA				
	XM		4.24	V	25° C	I _{OH} = 5 mA				
		3.90	4.22			I _{OH} = 10 mA				
			4.16			I _{OH} = 15 mA				
		3.40	4.12			I _{OH} = 20 mA				
			4.05			I _{OH} = 25 mA				
	V _{OL}	Output LOW Voltage			0.05	V	MIN, 25° C	I _{OL} < 1 μA, Inputs at 0 V or V _{DD} per the Truth Table		
					0.05		MAX			
						0.5	V	All		I _{OL} < 1 μA, Inputs at 1.5 or 3.5 V
I _{OL}	Output LOW Current		1		mA	MIN	V _{OUT} = 0.4 V	Inputs at 0 V or V _{DD} per the Truth Table		
			0.8			25° C				
			0.4			MAX				
I _{DD}	Quiescent Power Supply Current	XC			20	μA	MIN, 25° C	All Inputs at 0 V or V _{DD} and all Outputs Open		
					150		MAX			
		XM			5		MIN, 25° C			
					150		MAX			

FAIRCHILD CMOS • 4511B

DC CHARACTERISTICS: $V_{DD} = 10\text{ V}$, $V_{SS} = 0\text{ V}$ (Note 1)

SYMBOL	PARAMETER		LIMITS			UNITS	TEMP	TEST CONDITIONS	
			MIN	TYP	MAX				
V _{IH}	Input HIGH Voltage		7			V	All	Guaranteed Input HIGH Voltage	
V _{IL}	Input LOW Voltage				3	V	All	Guaranteed Input LOW Voltage	
V _{OH}	Output HIGH Voltage	XC or XM	9.1	9.58		V	25°C	I _{OH} < 1 μA	Inputs at 0 V or V _{DD} per the Truth Table
						V			
		XC	8.75	9.26 9.21			25°C	I _{OH} = 5 mA I _{OH} = 10 mA I _{OH} = 15 mA	
			8.10	9.14 9.10				I _{OH} = 20 mA I _{OH} = 25 mA	
			XM	9.00	9.26 9.21		V	25°C	
		8.60		9.14 9.10				I _{OH} = 20 mA I _{OH} = 25 mA	
V _{OL}	Output LOW Voltage			0.05		MIN, 25°C	I _{OL} < 1 μA, Inputs at 0 V or V _{DD} per the Truth Table		
				0.05	V	MAX			
				1	V	All		I _{OL} < 1 μA, Inputs at 3 or 7 V	
I _{OL}	Output LOW Current		2.6 2 1.2			mA	MIN 25°C MAX	V _{OUT} = 0.5 V	Inputs at 0 V or V _{DD} per the Truth Table
I _{DD}	Quiescent Power Supply Current	XC		40	μA	MIN, 25°C	All Inputs at 0 V or V _{DD} and all Outputs Open		
				300		MAX			
		XM		10		MIN, 25°C			
				300		MAX			

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DC CHARACTERISTICS: $V_{DD} = 15\text{ V}$, $V_{SS} = 0\text{ V}$ (Note 1)

SYMBOL	PARAMETER		LIMITS			UNITS	TEMP	TEST CONDITIONS		
			MIN	TYP	MAX					
V _{IH}	Input HIGH Voltage		11			V	All	Guaranteed Input HIGH Voltage		
V _{IL}	Input LOW Voltage				4	V	All	Guaranteed Input LOW Voltage		
V _{OH}	Output HIGH Voltage	XC or XM	14.10	14.59		V	25° C	I _{OH} < 1 μA	Inputs at 0 V or V _{DD} per the Truth Table	
					14.27			25° C		I _{OH} =5 mA
		XC	13.75	14.23	I _{OH} =10 mA					
			14.20		I _{OH} =15 mA					
			13.10	14.17	I _{OH} =20 mA					
			14.13		I _{OH} =25 mA					
			XM	14.27			25° C	I _{OH} =5 mA		
		14.00		14.23	I _{OH} =10 mA					
		14.20			I _{OH} =15 mA					
		13.60		14.17	I _{OH} =20 mA					
		14.13			I _{OH} =25 mA					
V _{OL}	Output LOW Voltage				0.05	V	MIN, 25° C	I _{OL} < 1 μA, Inputs at 0 V or V _{DD} per the Logic Function or Truth Table		
					0.05		MAX			
I _{IN}	Input Current	XC			1	μA	All	Lead under test at 0 V or V _{DD} All other Inputs simultaneously at 0 V or V _{DD}		
		XM			1					
I _{OL}	Output LOW Current		7.5			mA	MIN, 25° C	V _{OUT} = 1.5 V	Inputs at 0 V or V _{DD} per the Truth Table	
			4.5				MAX			
I _{DD}	Quiescent Power Supply Current	XC			80	μA	MIN, 25° C	All Inputs at 0 V or V _{DD} and all Outputs Open		
					600		MAX			
		XM			20		MIN, 25° C			
					600		MAX			

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (see Note 2)

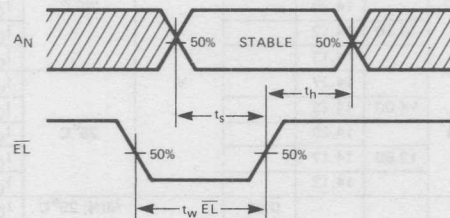
SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, A _N to a-g		212	480		90	190		68	152	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤20 ns
t _{PHL}	Propagation Delay, A _N to a-g		238	480		88	190		60	152	ns	
t _{PLH}	Propagation Delay, L _T to a-g		82	180		38	80		30	64	ns	
t _{PHL}	Propagation Delay, L _T to a-g		85	180		34	80		24	64	ns	
t _{PLH}	Propagation Delay, B to a-g		147	330		60	135		42	108	ns	
t _{PHL}	Propagation Delay, B to a-g		164	330		65	135		46	108	ns	
t _{PLH}	Propagation Delay, E _L to a-g		230	550		90	210		63	168	ns	
t _{PHL}	Propagation Delay, E _L to a-g		275	550		98	210		66	168	ns	
t _{TLH}	Output Transition Time		25	55		18	40		16	40	ns	
t _{THL}	Output Transition Time		75	135		26	75		17	45	ns	
t _{wEL}	EL Minimum Pulse Width	85	34		35	14		28	10		ns	
t _s	Set-Up Time, A _N to E _L	55	20		25	7		20	4		ns	
t _h	Hold-Time, A _N to E _L	55	19		25	6		20	4		ns	

NOTES:

1. Additional dc characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

AC WAVEFORMS

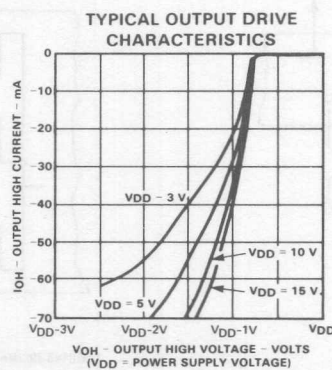
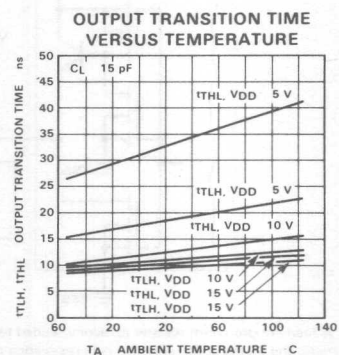
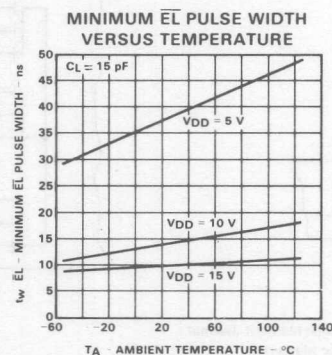
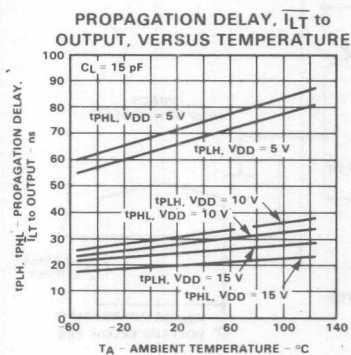
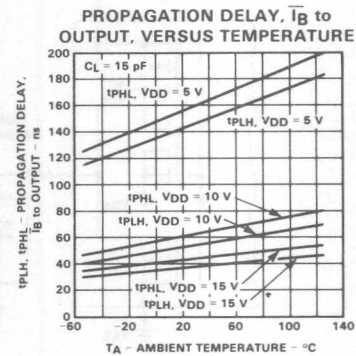
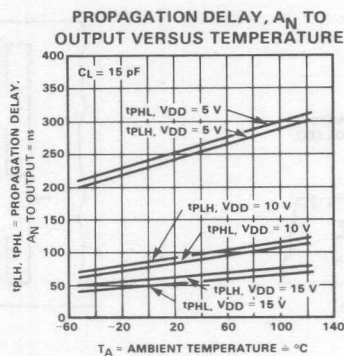
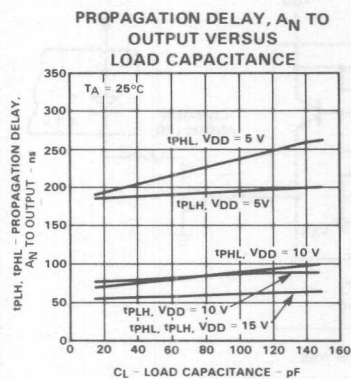
SET-UP AND HOLD-TIMES, A_N TO $\bar{E}L$ AND MINIMUM $\bar{E}L$ PULSE WIDTH



NOTE: Set-up and hold-times are shown as positive values but may be specified as negative values

SYMBOL	PARAMETER	LIMITS				TEST CONDITIONS
		V _{CC} = 10 V				
		V _{OL} = 10 V		V _{OH} = 10 V		
		MIN	MAX	MIN	MAX	
t _{PLH}	Propagation Delay, A _N to $\bar{E}L$	215	450	70	400	V _{CC} = 10 V f = 100 kHz
t _{PLH}	Propagation Delay, $\bar{E}L$ to A _N	120	480	25	190	
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	65	160	35	50	
t _{PLH}	Propagation Delay, A _N to $\bar{E}L$	35	100	34	50	
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	175	300	80	120	V _{CC} = 10 V f = 100 kHz
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	124	230	55	100	
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	230	350	80	210	
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	220	350	50	210	
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	25	50	15	40	V _{CC} = 10 V f = 100 kHz
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	25	50	15	40	
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	25	50	15	40	
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	25	50	15	40	
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	25	50	15	40	V _{CC} = 10 V f = 100 kHz
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	25	50	15	40	
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	25	50	15	40	
t _{PLH}	Propagation Delay, $\bar{E}L$ to $\bar{E}L$	25	50	15	40	

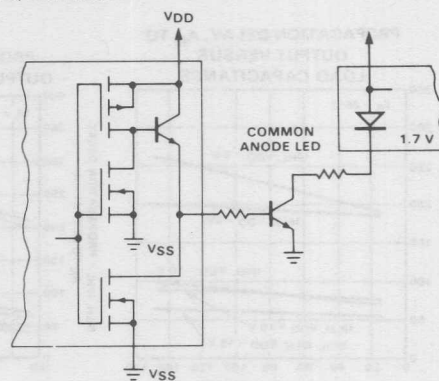
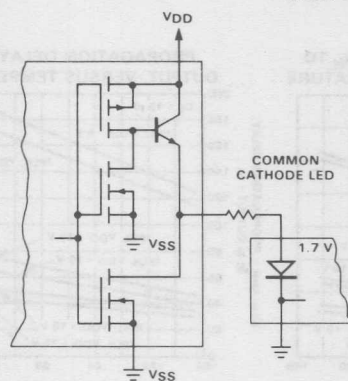
TYPICAL ELECTRICAL CHARACTERISTICS



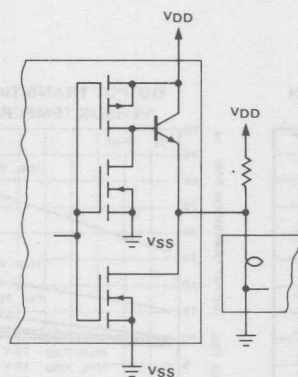
FAIRCHILD CMOS • 4511B

TYPICAL APPLICATIONS

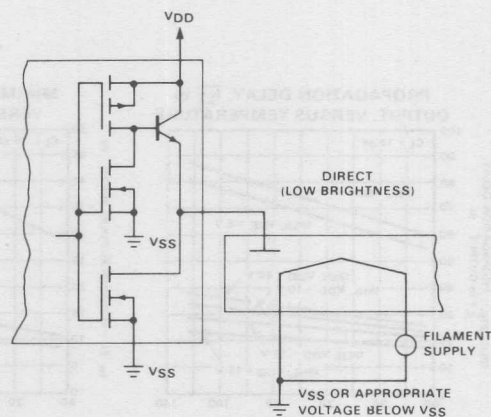
LIGHT EMITTING DIODE (LED) READOUT



INCANDESCENT READOUT

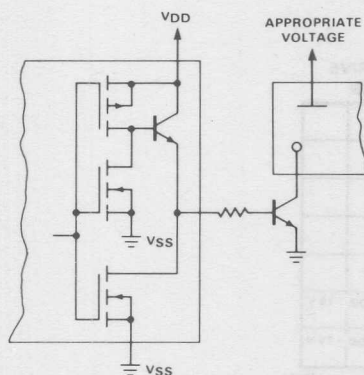


FLUORESCENT READOUT

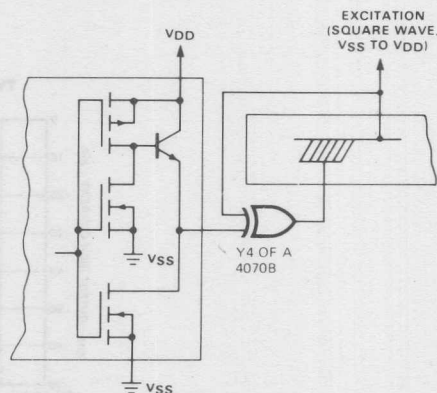


*A filament pre-warm resistor is recommended to reduce filament thermal shock and increase the effective cold resistance of the filament

GAS DISCHARGE READOUT



LIQUID CRYSTAL (LCD) READOUT**



**Direct dc drive of LCD not recommended for life of LCD readouts.

4512B

8-INPUT MULTIPLEXER WITH 3-STATE OUTPUTS

DESCRIPTION — The 4512B is an 8-Input Multiplexer with Active LOW logic and output enables (\bar{E} , \bar{EO}). One of eight binary inputs is selected by Select Inputs S_0 , S_1 and S_2 and is routed to the output F. A HIGH on the Output Enable (\bar{EO}) causes the F output to assume a high impedance or "OFF" state, regardless of other input conditions. This allows the output to interface directly with bus oriented systems (3-state). When the active LOW Enable (\bar{E}) is HIGH, it forces the output LOW provided the Output Enable (\bar{EO}) is LOW. By proper manipulation of the inputs, the 4512B can provide any logic functions of four variables. The 4512B cannot be used to multiplex analog signals.

- SELECTS ONE-OF-EIGHT DATA SOURCES
- PERFORMS PARALLEL-TO-SERIAL CONVERSION
- 3-STATE OUTPUTS WITH ACTIVE LOW OUTPUT ENABLE
- ACTIVE LOW LOGIC ENABLE

PIN NAMES

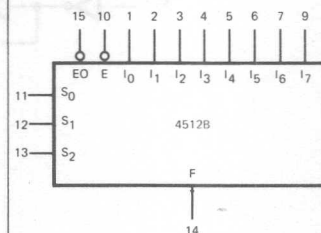
S_0, S_1, S_2	Select Inputs
\bar{EO}	Output Enable (Active LOW)
\bar{E}	Enable (Active LOW)
I_0 to I_7	Multiplexer Inputs
F	Multiplexer Output

TRUTH TABLE

INPUTS													OUTPUT
\bar{EO}	\bar{E}	S_2	S_1	S_0	I_0	I_1	I_2	I_3	I_4	I_5	I_6	I_7	F
L	H	X	X	X	X	X	X	X	X	X	X	X	L
L	L	L	L	L	L	X	X	X	X	X	X	X	L
L	L	L	L	L	H	X	X	X	X	X	X	X	H
L	L	L	L	H	X	L	X	X	X	X	X	X	L
L	L	L	L	H	X	H	X	X	X	X	X	X	H
L	L	L	H	L	X	X	L	X	X	X	X	X	L
L	L	L	H	L	X	X	H	X	X	X	X	X	H
L	L	L	H	H	X	X	X	L	X	X	X	X	L
L	L	L	H	H	X	X	X	H	X	X	X	X	H
L	L	L	H	H	X	X	X	X	L	X	X	X	L
L	L	H	L	L	X	X	X	X	H	X	X	X	H
L	L	H	L	L	X	X	X	X	X	L	X	X	L
L	L	H	L	H	X	X	X	X	X	H	X	X	H
L	L	H	L	H	X	X	X	X	X	X	L	X	L
L	L	H	H	L	X	X	X	X	X	X	H	X	H
L	L	H	H	H	X	X	X	X	X	X	X	L	L
L	L	H	H	H	X	X	X	X	X	X	X	H	H
H	X	X	X	X	X	X	X	X	X	X	X	X	Z

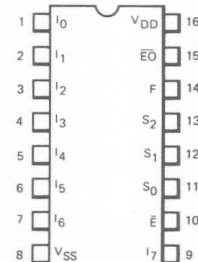
L = LOW Level
H = HIGH Level
X = Don't Care
Z = High Impedance State

LOGIC SYMBOL



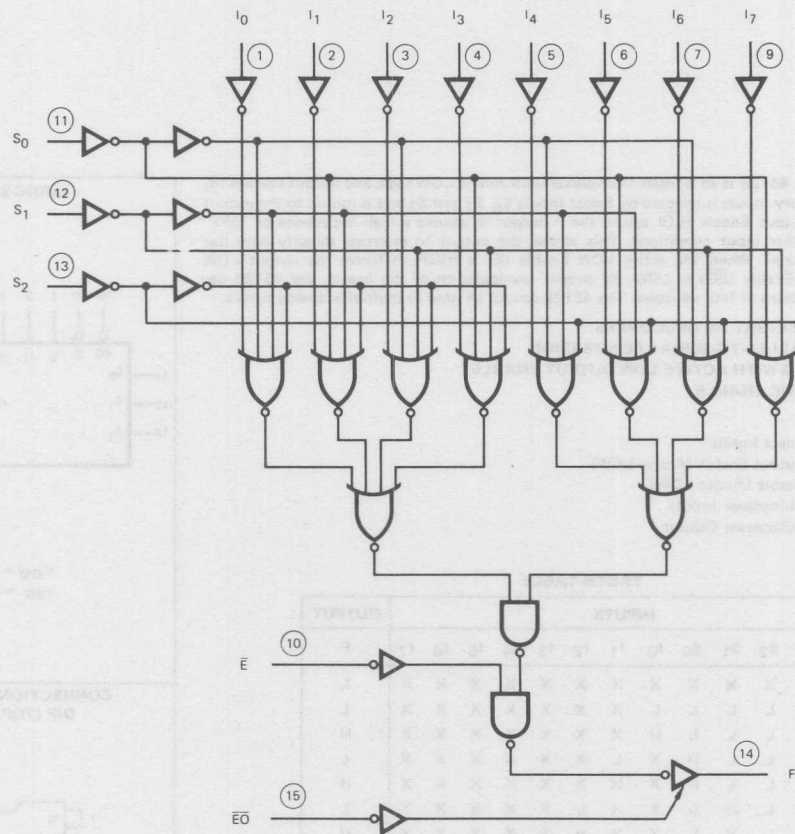
V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Number

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DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

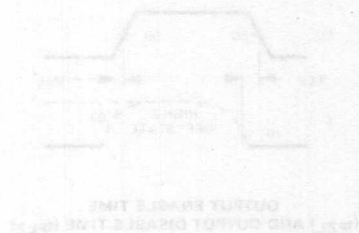
SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF Current HIGH	XC									1.6 12	μA	MIN, 25°C MAX	Output returned to V _{DD} . $\overline{E}O = V_{DD}$
		XM									0.4 12		MIN, 25°C MAX	
I _{OZL}	Output OFF Current LOW	XC									− 1.6 −12	μA	MIN, 25°C MAX	Output returned to V _{SS} . $\overline{E}O = V_{DD}$
		XM									− 0.4 −12		MIN, 25°C MAX	
I _{DD}	Quiescent Power Supply Current	XC			20 150			40 300			80 600	μA	MIN, 25°C MAX	All inputs at 0 V, or V _{DD}
		XM			5 150			10 300			20 600		μA	

AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ C$ (See Note 2)

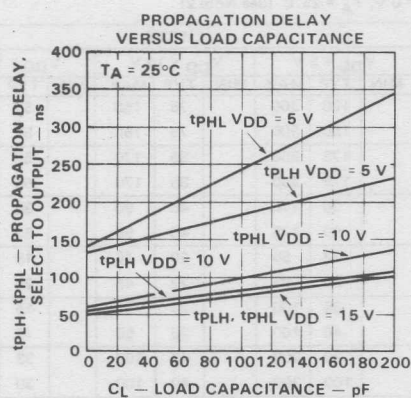
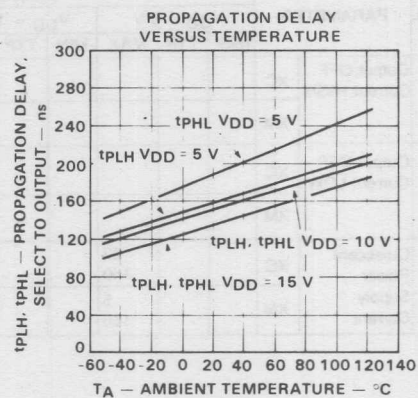
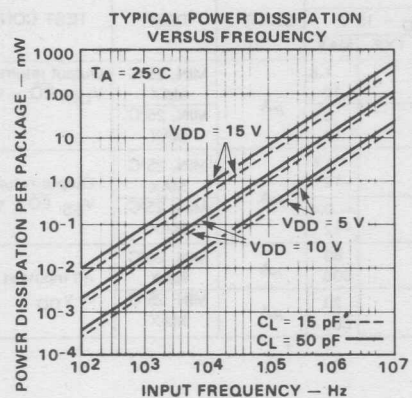
SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Data to Output		150	300		75	150		52	120	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}	Propagation Delay, Select to Output		175	350		85	170		60	136	ns	
t _{PLH}	Propagation Delay, Select to Output		175	350		85	170		65	136	ns	Input Transition Times ≤ 20 ns
t _{PLH}	Propagation Delay, E to Output		90	175		45	90		30	72	ns	
t _{PHL}	Propagation Delay, E to Output		90	175		45	90		32	72	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD}) (R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PZH}	Output Enable Time		33	85		20	45		18	36	ns	
t _{PZL}	Output Enable Time		30	85		22	45		20	36	ns	
t _{PHZ}	Output Disable Time		39	100		20	50		15	40	ns	
t _{PLZ}	Output Disable Time		40	100		20	50		15	40	ns	
t _{TLH}	Output Transition Time		90	200		40	100		33	65	ns	
t _{THL}	Output Transition Time		100	200		40	100		30	65	ns	

NOTES:

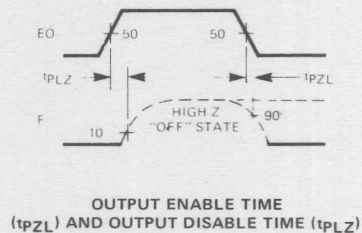
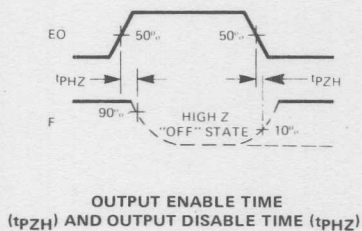
1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.



TYPICAL ELECTRICAL CHARACTERISTICS



SWITCHING WAVEFORMS



APPLICATIONS

MULTIPLEXER AS A FUNCTION GENERATOR — In most digital systems there are areas, usually in the control section, where a number of inputs generate an output in a highly irregular way. In other words, an unusual function must be generated which is apparently not available as an MSI building block. In such cases, many designers tend to return to classical methods of logic design with NAND and NOR gates using Boolean Algebra, Karnaugh maps and Veitch diagrams for logic minimization. Surprisingly enough, multiplexers can simplify these designs.

The 4512B 8-Input multiplexer can generate any one of the 65,536 different functions of four variables. An example will illustrate the technique. Assume four binary inputs are A, B, C and D and F is the desired function (See Fig. 1). If C is connected to S_0 , B to S_1 and A to S_2 , any combination of A, B and C will select an input (assuming the output is enabled). For each combination of A, B and C, the required output, as a function of the fourth variable D, is either H or L the same as D or the opposite of D. Therefore, the truth table may be examined and each input of the 4512B is connected to V_{DD} , V_{SS} , D or \bar{D} as required and in such fashion the function is generated.

In the example shown, (Fig. 1) the first two outputs are the opposite of D, so I_0 is connected to D. The second two are HIGH, so I_1 is connected to V_{DD} , etc.

32-INPUT MULTIPLEXER — The 3-State Output Enable can be used to expand the 4512B. A 32-Input Multiplexer utilizing four 4512B's and a 4011B is shown in Fig. 2.

INPUT VARIABLES				REQUIRED FUNCTION
A	B	C	D	F
L	L	L	L	H
L	L	L	H	L
L	L	H	L	H
L	L	H	H	H
L	H	L	L	L
L	H	L	H	H
L	H	H	L	L
L	H	H	H	L
H	L	L	L	L
.
.

H = HIGH Level
L = LOW Level

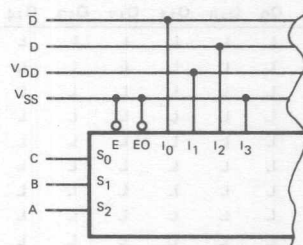


Fig. 1

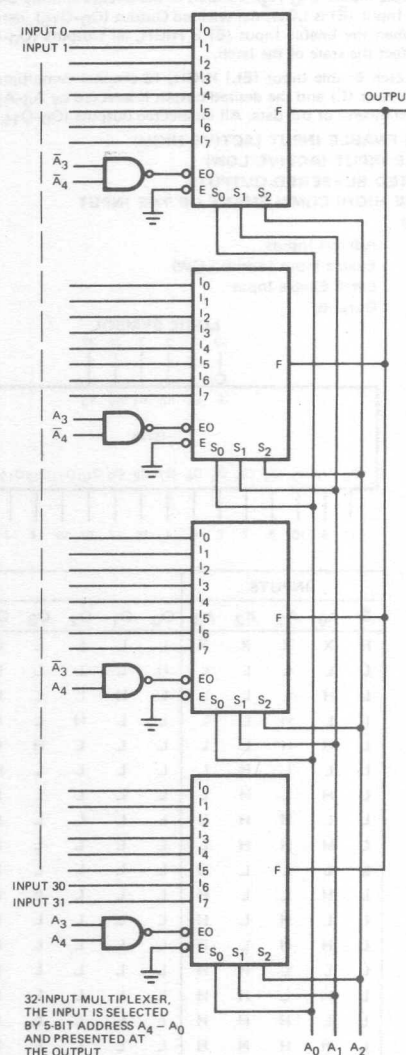


Fig. 2

4514B

1-OF-16 DECODER/DEMULTIPLEXER WITH INPUT LATCH

DESCRIPTION — The 4514B is a 1-of-16 Decoder/Demultiplexer with four binary weighted Address Inputs (A_0 – A_3), a Latch Enable Input (EL), an active LOW Enable Input (\bar{E}) and sixteen mutually exclusive active HIGH Outputs (O_0 – O_{15}).

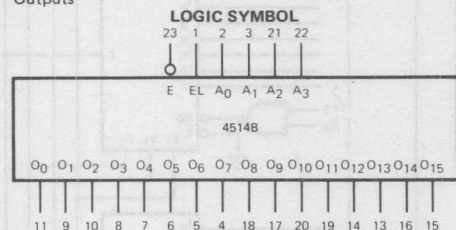
When the Latch Enable Input (EL) is HIGH, the selected Output (O_0 – O_{15}) is determined by the data on the Address Inputs (A_0 – A_3). When the Latch Enable Input (EL) goes LOW, the last data present at the Address inputs (A_0 – A_3) is stored in the latches and the Outputs (O_0 – O_{15}) remain stable. When the Enable Input (\bar{E}) is LOW, the selected Output (O_0 – O_{15}), determined by the contents of the latch, is HIGH. When the Enable Input (\bar{E}) is HIGH, all Outputs (O_0 – O_{15}) are LOW. The Enable Input (\bar{E}) does not affect the state of the latch.

With the Latch Enable Input (EL) HIGH, 16-channel demultiplexing results when data is applied to the Enable Input (\bar{E}) and the desired output is selected by A_0 – A_3 . The selected output (O_0 – O_{15}) will follow as the inverse of the data. All unselected outputs (O_0 – O_{15}) are LOW.

- LATCH ENABLE INPUT (ACTIVE HIGH)
- ENABLE INPUT (ACTIVE LOW)
- SELECTED BUFFERED OUTPUTS (ACTIVE HIGH) COMPLEMENT OF THE INPUT

PIN NAMES

A_0 – A_3 Address Inputs
 \bar{E} Enable Input (Active LOW)
 EL Latch Enable Input
 O_0 – O_{15} Outputs



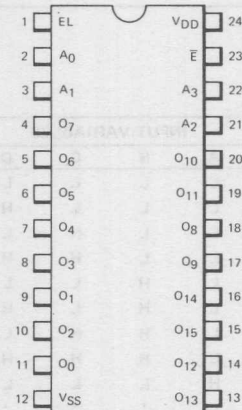
V_{DD} = Pin 24
 V_{SS} = Pin 12

TRUTH TABLE

INPUTS					OUTPUTS															
\bar{E}	A_0	A_1	A_2	A_3	O_0	O_1	O_2	O_3	O_4	O_5	O_6	O_7	O_8	O_9	O_{10}	O_{11}	O_{12}	O_{13}	O_{14}	O_{15}
H	X	X	X	X	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L
L	L	L	L	L	H	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L
L	L	L	L	L	L	H	L	L	L	L	L	L	L	L	L	L	L	L	L	L
L	L	L	L	L	L	L	H	L	L	L	L	L	L	L	L	L	L	L	L	L
L	L	L	L	L	L	L	L	H	L	L	L	L	L	L	L	L	L	L	L	L
L	L	L	L	L	L	L	L	L	H	L	L	L	L	L	L	L	L	L	L	L
L	L	L	L	L	L	L	L	L	L	H	L	L	L	L	L	L	L	L	L	L
L	L	L	L	L	L	L	L	L	L	L	H	L	L	L	L	L	L	L	L	L
L	L	L	L	L	L	L	L	L	L	L	L	H	L	L	L	L	L	L	L	L
L	L	L	L	L	L	L	L	L	L	L	L	L	H	L	L	L	L	L	L	L
L	L	L	L	L	L	L	L	L	L	L	L	L	L	H	L	L	L	L	L	L
L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	H	L	L	L	L	L
L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	H	L	L	L	L
L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	H	L	L	L
L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	H	L	L
L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	L	H	L

H = HIGH Level
 L = LOW Level
 EL = HIGH

CONNECTION DIAGRAM DIP (TOP VIEW)

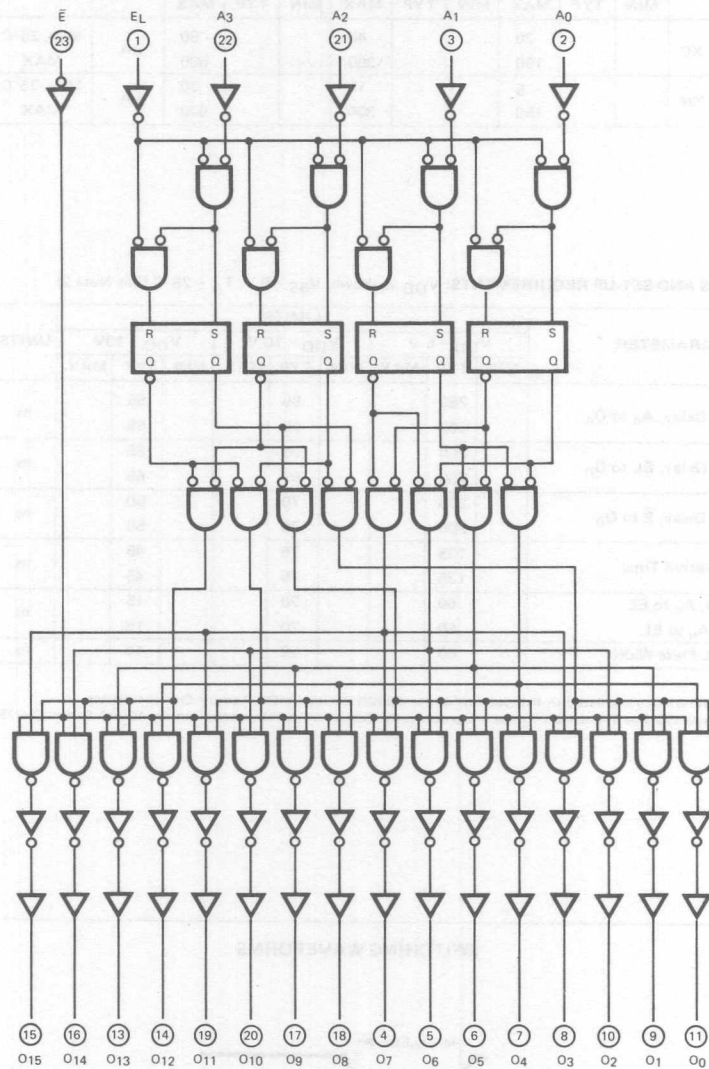


NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4514B

LOGIC DIAGRAM



V_{DD} = Pin 24
V_{SS} = Pin 12
○ = Pin Number

FAIRCHILD CMOS • 4514B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
	Supply Current	XM			150			300			600	μA	MAX	

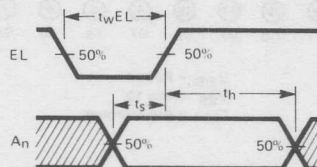
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, A _n to O _n		260			95			65		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			260			95			65			
t _{PLH}	Propagation Delay, EL to O _n		260			95			65		ns	
t _{PHL}			260			95			65			
t _{PLH}	Propagation Delay, \bar{E} to O _n		200			70			50		ns	
t _{PHL}			200			70			50			
t _{TLH}	Output Transition Time		135			75			45		ns	
t _{THL}			135			75			45			
t _s	Set-Up Time, A _n to EL		60			20			15		ns	
t _h	Hold Time, A _n to EL		60			20			15			
t _{wEL}	Minimum EL Pulse Width		60			20			15		ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

SWITCHING WAVEFORMS



MINIMUM E_L PULSE WIDTH AND SET-UP AND HOLD TIMES, A_n TO E_L

NOTE:

Set-up (t_s) and Hold (t_h) Times are shown as positive values but may be specified as negative values.

4515B

1-OF-16 DECODER/DEMULTIPLEXER WITH INPUT LATCH

DESCRIPTION — The 4515B is a 1-of-16 Decoder/Demultiplexer with four binary weighted Address Inputs (A_0 - A_3), a Latch Enable Input (EL), an active LOW Enable Input (\bar{E}) and sixteen mutually exclusive active LOW Outputs (\bar{O}_0 - \bar{O}_{15}).

When the Latch Enable Input (EL) is HIGH, the selected Output (\bar{O}_0 - \bar{O}_{15}) is determined by the data on the Address Inputs (A_0 - A_3). When the Latch Enable Input (EL) goes LOW, the last data present at the Address Inputs (A_0 - A_3) is stored in the latches and the Outputs (\bar{O}_0 - \bar{O}_{15}) remain stable. When the Enable Input (\bar{E}) is LOW, the selected Output (\bar{O}_0 - \bar{O}_{15}), determined by the contents of the latch, is LOW. When the Enable Input (\bar{E}) is HIGH, all Outputs (\bar{O}_0 - \bar{O}_{15}) are HIGH. The Enable Input (\bar{E}) does not affect the state of the latch.

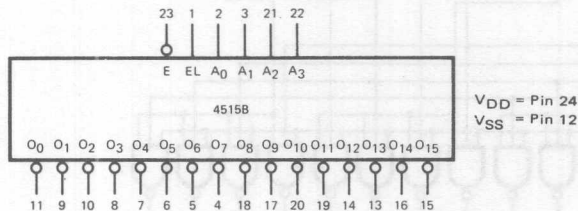
With the Latch Enable Input (EL) HIGH, 16-channel demultiplexing results when data is applied to the Enable Input (\bar{E}) and the desired output is selected by A_0 - A_3 . The selected Output (\bar{O}_0 - \bar{O}_{15}) will follow the data at the Enable Input (\bar{E}). All unselected outputs (\bar{O}_0 - \bar{O}_{15}) are HIGH.

- LATCH ENABLE INPUT (ACTIVE HIGH)
- ENABLE INPUT (ACTIVE LOW)
- BUFFERED OUTPUTS (ACTIVE LOW)

PIN NAMES

A_0 - A_3	Address Inputs
\bar{E}	Enable Input (Active LOW)
EL	Latch Enable Input
\bar{O}_0 - \bar{O}_{15}	Outputs (Active LOW)

LOGIC SYMBOL

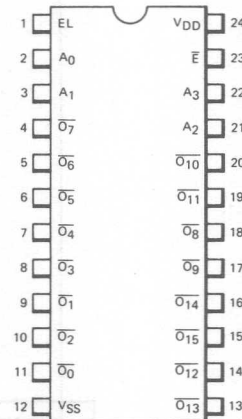


TRUTH TABLE

INPUTS					OUTPUTS															
\overline{E}	A_0	A_1	A_2	A_3	\overline{O}_0	\overline{O}_1	\overline{O}_2	\overline{O}_3	\overline{O}_4	\overline{O}_5	\overline{O}_6	\overline{O}_7	\overline{O}_8	\overline{O}_9	\overline{O}_{10}	\overline{O}_{11}	\overline{O}_{12}	\overline{O}_{13}	\overline{O}_{14}	\overline{O}_{15}
H	X	X	X	X	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
L	L	L	L	L	L	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
L	H	L	L	L	H	L	H	H	H	H	H	H	H	H	H	H	H	H	H	H
L	L	H	L	L	H	H	L	H	H	H	H	H	H	H	H	H	H	H	H	H
L	H	H	L	L	H	H	H	L	H	H	H	H	H	H	H	H	H	H	H	H
L	L	L	H	L	H	H	H	H	L	H	H	H	H	H	H	H	H	H	H	H
L	H	L	H	L	H	H	H	H	L	H	H	H	H	H	H	H	H	H	H	H
L	L	H	H	L	H	H	H	H	H	H	L	H	H	H	H	H	H	H	H	H
L	L	L	L	H	H	H	H	H	H	H	H	H	L	H	H	H	H	H	H	H
L	H	L	L	H	H	H	H	H	H	H	H	H	L	H	H	H	H	H	H	H
L	L	H	L	H	H	H	H	H	H	H	H	H	H	L	H	H	H	H	H	H
L	L	L	H	H	H	H	H	H	H	H	H	H	H	H	H	L	H	H	H	H
L	L	L	H	H	H	H	H	H	H	H	H	H	H	H	H	H	L	H	H	H
L	L	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	L	H	H
L	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	L	H
L	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	L

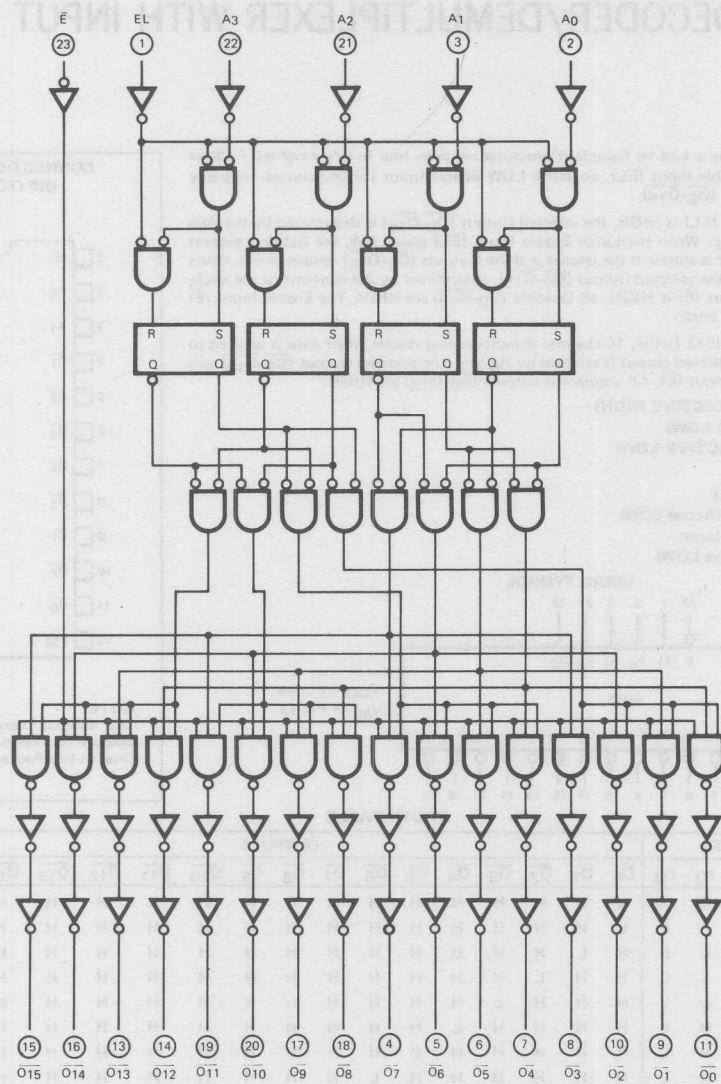
H = HIGH Level
L = LOW Level
EL = HIGH

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 24
V_{SS} = Pin 12
○ = Pin Number

FAIRCHILD CMOS • 4515B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

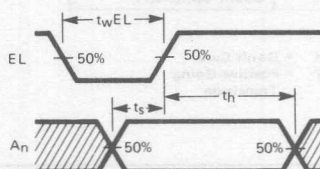
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, A _n to \overline{O}_n		260			95			65		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	Propagation Delay, \overline{E}_L to \overline{O}_n		260			95			65		ns	
t _{PLH}	Propagation Delay, \overline{E} to \overline{O}_n		200			70			50		ns	
t _{PHL}	Propagation Delay, \overline{E} to \overline{O}_n		200			70			50		ns	
t _{TLH}	Output Transition Time		135			75			45		ns	
t _{THL}	Output Transition Time		135			75			45		ns	
t _s	Set-Up Time, A _n to EL		60			20			15		ns	
t _h	Hold Time, A _n to EL		60			20			15		ns	
t _{wEL}	Minimum EL Pulse Width		60			20			15		ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

SWITCHING WAVEFORMS



MINIMUM EL PULSE WIDTH AND SET-UP AND HOLD TIMES, A_n TO \bar{E}_L

NOTE:

Set-up (t_s) and Hold (t_h) Times are shown as positive values but may be specified as negative values.

4516B

UP/DOWN COUNTER

DESCRIPTION — The 4516B is an edge-triggered synchronous Up/Down 4-Bit Binary Counter with a Clock Input (CP), an active HIGH Count Up/Down Control Input (UP/DN), an active LOW count Enable Input (CE), an asynchronous active HIGH Parallel Load Input (PL), four Parallel Inputs (P₀-P₃), four parallel Outputs (Q₀-Q₃), an active LOW Terminal Count Output (TC) and an overriding asynchronous Master Reset Input (MR).

Information on the Parallel Inputs (P₀-P₃) is loaded into the counter while the Parallel Load Input (PL) is HIGH, independent of all other input conditions except the Master Reset Input (MR) which must be LOW. When the Parallel Load Input (PL) and the Count Enable Input (CE) are LOW, the counter changes on the LOW-to-HIGH transition of the Clock Input (CP). The Count Up/Down Control Input (UP/DN) determines the direction of the count, HIGH for counting up, LOW for counting down. When counting up, the Terminal Count Output (TC) is LOW when Q₀ = Q₁ = Q₂ = Q₃ = HIGH and CE = LOW. When counting down the Terminal Count Output (TC) is LOW when Q₀ = Q₁ = Q₂ = Q₃ = LOW and the CE = LOW. A HIGH on the Master Reset Input (MR) resets the counter (Q₀ = Q₁ = Q₂ = Q₃ = LOW) independent of all other input conditions.

- UP/DOWN COUNT CONTROL
- SINGLE CLOCK INPUT (L → H EDGE-TRIGGERED)
- ASYNCHRONOUS PARALLEL LOAD INPUT
- ASYNCHRONOUS MASTER RESET

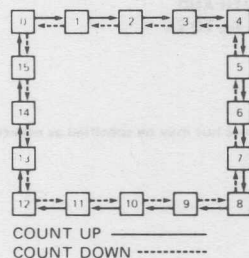
MODE SELECTION TABLE

PL	UP/DN	CE	CP	MODE
H	X	X	X	Parallel Load (P _n → Q _n)
L	X	H	X	No Change
L	L	L	↓	Count Down, Binary
L	H	L	↑	Count Up, Binary

MR = LOW
H = HIGH Level
L = LOW Level

X = Don't Care
↓ = Positive-Going Transition

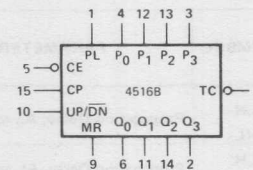
STATE DIAGRAM



LOGIC EQUATION FOR TERMINAL COUNT

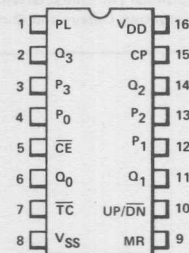
$$TC = \overline{CE} \cdot [(UP/DN) \cdot Q_0 \cdot Q_1 \cdot Q_2 \cdot Q_3] + [(UP/DN) \cdot \overline{Q_0} \cdot \overline{Q_1} \cdot \overline{Q_2} \cdot \overline{Q_3}]$$

LOGIC SYMBOL



V_{DD} = Pin 16
V_{SS} = Pin 8

CONNECTION DIAGRAM
DIP (TOP VIEW)

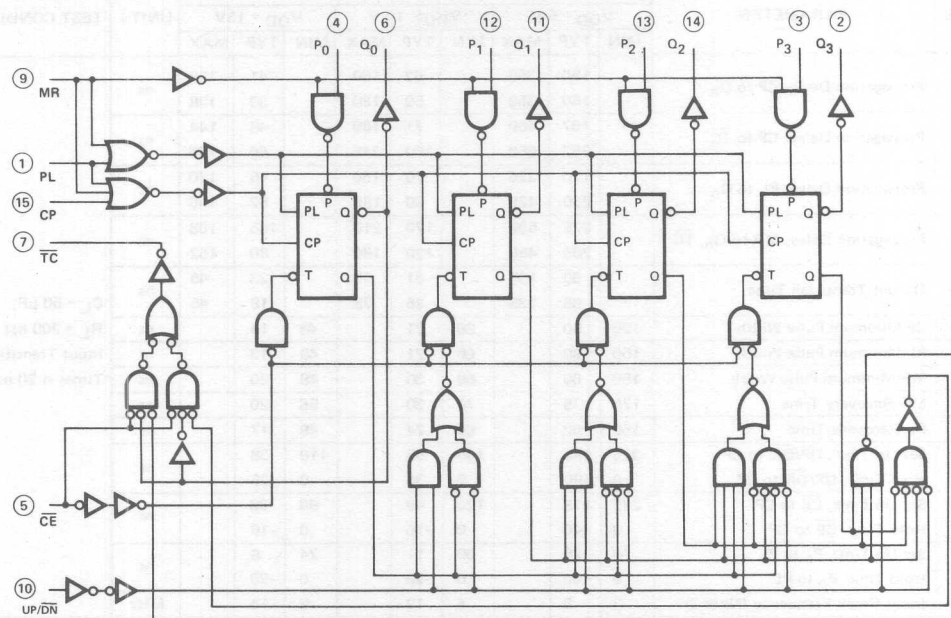


NOTE:
The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package,

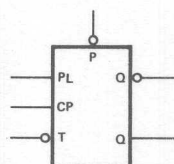
PIN NAMES

PL	Parallel Load Input (Active HIGH)
P ₀ -P ₃	Parallel Inputs
CE	Count Enable Input (Active LOW)
CP	Clock Pulse Input (L → H Edge-Triggered)
UP/DN	Up/Down Count Control Input
MR	Master Reset Input
TC	Terminal Count Output (Active LOW)
Q ₀ -Q ₃	Parallel Outputs

LOGIC DIAGRAM

V_{DD} = Pin 16V_{SS} = Pin 8

○ = Pin Number



PL (Parallel Load Input) — Asynchronously Loads P into Q, Overriding all Other Inputs

P (Parallel Input) — Data on this Pin is Asynchronously Loaded into Q, when PL is HIGH Overriding all Other Inputs

T (Toggle Input) — Forces the Q Output to Synchronously Toggle when a HIGH is placed on this Input

CP (Clock Pulse Input)

Q, \bar{Q} (True and Complementary Outputs)DC CHARACTERISTICS: V_{DD} as shown, V_{SS} = 0 V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

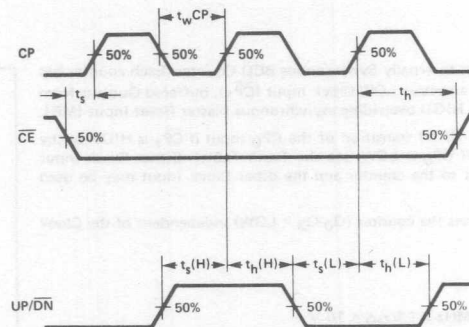
Notes on following page

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q _n		150	350		62	160		41	128	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			150	350		59	160		39	128		
t _{PLH}	Propagation Delay, CP to \overline{TC}		167	450		71	180		48	144	ns	
t _{PHL}			252	650		100	245		66	196		
t _{PLH}	Propagation Delay, PL to Q _n		170	325		70	150		45	120	ns	
t _{PHL}			220	425		90	195		62	156		
t _{PLH}	Propagation Delay, MR to Q _n , \overline{TC}		225	500		170	210		105	168	ns	
t _{PHL}			205	450		120	190		80	152		
t _{TLH}	Output Transition Time		60	135		31	75		23	45	ns	
t _{THL}			65	135		25	75		18	45		
t _{wCP}	CP Minimum Pulse Width	125	50		60	21		48	14		ns	
t _{wPL}	PL Minimum Pulse Width	150	60		60	21		48	16		ns	
t _{wMR}	MR Minimum Pulse Width	150	60		60	30		48	20		ns	
t _{rec}	MR Recovery Time	175	75		70	30		56	20		ns	
t _{rec}	PL Recovery Time	150	62		60	24		48	17		ns	
t _s	Set-Up Time, UP/ \overline{DN} to CP	325	145		140	55		110	38		ns	
t _h	Hold Time, UP/ \overline{DN} to CP	0	-90		0	-35		0	-25			
t _s	Set-Up Time, \overline{CE} to CP	275	118		120	49		96	33		ns	
t _h	Hold Time, \overline{CE} to CP	0	-40		0	-15		0	-10			
t _s	Set-Up Time, P _n to PL	70	29		30	11		24	8		ns	
t _h	Hold Time, P _n to PL	0	-40		0	-20		0	-20			
f _{MAX}	Input Clock Frequency (Note 3)	2	5		5	12		6	15		MHz	

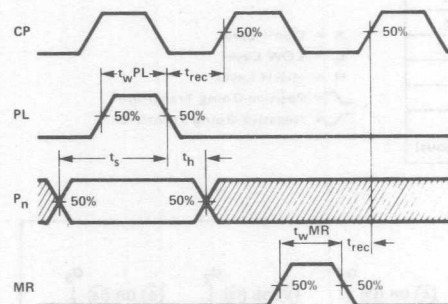
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For t_{MAX}, input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μs at V_{DD} = 5 V, 4 μs at V_{DD} = 10 V, and 3 μs at V_{DD} = 15 V.

SWITCHING WAVEFORMS



MINIMUM CP WIDTH, SET-UP AND HOLD TIMES, CE TO CP AND UP/DN TO CP



MINIMUM PL AND MR PULSE WIDTH, RECOVERY TIME FOR PL AND MR, AND SET-UP AND HOLD TIMES, P_n TO PL

NOTE:

Set-up and Hold Times are shown as positive values but may be specified as negative values.

4518B

DUAL 4-BIT DECADE COUNTER

DESCRIPTION — The 4518B is a Dual 4-Bit Internally Synchronous BCD Counter. Each counter has both an active HIGH Clock Input (CP_0) and an active LOW Clock Input (\overline{CP}_1), buffered Outputs from all four bit positions (Q_0 - Q_3) and an active HIGH overriding asynchronous Master Reset Input (MR).

The counter advances on either the LOW-to-HIGH transition of the CP_0 Input if \overline{CP}_1 is HIGH or the HIGH-to-LOW transition of the \overline{CP}_1 Input if CP_0 is LOW (see the Truth Table). Either Clock Input (CP_0 , \overline{CP}_1) may be used as the Clock Input to the counter and the other Clock Input may be used as a Clock Inhibit Input.

A HIGH on the Master Reset Input (MR) resets the counter (Q_0 - $Q_3 = \text{LOW}$) independent of the Clock Inputs (CP_0 , \overline{CP}_1).

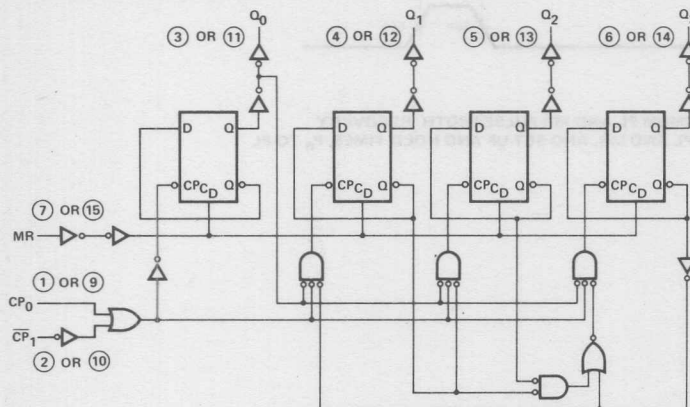
- TYPICAL COUNT FREQUENCY OF 10 MHz AT $V_{DD} = 10 \text{ V}$
- TRIGGERED ON EITHER A LOW-TO-HIGH OR A HIGH-TO-LOW TRANSITION
- ASYNCHRONOUS ACTIVE HIGH MASTER RESET
- BUFFERED OUTPUTS FROM ALL FOUR BIT POSITIONS
- FULLY SYNCHRONOUS COUNTING

TRUTH TABLE

CP_0	\overline{CP}_1	MR	MODE
	H	L	Counter Advances
	L	L	Counter Advances
	X	L	No Change
X		L	No Change
	L	L	No Change
H		L	No Change
X	X	H	Reset (Asynchronous)

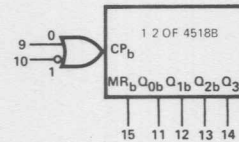
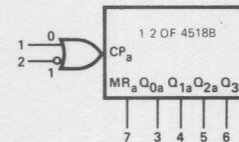
X = Don't Care
 L = LOW Level
 H = HIGH Level
 = Positive-Going Transition
 = Negative-Going Transition

1/2 OF A 4518B LOGIC DIAGRAM



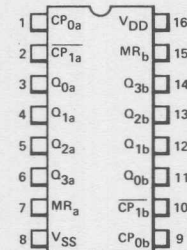
V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Number

LOGIC SYMBOLS



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM
 DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

PIN NAMES

CP_{0a} , CP_{0b} Clock Input (L \rightarrow H (Triggered))
 \overline{CP}_{1a} , \overline{CP}_{1b} Clock Input (H \rightarrow L (Triggered))
 MR_a , MR_b Master Reset Inputs
 Q_{0a} - Q_{3a} Outputs
 Q_{0b} - Q_{3b} Outputs

FAIRCHILD CMOS • 4518B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

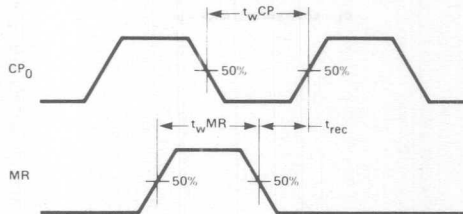
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $F_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
¹ PLH	Propagation Delay, CP ₀ or CP ₁ to Q _n		220	480		95	210		60	168	ns	CL = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
¹ PLH			220	480		95	210		60	168	ns	
¹ PHL	Propagation Delay, MR to Q _n		220	480		90	210		60	168	ns	
¹ TLH	Output Transition Time		65	135		35	70		25	45	ns	
¹ THL			65	135		35	70		25	45	ns	
t _{wMR}	MR Minimum Pulse Width	180	70		70	30		56	20		ns	
t _{wCP}	CP ₀ or CP ₁ Minimum Pulse Width	275	120		120	50		96	35		ns	
t _{rec}	MR Recovery Time	40	15		25	5		20	0		ns	
t _s	Set-Up Time, CP ₀ to CP ₁	275	130		125	57		100	40		ns	
t _s	Set-Up Time, CP ₁ to CP ₀	275	130		125	57		100	40		ns	
f _{MAX}	Input Count Frequency (Note 3)	2	4		4	10		5	12		MHz	

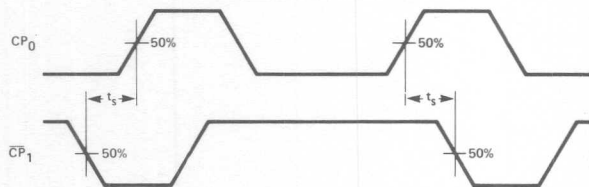
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

SWITCHING WAVEFORMS



MINIMUM PULSE WIDTHS FOR CP_0 , CP_1 AND MR AND MR RECOVERY TIME



SET-UP TIMES, CP_0 TO CP_1 AND CP_1 TO CP_0

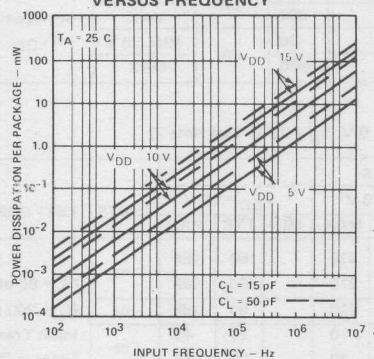
CONDITIONS: $CP_1 = \text{HIGH}$ and the device triggers on a LOW-to-HIGH transition at CP_0 . The timing also applies when $CP_0 = \text{LOW}$ and the device triggers on a HIGH-to-LOW transition at CP_1 .

NOTE:

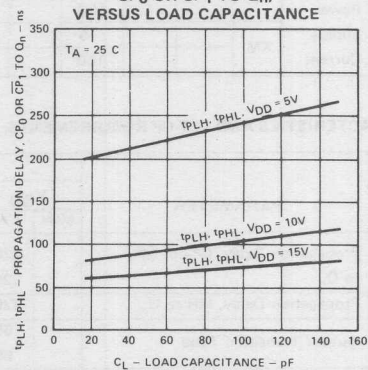
Set-up and Hold Times are shown as positive values but may be specified as negative values.

TYPICAL ELECTRICAL CHARACTERISTICS

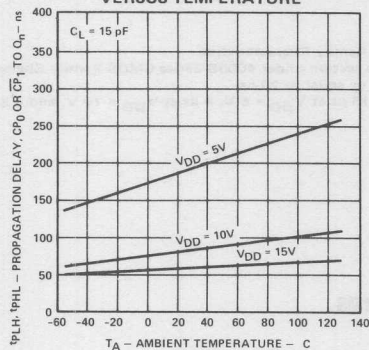
POWER DISSIPATION
VERSUS FREQUENCY



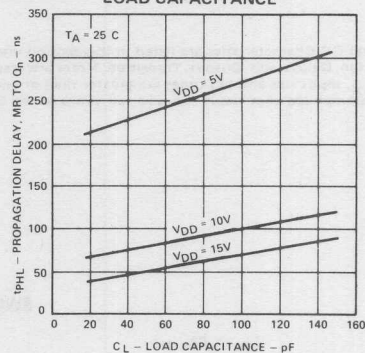
PROPAGATION DELAY,
CP0 OR CP1 TO Q_n ,
VERSUS LOAD CAPACITANCE



PROPAGATION DELAY,
CP0 OR CP1 TO Q_n ,
VERSUS TEMPERATURE



PROPAGATION DELAY,
MR TO Q_n , VERSUS
LOAD CAPACITANCE



4519B

QUAD 2-INPUT MULTIPLEXER

DESCRIPTION — The 4519B provides four multiplexing circuits with common selection inputs; each circuit contains two inputs and one output. It may be used to select four bits of information from one of two sources. The A inputs are selected when S_A is HIGH, the B inputs when S_B is HIGH. When S_A and S_B are HIGH, the output (Z_n) is the logical Exclusive-NOR of the A_n and B_n input ($Z_n = A_n \oplus B_n$). When S_A and S_B are LOW, the output (Z_n) is LOW, independent of the multiplexer inputs (A_n and B_n). The 4519B cannot be used to multiplex analog signals. The outputs utilize standard buffers for best performance.

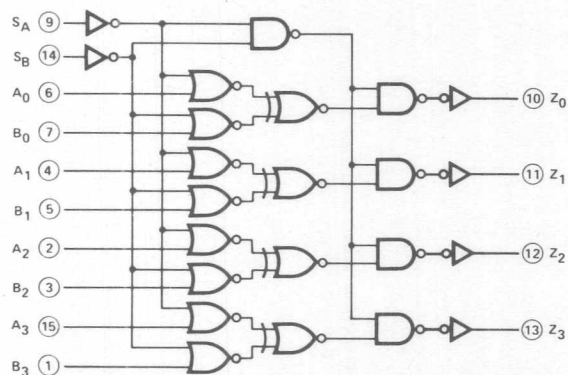
- COMMON SELECT INPUTS
- FULLY BUFFERED OUTPUTS

TRUTH TABLE

SELECT		INPUTS		OUTPUT
S_A	S_B	A_n	B_n	Z_n
L	L	X	X	L
H	L	L	X	L
H	L	H	X	H
L	H	X	L	L
L	H	X	H	H
H	H	L	L	H
H	H	L	H	L
H	H	H	L	L
H	H	H	H	H

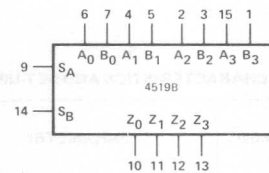
H = HIGH Level
L = LOW Level
X = Don't Care

LOGIC DIAGRAM



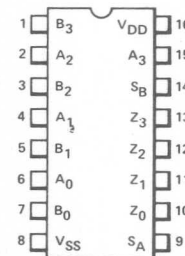
○ = Pin Number

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

PIN NAMES

S_A, S_B Select Inputs (Active HIGH)
 A_0-A_3, B_0-B_3 Multiplexer Inputs
 Z_0-Z_3 Multiplexer Outputs

FAIRCHILD CMOS • 4519B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, S _n to Z _n		110			50			40		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			110			50			40			
t _{PLH}	Propagation Delay, A _n , B _n to Z _n		110			50			40		ns	
t _{PHL}			110			50			40			
t _{TLH}	Output Transition Time		65			35			15		ns	
t _{THL}			65			35			15			

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

4520B

DUAL 4-BIT BINARY COUNTER

DESCRIPTION — The 4520B is a Dual 4-Bit Internally Synchronous Binary Counter. Each counter has both an active HIGH Clock Input (CP_0) and an active LOW Clock Input (CP_1), buffered Outputs from all four bit positions (Q_0 - Q_3) and an active HIGH overriding asynchronous Master Reset Input (MR).

The counter advances on either the LOW-to-HIGH transition of the CP_0 Input if $\overline{CP_1}$ is HIGH or the HIGH-to-LOW transition of the CP_1 Input if CP_0 is LOW (see the Truth Table). Either Clock Input (CP_0 , CP_1) may be used as the Clock Input to the counter and the other Clock Input may be used as a Clock Inhibit Input.

A HIGH on the Master Reset Input (MR) resets the counter (Q_0 - Q_3 = LOW) independent of the Clock Inputs (CP_0 , CP_1).

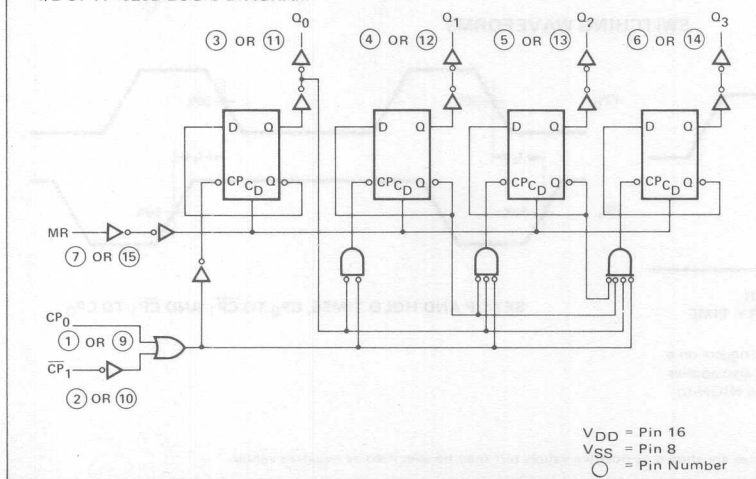
- TYPICAL COUNT FREQUENCY OF 10 MHz AT V_{DD} = 10 V
- TRIGGERED ON EITHER A LOW-TO-HIGH OR A HIGH-TO-LOW TRANSITION
- ASYNCHRONOUS ACTIVE HIGH MASTER RESET
- BUFFERED OUTPUTS FROM ALL FOUR BIT POSITIONS
- FULLY SYNCHRONOUS COUNTING

TRUTH TABLE

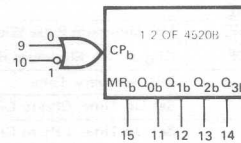
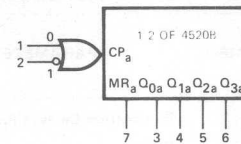
CP_0	$\overline{CP_1}$	MR	MODE
	H	L	Counter Advances
L		L	Counter Advances
	X	L	No Change
X		L	No Change
	L	L	No Change
H		L	No Change
X	X	H	Reset (Asynchronous)

X = Don't Care
 L = LOW Level
 H = HIGH Level
 = Positive-Going Transition
 = Negative-Going Transition

1/2 OF A 4520B LOGIC DIAGRAM

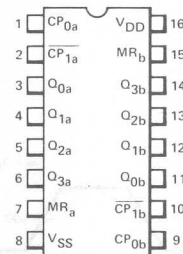


LOGIC SYMBOLS



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM
 DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

PIN NAMES

CP_{0a} , CP_{0b} Clock Input (L \rightarrow H Triggered)
 $\overline{CP_{1a}}$, $\overline{CP_{1b}}$ Clock Input (H \rightarrow L Triggered)
 MR_a , MR_b Master Reset Inputs
 Q_{0a} - Q_{3a} Outputs
 Q_{0b} - Q_{3b} Outputs

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

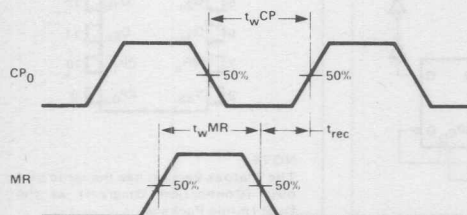
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP ₀ or CP ₁ to Q _n		220	480		95	210		60	168	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	Propagation Delay, MR to Q _n		220	480		95	210		60	168	ns	
t _{RLH}	Output Transition Time		65	135		35	70		25	45	ns	
t _{THL}	Output Transition Time		65	135		35	70		25	45	ns	
t _{WMR}	MR Minimum Pulse Width	180	70		70	30		56	20		ns	
t _{WCP}	CP ₀ or CP ₁ Minimum Pulse Width	275	120		120	50		96	35		ns	
t _{rec}	MR Recovery Time	40	15		25	5		20	0		ns	
t _s	Set-Up Time, CP ₀ to CP ₁	275	130		125	57		100	40		ns	
t _s	Set-Up Time, CP ₁ to CP ₀	275	130		125	57		100	40		ns	
f _{MAX}	Input Count Frequency (Note 3)	2	4		4	10		5	12		MHz	

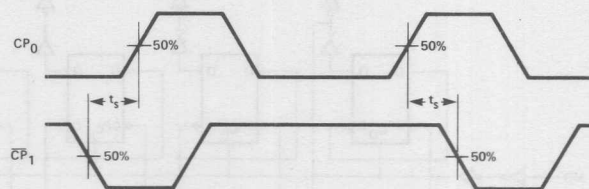
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μs at $V_{DD} = 5\text{ V}$, 4 μs at $V_{DD} = 10\text{ V}$, and 3 μs at $V_{DD} = 15\text{ V}$.

SWITCHING WAVEFORMS



MINIMUM PULSE WIDTHS FOR CP_0 , CP_1 AND MR AND MR RECOVERY TIME



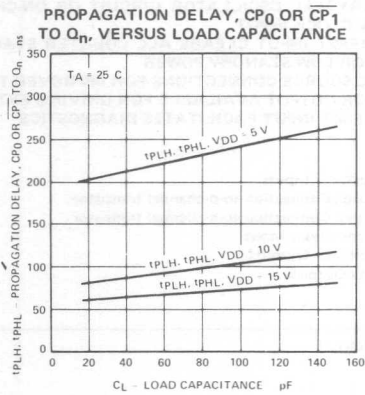
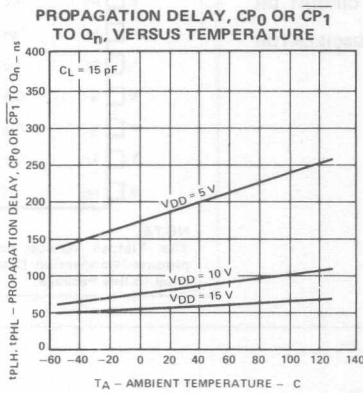
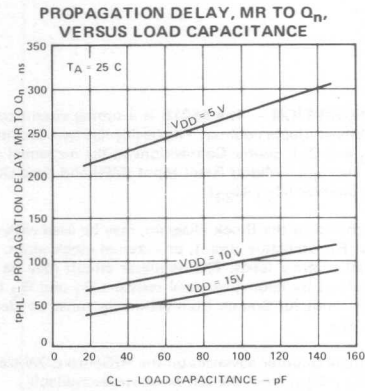
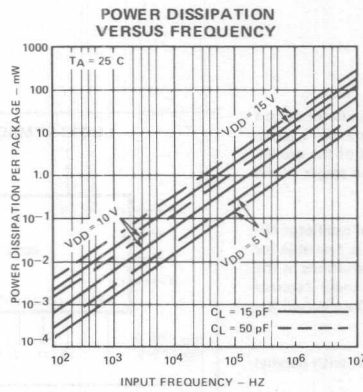
SET-UP AND HOLD TIMES, CP_0 TO $\overline{CP_1}$ AND $\overline{CP_1}$ TO CP_0

CONDITIONS: $\overline{CP_1} = \text{HIGH}$ and the device triggers on a LOW-to-HIGH transition at CP_0 . The timing also applies when $CP_0 = \text{LOW}$ and the device triggers on a HIGH-to-LOW transition at CP_1 .

NOTE:

Set up and Hold Times are shown as positive values but may be specified as negative values.

TYPICAL ELECTRICAL CHARACTERISTICS



4521B

24-STAGE BINARY COUNTER

GENERAL DESCRIPTION — The 4521B is a timing circuit consisting of an on-chip oscillator circuit and a 24-stage binary ripple counter. The device has two Oscillator Inputs (I_1 and I_2) and two Oscillator Outputs (O_1 and O_2), Source Connections to the n-channel and p-channel transistors of the oscillator circuit (S_N and S_P), a Master Reset Input (MR) and Data Outputs from the last seven stages of the 24-stage Ripple Counter (Q_{17} - Q_{23}).

The 4521B, as shown in the Block Diagram, may be used with either an external crystal oscillator circuit, an external RC oscillator circuit, or external clock input. Oscillator Output, O_2 , is available for driving additional external loads. The oscillator circuit may be made less sensitive to variations in the power supply voltage by adding external resistors R_1 and R_2 (See Block Diagram). If these external resistors are not required, Source Connection S_P must be tied to V_{DD} and Source Connection S_N must be tied to V_{SS} .

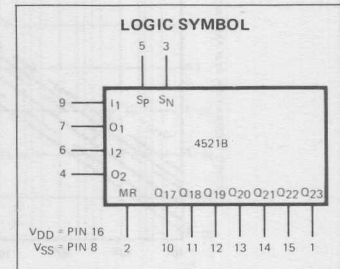
The 24-Stage Ripple Counter advances on the HIGH-to-LOW transition of the clock input with parallel Data Outputs (Q_{17} - Q_{23}) from the last seven stages available.

A HIGH on the Master Reset Input (MR) clears all counter stages, forcing all Parallel Data Outputs (Q_{17} - Q_{23}) LOW and disables the oscillator circuit, independent of all other inputs. This allows for very low standby power dissipation.

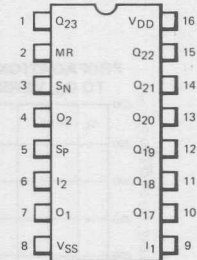
- ON-CHIP CRYSTAL OSCILLATOR CIRCUIT OR ON-CHIP RC OSCILLATOR CIRCUIT OR EXTERNAL CLOCK INPUT
- MASTER RESET INPUT CLEARS ALL COUNTER STAGES AND DISABLES OSCILLATOR CIRCUIT FOR LOW STANDBY POWER
- EXTERNAL SOURCE CONNECTIONS FOR IMPROVED TIMING STABILITY
- OSCILLATOR OUTPUT AVAILABLE FOR DRIVING EXTERNAL LOADS
- MASTER RESET INPUT FACILITATES DIAGNOSTICS

PIN NAMES

I_1, I_2	Oscillator Inputs
S_P	Source Connection-to-p-channel transistor
S_N	Source Connection-to-n-channel transistor
MR	Master Reset Input
O_1, O_2	Oscillator Outputs
$Q_{17}-Q_{23}$	Data Outputs



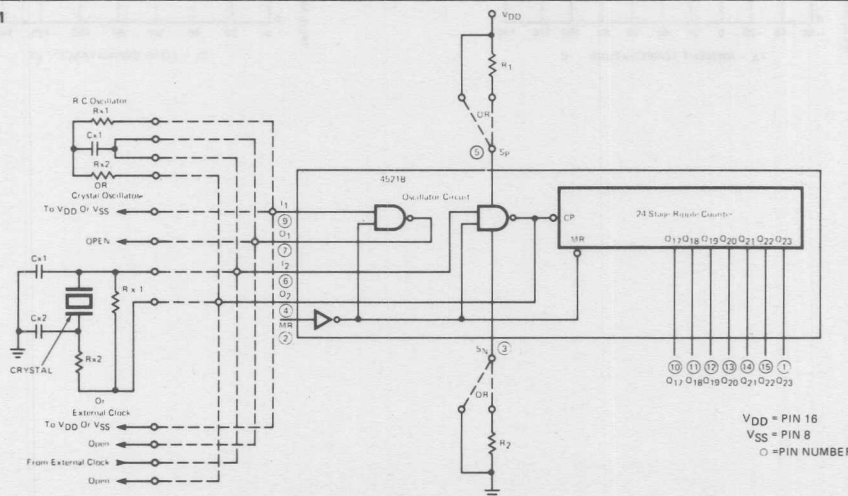
CONNECTION DIAGRAM DIP (TOP View)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

BLOCK DIAGRAM



4522B • 4526B

PROGRAMMABLE 4-BIT BCD/BINARY DOWN COUNTER

GENERAL DESCRIPTION — The 4522B/4526B is a synchronous Programmable 4-Bit BCD/Binary Down Counter with an active HIGH and an active LOW Clock Input (CP_0 , CP_1), an asynchronous Parallel Load Input (PL), four Parallel Inputs (P_0 - P_3), a Carry Forward Input (CF), four buffered Parallel Outputs (Q_0 - Q_3), a Terminal Count Output (TC) and an overriding asynchronous Master Reset Input (MR).

Information on the Parallel Inputs (P_0 - P_3) is loaded into the counter while the Parallel Load Input (PL) is HIGH, independent of all other input conditions except Master Reset Input (MR) which must be LOW. When the Parallel Load Input (PL) and the active LOW Clock Input (CP_1) are LOW, the counter advances on a LOW-to-HIGH transition of the active HIGH Clock Input (CP_0). When the Parallel Load Input (PL) is LOW and the active HIGH Clock Input (CP_0) is HIGH, the counter advances on a HIGH-to-LOW transition of the CP_1 Input. The Terminal Count Output (TC) is HIGH when the counter is in the zero state ($Q_0 = Q_1 = Q_2 = Q_3 = \text{LOW}$) and the Carry Forward Input (CF) is HIGH. A HIGH on the Master Reset Input (MR) resets the counter (Q_0 - $Q_3 = \text{LOW}$) independent of other input conditions.

- FULLY SYNCHRONOUS PROGRAMMABLE BCD/BINARY DOWN COUNTER
- CLOCK INPUT EITHER HIGH-TO-LOW OR LOW-TO-HIGH EDGE-TRIGGERED
- ASYNCHRONOUS MASTER RESET
- CASCADABLE
- ASYNCHRONOUS PARALLEL LOAD

PIN NAMES

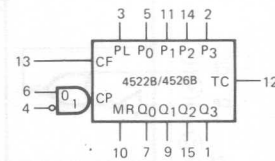
PL	Parallel Load Input
P_0 - P_3	Parallel Inputs
CF	Carry Forward Input
CP_0	Clock Input (L→H Edge-Triggered)
CP_1	Clock Input (H→L Edge-Triggered)
MR	Asynchronous Master Reset Input
TC	Terminal Count Output
Q_0 - Q_3	Buffered Outputs

MODE SELECTION TABLE

MR	PL	CP_0	CP_1	MODE
H	X	X	X	RESET (ASYNCHRONOUS)
L	H	X	X	PRESET (ASYNCHRONOUS)
L	L	↗	H	NO CHANGE
L	L	L	↘	NO CHANGE
L	L	↘	X	NO CHANGE
L	L	X	↗	NO CHANGE
L	L	↗	L	COUNTER ADVANCES
L	L	L	↘	COUNTER ADVANCES

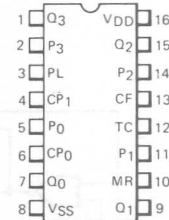
X = DON'T CARE
L = LOW LEVEL
H = HIGH LEVEL
↗ = POSITIVE GOING TRANSITION
↘ = NEGATIVE GOING TRANSITION

LOGIC SYMBOL



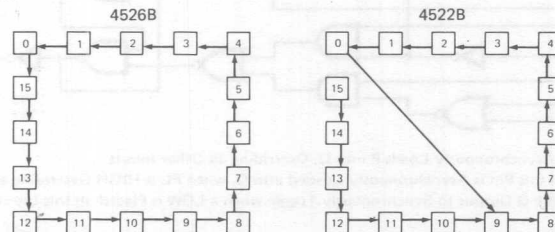
V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)

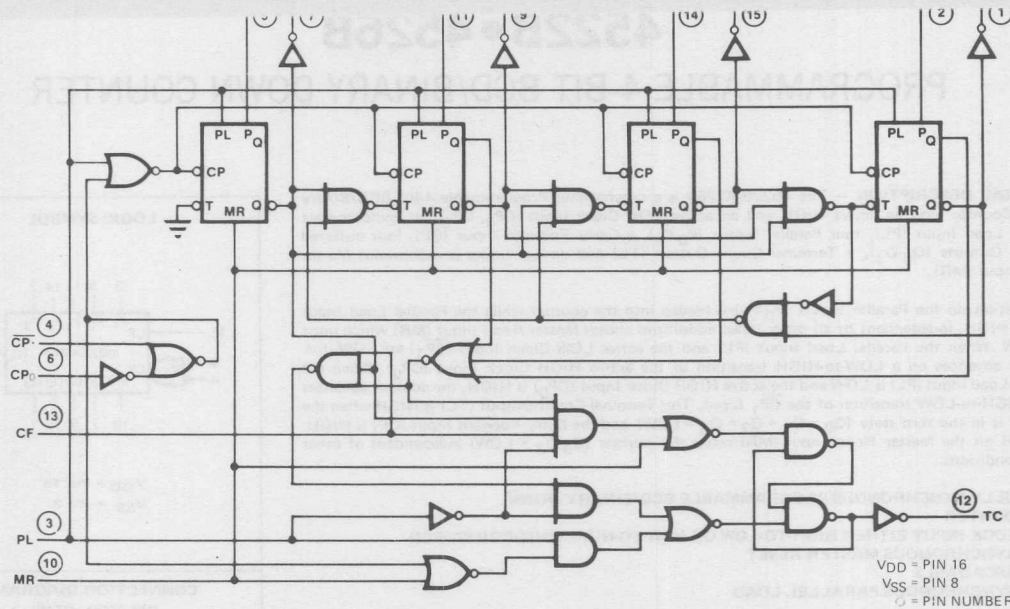


NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

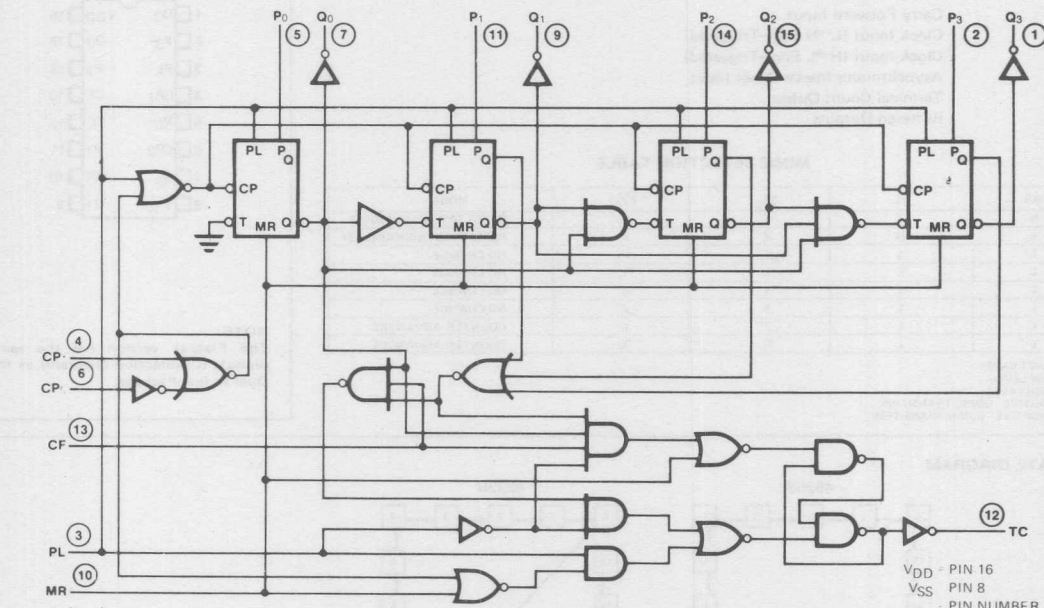
STATE DIAGRAM



LOGIC EQUATION FOR TERMINAL COUNT
 $TC = CF \cdot \bar{Q}_0 \cdot (\bar{Q}_1 + Q_2 + Q_3)$



4526 LOGIC DIAGRAM



PL (Parallel Load Input) - Asynchronously Loads P into Q, Overriding all Other Inputs
P (Parallel Input) - Data on this Pin is Asynchronously Loaded into Q, when PL is HIGH Overriding all Other Inputs
T (Toggle Input) - Forces the Q Output to Synchronously Toggle when a LOW is Placed on this Input.
CP (Clock Pulse Input)
Q, Q (True and Complimentary Outputs)
MR (Master Reset Input)

FAIRCHILD CMOS • 4522B/4526B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (Note 1)

SYMBOL	PARAMETER	LIMITS									UNITS	TEMP	TEST CONDITIONS	
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V						
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX				
I _{DD}	Quiescent	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
	Power				150			300			600		MAX	
	Supply	XM			5			10			20	μA	MIN, 25°C	
	Current				150			300			600		MAX	

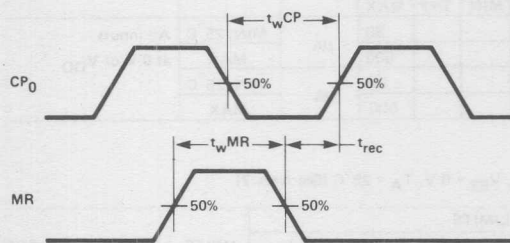
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ C$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		$V_{DD} = 5\text{ V}$			$V_{DD} = 10\text{ V}$			$V_{DD} = 15\text{ V}$				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP ₀ or		220			95		60			ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	\overline{CP}_1 to Q _n		220			95		60			ns	
t _{PLH}	Propagation Delay, CP ₀ or		240			105		66			ns	
t _{PHL}	\overline{CP}_1 to TC		240			105		66			ns	
t _{PLH}	Propagation Delay, CF		200			85		53			ns	
t _{PHL}	to TC		200			85		53			ns	
t _{PLH}	Propagation Delay, PL		220			90		65			ns	
t _{PHL}	to Q _n		220			90		65			ns	
t _{PHL}	Propagation Delay, MR to Q _n		220			95		60			ns	
t _{TLH}	Output Transition		65			25		18			ns	
t _{THL}	Time		65			25		18			ns	
t _{rec}	MR Recovery Time		15			5		0			ns	
t _{wMR}	MR Minimum Pulse Width		70			30		20			ns	
t _{rec}	PL Recovery Time		15			5		0			ns	
t _{wPL}	PL Minimum Pulse Width		70			30		20			ns	
t _{wCP}	CP Minimum Pulse Width		120			50		35			ns	
t _s	Set-Up Time, CF to CLOCK		150			50		35			ns	
t _h	Hold Time, CF to CLOCK		100			40		25			ns	
t _s	Set-Up Time, P _n to PL		30			15		10			ns	
t _h	Hold Time, P _n to PL		25			10		5			ns	
t _h	Hold Time, CP ₀ to \overline{CP}_1		130			57		40			ns	
t _h	Hold Time, \overline{CP}_1 to CP ₀		130			57		40			ns	
f _{MAX}	Input Count Frequency (Note 3)		4			10		12			MHz	

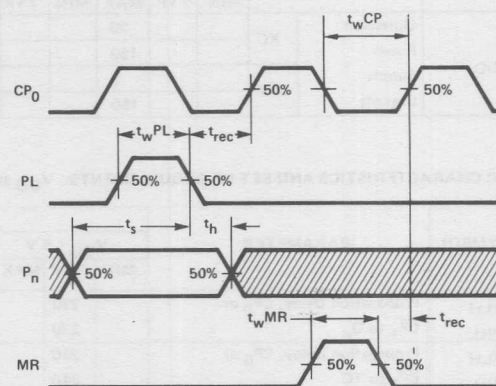
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μs at $V_{DD} = 5$ V, 4 μs at $V_{DD} = 10$ V, and 3 μs at $V_{DD} = 15$ V.

SWITCHING WAVEFORMS

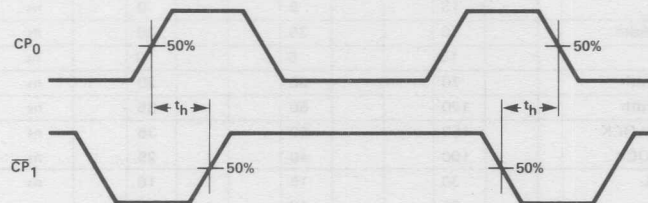


MINIMUM PULSE WIDTHS FOR
CP₀ AND MR AND MR RECOVERY TIME

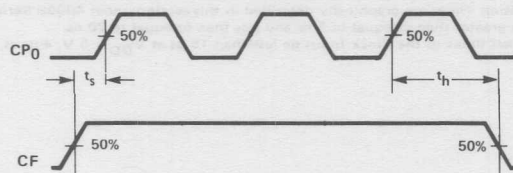


MINIMUM CP₀, PL AND MR PULSE WIDTH,
RECOVERY TIME FOR PL AND MR, AND SET-UP
AND HOLD TIMES, P_n TO PL

CONDITIONS: $\overline{CP_1}$ = LOW and the device triggers on a LOW-to-HIGH transition at CP₀. The timing also applies when CP₀ = HIGH and the device triggers on a HIGH-to-LOW transition at CP₁. MR = PL = LOW.



HOLD TIMES, CP₀ TO $\overline{CP_1}$ AND $\overline{CP_1}$ TO CP₀



SET UP AND HOLD TIMES, CF TO CP₀

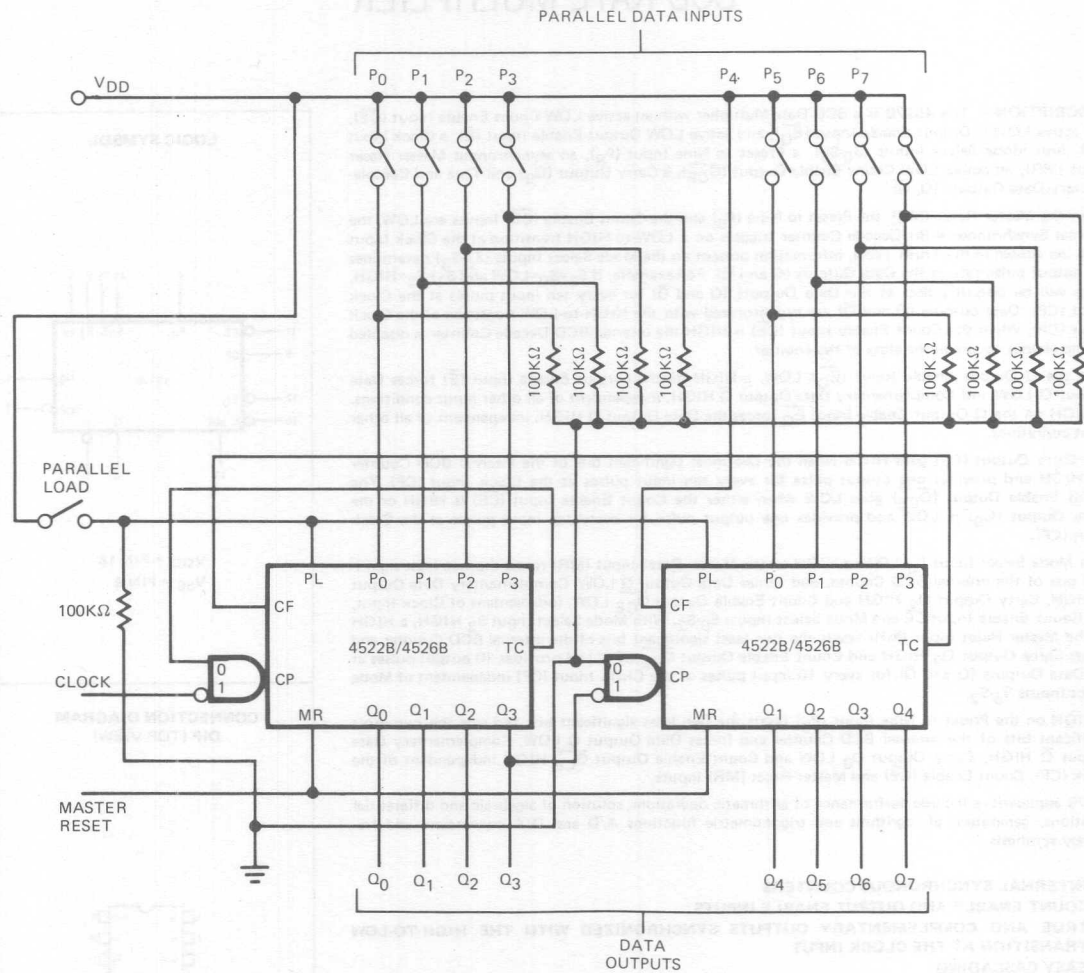
CONDITIONS: $\overline{CP_1}$ = LOW and the device triggers on a LOW-to-HIGH transition at CP₀. The timing also applies when CP₀ = HIGH and the device triggers on a HIGH-to-LOW transition at CP₁.

NOTE:

Set up and Hold Times are shown as positive values but may be specified as negative values.

TYPICAL APPLICATIONS

2-STAGE PROGRAMMABLE DOWN COUNTER



4527B

BCD RATE MULTIPLIER

DESCRIPTION — The 4527B is a BCD Rate Multiplier with an active LOW Count Enable Input (\overline{CE}), and active LOW Q Output Enable Input (\overline{EQ}), and active LOW Output Enable Input (\overline{E}), a Clock Input (CP), four Mode Select Inputs (S_0 - S_3), a Preset to Nine Input (P_9), an asynchronous Master Reset Input (MR), an active LOW Count Enable Output ($\overline{O_{CE}}$), a Carry Output (Q_9) and True and Complementary Data Outputs (Q, \overline{Q}).

When the Master Reset (MR), the Preset to Nine (P_9) and the Count Enable (\overline{CE}) Inputs are LOW, the internal Synchronous 4-Bit Decade Counter triggers on a LOW-to-HIGH transition at the Clock Input (CP). As shown in the Truth Table, information present on the Mode Select Inputs (S_0 - S_3) determines the output pulse rate at the Data Outputs (Q and \overline{Q}). For example, if S_3 - S_0 =LOW and S_1 - S_2 =HIGH, there will be output pulses at the Data Outputs (Q and \overline{Q}) for every ten input pulses at the Clock Input (CP). Data outputs (Q and \overline{Q}) are synchronized with the HIGH-to-LOW transition at the Clock Input (CP). When the Count Enable Input (\overline{CE}) is HIGH the internal BCD Decade Counter is disabled and no change occurs in the state of the counter.

With the Q Output Enable Input (\overline{EQ}) LOW, a HIGH on the Output Enable Input (\overline{E}) forces Data Output Q LOW and Complementary Data Output \overline{Q} HIGH, independent of all other input conditions. A HIGH on the Q Output Enable Input \overline{EQ} forces the Data Output Q HIGH, independent of all other input conditions.

The Carry Output (Q_9) goes HIGH when the two most significant bits of the internal BCD Counter are HIGH and provides one output pulse for every ten input pulses at the Clock Input (CP). The Count Enable Output ($\overline{O_{CE}}$) goes LOW when either the Count Enable Input (\overline{CE}) is HIGH or the Carry Output (Q_9) is LOW and provides one output pulse for every ten input pulses at the Clock Input (CP).

With Mode Select Input S_3 LOW, a HIGH on the Master Reset Input (MR) resets the two least significant bits of the internal BCD Counter and forces Data Output Q LOW, Complementary Data Output \overline{Q} HIGH, Carry Output Q_9 HIGH and Count Enable Output $\overline{O_{CE}}$ LOW, independent of Clock Input, CP, Count Enable Input \overline{CE} and Mode Select Inputs S_0 - S_2 . With Mode Select Input S_3 HIGH, a HIGH on the Master Reset Input (MR) resets the two least significant bits of the internal BCD Counter and forces Carry Output Q_9 HIGH and Count Enable Output $\overline{O_{CE}}$ LOW and provides 10 output pulses at the Data Outputs (Q and \overline{Q}) for every 10 input pulses at the Clock Input (CP) independent of Mode Select Inputs S_0 - S_2 .

A HIGH on the Preset to Nine Input (P_9) resets the two least significant bits and sets the two most significant bits of the internal BCD Counter and forces Data Output Q LOW, Complementary Data Output \overline{Q} HIGH, Carry Output Q_9 LOW and Count Enable Output $\overline{O_{CE}}$ HIGH independent of the Clock (CP), Count Enable (\overline{CE}) and Master Reset (MR) inputs.

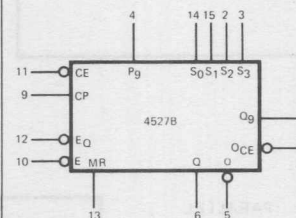
4527B applications include performance of arithmetic operations, solution of algebraic and differential equations, generation of logarithms and trigonometric functions A/D and D/A conversion, and frequency synthesis.

- INTERNAL SYNCHRONOUS COUNTERS
- COUNT ENABLE AND OUTPUT ENABLE INPUTS
- TRUE AND COMPLEMENTARY OUTPUTS SYNCHRONIZED WITH THE HIGH-TO-LOW TRANSITION AT THE CLOCK INPUT
- EASY CASCADING
- MASTER RESET AND PRESET TO NINE INPUTS

PIN NAMES

\overline{CE}	Count Enable Input (Active LOW)
\overline{EQ}	Q Output Enable Input (Active LOW)
\overline{E}	Output Enable Input (Active LOW)
CP	Clock Input (L→H Triggered)
S_0 - S_3	Mode Select Inputs
P_9	Preset to Nine Input
MR	Master Reset Input
$\overline{O_{CE}}$	Count Enable Output (Active LOW)
Q_9	Carry Output
Q	Data Output
\overline{Q}	Complementary Data Output (Active LOW)

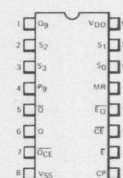
LOGIC SYMBOL



VDD = PIN 16

VSS = PIN 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

TRUTH TABLE

INPUTS										OUTPUTS			
										OUTPUT LOGIC LEVEL OR NUMBER OF OUTPUT PULSES			
S ₃	S ₂	S ₁	S ₀	NUMBER OF CLOCK PULSES ON INPUT CP	\overline{CE}	\overline{E}	\overline{EQ}	MR	P ₉	Q	\overline{Q}	Q ₉	$\overline{O_{CE}}$
L	L	L	L	10	L	L	L	L	L	L	H	1	1
L	L	L	H	10	L	L	L	L	L	1	1	1	1
L	L	H	L	10	L	L	L	L	L	2	2	1	1
L	L	H	H	10	L	L	L	L	L	3	3	1	1
L	H	L	L	10	L	L	L	L	L	4	4	1	1
L	H	L	H	10	L	L	L	L	L	5	5	1	1
L	H	H	L	10	L	L	L	L	L	6	6	1	1
L	H	H	H	10	L	L	L	L	L	7	7	1	1
H	L	L	L	10	L	L	L	L	L	8	8	1	1
H	L	L	H	10	L	L	L	L	L	9	9	1	1
H	L	H	L	10	L	L	L	L	L	8	8	1	1
H	L	H	H	10	L	L	L	L	L	9	9	1	1
H	H	L	L	10	L	L	L	L	L	8	8	1	1
H	H	L	H	10	L	L	L	L	L	9	9	1	1
H	H	H	L	10	L	L	L	L	L	8	8	1	1
H	H	H	H	10	L	L	L	L	L	9	9	1	1
X	X	X	X	10	H	L	L	L	L	*	*	*	*
X	X	X	X	10	L	H	L	L	L	L	H	1	1
X	X	X	X	10	L	L	H	L	L	H	**	1	1
H	X	X	X	10	L	L	L	H	L	10	10	H	L
L	X	X	X	10	L	L	L	H	L	L	H	H	L
X	X	X	X	10	L	L	L	L	H	L	H	L	H

L = LOW level

H = HIGH level

X = Don't Care

* Output Logic Level Depends upon the Internal State of the Counter

** Output is the same as the first 16 lines of the Truth Table with the number of Output pulses depending upon the logic levels at inputs S₀-S₃

4528B

DUAL RETRIGGERABLE RESETTABLE MONOSTABLE MULTIVIBRATOR

DESCRIPTION — The 4528B is a Dual Retriggerable Resettable Monostable Multivibrator. Each Multivibrator has an active LOW Input ($\overline{I_0}$), an active HIGH Input (I_1), an active LOW Clear Direct Input ($\overline{C_D}$), an Output (Q), its Complement (\overline{Q}) and two pins for connecting the external timing components (C_{ext} , C_{ext}/R_{ext}). An external timing capacitor must be connected between C_{ext} and C_{ext}/R_{ext} and an external resistor must be connected between C_{ext}/R_{ext} and V_{DD} .

A HIGH-to-LOW transition on the $\overline{I_0}$ Input when the I_1 Input is LOW or a LOW-to-HIGH transition on the I_1 Input when the $\overline{I_0}$ Input is HIGH produces a positive pulse (L \rightarrow H \rightarrow L) on the Q Output and a negative pulse (H \rightarrow L \rightarrow H) on the \overline{Q} Output if the Clear Direct Input ($\overline{C_D}$) is HIGH. A LOW on the Clear Direct Input ($\overline{C_D}$) forces the Q Output LOW, the \overline{Q} Output HIGH and inhibits any further pulses until the Clear Direct Input ($\overline{C_D}$) is HIGH.

- RECOMMENDED OPERATING VOLTAGE, $V_{DD} = 4.5$ TO 15 V
- TYPICAL OUTPUT PULSE WIDTH VARIATION $\pm 3\%$ AT $V_{DD} = 15$ V FROM DEVICE TO DEVICE
- TYPICAL OUTPUT PULSE WIDTH STABILITY $\pm 1\%$ OVER -40°C TO $+85^\circ\text{C}$ TEMPERATURE RANGE AT $V_{DD} = 10$ V
- TYPICAL OUTPUT PULSE WIDTH STABILITY $\pm 1\%$ AT $V_{DD} = 10$ V ± 0.25 V RESETTABLE
- TRIGGER ON EITHER A HIGH-TO-LOW TRANSITION ON $\overline{I_0}$ OR A LOW-TO-HIGH TRANSITION ON I_1
- COMPLEMENTARY OUTPUTS AVAILABLE
- BROAD TIMING RESISTOR RANGE, $5\text{ k}\Omega$ TO $2\text{ M}\Omega$
- OUTPUT PULSE WIDTH INDEPENDENT OF DUTY CYCLE WITH A WIDE 26 ns TO ∞ RANGE

PIN NAMES

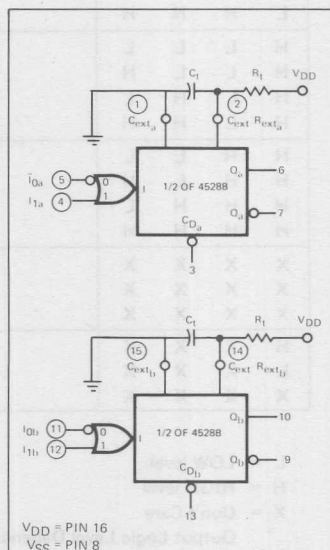
$\overline{I_{0a}}$, $\overline{I_{0b}}$
 I_{1a} , I_{1b}
 $\overline{C_{Da}}$, $\overline{C_{Db}}$
 Q_a , Q_b
 $\overline{Q_a}$, $\overline{Q_b}$
 C_{exta} , C_{extb}
 C_{ext}/R_{exta} , C_{ext}/R_{extb}

Input (H \rightarrow L Triggered)
 Input (L \rightarrow H Triggered)
 Clear Direct (Active LOW) Input
 Output
 Complimentary (Active LOW) Output
 External Capacitor Connections
 External Capacitor/Resistor Connections

TRUTH TABLE

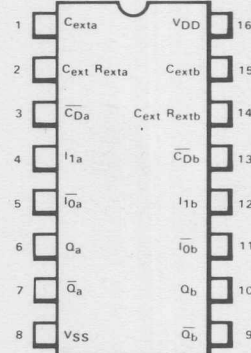
$\overline{I_0}$	I_1	$\overline{C_D}$	OPERATION
H \rightarrow L	L	H	Trigger
H	L \rightarrow H	H	Trigger
X	X	L	Reset

H = HIGH Level
 L = LOW Level
 H \rightarrow L = HIGH-to-LOW Transition
 L \rightarrow H = LOW-to-HIGH Transition
 X = Don't Care



V_{DD} = PIN 16
 V_{SS} = PIN 8

CONNECTION DIAGRAM DIP (TOP VIEW)

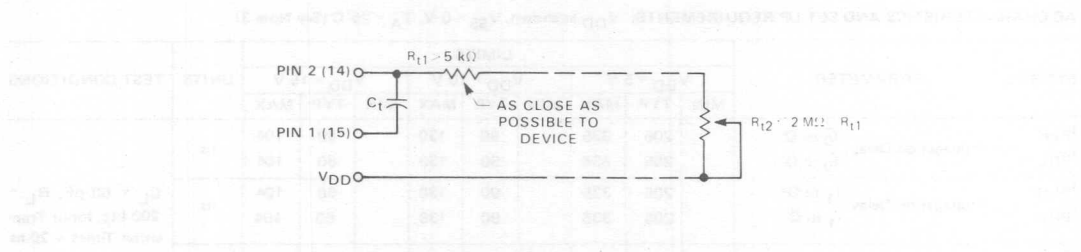


NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

OPERATING RULES

Timing

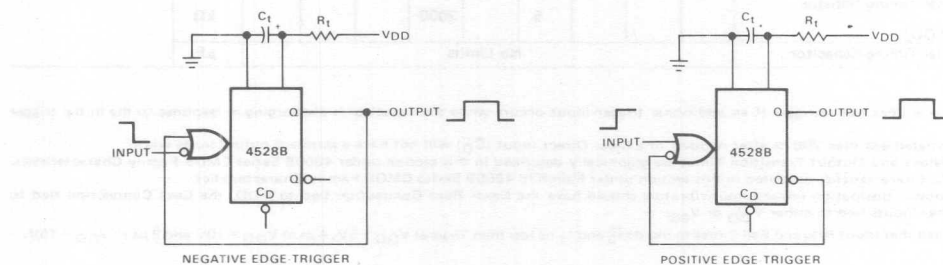
1. An external resistor (R_t) and external capacitor (C_t) are required as shown in the Logic Diagram. The value of R_t may vary from $5\text{ k}\Omega$ to $2\text{ M}\Omega$.
2. The value of C_t may vary from 0 to any necessary value available. If, however, the capacitor has significant leakage relative to V_{DD}/R_t the timing diagrams may not represent the pulse width obtained.
3. Polarized capacitors may be used directly. The (+) terminal of a polarized capacitor is connected to pin 2 (14) and the (-) terminal to pin 1 (15). Pin 2 (14) will remain positive with respect to pin 1 (15).
4. The output pulse width can be determined from the pulse width versus C_t or R_t graphs (Figures 1 and 2).
5. To obtain variable pulse width by remote trimming, the following circuit is recommended:



6. Under any operating condition, C_t and R_t (min) must be kept as close to the circuit as possible to minimize stray capacitance and reduce noise pickup.
7. V_{DD} and ground wiring should conform to good high frequency standards so that switching transients on V_{DD} and ground pins do not cause interaction between one shots. Use of a 0.01 to $0.1\text{ }\mu\text{F}$ bypass capacitor between V_{DD} and ground located near the 4528B is recommended.
8. To minimize noise problems, it is recommended that pin 1 and pin 15 be tied externally to V_{SS} .

Triggering

1. The minimum negative pulse width into $\overline{I_0}$ is 32 ns at $V_{DD} = 10\text{ V}$ and the minimum positive pulse width into I_1 is 32 ns at $V_{DD} = 10\text{ V}$.
2. When non-retriggerable operation is required, *i.e.*, when input triggers are to be ignored during a quasi-stable state, input latching is used to inhibit retriggering. The device does not retrigger if an additional trigger input occurs while the capacitor is discharging in response to the initial trigger input.



3. An overriding active LOW level Clear Direct ($\overline{C_D}$) is provided on each multivibrator. By applying a LOW to the $\overline{C_D}$, any timing cycle can be terminated or any new cycle inhibited until the LOW Clear Input is removed. Trigger inputs will not produce spikes in the output when the Clear Direct Input is held LOW. A new cycle initiated less than 200 ns after removal of a Clear Direct Input ($\overline{C_D}$) will not have a standard output pulse width.

SYMBOL	PARAMETER		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V			UNITS	TEMP	TEST CONDITIONS
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μ A	MIN. 25°C	Cext/Rext = V _{DD} All other inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply	XM			5			10			20	μ A	MIN. 25°C	
	Current				150			300			600		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, V_{SS} = 0 V, T_A = 25°C (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, I ₀ to Q		205	335		90	130		60	104	ns	C _L = 50 pF, R _L = 200 kΩ, Input Transition Times ≤ 20 ns R _t = 5 kΩ to 2 MΩ Any C _t
t _{PHL}			205	335		90	130		60	104		
t _{PLH}	Propagation Delay, I ₁ to Q		205	335		90	130		60	104	ns	
t _{PHL}			205	335		90	130		60	104		
t _{PLH}	Propagation Delay, C _D to Q		145	230		60	85		40	68	ns	
t _{PHL}			145	230		60	85		40	68		
t _{TLH}	Output Transition Time		70	135		32	70		22	45	ns	
t _{THL}			70	135		32	70		22	45		
t _{rec}	C _D Recovery Time (Note 1)	-50	-90		-20	-37		0	-25		ns	
t _{W0}	I ₀ Minimum Pulse Width (LOW)	70	45		32	24		26	20		ns	
t _{W1}	I ₁ Minimum Pulse Width (HIGH)	70	45		32	24		26	20		ns	
t _{WC_D}	C _D Minimum Pulse Width	65	45		32	26		26	21		ns	
t _{WQ}	Q Minimum Output Pulse Width		300	500		200	400		150	300	ns	
t _{WQ}	Q Output Pulse Width	R _t = 5 kΩ, C _t = 15 pF									μs	
		4.35	6.25	8	4	5.3	6.6	4	5	6		
		R _t = 10 kΩ, C _t = 1000 pF										
Δt	Change in Q Output Pulse Width over Temperature		±2	±10		±1	±7		±1	±5	%	
Δt	Change in Q Output Pulse Width over V _{DD}	T _A = -40°C to +85°C									%	
			±2	±4		±1	±2		±1	±2		
		V _{DD} = 5 V ±.25 V			V _{DD} = 10 V ±.25 V			V _{DD} = 15 V ±.25 V				
t _s	Set-Up Time, C _D to I ₀ or I ₁ (To prevent change in output)	20	5		-25	-45		-25	-35		ns	
R _t	External Timing Resistor Any V _{DD}				5		2000				kΩ	
C _t	External Timing Capacitor	No Limits									μF	

Notes:

1. The 4528B device does not retrigger if an additional trigger input occurs while the capacitor is discharging in response to the initial trigger input.
2. A new cycle initiated less than 200 ns after removal of a Clear Direct Input (\bar{C}_D) will not have a standard output pulse width.
3. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
4. Additional D. C. Characteristics are listed in this section under Fairchild 4000B Series CMOS Family Characteristics.
5. To minimize power dissipation unused multivibrators should have the Cext/ Rext Connection tied to V_{DD}, the Cext Connection tied to V_{SS} and all other inputs tied to either V_{DD} or V_{SS}.
6. It is recommended that Input Rise and Fall Times to inputs I₀ and I₁ be less than 15 μ s at V_{DD} = 5V, 4 μ s at V_{DD} = 10V and 3 μ s at V_{DD} = 15V.

TYPICAL ELECTRICAL CHARACTERISTICS

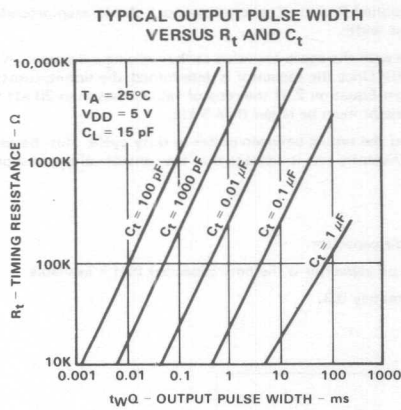


FIGURE 1.

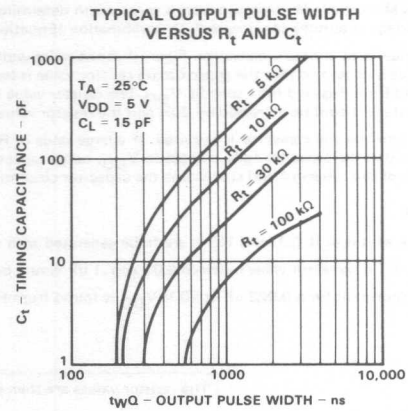
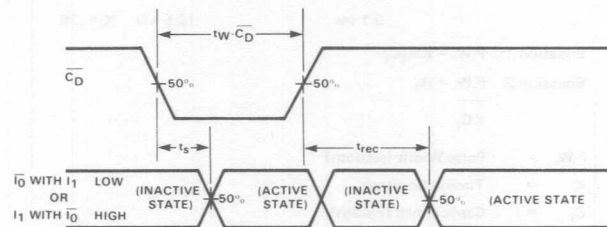
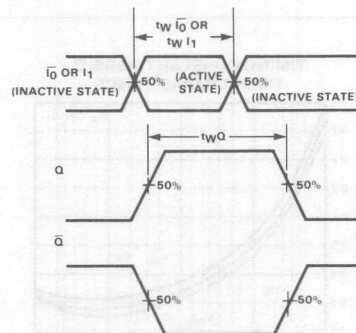


FIGURE 2.

AC WAVEFORMS



Set-up Time, $\overline{C_D}$ to $\overline{I_0}$ or I_1 . Recovery Time for $\overline{C_D}$ and Minimum $\overline{C_D}$ Pulse Width.



Minimum $\overline{I_0}$ or I_1 Pulse Width and Minimum Output Pulse Width.

NOTE: Set-up Time and Recovery Time are shown as Positive values, but may specified as Negative values.

APPLICATIONS

The 4528B Monostable Multivibrator has its pulse width determined by an externally supplied Resistor-Capacitor network. A two step procedure is suggested for determining the proper $R_t C_t$ combination (Equation 1) for a specific pulse width.

The first step is to choose a capacitor. Figure 1 shows pulse width versus resistor value with the capacitor value as the running parameter. A capacitor value is chosen so that the approximate resistor value is between 20 k Ω and 2 M Ω . Once the capacitor is determined, the timing constant (K) is found from Figure 3 for a specific V_{DD} . The resistor value is then determined from Equation 2. If the resistor value is less than 20 k Ω the timing constant should be increased by 20% and the resistor value re-calculated. The resistor must be larger than 5 k Ω .

No upper limit on the capacitor is required. If a large value of R_t and C_t are to be used the timing between pulses or duty cycle, must be sufficiently low that the capacitor fully charges to V_{DD} . Large capacitor values must be sufficiently low in leakage that the resistor value can supply the leakage of the capacitor and still charge the capacitor close to V_{DD} .

EXAMPLE:

Three pulse widths of 0.1, 1, and 10 ms are to be generated with the 4528B using a single capacitor.

From Figure 1 a capacitor value between 0.01 and .1 μ F would be reasonable. A 0.022 μ F capacitor is the only capacitor that is available.

The timing constant for a 0.022 μ F at 10 V V_{DD} is found from Figure 3 to be approximately 0.3.

The resistor values are then calculated:

Pulse Width	R_t
0.1 ms	15.1 k Ω
1 ms	151.1 k Ω
10 ms	1.51 M Ω

The 15.1 k Ω is less than 20 k Ω so add 20% to the K value and recalculate

Pulse Width	R_t	K = .36
0.1 ms	12.5 k Ω	

Equation 1: $P.W. = K R_t C_t$

Equation 2: $P.W. = \frac{R_t}{K C_t}$

P.W. = Pulse Width (seconds)

K = Timing Constant

C_t = Capacitance (Farads)

R_t = Resistance (ohms)

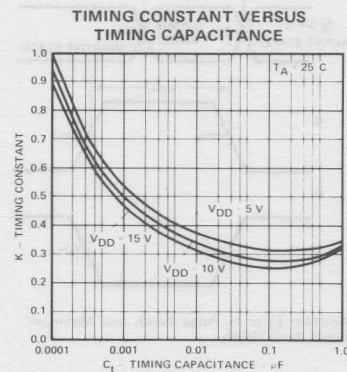


Fig. 3.

4531B

13-INPUT PARITY CHECKER GENERATOR

DESCRIPTION — The 4531B is a 13-Input Parity Checker/Generator with 13 Parity Inputs (I_0 - I_{12}) and a Parity Output (Z). When the number of Parity Inputs that are HIGH is even, the Output (Z) is LOW. When the number of Parity Inputs that are HIGH is odd, the Output (Z) is HIGH. For words of 12 bits or less, the Output (Z) can be used to generate either odd or even parity by appropriate termination of the unused Parity Input (s). For words of 14 or more bits, the devices can be cascaded by connecting the output (Z) of one device to any Parity Input (I_0 - I_{12}) of another device. When cascading devices, it is recommended that the Output (Z) of one device be connected to the I_{12} input of the other device since there is less delay to the Output (Z) from the I_{12} input than from any other Input (I_0 - I_{11}).

- VARIABLE WORD LENGTH
- FULLY BUFFERED OUTPUT (ACTIVE HIGH)
- PARITY INPUTS (ACTIVE HIGH)

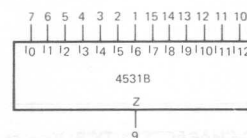
PIN NAMES	FUNCTION
I_0 - I_{12}	Parity Inputs
Z	Buffered Output

TRUTH TABLE

INPUTS													OUTPUT
I_0	I_1	I_2	I_3	I_4	I_5	I_6	I_7	I_8	I_9	I_{10}	I_{11}	I_{12}	Z
All Thirteen Inputs LOW													L
Any One Input HIGH													H
Any Two Inputs HIGH													L
Any Three Inputs HIGH													H
Any Four Inputs HIGH													L
Any Five Inputs HIGH													H
Any Six Inputs HIGH													L
Any Seven Inputs HIGH													H
Any Eight Inputs HIGH													L
Any Nine Inputs HIGH													H
Any Ten Inputs HIGH													L
Any Eleven Inputs HIGH													H
Any Twelve Inputs HIGH													L
All Thirteen Inputs HIGH													H

L = LOW Level
H = HIGH Level

LOGIC SYMBOL

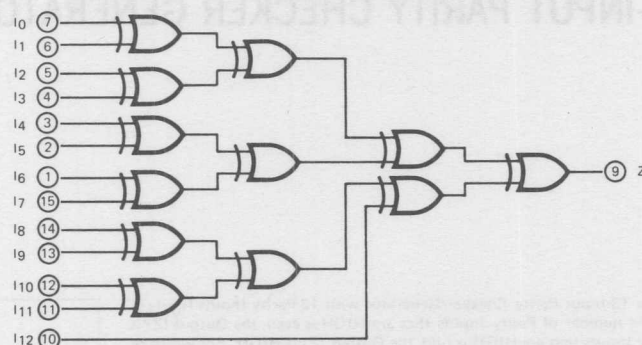


V_{DD} = Pin 16
 V_{SS} = Pin 8

**CONNECTION DIAGRAM
DIP (TOP VIEW)**



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.



V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Number

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power Supply Current	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
		XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, I ₀ -I ₁₁ to Z		195	500		80	225		55	180	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			195	500		80	225		55	180	ns	
t _{PLH}	Propagation Delay, I ₁₂ to Z		115	300		50	135		35	109	ns	
t _{PHL}			115	300		50	135		35	109	ns	
t _{TLH}	Output Transition Time		65	135		35	75		15	45	ns	
t _{THL}			65	135		35	75		15	45	ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

4532B

8-INPUT PRIORITY ENCODER

DESCRIPTION — The 4532B is an 8-Input Priority Encoder with eight active HIGH Priority Inputs (I_0 - I_7), three active HIGH Address Outputs (A_0 - A_2), an active HIGH Enable Input (E_{In}), an active HIGH Enable Output (E_{Out}) and an active HIGH Group Select Output (GS).

Data is accepted on the eight Priority Inputs (I_0 - I_7). The binary code corresponding to the highest Priority Input (I_0 - I_7) which is HIGH is generated on the Address Outputs (A_0 - A_2) if the Enable Input (E_{In}) is HIGH. Priority Input I_7 is assigned the highest priority. The Group Select output (GS) is HIGH when one or more Priority Inputs (I_0 - I_7) and the Enable Input (E_{In}) are HIGH. The Enable Output (E_{Out}) is HIGH when all the Priority Inputs (I_0 - I_7) are LOW and the Enable Input (E_{In}) is HIGH. The Enable Input (E_{In}) when LOW, forces all Outputs (A_0 - A_2 , GS, E_{Out}) LOW.

- ACTIVE HIGH PRIORITY INPUTS
- CASCADABLE

PIN NAMES

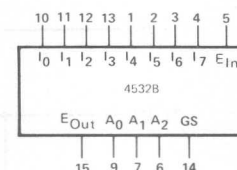
I_0 - I_7	Priority Inputs
E_{In}	Enable Input
E_{Out}	Enable Output
GS	Group Select Output
A_0 - A_2	Address Outputs

TRUTH TABLE

INPUTS									OUTPUTS				
E_{In}	I_7	I_6	I_5	I_4	I_3	I_2	I_1	I_0	GS	A_2	A_1	A_0	E_{Out}
L	X	X	X	X	X	X	X	X	L	L	L	L	L
H	L	L	L	L	L	L	L	L	L	L	L	L	H
H	H	X	X	X	X	X	X	X	H	H	H	H	L
H	L	H	X	X	X	X	X	X	H	H	H	L	L
H	L	L	H	X	X	X	X	X	H	H	L	H	L
H	L	L	L	H	X	X	X	X	H	H	L	L	L
H	L	L	L	L	H	X	X	X	H	L	H	H	L
H	L	L	L	L	L	H	X	X	H	L	L	H	L
H	L	L	L	L	L	L	H	X	H	L	L	H	L
H	L	L	L	L	L	L	L	H	H	L	L	L	L

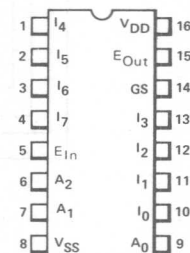
X = Don't Care (Either HIGH or LOW)
L = LOW Level
H = HIGH Level

LOGIC SYMBOL



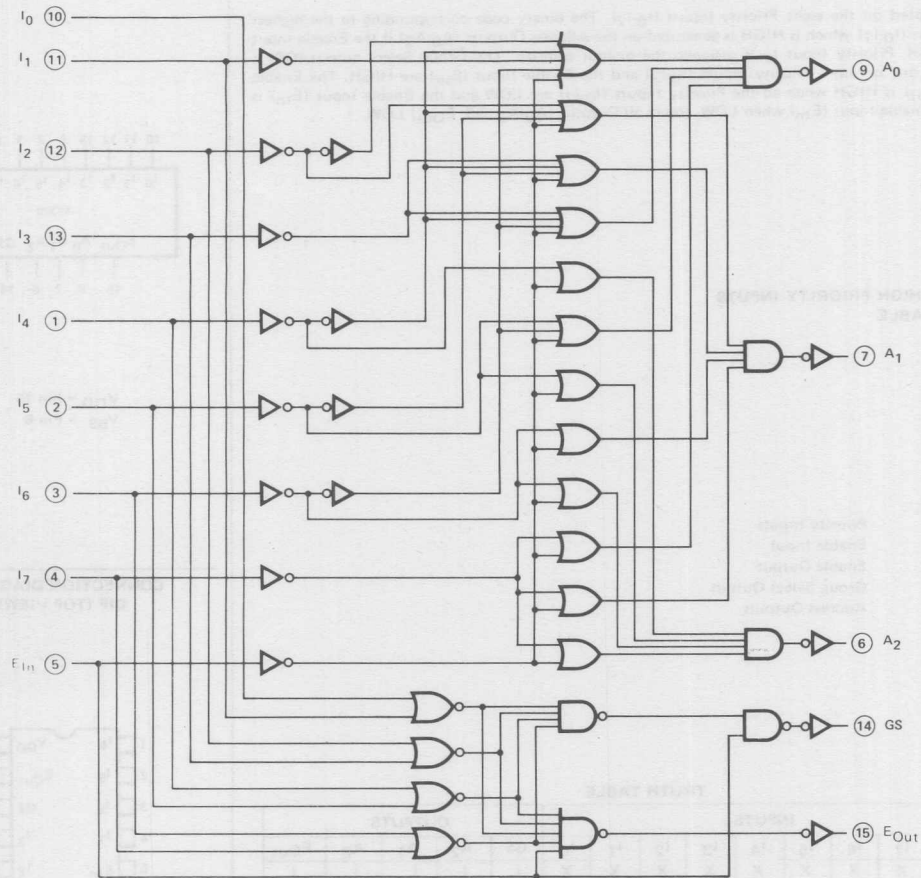
V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Number

FAIRCHILD CMOS • 4532B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMIT									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH} t _{PHL}	Propagation Delay, E _I n to E _O ut		85 85	200 200		45 45	90 90		35 35	70 70	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PLH} t _{PHL}	Propagation Delay, E _I n to G _S		65 65	150 150		35 35	70 70		25 25	56 56	ns	
t _{PLH} t _{PHL}	Propagation Delay, E _I n to A _n		70 70	200 200		35 35	90 90		30 30	70 70	ns	
t _{PLH} t _{PHL}	Propagation Delay, I _n to A _n		70 70	200 200		35 35	90 90		30 30	70 70	ns	
t _{PLH} t _{PHL}	Propagation Delay, I _n to G _S		75 70	200 200		40 35	90 90		31 28	70 70	ns	
t _{TLH} t _{THL}	Output Transition Time		65 65	135 135		35 35	75 75		15 15	45 45	ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

4534B

REAL TIME 5-DECADE COUNTER

DESCRIPTION — The 4534B is a Real Time 5-Decade Counter. Consisting of five BCD Ripple Counters with their respective outputs multiplexed via a non-chip Scan Counter and a Quad 5-Input Multiplexer. Select Inputs (S_0 and S_1) and the associated control logic provide for four different modes of operation as shown in the Mode Selection Table. An error detection circuit with programmable time delay is also included to facilitate input signal diagnostics. The 4534B is specifically designed for applications in real time or event counters where continual updating and multiplexed displays are used.

The 5-Decade BCD Ripple Counter advances on a LOW-to-HIGH transition at the Clock Input (CP). An error detection circuit searches for a logic transition on Clock Input \overline{CP} that is complementary to the logic transition on Clock Input CP. Whenever, a LOW-to-HIGH transition at CP is not accompanied by a HIGH-to-LOW transition at \overline{CP} (or vice-versa) within a time period determined by the external timing capacitor (C_X) an error is counted by the error detection circuitry. Three such errors force the Error Output (O_E) HIGH. If error detection is not required, Clock Input \overline{CP} must be tied to either V_{DD} or V_{SS} and External Capacitor Connections, C_{X1} and C_{X2} , and Error Output, O_E must be left open.

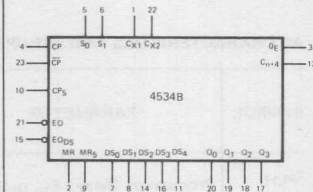
Data Outputs from the five BCD Ripple Counters are fed into a Quad 5-Input Multiplexer. The Scan Counter advances on a LOW-to-HIGH transition at the Scan Counter Clock Input (CP_S). Outputs from the Scan Counter feed into the multiplexer selecting, in turn, one of the five BCD digits for time multiplexing to the BCD Counter Outputs (Q_0 - Q_3). Digit Select Outputs (DS_0 - DS_4) from the Scan Counter are also available to indicate the selected digit. A HIGH on the Output Enable Input (\overline{EO}) forces the BCD Counter Outputs (Q_0 - Q_3) to assume a high impedance or "OFF" state, regardless of other input conditions. A HIGH on the Digit Select Output Enable Input (\overline{EO}_{DS}) forces the Digit Select Outputs (DS_0 - DS_4) to assume a high impedance or "OFF" state, regardless of other input conditions. A Ripple Carry Output (C_{n+4}) from BCD Ripple Counter 4 allows for easy cascading. Input C_{n+4} is HIGH for a single clock period when the outputs from all five BCD Ripple Counters are LOW or when the BCD Counter Master Reset Input (MR) is HIGH. A HIGH on the MR input resets all five BCD Ripple Counters ($Q_0 = Q_1 = Q_2 = Q_3 = \text{LOW}$) and initializes all Error Detection ($O_E = \text{LOW}$) and Control Logic independent of all other input conditions. A HIGH on the Scan Counter Master Reset Input (MR_S) resets the Scan Counter ($DS_0 = DS_1 = DS_2 = DS_3 = \text{LOW}$ and $DS_4 = \text{HIGH}$) independent of all other inputs.

- 5-DECADE COUNTER WITH DIGIT MULTIPLEXING TO THE OUTPUT
- FOUR OPERATING MODES
- ERROR DETECTION CIRCUIT
- 3-STATE OUTPUT ENABLES FOR BOTH DIGIT SELECT AND BCD COUNTER OUTPUTS
- ASYNCHRONOUS MASTER RESET FOR BOTH BCD AND SCAN COUNTERS
- FULLY CASCADABLE

PIN NAMES

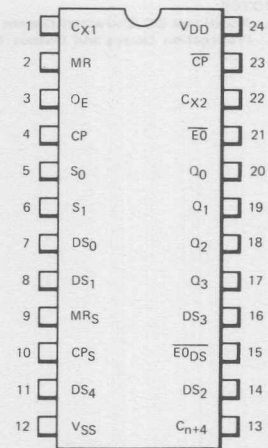
S_0, S_1	Mode Select Inputs
CP, \overline{CP}	True and Complementary BCD Counter Clock Inputs
CP_S	Scan Counter Clock Input
\overline{EO}	Output Enable (Active LOW) Input
\overline{EO}_{DS}	Digit Select Output Enable (Active LOW) Input
MR	BCD Counter Master Reset Input
MR_S	Scan Counter Master Reset Input
C_{X1}, C_{X2}	External Capacitor Connections
O_E	Error Output
C_{n+4}	Ripple Carry Output
DS_0 - DS_4	Digit Select Outputs
Q_0 - Q_3	BCD Counter Outputs

LOGIC SYMBOL



V_{DD} = PIN 24
 V_{SS} = PIN 12

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

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4538B

DUAL RETRIGGERABLE RESETTABLE MONOSTABLE MULTIVIBRATOR

DESCRIPTION — The 4538B is a Dual Precision Retriggerable Resettable Monostable Multivibrator. Each Multivibrator has an active LOW Input ($\overline{I_0}$), an active HIGH Input (I_1), an active LOW Clear Direct Input ($\overline{C_D}$), an Output (Q), its Complement (\overline{Q}) and two pins for connecting the external timing components (C_{ext} , C_{ext}/R_{ext}). An external timing capacitor must be connected between C_{ext} and C_{ext}/R_{ext} and an external resistor must be connected between C_{ext}/R_{ext} and V_{DD} .

A HIGH-to-LOW transition on the $\overline{I_0}$ Input when the I_1 Input is LOW or a LOW-to-HIGH transition on the I_1 Input when the $\overline{I_0}$ Input is HIGH produces a positive pulse ($L \rightarrow H \rightarrow L$) on the Q Output and a negative pulse ($H \rightarrow L \rightarrow H$) on the \overline{Q} Output if the Clear Direct Input ($\overline{C_D}$) is HIGH. A LOW on the Clear Direct Input ($\overline{C_D}$) forces the Q Output LOW, the \overline{Q} Output HIGH and inhibits any further pulses until the Clear Direct Input ($\overline{C_D}$) is HIGH.

- RECOMMENDED OPERATING VOLTAGE, $V_{DD} = 4.5$ TO 15 V
- TYPICAL OUTPUT PULSE WIDTH VARIATION $\pm 0.5\%$ AT $V_{DD} = 15$ V FROM DEVICE TO DEVICE
- TYPICAL OUTPUT PULSE WIDTH STABILITY $\pm 0.5\%$ OVER -40°C TO $+85^\circ\text{C}$ TEMPERATURE RANGE AT $V_{DD} = 10$ V
- TYPICAL OUTPUT PULSE WIDTH STABILITY $\pm 0.5\%$ AT $V_{DD} = 10$ V ± 0.25 V
- RESETTABLE
- TRIGGER ON EITHER A HIGH-TO-LOW TRANSITION ON $\overline{I_0}$ OR A LOW-TO-HIGH TRANSITION ON I_1
- COMPLEMENTARY OUTPUTS AVAILABLE
- OUTPUT PULSE WIDTH INDEPENDENT OF DUTY CYCLE

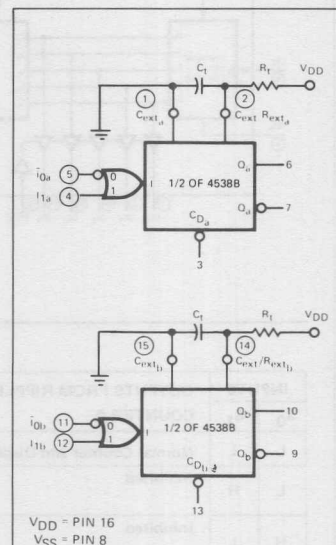
PIN NAMES

$\overline{I_0a}$, $\overline{I_0b}$	Input (H \rightarrow L Triggered)
I_1a , I_1b	Input (L \rightarrow H Triggered)
$\overline{C_Da}$, $\overline{C_Db}$	Clear Direct (Active LOW) Input
Qa , Qb	Output
\overline{Qa} , \overline{Qb}	Complementary (Active LOW) Output
C_{exta} , C_{extb}	External Capacitor Connections
C_{ext}/R_{exta} , C_{ext}/R_{extb}	External Capacitor/Resistor Connections

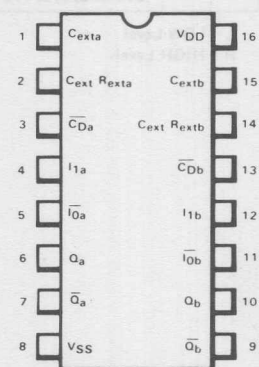
TRUTH TABLE

$\overline{I_0}$	I_1	$\overline{C_D}$	OPERATION
H \rightarrow L	L	H	Trigger
H	L \rightarrow H	H	Trigger
X	X	L	Reset

H = HIGH Level
L = LOW Level
H \rightarrow L = HIGH-to-LOW Transition
L \rightarrow H = LOW-to-HIGH Transition
X = Don't Care



CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

4539B

DUAL 4-INPUT MULTIPLEXER

DESCRIPTION — The 4539B is a Dual 4-Input Digital Multiplexer with common select logic. Each multiplexer has four Multiplexer Inputs (I_0 - I_3), an active LOW Enable Input (\bar{E}) and a Multiplexer Output (Z). When HIGH, the Enable Input (\bar{E}) forces the Multiplexer Output (Z) of the respective multiplexer LOW, independent of the Select (S_0 , S_1) and Multiplexer (I_0 - I_3) Inputs. With the Enable Input (\bar{E}) LOW, the common Select Inputs (S_0 , S_1) determine which Multiplexer Input (I_0 - I_3) on each of the multiplexers is routed to the respective Multiplexer Output (Z).

- COMMON SELECT LOGIC
- ACTIVE LOW ENABLES

PIN NAMES

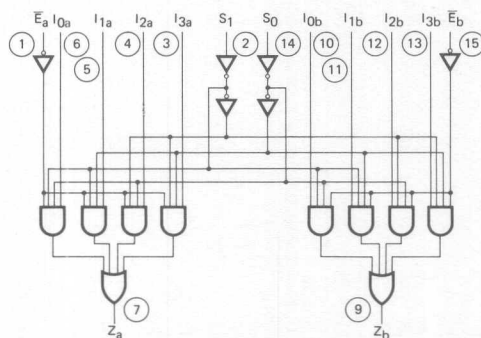
I_{0a} , I_{1a} , I_{2a} , I_{3a}	Multiplexer Inputs
I_{0b} , I_{1b} , I_{2b} , I_{3b}	Multiplexer Inputs
S_0 , S_1	Select Inputs
\bar{E}_a , \bar{E}_b	Enable Inputs (Active LOW)
Z_a , Z_b	Multiplexer Outputs

TRUTH TABLE

INPUTS			OUTPUT
S_0	S_1	\bar{E}	Z
X	X	H	L
L	L	L	I_0
L	H	L	I_1
H	L	L	I_2
H	H	L	I_3

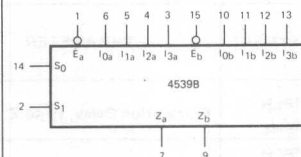
H = HIGH Level
L = LOW Level
X = Don't Care

LOGIC DIAGRAM



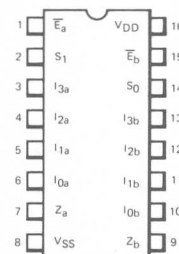
V_{DD} = Pin 16
 V_{SS} = Pin 8
○ = Pin Number

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, V_{SS} = 0 V, T_A = 25°C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, I _X to Z		166	375		71	160		51	125	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			140	350		58	140		40	110		
t _{PLH}	Propagation Delay, Select to Z		210	470		88	190		62	150	ns	
t _{PHL}			210	470		88	190		62	150		
t _{PLH}	Propagation Delay, \bar{E} to Z		120	275		53	110		37	85	ns	
t _{PHL}			118	275		51	110		38	85		
t _{TLH}	Output Transition Time		76	135		39	75		29	45	ns	
t _{THL}			66	135		30	75		22	45		

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

4543B

BCD TO 7-SEGMENT LATCH/DECODER/DRIVER FOR LIQUID CRYSTALS

DESCRIPTION — The 4543B is a BCD to 7-Segment Latch/Decoder/Driver for Liquid Crystal Displays with four Address Inputs (A_0 - A_3), a Latch Enable Input (EL), a Blanking Input (I_B), a Clock Control Input (CP), and seven Segment Outputs (a-g).

When the Latch Enable Input (EL) is HIGH, the state of the Segment Outputs (a-g) is determined by the data on the four Address Inputs (A_0 - A_3) and the Clock Control Input (CP). For driving Liquid Crystal Displays, a square wave must be applied to the CP input and to the electrically common backplane of the display. For common Cathode LED displays a LOW logic level must be applied to the CP input. For common anode LED displays a HIGH logic level must be applied to the CP input. When the Latch Enable Input (EL) goes LOW, the last data present at the address Inputs (A_0 - A_3) is stored in the latches and the Segment Outputs (a-g) remain stable.

A HIGH on the Blanking Input (I_B) forces all Segment Outputs (a-g) LOW. The Blanking Input (I_B) does not affect the latch circuit.

- **BLANKING INPUT**
- **MULTIPLEXING CAPABILITY**
- **LCD DISPLAY OR COMMON ANODE OR COMMON CATHODE LED DISPLAY CAPABILITY**
- **BLANKING ON ALL ILLEGAL INPUT COMBINATIONS**

PIN NAMES

A_0 - A_3	Address (Data) Inputs
EL	Latch Enable Input
I_B	Blanking Input
CP	Clock Control Input
a-g	Segment Outputs

TRUTH TABLE

INPUTS							OUTPUTS							DISPLAY
CP*	EL	I_B	A_3	A_2	A_1	A_0	a	b	c	d	e	f	g	
L	X	H	X	X	X	X	L	L	L	L	L	L	L	BLANK
L	H	L	L	L	L	L	H	H	H	H	H	H	L	0
L	H	L	L	L	L	H	L	H	H	L	L	L	L	1
L	H	L	L	L	H	L	H	H	L	H	H	L	H	2
L	H	L	L	L	H	H	L	H	H	H	L	L	H	3
L	H	L	L	H	L	L	L	H	H	L	L	H	H	4
L	H	L	L	H	L	H	H	L	H	H	L	H	H	5
L	H	L	L	H	H	L	H	L	H	H	H	H	H	6
L	H	L	L	H	H	H	L	H	H	H	L	L	L	7
L	H	L	H	L	L	L	H	H	H	H	H	H	H	8
L	H	L	H	L	L	H	H	H	H	H	L	H	H	9
L	H	L	H	L	H	L	L	L	L	L	L	L	L	BLANK
L	H	L	H	L	H	H	L	L	L	L	L	L	L	BLANK
L	H	L	H	H	L	L	L	L	L	L	L	L	L	BLANK
L	H	L	H	H	L	H	L	L	L	L	L	L	L	BLANK
L	H	L	H	H	H	L	L	L	L	L	L	L	L	BLANK
L	L	L	X	X	X	X	**							**
H	***	***	***				Inverse of the above Output Combinations							Display as Above

H = HIGH Level

L = LOW Level

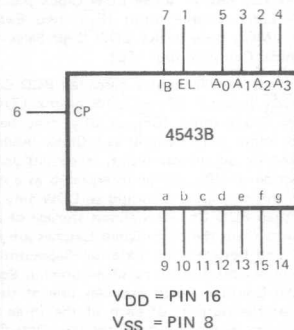
X = Don't Care

* = For Liquid Crystal displays a square wave is applied to CP. For common cathod Light Emitting Diode displays a LOW logic level is applied to CP. For common anode Light Emitting Diode displays a HIGH logic level is applied to CP.

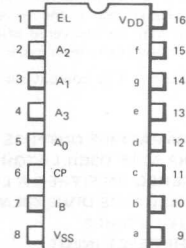
** = Depends upon the BCD Code applied during the HIGH-to-LOW transition of EL.

*** = The above combinations of logic levels.

LOGIC SYMBOL

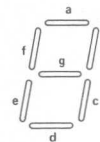


**CONNECTION DIAGRAM
DIP (TOP VIEW)**



Note: The flatpack version has the same pinouts (Connection Diagram) as the Dual In-Line Package.

NUMERICAL DESIGNATIONS



DISPLAY



4553B

3-DIGIT BCD COUNTER

FAIRCHILD CMOS LSI

DESCRIPTION — The 4553B is a 3-Digit Internally Synchronous BCD Counter with three synchronously cascaded BCD Counters, three Quad Latches, a Quad 3-Input Multiplexer, and an internal Scan Oscillator and Scan Counter for internal multiplexer selection.

The device has an active LOW Clock Input (\overline{CP}_0) and an active HIGH Clock Input (CP_1), an active LOW Latch Enable Input (\overline{E}_L), two External Capacitor Connections (C_{xa} , C_{xb}), a Master Reset Input (MR), three active LOW Digit Select Outputs (\overline{DSO}_0 - \overline{DSO}_2), four Data Outputs (Q_0 - Q_3) and a Terminal Count Output (TC).

The three synchronously cascaded BCD Counters advance on either the HIGH-to-LOW transition of the \overline{CP}_0 Input if CP_1 is LOW or the LOW-to-HIGH transition of the CP_1 Input if \overline{CP}_0 is HIGH. Either Clock Input (\overline{CP}_0 or CP_1) may be used as the Clock Input to the counters and the other Clock Input may be used as a Clock Inhibit Input provided certain constraints are observed. If CP_1 is used or an inhibit input, it should go HIGH while \overline{CP}_0 is LOW; otherwise, the LOW-to-HIGH transition of CP_1 will be interpreted as a clock and the counter will advance. Similarly, if \overline{CP}_0 is used as an inhibit input, it should go LOW only when CP_1 is HIGH. A Quad Latch at the output of each of the three BCD Counters allows storage of any given count with the Latch Enable Input (\overline{E}_L) HIGH. Outputs from the three Quad Latches are fed into a Quad 3-Input Multiplexer. An external capacitor (C_x) tied between the External Capacitor Connections (C_{xa} , C_{xb}) or an external clock tied to C_{xb} determines the frequency of an on-chip Scan Oscillator. The output of the Scan Oscillator is fed into a Scan Counter which provides one of three Select Inputs to the Quad 3-Input Multiplexer. Thus, data at the outputs of each of the three Quad Latches is internally time division multiplexed, providing one digit at a time at the four Data Outputs (Q_0 - Q_3). The frequency of the multiplex operation may be determined by either C_x or an external clock. Active LOW Digit Select Outputs (\overline{DSO}_0 - \overline{DSO}_2) are provided for display control. A Terminal Count Output (TC) is provided for cascading 4553B devices. TC is HIGH when the state of the counters is .999 ($Q_0 = Q_1 = Q_2 = Q_3 = TC = \text{LOW}$ for all BCD Counters), inhibits the Scan Oscillator and initializes the Scan Counter ($Q_0 = \text{HIGH}$, $Q_1 = Q_2 = \text{LOW}$) and forces all three Digit Select Outputs (\overline{DSO}_0 - \overline{DSO}_2) HIGH independent of all other input conditions. Information present in the three BCD Counters when the Latch Enable Input (\overline{E}_L) goes HIGH will be stored in the three Quad Latches independent of all other input conditions. This information may be recovered after a master reset provided the Latch Enable Input (\overline{E}_L) remains HIGH during the entire reset cycle.

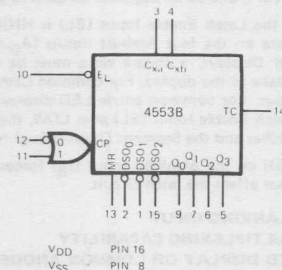
The 4553B offers TTL compatible output drive capabilities.

- TTL COMPATIBLE OUTPUTS
- ON-CHIP SCAN OSCILLATOR
- TRIGGERED ON EITHER A LOW-TO-HIGH OR A HIGH-TO-LOW TRANSITION
- INTERNAL TIME DIVISION MULTIPLEXING
- OUTPUT LATCHES
- MASTER RESET INPUT
- FULLY CASCADABLE

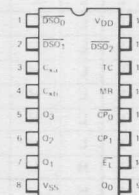
PIN NAMES

C_{xa} , C_{xb}	External Capacitor Connections
\overline{CP}_0	Clock Input (H→L Edge Triggered)
CP_1	Clock Input (L→H Edge Triggered)
\overline{E}_L	Latch Enable Input (Active LOW)
MR	Master Reset Input
\overline{DSO}_0 , \overline{DSO}_1 , \overline{DSO}_2	Digit Select Outputs (Active LOW)
Q_0 - Q_3	Data Outputs

LOGIC SYMBOL







CONNECTION DIAGRAM DIP (TOP VIEW)





NOTE:

The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

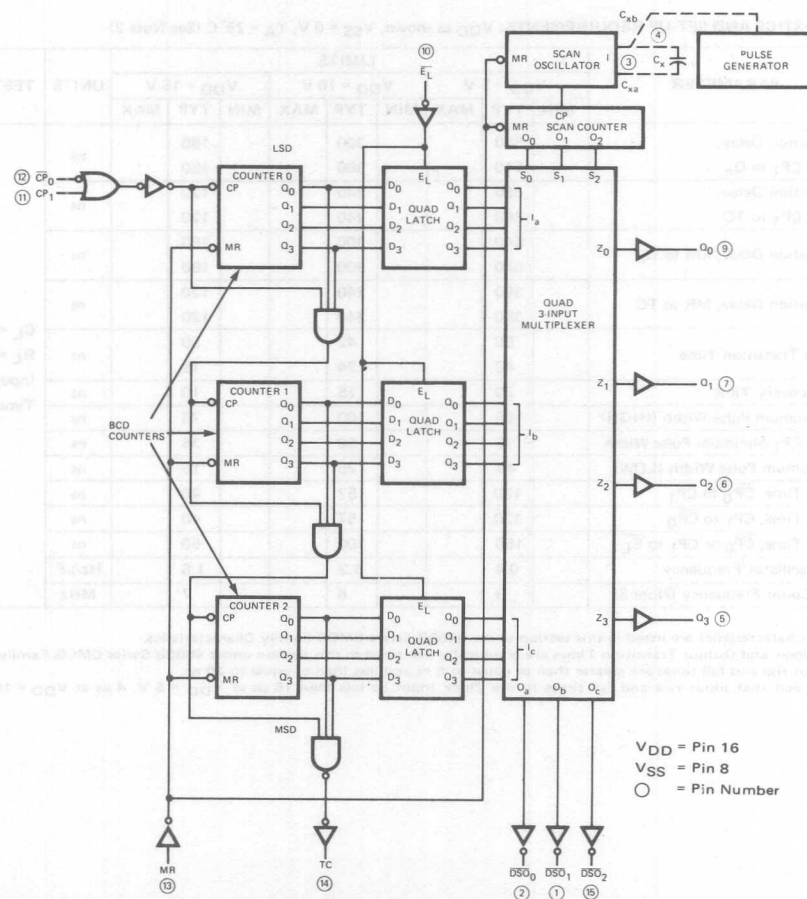
TRUTH TABLE

INPUTS				OUTPUTS
MR	$\overline{CP_0}$	CP_1	$\overline{E_L}$	Q_0-Q_3
L		L	L	NO CHANGE
L		L	L	COUNTER ADVANCES
L	X	H	X	NO CHANGE
L	H		L	COUNTER ADVANCES
L	H		L	NO CHANGE
L	L	X	X	NO CHANGE
L	X	X	H	LATCH NOT ENABLED
H	X	X	X	RESET ($Q_0-Q_3=LOW$)

H = HIGH Level
L = LOW Level
X = Don't Care

 = LOW-to-HIGH Transition
 = HIGH-to-LOW Transition

BLOCK DIAGRAM



DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OL}	Output LOW Current For All Outputs Except Cexta	XC	3.6			6			10			mA	MIN, 25°C	Inputs at V _{SS} or V _{DD} per the Logic Function or Truth Table, V _{OUT} = 0.4 V for V _{DD} = 5 V, V _{OUT} = 0.5 V for V _{DD} = 10 V, and V _{OUT} = 1.5 V for V _{DD} = 15 V
			2			3			8.4				MAX	
		XM	1.6			2.5			7				MIN, 25°C	
			3			6.2			19				MAX	
	Output LOW Current For Cexta	XC	2.5			5			15			mA	MIN, 25°C	
			1.6			3.5			10				MAX	
		XC	0.23			0.6			1.8				MIN, 25°C	
			0.20			0.5			1.5				MAX	
		XM	0.16			0.4			1.2				MIN, 25°C	
			0.5			0.4			0.28				MAX	
			1.1			0.9			0.65				MIN, 25°C	
			4.2			3.4			2.4				MAX	
I _{DD}	Quiescent Power	XC			32.5			65			130	μA	MIN, 25°C	All Inputs at 0 V or V _{DD}
					250			500			1000		MAX	
	Supply Current	XM			8.75			17.5			35	μA	MIN, 25°C	
					250			500			1000		MAX	

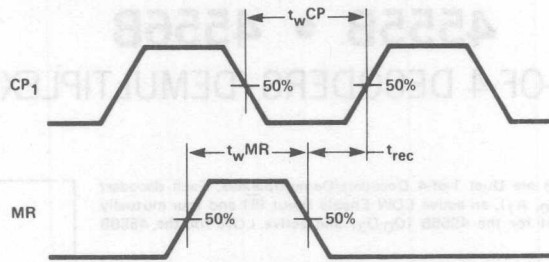
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP ₀ or CP ₁ to Q _n		540			300			180		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	Propagation Delay, CP ₀ or CP ₁ to TC		360			240			120		ns	
t _{PLH}	Propagation Delay, MR to Q _n		540			300			180		ns	
t _{PHL}	Propagation Delay, MR to TC		360			240			120		ns	
t _{TLH}	Output Transition Time		90			42			30		ns	
t _{THL}	MR Recovery Time		42			24			18		ns	
t _{rec}	MR Minimum Pulse Width (HIGH)		150			100			70		ns	
t _{wCP}	CP ₀ or CP ₁ Minimum Pulse Width		75			50			35		ns	
t _{wE_L(L)}	E _L Minimum Pulse Width (LOW)		40			25			15		ns	
t _s	Set-Up Time, CP ₀ to CP ₁		130			57			40		ns	
t _s	Set-Up Time, CP ₁ to CP ₀		130			57			40		ns	
t _s	Set-Up Time, CP ₀ or CP ₁ to E _L		150			100			50		ns	
f _{osc}	Scan Oscillator Frequency		0.4			1.2			1.6		Hz/μF	
f _{MAX}	Input Count Frequency (Note 3)		3			6			7		MHz	

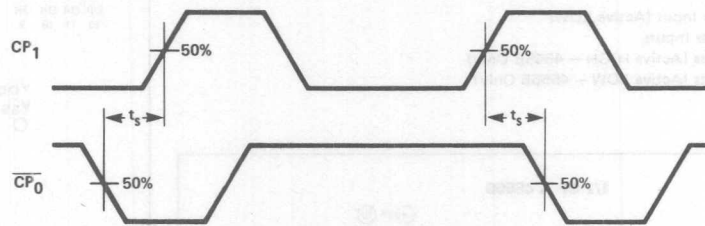
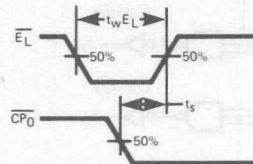
NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
- For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
- It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

SWITCHING WAVEFORMS


MINIMUM PULSE WIDTHS FOR CP_0 , CP_1 AND MR AND MR RECOVERY TIME

CONDITIONS: CP_0 = HIGH and the device triggers on a LOW-to-HIGH transition at CP_1 . The timing also applies when CP_1 = LOW and the device triggers on a HIGH-to-LOW transition at CP_0 .


SET-UP TIMES, CP_0 TO CP_1 AND CP_1 TO CP_0

SET-UP TIME, CP_0 OR CP_1 TO \overline{EL} AND MINIMUM \overline{EL} PULSE WIDTH

CONDITIONS: CP_1 = LOW and the device triggers on a HIGH-to-LOW transition at CP_0 . The timing also applies when CP_0 = HIGH and the device triggers on a LOW-to-HIGH transition at CP_1 .

NOTE:

Set-up and Hold-Times are shown as positive values but may be specified as negative values.

4555B • 4556B

DUAL 1-OF-4 DECODERS/DEMULTIPLEXERS

DESCRIPTION — The 4555B and 4556B are Dual 1-of-4 Decoders/Demultiplexers. Each decoder/demultiplexer has two Address Inputs (A_0 , A_1), an active LOW Enable Input (\bar{E}) and four mutually exclusive Outputs which are active HIGH for the 4555B (O_0 - O_3) and active LOW for the 4556B (\bar{O}_0 - \bar{O}_3).

When the 4555B is used as a decoder, the Enable Input (\bar{E}) when HIGH, forces all Outputs (O_0 - O_3) LOW. When used as a demultiplexer, the appropriate Output is selected by the Data on the Address Inputs (A_0 , A_1) and follows as the inverse of the Enable Input (\bar{E}). All unselected Outputs are LOW.

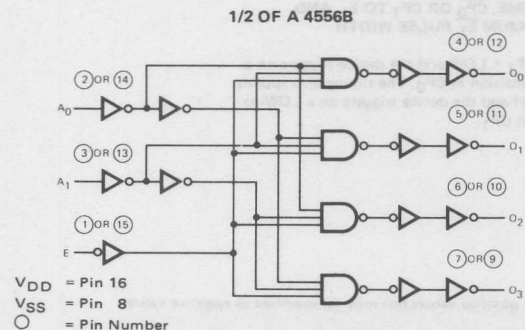
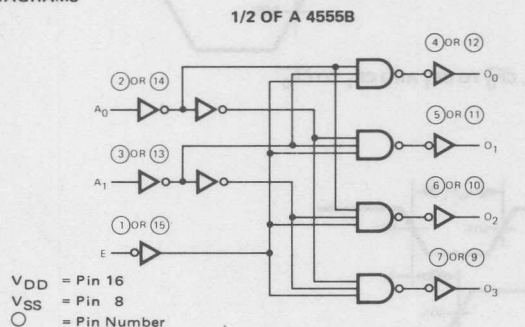
When the 4556B is used as a decoder, the Enable Input (\bar{E}) when HIGH forces all Outputs (\bar{O}_0 - \bar{O}_3) HIGH. When used as a demultiplexer, the appropriate Output is selected by the data on the Address Inputs (A_0 , A_1) and follows the state of the Enable Input (\bar{E}). All unselected Outputs are HIGH.

- ACTIVE HIGH OUTPUTS FOR THE 4555B AND
ACTIVE LOW OUTPUTS FOR THE 4556B
- OVERRIDING ACTIVE LOW ENABLE

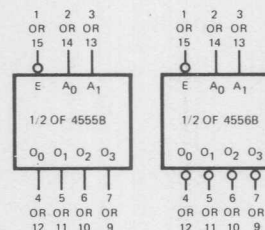
PIN NAMES

\bar{E}	Enable Input (Active LOW)
A_0 , A_1	Address Inputs
O_0 - O_3	Outputs (Active HIGH — 4555B Only)
\bar{O}_0 - \bar{O}_3	Outputs (Active LOW — 4556B Only)

LOGIC DIAGRAMS

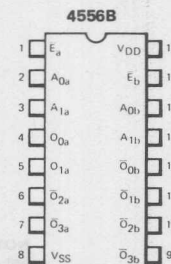
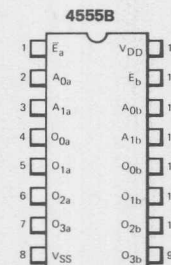


LOGIC SYMBOLS



V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Number

CONNECTION DIAGRAMS DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4555B • 4556B

4555B TRUTH TABLE

\bar{E}	A ₀	A ₁	O ₀	O ₁	O ₂	O ₃
L	L	L	H	L	L	L
L	H	L	L	H	L	L
L	L	H	L	L	H	L
L	H	H	L	L	L	H
H	X	X	L	L	L	L

H = HIGH Level
L = LOW Level
X = Don't Care

4556B TRUTH TABLE

\bar{E}	A ₀	A ₁	\bar{O}_0	\bar{O}_1	\bar{O}_2	\bar{O}_3
L	L	L	L	H	H	H
L	H	L	H	L	H	H
L	L	H	H	H	L	H
L	H	H	H	H	H	L
H	X	X	H	H	H	H

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$, 4555B only (See Note 2)

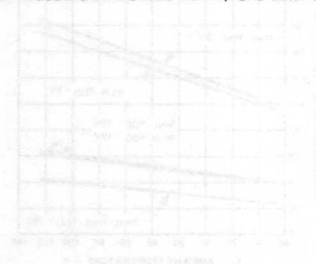
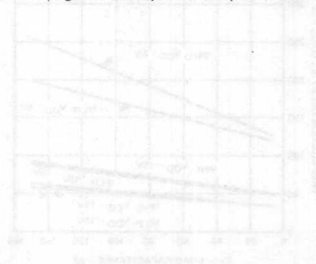
SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Address to Output		148	285		60	145		40	116	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			127	265		54	120		45	96		
t _{PLH}	Propagation Delay, \bar{E} to Output		148	315		60	150		40	120	ns	
t _{PHL}			127	295		53	140		40	112		
t _{TLH}	Output Transition Time		65	135		20	70		25	45	ns	
t _{THL}			66	135		25	70		20	45		

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$, 4556B only (See Note 2)

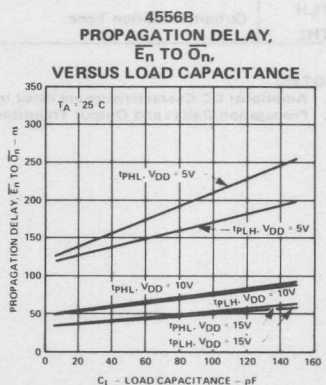
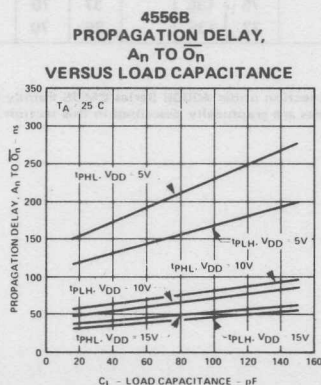
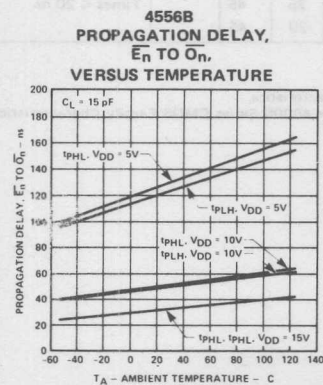
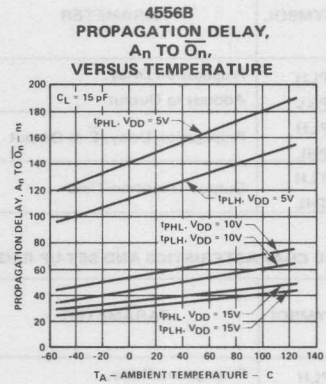
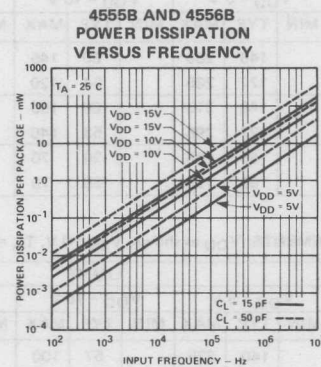
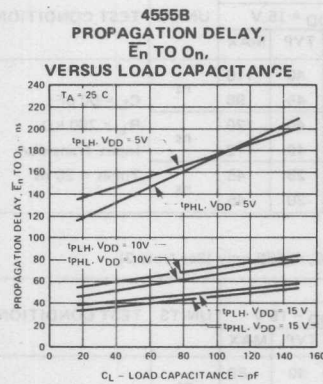
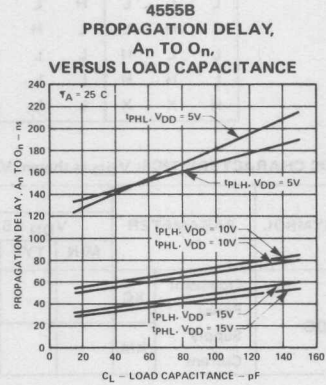
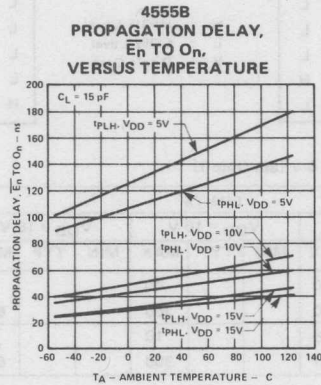
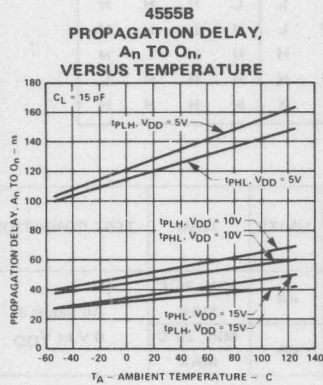
SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Address to Output		140	225		57	100		40	80	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			185	260		68	120		45	96		
t _{PLH}	Propagation Delay, \bar{E} to Output		134	225		55	110		40	88	ns	
t _{PHL}			145	245		58	110		40	88		
t _{TLH}	Output Transition Time		75	135		37	70		25	45	ns	
t _{THL}			77	135		29	70		20	45		

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.



TYPICAL ELECTRICAL CHARACTERISTICS



4557B

1-TO-64 BIT VARIABLE LENGTH SHIFT REGISTER

DESCRIPTION — The 4557B is a 1-to-64 Bit Variable Length Shift Register with two Serial Data Inputs (D_A, D_B), a Data Select Input (S_D), six Register Length Select Inputs ($S_1, S_2, S_4, S_8, S_{16}$ and S_{32}), active LOW and active HIGH Clock Inputs (\overline{CP}_0 and CP_1), True and Complementary Data Outputs (Q and \overline{Q}) and an overriding asynchronous Master Reset Input (MR).

The 4557B register length is programmable. As shown in the Register Selection Table, any shift register length of between 1 and 64 bits can be selected by applying appropriate logic levels to the Register Length Select Inputs ($S_1, S_2, S_4, S_8, S_{16}$ and S_{32}). Shift register length equals the sum of the 6-bit data word formed by the Register Length Select Inputs ($S_{32} S_{16} S_8 S_4 S_2 S_1$) plus one.

With Data Select Input (S_D) LOW, information at the Serial Data Input, D_B , is shifted into the Variable Length Shift Register on either a HIGH-to-LOW transition at \overline{CP}_0 while CP_1 is HIGH or a LOW-to-HIGH transition at CP_1 while \overline{CP}_0 is LOW. With the Data Select Input (S_D) HIGH, information at Serial Data Input D_A is shifted into the register on appropriate logic level transitions and logic levels at the Clock Inputs (\overline{CP}_0 and CP_1) as described above.

True and Complementary Data Outputs (Q and \overline{Q}) from the last stage of the variable length shift register are made available.

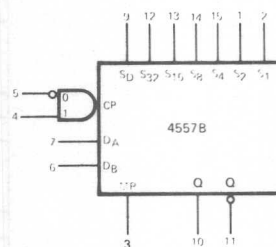
A HIGH on the Master Reset Input (MR) clears all registers to zero (Q =LOW, \overline{Q} =HIGH) independent of all other inputs.

- 1-TO-64 BIT PROGRAMMABLE SHIFT REGISTER
- TRUE AND COMPLEMENTARY DATA OUTPUTS AVAILABLE
- ASYNCHRONOUS MASTER RESET
- TRIGGERS ON EITHER A HIGH-TO-LOW OR LOW-TO-HIGH TRANSITION
- SERIAL DATA INPUT FROM EITHER OF TWO SOURCES

PIN NAMES

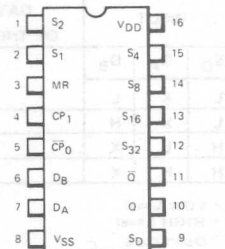
D_A, D_B	Serial Data Inputs
S_D	Data Select Input
$S_1, S_2, S_4, S_8, S_{16}, S_{32}$	Register Length Select Inputs
\overline{CP}_0	Clock Input (H→L Triggered)
CP_1	Clock Input (L→H Triggered)
MR	Master Reset Input
Q	Data Output
\overline{Q}	Complementary Data (Active LOW) Output

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The flatpak version has the same (Connection Diagram) as the Dual In-Line Package.

REGISTER SELECTION TABLE

SELECT INPUTS						REGISTER LENGTH
S ₃₂	S ₁₆	S ₈	S ₄	S ₂	S ₁	
L	L	L	L	L	L	1-BITS
L	L	L	L	L	H	2-BITS
L	L	L	L	H	L	3-BITS
L	L	L	L	H	H	4-BITS
L	L	L	H	L	L	5-BITS
L	L	L	H	L	H	6-BITS
.
H	L	L	L	L	L	33-BITS
H	L	L	L	L	H	34-BITS
H	L	L	L	H	L	35-BITS
.
H	H	H	H	L	L	61-BITS
H	H	H	H	L	H	62-BITS
H	H	H	H	H	L	63-BITS
H	H	H	H	H	H	64-BITS

L = LOW Level
H = HIGH Level





Note: Shift Register Length equals the sum of the Register Length Select Input "Word" (S₁, S₂, S₄, S₈, S₁₆ and S₃₂) plus one.



DATA INPUT SELECTION TABLE

INPUT			DATA INTO THE FIRST STAGE OF THE SELECTED SHIFT REGISTER
S _D	D _A	D _B	
L	X	L	L
L	X	H	H
H	L	X	L
H	H	X	H

L = LOW Level
H = HIGH Level
X = Don't Care

TRUTH TABLE

INPUTS			OPERATION
MR	CP ₀	CP ₁	
L	L		NO CHANGE
L		H	NO CHANGE
L	H	X	NO CHANGE
L	X	L	NO CHANGE
L		H	SELECTED REGISTER SHIFTS
L	L		SELECTED REGISTER SHIFTS
H	X	X	MASTER RESET

L = LOW Level
H = HIGH Level
X = Don't Care
 = Positive-Going Transition
 = Negative-Going Transition

4560B

BCD ADDER

DESCRIPTION — The 4560B is a BCD Adder with two 4-bit Data Inputs (A_0 - A_3 , B_0 - B_3), a Carry Input (C_0), four Sum Outputs (S_0 - S_3) and a Carry Output (C_4).

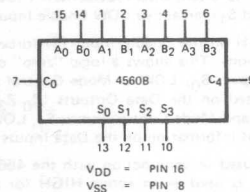
The 4560B uses full lookahead across 4-bits to generate the Carry Output (C_4). This minimizes the necessity for extensive "lookahead" and carry-cascading circuits.

In connection with the 4561B, 9's Complementer, a configuration for subtracting two BCD numbers can also be attained.

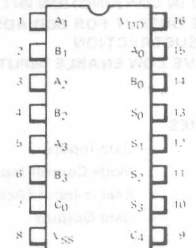
- FULLY CARRY LOOKAHEAD ACROSS FOUR BITS
- EASILY CASCADED

PIN NAMES	FUNCTION
A_0, B_0, A_1, B_1	Data Inputs
A_2, B_2, A_3, B_3	Data Inputs
C_0	Carry Input
S_0 - S_3	Sum Outputs
C_4	Carry Output

LOGIC SYMBOL

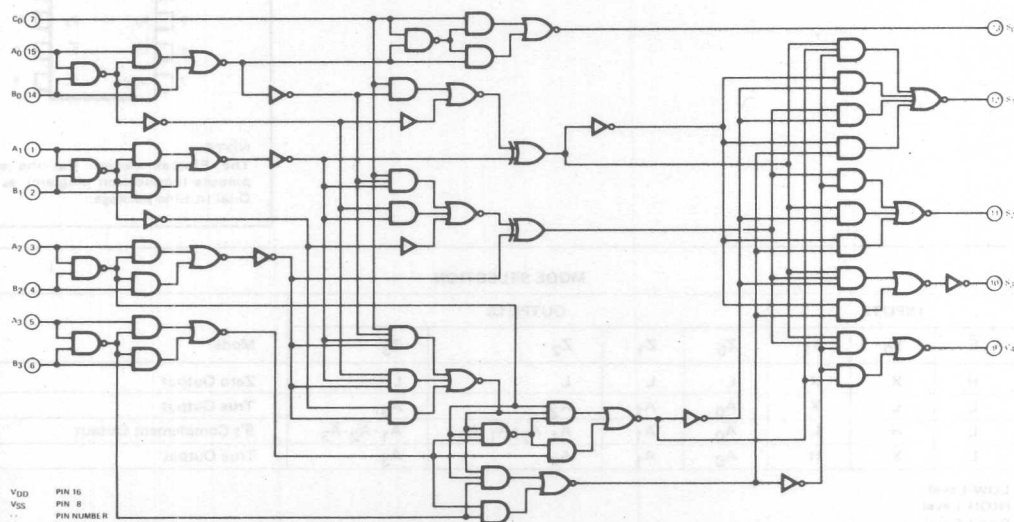


CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



4561B

9's COMPLEMENTER

DESCRIPTION — The 4561B is a 9's Complementer to be used in conjunction with the 4560B, BCD Adder, to attain BCD subtraction. The device has four Data Inputs (A_0 - A_3), two Mode Control Inputs (S_0 and S_1), an active LOW Enable Input (\bar{E}) and four Data Outputs (Z_0 - Z_3).

A HIGH on the Enable Input (\bar{E}) forces all Data Outputs (Z_0 - Z_3) LOW regardless of all other input conditions. This allows a logic "zero" on the output. With the Enable Input (\bar{E}) LOW and Mode Control Input, S_0 , LOW or Mode Control Input, S_1 , HIGH, information on the Data Inputs (A_0 - A_3) is presented on the Data Outputs (Z_0 - Z_3). With the Enable Input (\bar{E}) LOW, Mode Control Input, S_0 , HIGH and Mode Control Input, S_1 , LOW information on the Data Outputs (Z_0 - Z_3) is the 9's Complement of information on the Data Inputs (A_0 - A_3).

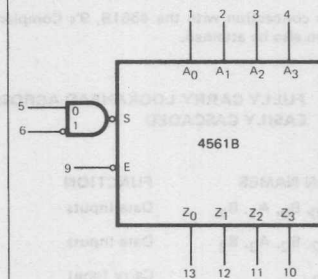
When used in conjunction with the 4560B, BCD Adder, the Mode Control Input, S_0 , (or S_1) of the 4561B is used as an active HIGH (or active LOW) Subtract Control Input while S_1 is LOW (or S_0 is HIGH).

- USED IN CONJUNCTION WITH THE 4560B, BCD ADDER
- TRUE OUTPUT FOR BCD ADDITION OR 9'S COMPLEMENT OUTPUT FOR BCD SUBTRACTION
- ACTIVE LOW ENABLE INPUT FOR "ZERO" OUTPUT FUNCTION

PIN NAMES

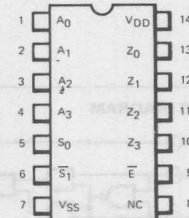
A_0 - A_3	Data Inputs
S_0 , S_1	Mode Control Inputs (Active HIGH and LOW)
\bar{E}	Enable Input (Active LOW)
Z_0 - Z_3	Data Outputs

LOGIC SYMBOL



V_{DD} = Pin 14
 V_{SS} = Pin 7
 NC = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (connection diagram) as the Dual In-Line package.

MODE SELECTION

INPUTS			OUTPUTS				Mode
\bar{E}	S_0	S_1	Z_0	Z_1	Z_2	Z_3	
H	X	X	L	L	L	L	Zero Output
L	L	X	A_0	A_1	A_2	A_3	True Output
L	H	L	\bar{A}_0	\bar{A}_1	\bar{A}_2	\bar{A}_3	9's Complement Output
L	X	H	A_0	A_1	A_2	A_3	True Output

L = LOW Level
 H = HIGH Level
 X = Don't Care

4566B

INDUSTRIAL TIME BASE GENERATOR

DESCRIPTION — The 4566B is an Industrial Time Base Generator consisting of a Divide by 10 Ripple Counter, a Divide by 5 or 6 Ripple Counter, and an on-chip Monostable Multivibrator with a fixed output pulse width range.

Both counters advance on a HIGH-to-LOW transition of the appropriate Clock Inputs (\overline{CP}_a and \overline{CP}_b) as shown in the Block Diagram. Count Select Input, S_b , controls the counter mode of the Divide by 5/6 Ripple Counter. With S_b LOW this counter operates as a divide by 6 counter and with S_b HIGH it operates as a divide by 5 counter thus permitting stable time generation from either a 50 or 60 Hz time base. Parallel Data Outputs from both ripple counters (Q_{0a} - Q_{3a} and Q_{0b} - Q_{2b}) are made available in BCD format. A HIGH on the Master Reset Input (MR) resets both counters (Q_{0a} - Q_{3a} = Q_{0b} - Q_{2b} =LOW) independent of all other inputs.

An on-chip monostable multivibrator is available for ease in generating an automatic master reset signal or for providing clock signals for added frequency stability.

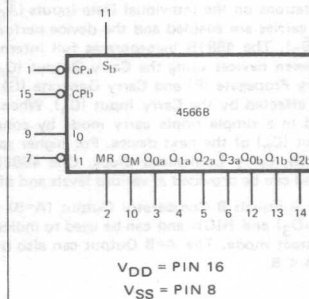
A LOW-to-HIGH transition on the I_0 input while the \overline{I}_1 input is LOW or a HIGH-to-LOW transition on the \overline{I}_1 input while I_0 is HIGH produces a positive pulse (L→H→L) on the Multivibrator Output (Q_m).

- ON-CHIP MONOSTABLE MULTIVIBRATOR TRIGGERED ON EITHER A LOW-TO-HIGH TRANSITION AT I_0 OR A HIGH-TO-LOW TRANSITION AT \overline{I}_1
- HIGH-TO-LOW TRIGGERED CLOCK INPUTS FOR EASY CASCADING
- TWO RIPPLE COUNTERS; DIVIDE BY 10 AND DIVIDE BY 5 OR 6 TO PERMIT STABLE TIME GENERATION FROM 50 OR 60 HZ LINE
- DATA OUTPUTS AVAILABLE IN BCD
- ASYNCHRONOUS MASTER RESET

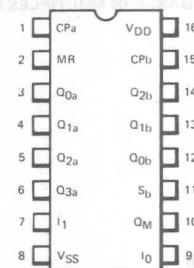
PIN NAMES

$\overline{CP}_a, \overline{CP}_b$	Clock Inputs (H→L Triggered)
S_b	Count Select Input
I_0	Trigger Input
\overline{I}_1	Trigger Input (Active LOW)
MR	Master Reset Input
Q_m	Multivibrator Output
$Q_{0a}, Q_{3a}, Q_{0b}, Q_{2b}$	Data Outputs

LOGIC SYMBOL



CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The flatpak version has the same pinouts (Connection Diagram) as the Dual In-Line Package

4-BIT ARITHMETIC LOGIC UNIT

DESCRIPTION — The 4581B is a 4-Bit Arithmetic Logic Unit which can perform all of the possible 16 logic operations on two variables and a variety of 16 arithmetic operations.

Controlled by the four Instruction Inputs (I_0 - I_3) and the Mode Control Input (M), the 4581B can perform a total of 32 logic and arithmetic operations on either active HIGH or active LOW operands (See Truth Table).

With the Mode Control Input (M) HIGH all internal carries are inhibited and the device performs logic operations on the individual Data Inputs (\bar{A}_0 - \bar{A}_3 and \bar{B}_0 - \bar{B}_3). With the Mode Control Input (M) LOW, the carries are enabled and the device performs arithmetic operations on the Data Inputs (\bar{A}_0 - \bar{A}_3 and \bar{B}_0 - \bar{B}_3). The 4581B incorporates full internal carry lookahead and provides for either ripple carry between devices using the Carry Output (C_{n+4}), or for carry lookahead between packages using the Carry Propagate (\bar{P}) and Carry Generate (\bar{G}) Outputs. Carry Propagate (\bar{P}) and Carry Generate (\bar{G}) are not affected by the Carry Input (C_n). When speed requirements are not stringent, the 4581B can be used in a simple ripple carry mode by connecting the Carry Output (C_{n+4}) of one device to Carry Input (C_n) of the next device. For higher speed operation the 4581B is used in conjunction with the 4582B, Carry Lookahead Block. One 4582B is required for each group of four 4581's. Carry lookahead can be provided at various levels and offers high speed capabilities over longer word lengths.

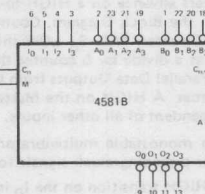
The A Equals B Comparator Output ($A=B$) from the 4581B goes HIGH when all four Data Outputs (\bar{O}_0 - \bar{O}_3) and HIGH and can be used to indicate logic equivalence over four bits when the unit is in the subtract mode. The $A=B$ Output can also be used with the Carry Output (C_{n+4}) to indicate $A > B$ or $A < B$.

- PROVIDES 16 ARITHMETIC OPERATIONS INCLUDING ADD, SUBTRACT, COMPARE, AND DOUBLE
- PROVIDES ALL 16 LOGIC OPERATIONS OF TWO VARIABLES INCLUDING EXCLUSIVE OR, COMPARE, AND NAND, OR, AND NOR.
- FULL LOOKAHEAD FOR HIGHER SPEED ARITHMETIC OPERATION ON LONG WORDS
- EXPANDABLE IN MULTIPLES OF FOUR BITS

PIN NAMES

\bar{A}_0 - \bar{A}_3	Data Inputs (Active LOW)
\bar{B}_0 - \bar{B}_3	Data Inputs (Active LOW)
I_0 - I_3	Instruction Inputs
M	Mode Control Input
C_n	Carry Input
\bar{O}_0 - \bar{O}_3	Data Outputs (Active LOW)
$A=B$	A Equals B Comparator Output
\bar{G}	Carry Generate Output (Active LOW)
\bar{P}	Carry Propagate Output (Active LOW)
C_{n+4}	Carry Output

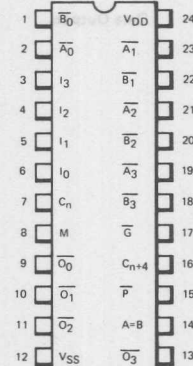
LOGIC SYMBOL



V_{DD} =PIN 24

V_{SS} =PIN 12

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

TRUTH TABLE

INSTRUCTION INPUTS				ACTIVE LOW DATA INPUTS & OUTPUTS		ACTIVE HIGH DATA INPUTS & OUTPUTS	
				LOGIC (M = H)	ARITHMETIC** (M = L) (C _n = L)	LOGIC (M = H)	ARITHMETIC** (M = L) (C _n = H)
I ₃	I ₂	I ₁	I ₀				
L	L	L	L	\bar{A}	A minus 1	\bar{A}	A
L	L	L	H	$\bar{A}\bar{B}$	AB minus 1	$A + \bar{B}$	A + B
L	L	H	L	$A + \bar{B}$	$A\bar{B}$ minus 1	$\bar{A}B$	A + B
L	L	H	H	Logical 1	minus 1	Logical 0	minus 1
L	H	L	L	$A + \bar{B}$	A plus (A + \bar{B})	$\bar{A}\bar{B}$	A plus $\bar{A}\bar{B}$
L	H	L	H	\bar{B}	$A\bar{B}$ plus (A + \bar{B})	\bar{B}	(A + B) plus $\bar{A}\bar{B}$
L	H	H	L	$A \oplus B$	A minus B minus 1	$A \oplus B$	A minus B minus 1
L	H	H	H	$A + \bar{B}$	A + \bar{B}	$\bar{A}\bar{B}$	$\bar{A}\bar{B}$ minus 1
H	L	L	L	$\bar{A}\bar{B}$	A plus (A + B)	$\bar{A} + B$	A plus AB
H	L	L	H	$A \oplus B$	A plus B	$A \oplus B$	A plus B
H	L	H	L	B	$\bar{A}\bar{B}$ plus (A + B)	B	(A + \bar{B}) plus AB
H	L	H	H	A + B	A + B	$\bar{A}B$	$\bar{A}B$ minus 1
H	H	L	L	Logical 0	A plus A*	Logical 1	A plus A*
H	H	L	H	$\bar{A}\bar{B}$	$\bar{A}\bar{B}$ plus A	$A + \bar{B}$	(A + B) plus A
H	H	H	L	$\bar{A}B$	$\bar{A}\bar{B}$ plus A	A + B	(A + \bar{B}) plus A
H	H	H	H	A	A	A	A minus 1

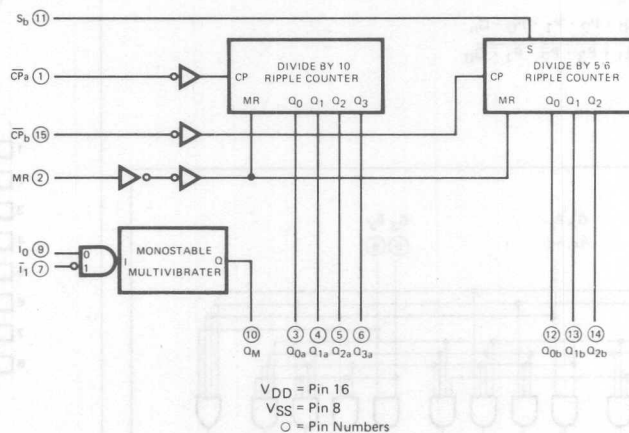
L = LOW Logic Level

H = HIGH Logic Level

*Each bit is shifted to the next more significant position

**Arithmetic operations expressed in 2's complement notation

BLOCK DIAGRAM



4582B

CARRY LOOKAHEAD GENERATOR

DESCRIPTION — The 4582B is a Carry Lookahead Generator which provides high speed lookahead over word lengths of more than four bits. The device has a Carry Input (C_n), four active LOW Carry Generate Inputs (\bar{G}_0 - \bar{G}_3), four active LOW Carry Propagate Inputs (\bar{P}_0 - \bar{P}_3), three Carry Outputs (C_{n+x} , C_{n+y} , C_{n+z}), an active LOW Carry Propagate Output (\bar{P}) and an active LOW Carry Generate Output (\bar{G}). The logic equations for all outputs are shown below.

- EXPANDABLE TO ANY NUMBER OF BITS
- HIGH SPEED LOOKAHEAD OVER WORD LENGTHS OF MORE THAN FOUR BITS

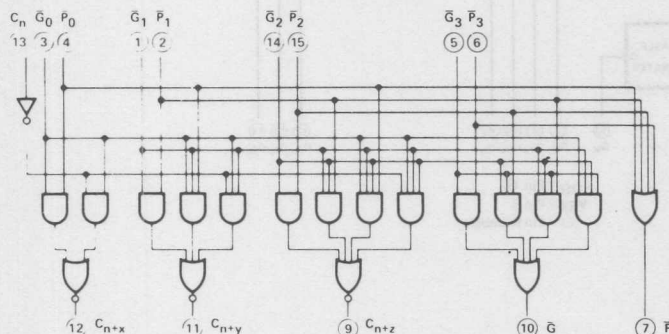
PIN NAMES


C_n	Carry Input
\bar{G}_0 - \bar{G}_3	Carry Generate Inputs (Active LOW)
\bar{P}_0 - \bar{P}_3	Carry Propagate Inputs (Active LOW)
C_{n+x} , C_{n+y} , C_{n+z}	Carry Outputs
\bar{G}	Carry Generate Output (Active LOW)
\bar{P}	Carry Propagate Output (Active LOW)

LOGIC EQUATIONS

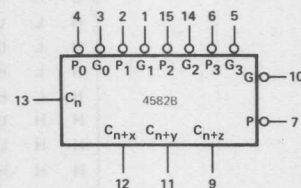
$$\begin{aligned}
 C_{n+x} &= G_0 + P_0 \cdot C_n \\
 C_{n+y} &= G_1 + P_1 \cdot G_0 + P_1 \cdot P_0 \cdot C_n \\
 C_{n+z} &= G_2 + P_2 \cdot G_1 + P_2 \cdot P_1 \cdot G_0 + P_2 \cdot P_1 \cdot P_0 \cdot C_n \\
 \bar{G} &= G_3 + P_3 \cdot G_2 + P_3 \cdot P_2 \cdot G_1 + P_3 \cdot P_2 \cdot P_1 \cdot G_0 \\
 \bar{P} &= \bar{P}_3 \cdot \bar{P}_2 \cdot \bar{P}_1 \cdot \bar{P}_0
 \end{aligned}$$

LOGIC DIAGRAM



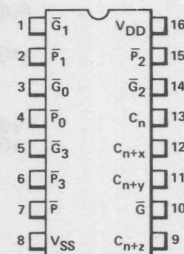
V_{DD} = Pin 16
 V_{SS} = Pin 8
 = Pin Numbers

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4582B

TRUTH TABLE

INPUTS										OUTPUTS				
C _n	G ₀	P ₀	G ₁	P ₁	G ₂	P ₂	G ₃	P ₃		C _{n+x}	C _{n+y}	C _{n+z}	G	P
X	H	H								L				
L	H	X								L				
X	L	X								H				
H	X	L								H				
X	X	X	H	H							L			
X	H	H	H	X							L			
L	H	X	H	X							L			
X	X	X	L	X							H			
X	L	X	X	L							H			
H	X	L	X	L							H			
X	X	X	X	X	H	H						L		
X	X	X	H	H	H	X						L		
X	H	H	H	X	H	X						L		
L	H	X	H	X	H	X						L		
X	X	X	X	X	L	X						H		
X	X	X	L	X	X	L						H		
X	L	X	X	L	X	L						H		
H	X	L	X	L	X	L						H		
	X		X	X	X	X	H	H					H	
	X		X	X	H	H	H	X					H	
	X		H	H	H	X	H	X					H	
	X		H	X	H	X	H	X					H	
	X		X	X	X	X	L	X					L	
	X		X	X	L	X	X	L					L	
	X		L	X	X	L	X	L					L	
	L		X	L	X	L	X	L					L	
		H		X		X		X						H
		X		H		X		X						H
		X		X		H		X						H
		X		X		X		H						H
		L		L		L		L						L

H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care

FAIRCHILD CMOS • 4582B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
	Power				150			300			600		MAX	
	Supply	XM			5			10			20	μA	MIN, 25°C	
	Current				150			300			600		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ C$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, C _n to C _{n+x} ,		160			75			55		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	C _{n+y} or C _{n+z}		160			75			55		ns	
t _{PLH}	Propagation Delay, P _n to C _{n+x}		160			75			55		ns	
t _{PHL}	C _{n+y} or C _{n+z}		160			75			55		ns	
t _{PLH}	Propagation Delay, G _n to C _{n+x} ,		160			75			55		ns	
t _{PHL}	C _{n+y} or C _{n+z}		160			75			55		ns	
t _{PLH}	Propagation Delay, P _n to G		160			75			55		ns	
t _{PHL}	to G		160			75			55		ns	
t _{PLH}	Propagation Delay, G _n to G		160			75			55		ns	
t _{PHL}			160			75			55		ns	
t _{PLH}	Propagation Delay, P _n to P		160			75			55		ns	
t _{PHL}			160			75			55		ns	
t _{TLH}	Output Transition Time		60			30			20		ns	
t _{THL}			60			30			20		ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

4583B

DUAL SCHMITT TRIGGER

DESCRIPTION — The 4583B is a Dual Schmitt Trigger offering both positive and negative threshold Voltages, V_{T+} and V_{T-} , which are programmable via R_{EXT+} , R_{EXTN} and R_{EXTC} inputs with the use of external resistors (see Figure 1). Each Schmitt Trigger operates independently offering both True (O_A , O_B) and Complementary ($\overline{O_A}$, $\overline{O_B}$) Outputs. $O_A \oplus \overline{O_B}$ provides the Exclusive NOR function for the inputs I_A and I_B . A LOW on the Output Enable Input (EO) forces the Complementary Outputs ($\overline{O_A}$, $\overline{O_B}$) to assume a high impedance or "OFF" state independent of all other input conditions.

- PROGRAMMABLE THRESHOLDS
- PROGRAMMABLE HYSTERESIS
- TRUE AND COMPLEMENTARY OUTPUTS AVAILABLE
- 3-STATE COMPLEMENTARY OUTPUTS WITH ACTIVE HIGH OUTPUT ENABLE
- EXCLUSIVE NOR OUTPUT AVAILABLE

PIN NAMES

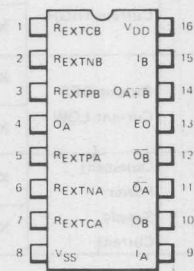
I _A , I _B	Schmitt Trigger Inputs
EO	Output Enable Input
R _{EXTPA} , R _{EXTPB}	Positive External Resistor Connections
R _{EXTNA} , R _{EXTNB}	Negative External Resistor Connections
R _{EXTCA} , R _{EXTCB}	Common External Resistor Connections
O _A , O _B	True Outputs
O _A , O _B	Complementary Outputs
O _A ⊕ O _B	Exclusive NOR Output

TRUTH TABLE

INPUTS			OUTPUTS					
I _A	I _B	E _O	O _A	$\overline{O_A}$	O _B	$\overline{O_B}$	$O_A \oplus O_B$	
L	L	L	L	Z	L	Z	L	
L	L	H	L	Z	L	Z	L	
L	H	L	L	Z	H	Z	H	
L	H	H	L	Z	H	L	H	
H	L	L	H	Z	L	Z	H	
H	L	H	H	Z	L	Z	H	
H	H	L	H	Z	H	Z	L	
H	H	H	H	Z	H	L	L	

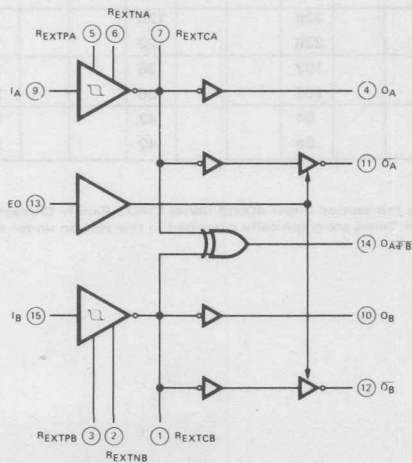
L = LOW Level
H = HIGH Level
Z = High Impedance "OFF" State

**CONNECTION DIAGRAM
DIP (TOP VIEW)**



NOTE:
The Flatpack version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Number

FAIRCHILD CMOS • 4583B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
V _{T+}	Positive-Going Threshold Voltage			3.25			5.9			8.5		V	25°C	R ₁ = R ₂ = 5 kΩ V _{IN} = V _{DD} to V _{SS}
V _{T-}	Negative-Going Threshold Voltage			1.75			4.1			6.5		V	25°C	R ₁ = R ₂ = 5 kΩ V _{IN} = V _{DD} to V _{SS}
V _{T+} to V _{T-}	Hysteresis	XC	0.6	1.5	3.7	0.72	1.8	4.5	0.8	2	5.5	V	25°C	R ₁ = R ₂ = 5 kΩ Hysteresis = V _{T+} Minus V _{T-}
		XM	1	1.5	2.2	1.2	1.8	2.7	1.3	2	2.8	V		
ΔV _T	Threshold Variation Between Schmitt Triggers			0.1			0.15			0.2		V	25°C	R ₁ = R ₂ = 5 kΩ
I _{OZH}	Output OFF Current HIGH	XC									1.6	μA	MIN, 25°C	Output Returned to V _{DD} , E _O = V _{SS}
											12		MAX	
		XM									0.4		MIN, 25°C	
											12		MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6	μA	MIN, 25°C	Output Returned to V _{SS} , E _O = V _{SS}
											-12		MAX	
		XM									-0.4		MIN, 25°C	
											-12		MAX	
I _{DD}	Quiescent Power Supply Current	XC		1			2			4	μA	MIN, 25°C	All Inputs at 0 V or V _{DD}	
				7.5			15		30	MAX				
		XM		0.25			0.5		1	μA		MIN, 25°C		
				7.5			15		30			MAX		

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Notes 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		$V_{DD} = 5\text{ V}$			$V_{DD} = 10\text{ V}$			$V_{DD} = 15\text{ V}$				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
tPLH	Propagation Delay, I_A or I_B to O_A or O_B		360			120			81		ns	$C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$ Input Transition Times $\leq 20\text{ ns}$
tPHL	Propagation Delay, I_A or I_B to $\overline{O_A}$ or $\overline{O_B}$		629			209			144		ns	
tPLH	Propagation Delay, I_A or I_B to $\overline{O_A}$ or $\overline{O_B}$		629			209			144		ns	
tPHL	Propagation Delay, I_A or I_B to $O_A \oplus B$		420			150			90		ns	
tPZH	Output Enable Time		336			120			72		ns	$(R_L = 1\text{ k}\Omega \text{ to } V_{SS})$ $(R_L = 1\text{ k}\Omega \text{ to } V_{DD})$
tPZL	Output Disable Time		336			120			72		ns	
tPHZ	Output Disable Time		102			36			21		ns	$(R_L = 1\text{ k}\Omega \text{ to } V_{SS})$ $(R_L = 1\text{ k}\Omega \text{ to } V_{DD})$
tPLZ	Output Disable Time		102			36			21		ns	
tTLH	Output Transition Time		84			42			30		ns	
tTHL	Output Transition Time		84			42			30		ns	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

SWITCHING WAVEFORMS

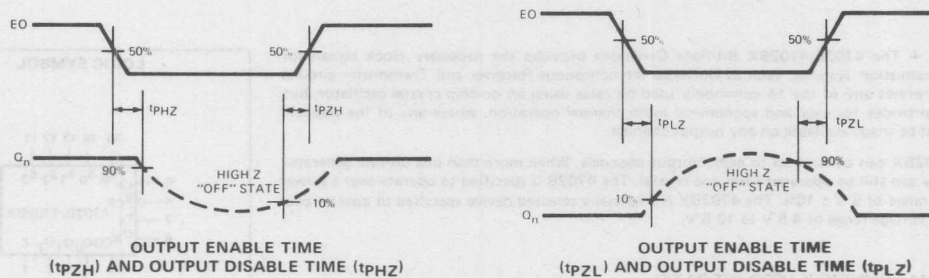
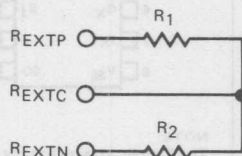
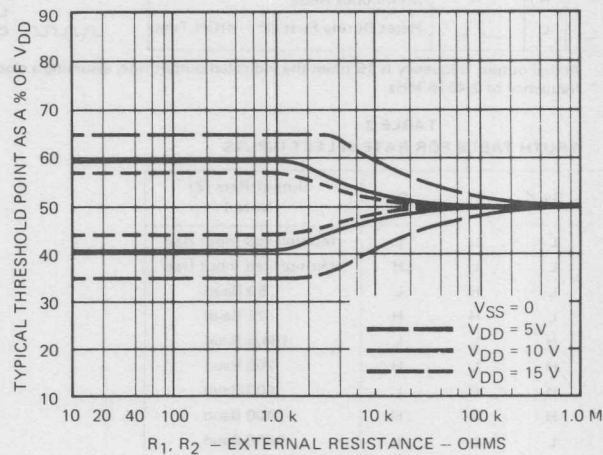
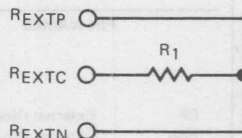


FIGURE 1 - TYPICAL THRESHOLD POINTS

A --- Feedback scheme for independent threshold adjustment:



B --- Feedback scheme for hysteresis adjustment:



4702B/4702BX

PROGRAMMABLE BIT-RATE GENERATOR

FAIRCHILD CMOS MACROLOGIC™

DESCRIPTION — The 4702B/4702BX Bit-Rate Generator provides the necessary clock signals for digital data transmission systems, such as Universal Asynchronous Receiver and Transmitter circuits (UARTs). It generates any of the 14 commonly used bit rates using an on-chip crystal oscillator, but its design also provides for easy and economical multi-channel operation, where any of the possible frequencies must be made available on any output channel.

One 4702B/4702BX can control up to eight output channels. When more than one bit-rate generator is required, they can still be operated from one crystal. The 4702B is specified to operate over a power supply voltage range of 5 V \pm 10%. The 4702BX is a specially selected device specified to operate over a power supply voltage range of 4.5 V to 12.5 V.

- PROVIDES 14 COMMONLY USED BIT-RATES
- ONE 4702B/4702BX CONTROLS UP TO EIGHT TRANSMISSION CHANNELS
- USES 2.4576 MHz INPUT FOR STANDARD FREQUENCY OUTPUTS (16 TIMES BIT RATE)
- CONFORMS TO EIA RS-404
- ON-CHIP INPUT PULL UP CIRCUITS
- TTL COMPATIBLE-OUTPUTS WILL SINK 1.6 mA
- INITIALIZATION CIRCUIT FACILITATES DIAGNOSTIC FAULT ISOLATION
- LOW POWER DISSIPATION — 1.35 mA POWER DISSIPATION AT 5 V AND 2.4576 MHz
- 16-PIN DUAL IN-LINE PACKAGE

TABLE 1
CLOCK MODES AND INITIALIZATION

I _X	\bar{E}_{CP}	CP	OPERATION
	H	L	Clocked from I _X
X	L		Clocked from CP
X	H	H	Continuous Reset
X	L		Reset During First CP = HIGH Time

H = HIGH Level
L = LOW Level
X = Don't Care
 = 1st HIGH Level Clock Pulse After \bar{E}_{CP} Goes LOW
 Clock Pulses

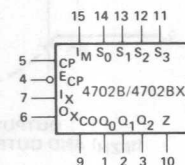
Note 1: Actual output frequency is 16 times the indicated output rate, assuming a clock frequency of 2.4576 MHz.

TABLE 2
TRUTH TABLE FOR RATE SELECT INPUTS

S ₃	S ₂	S ₁	S ₀	Output Rate (Z) Note 1
L	L	L	L	Multiplexed Input (I _M)
L	L	L	H	Multiplexed Input (I _M)
L	L	H	L	50 Baud
L	L	H	H	75 Baud
L	H	L	L	134.5 Baud
L	H	L	H	200 Baud
L	H	H	L	600 Baud
L	H	H	H	2400 Baud
H	L	L	L	9600 Baud
H	L	L	H	4800 Baud
H	L	H	L	1800 Baud
H	L	H	H	1200 Baud
H	H	L	L	2400 Baud
H	H	L	H	300 Baud
H	H	H	L	150 Baud
H	H	H	H	110 Baud

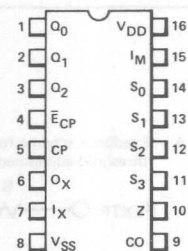
L = LOW Level
H = HIGH Level

LOGIC SYMBOL



V_{DD} = Pin 16
V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)

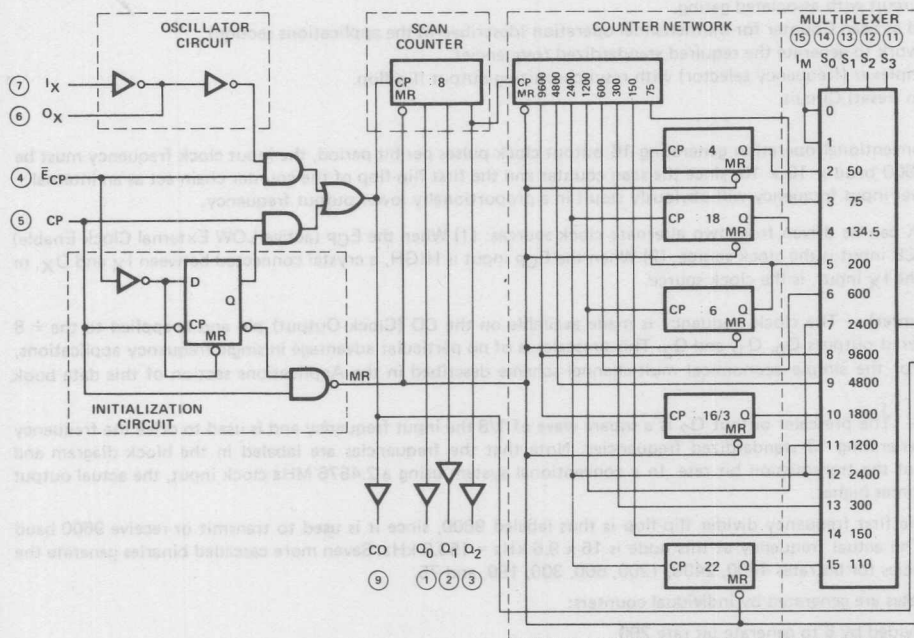


NOTE:
The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

PIN NAMES

CP External Clock Input
 \bar{E}_{CP} External Clock Enable Input (Active LOW)
I_X Crystal Input
I_M Multiplexed Input
S₀-S₃ Rate Select Inputs
CO Clock Output
O_X Crystal Drive Output
Q₀-Q₂ Scan Counter Outputs
Z Bit Rate Output

BLOCK DIAGRAM

V_{DD} = Pin 16V_{SS} = Pin 8

○ = Pin Number

FUNCTIONAL DESCRIPTION — Digital data transmission systems employ a wide range of standardized bit rates, ranging from 50 baud interfacing with electromechanical devices, to 9600 baud for high speed modems. Modern electronic systems commonly use Universal Asynchronous Receiver and Transmitter circuits (UARTs) to convert parallel data inputs into a serial bit stream (transmitter) and to reconvert the serial bit stream into parallel outputs (receiver). In order to resynchronize the incoming serial data, the receiver requires a clock rate that is a multiple of the incoming bit rate. Popular MOS-LSI UART circuits use a clock that is 16 times the transmitted bit rate. The 4702B/4702BX can generate 14 standardized clock rates from one commonly high frequency input.

The 4702B/4702BX contains the following five functional subsystems which are discussed in detail below:

1. An Oscillator Circuit with associated gating.
2. A prescaler used as Scan Counter for multichannel operation (described in the applications section).
3. A Counter Network to generate the required standardized frequencies.
4. An output Multiplexer (frequency selector) with resynchronizing output flip-flop.
5. An Initialization (reset) Circuit.

Oscillator — For conventional operation generating 16 output clock pulses per bit period, the input clock frequency must be 2.4576 MHz (i.e. 9600 baud \times 16 \times 16, since the scan counter and the first flip-flop of the counter chain act as an internal \div 16 prescaler). A lower input frequency will obviously result in a proportionally lower output frequency.

The 4702B/4702BX can be driven from two alternate clock sources: (1) When the \overline{ECP} (active LOW External Clock Enable) input is LOW, the CP input is the clock source. (2) When the \overline{ECP} input is HIGH, a crystal connected between I_X and O_X , or a signal applied to the I_X input, is the clock source.

Prescaler (Scan Counter) — The clock frequency is made available on the CO (Clock Output) pin and is applied to the \div 8 prescaler with buffered outputs Q_0 , Q_1 , and Q_2 . This prescaler is of no particular advantage in single frequency applications, but it is essential for the simple economical multichannel scheme described in the Applications section of this data book.

Counter Network — The prescaler output Q_2 is a square wave of 1/8 the input frequency and is used to drive the frequency counter network generating 13 standardized frequencies. Note that the frequencies are labeled in the block diagram and described in terms of the transmission bit rate. In a conventional system using a 2.4576 MHz clock input, the actual output frequencies are 16 times higher.

The output from the first frequency divider flip-flop is thus labeled 9600, since it is used to transmit or receive 9600 baud (bits per second). The actual frequency at this node is $16 \times 9.6 \text{ kHz} = 153.6 \text{ kHz}$. Seven more cascaded binaries generate the appropriate frequencies for bit rates 4800, 2400, 1200, 600, 300, 150, and 75.

The other five bit rates are generated by individual counters:

- bit rate 1200 is divided by 6 to generate bit rate 200,
- bit rate 200 is divided by 4 to generate bit rate 50,
- bit rate 2400 is divided by 18 to generate bit rate 134.5 with a frequency error of -0.87% ,
- bit rate 2400 is also divided by 22 to generate bit rate 110 with a frequency error of -0.83% , and
- bit rate 9600 is divided by 16/3 to generate bit rate 1800.

The 16/3 division is accomplished by alternating the divide ratio between 5 (twice) and 6 (once). The result is an exact average output frequency with some frequency modulation. Taking advantage of the \div 16 feature of the UART, the resulting distortion is less than 0.78%, irrespective of the number of elements in a character, and therefore well within the timing accuracy specified for high speed communications equipment. All signals except 1800, have a 50% duty cycle.

Output Multiplexer — The outputs of the counter network are fed to a 16-input multiplexer, which is controlled by the Rate Select inputs (S_0 - S_3). The multiplexer output is then resynchronized with the incoming clock in order to cancel all cumulative delays and to present an output signal at the buffered output (Z) that is synchronous with the prescaler outputs (Q_0 - Q_2). Table 2 lists the correspondence between select code and output bit rate. Two of the 16 codes do not select an internally generated frequency, but select an input into which the user can feed either a different, nonstandardized frequency, or a static level (HIGH or LOW) to generate "zero baud".

The bit rates most commonly used in modern data terminals (110, 150, 300, 1200, 2400 baud) require that no more than one input be grounded, easily achieved with a single pole, 5-position switch. 2400 baud is selected by two different codes, so that the whole spectrum of modern digital communication rates has a common HIGH on the S_3 input.

Initialization (Reset) — The initialization circuit generates a common master reset signal for all flip-flops in the 4702B/4702BX. This signal is derived from a digital differentiator that senses the first HIGH level on the CP input after the \overline{ECP} input goes LOW. When \overline{ECP} is HIGH, selecting the Crystal input, CP must be LOW. A HIGH level on CP would apply a continuous reset.

All inputs to the 4702B/4702BX, except I_X have on-chip pull-up circuits which improve TTL compatibility and eliminate the need to tie a permanently HIGH input to V_{DD} .

FAIRCHILD CMOS •4702B/4702BX

DC CHARACTERISTICS: $V_{DD} = 5\text{ V}$, $V_{SS} = 0\text{ V}$ (Note 1)

SYMBOL	PARAMETER		LIMITS			UNITS	TEMP	TEST CONDITIONS	
			MIN	TYP	MAX				
V _{IH}	Input HIGH Voltage		3.5			V	All	Guaranteed Input High Voltage	
V _{IL}	Input LOW Voltage				1.5	V	All	Guaranteed Input LOW Voltage	
V _{OH}	Output HIGH Voltage		4.95			V	MIN, 25°C	I _{OH} < 1 μA, Inputs at 0 or 5 V per the Logic Function or Truth Table I _{OH} < 1 μA, Inputs at 1.5 or 3.5 V	
			4.95				MAX		
					4.5				
V _{OL}	Output LOW Voltage				0.05	V	MIN, 25°C	I _{OL} < 1 μA, Inputs at 0 or 5 V per the Logic Function or Truth Table I _{OL} < 1 μA, Inputs at 1.5 or 3.5 V	
					0.05				
							0.5		
I _L (See Note 1)	Input LOW Current for Input I _X	XC			0.3	μA	MIN, 25°C	Pin under Test at 0 V All other Inputs Simultaneously at 5 V	
					1				
		XM			0.1	μA	MIN, 25°C		
					1				
	Input LOW Current for all Other Inputs	XC	-15	-30	-100	μA	25°C		
		XM	-15	-30	-100				
I _{IH}	Input HIGH Current for all Inputs	XC			0.3	μA	MIN, 25°C	Pin Under Test at 5 V All other Inputs Simultaneously at 0 V	
					1				
		XM			0.1	μA	MIN, 25°C		
					1				
I _{OH}	Output HIGH Current for Output O _X		-0.3			mA	MIN, 25°C	V _{OUT} = 4.5 V	Inputs at 0 or 5 V per Logic Function or Truth Table
			-0.1						
	Output HIGH Current for all other Outputs		-1.5			mA	MIN, 25°C	V _{OUT} = 2.5 V	
			-1						
		-0.5			mA	MIN, 25°C	V _{OUT} = 4.5 V		
		-0.3						MAX	
I _{OL}	Output LOW Current for Output O _X		0.2			mA	MIN, 25°C	V _{OUT} = 0.4 V	
			0.1						
	Output LOW Current for all Other Outputs		3.2			mA	MIN, 25°C		
			1.6						MAX
I _{DD}	Quiescent Power Supply Current	XC			100	μA	MIN, 25°C	E _{CP} = V _{DD} , CP = 0 V, All other Inputs at 0 V or V _{DD} (Note 6)	
					1000				
		XM			10	μA	MIN, 25°C		
					150				

See Notes on following page.



FAIRCHILD CMOS • 4702B/4702BX

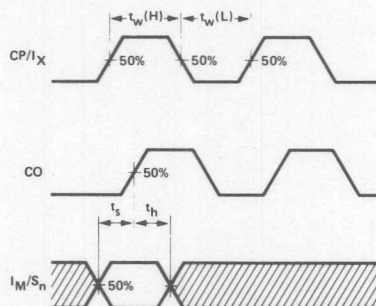
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $V_{DD} = 5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_A = 25^\circ\text{C}$

SYMBOL	PARAMETER	LIMITS			UNITS	TEST CONDITIONS
		MIN	TYP	MAX		
t _{PLH}	Propagation Delay		175	350	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns C _L < 7 pF on O _X
t _{PHL}	I _X to CO		135	275		
t _{PLH}	Propagation Delay		130	260	ns	
t _{PHL}	CP to CO		110	220		
t _{PLH}	Propagation Delay		53	Note 5	ns	
t _{PHL}	CO to Q _n		45			
t _{PLH}	Propagation Delay		37	85	ns	
t _{PHL}	CO to Z		32	75		
t _{TLH}	Output Transition		80	160	ns	
t _{THL}	Time (Except O _X)		35	75		
t _s	Set-Up Time, Select to CO	350	185		ns	
t _h	Hold Time, Select to CO		−182			
t _s	Set-Up Time, I _M to CO	350	190		ns	
t _h	Hold Time, I _M to CO	0	−182			
t _{wCP(L)}	Minimum Clock Pulse Width	120	60		ns	
t _{wCP(H)}	LOW and HIGH	120	60			
t _{wI_X(L)}	Minimum I _X Pulse Width	160	75		ns	
t _{wI_X(H)}	LOW and HIGH	160	75			

NOTES:

1. Propagation Delays and Output Transition Times are graphically described under 4000B Series CMOS Family Characteristics.
2. The first HIGH level Clock Pulse after \bar{E}_{CP} goes LOW must be at least 350 ns long to guarantee reset of all Counters.
3. It is recommended that input rise and fall times to the Clock Inputs (CP, I_X) be less than 15 μs at $V_{DD} = 5\text{ V}$, 4 μs at $V_{DD} = 10\text{ V}$, and 3 μs at $V_{DD} = 15\text{ V}$, and the V_{DD} pin should be decoupled.
4. Input current and quiescent power supply current are relatively higher for this device because of active pull-up circuits on all inputs except I_X . This is done for TTL compatibility.
5. For multichannel operation, propagation delay, CO to Q_n , plus set-up time, select to CO, is guaranteed to $\leq 367\text{ ns}$.
6. I_{DD} is measured on Pin 8 and does not include Input Leakage Currents.

SWITCHING WAVEFORMS



MINIMUM CP AND I_X PULSE WIDTHS AND SET-UP AND HOLD TIMES,
 SELECT INPUT (S_n) TO CLOCK OUTPUT (CO) AND I_M INPUT TO CLOCK OUTPUT (CO)

NOTE: Set-up and Hold Times are shown as positive values but may be specified as negative values.

APPLICATIONS

Single Channel Bit Rate Generator — Figure 1 shows the simplest application of the 4702B/4702BX. This circuit generates one of five possible bit rates as determined by the setting of a single pole, 5-position switch. The bit rate output (Z) drives one standard TTL load or four low power Schottky loads over the full temperature range. The possible output frequencies correspond to 110, 150, 300, 1200, and 2400 Baud. For many low cost terminals these five bit rates are adequate.

Simultaneous Generation of Several Bit Rates:

Fixed Programmed Multichannel Operation — Figure 2 shows a simple scheme that generates eight bit rates on eight output lines, using one 4702B/4702BX and one 93L34 8-Bit Addressable Latch. This and the following applications take advantage of the built-in scan counter (prescaler) outputs. As shown in the block diagram, these outputs (Q_0 to Q_2) go through a complete sequence of eight states for every half-period of the highest output frequency (9600 Baud). Feeding these Scan Counter outputs back to the Select inputs of the multiplexer causes the 4702B/4702BX to interrogate sequentially the state of eight different frequency signals. The 93L34 8-Bit Addressable Latch, addressed by the same Scan Counter outputs, reconverts the multiplexed single output (Z) of the 4702B/4702BX into eight parallel output frequency signals. In the simple scheme of Figure 2, input S_3 is left open (HIGH) and the following bit rates are generated:

Q_0 : 110 Baud,	Q_1 : 9600 Baud,	Q_2 : 4800 Baud,	Q_3 : 1800 Baud,
Q_4 : 1200 Baud,	Q_5 : 2400 Baud,	Q_6 : 300 Baud,	Q_7 : 150 Baud.

Other bit rate combinations can be generated by changing the Scan Counter to selector interconnection or by inserting logic gates into this path.

Fully Programmable Multichannel Operation — Figure 3 shows a fully programmable 8-channel bit rate generator system that, under computer control, generates arbitrarily assigned bit rates on all eight outputs simultaneously. The basic operation is similar to the previously described fixed programmed system, but two 9LS170 4 x 4 Register File MSI packages are connected as programmable look-up tables between the Scan Counter outputs (Q_0 to Q_2) and the multiplexer Select inputs (S_0 to S_3). The content of this 8-word by 4-bit memory determines which frequency appears at what output.

19200 Baud Operation — Though a 19200 Baud signal is not internally routed to the multiplexer, the 4702B/4702BX can be used to generate this bit rate by connecting the Q_2 output to the I_M input and applying select code 0 or 1. An additional 2-input NAND gate can be used to retain the "Zero Baud" feature on select code 0. Any multichannel operation that involves 19200 Baud must be limited to four outputs as shown in Figure 4. Only the two least significant Scan Counter outputs are used, so that the scan is completed within one half period of the 19200 output frequency.

Clock Expansion — One 4702B/4702BX can control up to eight output channels. For more than eight channels, additional bit rate generators are required. These bit rate generators can all be run from the same crystal or clock input. Figure 5 shows one possible expansion scheme. One 4702B/4702BX is provided with a crystal. All other devices derive their clock from this master. Figure 6 shows a different scheme where the master clock output feeds into the I_X input of all slaves and all E_{CP} inputs are normally held HIGH. This scheme retains the reset feature and the selection between two different clock sources of the basic 4702B/4702BX circuit.

During normal operation, the common E_{CP} line is HIGH and the common clock line (CP) is LOW. For diagnostic purposes the common E_{CP} is forced LOW. This deselected the crystal frequency and initiates the diagnostic mode. When CP goes HIGH for the first time, all 4702B/4702BXs are reset through their individual on-chip initialization circuitry. Subsequent LOW-to-HIGH clock transitions on the common CP line advance the scan counter, causing all 4702B/4702BXs to operate synchronously.

TYPICAL APPLICATIONS

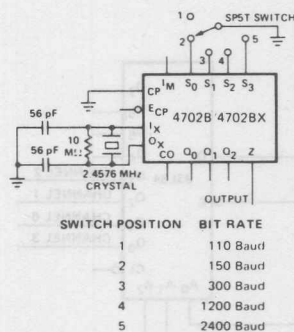


Fig. 1

SWITCH SELECTABLE BIT RATE GENERATOR
CONFIGURATION PROVIDING FIVE BIT RATES

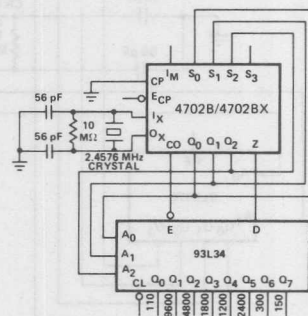
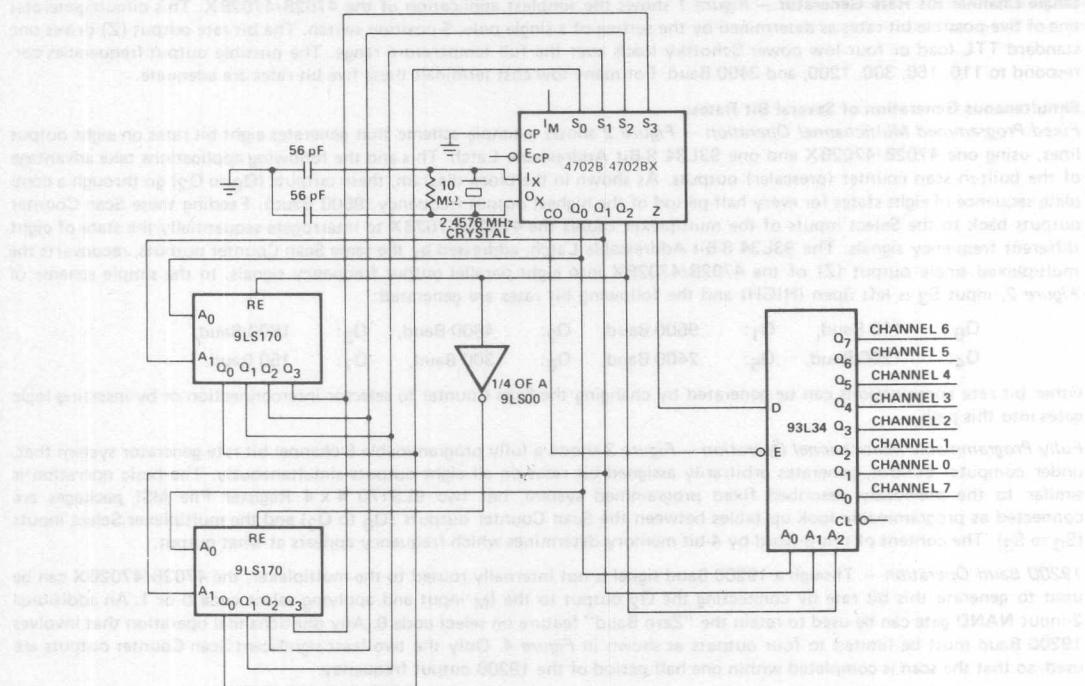


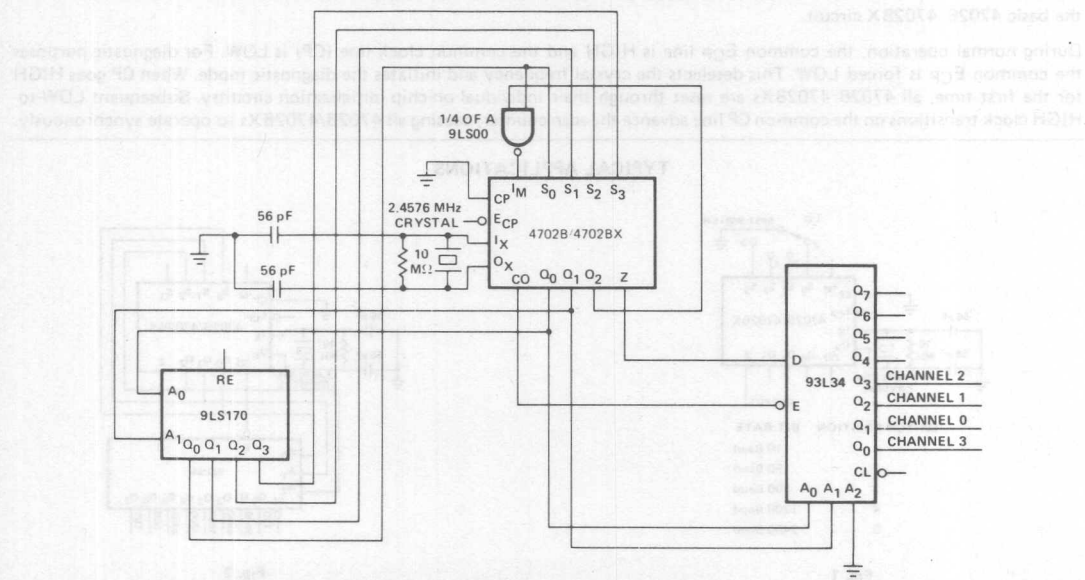
Fig. 2

BIT RATE GENERATOR CONFIGURATION
WITH EIGHT SIMULTANEOUS FREQUENCIES

TYPICAL APPLICATIONS (Cont'd)



FULLY PROGRAMMABLE 8-CHANNEL BIT RATE GENERATOR SYSTEM



FULLY PROGRAMMABLE 4-CHANNEL BIT RATE GENERATOR SYSTEM WITH THE 19.2k BAUD FEATURE

FAIRCHILD CMOS • 4702B/4702BX

TYPICAL APPLICATIONS (Cont'd)

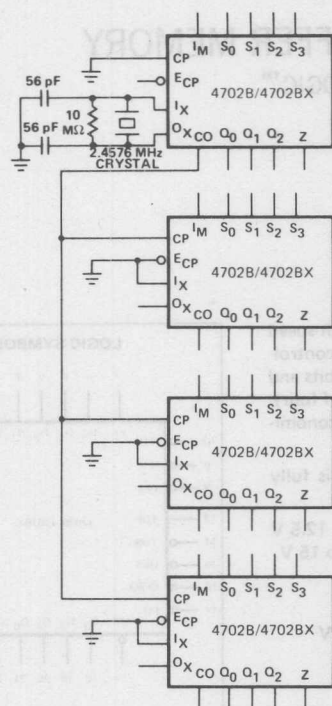


Fig. 5
CASCADE CLOCK EXPANSION SCHEME

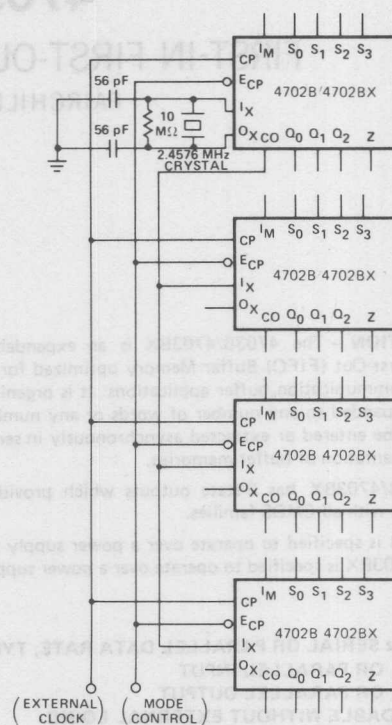


Fig. 6
TANDEM CLOCK EXPANSION SCHEME

CRYSTAL SPECIFICATION RECOMMENDATIONS — Table 3 is a convenient listing of recommended crystal specifications. Crystal manufacturers are also listed below.

TABLE 3 CRYSTAL SPECIFICATIONS

PARAMETERS	TYPICAL CRYSTAL SPEC
Frequency	2.4576 MHz "AT" Cut
Series Resistance (Max)	250 Ω
Unwanted Modes	-6 dB (Min)
Type of Operation	Parallel
Load Capacitance	32 pF · 0.5

CRYSTAL MANUFACTURERS

CTS Knights, Inc.
Sandwich, Ill. 60548
(815) 786-8411
Crystal #FI004

X-Tron Electronics
1869 National Ave.
Hayward, Calif.
(415) 783-2145

Erie Frequency Control
499 Lincoln St.
Carlisle, Pa. 17013
(717) 249-2232

International Crystal Mfg. Company
10 No. Lee
Oklahoma City, Okla. 73102
(405) 236-3741

Sentry Manufacturing Co.
Crystal Park
Chickasha, Oklahoma 73018
(405) 224-6780

Crystal // SGP 6-2.4576 or
Crystal // SGP-7-2.4576

4703B/4703BX

FIRST-IN FIRST-OUT (FIFO) BUFFER MEMORY

FAIRCHILD CMOS MACROLOGIC™

DESCRIPTION — The 4703B/4703BX is an expandable fall-through type high-speed First-In First-Out (FIFO) Buffer Memory optimized for high speed disc or tape controllers and communication buffer applications. It is organized as 16 words by four bits and may be expanded to any number of words or any number of bits (in multiples of four). Data may be entered or extracted asynchronously in serial or parallel, allowing economical implementation of buffer memories.

The 4703B/4703BX has 3-state outputs which provide added versatility and is fully compatible with all CMOS families.

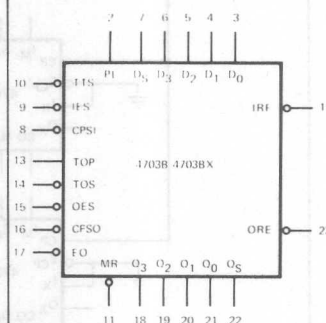
The 4703B is specified to operate over a power supply voltage range of 4.5 V to 12.5 V and the 4703BX is specified to operate over a power supply voltage range of 3 V to 15 V.

- 5.3 MHz SERIAL OR PARALLEL DATA RATE, TYPICALLY AT $V_{DD} = 10$ V
- SERIAL OR PARALLEL INPUT
- SERIAL OR PARALLEL OUTPUT
- EXPANDABLE WITHOUT EXTERNAL LOGIC
- 3-STATE OUTPUTS
- FULLY COMPATIBLE WITH ALL CMOS FAMILIES
- SLIM 24-PIN PACKAGE

PIN NAMES

D_0 – D_3	Parallel Data Inputs
D_S	Serial Data Input
PL	Parallel Load Input
CPSI	Serial Input Clock Input (HIGH-to-LOW Triggered)
CPSO	Serial Output Clock Input (HIGH-to-LOW Triggered)
IES	Serial Input Enable (Active LOW)
TTS	Transfer to Stack Input (Active LOW)
TOS	Transfer Out Serial Input (Active LOW)
TOP	Transfer Out Parallel Input
OES	Serial Output Enable Input (Active LOW)
EO	Output Enable Input (Active LOW)
MR	Master Reset Input (Active LOW)
IRF	Input Register Full Output (Active LOW)
ORE	Output Register Empty Output (Active LOW)
Q_0 – Q_3	Parallel Data Outputs
Q_S	Serial Data Output

LOGIC SYMBOL



V_{DD} = Pin 24
 V_{SS} = Pin 12

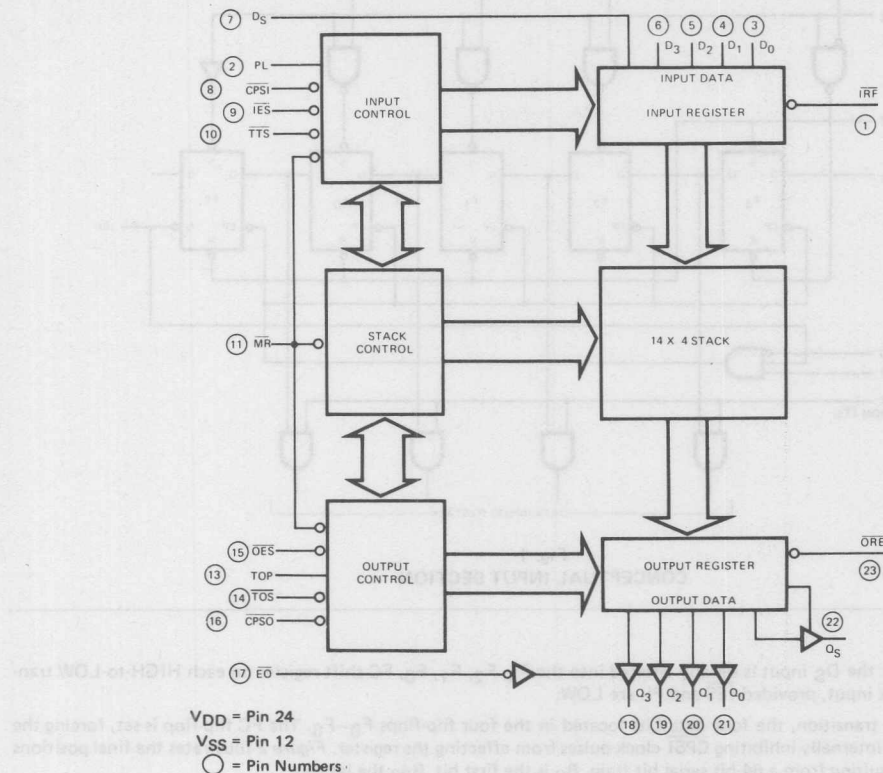
CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

BLOCK DIAGRAM



FUNCTIONAL DESCRIPTION — As shown in the block diagram the 4703B/4703BX consists of three sections:

1. An Input Register with parallel and serial data inputs as well as control inputs and outputs for input handshaking and expansion.
2. A 4-bit wide, 14-word deep fall-through stack with self-contained control logic.
3. An Output Register with parallel and serial data outputs as well as control inputs and outputs for output handshaking and expansion.

Since these three sections operate asynchronously and almost independently, they will be described separately below:

Input Register (Data Entry):

The Input Register can receive data in either bit-serial or in 4-bit parallel form. It stores this data until it is sent to the fall-through stack and generates the necessary status and control signals.

Figure 1 is a conceptual logic diagram of the input section, as described later, this 5-bit register is initialized by setting the F3 flip-flop and resetting the other flip-flops. The Q-output of the last flip-flop (FC) is brought out as the "Input Register Full" output (IRF). After initialization this output is HIGH.

Parallel Entry — A HIGH on the PL input loads the D₀–D₃ inputs into the F₀–F₃ flip-flops and sets the FC flip-flop. This forces the IRF output LOW indicating that the input register is full. During parallel entry, the CPSI input must be LOW. If parallel expansion is not being implemented, IES must be LOW to establish row mastership (see Expansion section). The D₀–D₃ inputs are "ones catching" and must remain stable while PL is HIGH.

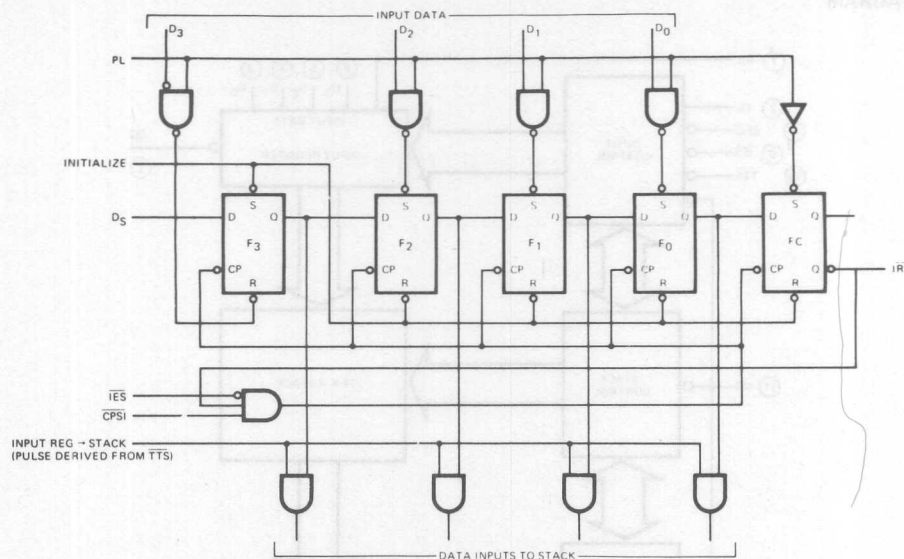


Fig. 1
CONCEPTUAL INPUT SECTION

Serial Entry — Data on the D_S input is serially entered into the F_3, F_2, F_1, F_0, F_C shift register on each HIGH-to-LOW transition of the $CPSI$ clock input, provided IES and PL are LOW.

After the fourth clock transition, the four data bits located in the four flip-flops F_0 – F_3 . The F_C flip-flop is set, forcing the IRF output LOW and internally inhibiting $CPSI$ clock pulses from effecting the register. Figure 2 illustrates the final positions in a 4703B/4703BX resulting from a 64-bit serial bit train. B_0 is the first bit, B_{63} the last bit.

Transfer to the Stack — The outputs of Flip-Flops F_0 – F_3 feed the stack. A LOW level on the TTS input initiates a "fall-through" action. If the top location of the stack is empty, data is loaded into the stack and the input register is re-initialized. Note that this initialization is postponed until PL is LOW again. Thus, automatic FIFO action is achieved by connecting the IRF output to the TTS input.

An RS Flip-Flop (the Request Initialization Flip-Flop shown in Figure 10) in the control section records the fact that data has been transferred to the stack. This prevents multiple entry of the same word into the stack despite the fact the IRF and TTS may still be LOW. The Request Initialization Flip-Flop is not cleared until PL goes LOW. Once in the stack, data falls through the stack automatically, pausing only when it is necessary to wait for an empty next location. In the 4703B/4703BX, as in most modern FIFO designs, the MR input only initializes the stack control section and does not clear the data.

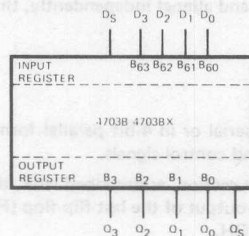


Fig. 2
FINAL POSITIONS IN A 4703B/4703BX RESULTING
FROM A 64-BIT SERIAL TRAIN

Output Register (Data Extraction) – The Output Register receives 4-bit data words from the bottom stack location, stores it and outputs data on a 3-state 4-bit parallel data bus or on a 3-state serial data bus. The output section generates and receives the necessary status and control signals. *Figure 3* is a conceptual logic diagram of the output section.

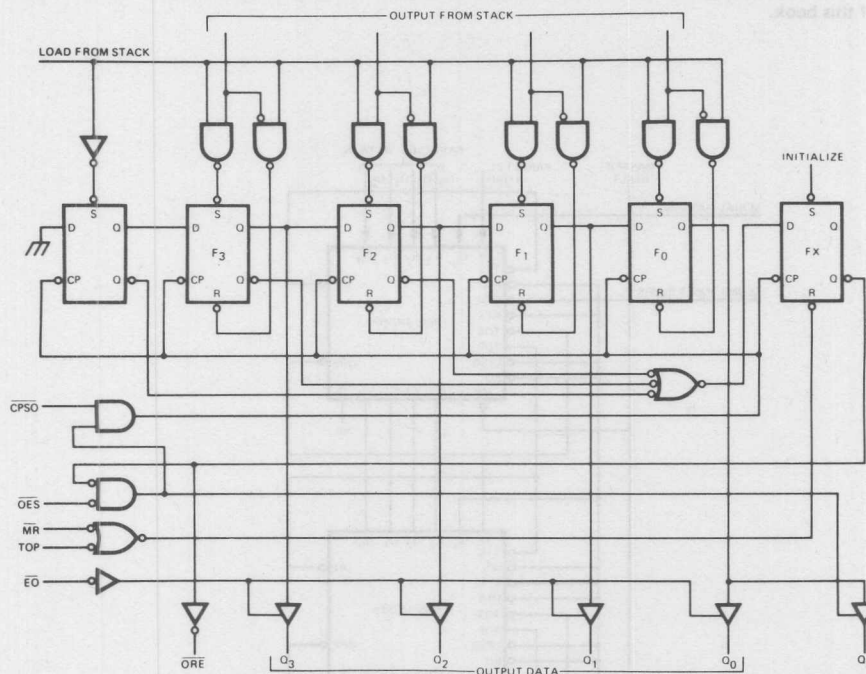


Fig. 3
CONCEPTUAL OUTPUT SECTION

Parallel Data Extraction – When the FIFO is empty after a LOW pulse is applied to \overline{MR} , the Output Register Empty (\overline{ORE}) output is LOW. After data has been entered into the FIFO and has fallen through to the bottom stack location, it is transferred into the Output Register provided the "Transfer Out Parallel" (TOP) input is HIGH. As a result of the data transfer \overline{ORE} goes HIGH, indicating valid data on the data outputs (provided the 3-state buffer is enabled). TOP can now be used to clock out the next word. When TOP goes LOW, \overline{ORE} will go LOW indicating that the output data has been extracted, but the data itself remains on the output bus until the next HIGH level at TOP permits the transfer of the next word (if available) into the Output Register. During parallel data extraction $\overline{CPS0}$ should be LOW. \overline{TOS} should be grounded for single slice operation or connected to the appropriate \overline{ORE} for expanded operation (see Expansion section).

TOP is not edge triggered. Therefore, if TOP goes HIGH before data is available from the stack, but data does become available before TOP goes LOW again, that data will be transferred into the Output Register. However, internal control circuitry prevents the same data from being transferred twice. If TOP goes HIGH and returns to LOW before data is available from the stack, $\overline{\text{ORE}}$ remains LOW indicating that there is no valid data at the outputs.

Serial Data Extraction – When the FIFO is empty after a LOW pulse is applied to \overline{MR} , the Output Register Empty (\overline{ORE}) output is LOW. After data has been entered into the FIFO and has fallen through to the bottom stack location, it is transferred into the Output Register provided \overline{TOS} is LOW and TOP is HIGH. As a result of the data transfer \overline{ORE} goes HIGH indicating valid data in the register. The 3-state Serial Data Output, Q_S , is automatically enabled and puts the first data bit on the output bus. Data is serially shifted out on the HIGH-to-LOW transition of \overline{CPSO} . To prevent false shifting, \overline{CPSO} should be LOW when the new word is being loaded into the Output Register. The fourth transition empties the shift register, forces \overline{ORE} output LOW and disables the serial output, Q_S (refer to Figure 3). For serial operation the \overline{ORE} output may be tied to the \overline{TOS} input, requesting a new word from the stack as soon as the previous one has been shifted out.

EXPANSION

Vertical Expansion — The 4703B/4703BX may be vertically expanded to store more words without external parts. The interconnections necessary to form a 46-word by 4-bit FIFO are shown in *Figure 4*. Using the same technique, any FIFO of $(15n + 1)$ words by four bits can be constructed, where n is the number of devices. Note that expansion does not sacrifice any of the 4703B/4703BX's flexibility for serial/parallel input and output. For other expansion schemes, refer to the Applications section of this book.

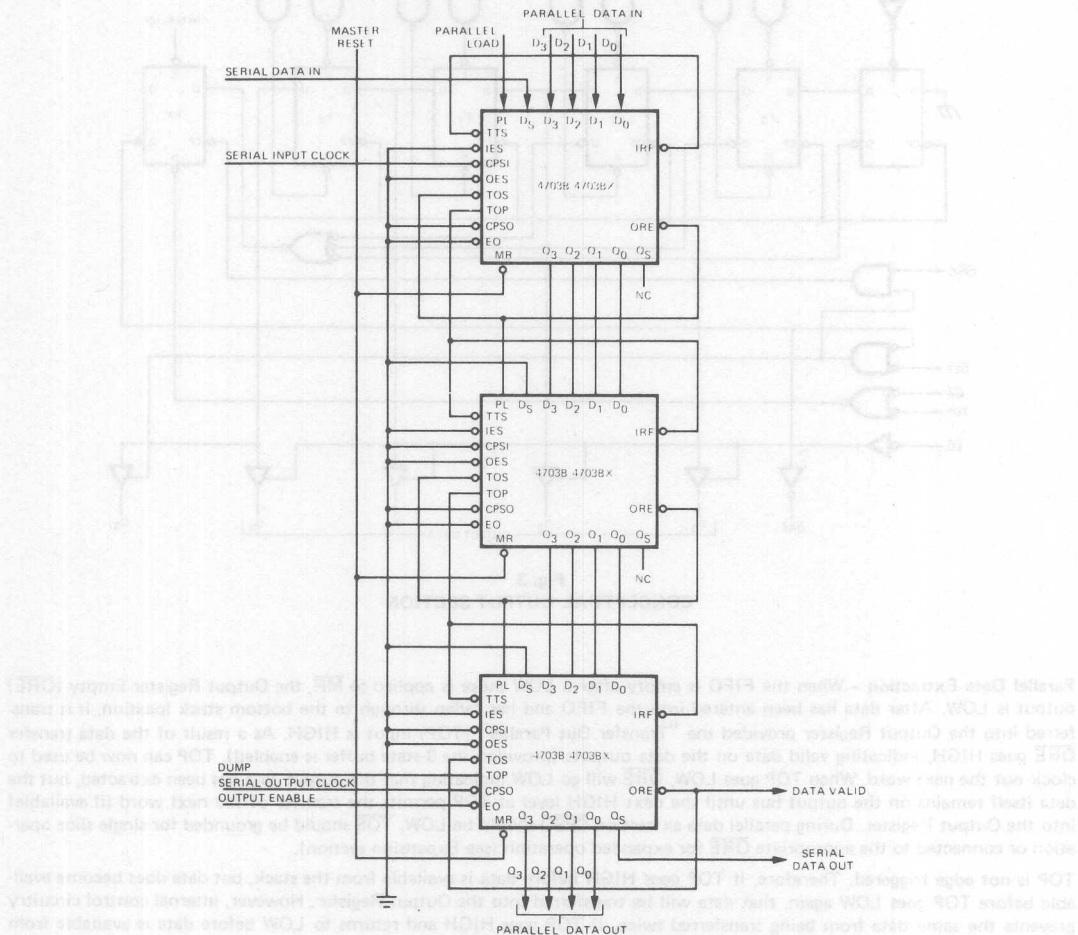


Fig. 4
A VERTICAL EXPANSION SCHEME

It should be noted that this form of horizontal expansion extracts a penalty in speed. A single FIFO is guaranteed to operate at 3.4 MHz; an array of four FIFOs connected in the above manner is guaranteed at 1.5 MHz. An expansion scheme that provides higher speed but requires additional components is shown in the Applications section of this book.

Horizontal and Vertical Expansion — The 4703B/4703BX can be expanded in both the horizontal and vertical directions without any external parts and without sacrificing any of its FIFO's flexibility for serial/parallel input and output. The interconnections necessary to form a 31-word by 16-bit FIFO are shown in *Figure 6*. Using the same technique, any FIFO of $(15m + 1)$ words by $(4n)$ bits can be constructed, where m is the number of devices in a column and n is the number of devices in a row.

Figures 7 and 8 show the timing diagrams for serial data entry and extraction for the 31-word by 16-bit FIFO shown in Figure 6. The final position of data after serial insertion of 496 bits into the FIFO array of Figure 6 is shown in Figure 9.

Fig. 5
A HORIZONTAL EXPANSION SCHEME

FAIRCHILD CMOS • 4703B/4703BX

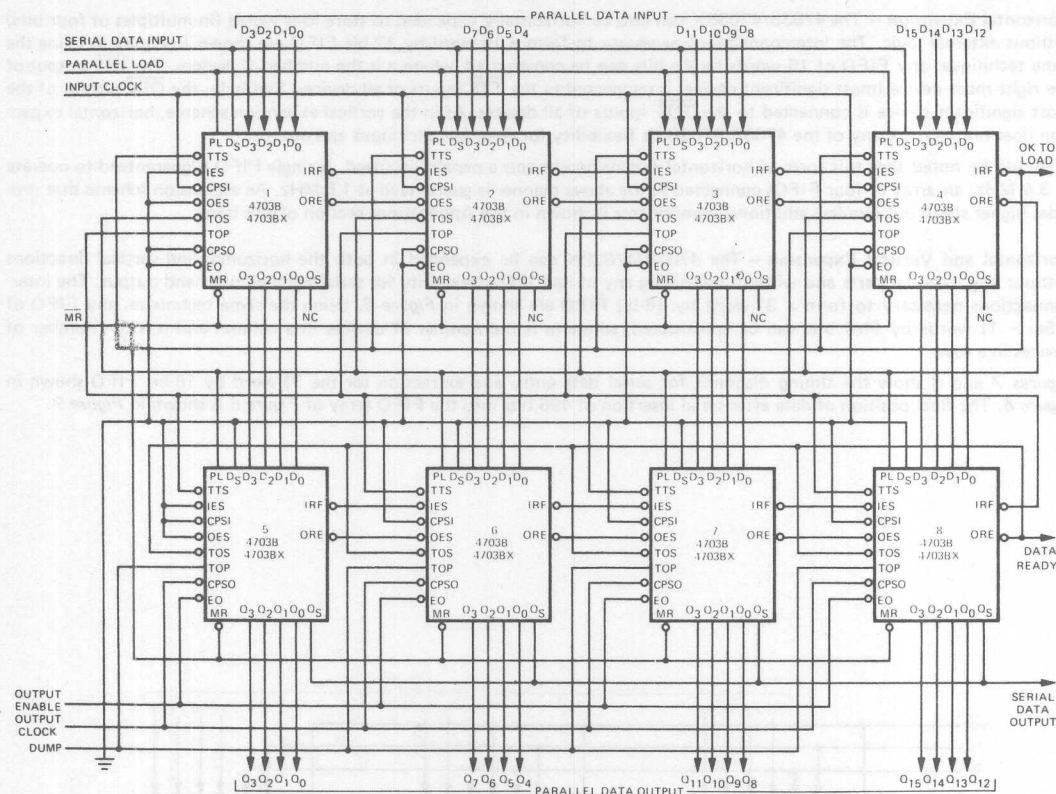


Fig. 6
A 31 X 16 FIFO ARRAY

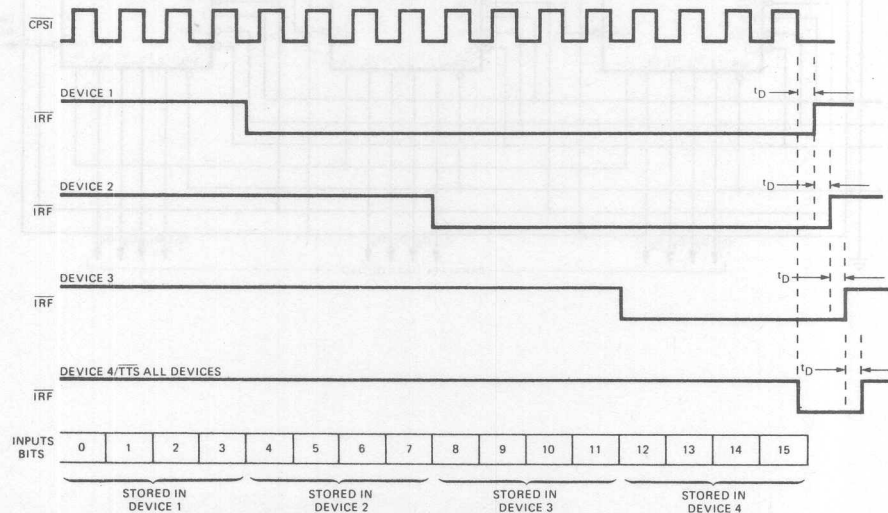


Fig. 7
SERIAL DATA ENTRY FOR ARRAY OF FIG. 6

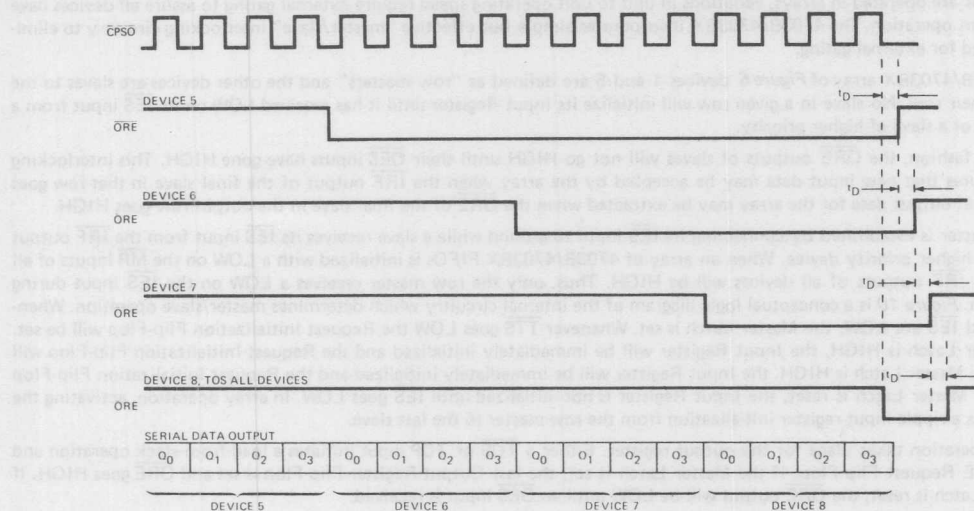


Fig. 8
SERIAL DATA EXTRACTION FOR ARRAY OF FIG. 6

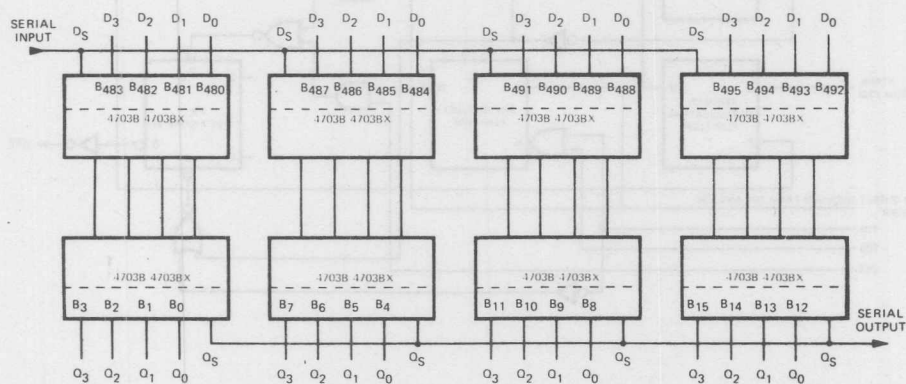


Fig. 9
FINAL POSITION OF A 496-BIT SERIAL INPUT

Interlocking Circuitry — Most conventional FIFO designs provide status signals analogous to $\overline{\text{IRF}}$ and $\overline{\text{ORE}}$. However, when these devices are operated in arrays, variations in unit to unit operating speed require external gating to assure all devices have completed an operation. The 4703B/4703BX incorporates simple but effective "master/slave" interlocking circuitry to eliminate the need for external gating.

In the 4703B/4703BX array of *Figure 6* devices 1 and 5 are defined as "row masters" and the other devices are slaves to the master in their row. No slave in a given row will initialize its Input Register until it has received LOW on its $\overline{\text{IES}}$ input from a row, master or a slave of higher priority.

In a similar fashion, the $\overline{\text{ORE}}$ outputs of slaves will not go HIGH until their $\overline{\text{OES}}$ inputs have gone HIGH. This interlocking scheme ensures that new input data may be accepted by the array when the $\overline{\text{IRF}}$ output of the final slave in that row goes LOW and that output data for the array may be extracted when the $\overline{\text{ORE}}$ of the final slave in the output row goes HIGH.

The row master is established by connecting its $\overline{\text{IES}}$ input to ground while a slave receives its $\overline{\text{IES}}$ input from the $\overline{\text{IRF}}$ output of the next higher priority device. When an array of 4703B/4703BX FIFOs is initialized with a LOW on the $\overline{\text{MR}}$ inputs of all devices, the $\overline{\text{IRF}}$ outputs of all devices will be HIGH. Thus, only the row master receives a LOW on the $\overline{\text{IES}}$ input during initialization. *Figure 10* is a conceptual logic diagram of the internal circuitry which determines master/slave operation. Whenever $\overline{\text{MR}}$ and $\overline{\text{IES}}$ are LOW, the Master Latch is set. Whenever $\overline{\text{TTS}}$ goes LOW the Request Initialization Flip-Flop will be set. If the Master Latch is HIGH, the Input Register will be immediately initialized and the Request Initialization Flip-Flop will be set. If the Master Latch is HIGH, the Input Register will be immediately initialized and the Request Initialization Flip-Flop will be set. If the Master Latch is reset, the Input Register is not initialized until $\overline{\text{IES}}$ goes LOW. In array operation, activating the $\overline{\text{TTS}}$ initiates a ripple input register initialization from the row master to the last slave.

A similar operation takes place for the output register. Either a $\overline{\text{TOS}}$ or $\overline{\text{TOP}}$ input initiates a load-from-stack operation and sets the $\overline{\text{ORE}}$ Request Flip-Flop. If the Master Latch is set, the last Output Register Flip-Flop is set and $\overline{\text{ORE}}$ goes HIGH. If the Master Latch is reset, the $\overline{\text{ORE}}$ output will be LOW until an $\overline{\text{OES}}$ input is received.

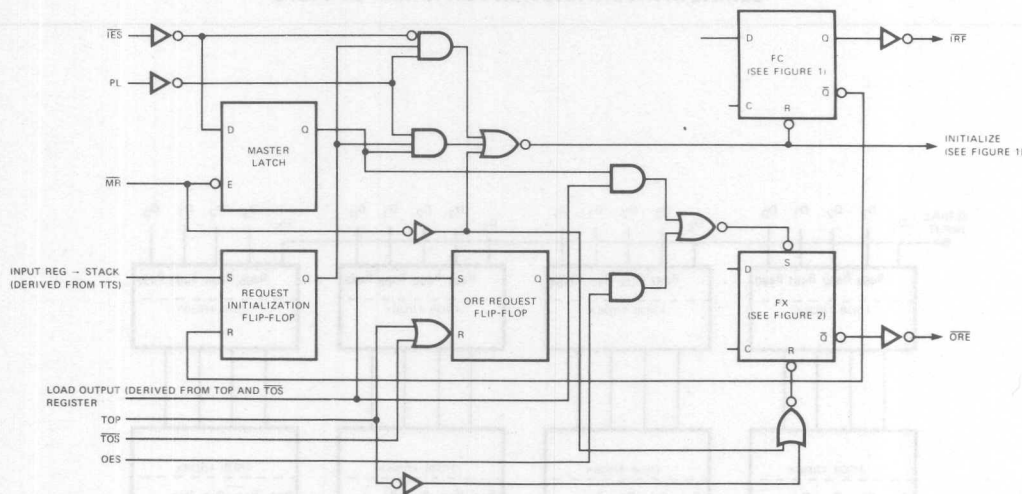


Fig. 10
CONCEPTUAL DIAGRAM, INTERLOCKING CIRCUITRY

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DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF HIGH Current	XC									1.6 12	μA	MIN, 25 °C MAX	Output Returned to V _{DD} , \overline{EO} = V _{DD}
		XM									0.4 12		MIN, 25 °C MAX	
I _{OZL}	Output OFF LOW Current	XC									-1.6 -12	μA	MIN, 25 °C MAX	Output Returned to V _{SS} , \overline{EO} = V _{DD}
		XM									-0.4 -12		MIN, 25 °C MAX	
I _{DD}	Quiescent Power Supply Current	XC			32.5 250			65 500			130 1000	μA	MIN, 25 °C MAX	All Inputs at 0 V or V _{DD}
		XM			8.75 250			17.5 500			35 1000		μA	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ C$ (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PHL}	Propagation Delay, \overline{CPSI} to \overline{IRF}		215	430		81	162		57	114	ns	C _L = 50 pF, R _L = 200 k Ω Input Transition Times \leq 20 ns
t _{PLH}	Propagation Delay, \overline{TTS} to \overline{IRF}		439	878		131	262		92	184	ns	
t _{PLH}	Propagation Delay, \overline{CPSO} to Q _S		306	612		68	136		48	96	ns	
t _{PHL}			299	598		79	158		56	112		
t _{PLH}	Propagation Delay, TOP to Q _N		325	650		128	256		90	180	ns	
t _{PHL}			293	586		114	228		80	160		

Notes on following page.

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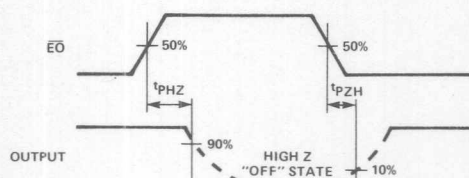
AC CHARACTERISTICS AND SET-UP REQUIREMENTS (Cont'd): V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$

SYMBOL		PARAMETER	LIMITS									UNITS	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PHL}	Propagation Delay, \overline{CPSO} to \overline{ORE}		159	318		74	148		52	104	ns	C _L = 50 pF, R _L = 200 k Ω Input Transition Times ≤ 20 ns	
t _{PLH}	Propagation Delay, \overline{TOS} to \overline{ORE}		320	640		114	228		80	160	ns		
t _{PLH}	Propagation Delay, TOP to \overline{ORE}		401	802		134	268		94	188	ns		
t _{PHL}	Propagation Delay, PL to \overline{IRF}		256	512		109	218		77	154	ns		
t _{PHL}	Propagation Delay, PL to \overline{IRF}		119	238		44	88		31	62	ns		
t _{FT}	Fall Through Time		2020	4040		820	1640		574	1148	ns	(R _L = 1 k Ω to V _{SS}) (R _L = 1 k Ω to V _{DD})	
t _{PZH}	Output Enable Time		51	102		24	48		17	34	ns		
t _{PZL}	Output Disable Time		85	170		33	66		24	48	ns	(R _L = 1 k Ω to V _{SS}) (R _L = 1 k Ω to V _{DD})	
t _{PHZ}	Output Disable Time		64	128		34	68		24	48	ns		
t _{PLZ}	Output Disable Time		80	160		39	78		28	56	ns	(R _L = 1 k Ω to V _{SS}) (R _L = 1 k Ω to V _{DD})	
t _{TLH}	Output Transition Time		46	92		25	50		18	36	ns		
t _{THL}	Output Transition Time		34	68		18	36		13	26	ns		
t _{WCP(H)}	Min \overline{CPSI} Pulse Width (HIGH)	118	59		44	22		31	16		ns		
t _{WCP(L)}	Min \overline{CPSI} Pulse Width (LOW)	220	110		108	54		76	38		ns		
t _{WCP(L)}	Min \overline{CPSO} Pulse Width (LOW)	120	60		60	30		42	21		ns		
t _{WCP(H)}	Min \overline{CPSO} Pulse Width (HIGH)	110	55		72	36		51	26		ns		
t _{WPL(H)}	Min PL Pulse Width (HIGH)	122	61		44	22		31	16		ns		
t _{WTTS(L)}	Min TTS Pulse Width (LOW)	160	80		124	62		87	44		ns		
t _{WTOS(L)}	Min \overline{TOS} Pulse Width (LOW)	182	91		60	30		42	21		ns		
t _{WTOP(L)}	Min TOP Pulse Width (LOW)	142	71		52	26		37	19		ns		
t _{WMR(L)}	Min \overline{MR} Pulse Width (LOW)	192	96		108	54		76	38		ns		
t _{rec}	\overline{MR} Recovery Time	44	22		36	18		26	13		ns		
t _s	Set-Up and Hold Times, D _s to \overline{CPSI}	104	52		40	20		28	14		ns		
t _h	Set-Up and Hold Times, \overline{TTS} to \overline{IRF} , Serial or Parallel Mode	-8	-15		24	12		18	9		ns		
t _s	Set-Up and Hold Times, \overline{TTS} to \overline{IRF} , Serial or Parallel Mode	186	93		98	49		70	35		ns		
t _h	Set-Up and Hold Times, \overline{TTS} to \overline{IRF} , Serial or Parallel Mode	76	38		52	26		38	19		ns		
t _s	Set-Up Time, \overline{ORE} to \overline{TOS}	-151	-302		-21	-42		-15	-30		ns		
f _{MAX}	Input CLOCK Frequency (Note 2)	1.1	2.3		2.6	5.3		3.4	6.9		ns		

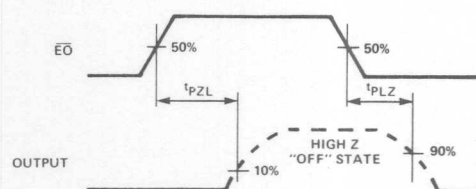
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. For f_{MAX} input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
3. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

SWITCHING WAVEFORMS



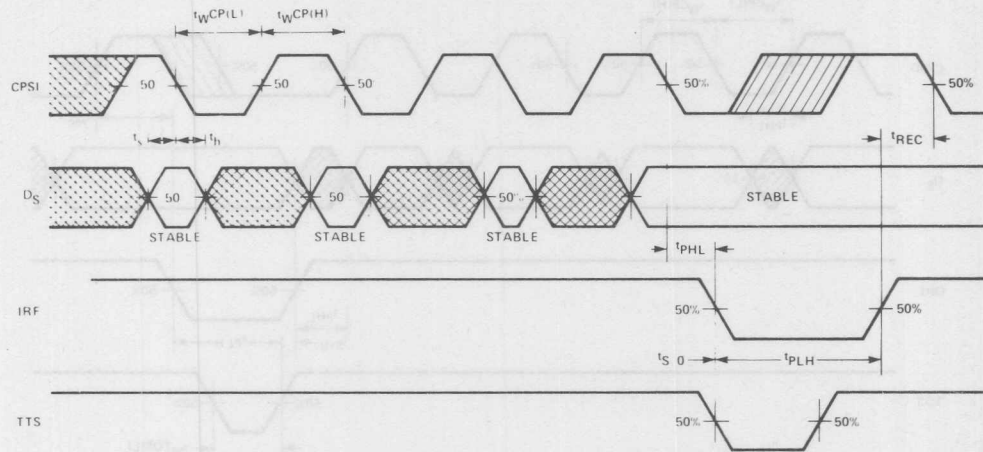
OUTPUT ENABLE TIME
(t_{PZH}) AND OUTPUT DISABLE TIME (t_{PHZ})



OUTPUT ENABLE TIME
(t_{PZL}) AND OUTPUT DISABLE TIME (t_{PLZ})

SWITCHING WAVEFORMS (Cont'd)

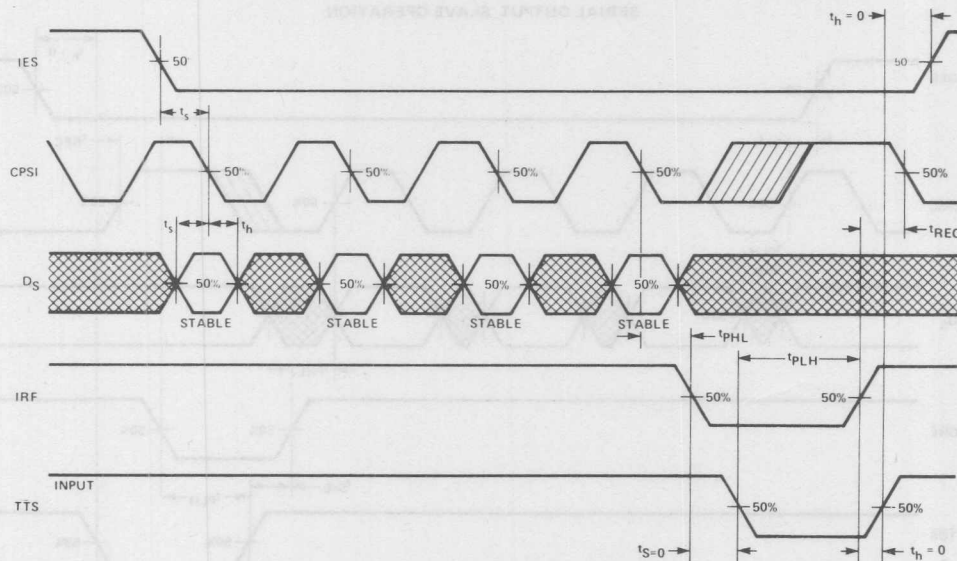
SERIAL INPUT UNEXPANDED OR MASTER OPERATION



MINIMUM \overline{CPSI} PULSE WIDTH, PROPAGATION DELAY, \overline{CPSI} TO \overline{IRF} AND \overline{TTS} TO \overline{IRF} , RECOVERY TIME, \overline{IRF} TO \overline{CPSI} , AND SET-UP AND HOLD TIMES, D_S TO \overline{CPSI} , AND \overline{TTS} TO \overline{IRF} .

CONDITIONS: STACK NOT FULL, \overline{IES} , $PL = LOW$

SERIAL INPUT EXPANDED SLAVE OPERATION



PROPAGATION DELAY, \overline{CPSI} TO \overline{IRF} AND \overline{TTS} TO \overline{IRF} , RECOVERY TIME, \overline{IRF} TO \overline{CPSI} AND SET-UP AND HOLD TIMES, \overline{IES} TO \overline{CPSI} , D_S TO \overline{CPSI} AND \overline{TTS} TO \overline{IRF} .

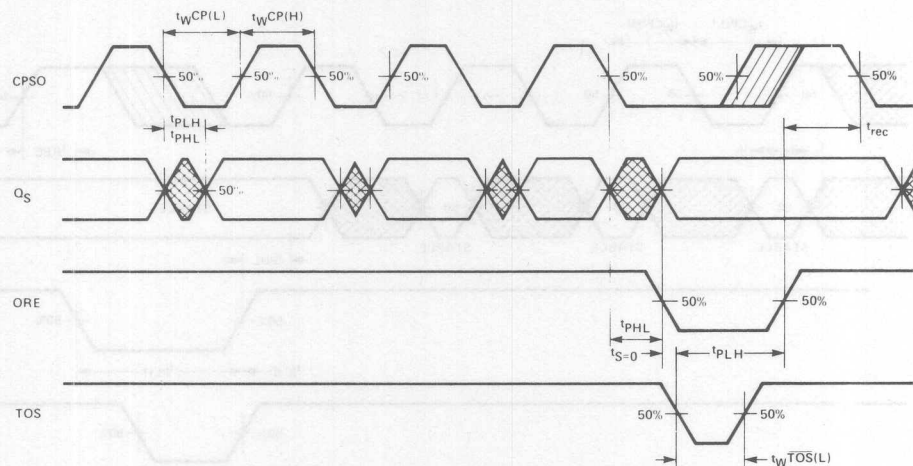
CONDITIONS: STACK NOT FULL $\overline{IES} = HIGH$ WHEN INITIALIZED, $PL = LOW$

NOTE:

Set up and hold times are shown as positive values but may be specified as negative values.

SWITCHING WAVEFORMS (Cont'd)

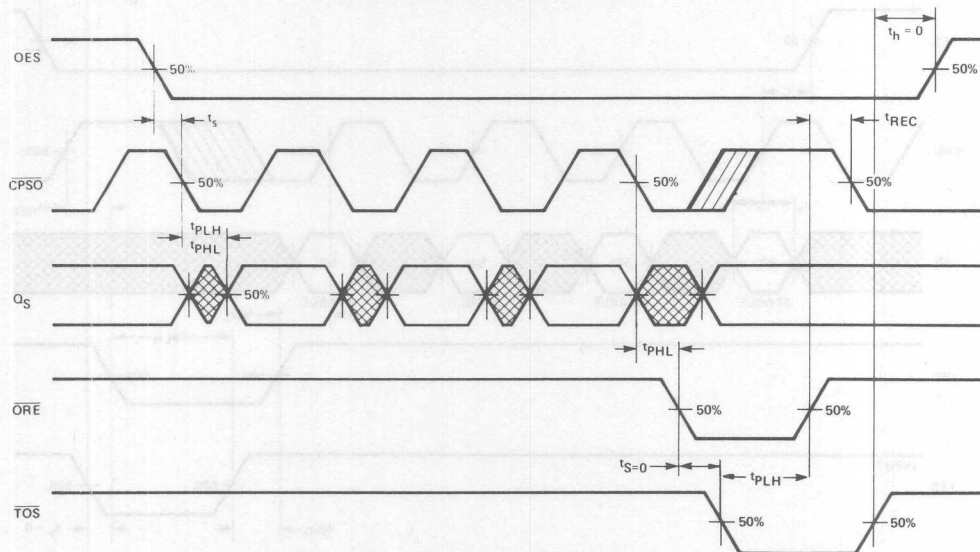
SERIAL OUTPUT, UNEXPANDED OR MASTER OPERATION



ORE RECOVERY TIME, PROPAGATION DELAY CP50 TO Q5, CP50 TO ORE, TOS TO ORE, MINIMUM CP50 PULSE WIDTH, MINIMUM TOS PULSE WIDTH AND SET-UP TIME ORE TO TOS.

CONDITIONS: DATA IN STACK, TOP = HIGH, IES = LOW
WHEN INITIALIZED, OES = LOW

SERIAL OUTPUT, SLAVE OPERATION



ORE RECOVERY TIME, PROPAGATION DELAY CP50 TO Q5, CP50 TO ORE, TOS TO ORE, AND SET-UP

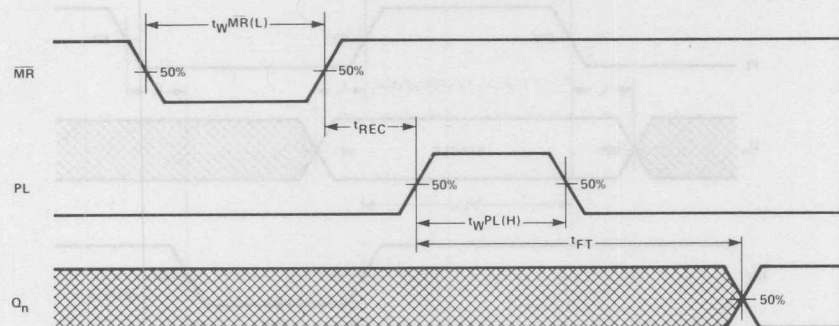
AND HOLD TIMES, OES TO CP50, ORE TO TOS, TOS TO OES

CONDITIONS: DATA IN STACK, TOP = HIGH, IES = HIGH
WHEN INITIALIZED

NOTE:

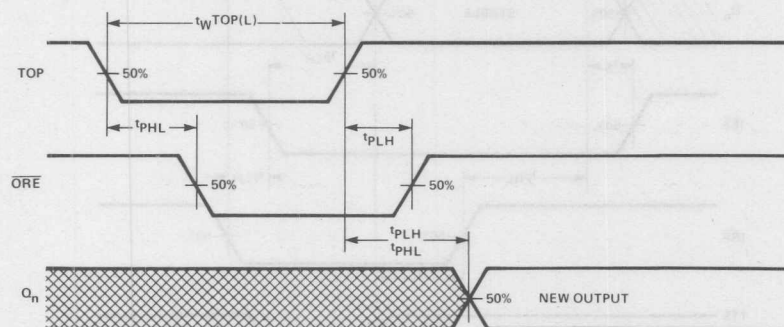
Set-up (t_s) and hold times (t_h) are shown as positive values but may be specified as negative values.

FALL THROUGH TIME



MINIMUM \overline{MR} AND PL PULSE WIDTHS, RECOVERY TIME
FOR MR AND FALL THROUGH TIME

CONDITIONS: \overline{TTS} CONNECTED TO \overline{IRF} , \overline{TOS} CONNECTED
TO \overline{ORE} , \overline{IES} , \overline{OES} , \overline{EO} , \overline{CPSO} = LOW, TOP = HIGH

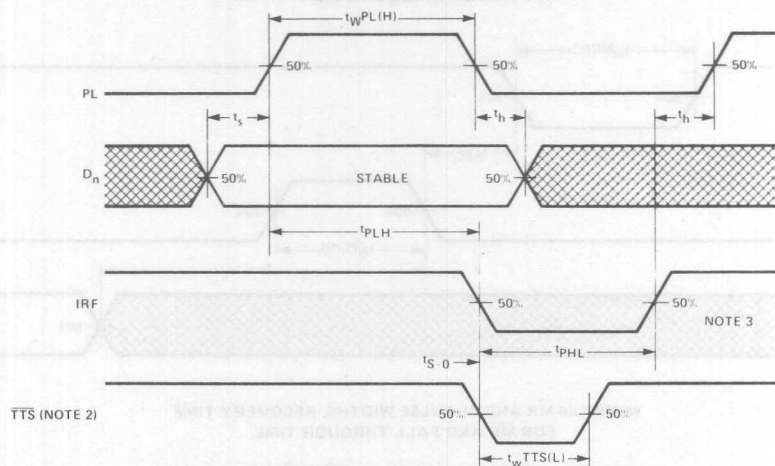
PARALLEL OUTPUT, FOUR BIT WORD OR
MASTER IN PARALLEL EXPANSION

PROPAGATION DELAY, TOP TO \overline{ORE} , TOP TO Q_n , AND
MINIMUM TOP PULSE WIDTH

CONDITIONS: \overline{IES} = LOW WHEN INITIALIZED, \overline{EO} = \overline{CPSO} =
LOW. DATA AVAILABLE IN STACK

SWITCHING WAVEFORMS (Cont'd)

PARALLEL LOAD MODE, FOUR BIT WORD (UNEXPANDED)
OR MASTER IN PARALLEL EXPANSION



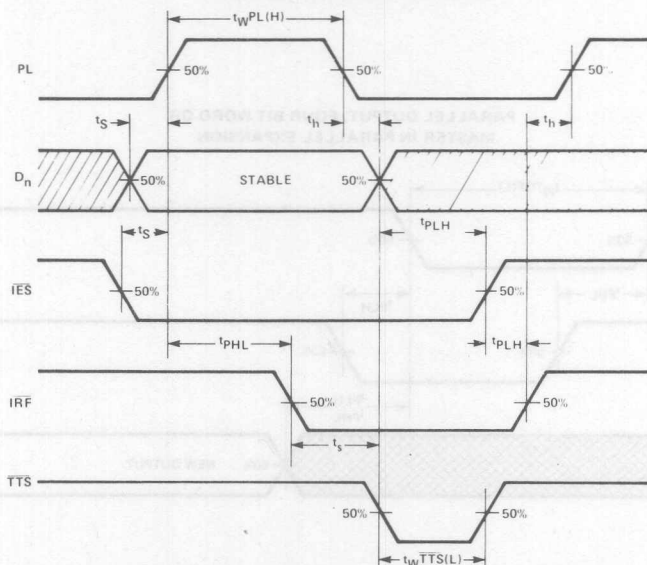
PROPAGATION DELAY PL TO $\overline{\text{IRF}}$, $\overline{\text{TTS}}$ TO $\overline{\text{IRF}}$,
MINIMUM PL AND $\overline{\text{TTS}}$ PULSE WIDTHS, AND SET-UP AND
HOLD TIMES D_n TO PL, $\overline{\text{IRF}}$ TO PL, $\overline{\text{TTS}}$ TO $\overline{\text{IRF}}$.

CONDITIONS: STACK NOT FULL, $\overline{\text{IES}}$ = LOW
WHEN INITIALIZED

NOTES:

1. Initialization requires a master reset to occur after power has been applied.
2. $\overline{\text{TTS}}$ normally connected to $\overline{\text{IRF}}$.
3. If stack is full, $\overline{\text{IRF}}$ will stay LOW.

PARALLEL LOAD, SLAVE MODE



PROPAGATION DELAY, $\overline{\text{TTS}}$ TO $\overline{\text{IES}}$, $\overline{\text{IES}}$ TO $\overline{\text{IRF}}$, PL TO $\overline{\text{IRF}}$,
MINIMUM PL AND $\overline{\text{TTS}}$ PULSE WIDTHS, AND SET-UP AND
HOLD TIMES, D_n TO PL, $\overline{\text{IRF}}$ TO $\overline{\text{TTS}}$, $\overline{\text{IRF}}$ TO PL

CONDITIONS: STACK NOT FULL, DEVICE INITIALIZED
WITH $\overline{\text{IES}}$ HIGH

NOTE:

Set-up (t_s) and hold times (t_h) are shown as positive values but may be specified as negative values.

4704B/4704BX

DATA PATH SWITCH

FAIRCHILD CMOS MACROLOGIC

DESCRIPTION — The 4704B/4704BX Data Path Switch (DPS) is a combinatorial array for closing data path loops around arithmetic/logic networks such as the 4705B/4705BX (Arithmetic Logic Register Stack). A total of 30 instructions (see *Table 1*) facilitate logic shifting, masking, sign extension, introduction of common constants and other operations.

The 5-bit Instruction (I_0 – I_4) selects one of the 32 instructions operating on two sets of 4-bit data inputs (D_0 – D_3 , K_0 – K_3). Left Input (LI) and Left Output (LO) and Right Input (RI) and Right Output (RO) are available for expansion in 4-bit increments. An active LOW Output Enable input (\overline{EO}) provides 3-state control of the data outputs (O_0 – O_3) for bus oriented applications.

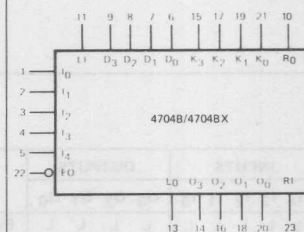
The 4704B/4704BX is fully compatible with all CMOS families. The 4704B is specified to operate over a power supply voltage range of 4.5 V to 12.5 V. The 4704BX is specified to operate over a power supply voltage range of 3 V to 15 V.

- EXPANDABLE IN MULTIPLES OF FOUR BITS
- TWO 4-BIT DATA INPUT BUSES
- 4-BIT DATA OUTPUT BUS WITH 3-STATE OUTPUT BUFFERS
- USEFUL FOR BYTE MASKING AND SWAPPING
- PROVIDES ARITHMETIC OR LOGIC SHIFT
- PROVIDES FOR SIGN EXTENSION
- GENERATES COMMONLY USED CONSTANTS
- SLIM 24-PIN PACKAGE

PIN NAMES

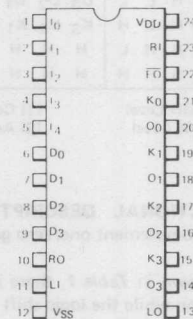
D_0 – D_3	D-Bus Inputs
K_0 – K_3	K-Bus Inputs
I_0 – I_4	Instruction Input
LI	Shift Left Input
LO	Shift Left Output
RI	Shift Right Input
RO	Shift Right Output
\overline{EO}	Output Enable Input (Active LOW)
O_0 – O_3	Data Outputs

LOGIC SYMBOL



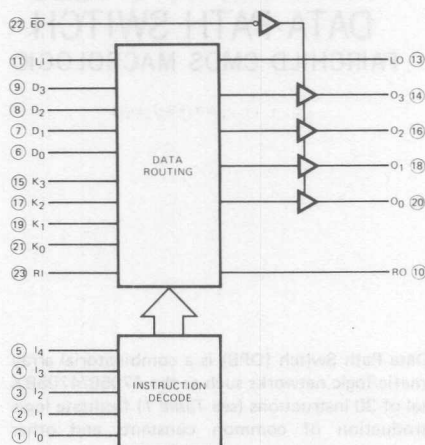
V_{DD} = Pin 24
 V_{SS} = Pin 12

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

BLOCK DIAGRAM



VDD = Pin 24

VSS = Pin 12

○ = Pin Number

TABLE 1
INSTRUCTION SET FOR THE 4704B/4704BX

INPUTS					OUTPUTS					FUNCTION
I ₄	I ₃	I ₂	I ₁	I ₀	O ₃	O ₂	O ₁	O ₀	RO	
L	L	L	L	L	L	L	L	L	L	Byte Mask
L	L	L	L	H	H	H	H	H	H	Byte Mask
L	L	L	H	L	L	L	L	H	H	Minus "2" in 2s Comp ⁽¹⁾
L	L	L	H	H	L	L	L	L	H	Minus "1" in 2s Comp ⁽¹⁾
L	L	H	L	L	D ₃	D ₂	D ₁	D ₀	H	Byte Mask, D-Bus
L	L	H	L	H	H	H	H	H	H	Byte Mask, D-Bus
L	L	H	H	L	D ₃	D ₂	D ₁	D ₀	H	Byte Mask, D-Bus
L	L	H	H	H	L	L	L	L	H	Byte Mask, D-Bus
L	H	L	L	L	L	H	H	H	H	Negative Byte Sign Mask
L	H	L	L	H	H	H	H	H	H	Positive Byte Sign Mask
L	H	L	H	L	K ₃	K ₂	K ₁	K ₀	H	Byte Mask, K-Bus
L	H	L	H	H	L	L	L	L	H	Byte Mask, K-Bus
L	H	H	L	L	D ₃	D ₂	D ₁	D ₀	H	Load Byte
L	H	H	L	H	K ₃	K ₂	K ₁	K ₀	H	Load Byte
L	H	H	H	L	H	H	H	L	H	Plus "1"
L	H	H	H	H	H	H	H	H	H	Zero
H	L	L	L	L	L	L	L	L	L	K-Bus Sign Extend
H	L	L	L	H	K ₃	K ₂	K ₁	K ₀	H	K-Bus Sign Extend
H	L	L	H	L	R ₁	R ₁	R ₁	R ₁	R ₁	D-Bus Sign Extend
H	L	L	H	H	D ₃	D ₃	D ₂	D ₁	D ₀	D-Bus Sign Extend
H	L	H	L	L	D ₃	D ₂	D ₁	D ₀	R ₁	D-Bus Shift Left
H	L	H	L	H	K ₃	K ₂	K ₁	K ₀	R ₁	K-Bus Shift Left
H	L	H	H	L	L ₁	D ₃	D ₂	D ₁	D ₀	D-Bus Shift Right
H	L	H	H	H	D ₃	D ₃	D ₂	D ₁	D ₀	D-Bus Shift Right Arith ⁽²⁾
H	H	L	L	L	L ₁	K ₃	K ₂	K ₁	K ₀	K-Bus Shift Right
H	H	L	L	H	K ₃	K ₃	K ₂	K ₁	K ₀	K-Bus Shift Right Arith ⁽²⁾
H	H	L	H	L	K ₃	K ₂	K ₁	K ₀	H	Byte Mask, K-Bus
H	H	L	H	H	H	H	H	H	H	Byte Mask, K-Bus
H	H	H	L	L	D ₃	D ₂	D ₁	D ₀	H	Complement D-Bus
H	H	H	L	H	K ₃	K ₂	K ₁	K ₀	H	Complement K-Bus
H	H	H	H	L	H	H	H	H	H	Undefined (Reserved)
H	H	H	H	H	H	H	H	H	H	Undefined (Reserved)

H = HIGH Level
L = LOW Level

(1) Comp = Complement
(2) Arith = Arithmetic

FUNCTIONAL DESCRIPTION — The 4704B/4704BX combines the functions of a dual 4-input multiplexer, a true/complement one/zero generator, and a shift left/shift right array.

As shown in Table 1, there are two shift right modes. The arithmetic right shift preserves the sign bit in the most significant position while the logic shift moves all positions. Right shift is defined as a 1-bit shift toward the least significant position.

For half-word arithmetic the 4704B/4704BX provides instructions which extend the sign bit left through the more significant slices. Shift linkages are available as individual inputs and outputs for complete flexibility.

The 4704B/4704BX may be used to generate constants +1, 0, -1 and -2 in complement notation.

EXPANSION – Arrays of larger than 4-bit word lengths are easily obtained. Figure 1 illustrates a 16-bit array constructed using four devices; device 1 is the least significant and device 4 is the most significant slice. Within each slice, inputs and outputs with '0' subscript are the least significant bits.

The I_1 through I_4 inputs of all devices are bussed. These four bus lines together with the I_0 inputs of the devices form an 8-bit instruction bus to control the array. In some applications, it may be possible to connect the I_0 inputs of devices 1 and 2 together and the I_0 inputs of devices 3 and 4 together, so that only six bits are needed to control the arrays. Connecting the LO of device 1 to RI of device 2, LO of device 2 to RI of device 3, etc., provides left shift (*i.e.*, shift towards most significant bit) and sign extension. In a similar fashion right shift operation is accomplished by connecting the LI input of a device to the RO of the next more significant device.

The sign-extend group consists of two adjacent instructions differing only in I_0 (refer to Table 1). When the code HLLHH is placed on the instruction inputs (D-Bus Sign Extend), the most significant bit of the D bus (D_3) is available on the LO output. The companion code HLLHL will copy the RI input (connected to LO of the previous stage) onto the output bus (D_0 – D_3) and to its own LO output. Thus when a sign extend function is desired (*e.g.*, arithmetic operations on the eight least significant bits in a 16-bit machine) the code HLLH will be applied to instruction inputs (I_4, I_3, I_2, I_1) of all the 4704B/4704BX's. I_0 of the most significant byte will be LOW and I_0 of the least significant byte will be HIGH. In a similar fashion sign-extend function on a number present on the K-Bus is executed by the code HLLL on I_4, I_3, I_2 , and I_1 .

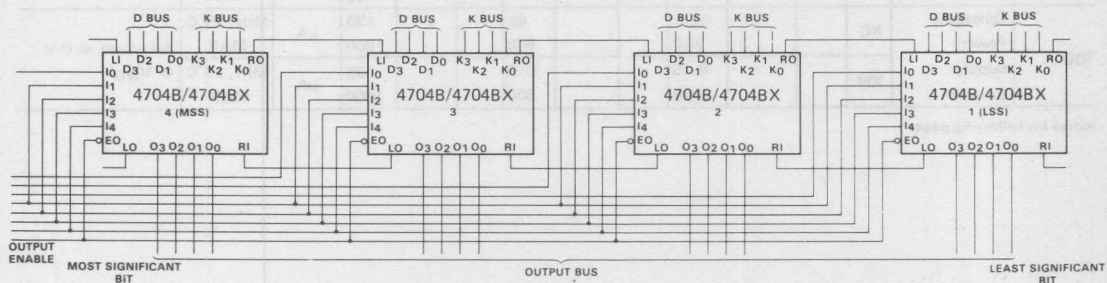


Fig. 1
16-BIT 4704B/4704BX ARRAY

The 4704B/4704BX provides several options for masking operations. For example, Byte Mask operation (LLLL on I_4, I_3, I_2, I_1) will force the output bus either HIGH or LOW depending on I_0 . Connecting I_0 of the most significant byte HIGH and I_0 of the least significant byte LOW will force the outputs of the DPS array to state of 00FF (in hexadecimal notation) 16. A LOW on any output is assumed as logic 1. When the output bus of the 4704B/4704BX is used as an input to a 16-bit Arithmetic Logic Register Stack (ALRS) network (see Figure 2), the ALRS can execute a logic AND function between its inputs bus and one of its registers, thus masking the least significant byte of that register. More complex masking operation can be executed using the Byte AND Mask and Byte OR Mask operations (see Table 1).

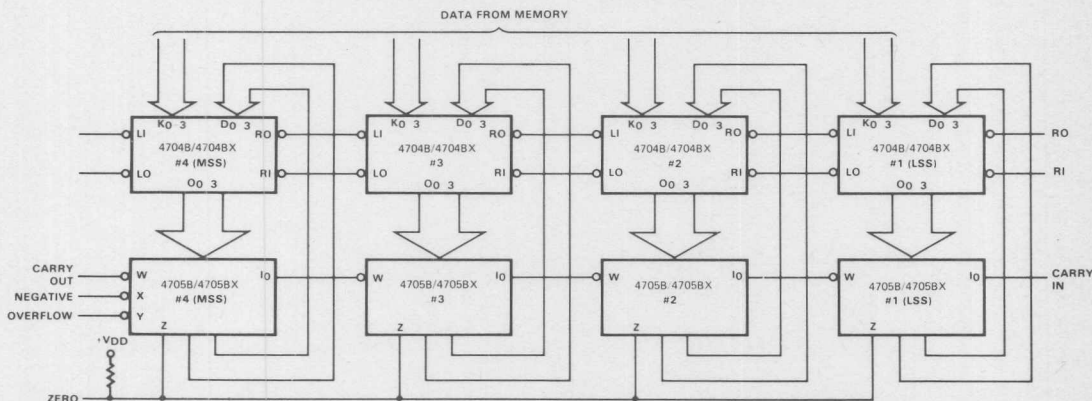


Fig. 2
16-BIT DATA PATH

FAIRCHILD CMOS • 4704B/4704BX

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF HIGH Current	XC									1.6	μA	MIN, 25°C	Output Returned to V _{DD} , E _O = V _{DD}
											12		MAX	
		XM									0.4		MIN, 25°C	
											12		MAX	
I _{OZL}	Output OFF LOW Current	XC									-1.6	μA	MIN, 25°C	Output Returned to V _{SS} , E _O = V _{DD}
											-12		MAX	
		XM									-0.4		MIN, 25°C	
											-12		MAX	
I _{DD}	Quiescent Power	XC			32.5			65			130	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					250			500			1000		MAX	
	Supply Current	XM			8.75			17.5			35	MIN, 25°C		
					250			500			1000	MAX		

Notes on following page.

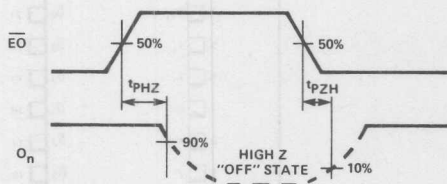
AC CHARACTERISTICS AND SET-UP REQUIREMENTS (Cont'd): V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, D _n , K _n to O _n		192	384		76	152		53	106	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			232	464		85	170		56	112	ns	
t _{PLH}	Propagation Delay, D _n , K _n to LO, RO		100	200		56	112		41	82	ns	
t _{PHL}			162	324		55	110		42	84	ns	
t _{PLH}	Propagation Delay, RI to LO		106	212		63	126		49	98	ns	
t _{PHL}			178	356		61	122		49	98	ns	
t _{PLH}	Propagation Delay, LI to RO		133	266		56	112		37	74	ns	
t _{PHL}			166	332		61	122		41	82	ns	
t _{PLH}	Propagation Delay, I _n to O _n		204	408		83	166		57	114	ns	
t _{PHL}			245	490		87	174		59	118	ns	
t _{PLH}	Propagation Delay, I _n to RO, LO		122	244		66	132		48	96	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PHL}			199	398		69	138		50	100	ns	
t _{PZH}	Output Enable Time		47	94		19	38		15	30	ns	
t _{PZL}			68	136		29	58		21	42	ns	
t _{PHZ}	Output Disable Time		46	92		41	82		34	68	ns	
t _{PLZ}			47	94		31	62		20	40	ns	
t _{TLH}	Output Transition Time, O _n		80	160		43	86		32	64	ns	r _s
t _{THL}			129	258		38	76		26	52	ns	
t _{TLH}	Output Transition Time, LO and RO		74	148		42	84		32	64	ns	
t _{THL}			76	152		40	80		27	54	ns	

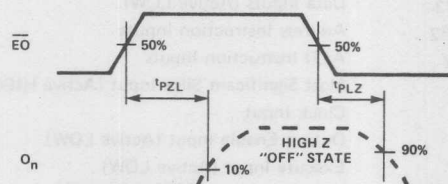
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

SWITCHING WAVEFORMS



OUTPUT ENABLE TIME
(t_{PZH}) AND OUTPUT DISABLE TIME (t_{PHZ})



OUTPUT ENABLE TIME
(t_{PZL}) AND OUTPUT DISABLE TIME (t_{PLZ})

4705B/4705BX

ARITHMETIC LOGIC REGISTER STACK

FAIRCHILD CMOS MACROLOGIC™

DESCRIPTION — The Arithmetic Logic Register Stack (ALRS) is designed to implement accumulators in high performance microprogrammed digital systems. The device contains a 4-bit arithmetic logic unit (ALU), an 8-word by 4-bit RAM, and associated control logic. The ALU implements eight arithmetic and logic functions where one 4-bit operand is supplied from an external source (input data bus) and the second 4-bit operand is supplied internally from one of the eight RAM words selected by the Address Inputs (A_0 - A_2). The result of the operation is loaded into the same RAM location and simultaneously, is loaded into the Output Register making it available at the 3-state output data bus.

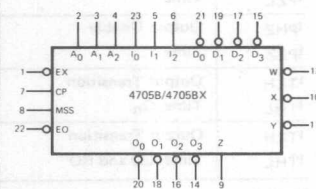
The 4705B/4705BX operates on four bits of data but features are provided for expansion to longer word lengths. Carry propagate and carry generate facilities are provided for an external carry lookahead where maximum operating speed is required. In applications where high-speed arithmetic is not needed, ripple expansion may also be implemented. The 4705B/4705BX provides three status signals: Zero, Negative and Overflow. These qualify the result of an operation. The 4705B/4705BX is fully compatible with all CMOS families. The 4705B is specified to operate over a power supply voltage range of 4.5 V to 12.5 V. The 4705BX is specified to operate over a power supply voltage range of 3 V to 15 V.

- VERY LOW POWER DISSIPATION
- EIGHT ACCUMULATORS IN A SINGLE PACKAGE
- HIGH SPEED—3.8 MHz MICROINSTRUCTION RATE TYPICALLY AT $V_{DD}=10V$
- EXPANDABLE IN MULTIPLES OF FOUR BITS
- PROVIDES FOR RIPPLE OR CARRY LOOKAHEAD
- IMPLEMENTS 64 MICROINSTRUCTIONS
- PROVIDES STATUS — ZERO, NEGATIVE, AND OVERFLOW
- 3-STATE OUTPUTS
- SLIM 24-PIN PACKAGE

PIN NAMES

\bar{D}_0 - \bar{D}_3	Data Inputs (Active LOW)
A_0 - A_2	Address Instruction Inputs
I_0 - I_2	ALU Instruction Inputs
MSS	Most Significant Slice Input (Active HIGH)
CP	Clock Input
$\bar{E}O$	Output Enable Input (Active LOW)
$\bar{E}X$	Execute Input (Active LOW)
\bar{O}_0 - \bar{O}_3	Data Outputs (Active LOW)
\bar{W}	Ripple Carry Outputs (Active LOW)
\bar{X}	Carry Propagate Output
\bar{Y}	Carry Generate Output
Z	Zero Status Output (Active HIGH, Open Collector)

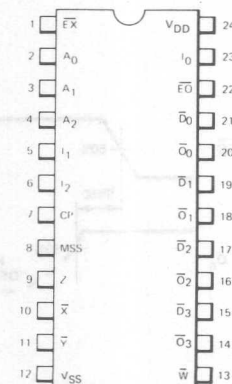
LOGIC SYMBOL



V_{DD} = Pin 24

V_{SS} = Pin 12

CONNECTION DIAGRAM DIP (TOP VIEW)



BLOCK DIAGRAM

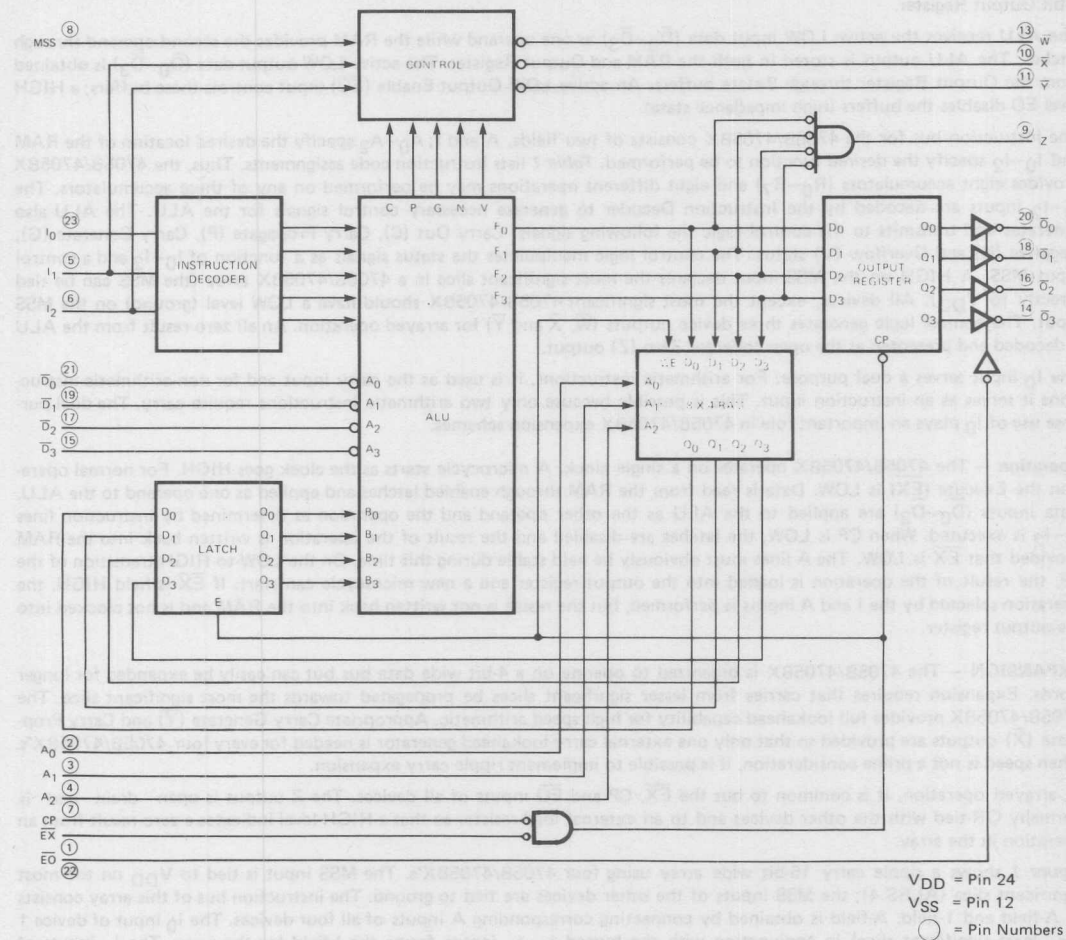


TABLE 1
INSTRUCTION FIELD ASSIGNMENT

I ₂ I ₁ I ₀	INTERNAL OPERATION	
L L L	R _x plus D-Bus plus 1 → R _x	Accumulate
L L H	R _x plus D-Bus → R _x	Accumulate
L H L	R _x • D-Bus → R _x	Logical AND
L H H	D-Bus → R _x	Load
H L L	R _x → Output Register	Output
H L H	R _x + D-Bus →	Logical OR
H H L	R _x ⊕ D-Bus → R _x	Exclusive OR
H H H	D-Bus → R _x	Load Complement

H = HIGH Level L = LOW Level

NOTES:

1. R_x is the RAM location addressed by A₀-A₂.
2. The result of any operation is always loaded into the Output Register.

FUNCTIONAL DESCRIPTION — As shown in the block diagram, the 4705B/4705BX Arithmetic Logic Register Stack (ALRS) consists of a 4-bit ALU, an 8-word by 4-bit RAM with output latches, an Instruction Decoder, Control Logic and a 4-bit Output Register.

The ALU receives the active LOW input data ($\bar{D}_0\text{--}\bar{D}_3$) as one operand while the RAM provides the second operand through latches. The ALU output is stored in both the RAM and Output Register. The active LOW output data ($\bar{O}_0\text{--}\bar{O}_3$) is obtained from the Output Register through 3-state buffers. An active LOW Output Enable (\bar{EO}) input controls these buffers; a HIGH level \bar{EO} disables the buffers (high impedance state).

The instruction bus for the 4705B/4705BX consists of two fields, A and I; $A_0\text{--}A_2$ specify the desired location of the RAM and $I_0\text{--}I_2$ specify the desired function to be performed. Table 1 lists instruction code assignments. Thus, the 4705B/4705BX provides eight accumulators ($R_0\text{--}R_7$) and eight different operations may be performed on any of these accumulators. The $I_0\text{--}I_2$ inputs are decoded by the Instruction Decoder to generate necessary control signals for the ALU. The ALU also generates and transmits to the control logic the following signals: Carry Out (C), Carry Propagate (P), Carry Generate (G), Negative (N) and Overflow (V) status. The control logic manipulates the status signals as a function of $I_0\text{--}I_2$ and a control input MSS. A HIGH on the MSS input declares the most significant slice in a 4705B/4705BX array (the MSS can be tied directly to V_{DD}). All devices, except the most significant 4705B/4705BX should have a LOW level (ground) on the MSS input. The control logic generates three device outputs (\bar{W} , \bar{X} and \bar{Y}) for arrayed operation. An all zero result from the ALU is decoded and presented at the open collector Zero (Z) output.

The I_0 input serves a dual purpose. For arithmetic instructions, it is used as the carry input and for non-arithmetic instructions it serves as an instruction input. This is possible because only two arithmetic instructions require carry. The dual purpose use of I_0 plays an important role in 4705B/4705BX expansion schemes.

Operation — The 4705B/4705BX operates on a single clock. A microcycle starts as the clock goes HIGH. For normal operation the Execute (\bar{EX}) is LOW. Data is read from the RAM through enabled latches and applied as one operand to the ALU. Data inputs ($\bar{D}_0\text{--}\bar{D}_3$) are applied to the ALU as the other operand and the operation as determined by instruction lines $I_0\text{--}I_2$ is executed. When CP is LOW, the latches are disabled and the result of the operation is written back into the RAM provided that \bar{EX} is LOW. The A lines must obviously be held stable during this time. On the LOW-to-HIGH transition of the CP, the result of the operation is loaded into the output register and a new microcycle can start. If \bar{EX} is held HIGH, the operation selected by the I and A inputs is performed, but the result is not written back into the RAM and is not clocked into the output register.

EXPANSION — The 4705B/4705BX is organized to operate on a 4-bit wide data bus but can easily be expanded for longer words. Expansion requires that carries from lesser significant slices be propagated towards the most significant slice. The 4705B/4705BX provides full lookahead capability for high speed arithmetic. Appropriate Carry Generate (\bar{Y}) and Carry Propagate (\bar{X}) outputs are provided so that only one external carry lookahead generator is needed for every four 4705B/4705BX's. When speed is not a prime consideration, it is possible to implement ripple carry expansion.

In arrayed operation, it is common to bus the \bar{EX} , CP and \bar{EO} inputs of all devices. The Z output is open drain and is normally OR-tied with the other devices and to an external load resistor so that a HIGH level indicates a zero result from an operation in the array.

Figure 1 shows a ripple carry 16-bit wide array using four 4705B/4705BX's. The MSS input is tied to V_{DD} on the most significant slice (ALRS 4); the MSS inputs of the other devices are tied to ground. The instruction bus of this array consists of A-field and I-field. A-field is obtained by connecting corresponding A inputs of all four devices. The I_0 input of device 1 (i.e., least significant slice) in conjunction with the bussed I_1 , I_2 inputs forms the I-field for the array. The I_0 inputs of devices 2, 3 and 4 are connected to the \bar{W} outputs of devices 1, 2 and 3 respectively. The ALU network generates the carry propagate output. The control logic operates on this signal as a function of I_1 and I_2 to generate the \bar{W} output. If both I_1 and I_2 are LOW (i.e., an arithmetic instruction), the \bar{W} output is the carry output of that slice. In case of non-arithmetic instructions, it assumes the state of the I_0 input. Thus, in Figure 1, if an arithmetic instruction is specified, carry propagates through the \bar{W} output to I_0 input of the next higher significant slice. On the other hand, non-arithmetic instructions effectively connect all I_0 inputs together to form the I-field for the array. The \bar{W} output of device 4 is the carry output from the array. The control logic also generates \bar{X} and \bar{Y} outputs which participate in expansion when full carry lookahead is required. These outputs are normally ignored in ripple expansion except for the most significant slice. In the most significant slice, \bar{X} and \bar{Y} correspond to Negative and Overflow status signals.

The \bar{X} output of device 4 is LOW, if the result of an operation has its most significant bit as "1" (i.e., negative result). Similarly a LOW on \bar{Y} output of device 4 indicates that arithmetic overflow has occurred. If the two operands have the same sign and the result has opposite sign, then it is assumed that an overflow has occurred. It should be noted that \bar{W} , \bar{X} and \bar{Y} are not controlled by \bar{EX} or CP. Figure 2 shows a 16-bit array with full carry lookahead expansion. Implementation of the lookahead scheme requires the use of an external 4582B in addition to the four 4705B/4705BX's in the array. Since device 1 is the least significant and device 4 is the most significant slice, the MSS inputs of the first three devices are connected to ground while device 4 has a HIGH at this input. The A-field for the array instruction bus is obtained by connecting corresponding A inputs of all four devices. Bussed I_1 and I_2 inputs together with the I_0 input of device 1 from the I-field for the array. The I_0 inputs for devices 2, 3 and 4 are obtained from the 4582B Carry Outputs (C_{n+x} , C_{n+z} respectively). Also the P and G inputs of

4582B are connected to \bar{X} and \bar{Y} outputs of the 4705B/4705BX as shown. The control logic in the 4705B/4705BX (see block diagram) generates \bar{X} and \bar{Y} outputs as a function of I_1 , I_2 and MSS inputs as well as the Carry Generate and Carry Propagate outputs of the ALU. If the MSS input of a slice is LOW and an arithmetic instruction is specified, its \bar{X} output is treated as carry-in into a slice irrespective of MSS. Thus, whenever I_1 and I_2 are LOW, the array behaves as an adder with full carry lookahead. The \bar{W} outputs still reflect carry output, which is ignored for devices 1, 2 and 3. The \bar{W} output of device 4 is the carry output from the array. Also note that the I_0 input of device 1 is not only an instruction input but also provides the carry input to the array so the I_0 input of device 1 must be connected to the appropriate 4582B input as shown.

When a non-arithmetic instruction is specified to the array, the control logic of the 4705B/4705BX forces a LOW on \bar{X} and a HIGH on \bar{Y} outputs on all except the most significant slice. An examination of the 4582B logic reveals that whenever P is LOW and G is HIGH the associated carry output is the same as the carry input. Thus, in Figure 2 devices 2, 3, and 4 will assume the logic level as that presented to the I_0 input of device 1 during non-arithmetic instructions effectively bussing I_0 through all four devices. As in the case of ripple expansion \bar{X} and \bar{Y} outputs of device 4 represent Negative and Overflow from the array.

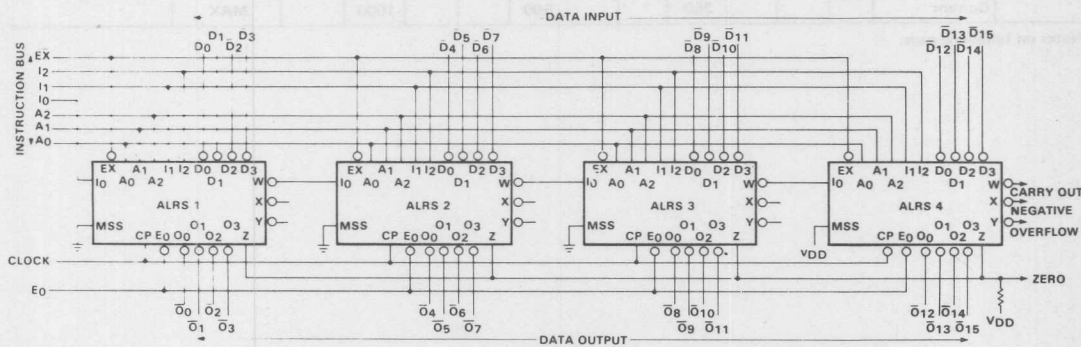


Fig. 1
RIPLE CARRY EXPANSION

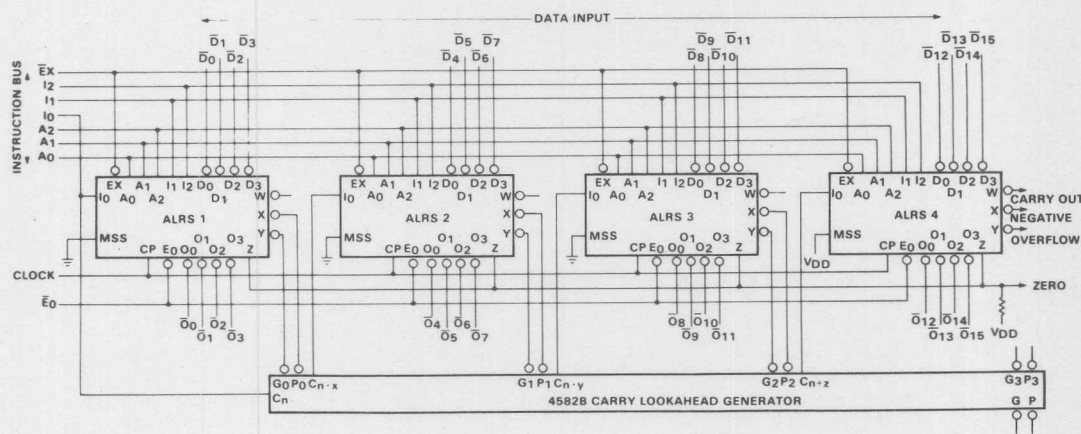


Fig. 2
CARRY LOOKAHEAD EXPANSION

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 3)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF Current HIGH	XC									1.6	μA	MIN, 25°C	Output Returned to V _{DD} , $\bar{E}O = V_{DD}$
											12		MAX	
		XM									0.4		MIN, 25°C	
											12		MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6	μA	MIN, 25°C	Output Returned to V _{SS} $\bar{E}O = V_{DD}$
											-12		MAX	
		XM									-0.4		MIN, 25°C	
											-12		MAX	
I _{DD}	Quiescent Power Supply Current	XC			32.5			65			130	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
				250			500			1000	MAX			
		XM			8.75			17.5			35		MIN, 25°C	
				250			500			1000	MAX			

Notes on following page.

FAIRCHILD CMOS • 4705B/4705BX

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $V_{DD} = 0 \text{ V}$, $T_A = 25^\circ\text{C}$, $C_L = 50 \text{ pF}$, $R_L = 200 \text{ k}\Omega$

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS (Note 6)
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to \bar{O}_n		163	326		71	142		50	100	ns	$\bar{E}\bar{O} = \bar{E}\bar{X} = V_{SS}$
t _{PHL}	CP to \bar{O}_n		174	348		70	140		49	98		
t _{PLH}	Propagation Delay, I_0 to \bar{W}		120	240		55	110		39	78	ns	I_1 or $I_2 = V_{DD}$
t _{PHL}	I_0 to \bar{W}		139	278		56	112		40	80		
t _{PLH}	Propagation Delay, \bar{D}_n to \bar{W}		251	502		101	202		71	142	ns	I_1 or $I_2 = V_{SS}$
t _{PHL}	\bar{D}_n to \bar{W}		186	372		61	122		43	86		
t _{PLH}	Propagation Delay, \bar{D}_n to \bar{X} , \bar{Y}		382	764		150	300		105	210	ns	$MSS = V_{DD}$ $I_1 = I_2 = V_{SS}$
t _{PHL}	\bar{D}_n to \bar{X} , \bar{Y}		363	726		140	280		98	196		
t _{PLH}	Propagation Delay, \bar{D}_n to \bar{X} , \bar{Y}		161	322		58	116		41	82	ns	$MSS = I_1 = I_2 = V_{SS}$
t _{PHL}	\bar{D}_n to \bar{X} , \bar{Y}		239	478		90	180		63	126		
t _{PLH}	Propagation Delay, I_1 , I_2 to \bar{X} , \bar{Y}		211	422		96	192		68	136	ns	$MSS = V_{SS}$
t _{PHL}	I_1 , I_2 to \bar{X} , \bar{Y}		266	532		109	218		77	154		
t _{PLH}	Propagation Delay, \bar{O}_n to Z		360	720		179	358		126	262	ns	$R_L = 1\text{k}\Omega$ to V_{DD}
t _{PHL}	\bar{O}_n to Z		251	502		95	190		67	134		
t _{PLH}	Propagation Delay, I_0 to \bar{W}		198	396		83	166		59	118	ns	$I_1 = I_2 = V_{SS}$
t _{PHL}	I_0 to \bar{W}		226	452		87	174		61	122		
t _{PLH}	Propagation Delay, I_1 , I_2 to \bar{W}		152	304		73	146		52	104	ns	$I_1 = I_2 = V_{SS}$
t _{PHL}	I_1 , I_2 to \bar{W}		252	504		104	208		73	146		
t _{PLH}	Propagation Delay, \bar{D}_3 to \bar{X}		317	634		123	246		87	174	ns	$I_1 = I_2 = MSS = V_{DD}$
t _{PHL}	\bar{D}_3 to \bar{X}		401	802		152	304		107	214		
t _{PLH}	Propagation Delay, A_n to \bar{X} , \bar{Y}		397	794		161	322		113	226	ns	$I_1 = I_2 = MSS = V_{SS}$
t _{PHL}	A_n to \bar{X} , \bar{Y}		538	1076		213	426		150	300		
t _{PLH}	Propagation Delay, A_n to \bar{X} , \bar{Y}		527	1054		205	410		144	288	ns	$I_1 = I_2 = V_{SS}$ $MSS = V_{DD}$
t _{PHL}	A_n to \bar{X} , \bar{Y}		668	1336		269	538		189	378		
t _{PLH}	Propagation Delay, A_n to \bar{X}		519	1038		202	404		142	284	ns	$I_1 = I_2 = MSS = V_{DD}$
t _{PHL}	A_n to \bar{X}		695	1380		279	558		196	392		
t _{PLH}	Propagation Delay, A_n to \bar{W}		556	1112		229	458		161	322	ns	$I_1 = I_2 = V_{SS}$
t _{PHL}	A_n to \bar{W}		415	830		161	322		113	226		
t _{PLH}	Propagation Delay, A_n to Z		512	1024		236	472		166	332	ns	$I_1 = I_2 = V_{SS}$
t _{PHL}	A_n to Z		618	1236		245	490		172	344		
t _{PLH}	Propagation Delay, I_1 , I_2 to \bar{X} , \bar{Y}		143	286		71	142		50	100	ns	$I_1 = I_2 = V_{SS}$ $MSS = V_{DD}$
t _{PHL}	I_1 , I_2 to \bar{X} , \bar{Y}		338	676		134	268		94	188		
t _{PLH}	Propagation Delay, I_0 to \bar{X} , \bar{Y}		171	342		85	170		60	120	ns	$I_1 = I_2 = V_{SS}$ $MSS = V_{DD}$
t _{PHL}	I_0 to \bar{X} , \bar{Y}		304	608		118	236		83	166		
t _{PLH}	Propagation Delay, I_1 , I_2 to Z		370	740		186	392		131	262	ns	$I_1 = I_2 = V_{SS}$
t _{PHL}	I_1 , I_2 to Z		276	552		109	218		77	154		
t _{PLH}	Propagation Delay, I_0 to Z		298	596		155	310		109	218	ns	$I_1 = I_2 = V_{SS}$
t _{PHL}	I_0 to Z		177	354		70	140		49	98		
t _{PZH}	Output Enable Time		71	142		36	72		26	52	ns	$(R_L = 1\text{ k}\Omega \text{ to } V_{SS})$ $(R_L = 1\text{ k}\Omega \text{ to } V_{DD})$
t _{PZL}	Output Disable Time		58	116		27	54		19	38		
t _{PHZ}	Output Disable Time		71	142		40	80		28	56	ns	$(R_L = 1\text{ k}\Omega \text{ to } V_{SS})$ $(R_L = 1\text{ k}\Omega \text{ to } V_{DD})$
t _{PLZ}	Output Disable Time		79	158		42	84		30	60		
t _{TLH}	Output Transition Time		95	190		54	108		38	76	ns	$C_L = 50\text{ pF}$
t _{THL}	Output Transition Time		67	134		27	54		19	38		

Notes on following page.

FAIRCHILD CMOS • 4705B/4705BX

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: (Cont'd)

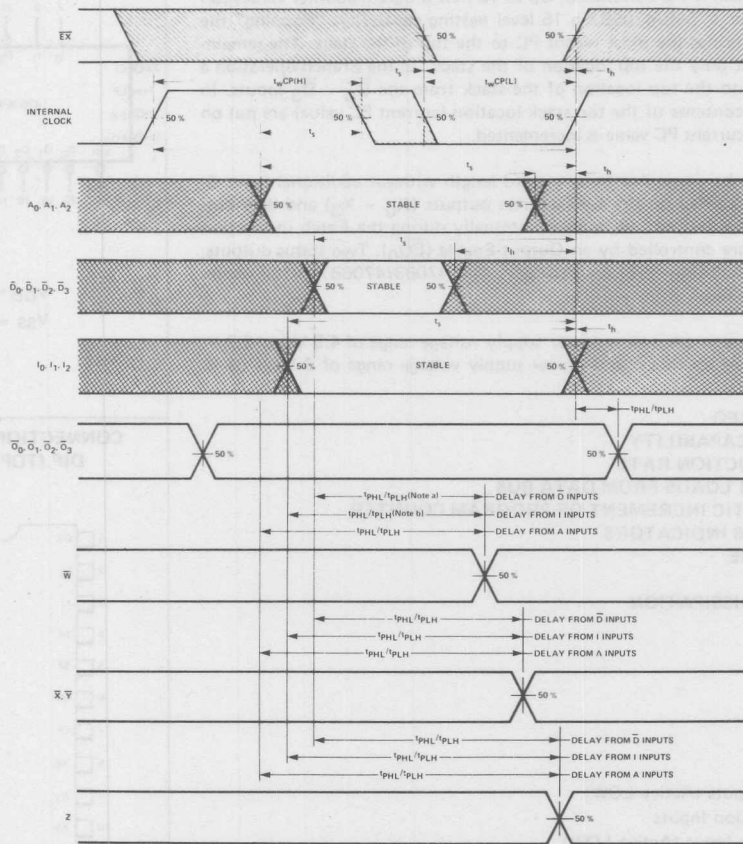
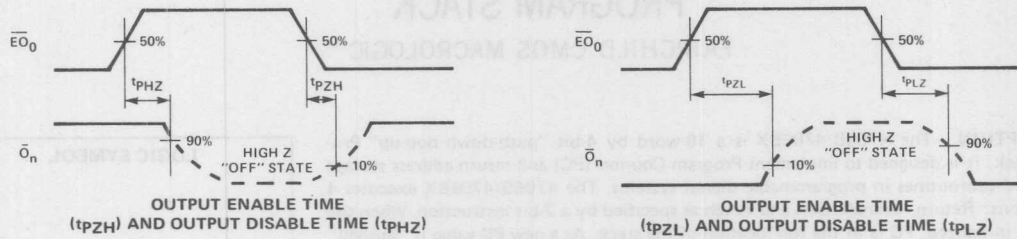
V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25$ °C (See Note 4)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS (Note 6)
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{CW}	Minimum Clock Period	1018	509		526	263		370	185		ns	C _L = 50 pF, R _L = 200 kΩ EX = V _{SS}
t _{WCP(L)}	CP Minimum Pulse Width ⁽¹⁾ (LOW)	214	107		102	51		72	36		ns	
t _{WCP(H)}	CP Minimum Pulse Width (HIGH)	484	242		222	111		156	78		ns	
t _s	Set-UP Time, EX to CP	326	163		198	99		134	67		ns	
t _h	Hold Time, EX to CP	20	0		15	0		10	0		ns	
t _s	Set-UP Time, A _n to CP	452	226		168	84		118	59		ns	
t _h	Hold Time, A _n to CP	20	0		15	-1		10	0		ns	
t _s	Set-UP Time, D _n to CP	500	250		198	99		140	70		ns	
t _h	Hold Time, D _n to CP	-35	-69		-11	-21		-8	-15		ns	
t _s	Set-UP Time, I _n to CP	502	251		224	112		158	79		ns	
t _h	Hold Time, I _n to CP	-29	-57		-12	-23		-9	-17		ns	
f _{MAX}	Input Count Frequency (Note 1)	0.98	1.97		1.9	3.8		2.47	4.94		MHz	

NOTES:

- For f_{MAX} input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
- It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V and 3 μ s at $V_{DD} = 15$ V.
- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- Propagation Delays and Output transition times are graphically described in this section under 4000B Series CMOS Family Characteristics.
- The Internal Clock is generated from CP and EX. The Internal Clock is HIGH if EX or CP is HIGH, LOW if EX and CP are LOW. For timing considerations the EX, CP two input active LOW AND gate is considered to exhibit no propagation delay. Actual timing requirements are referenced to the external CP and EX inputs.
- Input Transition Times ≤ 20 ns.

SWITCHING WAVEFORMS



PROPAGATION DELAYS, A_n to Z , I_n to Z , \bar{D}_n to Z ,
 A_n to \bar{X} , \bar{Y} , I_n to \bar{X} , \bar{Y} , \bar{D}_n to \bar{X} , \bar{Y} , A_n to \bar{W} , I_n to \bar{W} , \bar{D}_n to \bar{W} , I_n to \bar{O}_n
 SET-UP AND HOLD TIMES \bar{E}_X TO CP, A_n TO CP,
 \bar{D}_n TO CP, I_n TO CP, MINIMUM INTERNAL CLOCK PULSE

NOTES:

- Delay for logical operation (I_1 or $I_2 = \text{HIGH}$)
- Delay for arithmetic operation ($I_1 = I_2 = \text{LOW}$)
- Set-up Times (t_s) and Hold Times (t_h) are shown as positive values but may be specified as negative values.

4706B/4706BX PROGRAM STACK

FAIRCHILD CMOS MACROLOGIC™

DESCRIPTION —The 4706B/4706BX is a 16-word by 4-bit "push-down pop-up" Program Stack. It is designed to implement Program Counter (PC) and return address storage for nested subroutines in programmable digital systems. The 4706B/4706BX executes 4 instructions: Return, Branch, Call and Fetch as specified by a 2-bit instruction. When the device is initialized, PC is in the top location of the stack. As a new PC value is "pushed" into the stack (Call operation), all previous PC values effectively move down one level. The top location of the stack is the current PC. Up to 15 new program counter values can be stored, which gives the 4706B/4706BX a 15 level nesting capability. "Popping" the stack (Return operation) brings the most recent PC to the top of the stack. The remaining two instructions affect only the top location of the stack. In the Branch operation a new PC value is loaded into the top location of the stack from the $\bar{D}_0 - \bar{D}_3$ inputs. In the Fetch operation, the contents of the top stack location (current PC value) are put on the $X_0 - X_3$ bus and the current PC value is incremented.

The 4706B/4706BX may be expanded to any word length without additional logic. 3-state output drivers are provided on the 4-bit address outputs ($X_0 - X_3$) and data outputs, ($\bar{O}_0 - \bar{O}_3$); the X-Bus outputs are enabled internally during the Fetch instruction while the O-bus outputs are controlled by an Output Enable (\bar{EO}_0). Two status outputs, Stack Full (\bar{SF}) and Stack Empty (\bar{SE}) are provided. The 4706B/4706BX is fully compatible with all CMOS families.

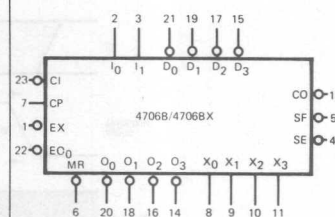
The 4706B is specified to operate over a power supply voltage range of 4.5 V to 12.5 V. The 4706BX is specified to operate over a power supply voltage range of 3 V to 15 V.

- 16-WORD BY 4-BIT LIFO
- 15-LEVEL NESTING CAPABILITY
- 2 MHz MICROINSTRUCTION RATE
- PROGRAM COUNTER LOADS FROM DATA BUS
- OPTIONAL AUTOMATIC INCREMENT OF PROGRAM COUNTER
- STACK LIMIT STATUS INDICATORS
- SLIM 24-PIN PACKAGE
- 3-STATE OUTPUTS
- VERY LOW POWER DISSIPATION

PIN NAMES

$\bar{D}_0 - \bar{D}_3$	Data Inputs (Active LOW)
I_0, I_1	Instruction Inputs
EX	Execute Input (Active LOW)
CP	Clock Input
\bar{MR}	Master Reset Input (Active LOW)
CI	Carry Input (Active LOW)
\bar{EO}_0	Output Enable Input (Active LOW)
$\bar{O}_0 - \bar{O}_3$	Output Data Outputs (Active LOW)
$X_0 - X_3$	Address Outputs
\bar{CO}	Carry Output (Active LOW)
\bar{SF}	Stack Full Output (Active LOW)
\bar{SE}	Stack Empty Output (Active LOW)

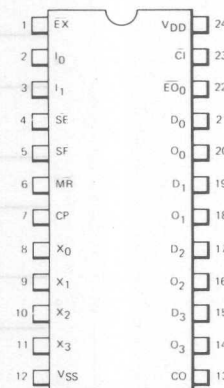
LOGIC SYMBOL



V_{DD} = Pin 24

V_{SS} = Pin 12

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

BLOCK DIAGRAM

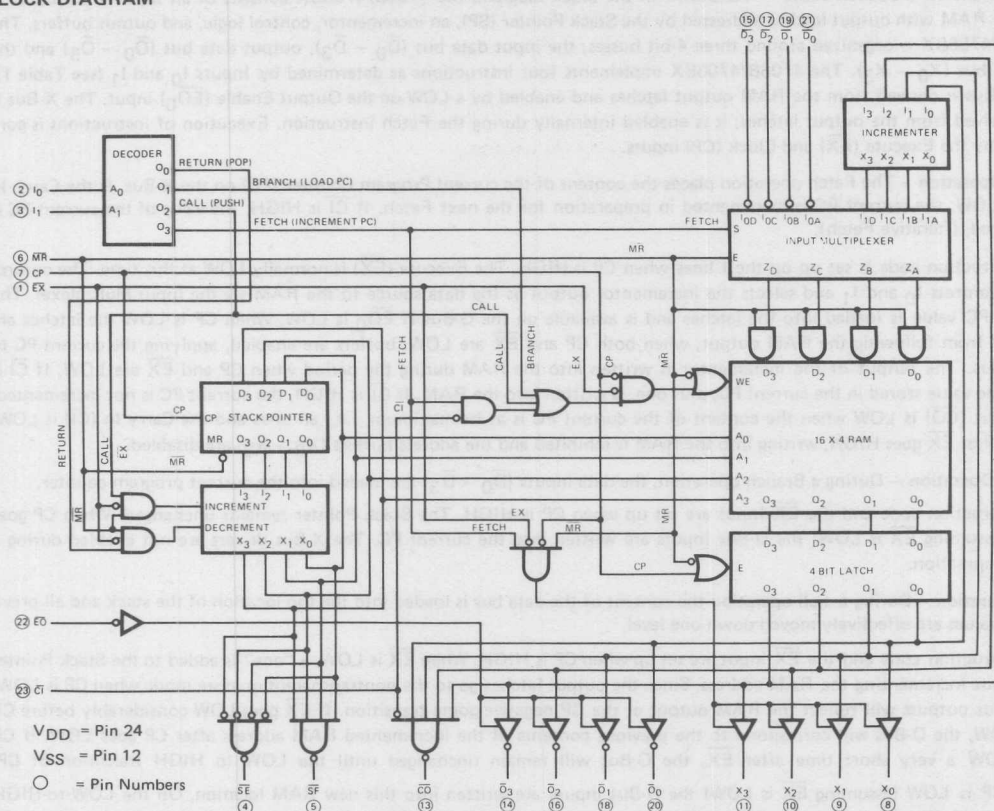


TABLE 1
INSTRUCTION SET FOR THE 4706B/4706BX

I ₁ I ₀	INSTRUCTION	INTERNAL OPERATION	X-BUS	O-BUS (WITH \overline{EO}_0 LOW)
L L	Return (Pop)	Decrement Stack Pointer	Disabled	Depending on the relative timing of \overline{EX} and CP, the outputs will reflect the current program counter or the new value while CP is LOW. When CP goes HIGH again, the output will reflect the new value.
L H	Branch (Load PC)	Load D-Bus into Current Program Counter Location	Disabled	Current Program Counter until CP goes HIGH again, then updated with newly entered PC value.
H L	Call (Push)	Increment Stack Pointer and Load D-Bus into New Program Counter Location	Disabled	Depending on the relative timing of \overline{EX} and CP, the outputs will reflect the current program counter or the previous contents of the incremented SP location. When CP goes HIGH again, the outputs will reflect the newly entered PC value. See Switching Waveforms for details.
H H	Fetch (Increment PC)	Increment Current Program Counter if \overline{CI} is LOW	Current Program Counter while both CP and \overline{EX} are LOW, disabled while CP or \overline{EX} is HIGH	Current Program Counter until CP goes HIGH again, then updated with incremented PC value.

H = HIGH Level L = LOW Level

FUNCTIONAL DESCRIPTION — As shown in the block diagram, the 4706B/4706BX consists of an Input Multiplexer, a 16 X 4 RAM with output latches addressed by the Stack Pointer (SP), an incrementor, control logic, and output buffers. The 4706B/4706BX is organized around three 4-bit busses; the input data bus ($\overline{D}_0 - \overline{D}_3$), output data bus ($\overline{O}_0 - \overline{O}_3$) and the address bus ($X_0 - X_3$). The 4706B/4706BX implements four instructions as determined by Inputs I_0 and I_1 (see Table 1). The O-Bus is derived from the RAM output latches and enabled by a LOW on the Output Enable (\overline{EO}_0) input. The X-Bus is also derived from the output latches; it is enabled internally during the Fetch instruction. Execution of instructions is controlled by the Execute (\overline{EX}) and Clock (CP) inputs.

Fetch Operation — The Fetch operation places the content of the current Program Counter (PC) on the X-Bus. If the Carry In (\overline{CI}) is LOW, the current PC is incremented in preparation for the next Fetch. If \overline{CI} is HIGH, the value of the current PC is unchanged, (Iterative Fetch).

The instruction code is set up on the I lines when CP is HIGH. The Execute (\overline{EX}) is normally LOW at this time. The control logic interprets I_0 and I_1 and selects the incrementor output as the data source to the RAM via the Input Multiplexer. The current PC value is loaded into the latches and is available on the O-Bus if \overline{EO}_0 is LOW. When CP is LOW the latches are disabled from following the RAM output, when both CP and \overline{EX} are LOW, buffers are enabled, applying the current PC to the X-Bus. The output of the incrementor is written into the RAM during the period when CP and \overline{EX} are LOW. If \overline{CI} is LOW, the value stored in the current PC, plus one, is written into the RAM. If \overline{CI} is HIGH, the current PC is not incremented. Carry Out (\overline{CO}) is LOW when the content of the current PC is at its maximum, i.e., all ones and the Carry In (\overline{CI}) is LOW. When CP or \overline{EX} goes HIGH, writing into the RAM is inhibited and the address buffers ($X_0 - X_3$) are disabled.

Branch Operation — During a Branch operation, the data inputs ($\overline{D}_0 - \overline{D}_3$) are loaded into the current program counter.

The instruction code and the \overline{EX} Input are set up when CP is HIGH. The Stack Pointer remains unchanged. When CP goes LOW (assuming \overline{EX} is LOW) the D-Bus Inputs are written into the current PC. The X-Bus drivers are not enabled during a Branch operation.

Call Operation — During a Call operation the content of the data bus is loaded into the top location of the stack and all previous PC values are effectively moved down one level.

The instruction code and the \overline{EX} input are set up when CP is HIGH. When \overline{EX} is LOW, a "one" is added to the Stack Pointer value thus incrementing the RAM address. Since the output latches go to the nontransparent or store mode when CP is LOW, the O-Bus outputs will reflect the RAM output at the CP negative-going transition. If \overline{EX} goes LOW considerably before CP goes LOW, the O-Bus will correspond to the previous contents of the incremented RAM address after CP goes LOW. If CP goes LOW a very short time after \overline{EX} , the O-Bus will remain unchanged until the LOW to HIGH transition of CP.

When CP is LOW (assuming \overline{EX} is LOW) the D-Bus inputs are written into this new RAM location. On the LOW-to-HIGH transition of CP, the incremented Stack Pointer value is loaded into the Stack Pointer and the O-Bus outputs reflect the newly entered data. When the RAM address is "1111" the Stack Full output (\overline{SF}) is LOW, indicating that no further Call operations should be initiated. If an additional Call operation is performed SP is incremented to (0000), the contents of that location will be written over, \overline{SF} will go HIGH and the Stack Empty (\overline{SE}) will go LOW.

The X-Bus drivers are not enabled during a Call operation.

Return Operation — During the Return operation the previous PC is "popped" to become the current PC.

The instruction is set up when CP is HIGH. When \overline{EX} is LOW, a "one" is subtracted from the Stack Pointer value, thus decrementing the RAM address. If \overline{EX} goes LOW considerably before CP goes LOW, the O-Bus will correspond to the new value after \overline{EX} goes LOW. If CP goes LOW a short time after \overline{EX} , the O-Bus will remain unchanged until the LOW-to-HIGH transition of CP.

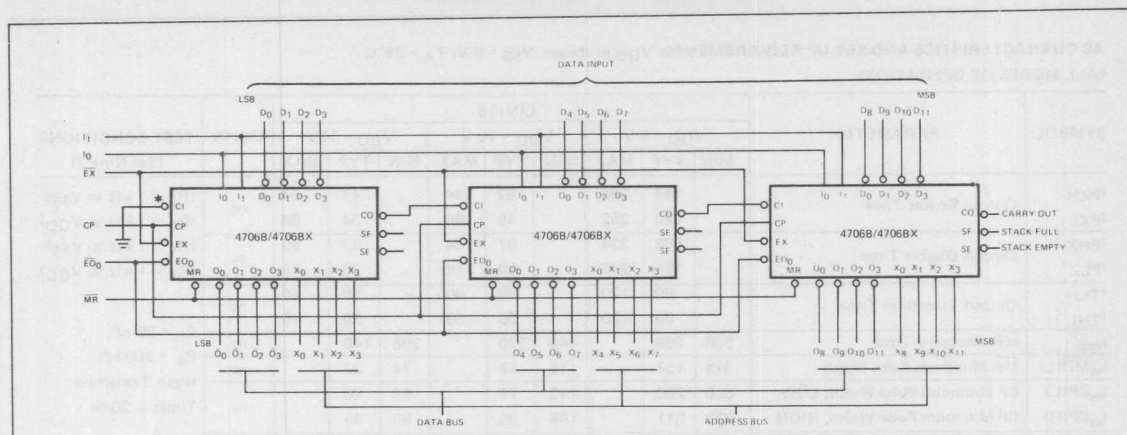
On the LOW-to-HIGH transition of CP the decremented Stack Pointer value is loaded into the Stack Pointer and the O-Bus outputs correspond to the new "popped" value.

The X-Bus drivers are not enabled during a Return operation. When the RAM address is "0000", the Stack Empty output (\overline{SE}) is LOW, indicating that no further return operations should be initiated. If an additional Return operation is performed, SP is decremented to "1111", the \overline{SE} will go HIGH and the Stack Full output (\overline{SF}) will go LOW. A LOW on the Master Reset (\overline{MR}) causes the SP to be reset and the contents of that RAM location (0000) to be cleared. The Stack Empty (\overline{SE}) output goes LOW. This operation overrides all other inputs.

EXPANSION — The 4706B/4706BX may be expanded to any word length in multiples of four without external logic. The connection for expanded operation is shown in Figure 1. Carry In (\overline{CI}) and Carry Out (\overline{CO}) are connected to provide automatic increment of the current program counter during Fetch. The \overline{CI} input of the least significant 4706B/4706BX is tied LOW to ground.

If automatic increment during Fetch is not desired, the \overline{CI} input of the least significant 4706B/4706BX is held HIGH.

FAIRCHILD CMOS • 4706B/4706BX



*Tie to V_{DD} to disable automatic increment.

Fig. 1
4706B/4706BX EXPANSION A 16 X 12-PROGRAM STACK

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									TEMP	TEST CONDITIONS	
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF	XC									1.6	μA	MIN, 25°C	Output Returned to V _{DD} , E _{O0} = V _{DD}
											12		MAX	
	Current HIGH	XM									0.4		MIN, 25°C	
											12		MAX	
I _{OZL}	Output OFF	XC									-1.6	μA	MIN, 25°C	Output Returned to V _{SS} E _{O0} = V _{DD}
											-12		MAX	
	Current LOW	XM									-0.4		MIN, 25°C	
											-12		MAX	
I _{DD}	Quiescent Power	XC			32.5			65			130	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					250			500			1000		MAX	
	Supply Current	XC			8.75			17.5			35		MIN, 25°C	
		XM			250			500			1000		MAX	

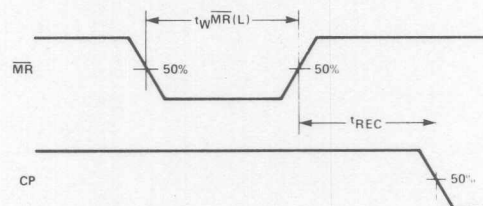
Notes on following pages.

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$
(ALL MODES OF OPERATION)

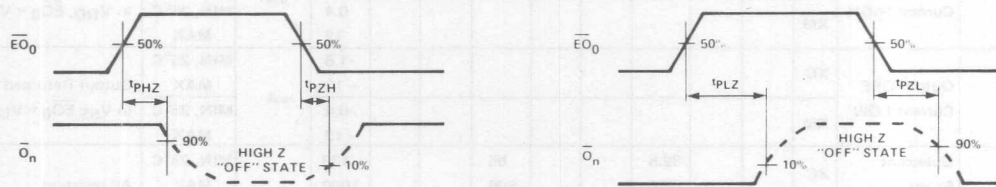
SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS (See Note 2)
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PZH}	Output Enable Time		144	288		62	124		47	94	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PZL}			126	252		48	96		34	68		
t _{PHZ}	Output Disable Time		162	324		67	134		45	90	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PLZ}			121	242		59	118		38	76		
t _{TLH}	Output Transition Time		60	120		30	60		20	40	ns	(R _L = 1 kΩ to V _{DD})
t _{THL}			60	120		30	60		20	40		
t _{rec}	MR Recovery Time	538	269		440	220		296	148		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{wMR(L)}	MR Minimum Pulse Width	314	157		116	58		74	37		ns	
t _{wCP(L)}	CP Minimum Pulse Width, LOW	520	260		142	71		80	40		ns	
t _{wCP(H)}	CP Minimum Pulse Width, HIGH	622	311		196	98		90	45		ns	
t _{CO}	Clock Period	1142	571		558	279		440	220		ns	

Notes on following pages.

RESET OPERATION



MINIMUM \overline{MR} PULSE WIDTH AND \overline{MR} RECOVERY TIME



\overline{EO}_0 TO OUTPUT ENABLE AND DISABLE TIMES

NOTE: Set-up (t_s) and Hold (t_h) Times are shown as positive values but may be specified as negative values.

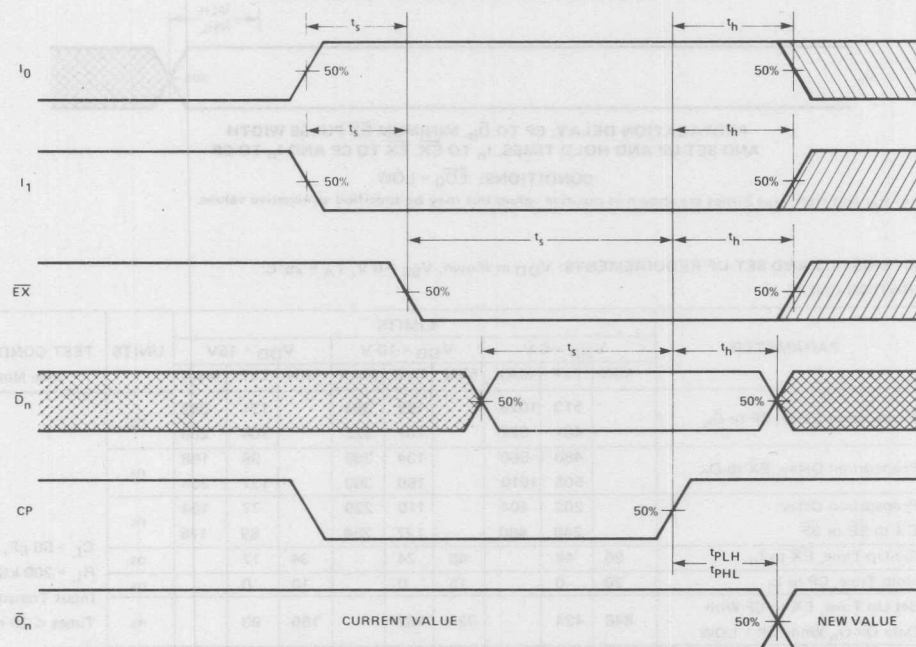
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AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$
(BRANCH OPERATION)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS (See Note 2)
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH} t _{PHL}	Propagation Delay, CP to \bar{O}_n		287 238	574 476		109 84	218 168		78 61	156 122	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _s	Set-Up Time, I _N to $\bar{E}X$	172	86		58	29		42	21		ns	
t _h	Hold Time, I _N to $\bar{E}X$	20	0		15	0		10	0		ns	
t _s	Set-Up Time, \bar{O}_n to CP	182	91		106	53		64	32		ns	
t _h	Hold Time, \bar{O}_n to CP	20	0		15	0		10	0		ns	
t _h	Hold Time, I _N to CP	20	0		15	0		10	0		ns	
t _{wEX}	Min. EX Pulse Width	188	94		74	37		50	25		ns	

Notes on following pages.

BRANCH OPERATION, CP GOES HIGH BEFORE $\bar{E}\bar{X}$

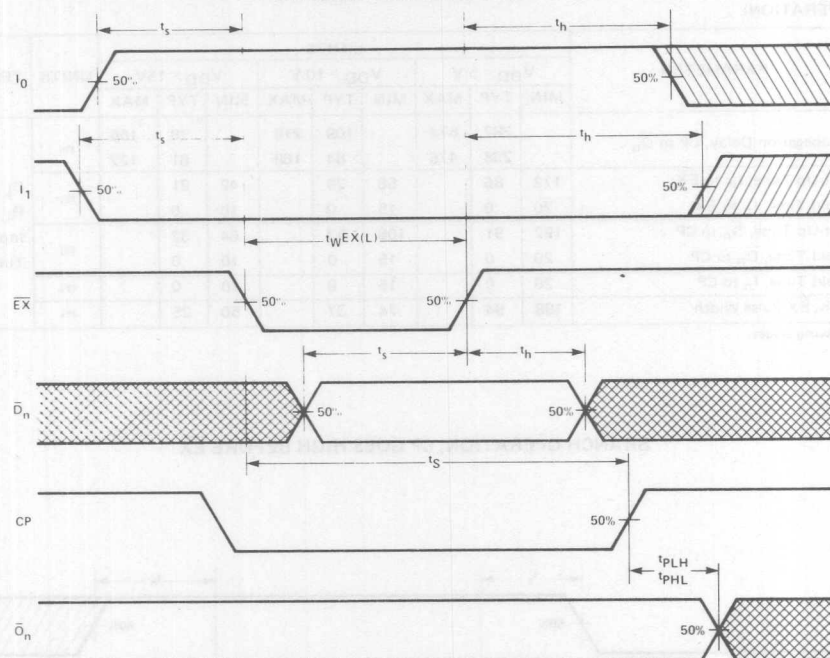


PROPAGATION DELAY CP TO \bar{O}_n AND SET-UP AND HOLD TIMES, I_n TO $\bar{E}\bar{X}$, \bar{O}_n TO CP AND I_n TO CP

CONDITIONS: $\bar{E}\bar{O}_0 = \text{LOW}$

NOTE: Set-up (t_s) and Hold (t_h) Times are shown as positive values but may be specified as negative values.

SWITCHING WAVEFORMS FOR A BRANCH OPERATION EX GOES HIGH BEFORE CP



PROPAGATION DELAY, CP TO \bar{O}_n , MINIMUM $\bar{E}X$ PULSE WIDTH
AND SET-UP AND HOLD TIMES, I_n TO $\bar{E}X$, $\bar{E}X$ TO CP AND I_n TO CP

CONDITIONS: $\bar{E}O_0 = \text{LOW}$

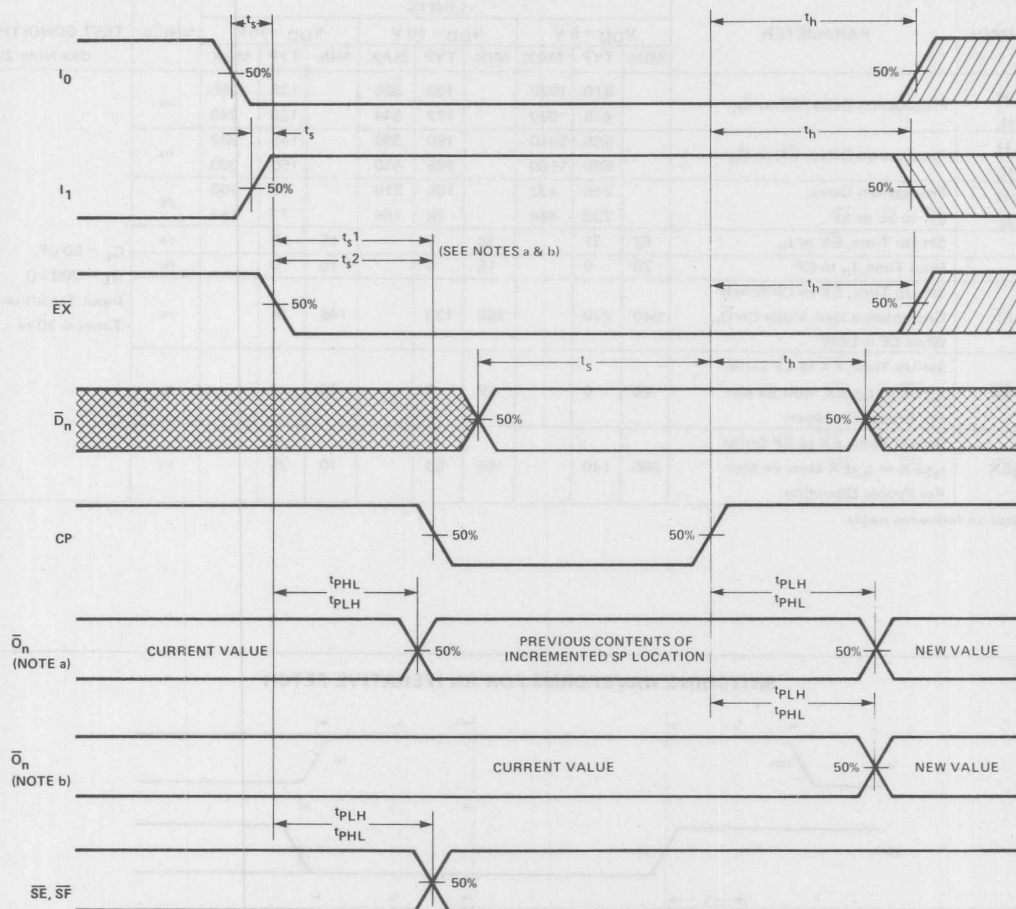
NOTE: Set up (t_s) and Hold (t_h) Times are shown as positive values but may be specified as negative values.

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0 \text{ V}$, $T_A = 25^\circ\text{C}$
(CALL OPERATION ONLY)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS (See Note 2)
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to \bar{O}_n		513	1026		182	364		121	242	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times < 20 ns
t _{PHL}			461	922		161	322		104	208		
t _{PLH}	Propagation Delay, $\bar{E}X$ to \bar{O}_n		480	960		134	268		99	198	ns	
t _{PHL}			505	1010		180	360		127	254		
t _{PLH}	Propagation Delay, $\bar{E}X$ to $\bar{S}E$ or $\bar{S}F$		202	404		110	220		77	154	ns	
t _{PHL}			240	480		127	254		89	178		
t _s	Set-Up Time, $\bar{E}X$ to I _n	96	48		48	24		34	17		ns	
t _h	Hold Time, CP to I _n	20	0		15	0		10	0		ns	
t _{s1} $\bar{E}X$	Set-Up Time, $\bar{E}X$ to CP With Data On \bar{O}_n While CP = LOW	848	424		324	162		186	93		ns	
t _{s2} $\bar{E}X$	Set-Up Time, $\bar{E}X$ to CP With No Change In \bar{O}_n While CP = LOW	20	0		15	0		10	0		ns	
t _h $\bar{E}X$	Hold Time, CP to $\bar{E}X$	20	0		15	0		10	0		ns	
t _s	Set-Up Time, \bar{D}_n to CP	426	213		194	97		128	64		ns	
t _h	Hold Time, \bar{D}_n to CP	20	0		15	0		10	0		ns	

Notes on following pages.

SWITCHING WAVEFORMS FOR A CALL (PUSH) OPERATION



PROPAGATION DELAY, CP TO \overline{O}_n , \overline{EX} TO \overline{O}_n ,
 \overline{EX} TO SE OR SF , AND SET-UP AND HOLD TIMES,
 \overline{EX} TO I_n , CP TO I_n , \overline{D}_n TO CP, CP TO \overline{EX} .

CONDITIONS: $\overline{EO}_0 = LOW$

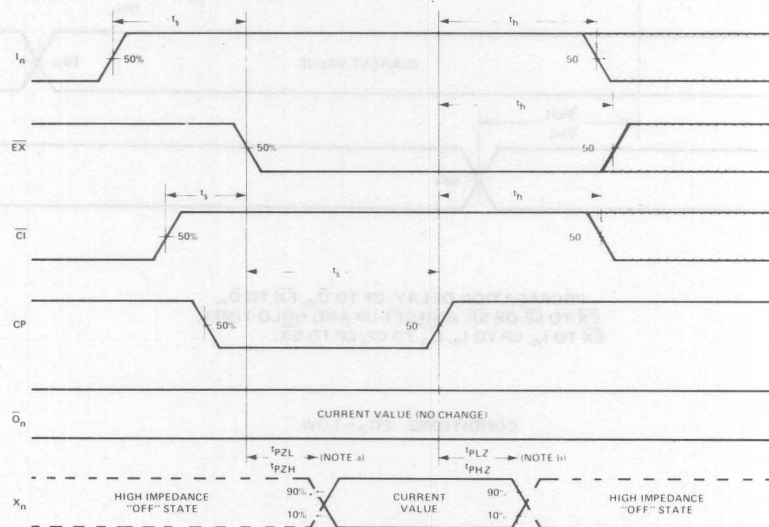
- NOTES: a. Condition which occurs when \overline{EX} goes LOW considerably before CP goes LOW (t_{s1} EX is met).
b. Condition which occurs when \overline{EX} goes LOW slightly before CP goes LOW (t_{s2} EX is met).
c. Set-up and Hold Times are shown as positive values but may be specified as negative values.

(RETURN OPERATION ONLY)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS (See Note 2)
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to \bar{O}_n		510	1020		193	386		130	260	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			475	950		172	344		120	240		
t _{PLH}	Propagation Delay, $\bar{E}X$ to \bar{O}_n		505	1010		150	300		142	282	ns	
t _{PHL}			580	1160		205	410		150	300		
t _{PLH}	Propagation Delay, EX to SE or SF		216	432		105	210		79	158	ns	
t _{PHL}			233	466		78	156		77	154		
t _s	Set-Up Time, $\bar{E}X$ to I _N	62	31		18	9		10	5		ns	
t _h	Hold Time, I _N to CP	20	0		15	0		10	0		ns	
t _{s1} $\bar{E}X$	Set-Up Time, EX to CP Which Guarantees a New Value On \bar{O}_n While CP is LOW	540	270		266	133		148	74		ns	
t _{s2} $\bar{E}X$	Set-Up Time, $\bar{E}X$ to CP Either t _{s2} $\bar{E}X$ or t _{s3} $\bar{E}X$ Must Be Met For Proper Operation	20	0		15	0		10	0		ns	
t _{s3} $\bar{E}X$	Set-Up Time, $\bar{E}X$ to CP Either t _{s2} $\bar{E}X$ or t _{s3} $\bar{E}X$ Must Be Met For Proper Operation	280	140		186	93		70	35		ns	

Notes on following pages.

SWITCHING WAVEFORMS FOR AN ITERATIVE FETCH



OUTPUT X_n DISABLE DELAY, OUTPUT X_n ENABLE DELAY, AND SET-UP AND HOLD TIMES, I_n TO EX, I_n TO CP, EX TO CP, AND CI TO EX.

CONDITIONS: $\bar{E}O_0$ = LOW, CP GOES HIGH BEFORE $\bar{E}X$

- NOTES: a. X₀ - X₃ turn on delay measured from time both EX and CP go LOW.
 b. X₀ - X₃ turn off delay measured from time either EX or CP goes HIGH.
 c. Set-up and Hold Times are shown as positive values but may be specified as negative values.

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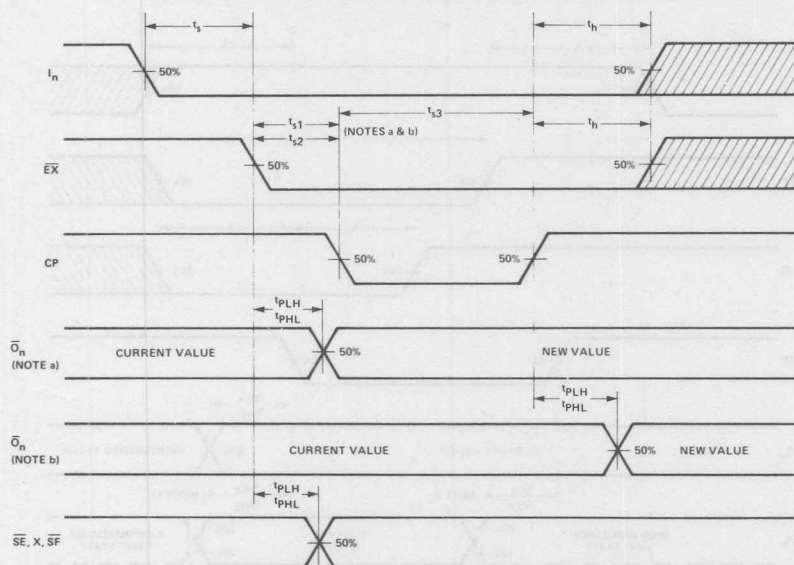
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$
(FETCH OPERATION ONLY)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS (See Note 2)
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to \overline{O}_n		274	548		108	216		77	154	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD}) (R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PHL}			215	430		82	164		57	114	ns	
t _{PZH}	Output Enable Time (X _n)		144	288		62	124		47	94	ns	
t _{PZL}			126	252		48	96		34	68	ns	
t _{PHZ}	Output Disable Time (X _n)		162	324		67	134		45	90	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times < 20 ns
t _{PLZ}			121	242		59	118		38	76	ns	
t _s	Set-Up Time, I _n to \overline{EX}	488	244		134	67		90	45		ns	
t _h	Hold Time, I _n to CP ro \overline{EX}	20	0		15	0		10	0		ns	
t _s	Set-Up Time, \overline{EX} to CP	644	322		170	85		148	74		ns	
t _s	Set-Up Time, \overline{CI} to CP	570	285		132	66		90	45		ns	
t _h	Hold Time, \overline{CI} to \overline{EX}	20	0		15	0		10	0		ns	

NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
- It is recommended that input rise and fall times to the Clock Input be less than $15\text{ }\mu\text{s}$ at $V_{DD} = 5\text{ V}$, $4\text{ }\mu\text{s}$ at $V_{DD} = 10\text{ V}$, and $3\text{ }\mu\text{s}$ at $V_{DD} = 15\text{ V}$.

SWITCHING WAVEFORMS FOR A RETURN (POP) OPERATION

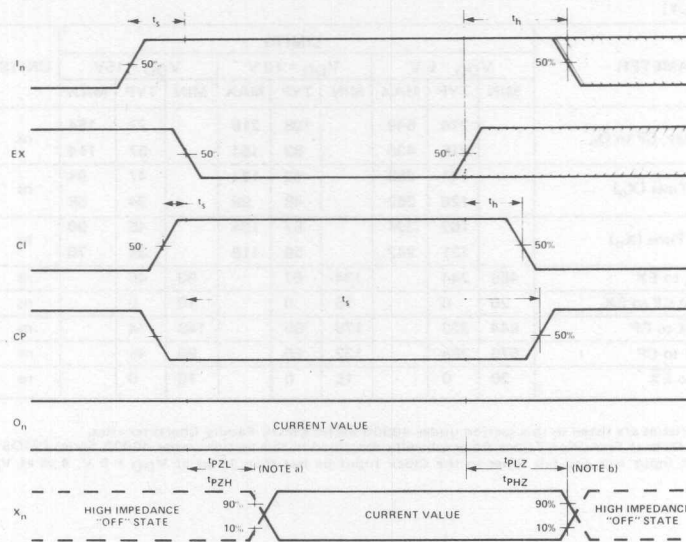


PROPAGATION DELAY, CP TO \overline{O}_n , \overline{EX} TO \overline{O}_n , \overline{EX} TO SE OR SF ,
AND SET-UP AND HOLD TIMES, \overline{EX} TO I_n , I_n TO CP, \overline{EX} TO CP

CONDITIONS: $\overline{EO}_0 = \text{LOW}$

- NOTES: a. Condition which occurs when \overline{EX} goes LOW considerably before CP goes LOW ($T_{s1}\overline{EX}$ is met).
b. Condition which occurs when \overline{EX} goes LOW slightly before or after CP goes LOW (Either $t_{s2}\overline{EX}$ or $t_{s3}\overline{EX}$ are met).
c. Set-up and Hold Times are shown as positive values but may be specified as negative values.

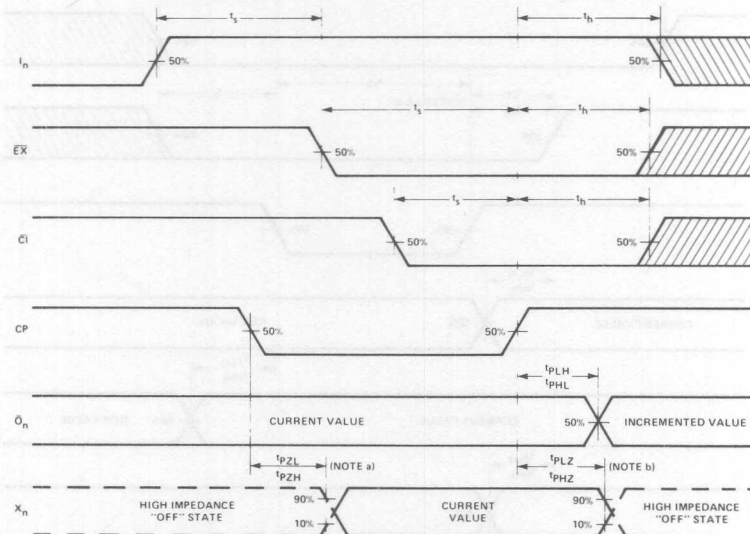
SWITCHING WAVEFORMS FOR AN ITERATIVE FETCH (Cont'd)



OUTPUT X_n ENABLE AND DISABLE TIMES AND
SET-UP AND HOLD TIMES, I_n TO \overline{EX} , CI TO \overline{EX} AND \overline{EX} TO CP .

CONDITIONS: $\overline{EO}_0 = \text{LOW}$, \overline{EX} GOES HIGH BEFORE CP

SWITCHING WAVEFORMS FOR A FETCH OPERATION WITH INCREMENT PC

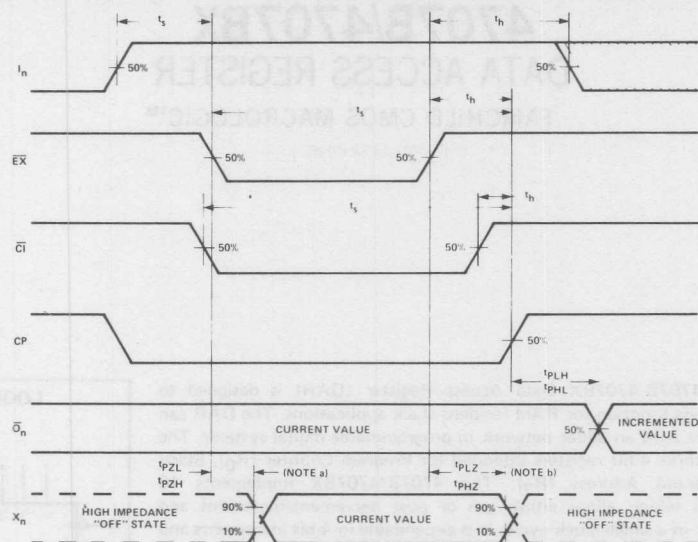


PROPAGATION DELAY, CP TO \overline{O}_n , OUTPUT X_n ENABLE AND DISABLE TIMES
AND SET-UP AND HOLD TIMES, I_n TO \overline{EX} , \overline{EX} TO CP , AND CI TO CP

CONDITIONS: $\overline{EO}_0 = \text{LOW}$, CP GOES HIGH BEFORE \overline{EX}

- NOTES:
- $X_0 - X_3$ turn on delay measured from time both \overline{EX} and CP go LOW.
 - $X_0 - X_3$ turn off delay measured from time either \overline{EX} or CP goes HIGH.
 - Set-up and Hold Times are shown as positive values but may be specified as negative values.

SWITCHING WAVEFORMS FOR A FETCH OPERATION WITH INCREMENT PC



PROPAGATION DELAY CP TO \overline{O}_n , OUTPUT X_n ENABLE AND DISABLE TIMES, AND SET-UP AND HOLD TIMES, I_n TO \overline{EX} , \overline{EX} TO CP AND \overline{CI} TO CP

CONDITIONS: $\overline{EO}_0 = \text{LOW}$, \overline{EX} GOES HIGH BEFORE CP

- NOTES: a. $X_0 - X_3$ turn on delay measured from the time both \overline{EX} and CP go LOW.
b. $X_0 - X_3$ turn on delay measured from the time either \overline{EX} or CP go HIGH.
c. Set-up and Hold Times are shown as positive values but may be specified as negative values.

4707B/4707BX

DATA ACCESS REGISTER

FAIRCHILD CMOS MACROLOGIC™

DESCRIPTION — The 4707B/4707BX Data Access Register (DAR) is designed to perform the memory address function for RAM resident stack applications. The DAR can implement general registers with an adder network in programmable digital systems. The 4707B/4707BX contains three 4-bit registers intended for Program Counter (R_0), Stack Pointer (R_1), and Operand Address (R_2). The 4707B/4707BX implements 16 instructions (see *Table 1*) which allow either pre or post decrement/increment and register-to-register transfer in a single clock cycle. It is expandable in 4-bit increments and can operate at a 11.8 MHz microinstruction rate on a 16-bit word. The 3-state outputs are provided for bus oriented applications.

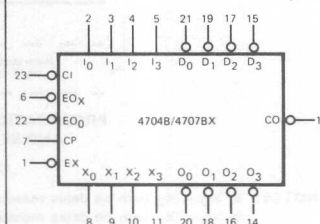
The 4707B/4707BX is fully compatible with all CMOS families. The 4707B is specified to operate over a power supply voltage range of 4.5 V to 12.5 V. The 4707BX is specified to operate over a power supply voltage range of 3 V to 15 V.

- HIGH SPEED—11.8 MHz MICROINSTRUCTION RATE, TYPICALLY AT $V_{DD}=10$ V
- THREE 4-BIT REGISTERS
- 16 INSTRUCTIONS FOR REGISTER MANIPULATION
- TWO SEPARATE OUTPUT PORTS, ONE TRANSPARENT
- RELATIVE ADDRESSING CAPABILITY
- 3-STATE OUTPUTS
- OPTIONAL PRE OR POST ARITHMETIC
- EXPANDABLE IN MULTIPLES OF FOUR BITS
- SLIM 24-PIN PACKAGE

PIN NAMES

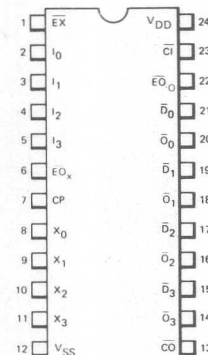
$\bar{D}_0 - \bar{D}_3$	Data Inputs (Active LOW)
$I_0 - I_3$	Instruction Word Inputs
\bar{CI}	Carry Input (Active LOW)
\bar{CO}	Carry Output (Active LOW)
CP	Clock Input (L → H Edge-Triggered)
EX	Execute Input (Active LOW)
\bar{EO}_X	Address Output Enable Input (Active LOW)
\bar{EO}_0	Data Output Enable Input (Active LOW)
$X_0 - X_3$	Address Outputs
$\bar{O}_0 - \bar{O}_3$	Data Outputs (Active Low)

LOGIC SYMBOL



V_{DD} = Pin 24
 V_{SS} = Pin 12

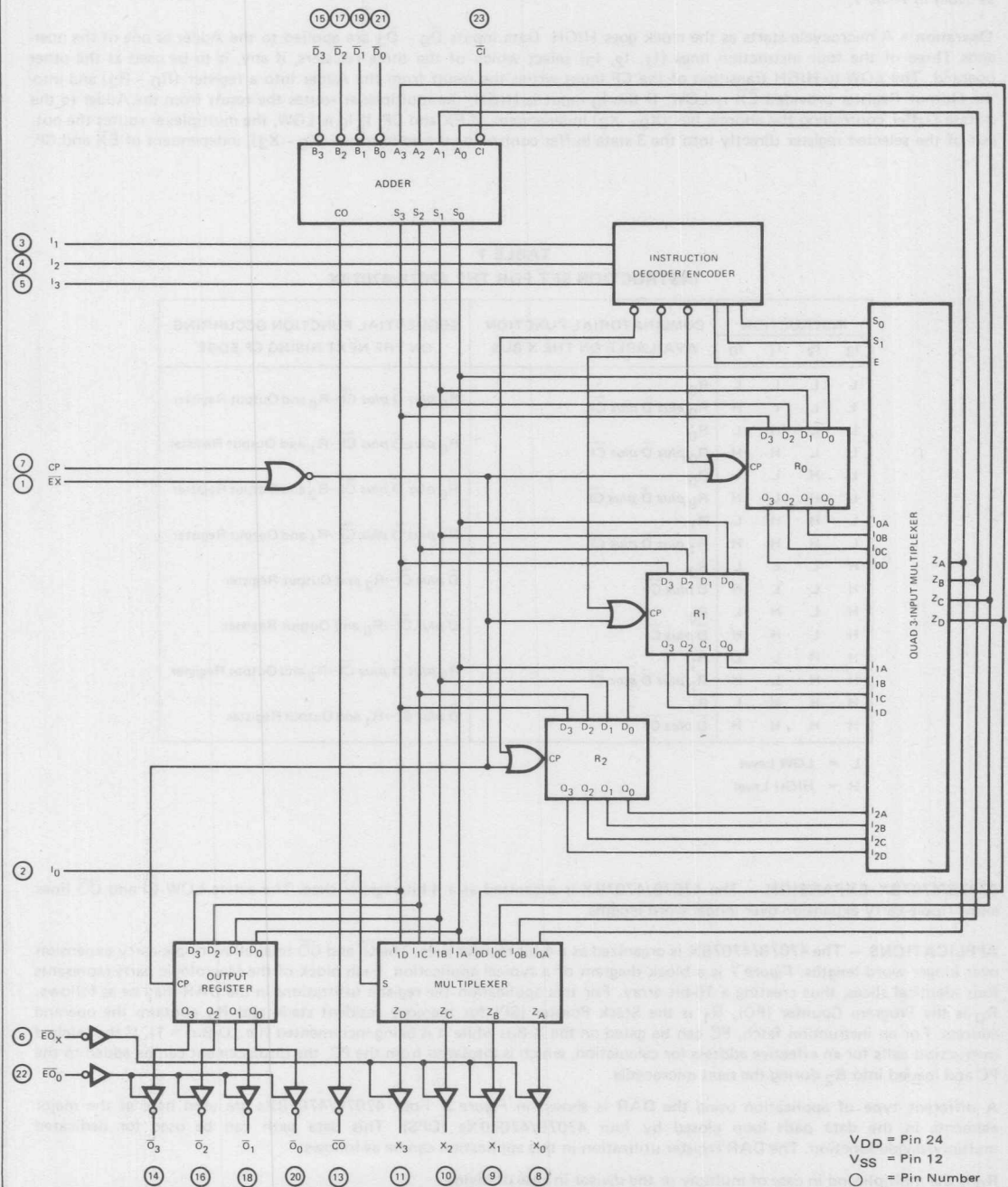
CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

BLOCK DIAGRAM



FUNCTIONAL DESCRIPTION — The 4707B/4707BX contains a 4-bit slice of three registers (R_0 – R_2), a 4-Bit Adder, 3-state address output buffers (X_0 – X_3) and a separate Output Register with 3-state buffers (\bar{O}_0 – \bar{O}_3), allowing output of the register contents on the data bus (refer to the block diagram). The DAR performs 16 instructions, selected by I_0 – I_3 inputs, as listed in Table 1.

Operation — A microcycle starts as the clock goes HIGH. Data inputs \bar{D}_0 – \bar{D}_3 are applied to the Adder as one of the operands. Three of the four instruction lines (I_1 , I_2 , I_3) select which of the three registers, if any, is to be used as the other operand. The LOW-to-HIGH transition of the CP Input writes the result from the Adder into a register (R_0 – R_2) and into the Output Register provided \bar{EX} is LOW. If the I_0 input is HIGH, the multiplexer routes the result from the Adder to the 3-state buffer controlling the address bus (X_0 – X_3) independent of \bar{EX} and CP. If I_0 is LOW, the multiplexer routes the output of the selected register directly into the 3-state buffer controlling the address bus (X_0 – X_3), independent of \bar{EX} and CP.

TABLE 1
INSTRUCTION SET FOR THE 4707B/4707BX

INSTRUCTION				COMBINATORIAL FUNCTION AVAILABLE ON THE X-BUS	SEQUENTIAL FUNCTION OCCURRING ON THE NEXT RISING CP EDGE
I_3	I_2	I_1	I_0		
L	L	L	L	R_0	
L	L	L	H	$R_0 \text{ plus } \bar{D} \text{ plus } \bar{CI}$	$R_0 \text{ plus } \bar{D} \text{ plus } \bar{CI} \rightarrow R_0$ and Output Register
L	L	H	L	R_0	
L	L	H	H	$R_0 \text{ plus } \bar{D} \text{ plus } \bar{CI}$	$R_0 \text{ plus } \bar{D} \text{ plus } \bar{CI} \rightarrow R_1$ and Output Register
L	H	L	L	R_0	
L	H	L	H	$R_0 \text{ plus } \bar{D} \text{ plus } \bar{CI}$	$R_0 \text{ plus } \bar{D} \text{ plus } \bar{CI} \rightarrow R_2$ and Output Register
L	H	H	L	R_1	
L	H	H	H	$R_1 \text{ plus } \bar{D} \text{ plus } \bar{CI}$	$R_1 \text{ plus } \bar{D} \text{ plus } \bar{CI} \rightarrow R_1$ and Output Register
H	L	L	L	R_2	
H	L	L	H	$\bar{D} \text{ plus } \bar{CI}$	$\bar{D} \text{ plus } \bar{CI} \rightarrow R_2$ and Output Register
H	L	H	L	R_0	
H	L	H	H	$\bar{D} \text{ plus } \bar{CI}$	$\bar{D} \text{ plus } \bar{CI} \rightarrow R_0$ and Output Register
H	H	L	L	R_2	
H	H	L	H	$R_2 \text{ plus } \bar{D} \text{ plus } \bar{CI}$	$R_2 \text{ plus } \bar{D} \text{ plus } \bar{CI} \rightarrow R_2$ and Output Register
H	H	H	L	R_1	
H	H	H	H	$\bar{D} \text{ plus } \bar{CI}$	$\bar{D} \text{ plus } \bar{CI} \rightarrow R_1$ and Output Register

L = LOW Level

H = HIGH Level

4707B/4707BX EXPANSION — The 4707B/4707BX is organized as a 4-bit register slice. The active LOW \bar{CI} and \bar{CO} lines allow ripple-carry expansion over longer word lengths.

APPLICATIONS — The 4707B/4707BX is organized as a 4-bit register slice. The \bar{CI} and \bar{CO} lines allow ripple-carry expansion over longer word lengths. Figure 1 is a block diagram of a typical application. Each block of the Macrologic parts represents four identical slices, thus creating a 16-bit array. For this application the register utilizations in the DAR may be as follows: R_0 is the Program Counter (PC), R_1 is the Stack Pointer (SP) for memory resident stack and R_2 contains the operand address. For an instruction fetch, PC can be gated on the X-Bus while it is being incremented (i.e., D-Bus = 1). If the fetched instruction calls for an effective address for calculation, which is displaced from the PC, the displacement can be added to the PC and loaded into R_2 during the next microcycle.

A different type of application using the DAR is shown in Figure 2. Four 4707B/4707BXs are used here as the major elements in the data path loop closed by four 4707B/4707BXs (DPS). This data path can be used for dedicated multiply/divide function. The DAR register utilization in this application can be as follows:

R_0 is the multiplicand in case of multiply or the divisor in case of divide;

R_1 is the temporary result in case of multiply or the dividend/quotient in case of divide;

R_2 is the product in case of multiply or a temporary register in case of divide.

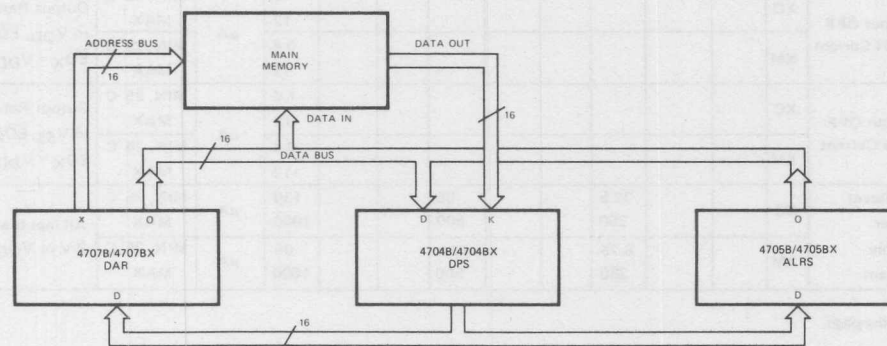


Fig. 1
TYPICAL MEMORY ADDRESS APPLICATION

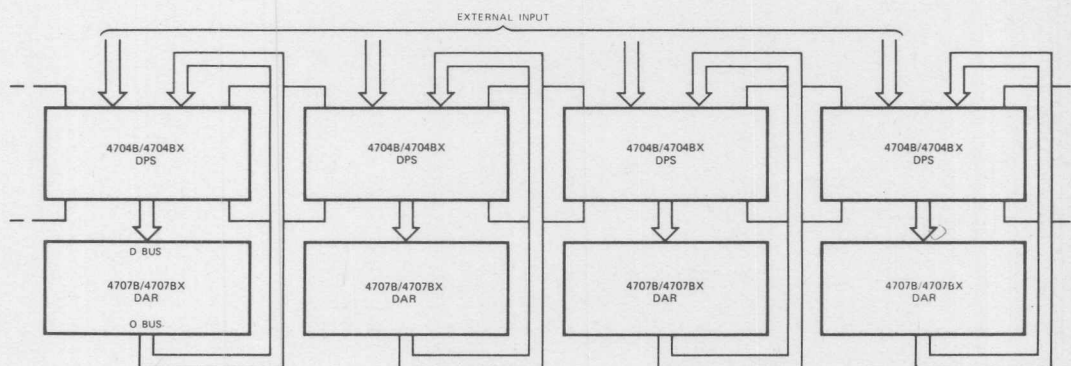


Fig. 2
TYPICAL DATA PATH APPLICATION

FAIRCHILD CMOS • 4707B/4707BX

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF HIGH Current	XC									1.6 12	μA	MIN, 25° C MAX	Output Returned to V _{DD} , $\overline{EO}_0 = V_{DD}$ $\overline{EO}_X = V_{DD}$
		XM									0.4 12		MIN, 25° C MAX	
I _{OZL}	Output OFF LOW Current	XC									-1.6 -12	μA	MIN, 25° C MAX	Output Returned to V _{SS} , $\overline{EO}_0 = V_{DD}$ $\overline{EO}_X = V_{DD}$
		XM									-0.4 -12		MIN, 25° C MAX	
I _{DD}	Quiescent Power	XC			32.5 250			65 500			130 1000	μA	MIN, 25° C MAX	All inputs at 0 V or V _{DD}
	Supply Current	XM			8.75 250			17.5 500			35 1000		MIN, 25° C MAX	

Notes on following page.

FAIRCHILD CMOS • 4707B/4707BX

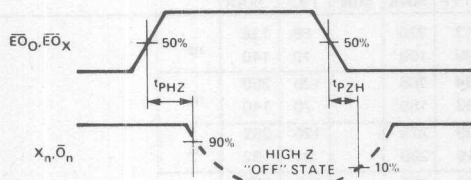
AC CHARACTERISTICS AND SET-UP REQUIREMENTS : V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Internal Clock to Q _n		243	486		113	226		68	136	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	Propagation Delay, Internal Clock to Q _n		232	464		99	198		70	140	ns	
t _{PLH}	Propagation Delay, I ₁ – I ₃ to X _n With I ₀ = LOW		288	576		134	268		125	250	ns	
t _{PHL}	Propagation Delay, I ₁ – I ₃ to X _n With I ₀ = LOW		243	486		93	186		70	140	ns	
t _{PLH}	Propagation Delay, I ₁ – I ₃ to X _n With I ₀ = HIGH		383	766		139	278		126	252	ns	
t _{PHL}	Propagation Delay, I ₁ – I ₃ to X _n With I ₀ = HIGH		302	604		119	238		91	182	ns	
t _{PLH}	Propagation Delay, Internal Clock to X _n With I ₀ = LOW		288	576		134	268		125	250	ns	
t _{PHL}	Propagation Delay, Internal Clock to X _n With I ₀ = LOW		244	488		93	186		63	126	ns	
t _{PLH}	Propagation Delay, Internal Clock to X _n With I ₀ = HIGH		221	442		97	194		69	138	ns	
t _{PHL}	Propagation Delay, Internal Clock to X _n With I ₀ = HIGH		358	716		146	292		110	220	ns	
t _{PLH}	Propagation Delay, D _n to X _n		221	442		97	194		69	138	ns	
t _{PHL}	Propagation Delay, D _n to X _n		211	422		79	158		55	110	ns	
t _{PLH}	Propagation Delay, C _I to X _n		276	552		136	272		89	178	ns	
t _{PHL}	Propagation Delay, C _I to X _n		277	554		146	292		95	190	ns	
t _{PLH}	Propagation Delay, I ₀ to X _n		168	336		82	164		59	118	ns	
t _{PHL}	Propagation Delay, I ₀ to X _n		137	274		63	126		47	94	ns	
t _{PLH}	Propagation Delay, Positive-going Internal Clock to C _O		258	516		127	254		80	160	ns	
t _{PHL}	Propagation Delay, Positive-going Internal Clock to C _O		325	650		141	282		91	182	ns	
t _{PLH}	Propagation Delay, C _I to C _O		132	264		51	102		32	64	ns	
t _{PHL}	Propagation Delay, C _I to C _O		143	286		53	106		35	70	ns	
t _{PLH}	Propagation Delay, D _n to C _O		152	304		63	126		46	92	ns	
t _{PHL}	Propagation Delay, D _n to C _O		149	298		65	130		46	92	ns	
t _{PLH}	Propagation Delay, I ₁ – I ₃ to C _O		274	548		142	284		85	170	ns	
t _{PHL}	Propagation Delay, I ₁ – I ₃ to C _O		305	610		158	316		85	170	ns	
t _{PZH}	Output Enable Time		79	158		30	60		14	28	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PZL}	Output Enable Time		90	180		34	68		23	46	ns	
t _{PHZ}	Output Disable Time		53	106		26	52		22	44	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PLZ}	Output Disable Time		61	122		28	56		23	46	ns	
t _{TLH}	Output Transition Time		105	210		54	108		45	90	ns	
t _{THL}	Output Transition Time		62	124		31	62		22	44	ns	
t _{WCP(H)}	Internal CP minimum Pulse Width (HIGH)	282	141		240	120		176	88		ns	
t _{WCP(L)}	Internal CP Minimum Pulse Width (LOW)	102	51		48	24		44	22		ns	
t _s	Set-up Time, I ₁ – I ₃ to Internal Clock	218	109		82	41		60	30		ns	
t _h	Hold Time, I ₁ – I ₃ to Internal Clock	–48	–96		–17	–34		–12	–24		ns	
t _s	Set-up Time, D _n , C _I to Internal Clock	170	85		88	44		58	29		ns	
t _h	Hold Time, D _n , C _I to Internal Clock	28	14		30	15		28	14		ns	
t _s	Set-up Time, C _I to Internal Clock	82	41		44	22		38	19		ns	
t _h	Hold Time, C _I to Internal Clock	112	56		58	29		42	21		ns	
t _{CW}	Internal Clock Period (Note 3)	388	194		170	85		146	73		ns	
f _{MAX}	Input Count Frequency (Note 4)	2.6	5.2		5.9	11.8		6.8	13.7		MHz	

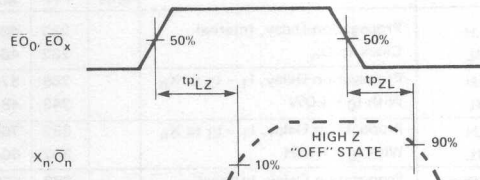
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. The Internal Clock is generated from CP and EX. The Internal Clock is HIGH if EX or CP is HIGH, LOW if EX and CP are LOW. For timing considerations the EX, CP two input active LOW NAND gate is considered to exhibit no propagation delay. Actual timing requirements are referenced to the external CP and EX inputs.
4. For f_{MAX} input rise and fall times are greater than or equal to 5 ns or less than or equal to 20 ns.
5. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V and 3 μ s at $V_{DD} = 15$ V.

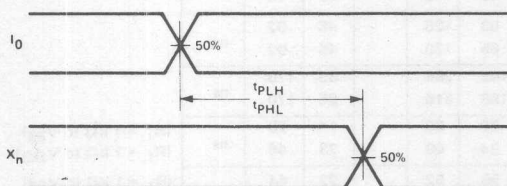
SWITCHING WAVEFORMS



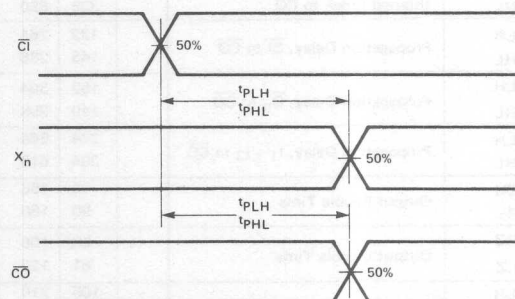
OUTPUT ENABLE TIME
(t_{PHZ}) AND OUTPUT DISABLE TIME (t_{PHZ})



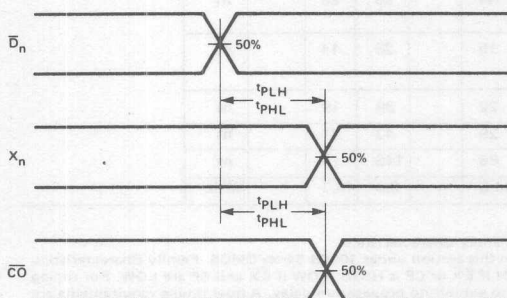
OUTPUT ENABLE TIME
(t_{PLZ}) AND OUTPUT DISABLE TIME (t_{PLZ})



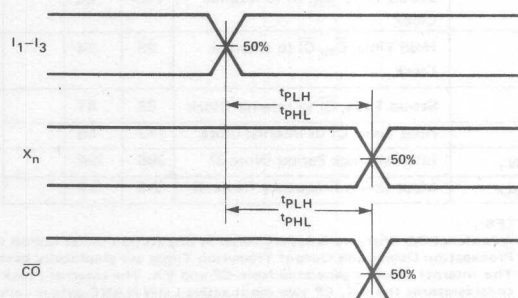
PROPAGATION DELAY, I_0 TO X_n
CONDITIONS: \overline{EO}_x = LOW



PROPAGATION DELAY, \overline{C}_1 TO X_n AND \overline{C}_1 TO \overline{C}_0
CONDITIONS: \overline{EO}_x = LOW, I_0 = HIGH

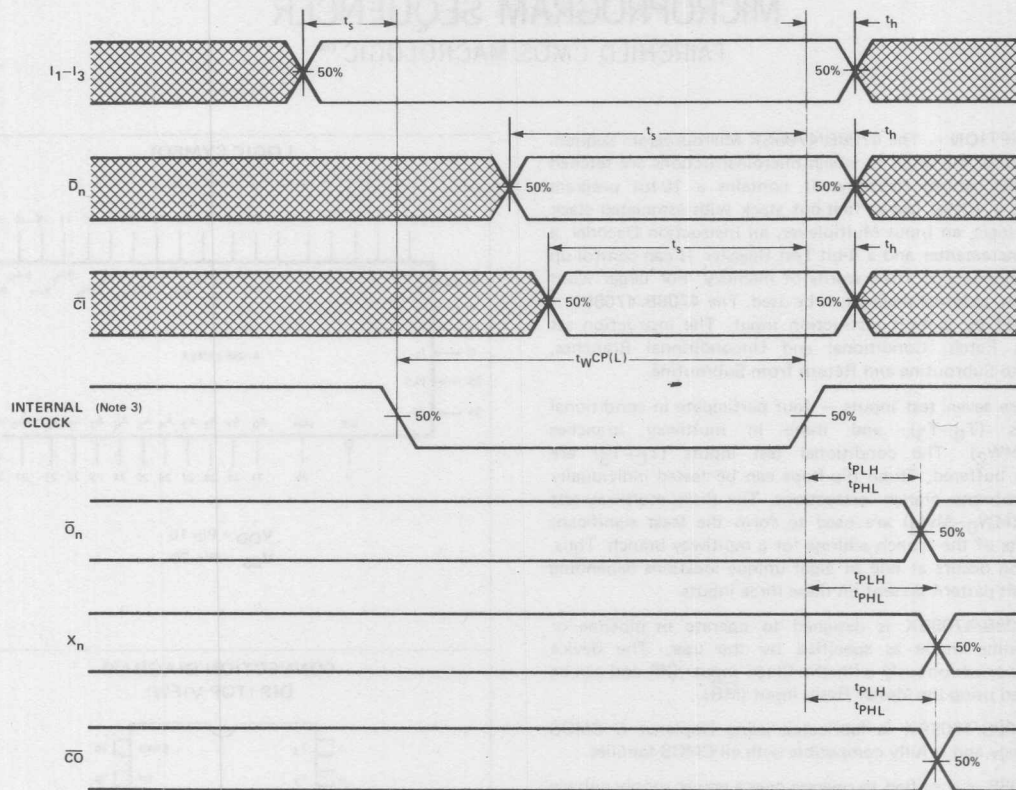


PROPAGATION DELAY, \overline{D}_n TO X_n AND \overline{D}_n TO \overline{C}_0
CONDITIONS: \overline{EO}_x = LOW, I_0 = HIGH



PROPAGATION DELAY, I_1-I_3 TO \overline{C}_0 AND I_1-I_3 TO X_n
CONDITIONS: \overline{EO}_x = LOW

SWITCHING WAVEFORMS (Cont'd)



PROPAGATION DELAYS, INTERNAL CLOCK TO \overline{O}_n ,
INTERNAL CLOCK TO X_n , INTERNAL CLOCK TO \overline{CO} ,
SET-UP AND HOLD TIMES, I_1-I_3 TO INTERNAL CLOCK,
 D_n TO INTERNAL CLOCK, C_n TO INTERNAL CLOCK,
AND MINIMUM INTERNAL CLOCK PULSE WIDTH

CONDITIONS: $\overline{EO}_x = \overline{EO}_o = \text{LOW}$

NOTE: Set-up (t_s) and Hold (t_h) Times are shown as positive values but may be specified as negative values.

4708B/4708BX

MICROPROGRAM SEQUENCER

FAIRCHILD CMOS MACROLOGIC™

DESCRIPTION — The 4708B/4708BX Microprogram Sequencer controls the order in which microinstructions are fetched from the control memory. It contains a 10-bit program counter, a 4-level last-in first-out stack with associated stack control logic, an Input Multiplexer, an Instruction Decoder, a 10-bit Incrementer and a 4-bit Test Register. It can control up to a maximum of 1024 words of memory. For larger word capacities, external paging can be used. The 4708B/4708BX is controlled by a 4-bit instruction input. The instruction set includes Fetch, Conditional and Unconditional Branches, Branch to Subroutine and Return from Subroutine.

There are seven test inputs — four participate in conditional branches (T_0 – T_3), and three in multiway branches (MW_0 – MW_2). The conditional test inputs (T_0 – T_3) are flip-flop buffered. These flip-flops can be tested individually by appropriate branch instructions. The three multiway-test inputs (MW_0 – MW_2) are used to form the least significant three bits of the branch address for a multiway branch. Thus, branching occurs at one of eight unique locations depending on the bit pattern present on these three inputs.

The 4708B/4708BX is designed to operate in pipeline or non-pipeline mode as specified by the user. The device operates synchronously with the Clock input (CP) and can be initialized using the Master Reset input (MR).

The 4708B/4708BX is fabricated using Isoplanar C CMOS technology and is fully compatible with all CMOS families.

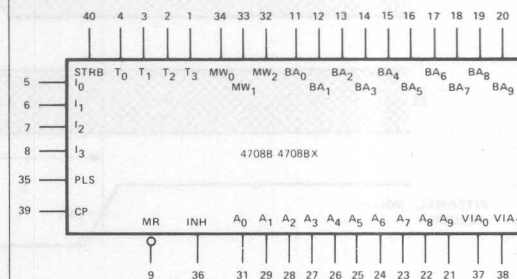
The 4708B is specified to operate over a power supply voltage range of 4.5 V to 12.5 V. The 4708BX is specified to operate over a power supply voltage range of 3 V to 15 V.

- **CONTROLS 1024 WORDS OF MICROPROGRAM MEMORY (10-BIT ADDRESS)**
- **UNRESTRICTED BRANCHING WITHIN 10-BIT ADDRESS SPACE**
- **16 INSTRUCTIONS**
- **FOUR FLIP-FLOP BUFFERED TEST INPUTS FOR CONDITIONAL BRANCHES**
- **8-WAY BRANCH CAPABILITY**
- **PIPELINE/NON-PIPELINE MODE OF OPERATION**

PIN NAMES

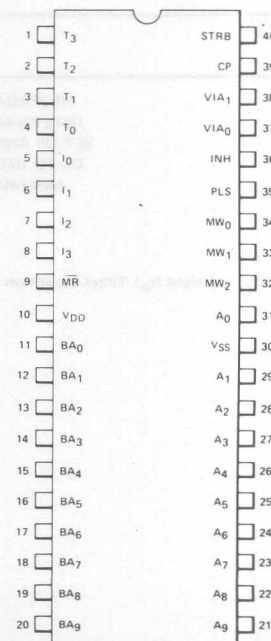
BA_0 – BA_9	Branch Address Inputs
T_0 – T_3	Test Inputs
MW_0 – MW_2	Multiway Branch Inputs
I_0 – I_3	Instruction Inputs
PLS	Pipeline Select Input
\overline{MR}	Master Reset Input (Active LOW)
CP	Clock Pulse Input
STRB	Strobe Input
A_0 – A_9	Address Outputs
VIA_0 , VIA_1	VIA Outputs
INH	Inhibit Output

LOGIC SYMBOL

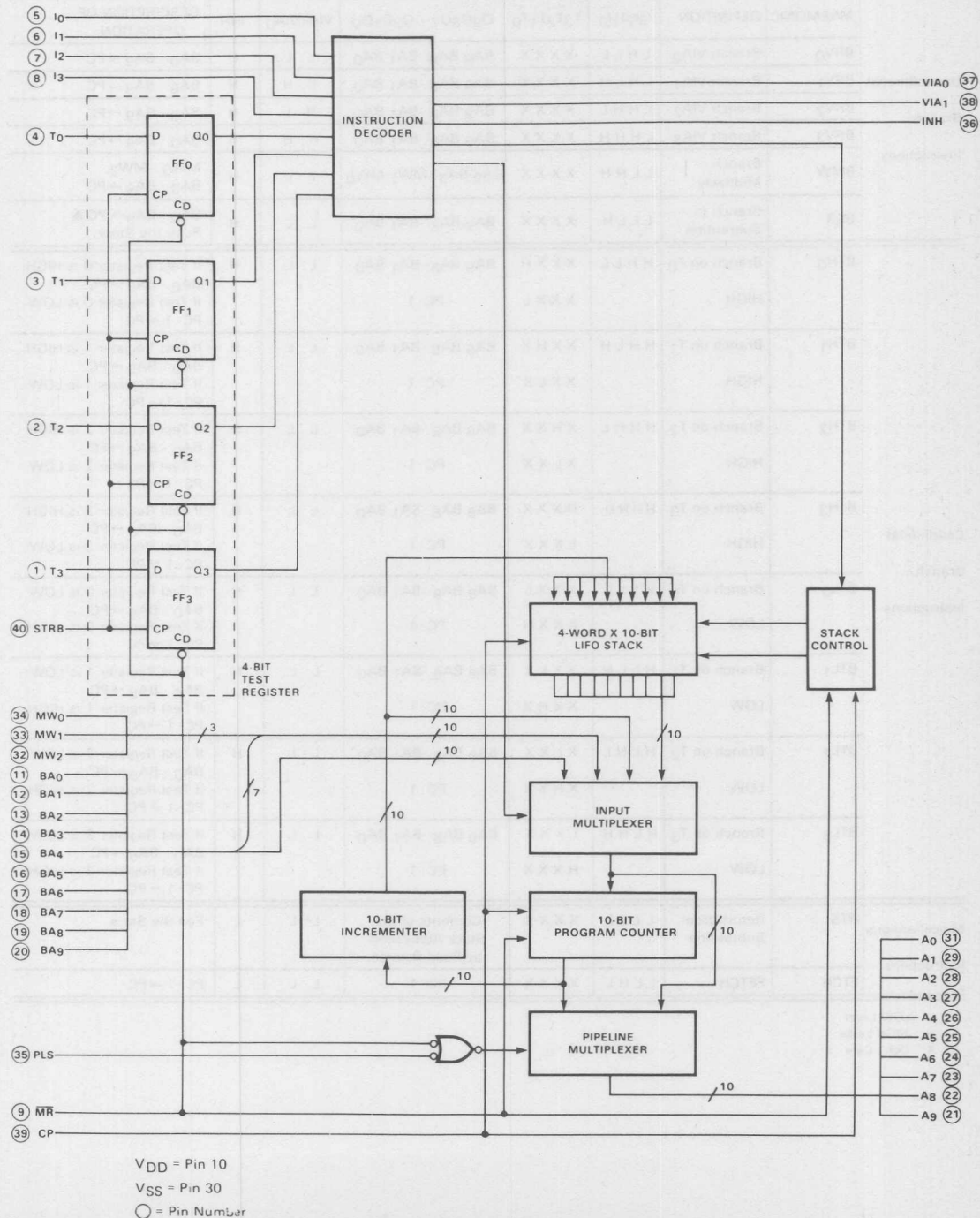


V_{DD} = Pin 10
 V_{SS} = Pin 30

CONNECTION DIAGRAM DIP (TOP VIEW)



BLOCK DIAGRAM



FAIRCHILD CMOS • 4708B/4708BX

TABLE 1
4708B/4708BX INSTRUCTION SET

	MNEMONIC	DEFINITION	I ₃ I ₂ I ₁ I ₀	T ₃ T ₂ T ₁ T ₀	O ₉ O ₈ O ₇ ...O ₂ O ₁ O ₀	VIA ₁ VIA ₀	INH	DESCRIPTION OF OPERATION
Unconditional Branch Instructions	BRV ₀	Branch VIA ₀	L H L L	X X X X	BA ₉ BA ₈ ..BA ₁ BA ₀	L L	H	BA ₀ - BA ₉ → PC
	BRV ₁	Branch VIA ₁	L H L H	X X X X	BA ₉ BA ₈ ..BA ₁ BA ₀	L H	H	BA ₀ - BA ₉ → PC
	BRV ₂	Branch VIA ₂	L H H L	X X X X	BA ₉ BA ₈ ..BA ₁ BA ₀	H L	H	BA ₀ - BA ₉ → PC
	BRV ₃	Branch VIA ₃	L H H H	X X X X	BA ₉ BA ₈ ..BA ₁ BA ₀	H H	H	BA ₀ - BA ₉ → PC
	BMW	Branch Multiway	L L H H	X X X X	BA ₉ BA ₃ ..MW ₂ MW ₀	L L	H	MW ₀ - MW ₂ . BA ₃ - BA ₉ → PC
	BSR	Branch to Subroutine	L L L H	X X X X	BA ₉ BA ₈ ..BA ₁ BA ₀	L L	H	BA ₀ - BA ₉ → PC & Push the Stack
Conditional Branch Instructions	BTH ₀	Branch on T ₀ HIGH	H H L L X X X L	X X X H X X X L	BA ₉ BA ₈ ..BA ₁ BA ₀ PC · 1	L L	H	If Test Register 0 is HIGH: BA ₀ - BA ₉ → PC If Test Register 0 is LOW: PC · 1 → PC
	BTH ₁	Branch on T ₁ HIGH	H H L H X X L X	X X H X X X L X	BA ₉ BA ₈ ..BA ₁ BA ₀ PC · 1	L L	H	If Test Register 1 is HIGH: BA ₀ - BA ₉ → PC If Test Register 1 is LOW: PC · 1 → PC
	BTH ₂	Branch on T ₂ HIGH	H H H L X L X X	X H X X X L X X	BA ₉ BA ₈ ..BA ₁ BA ₀ PC · 1	L L	H	If Test Register 2 is HIGH: BA ₀ - BA ₉ → PC If Test Register 2 is LOW: PC · 1 → PC
	BTH ₃	Branch on T ₃ HIGH	H H H H L X X X	H X X X L X X X	BA ₉ BA ₈ ..BA ₁ BA ₀ PC · 1	L L	H	If Test Register 3 is HIGH: BA ₀ - BA ₉ → PC If Test Register 3 is LOW: PC · 1 → PC
	BTL ₀	Branch on T ₀ LOW	H L L L X X X H	X X X L X X X H	BA ₉ BA ₈ ..BA ₁ BA ₀ PC · 1	L L	H	If Test Register 0 is LOW: BA ₀ - BA ₉ → PC If Test Register 0 is HIGH: PC · 1 → PC
	BTL ₁	Branch on T ₁ LOW	H L L H X X H X	X X L X X X H X	BA ₉ BA ₈ ..BA ₁ BA ₀ PC · 1	L L	H	If Test Register 1 is LOW: BA ₀ - BA ₉ → PC If Test Register 1 is HIGH: PC · 1 → PC
	BTL ₂	Branch on T ₂ LOW	H L H L X H X X	X L X X X H X X	BA ₉ BA ₈ ..BA ₁ BA ₀ PC · 1	L L	H	If Test Register 2 is LOW: BA ₀ - BA ₉ → PC If Test Register 2 is HIGH: PC · 1 → PC
	BTL ₃	Branch on T ₃ LOW	H L H H H X X X	L X X X H X X X	BA ₉ BA ₈ ..BA ₁ BA ₀ PC · 1	L L	H	If Test Register 3 is LOW: BA ₀ - BA ₉ → PC If Test Register 3 is HIGH: PC · 1 → PC
Miscellaneous Instructions	RTS	Return from Subroutine	L L L L	X X X X	Contents of the Stack Addressed by Read Pointer	L L	L	Pop the Stack
	FTCH	FETCH	L L H L	X X X X	PC · 1	L L	L	PC · 1 → PC

L LOW Level
H HIGH Level
X Don't Care

FUNCTIONAL DESCRIPTION — The 4708B/4708BX Microprogram Sequencer, shown in the block diagram consists of a 10-bit Program Counter (PC), a 4-word by 10-bit Last-In First-Out (LIFO) Stack with associated Stack Control, an Input Multiplexer, a Pipeline Multiplexer, an Instruction Decoder, a 10-bit Incrementer, and a 4-bit Test Register comprised of four edge-triggered D flip-flops.

The Pipeline Multiplexer has two ports — the PC output provides the input port for the non-pipeline mode and the Input Multiplexer output provides the input port for the pipeline mode. Port selection is controlled by the Pipeline Select (PLS) and Master Reset (\overline{MR}) inputs. A LOW level on the \overline{MR} input forces the non-pipeline mode of operation and clears the PC. Thus when the 4708B/4708BX is initialized by the \overline{MR} input, the A_0 through A_9 outputs are LOW regardless of the state of the PLS input. A LOW level on the PLS input specifies non-pipeline mode and a HIGH specifies pipeline mode.

The Program Counter is a 10-bit edge-triggered register. The LOW-to-HIGH transition on the Clock (CP) input loads the Input Multiplexer output into the PC. The PC input is always the address of the next microinstruction. Because of the edge-triggered nature of the PC register, the PC output remains static for a full clock cycle. Thus, in the non-pipeline mode, the PC output can be used to address a control memory built with static devices without storing the memory output in an external microinstruction register. However, in the pipeline mode, the 4708B/4708BX provides the next address information as soon as available; therefore, execution of a microinstruction can be overlapped with the fetching of the next microinstruction. To ensure microinstruction stability for a full clock cycle, the control-memory output should be buffered with an external microinstruction register.

The Input Multiplexer receives data from four different sources. One port is the output of the LIFO Stack; a second is the output of the 10-bit Incrementer. The Incrementer always adds one to the PC contents. The third and fourth ports are the branch and multiway-branch ports, the former comprised of the Branch Address inputs (BA_0 – BA_9) and the latter comprised of the seven most significant Branch Address inputs (BA_3 through BA_9) and the three Multiway inputs (MW_0 through MW_2).

The 4-word by 10-bit LIFO Stack is a RAM and receives data from the Incrementer output. The Stack Control logic generates the appropriate control signals, while stack pointers in the Stack Control generate the read and write addresses.

The 4-bit Test Register consists of four type-D flip-flops. The data inputs, which are the four Test inputs (T_0 through T_3), are loaded on the LOW-to-HIGH transition of the Strobe input (STRB).

The Instruction Decoder receives the 4-bit Instruction input (I_0 through I_3) and the Test Register output and generates the VIA_0 , VIA_1 and Inhibit (INH) outputs of the 4708B/4708BX. In addition, it generates appropriate logic signals for the Stack Control and Input Multiplexer.

Stack Control — The 4708B/4708BX has a 4-level subroutine nesting capability as detailed in *Figure 1*. The R_0 and R_1 (Read Address) inputs to the 4-word by 10-bit LIFO Stack specify the address from which information will be read. The W_0 and W_1 (Write Address) inputs specify the address into which information will be written; and the 4708B/4708BX Incrementer output provides the information to be written into the stack (see block diagram). In addition, writing into the memory is controlled by the Write Enable (WE) and CP inputs.

The R_0 , R_1 and W_0 , W_1 inputs of the LIFO Stack are derived from the outputs of a 3-bit edge-triggered register called the Stack Pointer (SP). The least significant two bits (SP_0 and SP_1) of this register are the read address inputs to the memory. The SP outputs are also connected to a Stack-Pointer Incrementer and a Decrementer that generate $SP + 1$ and $SP - 1$ respectively. The least significant two bits of the Incrementer are the write address bits for the memory.

The outputs of the Incrementer, Decrementer and the Stack Pointer are fed as inputs to a 3-port Stack-Pointer Multiplexer which, in turn, feeds the Stack Pointer inputs. Stack pointer loading always occurs on the LOW-to-HIGH transition of the CP input. The \overline{MR} input clears the Stack Pointer. The Stack Pointer Control receives two inputs from the 4708B/4708BX Instruction Decoder — the BSR input, which is active whenever a Branch-to-Subroutine (BSR) instruction is present on the I_0 through I_3 inputs, and the RTS input, which is active whenever a Return-from-Subroutine (RTS) instruction is specified. The port selection of the Stack Pointer Multiplexer is controlled by the outputs of the Stack Pointer Control. For all 4708B/4708BX instructions except BSR and RTS, the Stack Pointer Multiplexer selects the Stack Pointer outputs as the instruction source.

Writing into the memory takes place whenever the \overline{WE} and CP inputs are LOW. Note that the most significant register bit, SP_2 controls the \overline{WE} input to prevent writing into the memory when all four locations are filled with return addresses. Thus the 4708B/4708BX does not store and return addresses beyond four nesting levels.

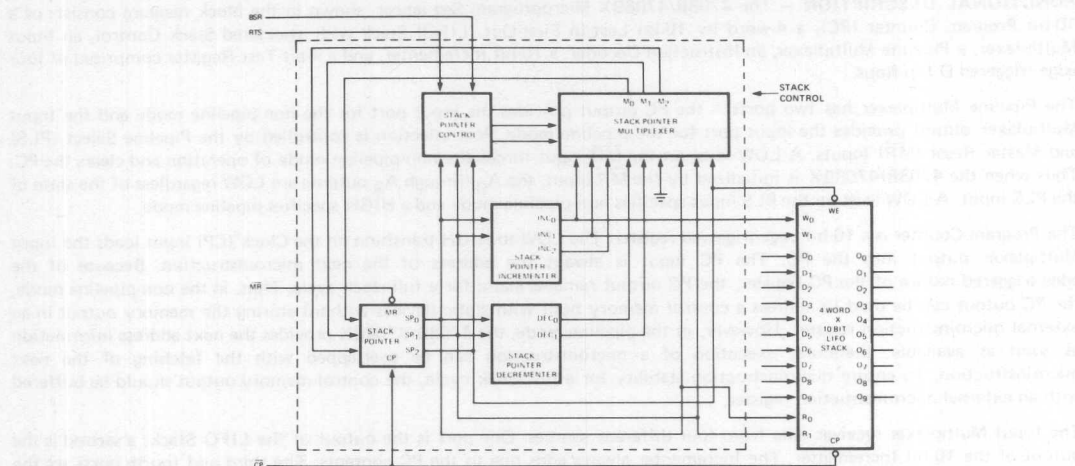


Fig. 1
STACK CONTROL

4708B/4708BX INSTRUCTIONS

The 4708B/4708BX instruction set has 16 instructions (*Table 1*). These instructions can be divided into three groups — unconditional branches, conditional branches and miscellaneous — and are specified by appropriate logic levels on the I₀–I₃ inputs.

The unconditional branch group consists of four Branch VIA instructions (BRV₀–BRV₃), Branch Multiway (BMW) and Branch to Subroutine (BSR). This group requires that the next address be explicitly specified on the BA inputs.

The conditional branch group consists of eight instructions, Branch Test HIGH (BTH₀–BTH₃) and Branch Test LOW (BTL₀–BTL₃), for interrogating the four test flip-flops of the 4708B/4708BX individually. The BTH₀–BTH₃ instructions test flip-flops T₀–T₃ respectively for a HIGH on the Q output (see block diagram). Similarly BTL₀–BTL₃ test for a LOW on the corresponding Q output. If the test condition is satisfied, the next address is taken from the Branch Address (BA₀–BA₉) inputs. If the test condition is not satisfied the 4708B/4708BX performs a Fetch operation.

The miscellaneous group consists of two instructions — Fetch (FTCH) and Return from Subroutine (RTS). These instructions do not require explicit specification of the next address. For the FTCH instruction, the next address is assumed to be the address of the current microinstruction + 1. For RTS, the next address is taken from the Stack. *The Inhibit (INH) output of the 4708B/4708BX is LOW only for FTCH and RTS instructions. For all other instruction, the INH output is HIGH.*

The VIA outputs of the 4708B/4708BX (VIA₀, VIA₁) are LOW for all instructions except BRV₁–BRV₃. For BRV₁, the VIA₀ is HIGH and VIA₁ LOW. For BRV₂, the VIA₀ is LOW and VIA₁ HIGH. For BRV₃, both VIA₀ and VIA₁ are HIGH.

Unconditional Branches

BRV₀–BRV₃ — Whenever a Branch VIA instruction code is present on the I₀–I₃ inputs, the Instruction Decoder (see block diagram) establishes the appropriate HIGH/LOW pattern on the VIA₀ and VIA₁ outputs per *Table 1*. The Instruction Decoder also forces the INH output HIGH. Moreover, the BA₀–BA₉ inputs are selected as the source of the next address by the Input Multiplexer.

If the 4708B/4708BX is in the pipeline mode (PLS input HIGH), the Pipeline Multiplexer transfers the BA₀–BA₉ inputs to the A₀–A₉ outputs. The BA₀–BA₉ inputs are loaded into the PC on the LOW-to-HIGH transition of the CP input. Conversely, if the non-pipeline mode of operation is selected, the BA₀–BA₉ inputs appear on the output only after the LOW-to-HIGH transition of the CP input.

BMW — For a Branch Multiway instruction, the Instruction Decoder forces the VIA₀ and VIA₁ outputs LOW and INH output HIGH. The Input Multiplexer selects the BA₃–BA₉ inputs as the most significant seven bits and MW₀–MW₂ inputs as the least significant three bits of the next address. If the pipeline mode of operation is selected, the next address formed by the Input Multiplexer (BA₃–BA₉ and MW₀–MW₂ inputs) is transferred to the A₀–A₉ outputs. On the LOW-to-HIGH transition of the CP input, this next address is also loaded into the PC. For non-pipeline mode, the next address is available on the A₀–A₉ outputs only after the CP transition.

BSR – During a Branch-to-Subroutine instruction, the Instruction Decoder forces a LOW on the VIA_0 and VIA_1 outputs and a HIGH on the INH output. The Input Multiplexer selects the $BA_0 - BA_9$ inputs as the source for the next address. If the pipeline mode is selected, this next address is transferred to the $A_0 - A_9$ outputs by the Pipeline Multiplexer. As usual, the PC is updated with this next address on the LOW-to-HIGH transition of the CP input. During non-pipeline operation, the next address appears on the output only after the CP transition.

The PC holds the address of the current microinstruction. For the BSR instruction, the return address must be stored in the Stack, which is fed by the PC through an Incrementer (see block diagram). When the CP input is LOW, the incremented value is written into the Stack as a return address. The LOW-to-HIGH transition of the CP input not only loads the PC with the next address, i.e., $BA_0 - BA_9$ inputs, but also increments the Stack Pointer as explained above.

Conditional Branches

BTH₀ – BTH₃ – For a Branch Test HIGH instruction, the Instruction Decoder establishes a LOW on VIA_0 and VIA_1 outputs and HIGH on the INH output. It then tests for a HIGH on the Q output of the corresponding flip-flop in the test register. If a HIGH level is found, the Input Multiplexer selects the $BA_0 - BA_9$ inputs as the source for the next address.

On the other hand, if the tested Q output of the flip-flop is LOW, the Incrementer output is selected as the source of the next address by the Input Multiplexer. In either case, the PC is loaded with the next address on the LOW-to-HIGH transition of the CP input. As usual, if the pipeline mode is selected, the next address is transferred to the $A_0 - A_9$ outputs. For non-pipeline mode, the next address appears on the output after the clock transition.

BTL₀ – BTL₃ – Operation of the Branch Test LOW instructions is identical to BTH₀ – BTH₃ except that Q outputs of the test register flip-flops are tested for a LOW. If the tested output is LOW, a branch occurs. If tested output is HIGH the Incrementer output is the next address.

Miscellaneous

FTCH – For a Fetch instruction, the Instruction Decoder establishes a LOW on the VIA_0 and VIA_1 outputs. In addition, the INH output is also LOW. The Input Multiplexer selects the Incrementer output as the next address. If pipeline mode is selected, the Incrementer output is transferred to the $A_0 - A_9$ outputs. For non-pipeline mode, the incremented address appears at the output only after the clock transition.

RTS – For a Return-from-Subroutine instruction, the Instruction Decoder establishes a LOW on the VIA_0 , VIA_1 and the INH outputs. The Input Multiplexer selects the Stack output as the source of the next address. As usual, for the pipeline mode, the next address is transferred to the output by the Pipeline Multiplexer. For non-pipeline operation, the next address appears on the output only after the clock transition. In addition, this instruction also decrements the Stack Pointer as described above.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS			
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V								
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX						
I _{DD}	Quiescent Power	XC			32.5						65			130	μA	MIN, 25°C	All Inputs at 0 V or V _{DD}
					250						500			1000		MAX	
	Supply Current	XM			8.75						17.5			35	μA	MIN, 25°C	
					250						500			1000		MAX	

FAIRCHILD CMOS • 4708B/4708BX

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$, $C_L = 50$ pF, $R_L = 200$ k Ω ,

Input Transition ≤ 20 ns. (Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, I _N to V _{IA_N}		290			145			116		ns	I ₁ =I ₂ =V _{DD} , I ₃ =V _{SS} Input=I ₀ , Output=V _{IA₀}
t _{PHL}			385			195			156			
t _{PLH}	Propagation Delay, I _N to INH		290			145			116		ns	I ₁ =V _{DD} , I ₂ =I ₃ =V _{SS} Input=I ₀ , Output=INH
t _{PHL}			385			195			156			
t _{PLH}	Propagation Delay, CP to A _N (Non-Pipeline)		430			215			172		ns	I ₁ =V _{DD} , PLS=I ₀ = I ₂ =I ₃ =V _{SS}
t _{PHL}			480			240			192			
t _{PLH}	Propagation Delay, CP to A _N (Pipeline)		860			430			344		ns	PLS=I ₁ =V _{DD} , I ₀ =I ₂ =I ₃ =V _{SS}
t _{PHL}			945			475			380			
t _{PLH}	Propagation Delay, BA _N to A _N (Pipeline)		290			145			116		ns	PLS=I ₀ =I ₁ =I ₂ = V _{DD} , I ₃ =V _{SS}
t _{PHL}			385			195			156			
t _{PLH}	Propagation Delay, I _N to A _N (Pipeline)		770			385			308		ns	I ₀ =I ₁ =BA ₀ =PLS=V _{DD} , I ₃ =MW ₀ =V _{SS} Output=A ₀ , Input=I ₂
t _{PHL}			870			435			348			
t _{TLH}	Output Transition Time		60			40			32		ns	
t _{THL}			60			40			32			
t _{rec}	MR Recovery Time		120			120			96		ns	
t _{WMR} (L)	MR Minimum Pulse Width		280			140			112		ns	
t _{WCP} (H)	CP Minimum Pulse Width (HIGH)		280			140			112		ns	I ₁ =V _{DD} , I ₀ =I ₂ =
t _{WCP} (L)	CP Minimum Pulse Width (LOW)		240			120			96		ns	I ₃ =PLS=V _{SS}
t _s	Set-Up Time, BA _N to CP		240			120			96		ns	I ₂ =V _{DD} , I ₀ =I ₁ =I ₃ = PLS=V _{SS} , Input=BA ₀ , Output=A ₀
t _h	Hold Time, BA _N to CP		-10			-5			-3			
t _s	Set-Up Time, I _N to CP		720			360			288		ns	I ₀ =I ₁ =BA ₀ =V _{DD} , I ₀ = MW ₀ , PLS=V _{SS} , Input=I ₂ , Output=A ₀
t _h	Hold Time, I _N to CP		-10			-5			-3			
t _s	Set-Up Time, T _N to STRB		120			60			48		ns	I ₂ =I ₃ =PLS=V _{DD} , I ₀ =I ₁ =BA ₀ =V _{SS} , Input=T ₀ , Output=A ₀
t _h	Hold Time, T _N to STRB		-10			-5			-3			
t _s	Set-Up Time, STRB to CP (Required to achieve a conditional branch in the same microcycle)		480			240			192		ns	I ₃ =T ₀ =V _{DD} , I ₀ =I ₁ = I ₂ =PLS=BA ₀ =V _{SS} , Input=STRB, Output=A ₀
f _{MAX}	Input Count Frequency (Note 3)										MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

4710B/4710BX

REGISTER STACK • 16×4 RAM WITH 3-STATE OUTPUT REGISTER

FAIRCHILD CMOS MACROLOGIC™

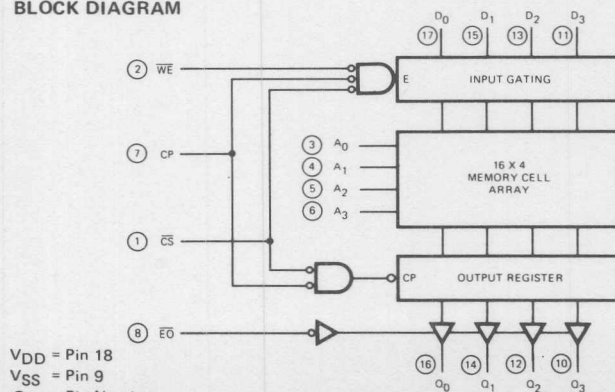
DESCRIPTION — The 4710B/4710BX is a register oriented high speed 64-bit Read/Write Memory organized as 16-words by 4-bits. An edge triggered 4-bit output register allows new input data to be written while previous data is held. 3-state outputs are provided for maximum versatility. The 4710B/4710BX is fully compatible with all CMOS families. The 4710B is specified to operate over a power supply voltage range of 4.5 V to 12.5 V. The 4710BX is specified to operate over a power supply voltage range of 3 V to 15 V.

- EDGE-TRIGGERED OUTPUT REGISTER
- 3-STATE OUTPUTS
- OPTIMIZED FOR REGISTER STACK OPERATION
- 18-PIN PACKAGE

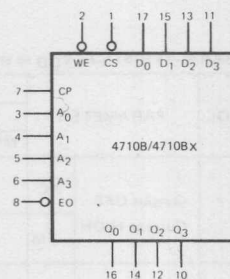
PIN NAMES

A ₀ -A ₃	Address Inputs
D ₀ -D ₃	Data Inputs
CS	Chip Select Input (Active LOW)
\overline{EO}	Output Enable Input (Active LOW)
WE	Write Enable Input (Active LOW)
CP	Clock Input (Outputs Change on LOW to HIGH Transition)
Q ₀ -Q ₃	Outputs

BLOCK DIAGRAM

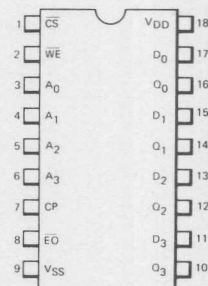


LOGIC SYMBOL



V_{DD} = Pin 18
V_{SS} = Pin 9

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4710B/4710BX

FUNCTIONAL DESCRIPTION – The 4710B/4710BX consists of a 16 X 4-bit RAM selected by four address inputs ($A_0 - A_3$) and an edge-triggered 4-bit Output Register with 3-state Output Buffers.

Write Operation – When the three control inputs: Write Enable (\overline{WE}), Chip Select (\overline{CS}), and Clock (CP), are LOW the information on the data inputs ($D_0 - D_3$) is written into the memory location selected by the address inputs ($A_0 - A_3$). If the input data changes while \overline{WE} , \overline{CS} , and CP are LOW, the contents of the selected memory location follows these changes provided set-up time criteria are met.

Read Operation – Whenever \overline{CS} is LOW and CP goes from LOW-to-HIGH, the contents of the memory location selected by the address inputs ($A_0 - A_3$) is edge triggered into the Output Register.

A 3-State Output Enable (\overline{EO}) controls the output buffers. When \overline{EO} is HIGH the four outputs ($Q_0 - Q_3$) are in a high impedance or OFF state; when \overline{EO} is LOW, the outputs are determined by the state of the Output Register.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF Current HIGH	XC									1.6 12	μA	MIN, 25°C MAX	Output Returned to V _{DD} , $\overline{EO} = V_{DD}$
		XM									0.4 12		MIN, 25°C MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6 - 12	μA	MIN, 25°C MAX	Output Returned to V _{SS} $\overline{EO} = V_{DD}$
		XM									-0.4 - 12		MIN, 25°C MAX	
I _{DD}	Quiescent Power	XC			20 150			40 300			80 600	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
	Supply Current	XM			5 150			10 300			20 600		MIN, 25°C MAX	

Notes on following page.

FAIRCHILD CMOS • 4710B/4710BX

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS			
		$V_{DD} = 5\text{ V}$			$V_{DD} = 10\text{ V}$			$V_{DD} = 15\text{ V}$							
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX					
READ MODE															
t_{PLH}	Propagation Delay, CP to Output		146	292		56	112		40	80	ns	$(R_L = 1\text{ k}\Omega \text{ to } V_{SS})$ $(R_L = 1\text{ k}\Omega \text{ to } V_{DD})$ $(R_L = 1\text{ k}\Omega \text{ to } V_{SS})$ $(R_L = 1\text{ k}\Omega \text{ to } V_{DD})$			
t_{PHL}	Propagation Delay, \overline{EO} to Output		125	250		49	98		34	68	ns				
t_{PZH}	Enable Time, \overline{EO} to Output		57	114		20	40		16	32	ns				
t_{PZL}	Disable Time, \overline{EO} to Output		81	162		31	62		23	46	ns				
t_{PHZ}	Disable Time, \overline{EO} to Output		57	114		29	58		23	46	ns				
t_{PLZ}	Disable Time, \overline{EO} to Output		72	144		31	62		25	50	ns				
t_{TLH}	Output Transition Time		75	150		45	90		35	70	ns	$C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$ Input Transition Times $\leq 20\text{ ns}$			
t_{THL}	Output Transition Time		80	160		45	90		35	70	ns				
WRITE MODE															
$t_{W\overline{WE}}$	Minimum \overline{WE} Pulse Width (Note 3)	218	109		104	52		62	31		ns				
$t_{W\overline{CS}}$	Minimum \overline{CS} Pulse Width (Note 3)	226	113		124	62		74	37		ns				
$t_{W\overline{CP}}$	Minimum CP Pulse Width (Note 3)	240	120		124	62		74	37		ns				
t_s	Set-Up Time \overline{CS} to \overline{WE} (Note 4)	326	163		198	99		134	67		ns				
t_h	Hold Time, \overline{CS} to \overline{WE} (Note 4)	0	-15		0	-10		0	-5		ns				
t_s	Set-Up Time, \overline{CS} to CP	186	93		104	52		68	34		ns				
t_h	Hold Time, \overline{CS} to CP	0	-15		0	-10		0	-5		ns				
t_s	Set-Up Time, $\overline{D_n}$ to \overline{WE} (Note 4)	176	88		70	35		48	24		ns				
t_h	Hold Time, $\overline{D_n}$ to \overline{WE} (Note 4)	0	-15		0	-10		0	-5		ns				
t_s	Set-Up Time, Address to \overline{WE} (Note 4)	206	103		100	50		58	29		ns				
t_h	Hold Time, Address to \overline{WE} (Note 4)	0	-15		0	-10		0	-5		ns				
READ MODE															
t_s	Set-Up Time Address to CP	706	353		372	186		208	104		ns				
t_h	Hold Time Address to CP	0	-15		0	-10		0	-5		ns				

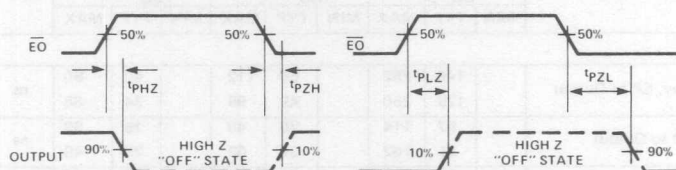
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. Writing occurs when \overline{WE} , \overline{CE} , and CP are LOW.
4. Assuming \overline{WE} is utilized as a Writing STROBE.
5. It is recommended that input rise and fall times to the Clock Input be less than 15 μs at $V_{DD} = 5$ V, 4 μs at $V_{DD} = 10$ V and 3 μs at $V_{DD} = 15$ V.

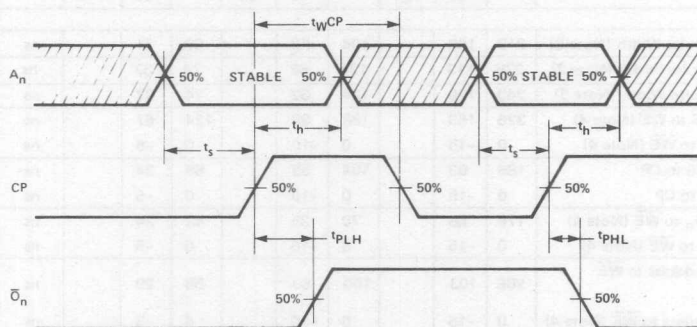
FAIRCHILD CMOS • 4710B/4710BX

SWITCHING WAVEFORMS

READ MODE



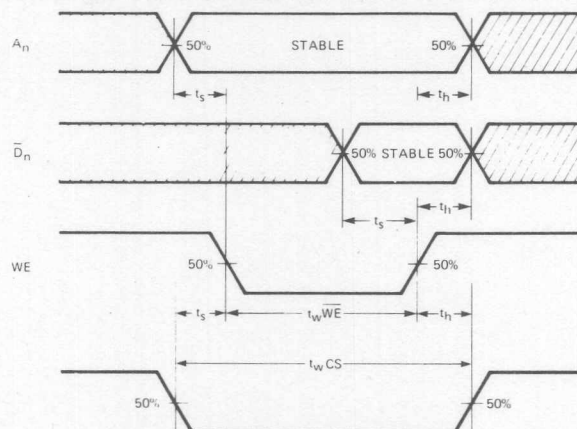
$\overline{E_0}$ TO OUTPUT ENABLE AND DISABLE TIMES



MINIMUM CP PULSE WIDTH, PROPAGATION DELAY CLOCK TO OUTPUT,
AND SET-UP AND HOLD TIMES ADDRESS TO CLOCK

CONDITIONS: $\overline{CS} = \overline{E_0} = \text{LOW}$, $\overline{WE} = \text{HIGH}$

WRITE MODE



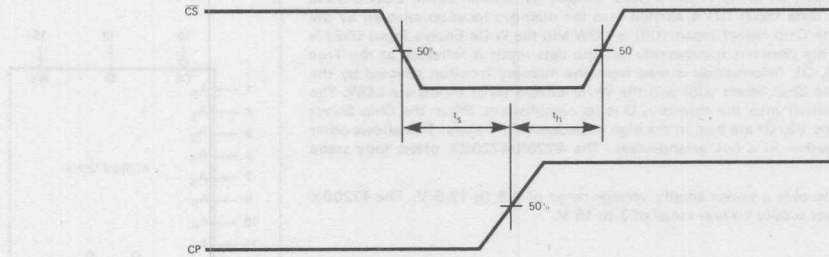
MINIMUM \overline{CS} PULSE WIDTH, MINIMUM WRITE ENABLE PULSE WIDTH,
SET-UP AND HOLD TIMES ADDRESS TO \overline{WE} , DATA TO \overline{WE} , AND \overline{CS} TO \overline{WE}

CONDITIONS: CP = LOW

NOTE: Set-Up (t_s) and Hold Times (t_h) are shown as positive values but may be specified as negative values.

SWITCHING WAVEFORMS (CONT'D)

WRITE MODE



SET-UP AND HOLD TIMES, \overline{CS} TO CP

NOTE: Set-up Times (t_s) and Hold Times (t_h) are shown as positive values, but may be specified as negative values.

4720B/4720BX

256-BIT RANDOM ACCESS MEMORY WITH 3-STATE OUTPUTS

DESCRIPTION — The 4720B/4720BX is a 256-Bit Random Access Memory with 3-State Outputs. It has a Data Input (D), eight Address inputs (A_0 - A_7), an active HIGH Write Enable Input (WE), an active LOW Chip Select Input (\overline{CS}), an active HIGH 3-State Output (Q) and an active LOW 3-State Output (\overline{Q}). Information on the Data Input (D) is written into the memory location selected by the Address Inputs (A_0 - A_7) when the Chip Select Input (\overline{CS}) is LOW and the Write Enable Input (WE) is HIGH. Under these conditions, the device is transparent, i.e., the data input is reflected at the True and Complementary Outputs (Q, \overline{Q}). Information is read from the memory location selected by the Address Inputs (A_0 - A_7) while the Chip Select (\overline{CS}) and the Write Enable (WE) Inputs are LOW. The Q Output is the information written into the memory, \overline{Q} is its complement. When the Chip Select Input (\overline{CS}) is HIGH, both outputs (Q, \overline{Q}) are held in the high impedance OFF state. This allows other 3-State outputs to be wired together in a bus arrangement. The 4720B/4720BX offers fully static operation.

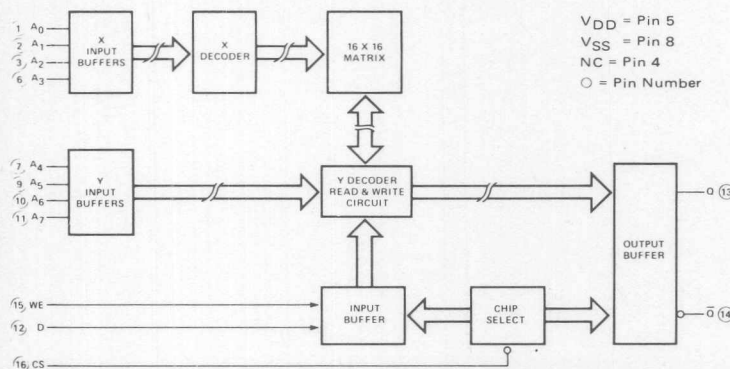
The 4720B is specified to operate over a power supply voltage range of 4.5 to 12.5 V. The 4720BX is specified to operate over a power supply voltage range of 3 to 15 V.

- 3-STATE OUTPUTS
- ORGANIZATION — 256 WORDS X 1-BIT
- ON-CHIP DECODING
- TRUE AND COMPLEMENT OUTPUTS AVAILABLE
- FULLY STATIC
- LOW POWER DISSIPATION
- HIGH SPEED
- TYPICAL HOLDING VOLTAGE OF 1.5 V

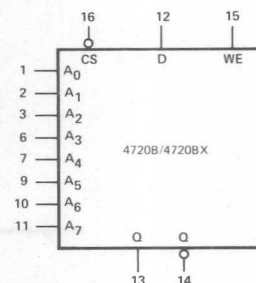
MODE SELECTION

\overline{CS}	WE	Q	\overline{Q}	MODE
L	H	Data Written Into Memory	Complement of Data Written Into Memory	Write
L	L	Data Written Into Memory	Complement of Data Written Into Memory	Read
H	X	High Impedance	High Impedance	Inhibit

BLOCK DIAGRAM

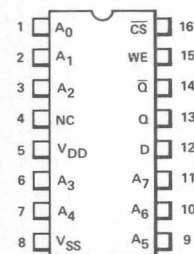


LOGIC SYMBOL



V_{DD} = Pin 5
 V_{SS} = Pin 8
 NC = Pin 4

CONNECTION DIAGRAM
DIP (TOP VIEW)



PIN NAMES

\overline{CS} Chip Select Input (Active LOW)
 WE Write Enable Input
 D Data Input
 A_0 - A_7 Address Inputs
 Q 3-State Output (Active HIGH)
 \overline{Q} 3-State Output (Active LOW)

NOTE:
 The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 4720B/4720BX

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF Current, HIGH	XC									1.6 12	μA	MIN, 25°C MAX	Output Returned to V _{DD} , \overline{CS} = V _{DD}
		XM									0.4 12		MIN, 25°C MAX	
I _{OZL}	Output OFF Current, LOW	XC									-1.6 -12	μA	MIN, 25°C MAX	Output Returned to V _{SS} , \overline{CS} = V _{DD}
		XM									-0.4 -12		MIN, 25°C MAX	
I _{DD}	Quiescent Power Supply Current	XC			20 150			40 300			80 600	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
		XM			5 150			10 300			20 600		μA	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ C$ (See Note 2)

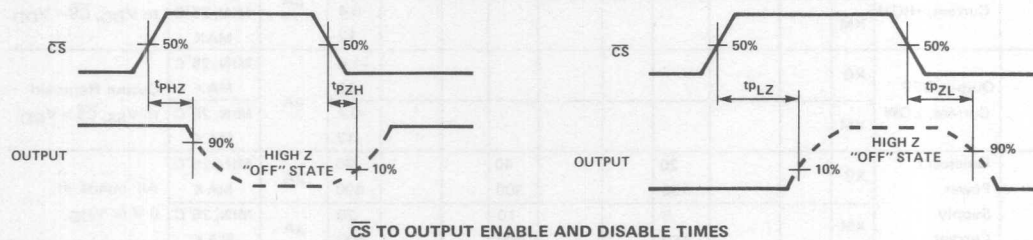
SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS	
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
	READ MODE												
t _{PLH}	Propagation Delay, Address to Output		250	500		95	190		68	136	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD}) (R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})	
t _{PHL}			250	500		95	190		68	136			
t _{PZH}	Enable Time, \overline{CS} to Output		30	60		15	30		11	22	ns		
t _{PZL}			35	70		17	34		12	24			
t _{PHZ}	Disable Time, \overline{CS} to Output		25	50		15	30		11	22	ns		
t _{PLZ}			27	54		16	32		12	24			
t _{TLH}	Output Transition Time		75	150		35	70		25	50	ns		
t _{THL}			75	150		35	70		25	50			
	WRITE MODE												
t _{PLH}	Propagation Delay, WE to Output		250	500		100	200		65	130	ns		C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			250	500		100	200		65	130			
	WRITE MODE												
t _w WE	Minimum WE Pulse Width	240	120		110	55		80	40		ns		
t _s	Set-Up Time, D to WE	80	40		38	19		28	14		ns		
t _h	Hold Time, D to WE	40	20		22	11		18	9				
t _s	Set-Up Time, Address to WE	260	130		130	65		90	45		ns		
t _h	Hold Time, Address to WE	160	80		80	40		40	20				
t _s	Set-Up Time, \overline{CS} to WE	60	30		30	15		20	10		ns		
t _h	Hold Time, \overline{CS} to WE	60	30		30	15		20	10				

NOTES:

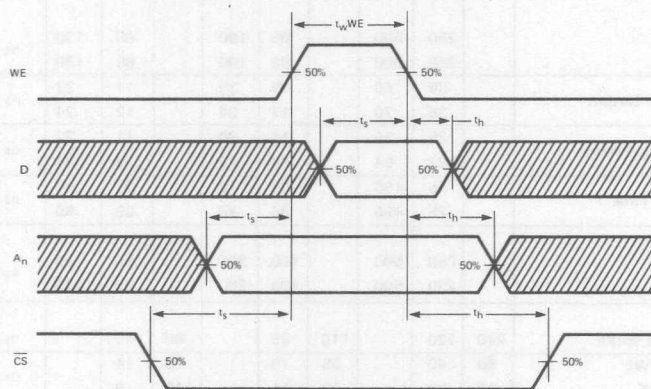
1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. All set-up (t_s) and hold (t_h) times are measured with minimum write enable pulse width (t_{wWE}).

SWITCHING WAVEFORMS

READ MODE



WRITE MODE



MINIMUM PULSE WIDTH FOR WE AND SET-UP AND HOLD TIMES,
D TO WE, A_n TO WE, AND CS TO WE

Note: Set-up and Hold Times are shown as positive values but may be specified as negative values.

4721B/4721BX

1024-BIT (256 x 4) RANDOM ACCESS MEMORY WITH 3-STATE OUTPUTS

FAIRCHILD CMOS LSI

DESCRIPTION — The 4721B/4721BX is a 1024-Bit Random Access Memory, organized 256 words x 4 bits, with 3-state outputs. It has four Data Inputs (D_0 - D_3), eight Address Inputs (A_0 - A_7), an active LOW Write Enable Input (\overline{WE}), two Chip Select Inputs, one active LOW (\overline{CS}_0) and one active HIGH (CS_1), four 3-State Data Outputs (Q_0 - Q_3) and an active LOW Output Enable Input (\overline{EO}).

Information on the Data Inputs (D_0 - D_3) is written into the memory location selected by the Address Inputs (A_0 - A_7) when \overline{CS}_0 and \overline{WE} are LOW and CS_1 is HIGH. Under these conditions the Outputs (Q_0 - Q_3) are held in a high impedance OFF state. Information is read from the memory location selected by the Address Inputs (A_0 - A_7) while \overline{CS}_0 is LOW and CS_1 and \overline{WE} are HIGH. When \overline{CS}_0 is HIGH or CS_1 is LOW all Outputs (Q_0 - Q_3) are held in the high impedance OFF state. This allows other 3-state outputs to be wired together in a bus arrangement.

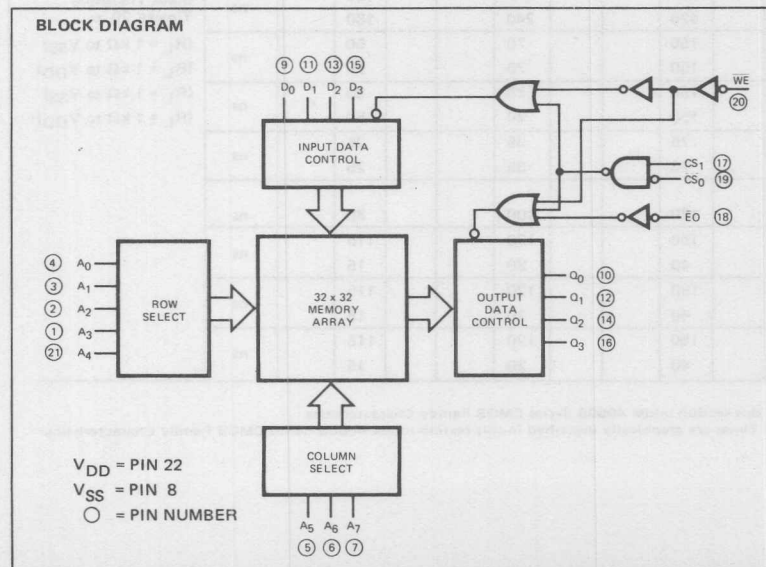
A HIGH on the active LOW Output Enable Input (\overline{EO}) forces all Data Outputs (Q_0 - Q_3) to a high impedance OFF status regardless of all other input conditions. The 4721B/4721BX offers fully static operation. The 4721B is specified to operate over a power supply voltage range of 5 ± 0.5 V. The 4721BX is specified to operate over a power supply voltage range of 4.5 V to 12.5 V.

- TYPICAL HOLDING VOLTAGE OF 1.5 V
- 3-STATE OUTPUTS
- ORGANIZATION — 256 WORDS X 4 BITS
- ON-CHIP DECODING
- FULLY STATIC OPERATION
- LOW POWER DISSIPATION
- HIGH SPEED
- TWO CHIP SELECT INPUTS FOR EASY MEMORY EXPANSION
- ACTIVE LOW OUTPUT ENABLE INPUT

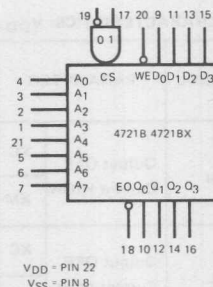
PIN NAMES

A_0 - A_7	Address Inputs
D_0 - D_3	Data Inputs
\overline{CS}_0 , CS_1	Chip Select (Active LOW and Active HIGH) Inputs
\overline{WE}	Write Enable (Active LOW) Input
Q_0 - Q_3	Data Outputs
\overline{EO}	Output Enable (Active LOW) Input

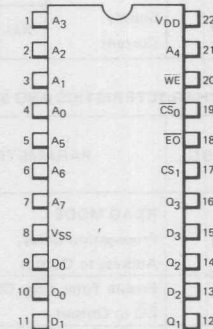
BLOCK DIAGRAM



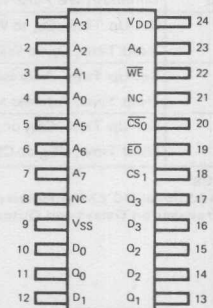
LOGIC SYMBOL



CONNECTION DIAGRAM DIP (TOP VIEW)



CONNECTION DIAGRAM FLATPAK (TOP VIEW)



FAIRCHILD CMOS • 4721B/4721BX

MODE SELECTION

INPUTS				OUTPUTS	MODE
EO	CS ₀	CS ₁	WE	Q _n	
H	X	X	X	High Impedance	Output Disabled
H	L	H	L	High Impedance	Write — Output Disabled
H	L	H	H	High Impedance	Output Disabled
L	H	X	X	High Impedance	Inhibit
L	X	L	X	High Impedance	Inhibit
L	L	H	L	Data Written Into Memory	Write — Transparent
L	L	H	H	Data Written Into Memory	READ

L = LOW Level
H = HIGH Level
X = Don't Care

DC CHARACTERISTICS: V_{DD} as shown, V_{SS} = 0 V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 12.5 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF Current HIGH	XC									1.6 12	μA	MIN, 25°C MAX	Output Returned to V _{DD} , E _O = V _{DD}
		XM									0.4 12		MIN, 25°C MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6 - 12	μA	MIN, 25°C MAX	Output Returned to V _{SS} , E _O = V _{DD}
		XM									-0.4 - 12		MIN, 25°C MAX	
I _{DD}	Quiescent Power Supply Current	XC			32.5 250			65 500			130 1000	μA	MIN, 25°C MAX	C _{S0} = V _{DD} , C _{S1} = V _{SS} All inputs at 0 V or V _{DD}
		XM			8.75 250			17.5 500			35 1000		MIN, 25°C MAX	

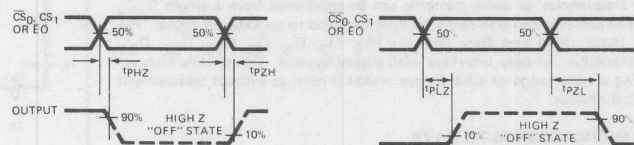
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, V_{SS} = 0 V, T_A = 25°C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS	
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 12.5 V					
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
	READ MODE											ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PLH}	Propagation Delay, Address to Output		420			240			180				
t _{PHL}	Address to Output		420			240			180				
t _{PZH}	Enable Time, $\overline{CS_0}$, CS ₁ or \overline{EO} to Output		150			70			50		ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})	
t _{PZL}	\overline{EO} to Output		150			70			50				
t _{PHZ}	Disable Time, $\overline{CS_0}$, CS ₁ or \overline{EO} to Output		150			70			50		ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})	
t _{PLZ}	\overline{EO} to Output		150			70			50				
t _{TLH}	Output Transition Time		75			35			25		ns		
t _{THL}			75			35			25				
	WRITE MODE											ns	
t _w \overline{WE}	Minimum \overline{WE} Pulse Width		180			100			80				
t _s	Set-Up Time, D _n to \overline{WE}		150			120			115		ns		
t _h	Hold Time, D _n to \overline{WE}		40			20			15				
t _s	Set-Up Time, Address to \overline{WE}		150			120			115		ns		
t _h	Hold Time, Address to \overline{WE}		40			20			15				
t _s	Set-Up Time, $\overline{CS_0}$ or CS ₁ to \overline{WE}		150			120			115		ns		
t _h	Hold Time, $\overline{CS_0}$ or CS ₁ to \overline{WE}		40			20			15				

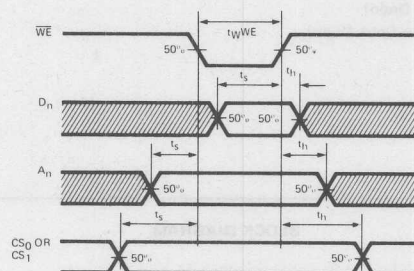
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

AC WAVEFORMS



OUTPUT ENABLE AND DISABLE TIMES



MINIMUM \overline{WE} PULSE WIDTH AND SET-UP AND HOLD TIMES,
 D_n TO \overline{WE} , A_n TO \overline{WE} , AND CS_0 OR CS_1 TO \overline{WE}

NOTE:

Set-up and Hold Times are shown as positive values but may be specified as negative values.

4722B

PROGRAMMABLE TIMER/COUNTER

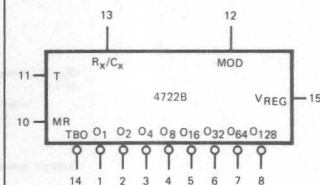
GENERAL DESCRIPTION —The 4722B Programmable Timer/Counter is a monolithic controller capable of producing accurate microsecond to five day time delays. Long delays, up to three years, can easily be generated by cascading two timers. The timer consists of a time base oscillator programmable 8-bit counter and control flip-flop. An external resistor capacitor ($R_X C_X$) network sets the oscillator frequency and allows delay times from $1 R_X C_X$ to $255 R_X C_X$ to be selected. In the astable mode of operation, 255 frequencies or pulse patterns can be generated from a single $R_X C_X$ network. These frequencies or pulse patterns can also easily be synchronized to an external signal. The Trigger Input (T), Master Reset Input (MR) and Data Outputs ($\bar{O}_0, \bar{O}_2, \bar{O}_4, \bar{O}_8, \bar{O}_{16}, \bar{O}_{32}, \bar{O}_{64}, \bar{O}_{128}$) are all TTL and DTL compatible for easy interface with digital system. The timer's high accuracy and versatility in producing a wide range of time delays makes it ideal as a direct replacement for mechanical or electromechanical devices.

- ACCURATE TIMING FROM MICROSECONDS TO DAYS
- PROGRAMMABLE DELAYS FROM $1 R_X C_X$ TO $255 R_X C_X$
- TTL, DTL AND CMOS COMPATIBLE OUTPUTS
- TIMING DIRECTLY PROPORTIONAL TO $R_X C_X$ TIME CONSTANT
- HIGH ACCURACY
- EXTERNAL SYNC AND MODULATION CAPABILITY
- WIDE SUPPLY VOLTAGE RANGE
- EXCELLENT SUPPLY VOLTAGE REJECTION
- LOW POWER DISSIPATION

PIN NAMES

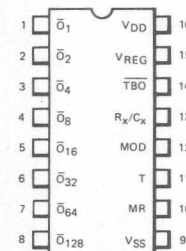
R_X/C_X	External Resistor/Capacitor Connection
T	Trigger Input
MOD	Modulation Input
MR	Master Reset Input
V_{REG}	Regulator Output
\bar{TBO}	Time Base Output (Open Drain)
$\bar{O}_1, \bar{O}_2, \bar{O}_4, \bar{O}_8,$ $\bar{O}_{16}, \bar{O}_{32}, \bar{O}_{64}, \bar{O}_{128}$	Data Outputs (Active Low-Open Drain)

LOGIC SYMBOL



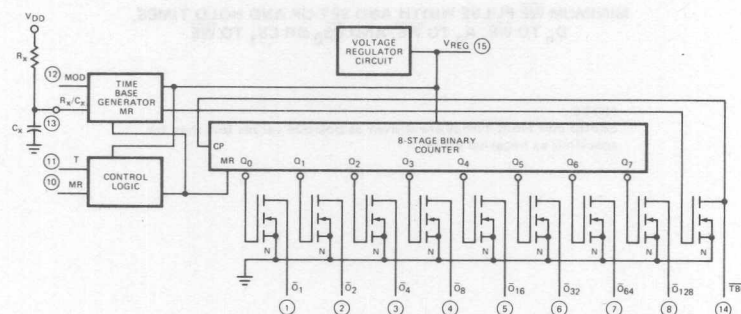
V_{DD} = Pin 16
 V_{SS} = Pin 9

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

BLOCK DIAGRAM



FUNCTIONAL DESCRIPTION

When power is applied to the 4722B with no Trigger (T) or Master Reset (MR) Inputs, the circuit starts with all outputs in a high impedance OFF state. Application of a positive-going trigger pulse to T initiates the timing cycle. The Trigger Input (T) activates the Time-Base Generator, enables the counter and sets the counter outputs LOW. The time-base generator generates timing pulses with a period $T = 1 R_X C_X$. These clock pulses are counted by the 8-stage Binary Counter. The timing sequence is completed when a positive-going pulse is applied to MR.

Once triggered, the circuit is immune from additional trigger inputs until the timing cycle is completed or a Master Reset is applied. If both the Master Reset and Trigger Inputs are activated simultaneously, the Trigger Input takes precedence.

Figure 1 gives the timing sequence of output waveforms at various circuit terminals, subsequent to a Trigger Input. When the circuit is in a Master Reset state, both the time-base and the counter sections are disabled and all the counter outputs are in a high impedance OFF state.

In most timing applications, one or more of the counter outputs are connected to the Master Reset terminal with S1 closed (Figure 2). The circuit starts timing when a Trigger Input is applied and automatically resets itself to complete the timing cycle when a programmed count is completed. If none of the counter outputs are connected back to the Master Reset terminal (switch S1 open), the circuit operates in an astable or free-running mode, following a Trigger Input.

Important Operating Information

- Ground connection is pin 9.
- Master Reset sets all outputs to a high impedance OFF state.
- Trigger sets all outputs LOW.
- Time-base \overline{TBO} can be disabled by bringing the R_X/C_X Input LOW via a pull-down resistor.
- Normal Time-base Output (\overline{TBO}) is a negative-going pulse greater than 500 ns.
- Master Reset stops the time-base generator.
- Data outputs $\overline{O}_1 \dots \overline{O}_{128}$ sink 1.6 mA current with $V_{OL} \leq 0.4$ V;
- For use with external clock, minimum clock pulse amplitude should be 0.7 V_{DD} , with greater than 1 μ s pulse duration.

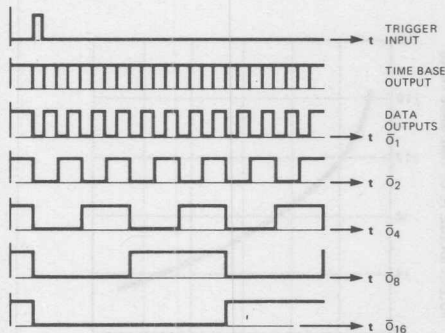


Fig. 1 Timing Diagram of Output Waveforms

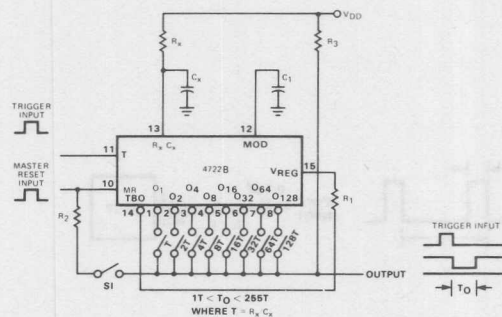


Fig. 2 Basic Circuit Connection for Timing Applications
Monostable: S1 Closed
Astable: S1 Open

CIRCUIT CONTROLS**Data Outputs ($\bar{O}_1 \dots \bar{O}_{128}$)**

The Data Outputs are buffered open-drain type stages, as shown in the block diagram. Each output is capable of sinking 1.6 mA at 0.4 V V_{OL} . In the Master Reset condition, all the Data Outputs are in a high impedance OFF state. Following a Trigger Input, the Outputs change state in accordance with the timing diagram of *Figure 1*. The Data Outputs can be used individually, or can be connected together in a wired-OR configuration, as described in the Programming section.

Master Reset and Trigger Inputs (MR and T)

The circuit is reset or triggered with positive-going control pulses applied to MR and T, respectively. Once triggered, the circuit is immune to additional trigger inputs until the end of the timing cycle.

Modulation Input (MOD)

The oscillator time-base period T can be modulated by applying a dc voltage to MOD. The time-base generator can be synchronized to an external clock by applying a sync pulse to MOD, as shown in *Figure 3*.

The time base can be synchronized by setting the time-base period T to be an integer multiple of the sync pulse period, T_s . This can be done by choosing the timing components R_x and C_x such that:

$$T = R_x C_x = (T_s / m)$$

where

$$m \text{ is an integer, } 1 \leq m \leq 10$$

Figure 4 gives the typical pull-in range for harmonic synchronization for various values of harmonic modulus, m. For $m < 10$, typical pull-in range is greater than $\pm 4\%$ of time-base frequency.

 R_x/C_x Connection

The time-base period T is determined by the external $R_x C_x$ network connected to R_x/C_x . When the time base is triggered, the waveform at R_x/C_x is an exponential ramp with a period $T = 1.0 R_x C_x$.

Time-Base Output (\bar{TBO})

The Time-Base Output is an open-drain type stage as shown in the block diagram and requires a pull-up resistor to V_{REG} for proper circuit operation. In the Master Reset state, the time-base output is in a high impedance OFF state. After triggering, it produces a negative-going pulse train with a period $T = R_x C_x$ as shown in the diagram of *Figure 1*. The Time-Base Output is internally connected to the binary-counter section and can also serve as the input for the external clock signal when the circuit is operated with an external time base. The counter section triggers on the negative-going edge of the timing or clock pulses generated at \bar{TBO} . The counter section can be disabled by clamping the voltage level at \bar{TBO} to ground.

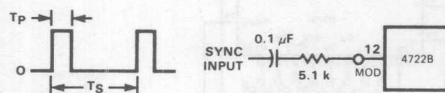


Fig. 3 Operation with External Sync. Signal

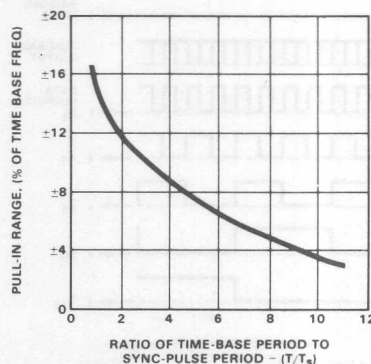


Fig. 4 Typical Pull-in Range for Harmonic Synchronization

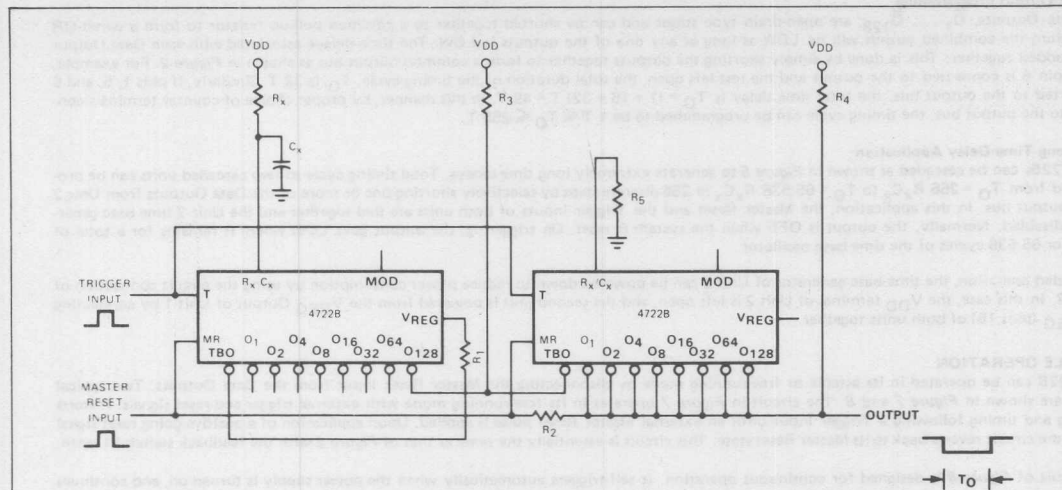


Fig. 5 Cascaded Operation for Long Delays

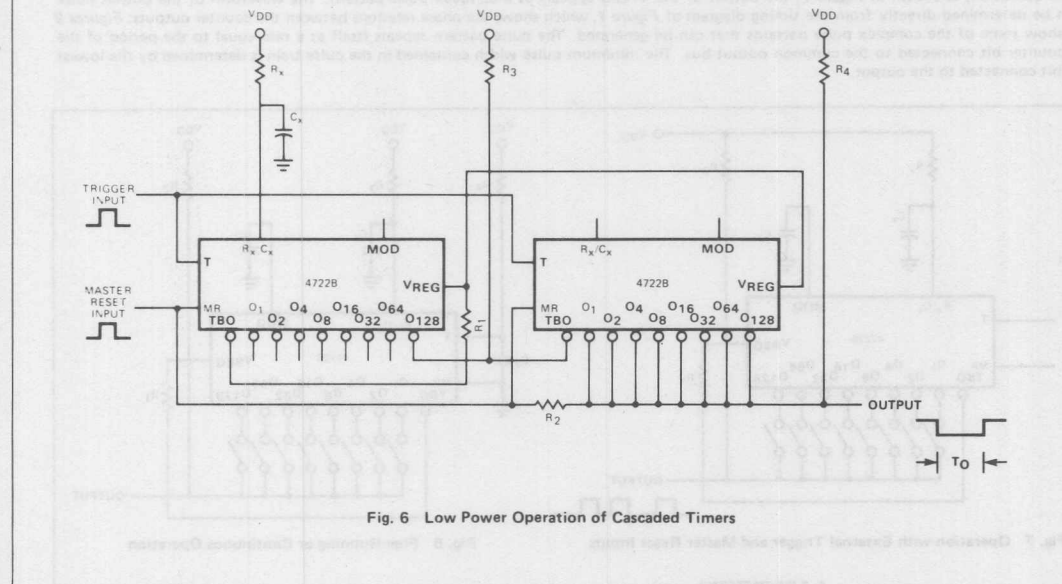


Fig. 6 Low Power Operation of Cascaded Timers

Regulator Output (V_{REG})

The Regulator Output (V_{REG}) is used internally to drive the counter and the control logic. This terminal can also be used as a supply to additional 4722B circuits when several timer circuits are cascaded (see Figure 6) to minimize power dissipation. For circuit operation with an external clock, V_{REG} can be used as the V_{DD} input terminal to power down the internal time base and reduce power dissipation. When supply voltages less than 4.5 V are used with the internal time-base, V_{REG} should be shorted to V_{DD} .

MONOSTABLE OPERATION

Precision Timing

In precision timing applications, the 4722B is used in its monostable or self-resetting mode. The generalized circuit connection for this application is shown in Figure 2. The output is normally OFF and goes LOW following a Trigger Input. It remains LOW for the time duration, T_O , and then returns to the OFF state. The duration of the timing cycle T_O is given as:

$$T_O = NT = NR_x C_x$$

where $T = R_x C_x$ is the time-base period as set by the choice of timing components at R_x/C_x and N is an integer in the range of $1 \leq N \leq 255$ as determined by the combination of counter outputs $O_1 \dots O_{128}$, connected to the output bus.

are shorted to the output bus, the total time delay is $T_O = (1 + 16 + 32) T = 49 T$. In this manner, by proper choice of counter terminals connected to the output bus, the timing cycle can be programmed to be $1 T \leq T_O \leq 255 T$.

Ultra-Long Time-Delay Application

Two 4722Bs can be cascaded as shown in Figure 5 to generate extremely long time delays. Total timing cycle of two cascaded units can be programmed from $T_O = 256 R_x C_x$ to $T_O = 65,536 R_x C_x$ in 256 discrete steps by selectively shorting one or more of the Data Outputs from Unit 2 to the output bus. In this application, the Master Reset and the Trigger Inputs of both units are tied together and the Unit 2 time base generator is disabled. Normally, the output is OFF when the system is reset. On triggering, the output goes LOW where it remains for a total of $(256)^2$ or 65,536 cycles of the time-base oscillator.

In cascaded operation, the time-base generator of Unit 2 can be powered down to reduce power consumption by using the circuit connection of Figure 6. In this case, the V_{DD} terminal of Unit 2 is left open, and the second unit is powered from the V_{REG} Output of Unit 1 by connecting the V_{REG} (pins 15) of both units together.

ASTABLE OPERATION

The 4722B can be operated in its astable or free-running mode by disconnecting the Master Reset Input from the Data Outputs. Two typical circuits are shown in Figure 7 and 8. The circuit in Figure 7 operates in its free-running mode with external trigger and reset signals. It starts counting and timing following a Trigger Input until an external Master Reset pulse is applied. Upon application of a positive-going reset signal to MR, the circuit reverts back to its Master Reset state. This circuit is essentially the same as that of Figure 2 with the feedback switch S1 open.

The circuit of Figure 8 is designed for continuous operation. It self-triggers automatically when the power supply is turned on, and continues to operate in its free-running mode indefinitely, in astable or free-running operation; each of the counter outputs can be used individually as synchronized oscillators, or they can be interconnected to generate complex pulse patterns.

Binary Pattern Generation

In astable operation, as shown in Figure 7, the output of the 4722B appears as a complex pulse pattern. The waveform of the output pulse train can be determined directly from the timing diagram of Figure 1, which shows the phase relations between the counter outputs. Figures 9 and 10 show some of the complex pulse patterns that can be generated. The pulse pattern repeats itself at a rate equal to the period of the highest counter bit connected to the common output bus. The minimum pulse width contained in the pulse train is determined by the lowest counter bit connected to the output.

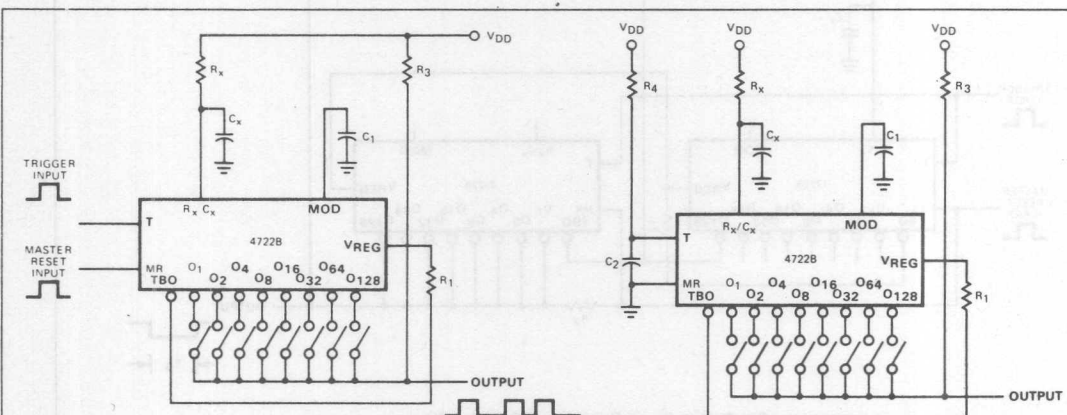


Fig. 7 Operation with External Trigger and Master Reset Inputs

Fig. 8 Free-Running or Continuous Operation

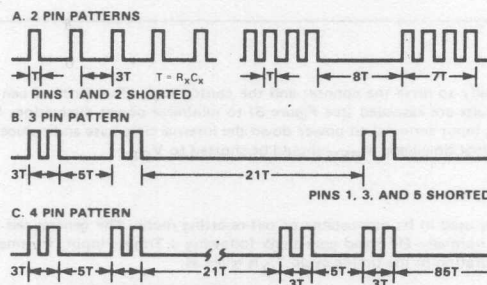


Fig. 9 Binary Pulse Patterns Obtained by Shorting Various Counter Outputs

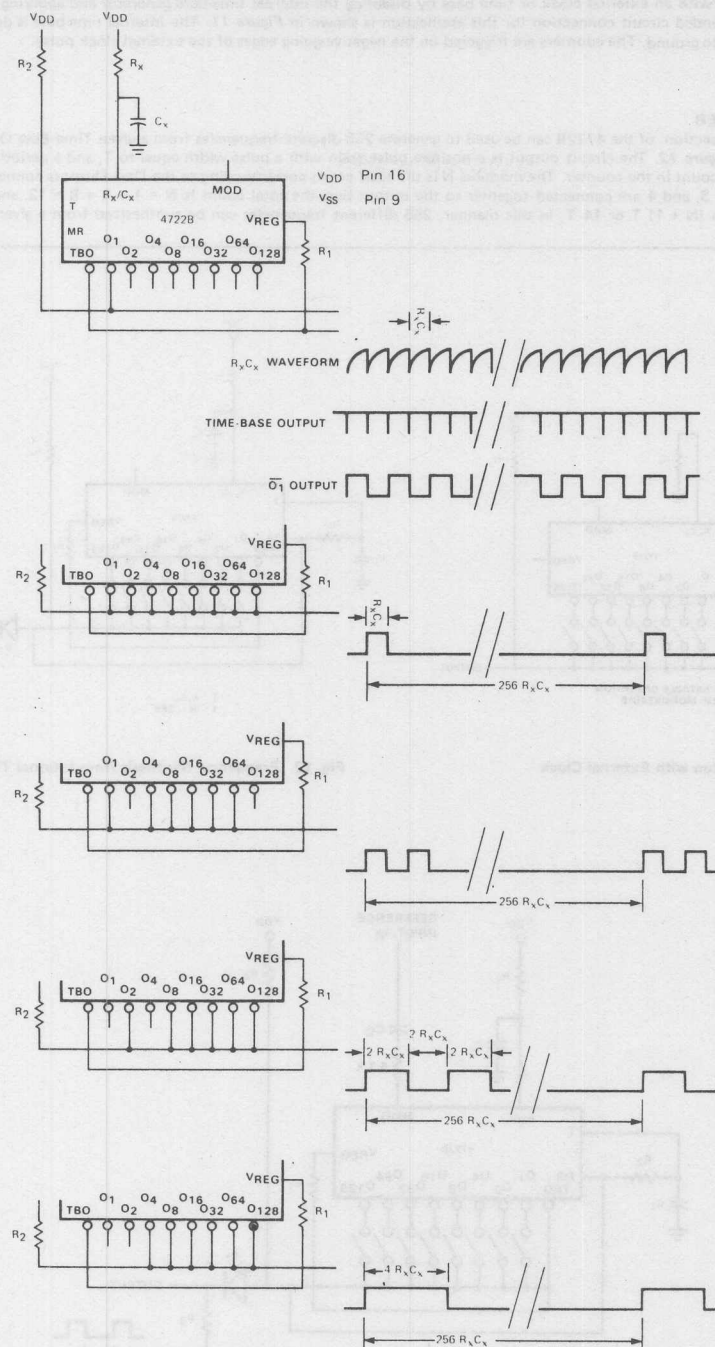


Fig. 10 Continuous Free-run Operation Examples of Output

OPERATION WITH EXTERNAL CLOCK

The 4722B can be operated with an external clock or time base by disabling the internal time-base generator and applying the external clock input to TBO. The recommended circuit connection for this application is shown in *Figure 11*. The internal time base is de-activated by connecting a resistor from $R_X C_X$ to ground. The counters are triggered on the negative-going edges of the external clock pulse.

FREQUENCY SYNTHESIZER

The programmable counter section of the 4722B can be used to generate 255 discrete frequencies from a given Time-Base Output setting using the circuit connection of *Figure 12*. The circuit output is a positive pulse train with a pulse width equal to T , and a period equal to $(N + 1) T$ where N is the programmed count in the counter. The modulus N is the total count corresponding to the Data Outputs connected to the output bus. For example, if pins 1, 3, and 4 are connected together to the output bus, the total count is $N = 1 + 4 + 8 = 13$, and the period of the output waveform is equal to $(N + 1) T$ or $14 T$. In this manner, 255 different frequencies can be synthesized from a given time-base setting.

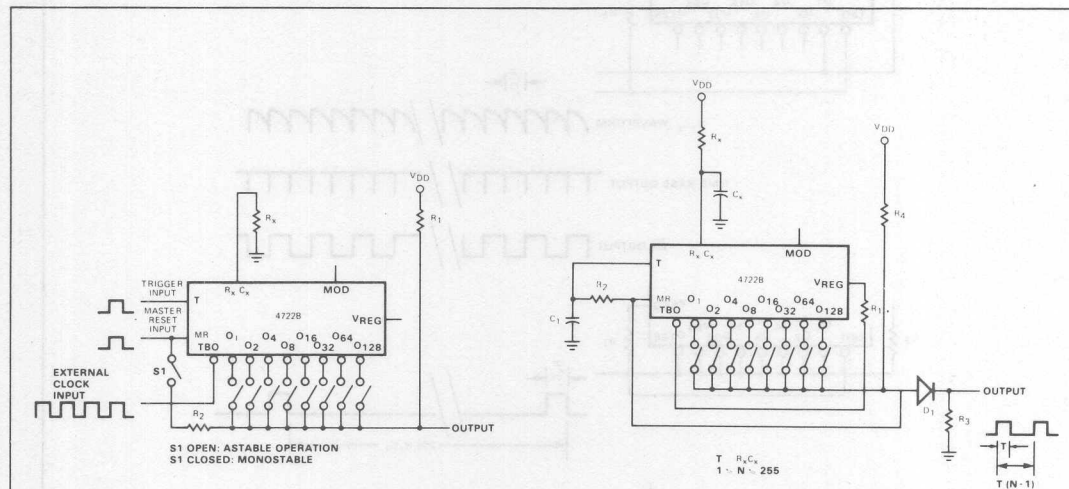


Fig. 12 Frequency Synthesis from Internal Time-Base

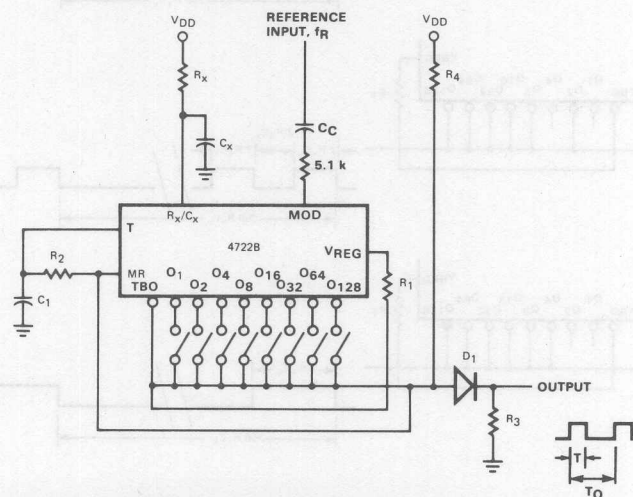


Fig. 13 Frequency Synthesis by Harmonic Locking to an External Reference

SYNTHESIS WITH HARMONIC LOCKING

The harmonic synchronizing feature of the time base can be used to generate a wide number of discrete frequencies from a given input reference frequency. The circuit connection for this application is shown in *Figure 13* (see *Figures 3* and *4* for external sync waveform and harmonic capture range). If the time base is synchronized to (m)th harmonic of input frequency where $1 \leq m \leq 10$, the frequency f_O of the output waveform in *Figure 13* is related to the input reference frequency f_R as

$$f_O = f_R \frac{m}{(N+1)}$$

where m is the harmonic number, and N is the programmed counter modulus. For a range of $1 \leq N \leq 255$, the circuit of *Figure 13* can produce 2550 different frequencies from a single fixed reference.

The circuit of *Figure 13* can be used to generate frequencies which are not harmonically related to a reference input. For example, by selecting the external $R_X C_X$ to set $m = 10$ and setting $N = 5$, a 100 Hz output frequency synchronized to 60 Hz power line frequency can be obtained.

STAIRCASE GENERATOR

The 4722B Programmable Timer/Counter can be interconnected with an external operational amplifier and a precision resistor ladder to form a staircase generator as shown in *Figure 14*. Under Master Reset condition, the output is LOW. When a Trigger is applied, the op amp output goes HIGH and generates a negative-going staircase of 256 equal steps. The time duration of each step is equal to the time-base period T. The staircase can be stopped at any level by applying a disable signal to TBO, through a steering diode, as shown in *Figure 14*. The count is stopped when TBO is clamped.

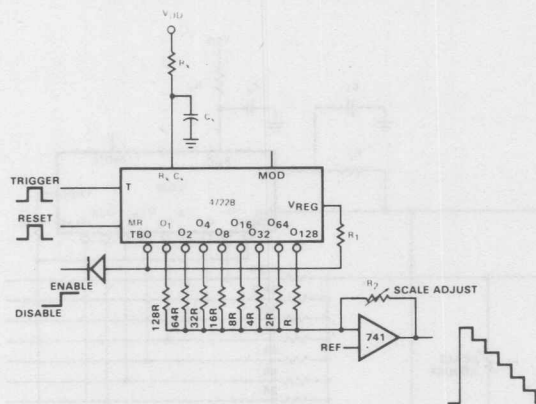


Fig. 14 Staircase Generator

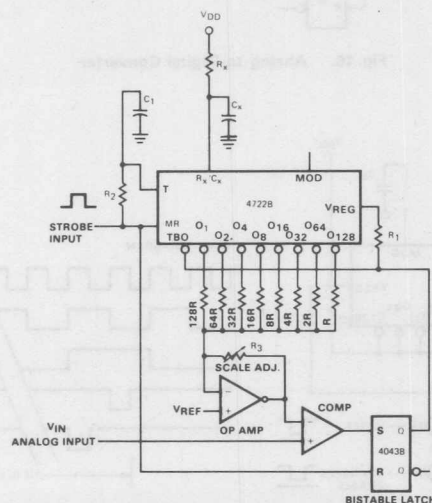


Fig. 15 Digital Sample and Hold Circuit

section. When a strobe input is applied, the $R_x C_x$ low-pass network between the Master Reset and the Trigger Inputs resets the timer, then triggers it. This strobe input also sets the output of the bistable latch to a HIGH stage and activates the counter.

The circuit generates a staircase voltage at the op amp output. When the level of the staircase reaches that of the analog input to be sampled, the comparator changes state, activates the bistable latch and stops the count. At this point, the voltage level at the op amp output corresponds to the sampled analog input. Once the input is sampled, it is held until the next strobe signal.

ANALOG-TO-DIGITAL CONVERTER

Figure 16 shows a simple 8-bit A/D converter system using the 4722B. Circuit operation is very similar to that of the digital sample and hold system of Figure 15. In the case of A/D conversion, the digital output is obtained in parallel format from the binary-counter outputs with the output at pin 8 corresponding to the most significant bit (MSB).

DIGITAL TACHOMETER TIME BASE

A digital tachometer requires a time-base generator to supply two pulse outputs at specific intervals, e.g., every second. The first pulse is a command (load) to transfer the accumulated counts in the counter section into latches (memory); the second resets the counter to zero. A simple adjustable time base, accurate to approximately $\pm 0.5\%$, can be implemented using the circuit in Figure 17.

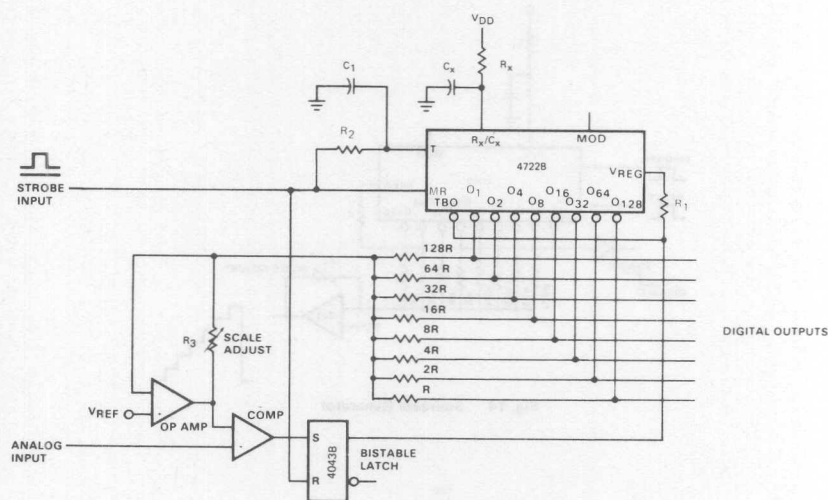


Fig. 16. Analog-to-Digital Converter

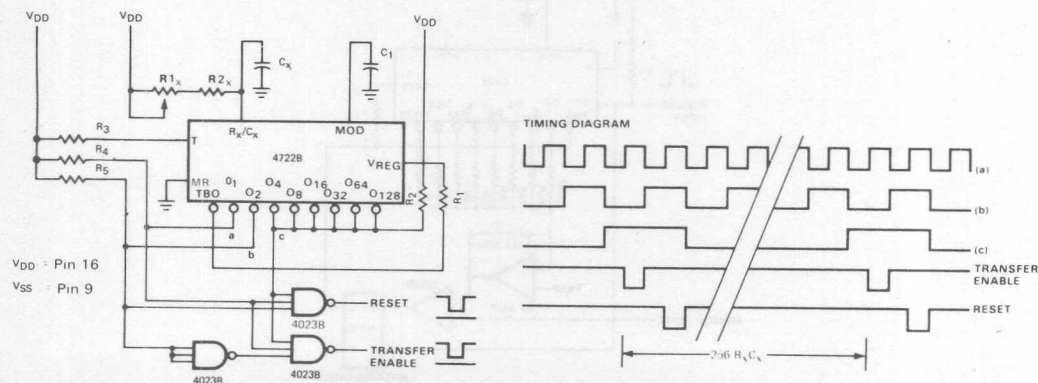


Fig. 17 Simple Time Generator for a Digital Tachometer

4723B

DUAL 4-BIT ADDRESSABLE LATCH

DESCRIPTION – The 4723B is a Dual 4-Bit Addressable Latch with common control inputs; these include two Address Inputs (A_0, A_1), an active LOW Enable Input (\bar{E}) and an active HIGH Clear Input (CL). Each latch has a Data Input (D) and four Outputs (Q_0-Q_3).

When the Enable (\bar{E}) and Clear (CL) Inputs are HIGH, all Outputs (Q_0-Q_3) are LOW. Dual 4-channel demultiplexing occurs when the Clear Input (CL) is HIGH and the Enable Input (\bar{E}) is LOW.

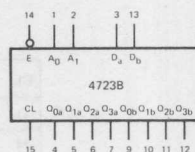
When the Clear (CL) and Enable (\bar{E}) inputs are LOW, the selected Output (Q_0-Q_3), determined by the Address Inputs (A_0, A_1), follows the Data Input (D). When the Enable Input (\bar{E}) goes HIGH, the contents of the latch are stored. When operating in the addressable latch mode ($\bar{E} = CL = LOW$), changing more than one bit of the address (A_0, A_1) could impose a transient wrong address. Therefore, this should only be done while in the memory mode ($\bar{E} = HIGH, CL = LOW$).

- SERIAL-TO-PARALLEL CAPABILITY
- OUTPUT FROM EACH STORAGE BIT IS AVAILABLE
- RANDOM (ADDRESSABLE) DATA ENTRY
- ACTIVE HIGH DECODING OR DEMULTIPLEXING CAPABILITY
- EASILY EXPANDABLE
- ACTIVE HIGH COMMON CLEAR

PIN NAMES

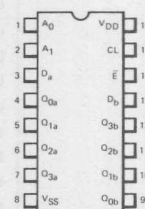
A_0, A_1	Address Inputs
D_a, D_b	Data Inputs
\bar{E}	Enable Input (Active LOW)
CL	Clear Input (Active HIGH)
Q_0a-Q_3a, Q_0b-Q_3b	Parallel Latch Outputs

LOGIC SYMBOL



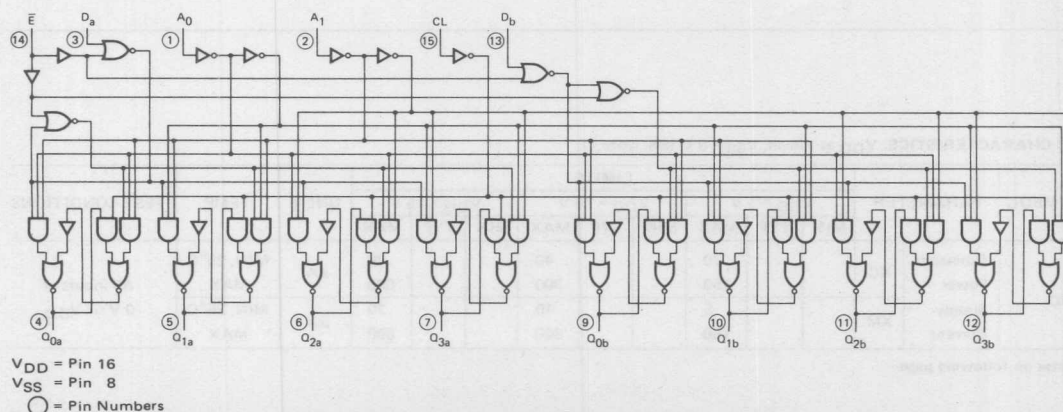
V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



FAIRCHILD CMOS • 4723B

MODE SELECTION

\bar{E}	CL	MODE
L	L	Addressable Latch
H	L	Memory
L	H	Dual 4-Channel Demultiplexer
H	H	Clear

H = HIGH Level

L = LOW Level

TRUTH TABLE

CL	\bar{E}	D	A ₀	A ₁	Q ₀	Q ₁	Q ₂	Q ₃	MODE
H	H	X	X	X	L	L	L	L	Clear
H	L	L	L	L	L	L	L	L	Demultiplexer
H	L	H	L	L	H	L	L	L	
H	L	L	H	L	L	L	L	L	
H	L	H	H	L	L	H	L	L	
H	L	L	L	H	L	L	L	L	
H	L	H	L	H	L	L	H	L	
H	L	L	H	H	L	L	L	L	
H	L	H	H	H	L	L	L	H	
L	H	X	X	X	Q _{N-1}	Q _{N-1}	Q _{N-1}	Q _{N-1}	Memory
L	L	L	L	L	L	Q _{N-1}	Q _{N-1}	Q _{N-1}	Addressable Latch
L	L	H	L	L	H	Q _{N-1}	Q _{N-1}	Q _{N-1}	
L	L	L	H	L	Q _{N-1}	L	Q _{N-1}	Q _{N-1}	
L	L	H	H	L	Q _{N-1}	H	Q _{N-1}	Q _{N-1}	
L	L	L	L	H	Q _{N-1}	Q _{N-1}	L	Q _{N-1}	
L	L	H	L	H	Q _{N-1}	Q _{N-1}	H	Q _{N-1}	
L	L	L	H	H	Q _{N-1}	Q _{N-1}	Q _{N-1}	L	
L	L	H	H	H	Q _{N-1}	Q _{N-1}	Q _{N-1}	H	

L = LOW Level

H = HIGH Level

X = Don't Care

Q_{N-1} = State before the positive transition of the Enable Input

DC CHARACTERISTICS: V_{DD} as shown, V_{SS} = 0 V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

Notes on following page.

FAIRCHILD CMOS • 4723B

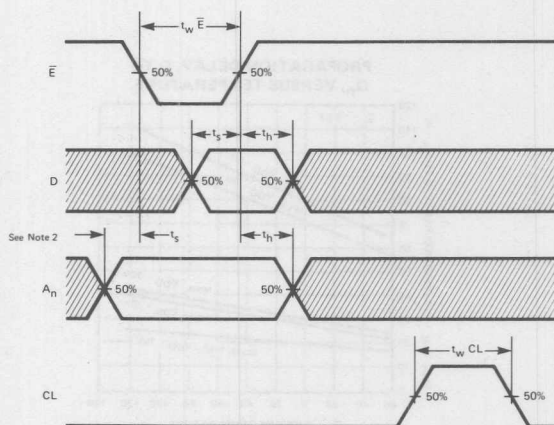
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, \bar{E} to Q _N		110	225		50	100		35	80	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			110	225		50	100		35	80		
t _{PLH}	Propagation Delay, D to Q _N		95	200		45	85		30	68	ns	
t _{PHL}			95	200		45	85		30	68		
t _{PLH}	Propagation Delay, Address to Q _N		120	250		55	100		40	80	ns	
t _{PHL}			120	250		55	100		40	80		
t _{PHL}	Propagation Delay, CL to Q _N		95	190		45	85		30	68	ns	
t _{TLH}	Output Transition Time		75	135		40	70		25	45	ns	
t _{THL}			75	135		40	70		25	45		
t _s	Set-Up Time, D to \bar{E}	50	30		30	10		24	5		ns	
t _h	Hold Time, D to \bar{E}	30	15		30	15		24	10		ns	
t _s	Set-Up Time, Address to \bar{E}	90	30		35	10		28	5		ns	
t _h	Hold Time, Address to \bar{E}	0	-5		5	0		4	0		ns	
t _w \bar{E}	Minimum \bar{E} Pulse Width	70	50		35	20		28	15		ns	
t _w CL	Minimum CL Pulse Width	70	50		35	20		28	15		ns	

NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

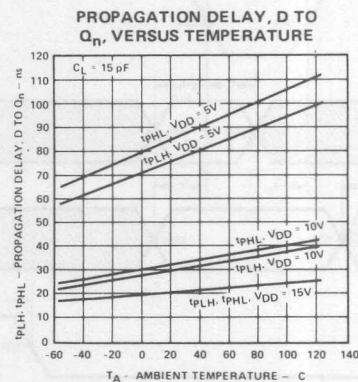
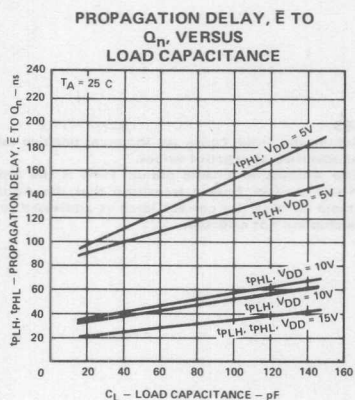
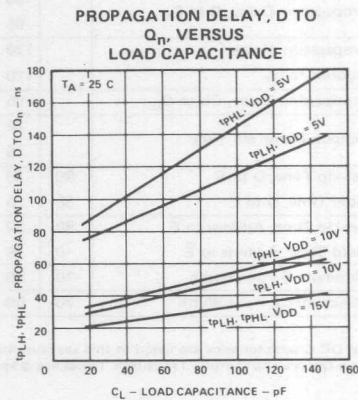
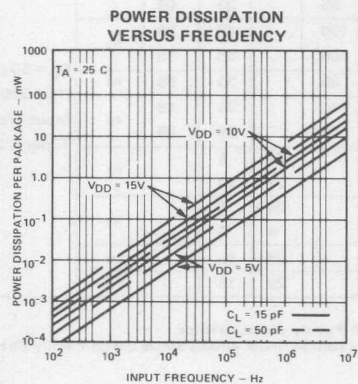
SWITCHING WAVEFORMS



MINIMUM PULSE WIDTH FOR \bar{E} AND CL AND SET-UP AND HOLD TIMES, D TO \bar{E} AND A_n TO \bar{E}

NOTES:

- Set-up and Hold Times are shown as positive values but may be specified as negative values.
- The Address to Enable Set-up Time is the time before the HIGH-to-LOW Enable transition that the Address must be stable so that the correct latch is addressed and the other latches are not affected.



4724B

8-BIT ADDRESSABLE LATCH

DESCRIPTION — The 4724B is an 8-Bit Addressable Latch with three Address Inputs (A_0 – A_2), a Data Input (D), an active LOW Enable Input (\bar{E}), an active HIGH Clear Input (CL) and eight Parallel Latch Outputs (Q_0 – Q_7).

When the Enable (\bar{E}) and the Clear (CL) Inputs are HIGH, all Outputs (Q_0 – Q_7) are LOW. Eight-channel demultiplexing or active HIGH 1-of-8 decoding with output enable operation occurs when the Clear Input (CL) is HIGH and the Enable Input (\bar{E}) is LOW.

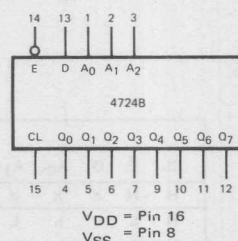
When the Clear (CL) and Enable (\bar{E}) Inputs are LOW, the selected Output (Q_0 – Q_7) (determined by the address Inputs A_0 – A_2) follows the Data Input (D). When the Enable Input (\bar{E}) goes HIGH, the contents of the latch are stored. When operating in the addressable latch mode ($\bar{E} = \text{CL} = \text{LOW}$), changing more than one bit of the address (A_0 – A_2) could impose a transient wrong address. Therefore, this should only be done while in the memory mode ($\bar{E} = \text{HIGH}$, $\text{CL} = \text{LOW}$).

- SERIAL-TO-PARALLEL CAPABILITY
- EIGHT BITS OF STORAGE WITH THE OUTPUT OF EACH BIT AVAILABLE
- RANDOM (ADDRESSABLE) DATA ENTRY
- ACTIVE HIGH DEMULTIPLEXING OR DECODING CAPABILITY
- EASILY EXPANDABLE
- COMMON ACTIVE HIGH CLEAR

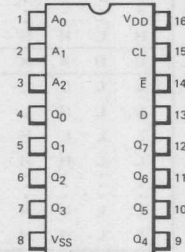
PIN NAMES

A_0 – A_2	Address Inputs
D	Data Input
\bar{E}	Enable Input (Active LOW)
CL	Clear Input (Active HIGH)
Q_0 – Q_7	Parallel Latch Outputs

LOGIC SYMBOL

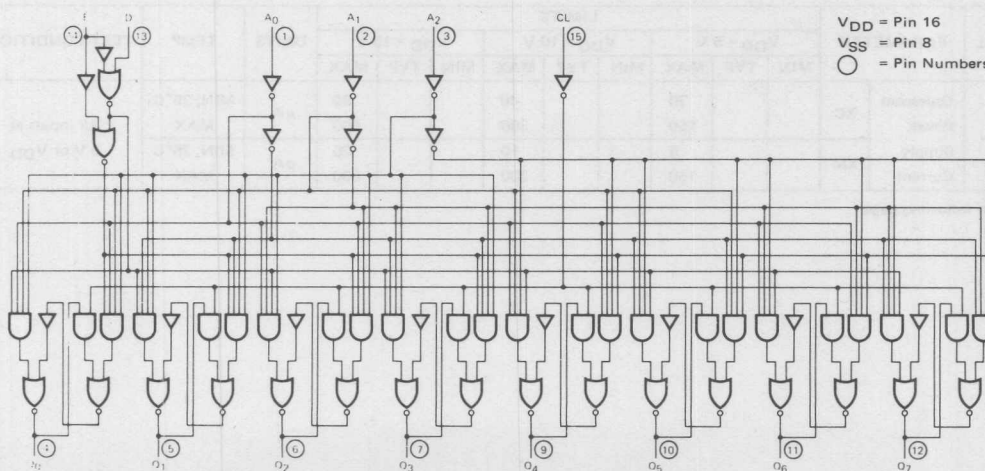


CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
○ = Pin Numbers

FAIRCHILD CMOS • 4724B

MODE SELECTION

\bar{E}	CL	MODE
L	L	Addressable Latch
H	L	Memory
L	H	Active HIGH 8-Channel Demultiplexer
H	H	Clear

L = LOW Level

H = HIGH Level

TRUTH TABLE

						PRESENT OUTPUT STATES								MODE
CL	\bar{E}	D	A ₀	A ₁	A ₂	Q ₀	Q ₁	Q ₂	Q ₃	Q ₄	Q ₅	Q ₆	Q ₇	
H	H	X	X	X	X	L	L	L	L	L	L	L	L	CLEAR
H	L	L	L	L	L	L	L	L	L	L	L	L	L	DEMULTIPLEX
H	L	H	L	L	L	H	L	L	L	L	L	L	L	
H	L	L	H	L	L	L	L	L	L	L	L	L	L	
H	L	H	H	L	L	L	H	L	L	L	L	L	L	
⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	
⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	
H	L	H	H	H	H	L	L	L	L	L	L	L	H	
L	H	X	X	X	X	Q _{N-1} →								MEMORY
L	L	L	L	L	L	L	Q _{N-1}	Q _{N-1}	Q _{N-1}	→				ADDRESSABLE LATCH
L	L	H	L	L	L	H	Q _{N-1}	Q _{N-1}	Q _{N-1}	→				
L	L	L	H	L	L	Q _{N-1}	L	Q _{N-1}	Q _{N-1}	→				
L	L	H	H	L	L	Q _{N-1}	H	Q _{N-1}	Q _{N-1}	→				
⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮					
⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮					
L	L	L	H	H	H	Q _{N-1}	→				Q _{N-1}	L		
L	L	H	H	H	H	Q _{N-1}	→				Q _{N-1}	H		

L = LOW Level

H = HIGH Level

X = Don't Care

Q_{N-1} = State Before the Positive Transition of the Enable Input

DC CHARACTERISTICS: V_{DD} as shown, V_{SS} = 0 V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

Notes on following page.

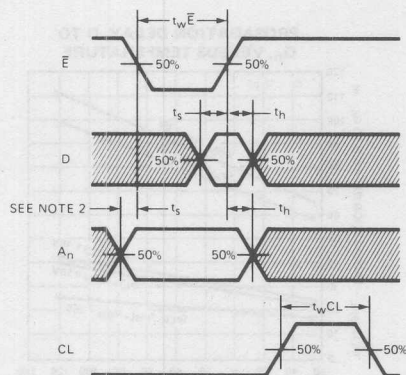
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, \bar{E} to Q _N		110	225		50	100		35	80	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			110	225		50	100		35	80		
t _{PLH}	Propagation Delay, D to Q _N		95	200		45	85		30	68	ns	
t _{PHL}			95	200		45	85		30	68		
t _{PLH}	Propagation Delay, Address to Q _N		120	250		55	100		40	80	ns	
t _{PHL}			120	250		55	100		40	80		
t _{PHL}	Propagation Delay, CL to Q _N		95	190		45	85		30	68	ns	
t _{TLH}	Output Transition Time		75	135		40	70		25	45	ns	
t _{THL}			75	135		40	70		25	45		
t _s	Set-Up Time, D to \bar{E}	50	30		30	10		24	5		ns	
t _h	Hold Time, D to \bar{E}	30	15		30	15		24	10		ns	
t _s	Set-Up Time, Address to \bar{E}	90	30		35	10		28	5		ns	
t _h	Hold Time, Address to \bar{E}	0	-5		5	0		4	0			
t _w \bar{E}	Minimum \bar{E} Pulse Width	70	50		35	20		28	15		ns	
t _w CL	Minimum CL Pulse Width	70	50		35	20		28	15		ns	

NOTES:

- Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
- Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

SWITCHING WAVEFORMS



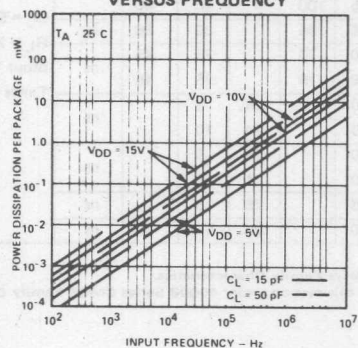
MINIMUM PULSE WIDTH FOR \bar{E} AND CL
AND SET-UP AND HOLD TIMES, D TO \bar{E} AND A_n TO \bar{E}

NOTES:

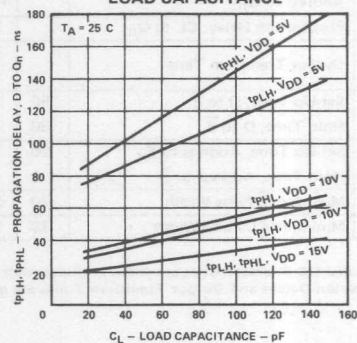
- Set-up and Hold Times are shown as positive values but may be specified as negative values.
- The Address to Enable Set-up Time is the time before the HIGH-to-LOW Enable transition that the Address must be stable so that the correct latch is addressed and the other latches are not affected.

TYPICAL ELECTRICAL CHARACTERISTICS

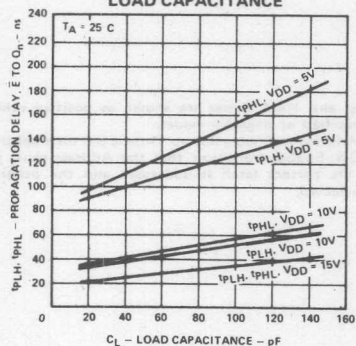
POWER DISSIPATION
VERSUS FREQUENCY



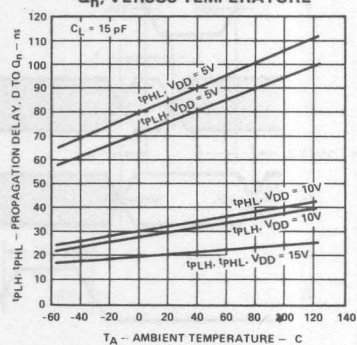
PROPAGATION DELAY, D TO Q_n , VERSUS
LOAD CAPACITANCE



PROPAGATION DELAY, E TO Q_n , VERSUS
LOAD CAPACITANCE



PROPAGATION DELAY, D TO Q_n , VERSUS TEMPERATURE



4725B/4725BX

64-BIT (16×4) RANDOM ACCESS MEMORY WITH 3-STATE OUTPUTS

DESCRIPTION — The 4725B/4725BX is a 64-Bit Random Access Memory with 3-State Outputs organized as 16 words by four bits with four Data Inputs (D_0 - D_3), four Address Inputs (A_0 - A_3), an active LOW Write Enable Input (\overline{WE}), an active LOW Chip Select Input (\overline{CS}) and four active LOW 3-State Outputs ($\overline{Q_0}$ - $\overline{Q_3}$).

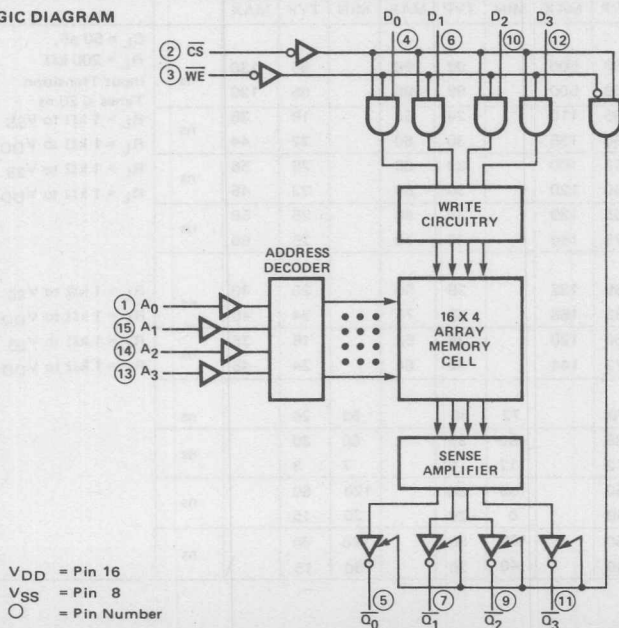
Information on the four Data Inputs (D_0 - D_3) is written into the memory location selected by the Address Inputs (A_0 - A_3) when both the Chip Select Input (\overline{CS}) and the Write Enable Input (\overline{WE}) are LOW. Under these conditions, the Outputs ($\overline{Q_0}$ - $\overline{Q_3}$) are held in a high impedance OFF state. Information is read from the memory location selected by the Address Inputs (A_0 - A_3) while the Chip Select Input (\overline{CS}) is LOW and the Write Enable Input (\overline{WE}) is HIGH. The Outputs ($\overline{Q_0}$ - $\overline{Q_3}$) are the complement of the information written into the memory. When the Chip Select Input (\overline{CS}) is HIGH, all Outputs ($\overline{Q_0}$ - $\overline{Q_3}$) are held in the high impedance OFF state. This allows other 3-State outputs to be wired together in a bus arrangement. The 4725B/4725BX offers fully static operation. The 4725B is specified to operate over a power supply voltage range of 4.5 to 12.5V. The 4725BX is specified to operate over a power supply voltage range of 3 to 15V.

- 3-STATE OUTPUTS
- ORGANIZATION — 16 WORDS X 4 BITS
- ON-CHIP DECODING
- INVERTED DATA OUTPUT
- FULLY STATIC OPERATION
- TYPICAL HOLDING VOLTAGE OF 1.5V

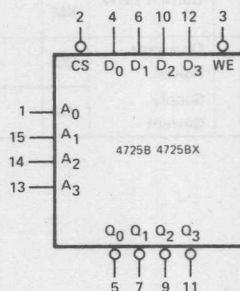
MODE SELECTION

\overline{CS}	\overline{WE}	OUTPUTS	MODE
L	L	High Impedance	Write
L	H	Outputs are Complement of Data Written into Location	Read
H	X	High Impedance	Inhibit

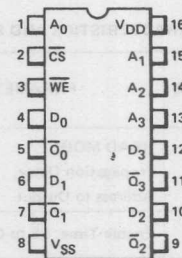
LOGIC DIAGRAM



LOGIC SYMBOL



CONNECTION DIAGRAM
DIP (TOP VIEW)



V_{DD} = Pin 16
 V_{SS} = Pin 8

NOTE:

The Flatpak version has the same pin-outs (Connection Diagram) as the Dual In-line Package.

PIN NAMES

\overline{CS} Chip Select Input (Active LOW)
 \overline{WE} Write Enable Input (Active LOW)
 D_0 - D_3 Data Inputs
 A_0 - A_3 Address Inputs
 $\overline{Q_0}$ - $\overline{Q_3}$ 3-State Outputs (Active LOW)

FAIRCHILD CMOS • 4725B/4725BX

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF Current HIGH	XC									1.6 12	μA	MIN, 25°C MAX	Output Returned to V _{DD} , \overline{CS} = V _{DD}
		XM									0.4 12		MIN, 25°C MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6 - 12	μA	MIN, 25°C MAX	Output Returned to V _{SS} , \overline{CS} = V _{DD}
		XM									-0.4 - 12		MIN, 25°C MAX	
I _{DD}	Quiescent Power	XC			20 150			40 300			80 600	μA	MIN, 25°C MAX	All inputs at 0 V or V _{DD}
	Supply Current	XM			5 150			10 300			20 600		MIN, 25°C MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS	
		$V_{DD} = 5\text{ V}$			$V_{DD} = 10\text{ V}$			$V_{DD} = 15\text{ V}$					
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
	READ MODE												$C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$ Input Transition Times $\leq 20\text{ ns}$ $R_L = 1\text{ k}\Omega$ to V_{SS} $R_L = 1\text{ k}\Omega$ to V_{DD} $R_L = 1\text{ k}\Omega$ to V_{SS} $R_L = 1\text{ k}\Omega$ to V_{DD}
t_{PLH}	Propagation Delay, Address to Output		250	500		98	196		65	130	ns		
t_{PHL}	Propagation Delay, Output to Address		250	500		98	196		65	130	ns		
t_{PZH}	Enable Time, \overline{CS} to Output		55	110		24	50		18	36	ns		
t_{PZL}	Disable Time, \overline{CS} to Output		66	135		30	60		22	44	ns		
t_{PHZ}	Enable Time, \overline{CS} to Output		53	100		33	66		28	56	ns		
t_{PLZ}	Disable Time, \overline{CS} to Output		60	120		30	60		23	46	ns		
t_{TLH}	Output Transition Time		65	130		30	60		25	50	ns		
t_{THL}	Output Transition Time		75	150		35	70		25	50	ns		
	WRITE MODE												$R_L = 1\text{ k}\Omega$ to V_{SS} $R_L = 1\text{ k}\Omega$ to V_{DD} $R_L = 1\text{ k}\Omega$ to V_{SS} $R_L = 1\text{ k}\Omega$ to V_{DD}
t_{PZH}	Enable Time, \overline{WE} to Output		69	138		28	56		20	40	ns		
t_{PZL}	Disable Time, \overline{WE} to Output		83	166		35	70		24	48	ns		
t_{PHZ}	Enable Time, \overline{WE} to Output		60	120		26	52		18	36	ns		
t_{PLZ}	Disable Time, \overline{WE} to Output		72	144		32	64		24	48	ns		
$t_{W\overline{WE}}$	Minimum \overline{WE} Pulse Width	160	79		72	36		52	26		ns		
t_s	Set-Up Time, D_n to \overline{WE}	170	85		80	39		60	30		ns		
t_h	Hold Time, D_n to \overline{WE}	24	12		12	6		7	3		ns		
t_s	Set-Up Time, Address to \overline{WE}	300	150		160	80		120	60		ns		
t_h	Hold Time, Address to \overline{WE}	0	-40		0	-20		30	-15		ns		
t_s	Set-Up Time, \overline{CS} to \overline{WE}	300	150		160	80		120	60		ns		
t_h	Hold Time, \overline{CS} to \overline{WE}	80	40		40	20		30	15		ns		

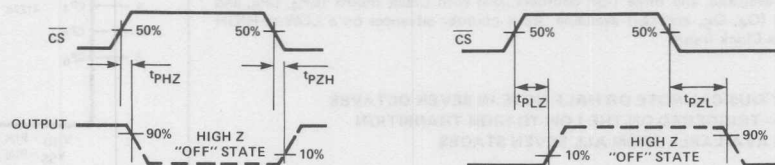
Notes on following page

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. All Set-Up (t_s) and Hold (t_h) times are measured with minimum Write Enable Pulse Width (t_{WWE}).

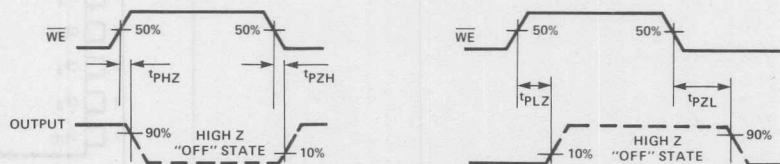
SWITCHING WAVEFORMS

READ MODE

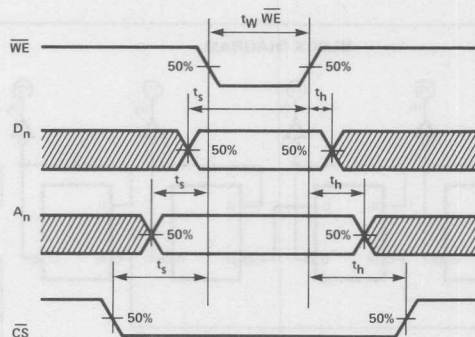


\overline{CS} TO OUTPUT ENABLE AND DISABLE TIMES

WRITE MODE



\overline{WE} TO OUTPUT ENABLE AND DISABLE TIMES



MINIMUM \overline{WE} PULSE WIDTH AND SET-UP AND HOLD TIMES,
 D_n TO \overline{WE} , A_n TO \overline{WE} , AND \overline{CS} TO \overline{WE}

Note: Set-up and Hold Times are shown as positive values but may be specified as negative values.

4727B

7-STAGE COUNTER

DESCRIPTION — The 4727B is a 7-Stage Frequency Counter especially useful for frequency synthesis in musical applications. The device is designed to generate, from a primary chromatic scale, each of the twelve flats, sharps, and naturals comprising each chromatic scale of the seven additional octaves in the musical spectrum. Twelve 4727B devices are required to generate the entire musical spectrum from a primary scale.

The 4727B consists of a pair of 2-Bit Counters, with Clock Inputs (CP₀ and CP₂) and Parallel Outputs (Q₀ and Q₁, Q₂ and Q₃), available, and three 1-bit counters, also with Clock Inputs (CP₄, CP₅, and CP₆) and Parallel Outputs (Q₄, Q₅, and Q₆) available. Each counter advances on a LOW-to-HIGH transition at the appropriate Clock Input.

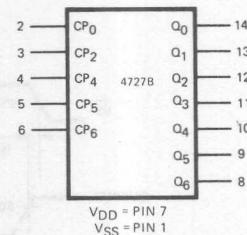
- REPEATS A PRIMARY MUSICAL NOTE OR HALF NOTE IN SEVEN OCTAVES
- CLOCK INPUT EDGE — TRIGGERED ON THE LOW-TO-HIGH TRANSITION
- BUFFERED OUTPUTS AVAILABLE FROM ALL SEVEN STAGES

PIN NAMES

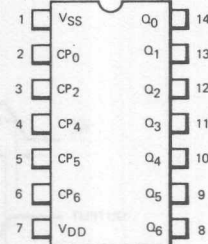
CP₀-CP₆ CLOCK INPUTS (L→H TRIGGERED)

Q₀-Q₆ PARALLEL OUTPUTS

LOGIC SYMBOL

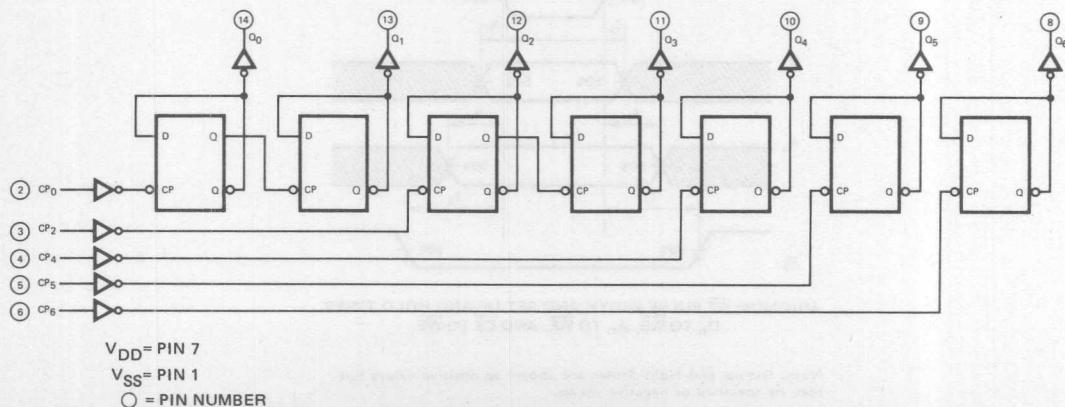


CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-Line Package.

BLOCK DIAGRAM



FAIRCHILD CMOS • 4727B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER	LIMITS									UNITS	TEMP	TEST CONDITIONS	
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V						
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX				
I _{OH}	Output High Current	-0.3 -0.25 -0.2			-0.84 -0.7 -0.56			-1.8 -1.5 -1.1			mA	MIN 25° C MAX	V _{OUT} = 4.5 V For V _{DD} = 5 V. V _{OUT} = 9.5 V For V _{DD} = 10 V. V _{OUT} = 13.5 V For V _{DD} = 15 V.	Inputs at V _{SS} or V _{DD} Per the Logic Function or Truth Table
I _{OL}	Output Low Current	0.64 0.51 0.36			1.6 1.3 0.9			4.2 3.4 2.4			mA	MIN 25° C MAX	V _{OUT} = 0.4 V for V _{DD} = 5 V V _{OUT} = 0.5 V for V _{DD} = 10 V V _{OUT} = 1.5 V for V _{CC} = 15 V	
I _{DD}	Quiescent Power	XC		20 150			40 300			80 600	μA	MIN, 25° C MAX	All Inputs at V _{DD} or V _{SS}	
	Supply Current	XM		5 150			10 300			20 600	μA	MIN, 25° C MAX		

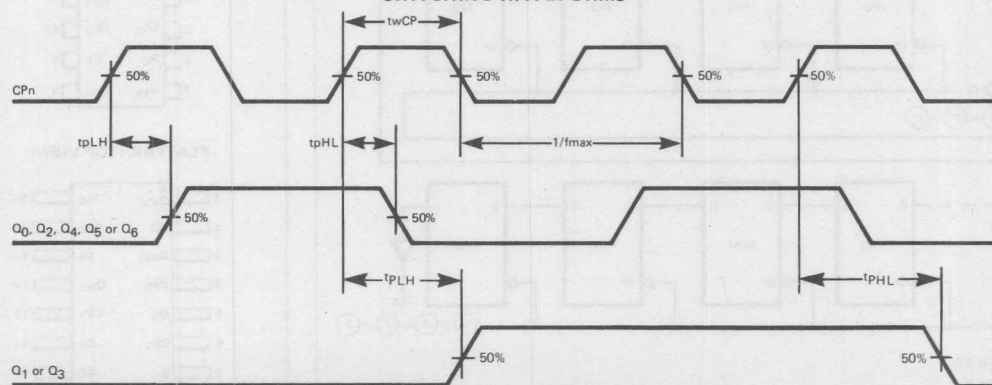
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH} t _{PHL}	Propagation Delay, CP _n to Q ₀ , Q ₂ , Q ₄ , Q ₅ or Q ₆		225 225	500 500		90 90	250 250		75 75	200 200	ns	C _L = 50 pF R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PLH} t _{PHL}	Propagation Delay, CP _n to Q ₁ or Q ₃		365 365	1000 1000		130 130	500 500		100 100	400 400	ns	
t _{TLH} t _{THL}	Output Transition Times		70 70	500 500		40 40	250 250		30 30	200 200	ns	
T _{wCP}	Min Clock Pulse Width	250	125		125	65		100	50		ns *	
f _{MAX}	Input Count Frequency (Note 3)	2	4		4	8		5	10		MHz	

NOTES:

- Additional DC characteristics are listed in this section under "4000B Series CMOS Family Characteristics."
- Propagation Delays and Output Transition Times are graphically described in this section under "4000B Series CMOS Family Characteristics."
- For f_{MAX} Input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.

SWITCHING WAVEFORMS



PROPAGATION DELAY, CP to Q_n , MINIMUM CLOCK PULSE WIDTH AND MAXIMUM FREQUENCY

4731B/4731BX

QUAD 64-BIT STATIC SHIFT REGISTER

DESCRIPTION — The 4731B/4731BX is a Quad 64-Bit Shift Register each with separate Serial Data Inputs (D_A - D_D), Clock Inputs (CP_A - CP_D) and Data Outputs (Q_{63A} - Q_{63D}) from the 64th register position.

Information present on the Serial Data Inputs is shifted into the first register position and all the data in the register is shifted one position to the right on a HIGH-to-LOW transition of the Clock Inputs (CP_A - CP_D).

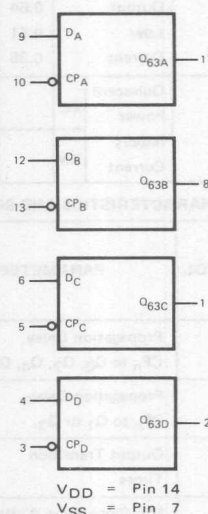
Low impedance outputs are provided for direct interface to TTL. The 4731B is specified to operate over a power supply voltage range of 4.5 V to 12.5 V, the 4731BX is specified to operate over a power supply voltage range of 3 V to 15 V.

- FREQUENCIES UP TO 8 MHz AT $V_{DD} = 10$ V
- SERIAL-TO-SERIAL DATA TRANSFER
- SEPARATE CLOCK INPUTS, DATA INPUTS AND FULLY BUFFERED OUTPUTS FOR EACH REGISTER
- DIRECT INTERFACE TO TTL
- 14-PIN PACKAGE

PIN NAMES

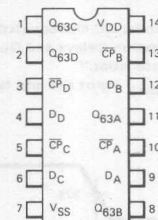
D_A - D_D	Serial Data Inputs
CP_A - CP_D	Clock Input (H→L Edge-Triggered)
Q_{63A} - Q_{63D}	Buffered Outputs from the 64th Register Position

LOGIC SYMBOL

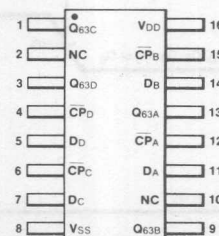


CONNECTION DIAGRAMS

DIP (TOP VIEW)

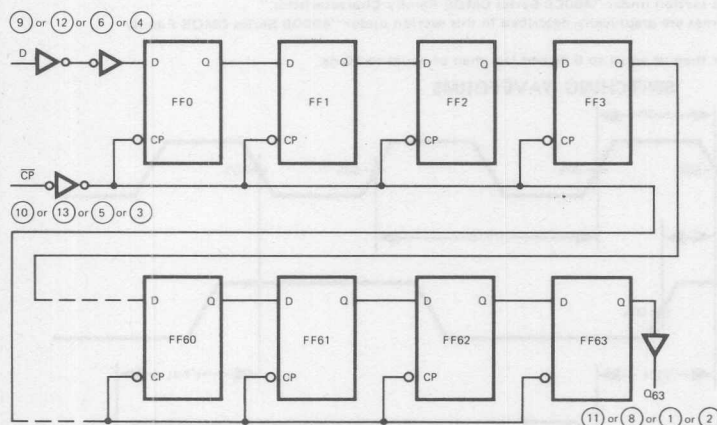


FLATPAK (TOP VIEW)



LOGIC DIAGRAM

1/4 OF A 4731B/4731BX



V_{DD} = Pin 14
 V_{SS} = Pin 7
 ○ = Pin Number

FAIRCHILD CMOS • 4731B/4731BX

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			100			200			400	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					750			1500			3000		MAX	
	Supply Current	XM			25			50			100	μA	MIN, 25°C	
					750			1500			3000		MAX	

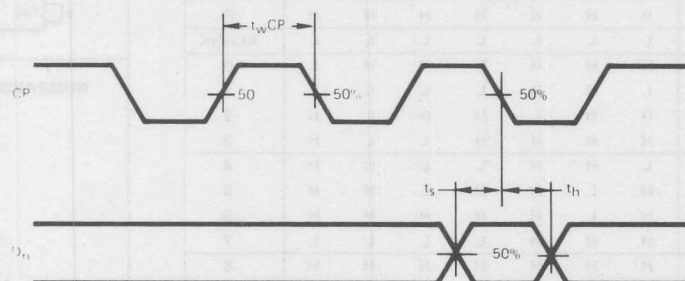
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, \overline{CP} to Q ₆₃		190	450		95	200		65	160	ns	C _L = 50 pF R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			190	450		95	200		65	160		
t _{TLH}	Output Transition Time		45	135		30	70		20	45	ns	
t _{THL}			30	90		30	50		20	35		
t _{wCP}	\overline{CP} Minimum Pulse Width	300	100		150	50		120	40		ns	
t _s	Set-Up Time D to \overline{CP}	100	-20		40	-12		40	-7		ns	
t _h	Hold Time D to \overline{CP}	100	35		40	12		40	11		ns	
f _{MAX}	Max. Input Clock Frequency (Note 3)	1.5	4		3	8		4	14		MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

SWITCHING WAVEFORMS



MINIMUM CLOCK PULSE WIDTH AND SET-UP AND HOLD TIMES, D TO \overline{CP}

NOTE:

1. Set up and Hold Times are shown as positive values but may be specified as negative values.

BCD-TO-7 SEGMENT LATCH/DECODER/DRIVER WITH RIPPLE BLANKING

DESCRIPTION: The 4734B is a BCD-to-7 Segment Latch/Decoder/Driver with Ripple Blanking. It has four Address Inputs (A_0 - A_3), an active LOW Latch Enable Input (\overline{EL}), an active LOW Blanking Input ($\overline{I_B}$), an active LOW Lamp Test Input ($\overline{I_{LT}}$), a Ripple Blanking Input (I_{RB}), a Ripple Blanking Output (O_{RB}) and seven active HIGH NPN bipolar Segment Outputs (a-g).

When the Lamp Test Input ($\overline{I_{LT}}$) is LOW, all the Segment Outputs (a-g) are HIGH; independent of all other input conditions. The Lamp Test Input ($\overline{I_{LT}}$) does not affect the Ripple Blanking Output (O_{RB}). With the Lamp Test Input ($\overline{I_{LT}}$) HIGH, a LOW on the Blanking Input ($\overline{I_B}$) forces the Segment Outputs (a-g) LOW; independent of all other input conditions. The Blanking Input ($\overline{I_B}$) does not affect the Ripple Blanking Output (O_{RB}). The Ripple Blanking Output (O_{RB}) is HIGH when the Ripple Blanking Input (I_{RB}) is HIGH and the latch contains binary zero. With the Lamp Test Input ($\overline{I_{LT}}$) HIGH, the display is blank when the Ripple Blank Output (O_{RB}) is HIGH.

When the Latch Enable Input (\overline{EL}) is LOW, the state of the latch is determined by the data on the Address Inputs (A_0 - A_3). When the Latch Enable Input (\overline{EL}) goes HIGH, the last data present at the Address Inputs (A_0 - A_3) is stored in the latch. The Lamp Test ($\overline{I_{LT}}$), Blanking ($\overline{I_B}$) and Ripple Blanking (I_{RB}) inputs do not affect the latch circuit.

- HIGH CURRENT SOURCING OUTPUTS (UP TO 25 mA)
- BLANKING INPUT (ACTIVE LOW)
- LAMP TEST INPUT (ACTIVE LOW)
- LAMP INTENSITY MODULATION CAPABILITY
- MULTIPLEXING CAPABILITY
- RIPPLE BLANKING INPUT/OUTPUT

PIN NAMES

A_0 - A_3	Address (Data) Inputs	$\overline{I_{LT}}$	Lamp Test Input (Active LOW)
\overline{EL}	Latch Enable Input (Active LOW)	I_{RB}	Ripple Blanking Input
$\overline{I_B}$	Blanking Input (Active LOW)	O_{RB}	Ripple Blanking Output
		a-g	Segment Outputs

TRUTH TABLE

INPUTS				OUTPUTS							DISPLAY
A_3	A_2	A_1	A_0	a	b	c	d	e	f	g	
X	X	X	X	H	H	H	H	H	H	H	8
X	X	X	X	L	L	L	L	L	L	L	BLANK
L	L	L	L	H	H	H	H	H	H	L	0
L	L	L	H	L	H	H	L	L	L	L	1
L	L	H	L	H	H	L	H	H	L	H	2
L	L	H	H	H	H	H	H	L	L	H	3
L	H	L	L	L	H	H	L	L	H	H	4
L	H	L	H	H	L	H	H	L	H	H	5
L	H	H	L	H	L	H	H	H	H	H	6
L	H	H	H	H	H	H	L	L	L	L	7
H	L	L	L	H	H	H	H	H	H	H	8
H	L	L	H	H	H	H	H	L	H	H	9
H	L	H	L	L	L	L	L	L	L	L	BLANK
H	L	H	H	L	L	L	L	L	L	L	BLANK
H	H	L	L	L	L	L	L	L	L	L	BLANK
H	H	L	H	L	L	L	L	L	L	L	BLANK
H	H	H	L	L	L	L	L	L	L	L	BLANK
H	H	H	H	L	L	L	L	L	L	L	BLANK

CONDITIONS:

\overline{EL} = LOW, $\overline{I_B}$ = HIGH

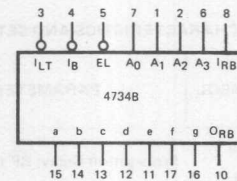
$\overline{I_{LT}}$ = HIGH, and I_{RB} = LOW

L = LOW Level

H = HIGH Level

X = Don't Care

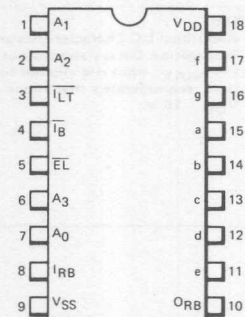
LOGIC SYMBOL



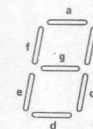
V_{DD} = Pin 18

V_{SS} = Pin 9

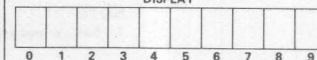
CONNECTION DIAGRAM DIP (TOP VIEW)



NUMERICAL DESIGNATIONS

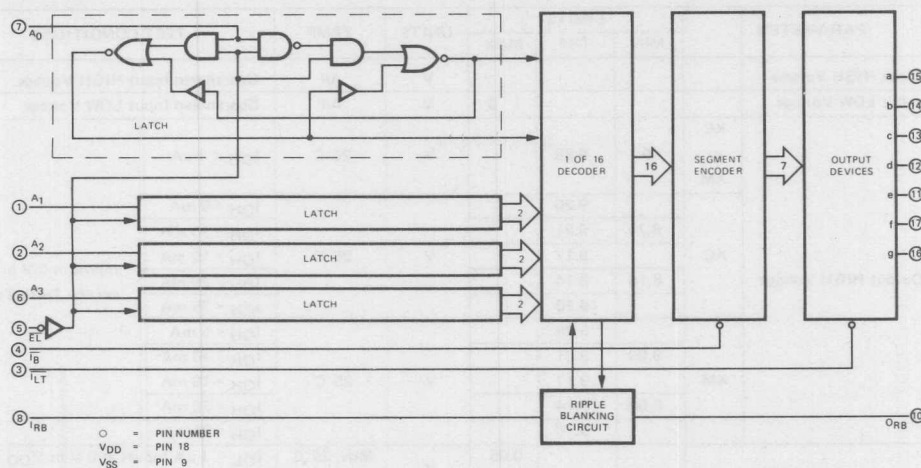


DISPLAY



FAIRCHILD CMOS • 4734B

BLOCK DIAGRAM



DC CHARACTERISTICS: $V_{DD} = 5\text{ V}$, $V_{SS} = 0\text{ V}$ (Note 1)

SYMBOL	PARAMETER		LIMITS			UNITS	TEMP	TEST CONDITIONS		
			MIN	TYP	MAX					
V _{IH}	Input HIGH Voltage		3.5			V	All	Guaranteed Input HIGH Voltage		
V _{IL}	Input LOW Voltage				. 1.5	V	All	Guaranteed Input LOW Voltage		
V _{OH}	Output HIGH Voltage	XC or XM	4.1	4.57		V	25°C	I _{OH} < 1 μA	Inputs at 0 V or V _{DD} per the Truth Table	
		XC		4.24		V	25°C	I _{OH} = 5 mA		
			3.60	4.22				I _{OH} = 10 mA		
					4.16					I _{OH} = 15 mA
				2.80	4.12					I _{OH} = 20 mA
		XM		4.05		V	25°C	I _{OH} = 25 mA		
				4.24				I _{OH} = 5 mA		
			3.90	4.22				I _{OH} = 10 mA		
				4.16				I _{OH} = 15 mA		
			3.40	4.12				I _{OH} = 20 mA		
				4.05				I _{OH} = 25 mA		
V _{OL}	Output LOW Voltage			0.05	V	MIN, 25°C	I _{OL} < 1 μA Inputs at 0 V or V _{DD} per the Truth Table			
				0.05		MAX				
						0.5	V	All	I _{OL} < 1 μA Inputs at 1.5 or 3.5 V	
I _{OL}	Output LOW Current		1 0.8 0.4			mA	MIN, 25°C MAX	V _{OUT} = 0.4 V	Inputs at 0 V or V _{DD} per the Truth Table	
I _{DD}	Quiescent Power Supply Current	XC			20	μA	MIN, 25°C	All Inputs at 0 V or V _{DD} and All Outputs Open		
					150		MAX			
		XM			5		MIN, 25°C			
					150		MAX			

Notes on following pages.

FAIRCHILD CMOS • 4734B

DC CHARACTERISTICS: $V_{DD} = 10\text{ V}$, $V_{SS} = 0\text{ V}$ (Note 1)

SYMBOL	PARAMETER		LIMITS			UNITS	TEMP	TEST CONDITIONS	
			MIN	TYP	MAX				
V_{IH}	Input HIGH Voltage		7			V	All	Guaranteed Input HIGH Voltage	
V_{IL}	Input LOW Voltage				3	V	All	Guaranteed Input LOW Voltage	
V_{OH}	Output HIGH Voltage	XC or XM	9.1	9.58		V	25 °C	$I_{OH} < 1\text{ }\mu\text{A}$	Inputs at 0 V or V_{DD} per the Truth Table
		XC		8.75	9.21	V	25 °C	$I_{OH} = 10\text{ mA}$	
					9.17			$I_{OH} = 15\text{ mA}$	
				8.10	9.14			$I_{OH} = 20\text{ mA}$	
					9.10			$I_{OH} = 25\text{ mA}$	
		XM			9.26	V	25 °C	$I_{OH} = 5\text{ mA}$	
				9.00	9.21			$I_{OH} = 10\text{ mA}$	
					9.17			$I_{OH} = 15\text{ mA}$	
				8.60	9.14			$I_{OH} = 20\text{ mA}$	
					9.10			$I_{OH} = 25\text{ mA}$	
V_{OL}	Output LOW Voltage			0.05 0.05	V	MIN, 25 °C MAX	$I_{OL} < 1\text{ }\mu\text{A}$ Inputs at 0 V or V_{DD} per the Truth Table		
				1	V	All	$I_{OL} < 1\text{ }\mu\text{A}$ Inputs at 3 or 7 V		
I_{OL}	Output LOW Current		2.6 2 1.2			mA	MIN, 25 °C MAX	$V_{OUT} = 0.5\text{ V}$	Inputs at 0 V or V_{DD} per the Truth Table
I_{DD}	Quiescent Power Supply Current	XC			40	μA	MIN, 25 °C	All Inputs at 0 V or V_{DD} and all Outputs Open	
					300		MAX		
		XM			10		MIN, 25 °C		
					300		MAX		

Notes on following pages.

FAIRCHILD CMOS • 4734B

DC CHARACTERISTICS: $V_{DD} = 15\text{ V}$, $V_{SS} = 0\text{ V}$ (Note 1)

SYMBOL	PARAMETER	LIMITS			UNITS	TEMP	TEST CONDITIONS
		MIN	TYP	MAX			
V_{IH}	Input HIGH Voltage	11			V	All	Guaranteed Input HIGH Voltage
V_{IL}	Input LOW Voltage			4	V	All	Guaranteed Input LOW Voltage
V_{OH}	Output HIGH Voltage	XC or XM	14.10	14.59	V	25°C	$I_{OH} < 1\text{ }\mu\text{A}$
		XC	13.75	14.23	V	25°C	$I_{OH} = 5\text{ mA}$
							$I_{OH} = 10\text{ mA}$
							$I_{OH} = 15\text{ mA}$
							$I_{OH} = 20\text{ mA}$
		XM	13.10	14.17	V	25°C	$I_{OH} = 25\text{ mA}$
							$I_{OH} = 5\text{ mA}$
							$I_{OH} = 10\text{ mA}$
							$I_{OH} = 15\text{ mA}$
							$I_{OH} = 20\text{ mA}$
							$I_{OH} = 25\text{ mA}$
							Inputs at 0 V or V_{DD} per the Truth Table
V_{OL}	Output LOW Voltage			0.05	V	MIN, 25°C	$I_{OL} < 1\text{ }\mu\text{A}$ Inputs at 0 V or V_{DD} per the Logic Function or Truth Table
				0.05	V	MAX	
I_{IN}	Input Current	XC		1	μA	All	Lead under test at 0 V or V_{DD} All other Inputs simultaneously at 0 V or V_{DD}
		XM		1	μA	All	
I_{OL}	Output LOW Current		7.5		mA	MIN, 25°C	$V_{OUT} = 1.5\text{ V}$ Inputs at 0 V or V_{DD} per the Truth Table
			4.5			MAX	
I_{DD}	Quiescent Power	XC		80	μA	MIN, 25°C	All Inputs at 0 V or V_{DD} and all Outputs Open
				600		MAX	
	Supply Current	XM		20		MIN, 25°C	
				600		MAX	

Notes on following page.

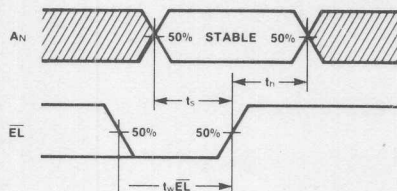
SYMBOL	PARAMETER	V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, A _n to a – g		212			90			68		ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			238			88			60			
t _{PLH}	Propagation Delay, $\overline{\text{I}}_{\text{LT}}$ to a – g		82			38			30		ns	
t _{PHL}			85			34			24			
t _{PLH}	Propagation Delay, $\overline{\text{I}}_{\text{B}}$ to a – g		147			60			42		ns	
t _{PHL}			164			65			46			
t _{PLH}	Propagation Delay, $\overline{\text{E}}_{\text{L}}$ to a – g		230			90			63		ns	
t _{PHL}			275			98			66			
t _{PLH}	Propagation Delay, A _n to O _{RB}		212			90			68		ns	
t _{PHL}			238			88			60			
t _{PLH}	Propagation Delay, I _{QB} to O _{RB}		147			60			42		ns	
t _{PHL}			164			65			46			
t _{TLH}	Output Transition Time		25			18			16		ns	
t _{THL}			75			26			17			
t _{wEL}	$\overline{\text{E}}_{\text{L}}$ Minimum Pulse Width		34			14			10		ns	
t _s	Set-Up Time, A _n to E _L		20			7			4		ns	
t _h	Hold Time, A _n to $\overline{\text{E}}_{\text{L}}$		19			6			4			

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

SWITCHING WAVEFORMS

SET-UP AND HOLD TIMES, A_N TO
E_L AND MINIMUM E_L PULSE
WIDTH

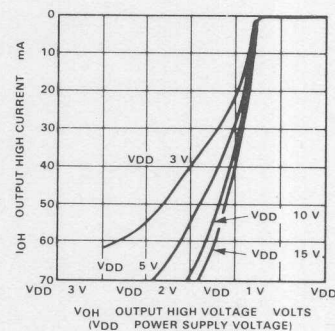


NOTE:

Set-up and Hold Times are shown as positive values but may be specified as negative values.

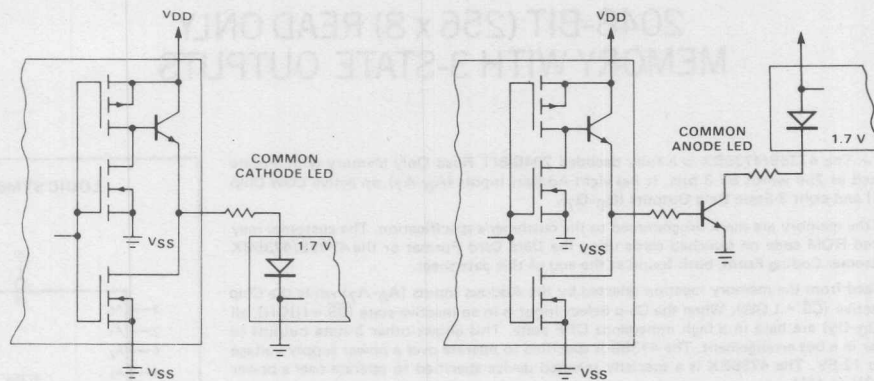
TYPICAL ELECTRICAL CHARACTERISTICS

TYPICAL OUTPUT DRIVE
CHARACTERISTICS

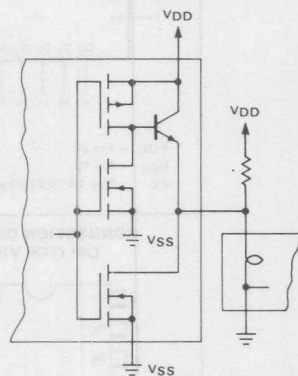


TYPICAL APPLICATIONS

LIGHT EMITTING DIODE (LED) READOUT

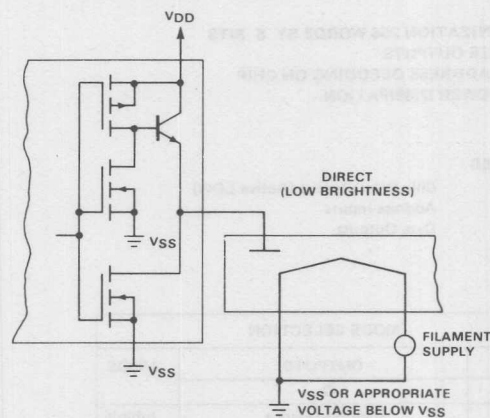


INCANDESCENT READOUT

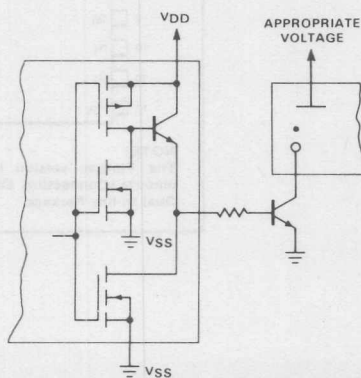


*A filament pre warm resistor is recommended to reduce filament thermal shock and increase the effective cold resistance of the filament.

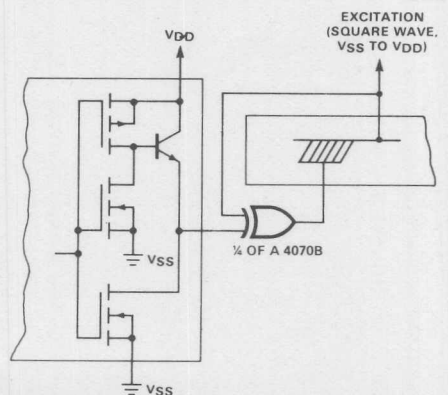
FLUORESCENT READOUT



GAS DISCHARGE READOUT



LIQUID CRYSTAL (LCD) READOUT**



**Direct dc drive of LCD's not recommended for life of LCD readouts.

4735B/4735BX

2048-BIT (256 x 8) READ ONLY MEMORY WITH 3-STATE OUTPUTS

DESCRIPTION — The 4735B/4735BX is a fully decoded 2048-BIT Read Only Memory with 3-State Outputs, organized as 256 words by 8 bits. It has eight Address Inputs (A_0 - A_7), an active LOW Chip Select Input (\overline{CS}) and eight 3-State Data Outputs (Q_0 - Q_7).

The contents of the memory are mask programmed to the customer's specification. The customer may specify the desired ROM code on punched cards using the Data Card Format or the 4735B/4735BX CMOS ROM Customer Coding Form, both found at the end of this data sheet.

Information is read from the memory location selected by the Address Inputs (A_0 - A_7) while the Chip Select Input is active (\overline{CS} = LOW). When the Chip Select Input is in an inactive state (\overline{CS} = HIGH), all Data Outputs (Q_0 - Q_7) are held in a high impedance OFF state. This allows other 3-state outputs to be wired together in a bus arrangement. The 4735B is specified to operate over a power supply voltage range of 4.5V to 12.5V. The 4735BX is a specially selected device specified to operate over a power voltage range of 3V to 15V.

- ORGANIZATION 256 WORDS BY 8 BITS
- 3-STATE OUTPUTS
- FULL ADDRESS DECODING ON CHIP
- LOW POWER DISSIPATION

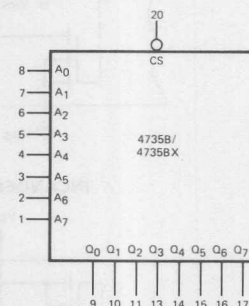
PIN NAMES

\overline{CS}	Chip Select Inputs (Active LOW)
A_0 - A_7	Address Inputs
Q_0 - Q_7	Data Outputs

MODE SELECTION		
INPUTS	OUTPUTS	MODE
\overline{CS}	Q_n	
H	High Impedance	Inhibit
L	Data Programmed Into Memory	READ

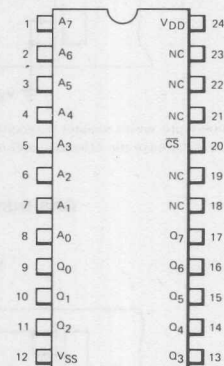
H = High Level
L = Low Level

LOGIC SYMBOL



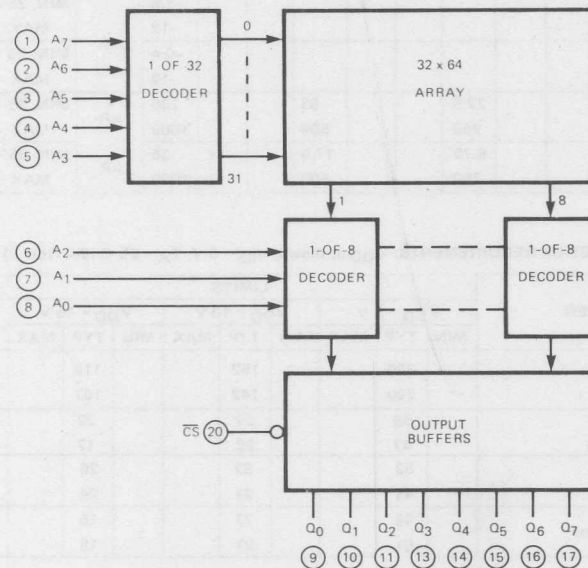
V_{DD} = Pin 24
 V_{SS} = Pin 12
NC = Pins 18, 19, 21, 22 and 23

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

BLOCK DIAGRAM



NC = Pins 18, 19, 21, 22 and 23

V_{DD} = Pin 24

V_{SS} = Pin 12

○ = Pin Numbers

FAIRCHILD CMOS LSI • 4735B/4735BX

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITION	
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V						
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX				
I _{OZH}	Output OFF Current HIGH	XC									1.6	μA	MIN, 25°C	Output Returned to V _{DD} , CS = V _{DD} .	
											12		MAX		
		XM									0.4		μA		MIN, 25°C
											12				MAX
I _{OZL}	Output OFF Current LOW	XC									-1.6	μA	MIN, 25°C	Output Returned to V _{SS} , CS = V _{DD} .	
											-12		MAX		
		XM									-0.4		μA		MIN, 25°C
											-12				MAX
I _{DD}	Quiescent Power Supply Current	XC			32.5			65			130	μA	MIN, 25°C	All Inputs at 0 V or V _{DD}	
					250			500			1000		MAX		
		XM			8.75			17.5			35		μA		MIN, 25°C
					250			500			1000				MAX

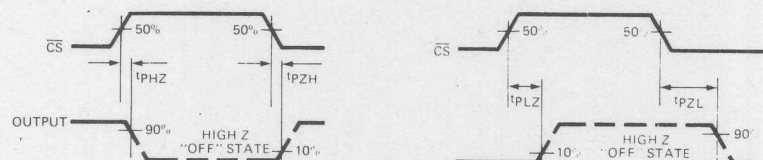
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ C$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Address to Output		300			152			118		ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			290			142			107			
t _{PZH}	Enable Time		55			27			22		ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PZL}	Chip Select to Output		47			22			17			
t _{PHZ}	Disable Time,		53			32			26		ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PLZ}	Chip Select to Output		43			27			24			
t _{TLH}	Output Transition Time		49			23			15		ns	Input Transition Times ≤ 20 ns
t _{THL}			61			21			15			

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

SWITCHING WAVEFORMS



4735B/4735BX DATA CARD FORMAT

The most efficient method of ordering the 4735B/4735BX is to punch the desired truth table on punched cards in the format described below. Fairchild will generate mask and test program data directly from these inputs. This eliminates the chance of error when transcribing inputs from a handwritten truth table.

Data should be provided on a deck of 45 standard 80 column cards containing the following information.

CARD NO. 1 — Customer Identification

Column	Content
1-80	Customer Name, Drawing or Specification control number, date, "4735B/4735BX", "DC", "DM", "PC", "FC", or "FM".

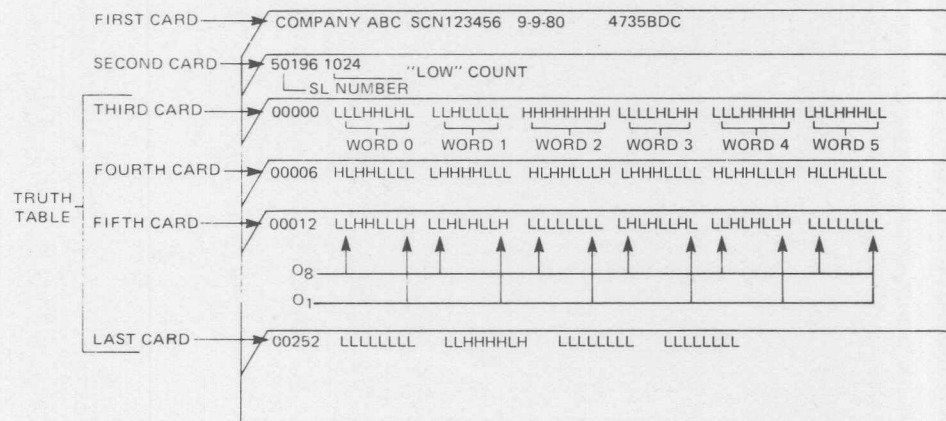
CARD NO. 2 — Fairchild SL Number and LOW Count

Column	Content
1-5	Punch the 5-digit Fairchild SL number. This SL number is supplied by the factory through your Fairchild sales representative.
7-10	Punch the 4-digit number which represents the total number of "LOW's" in the data pattern. (For verification of data).

CARDS NO. 3 through 45 — Truth Table Deck

Each card will contain instructions for the output levels for six input words.

Column	Content
1-5	Punch the numerals representing the "DECIMAL" address of the first word on that card. The words are entered sequentially (0 through 255).
10-17	Punch the desired combination of "HIGH's" and "LOW's" representing the output levels for outputs Q_7 , Q_6 , Q_5 , Q_4 , Q_3 , Q_2 , Q_1 and Q_0 (in that order), for the first word on the card. "H" signifies a HIGH voltage on the data output line. "L" signifies a LOW voltage on the data output line.
21-28	Punch the desired combination of "H's" and "L's" representing the output levels for the second word on the card.
32-39	Punch the desired combination of "H's" and "L's" representing the output levels for the third word on the card.
43-50	Punch the desired combination of "H's" and "L's" representing the output levels for the fourth word on the card.
54-61	Punch the desired combination of "H's" and "L's" representing the output levels for the fifth word on the card.
65-72	Punch the desired combination of "H's" and "L's" representing the output levels for the sixth word on the card.

Example:

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CUSTOMER CODING FORM

The customer can also specify the desired ROM code by using the 4735B/4735BX Customer Coding Form (on the following pages) printed in the format below.

WORD NO.	OUTPUTS								REMARKS
	Q ₇	Q ₆	Q ₅	Q ₄	Q ₃	Q ₂	Q ₁	Q ₀	
0	L	L	L	H	H	L	H	L	
1	L	L	H	L	L	L	L	L	
2	H	H	H	H	H	H	H	H	
	↓	↓	↓	↓	↓	↓	↓	↓	↓
254	L	L	L	L	L	L	L	L	
255	L	L	L	L	L	L	L	L	

4735B/4735BX ADDRESS SCHEME

The 256 decimal addresses are defined by their binary equivalent with A₇ = MSB and A₀ = LSB as shown below.

DECIMAL ADDRESS	BINARY ADDRESS INPUTS								
	A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	
0	L	L	L	L	L	L	L	L	
1	L	L	L	L	L	L	L	H	
2	L	L	L	L	L	L	H	L	
3	L	L	L	L	L	H	H	L	
↓	↓	↓	↓	↓	↓	↓	↓	↓	
255	H	H	H	H	H	H	H	H	

"H" signifies a HIGH voltage applied to the address inputs. "L" signifies a LOW voltage applied to the address inputs.

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4735B/4735BX CUSTOMER CODING FORM

WORD NO.	OUTPUTS								REMARKS
	Q ₇	Q ₆	Q ₅	Q ₄	Q ₃	Q ₂	Q ₁	Q ₀	
0									
1									
2									
3									
4									
5									
6									
7									
8									
9									
10									
11									
12									
13									
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50									

FAIRCHILD CMOS • 4735B/4735BX

4735B/4735BX CUSTOMER CODING FORM (Cont'd)

WORD NO.	OUTPUTS								REMARKS
	Q ₇	Q ₆	Q ₅	Q ₄	Q ₃	Q ₂	Q ₁	Q ₀	
51									
52									
53									
54									
55									
56									
57									
58									
59									
60									
61									
62									
63									
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99									
100									
101									

FAIRCHILD CMOS • 4735B/4735BX

4735B/4735BX CUSTOMER CODING FORM (Cont'd)

WORD NO.	OUTPUTS								REMARKS
	Q ₇	Q ₆	Q ₅	Q ₄	Q ₃	Q ₂	Q ₁	Q ₀	
102									
103									
104									
105									
106									
107									
108									
109									
110									
111									
112									
113									
114									
115									
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147									
148									
149									
150									
151									
152									

FAIRCHILD CMOS • 4735B/4735BX

4735B/4735BX CUSTOMER CODING FORM (Cont'd)

WORD NO.	OUTPUTS								REMARKS
	Q ₇	Q ₆	Q ₅	Q ₄	Q ₃	Q ₂	Q ₁	Q ₀	
153									
154									
155									
156									
157									
158									
159									
160									
161									
162									
163									
164									
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199									
200									
201									
202									
203									

FAIRCHILD CMOS • 4735B/4735BX

4735B/4735BX CUSTOMER CODING FORM (Cont'd)

WORD NO.	OUTPUTS								REMARKS
	Q ₇	Q ₆	Q ₅	Q ₄	Q ₃	Q ₂	Q ₁	Q ₀	
204									
205									
206									
207									
208									
209									
210									
211									
212									
213									
214									
215									
216									
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253									
254									
255									

4736B/4736BX

1024-BIT RANDOM ACCESS MEMORY WITH 3-STATE OUTPUTS

DESCRIPTION — The 4736B/4736BX is a 1024-Bit, Random Access Memory, organized 1024 words x 1 bit, with 3-state outputs. It has a Data Input (D), ten Address Inputs (A₀-A₉), an active LOW Write Enable Input (WE), an active LOW Chip Select Input (CS), and one 3-State Data Output (Q).

Information on the Data Input (D) is written into the memory location selected by the Address Inputs (A₀-A₉) when the Chip Select Input (CS) and the Write Enable Input (WE) are LOW. Under these conditions the Data Output (Q) is held in a high impedance OFF state. Information is read from the memory location selected by the Address Inputs (A₀-A₉) while CS is LOW and WE is HIGH. When CS is HIGH the Data Output (Q) is held in a high impedance OFF state. This allows other 3-state outputs to be wired together in a bus arrangement. The 4736B/4736BX offers fully static operation. The 4736B is specified to operate over a Power Supply Voltage Range of 5 ± 0.5 V. The 4736BX is specified to operate over a Power Supply Voltage Range of 4.5 V to 12.5 V.

- TYPICAL HOLDING VOLTAGE OF 1.5 V
- 3-STATE OUTPUTS
- ORGANIZATION — 1024 WORDS x 1 BIT
- ON-CHIP DECODING
- FULLY STATIC OPERATION
- LOW POWER DISSIPATION
- HIGH SPEED
- CHIP SELECT INPUT FOR EASY MEMORY EXPANSION

PIN NAMES

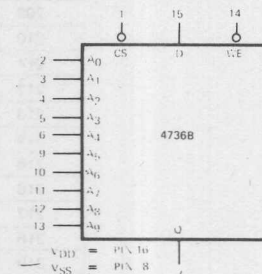
CS	Chip Select (Active LOW) Input
A ₀ -A ₉	Address Inputs
WE	Write Enable (Active LOW) Input
D	Data Input
Q	Data Output

MODE SELECTION

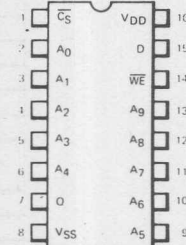
INPUTS		OUTPUT	MODE
CS	WE	Q	
H	X	High Impedance	Inhibit
L	L	High Impedance	Write
L	H	Data Written Into Memory	Read

H = HIGH Level
L = LOW Level
X = Don't Care

LOGIC SYMBOL

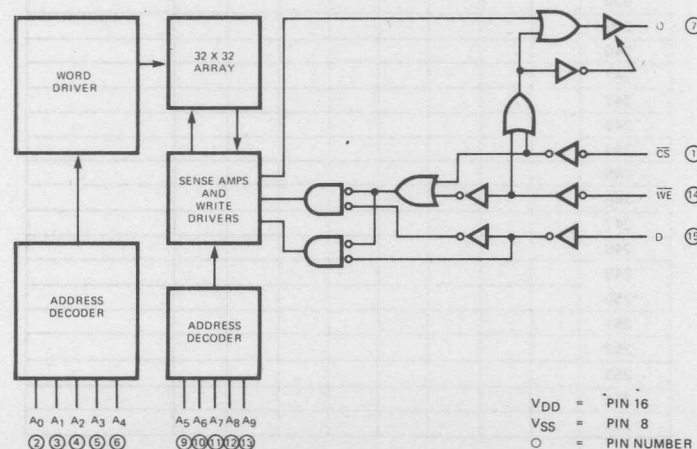


CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

BLOCK DIAGRAM



VDD = PIN 16
VSS = PIN 8
O = PIN NUMBER

FAIRCHILD CMOS • 4736B/4736BX

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 12.5 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OZH}	Output OFF	XC									1.6	μA	MIN, 25° C	Output Returned to V _{DD} . \overline{CS} = V _{DD}
											12		MAX	
	Current HIGH	XM									0.4		MIN, 25° C	
											12		MAX	
I _{OZL}	Output OFF	XC									-1.6	μA	MIN, 25° C	Output Returned to V _{SS} . \overline{CS} = V _{DD}
											- 12		MAX	
	Current LOW	XM									-0.4		MIN, 25° C	
											- 12		MAX	
I _{DD}	Quiescent Power	XC			32.5			65			130	μA	MIN, 25° C	\overline{CS} = V _{DD}
					250			500			1000		MAX	All inputs at
	Supply Current	XM			8.75			17.5			35		MIN, 25° C	0 V or V _{DD}
					250			500			1000		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS	
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 12.5 V					
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
	READ MODE												C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PLH}	Propagation Delay, Address to Output		500			320			260		ns		
t _{PHL}	Propagation Delay, Address to Output		500			320			260		ns		
t _{PZH}	Enable Time, \overline{CS} to Output		150			70			50		ns	(R _L = 1 kΩ to V _{SS})	
t _{PZL}	Enable Time, \overline{CS} to Output		150			70			50		ns	(R _L = 1 kΩ to V _{DD})	
t _{PHZ}	Disable Time, \overline{CS} to Output		150			70			50		ns	(R _L = 1 kΩ to V _{SS})	
t _{PLZ}	Disable Time, \overline{CS} to Output		150			70			50		ns	(R _L = 1 kΩ to V _{DD})	
t _{TLH}	Output Transition Time		75			35			25		ns		
t _{THL}	Output Transition Time		75			35			25		ns		
	WRITE MODE												(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD}) (R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PZH}	Enable Time, \overline{WE} to Output		150			70			50		ns		
t _{PZL}	Enable Time, \overline{WE} to Output		150			70			50		ns		
t _{PHZ}	Disable Time, \overline{WE} to Output		150			70			50		ns		
t _{PLZ}	Disable Time, \overline{WE} to Output		150			70			50		ns		
t _w \overline{WE}	Minimum \overline{WE} Pulse Width		180			100			80		ns		
t _s	Set-Up Time, D _n to \overline{WE}		150			120			115		ns		
t _h	Hold Time, D _n to \overline{WE}		40			20			15		ns		
t _s	Set-Up Time, Address to \overline{WE}		150			120			115		ns		
t _h	Hold Time, Address to \overline{WE}		40			20			15		ns		
t _s	Set-Up Time, \overline{CS} to \overline{WE}		150			120			115		ns		
t _h	Hold Time, \overline{CS} to \overline{WE}		40			20			15		ns		

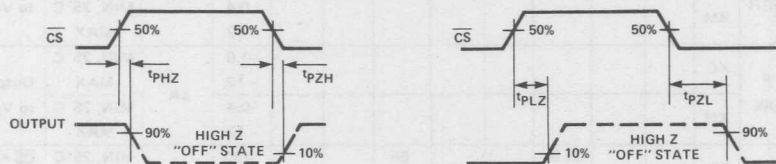
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

FAIRCHILD CMOS • 4736B/4736BX

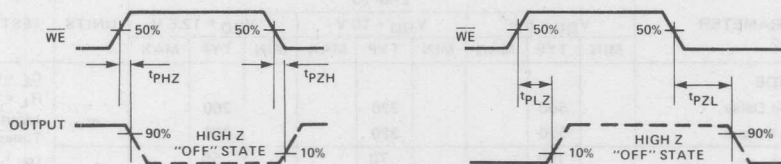
AC WAVEFORMS

READ MODE

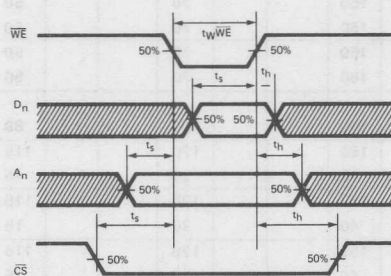


\overline{CS} TO OUTPUT ENABLE AND DISABLE TIMES

WRITE MODE



\overline{WE} TO OUTPUT ENABLE AND DISABLE TIMES



MINIMUM \overline{WE} PULSE WIDTH AND SET-UP AND HOLD TIMES, D_n TO \overline{WE} , A_n TO \overline{WE} , AND \overline{CS} TO \overline{WE}

Note: Set-up and Hold Times are shown as positive values but may be specified as negative values.

4737B

7-STAGE COUNTER

DESCRIPTION — The 4737B is a 7-Stage Frequency Counter especially useful for frequency synthesis in musical applications. The device is designed to generate, from a primary chromatic scale, each of the twelve flats, sharps, and naturals comprising each chromatic scale of the seven additional octaves in the musical spectrum. Twelve 4737B devices are required to generate the entire musical spectrum from a primary scale.

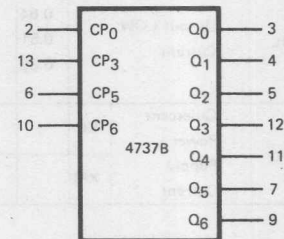
The 4737B consists of one 3-Bit Counter, with a Clock Input (CP₀) and Parallel Output (Q₀–Q₂) available, one 2-Bit Counter with a Clock Input (CP₃) and Parallel Outputs (Q₃–Q₄) available, and two 1-Bit Counters, also with Clock Inputs (CP₅ and CP₆) and Parallel Outputs (Q₅ and Q₆) available. Each counter advances on a LOW-to-HIGH transition at the appropriate Clock Input.

- REPEATS A PRIMARY MUSICAL NOTE OR HALF NOTE IN SEVEN OCTAVES
- CLOCK INPUT EDGE-TRIGGERED ON THE LOW-TO-HIGH TRANSITION
- BUFFERED OUTPUTS AVAILABLE FROM ALL SEVEN STAGES

PIN NAMES

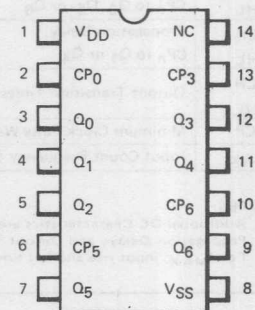
CP₀, CP₃, CP₅, CP₆ Clock Inputs (L→H Triggered)
Q₀–Q₆ Parallel Outputs

LOGIC SYMBOL



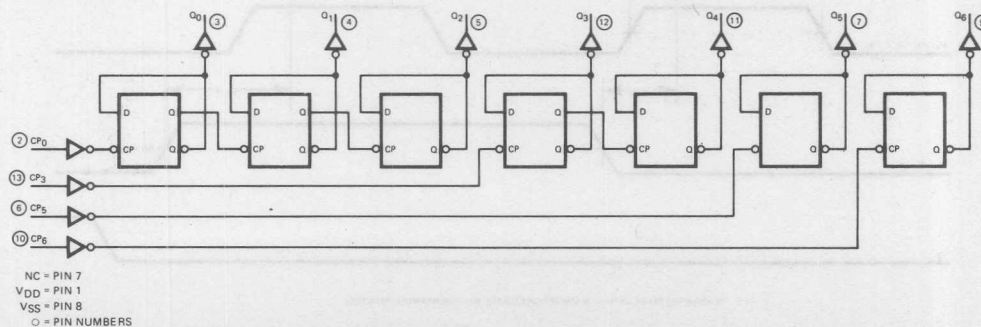
V_{DD} = Pin 1
V_{SS} = Pin 8
NC = Pin 14

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Platpak version has the same pin-outs (Connection Diagram) as the Dual In-Line Package.

LOGIC DIAGRAM



FAIRCHILD CMOS • 4737B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OH}	Output HIGH Current	-0.3			-0.84			-1.8			mA	MIN 25°C MAX	V _{OUT} = 4.5 V for V _{DD} = 5 V V _{OUT} = 9.5 V for V _{DD} = 10 V V _{OUT} = 13.5 V for V _{DD} = 15 V Inputs at V _{SS} or V _{DD} per the Logic Function or Truth Table	
I _{OL}	Output LOW Current	0.64 0.51 0.36			1.6 1.3 0.9			4.2 3.4 2.4			mA	MIN 25°C MAX	V _{OUT} = 0.4 V for V _{DD} = 5 V V _{OUT} = 0.5 V for V _{DD} = 10 V V _{OUT} = 1.5 V for V _{DD} = 15 V Inputs at V _{SS} or V _{DD} per the Logic Function or Truth Table	
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All Inputs at V _{DD} or V _{SS}
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

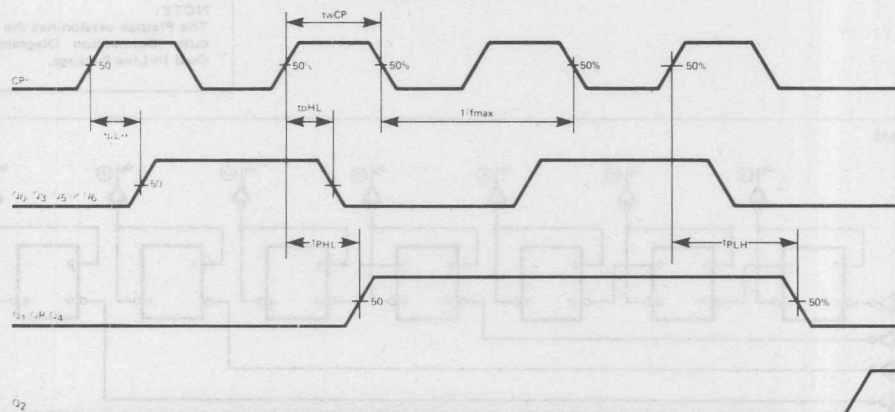
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP _n to Q ₃ , Q ₅ , or Q ₆		225	500		90	250		75	200	ns	C _L = 50 pF R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	Propagation Delay, CP _n to Q ₁ or Q ₄		225	500		90	250		75	200	ns	
t _{PLH}	Propagation Delay, CP _n to Q ₁ or Q ₄		365	1000		130	500		100	400	ns	
t _{PHL}	Propagation Delay, CP _n to Q ₃ , Q ₅ , or Q ₆		365	1000		130	500		100	400	ns	
t _{TLH}	Output Transition Times		70	500		40	250		30	200	ns	
t _{THL}	Output Transition Times		70	500		40	250		30	200	ns	
t _{wCP}	Minimum Clock Pulse Width	250	125		125	65		100	50		ns	
f _{MAX}	Input Count Frequency (Note 3)	2	4		4	8		5	10		MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.

SWITCHING WAVEFORMS



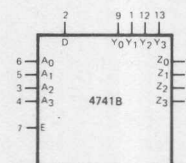
PROPAGATION DELAY, CP TO Q ; MINIMUM CLOCK PULSE WIDTH AND MAXIMUM FREQUENCY

4741B

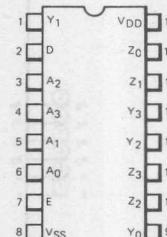
The device has four Address Inputs (A_0 - A_3), a Data Input (D), an Enable Input (E) and eight independent analog Input/Outputs (Y_0 - Y_3 and Z_0 - Z_3). When the Enable Input (E) is HIGH, the selected Output (Q_0 - Q_5) of the 16-Bit Addressable Latch (determined by the Address Inputs, A_0 - A_3) follows the Data Input (D) thus turning the selected analog switch ON or OFF. With the Data Input (D) HIGH, any one of the 16 analog switches may be individually turned ON by first applying the appropriate Address Inputs (A_0 - A_3) and then taking the Enable Input (E) HIGH. With the Data Input (D) LOW, any one of the 16 switches may be individually turned OFF by first applying the appropriate Address Inputs (A_0 - A_3) and then taking the Enable Input (E) HIGH. The Enable Input (E) may remain HIGH as long as the Address Inputs (A_0 - A_3) are stable. However, to prevent erroneous switch selection the Enable Input (E) must be LOW whenever the Address Inputs (A_0 - A_3) are changed.

- LOW ON RESISTANCE—TYPICALLY 85Ω at $V_{DD} = 10V$
- ON-CHIP ADDRESS DECODER AND CONTROL LATCHES
- INPUT SIGNAL FREQUENCIES UP TO 10 MHz
- ANALOG OR DIGITAL CROSSPOINT SWITCH

Y ₀ -Y ₃	Analog Input/Outputs
Z ₀ -Z ₃	Analog Input/Outputs
A ₀ -A ₃	Address Inputs
D	Data Input
E	Enable Input

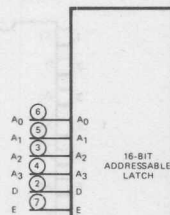


CONNECTION DIAGRAM
DIP (TOP VIEW)

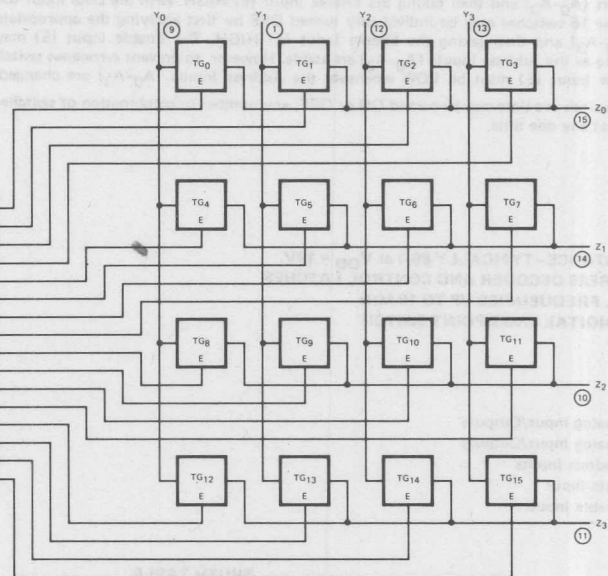
[illegible]

L = LOW Level X = Don't Care
H = HIGH Level NC = No Change

BLOCK DIAGRAM



V_{DD} @ Pin 16
V_{DD} = Pin 16
V_{SS} = Pin 8
○ = Pin Number
TG = Transmission Gate

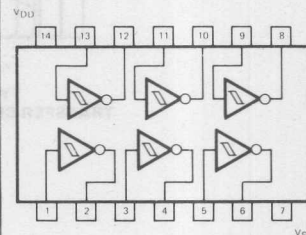


40014B/74C14/54C14

HEX SCHMITT TRIGGER

DESCRIPTION — The 40014B is a general purpose Hex Schmitt Trigger offering positive and negative threshold voltages, V_{T+} and V_{T-} , which show very low variation with temperature (typically $0.0005V/^{\circ}C$ at $V_{DD} = 10V$) and guaranteed hysteresis, V_{T+} to $V_{T-} \geq 0.2 V_{DD}$. Outputs are fully buffered for highest noise immunity. The 40014B is a direct replacement for the 74C14/54C14.

LOGIC AND CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The flatpak version has the same pinouts (Connection Diagram) as the dual in-line package.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0 V$ (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
V _{T+}	Positive-Going Threshold Voltage		3	3.6	4.3	6	6.8	8.6	9	10	12.9	V	All	V _{IN} = V _{SS} to V _{DD}
V _{T-}	Negative-Going Threshold Voltage		0.7	1.4	2	1.4	3.2	4	2.1	5	6	V	All	V _{IN} = V _{DD} to V _{SS}
V _{T+} to V _{T-}	Hysteresis		1	2.2	3.6	2	3.6	7.2	3	5	10.8	V	All	Guaranteed Hysteresis = V _{T+} Minus V _{T-}
I _{DD}	Quiescent Power	XC			1			2			4	μA	MIN, 25°C	All Inputs at 0 V or V _{DD}
					7.5			15		30			MAX	
	Supply Current	XM			0.25			0.5			1	μA	MIN, 25°C	
					7.5			15		30			MAX	

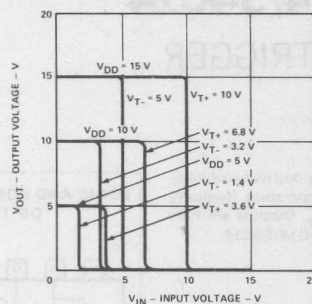
AC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0 V$, $T_A = 25^{\circ}C$.

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS (See Note 2)
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay		90	200		42	100		35	80	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			90	200		42	100		35	80		
t _{TLH}	Output Transition Time		70	135		30	75		22	45	ns	Input Transition Times ≤ 20 ns
t _{THL}			70	135		30	75		22	45		

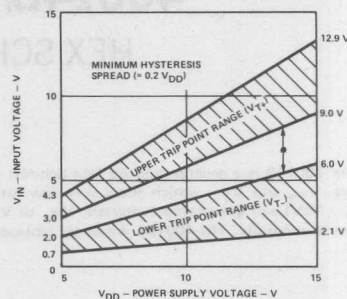
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

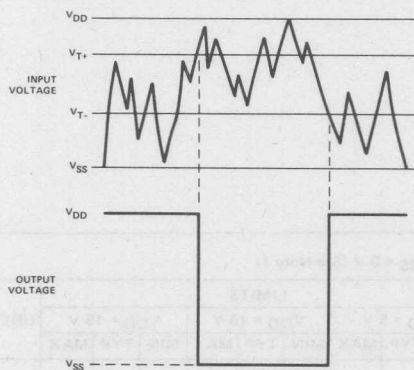
TYPICAL PERFORMANCE CHARACTERISTICS



TYPICAL TRANSFER CHARACTERISTICS

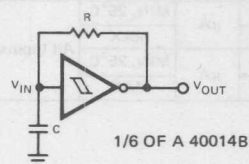


GUARANTEED TRIP POINT RANGE



LOW POWER OSCILLATOR

TYPICAL APPLICATION



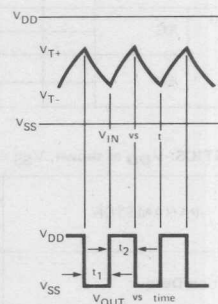
$$t_1 = RCL_n \left(\frac{V_{T+}}{V_{T-}} \right)$$

$$t_2 = RCL_n \left(\frac{V_{DD} - V_{T-}}{V_{DD} - V_{T+}} \right)$$

$$f \approx \frac{1}{RC L_n \left(\frac{V_{T+}(V_{DD} - V_{T-})}{V_{T-}(V_{DD} - V_{T+})} \right)}$$

NOTE:

The equations assume that $t_1 + t_2 \gg t_{PLH} + t_{PHL}$.



40085B/74C85/54C85

4-BIT MAGNITUDE COMPARATOR

DESCRIPTION — The 40085B is a 4-Bit Magnitude Comparator which compares two 4-bit words (A, B), each word having four Parallel Inputs (A_0 - A_3 , B_0 - B_3); A_3 , B_3 being the most significant inputs. Operation is not restricted to binary codes, the device will work with any monotonic code. Three Outputs are provided: "A greater than B" ($O_{A>B}$), "A less than B" ($O_{A<B}$), "A equal to B" ($O_{A=B}$). Three Expander Inputs, $I_{A>B}$, $I_{A<B}$, $I_{A=B}$, allow cascading without external gates. For proper compare operation the Expander Inputs to the least significant position must be connected as follows: $I_{A<B} = I_{A>B} = L$, $I_{A=B} = H$. For serial (ripple) expansion, the $O_{A>B}$, $O_{A<B}$ and $O_{A=B}$ Outputs are connected respectively to the $I_{A>B}$, $I_{A<B}$, and $I_{A=B}$ inputs of the next most significant comparator, as shown in Figure 1. Refer to Applications section of data sheet for high speed method of comparing large words.

The Truth Table on the following page describes the operation of the 40085B under all possible logic conditions. The upper 11 lines describe the normal operation under all conditions that will occur in a single device or in a series expansion scheme. The lower five lines describe the operation under abnormal conditions on the cascading inputs. These conditions occur when the parallel expansion technique is used.

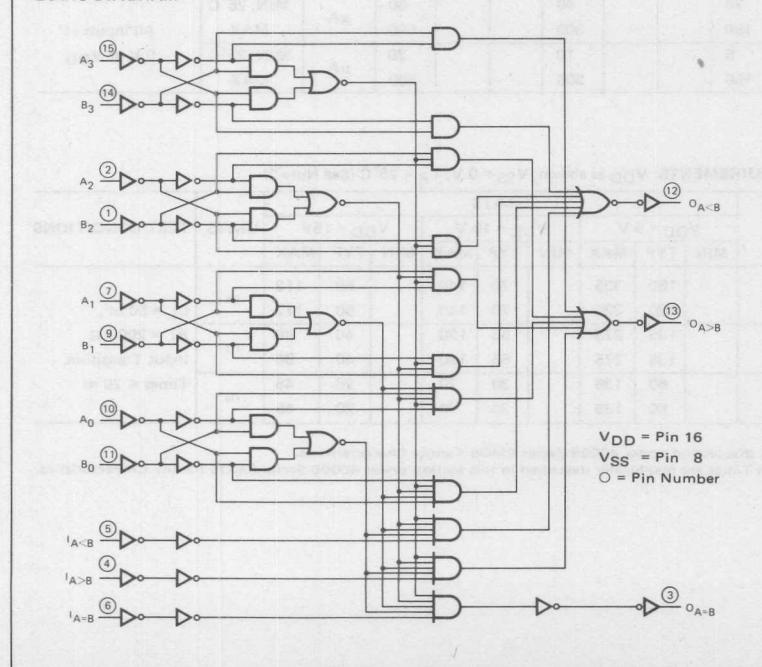
The 40085B is a direct replacement for the 74C85/54C85.

- EASILY EXPANDABLE
- BINARY OR BCD COMPARISON
- $O_{A>B}$, $O_{A<B}$, AND $O_{A=B}$ OUTPUTS AVAILABLE

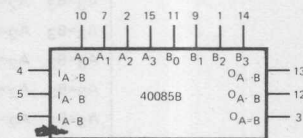
PIN NAMES

A_0 - A_3	Word A Parallel Inputs
B_0 - B_3	Word B Parallel Inputs
$I_{A>B}$, $I_{A<B}$, $I_{A=B}$	Expander Inputs
$O_{A>B}$	A Greater than B Output
$O_{A<B}$	A Less than B Output
$O_{A=B}$	A Equal to B Output

LOGIC DIAGRAM

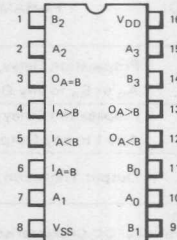


LOGIC SYMBOL



VDD = Pin 16
VSS = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 40085B/74C85/54C85

TRUTH TABLE

COMPARING INPUTS				CASCADING INPUTS			OUTPUTS		
A ₃ B ₃	A ₂ B ₂	A ₁ B ₁	A ₀ B ₀	I _A >B	I _A <B	I _A =B	O _A >B	O _A <B	O _A =B
A ₃ >B ₃	X	X	X	X	X	X	H	L	L
A ₃ <B ₃	X	X	X	X	X	X	L	H	L
A ₃ =B ₃	A ₂ >B ₂	X	X	X	X	X	H	L	L
A ₃ =B ₃	A ₂ <B ₂	X	X	X	X	X	L	H	L
A ₃ =B ₃	A ₂ =B ₂	A ₁ >B ₁	X	X	X	X	H	L	L
A ₃ =B ₃	A ₂ =B ₂	A ₁ <B ₁	X	X	X	X	L	H	L
A ₃ =B ₃	A ₂ =B ₂	A ₁ =B ₁	A ₀ >B ₀	X	X	X	H	L	L
A ₃ =B ₃	A ₂ =B ₂	A ₁ =B ₁	A ₀ <B ₀	X	X	X	L	H	L
A ₃ =B ₃	A ₂ =B ₂	A ₁ =B ₁	A ₀ =B ₀	H	L	L	H	L	L
A ₃ =B ₃	A ₂ =B ₂	A ₁ =B ₁	A ₀ =B ₀	L	H	L	L	H	L
A ₃ =B ₃	A ₂ =B ₂	A ₁ =B ₁	A ₀ =B ₀	L	L	H	L	L	H
A ₃ =B ₃	A ₂ =B ₂	A ₁ =B ₁	A ₀ =B ₀	L	H	H	L	H	H
A ₃ =B ₃	A ₂ =B ₂	A ₁ =B ₁	A ₀ =B ₀	H	L	H	H	L	H
A ₃ =B ₃	A ₂ =B ₂	A ₁ =B ₁	A ₀ =B ₀	H	H	H	H	H	H
A ₃ =B ₃	A ₂ =B ₂	A ₁ =B ₁	A ₀ =B ₀	H	H	L	H	H	L
A ₃ =B ₃	A ₂ =B ₂	A ₁ =B ₁	A ₀ =B ₀	L	L	L	L	L	L

H = HIGH Level
L = LOW Level
X = Don't Care

DC CHARACTERISTICS: V_{DD} as shown, V_{SS} = 0 V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600			

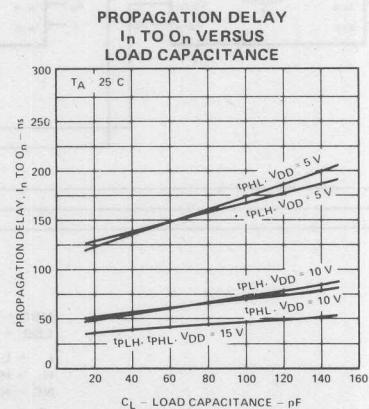
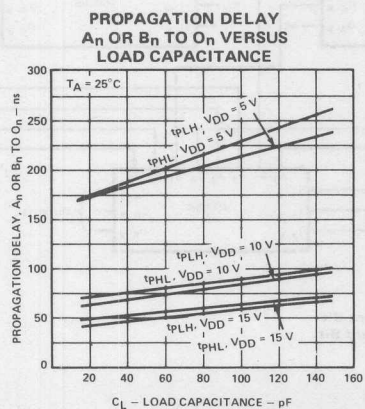
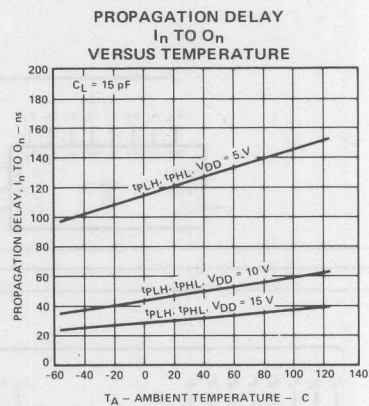
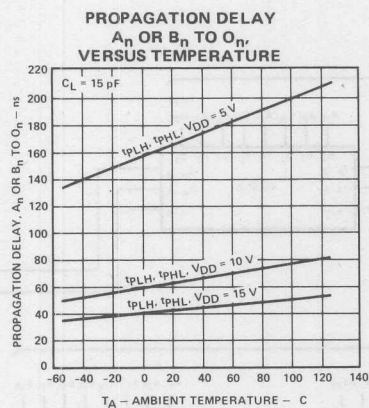
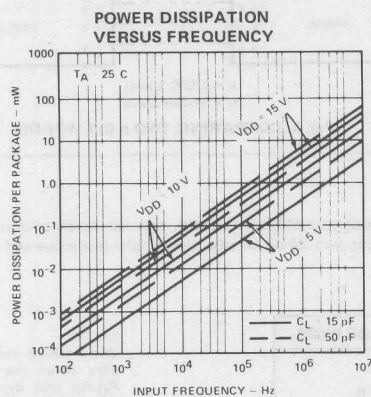
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, V_{SS} = 0 V, T_A = 25°C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, A _n or B _n to any Output		180	335		70	140		50	112	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			180	335		70	140		50	112		
t _{PLH}	Propagation Delay, Any I to any Output		135	275		55	120		40	96	ns	
t _{PHL}			135	275		55	120		40	96		
t _{TLH}	Output Transition Time		60	135		30	70		20	45	ns	
t _{THL}			60	135		30	70		20	45		

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS



APPLICATIONS

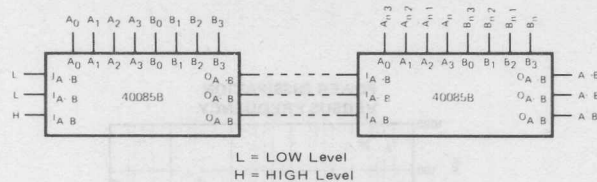


Fig. 1. COMPARING TWO n-BIT WORDS

Figure 2 shows a high speed method of comparing two 24-bit words with only two levels of device delay. With the technique shown in Figure 1, six levels of device delay result when comparing two 24-bit words. The parallel technique can be expanded to any number of bits, see Table I.

TABLE I

WORD LENGTH	NUMBER OF PKGS.
1-4 Bits	1
5-24 Bits	2 - 6
25-120 Bits	8 - 31

NOTE:

The F40085 can be used as a 5-bit comparator only when the outputs are used to drive the A_0 - A_3 and B_0 - B_3 inputs of another 40085B as shown in Figure 2 in positions #1, 2, 3, and 4.

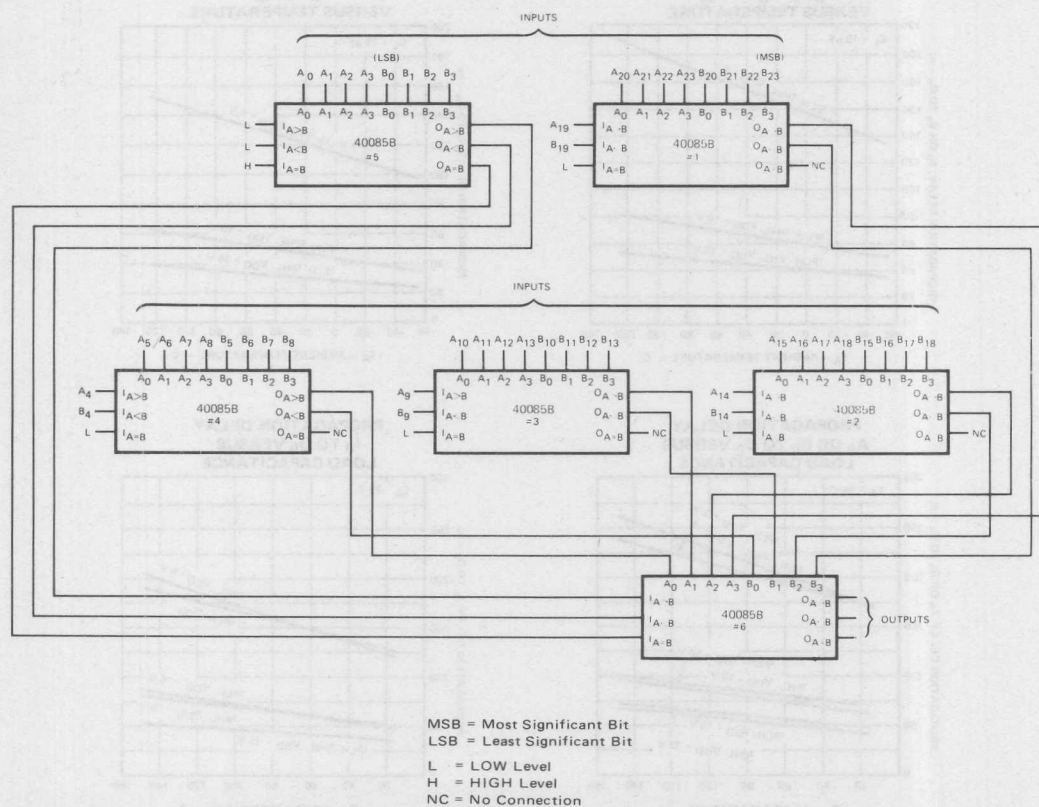


Fig. 2. COMPARISON OF TWO 24-BIT WORDS

40097B • 40098B

3-STATE HEX NON-INVERTING AND INVERTING BUFFERS

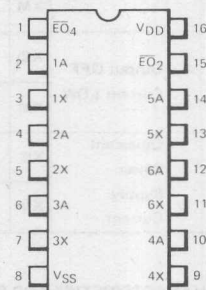
DESCRIPTION — These two CMOS buffers provide high current output capability suitable for driving high capacitance loads. The 40097B is a Non-Inverting CMOS Buffer with 3-state outputs and the 40098B is an Inverting CMOS Buffer with 3-state outputs. The 3-state outputs of each device are controlled by two Enable Inputs (\overline{EO}_4 , \overline{EO}_2). A HIGH on Enable Input \overline{EO}_4 causes the Outputs of four of the six buffer elements to assume a high impedance or OFF state, regardless of other input conditions and a HIGH on Enable Input \overline{EO}_2 causes the Outputs of the remaining two buffer elements to assume a high impedance or OFF state, regardless of other input conditions.

- 3-STATE OUTPUTS
- TTL COMPATIBLE -- FAN OUT OF ONE TTL LOAD
- ACTIVE LOW ENABLE INPUTS

PIN NAMES

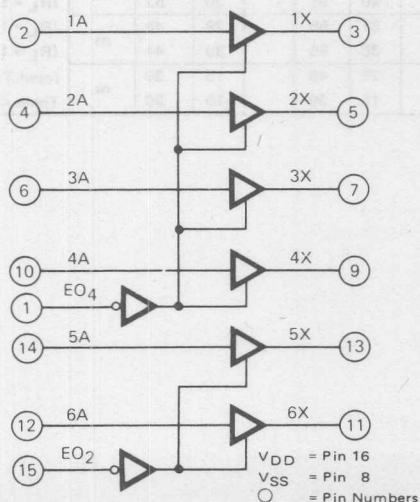
1A - 6A	Buffer Inputs
\overline{EO}_4 , \overline{EO}_2	Enable Inputs (Active LOW)
1X - 6X	Buffer Outputs (Active HIGH for the 40097B and Active LOW for the 40098B)

CONNECTION DIAGRAM DIP (TOP VIEW)

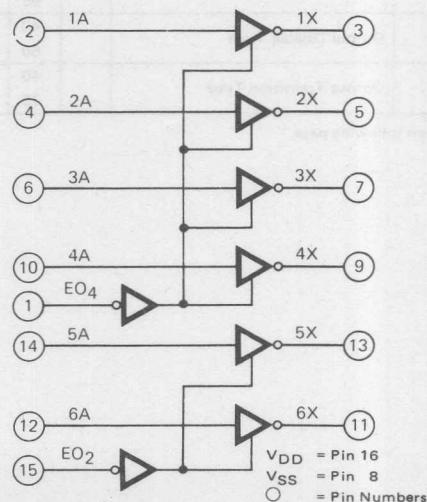


NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

40097B LOGIC DIAGRAM



40098B LOGIC DIAGRAM



FAIRCHILD CMOS • 40097B • 40098B

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{OH}	Output HIGH Current		-1.0			-2.0			-3.2			mA	MIN, 25°C	V _{OUT} = 4.5 V for V _{DD} = 5 V V _{OUT} = 9.5 V for V _{DD} = 10 V V _{OUT} = 14.5 V for V _{DD} = 15 V Inputs at V _{SS} or V _{DD} Per Logic Function
			-0.7			-1.4			-2.2				MAX	
I _{OL}	Output LOW Current		2.5			6.25			11.25			mA	MIN, 25°C	V _{OUT} = 0.4 V for V _{DD} = 5 V V _{OUT} = 0.5 V for V _{DD} = 10 V V _{OUT} = 0.5 V for V _{DD} = 15 V Inputs at V _{SS} or V _{DD} Per Logic Function
			1.8			4.5			8.25				MAX	
I _{OZH}	Output OFF Current HIGH	XC									1.6	μA	MIN, 25°C	Output Returned to V _{DD} , E _{O_n} = V _{DD}
											12		MAX	
		XM									0.4		MIN, 25°C	
											12		MAX	
I _{OZL}	Output OFF Current LOW	XC									-1.6	μA	MIN, 25°C	Output Returned to V _{SS} , E _{O_n} = V _{DD}
											-12		MAX	
		XM									-0.4		MIN, 25°C	
											-12		MAX	
I _{DD}	Quiescent Power Supply Current	XC			4			8			16	μA	MIN, 25°C	All Inputs at 0 V or V _{DD}
					30			60			120		MAX	
		XM			1			2			4		MIN, 25°C	
					30			60			120		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$, 40097B only (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Data to Output		65	100		25	40		20	32	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			80	100		28	40		20	32		
t _{PZH}	Output Enable Time		70	110		35	55		29	44	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PZL}			95	150		40	65		30	52		
t _{PHZ}	Output Disable Time		40	65		31	55		29	44	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PLZ}			60	95		35	55		30	44		
t _{TLH}	Output Transition Time		40	65		25	40		15	30	ns	Input Transition Times ≤ 20 ns
t _{THL}			30	60		15	30		15	30		

Notes on following page.

FAIRCHILD CMOS • 40097B • 40098B

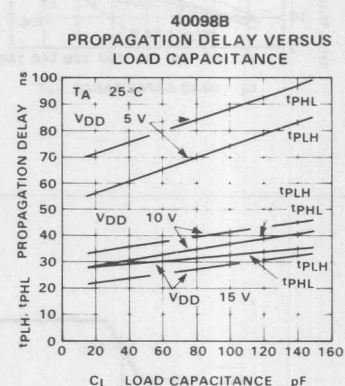
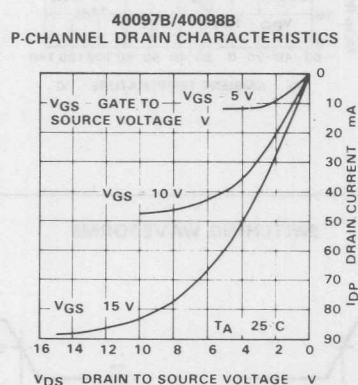
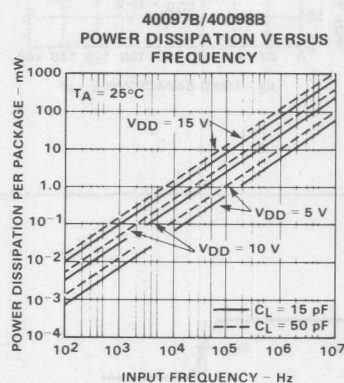
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$, 40098B only (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, Data to Output		65	120		30	55		30	44	ns	C _L = 50 pF, R _L = 200 kΩ
t _{PHL}			85	155		35	65		30	52		
t _{PZH}	Output Enable Time		70	110		35	55		29	44	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PZL}			95	170		40	60		30	48		
t _{PHZ}	Outside Disable Time		40	70		31	55		29	44	ns	(R _L = 1 kΩ to V _{SS}) (R _L = 1 kΩ to V _{DD})
t _{PLZ}			60	105		35	55		30	44		
t _{TLH}	Output Transition Time		40	65		25	40		15	30	ns	Input Transition Times ≤ 20 ns
t _{THL}			30	60		15	30		15	30		

NOTES:

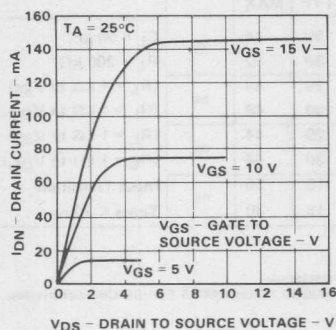
1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.

TYPICAL ELECTRICAL CHARACTERISTICS

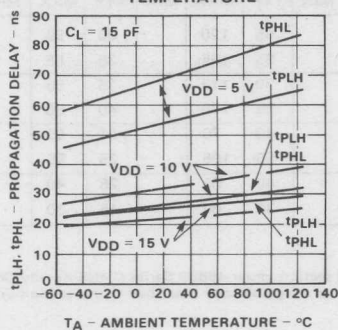


TYPICAL ELECTRICAL CHARACTERISTICS (Cont'd)

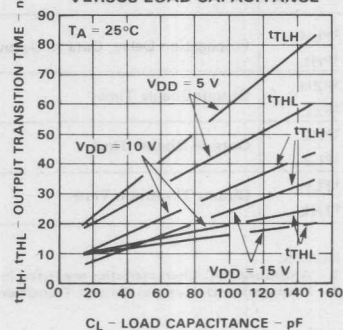
40098B
N-CHANNEL DRAIN CHARACTERISTICS



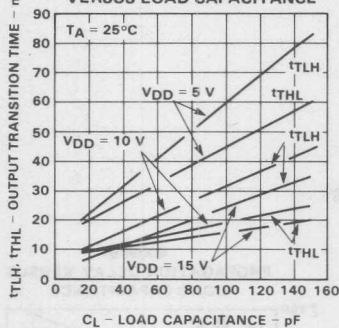
40098B
PROPAGATION DELAY VERSUS TEMPERATURE



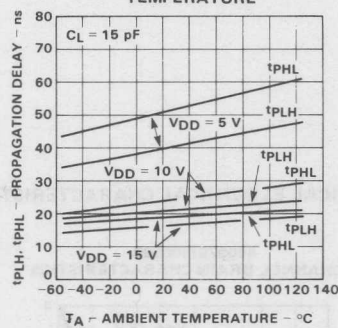
40098B
OUTPUT TRANSITION TIME VERSUS LOAD CAPACITANCE



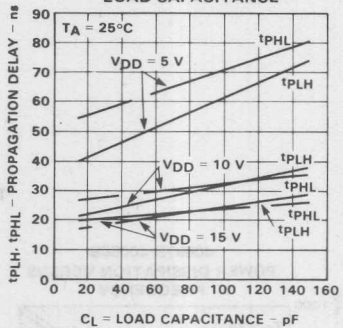
40097B
OUTPUT TRANSITION TIME VERSUS LOAD CAPACITANCE



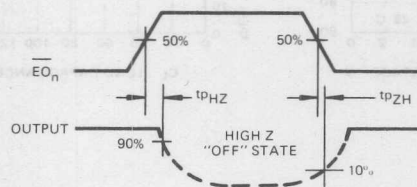
40097B
PROPAGATION DELAY VERSUS TEMPERATURE



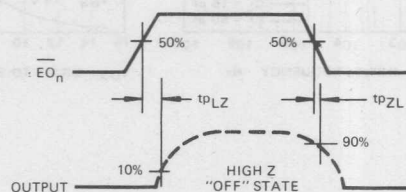
40097B
PROPAGATION DELAY VERSUS LOAD CAPACITANCE



SWITCHING WAVEFORMS



OUTPUT ENABLE TIME (tpZH) AND OUTPUT DISABLE TIME (tpHZ)



OUTPUT ENABLE TIME (tpLZ) AND OUTPUT DISABLE TIME (tpLZ)

40160B/74C160/54C160 • 40161B/74C161/54C161 40162B/74C162/54C162 • 40163B/74C163/54C163

4-BIT SYNCHRONOUS COUNTERS

DESCRIPTION — The 40160B and the 40162B are fully synchronous edge-triggered 4-Bit Decade Counters. The 40161B and the 40163B are fully synchronous edge-triggered 4-Bit Binary Counters. Each device has a Clock Input (CP); four synchronous Parallel Data Inputs (P_0 - P_3); three synchronous Mode Control Inputs, Parallel Enable (PE), Count Enable Parallel (CEP) and Count Enable trickle (CET); Buffered Outputs from all four bit positions (Q_0 - Q_3); and a Terminal Count Output (TC). The 40162B and 40163B have an additional synchronous Mode Control Input, Synchronous Reset (\overline{SR}). Alternately, the 40160B and 40161B have an overriding asynchronous Master Reset (\overline{MR}).

Operation is fully synchronous except for Master Reset on the 40160B and 40161B and occurs on the LOW-to-HIGH transition of the Clock Input (CP). When the Parallel Enable Input (PE) is LOW, the next LOW-to-HIGH transition of the Clock Input (CP) loads data into the counter from Parallel Inputs (P_0 - P_3). When the Parallel Enable Input (\overline{PE}) is HIGH, the next LOW-to-HIGH transition of the Clock Input (CP) advances the counter to its next state only if both Count Enable Inputs (CEP and CET) are HIGH when the state of the counter is nine ($Q_0 = Q_3 = \text{HIGH}$, $Q_1 = Q_2 = \text{LOW}$) for the 40160B and 40162B/fifteen ($Q_0 = Q_1 = Q_2 = Q_3 = \text{HIGH}$) for the 40161B and 40163B and the Count Enable Trickle Input (CET) is HIGH. For the 40162B and 40163B a LOW on the Synchronous Reset Input (\overline{SR}) sets all Outputs (Q_0 - Q_3 and TC) LOW on the next LOW-to-HIGH transition of the Clock Input (CP) independent of the state of all other synchronous Mode Control Inputs (CEP, CET, PE). For the 40160B and 40161B, a LOW on the overriding asynchronous Master Reset (\overline{MR}) sets all outputs (Q_0 - Q_3 and TC) LOW, independent of the state of all other inputs.

These devices perform multistage synchronous counting without additional components by using a carry look-ahead counting technique.

The 40160B, 40161B, 40162B, and 40163B are edge-triggered; therefore, the synchronous Mode Control Input (CEP, CET, \overline{PE} for the 40160B/40161B and CEP, CET, PE, \overline{SR} for the 40162B/40163B) must be stable only during the set-up time before the LOW-to-HIGH transition of the Clock Input (CP).

The 40160B, 40161B, 40162B and 40163B are direct replacements for the 74C160/54C160, 74C161/54C161, 74C162/54C162, and 74C163/54C163 respectively.

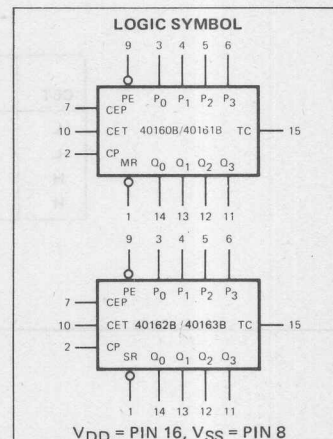
- 12 MHz TYPICAL COUNT FREQUENCY AT $V_{DD} = 10\text{ V}$
- DECODED TERMINAL COUNT
- FULLY SYNCHRONOUS COUNTING AND PARALLEL ENTRY
- SYNCHRONOUS (40162B/40163B) OR ASYNCHRONOUS (40160B/40161B) RESET
- BUILT-IN CARRY CIRCUITRY
- FULLY EDGE-TRIGGERED

PIN NAMES

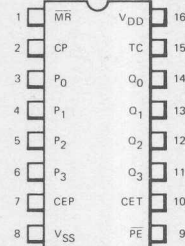
\overline{PE}	Parallel Enable Input (Active LOW)
P_0 - P_3	Parallel Inputs
CEP	Count Enable Parallel Input
CET	Count Enable Trickle Input
CP	Clock Input (L \rightarrow H Edge-Triggered)
\overline{MR}	Master Reset Input (Active LOW) for the 40160B/40161B Only
\overline{SR}	Synchronous Reset Input (Active LOW) for the 40162B/40163B Only
Q_0 - Q_3	Parallel Outputs
TC	Terminal Count Output

SELECTOR GUIDE

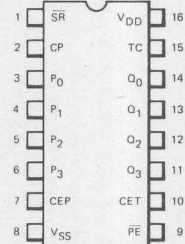
RESET	MODULUS	
	DECADE	BINARY
Asynchronous	40160B	40161B
Synchronous	40162B	40163B



40160B/40161B CONNECTION DIAGRAM DIP (TOP VIEW)



40162B/40163B CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 40160B/74C160/54C160 • 40161B/74C161/54C161 •
40162B/74C162/54C162 • 40163B/74C163/54C163

SYNCHRONOUS MODE SELECTION
40160B/40161B

\overline{PE}	CEP	CET	MODE
L	X	X	Preset
H	L	X	No Change
H	X	L	No Change
H	H	H	Count

\overline{MR} = HIGH

SYNCHRONOUS MODE SELECTION
40162B/40163B

\overline{SR}	\overline{PE}	CEP	CET	MODE
H	L	X	X	Preset
H	H	L	X	No Change
H	H	X	L	No Change
H	H	H	H	Count
L	X	X	X	Reset

TERMINAL COUNT GENERATION

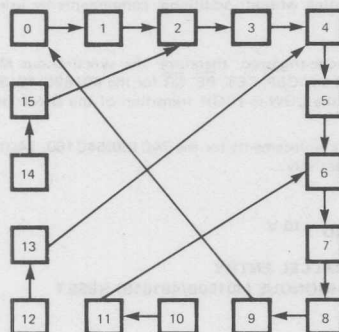
CET	40160B/40162B ($Q_0 \cdot \overline{Q_1} \cdot \overline{Q_2} \cdot Q_3$)	40161B/40163B ($Q_0 \cdot Q_1 \cdot Q_2 \cdot Q_3$)	TC
L	L	L	L
L	H	H	L
H	L	L	L
H	H	H	H

H = HIGH Level
L = LOW Level
X = Don't Care

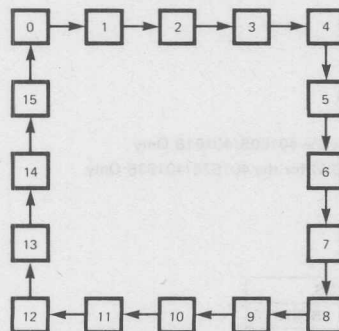
$$TC = CET \cdot Q_0 \cdot \overline{Q_1} \cdot \overline{Q_2} \cdot Q_3 \text{ (40160B/40162B)}$$

$$TC = CET \cdot Q_0 \cdot Q_1 \cdot Q_2 \cdot Q_3 \text{ (40161B/40163B)}$$

STATE DIAGRAM
40160B • 40162B



STATE DIAGRAM
40161B • 40163B

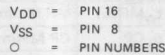


NOTE:

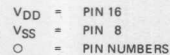
The 40160B or 40162B can be preset to any state, but will not count beyond 9. If preset to state 10, 11, 12, 13, 14 or 15, they will return to their normal sequence within two clock pulses.

40162B/74C162/54C162 • 40163B/74C163/54C163

The 40161B and 40163B binary synchronous counters are similar. However, the 40161B has an asynchronous master reset circuit as shown on the 40160B/40162B Logic Diagram.



The 40160B and 40162B BCD synchronous counters are similar. However, the 40162B has a synchronous reset circuit as shown on the 40161B/40163B Logic Diagram.



FAIRCHILD CMOS • 40160B/74C160/54C160 • 40161B/74C161/54C161 •
40162B/74C162/54C162 • 40163B/74C163/54C163

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

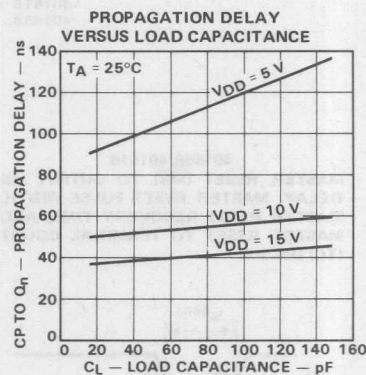
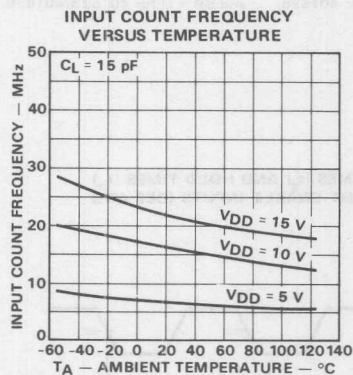
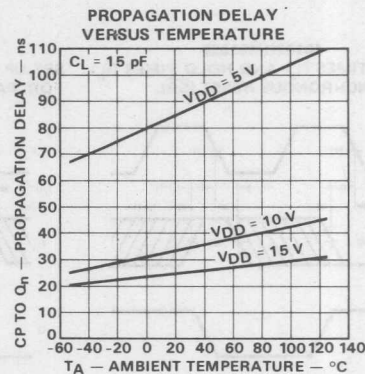
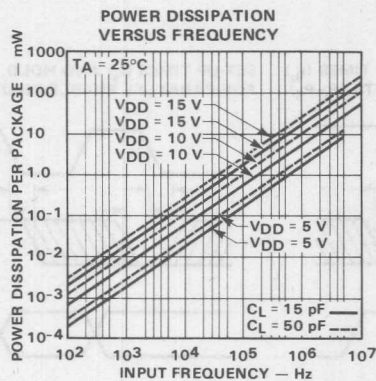
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS	
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
t _{PLH}	Propagation Delay, CP to Q		120	220		55	105		40	84	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns	
t _{PHL}			120	220		55	105		38	84			
t _{PLH}	Propagation Delay, CP to TC		155	285		70	130		45	104	ns		(40160B/40161B)

NOTES:

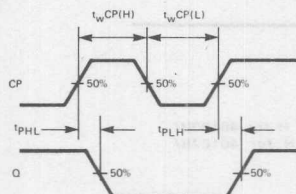
1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

TYPICAL ELECTRICAL CHARACTERISTICS



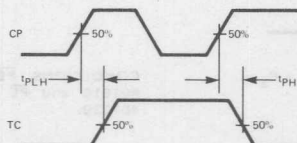
SWITCHING DIAGRAMS

CLOCK (CP) TO OUTPUT (Q)
PROPAGATION DELAYS AND MINIMUM
CLOCK PULSE WIDTH



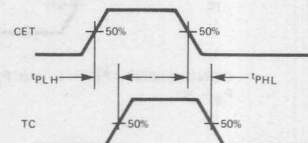
CONDITIONS: $\overline{PE} = \overline{MR} = CEP = CET = H$ for 40160B/40161B and $\overline{PE} = \overline{SR} = CEP = CET = H$ for 40162B/40163B.

CLOCK (CP) TO TERMINAL COUNT (TC)
PROPAGATION DELAYS



CONDITIONS: See the Terminal Count Generation Table. $\overline{PE} = CEP = CET = \overline{MR} = H$ for 40160B/40161B and $\overline{PE} = CEP = CET = \overline{SR} = H$ for 40162B/40163B.

COUNT ENABLE TRICKLE INPUT (CET)
TO TERMINAL COUNT OUTPUT (TC)
PROPAGATION DELAYS

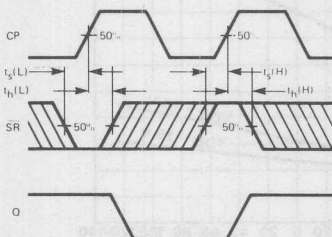


CONDITIONS: See the Terminal Count Generation Table. $CP = \overline{PE} = CEP = \overline{MR} = H$ for 40160B/40161B and $CP = \overline{PE} = CEP = \overline{SR} = H$ for 40162B/40163B.

SWITCHING DIAGRAMS (Continued)

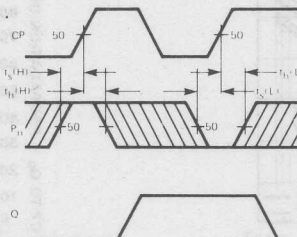
40162B/40163B

SET-UP TIMES (t_s) AND HOLD TIMES (t_h)
FOR SYNCHRONOUS RESET (SR).



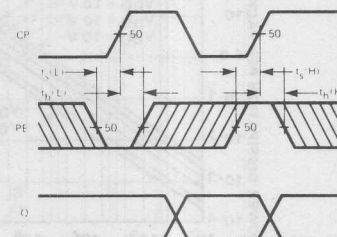
CONDITIONS: $\overline{PE} = L$, $P_0-P_3 = H$.

SET-UP TIMES (t_s) AND HOLD TIMES (t_h)
FOR PARALLEL DATA INPUTS (P_0-P_3).



CONDITIONS: $\overline{PE} = L$, $\overline{MR} = H$ for 40160B/
40161B and $\overline{PE} = L$, $\overline{SR} = H$ for 40162B/
40163B.

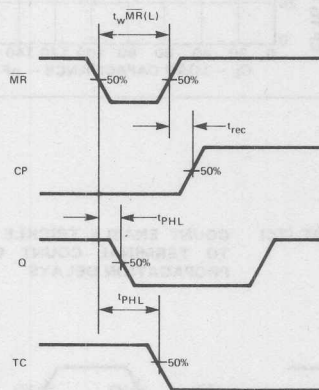
SET-UP TIMES (t_s) AND HOLD TIMES (t_h)
FOR PARALLEL ENABLE INPUT PE.



CONDITIONS: $\overline{MR} = H$ for 40160B/40161B
and $\overline{SR} = H$ for 40162B/40163B.

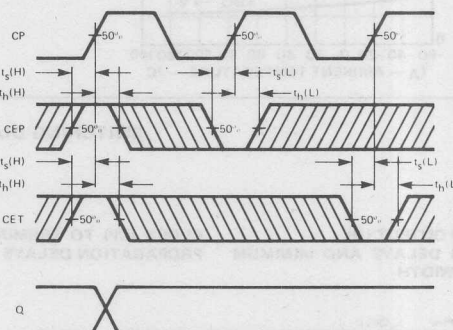
40160B/40161B

MASTER RESET (\overline{MR}) TO OUTPUT (Q)
DELAY, MASTER RESET PULSE WIDTH,
MASTER RESET RECOVERY TIME, AND
MASTER RESET TO TERMINAL COUNT
(TC) DELAY.



CONDITIONS: $\overline{PE} = L$ and $P_0 = P_1 = P_2 =$
 $P_3 = H$.

SET-UP TIMES (t_s) AND HOLD TIMES (t_h)
FOR COUNT ENABLE INPUTS (CEP AND
CET).



CONDITIONS: $\overline{PE} = \overline{MR} = H$ for 40160B/
40161B and $\overline{PE} = \overline{SR} = H$ for 40162B/
40163B.

NOTE:

1. Set-up Times (t_s) and Hold Times (t_h) are shown as positive values, but may be specified as negative values.

40174B/74C174/54C174

HEX D FLIP-FLOP

DESCRIPTION — The 40174B is a Hex Edge-Triggered D Flip-Flop with six Data Inputs (D_0 - D_5), a Clock Input (CP) an overriding asynchronous Master Reset (\overline{MR}), and six Buffered Outputs (Q_0 - Q_5).

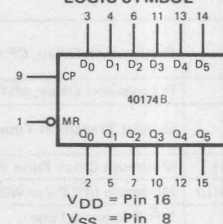
Information on the Data Inputs (D_0 - D_5) is transferred to the Buffered Outputs (Q_0 - Q_5) on the LOW-to-HIGH transition of the Clock Input (CP) if the Master Reset Input (\overline{MR}) is HIGH. When LOW, the Master Reset Input (\overline{MR}) resets all flip-flops (Q_0 - Q_5 = LOW) independent of the Clock (CP) and Data Inputs (D_0 - D_5). The 40174B is a direct replacement for the 74C174/54C174.

- TYPICAL CLOCK FREQUENCY OF 16 MHz AT $V_{DD} = 10$ V
- COMMON CLOCK TRIGGERED ON LOW-TO-HIGH TRANSITION
- COMMON ACTIVE LOW MASTER RESET
- FULLY EDGE-TRIGGERED CLOCK INPUT

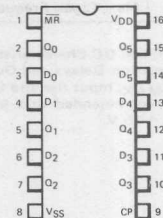
PIN NAMES

D_0 - D_5 Data Inputs
 CP Clock Input (L-H Edge-Triggered)
 \overline{MR} Master Reset Input (Active LOW)
 Q_0 - Q_5 Buffered Outputs from the Flip-Flops

LOGIC SYMBOL



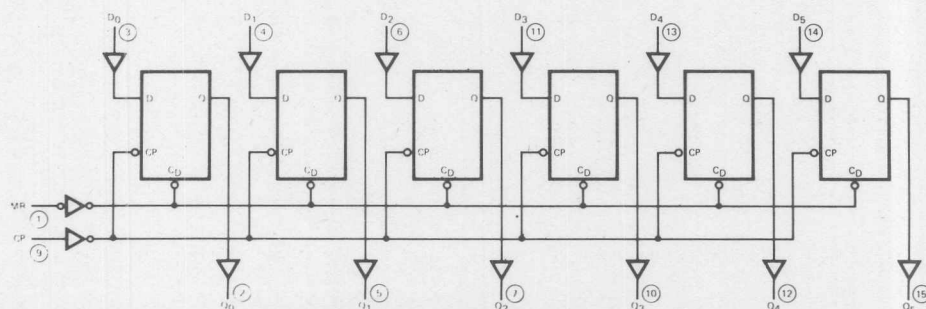
CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Numbers

FAIRCHILD CMOS • 40174B/74C174/54C174

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600			

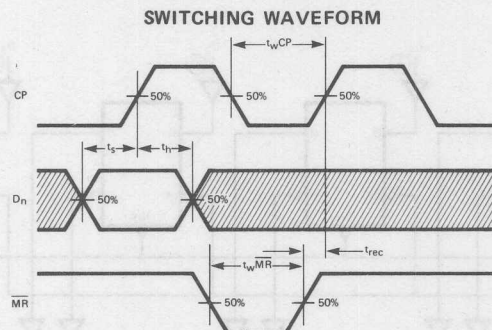
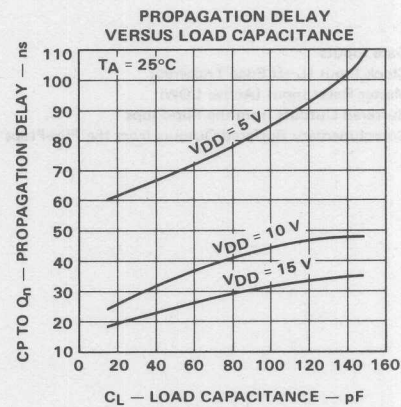
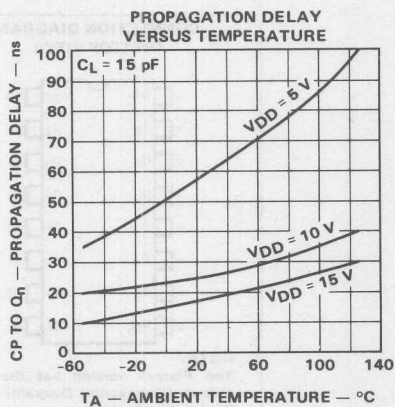
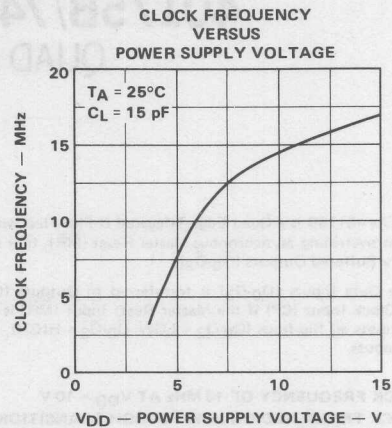
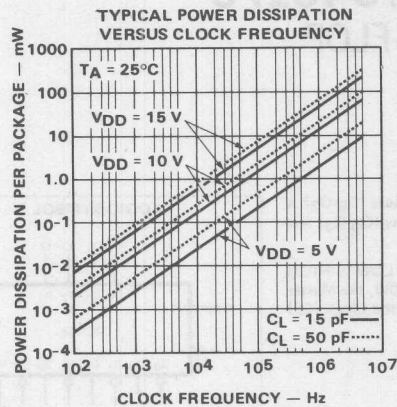
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q _n		70	115		35	60		25	48	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			70	115		35	60		25	48		
t _{PHL}	Propagation Delay, MR to Q _n		80	125		40	65		25	52	ns	
t _{TLH}	Output Transition Time		65	135		35	70		15	45	ns	
t _{THL}			65	135		35	70		15	45		
t _w CP(L)	Minimum Clock Pulse Width	45	25		20	10		16	8		ns	
t _w MR(L)	Minimum MR Pulse Width	55	35		35	20		28	15		ns	
t _{rec}	MR Recovery Time	25	6		13	5		11	2		ns	
t _s	Set-Up Time, D _n to CP	5	1		5	1		4	0		ns	
t _h	Hold Time, D _n to CP	20	10		10	2		8	1			
f _{MAX}	Max. Clock Frequency (Note 3)	5	9		8	16		9	19		MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

TYPICAL ELECTRICAL CHARACTERISTICS



MINIMUM PULSE WIDTHS FOR CP AND \overline{MR} , \overline{MR} RECOVERY TIME, AND SET-UP AND HOLD TIMES, D_n TO CP

NOTE: Set-up and Hold Times are shown as positive values but may be specified as negative values

40175B/74C175/54C175

QUAD D FLIP-FLOP

DESCRIPTION — The 40175B is a Quad Edge-Triggered D Flip-Flop with four Data Inputs (D_0 - D_3), a Clock Input (CP) an overriding asynchronous Master Reset (MR), four Buffered Outputs (Q_0 - Q_3) and four Complementary Buffered Outputs (\bar{Q}_0 - \bar{Q}_3).

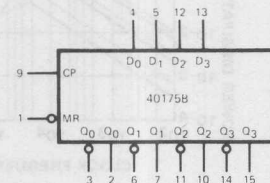
Information on the Data Inputs (D_0 - D_3) is transferred to Outputs (Q_0 - Q_3) on the LOW-to-HIGH Transition of the Clock Input (CP) if the Master Reset Input (MR) is HIGH. When LOW, the Master Reset Input (MR) resets all flip-flops (Q_0 - Q_3 = LOW, \bar{Q}_0 - \bar{Q}_3 = HIGH), independent of the Clock (CP) and Data (D_0 - D_3) Inputs.

- TYPICAL CLOCK FREQUENCY OF 16 MHz AT $V_{DD} = 10$ V
- COMMON CLOCK TRIGGERED ON LOW-TO-HIGH TRANSITION
- COMMON ACTIVE LOW MASTER RESET
- TRUE AND COMPLEMENTARY OUTPUTS AVAILABLE
- FULLY EDGE-TRIGGERED CLOCK INPUT

PIN NAMES

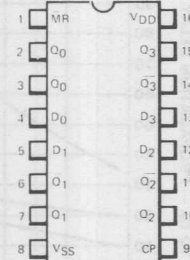
D_0 - D_3	Data Inputs
CP	Clock Input (L→H Edge-Triggered)
MR	Master Reset Input (Active LOW)
Q_0 - Q_3	Buffered Outputs from the Flip-Flops
\bar{Q}_0 - \bar{Q}_3	Complimentary Buffered Outputs from the Flip-Flops

LOGIC SYMBOL



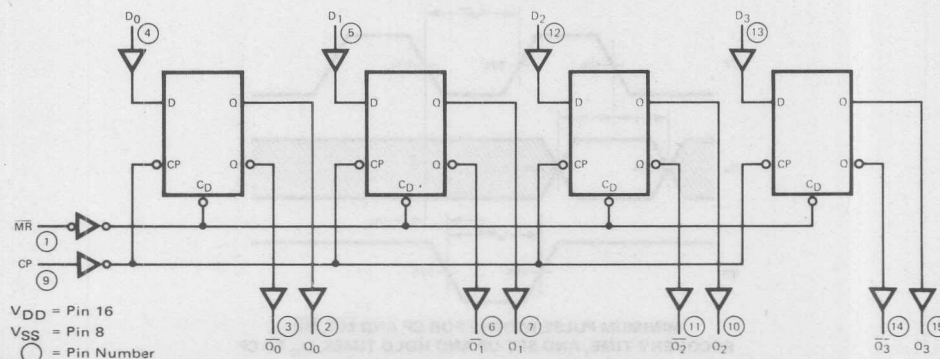
V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

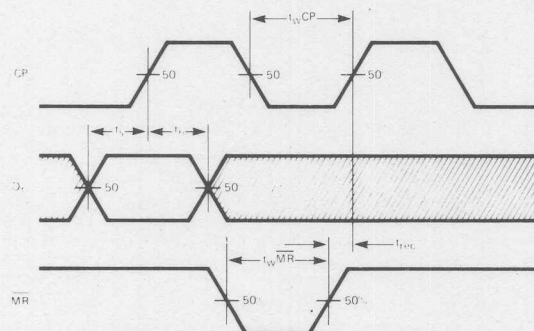
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q _n or Q̄ _n		70	190		35	75		25	60	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			70	190		35	75		25	60		
t _{PLH}	Propagation Delay, MR to Q _n or Q̄ _n		80	200		40	70		25	56	ns	
t _{PHL}			80	200		40	70		25	56		
t _{TLH}	Output Transition Time		65	135		35	75		15	45	ns	
t _{THL}			65	135		35	75		15	45		
t _{wCP(L)}	Minimum Clock Pulse Width	80	25		45	10		36	8		ns	
t _{wMR(L)}	Minimum MR Pulse Width	60	35		30	20		24	15		ns	
t _{rec}	MR Recovery Time	0	-50		0	-25		0	-15		ns	
t _s	Set-Up Time, D _n to CP	45	20		20	7		16	3		ns	
t _h	Hold Time, D _n to CP	10	-10		5	-5		4	-3			
f _{MAX}	Max. Clock Frequency (Note 3)	4	9		10	16		12	19		MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

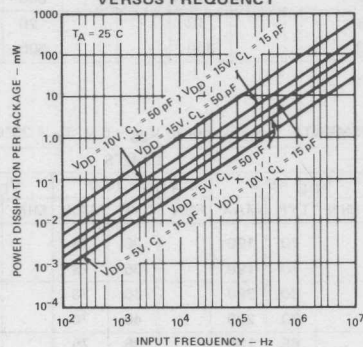
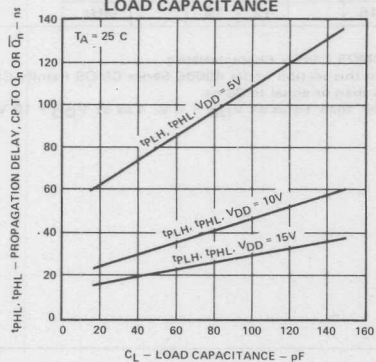
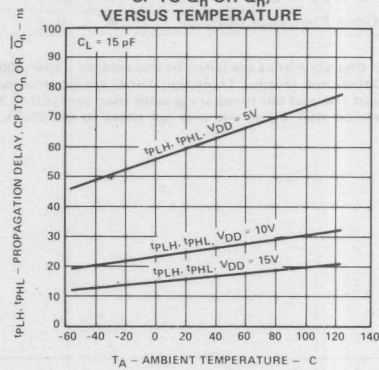
SWITCHING WAVEFORMS



MINIMUM PULSE WIDTHS FOR CP AND \overline{MR} ,
MR RECOVERY TIME, AND SET-UP AND HOLD TIMES, D_n TO CP

Note: Set-up and Hold Times are shown as positive values but may be specified as negative values.

TYPICAL ELECTRICAL CHARACTERISTICS

POWER DISSIPATION
VERSUS FREQUENCYPROPAGATION DELAY, CP TO Q_n OR \bar{Q}_n , VERSUS
LOAD CAPACITANCEPROPAGATION DELAY,
CP TO Q_n OR \bar{Q}_n ,
VERSUS TEMPERATURE

40192B/54/74C192 • 40193B/54/74C193

4-BIT UP/DOWN DECADE AND BINARY COUNTER

DESCRIPTION — The 40192B is a 4-Bit Synchronous Up/Down BCD Decade Counter and the 40193B is a 4-Bit Synchronous Up/Down Binary Counter. Both operate the same except for the count sequence. Both counters have a Count Up Clock Input (CP_U), a Count Down Clock Input (CP_D), an asynchronous Parallel Load Input (\overline{PL}), four Parallel Data Inputs (P_0 - P_3), an overriding asynchronous Master Reset (MR), four Counter Outputs (Q_0 - Q_3), a Terminal Count Up (Carry) Output ($\overline{TC_U}$) and a Terminal Count Down (Borrow) Output ($\overline{TC_D}$).

When the Master Reset Input (MR) is LOW and the Parallel Load Input (\overline{PL}) is HIGH, the Counter Outputs change state on the LOW-to-HIGH transition of either Clock Input. However, for correct counting, both Clock Inputs cannot be LOW simultaneously. With the Master Reset Input (MR) LOW, information on the Parallel Data Inputs (P_0 - P_3) is loaded into the counter when the Parallel Load Input (\overline{PL}) is LOW and stored in the counter when the Parallel Load Input (\overline{PL}) goes HIGH, independent of Clock Inputs (CP_U , CP_D). When HIGH, the Master Reset (MR) resets the counter independent of all other input conditions. See equations below for Terminal Count Outputs ($\overline{TC_U}$, $\overline{TC_D}$).

- TYPICAL COUNT FREQUENCY OF 8 MHz AT $V_{DD} = 10 V$
- SYNCHRONOUS OPERATION
- INTERNAL CASCADING CIRCUITRY PROVIDED
- ACTIVE LOW PARALLEL LOAD
- ACTIVE HIGH ASYNCHRONOUS MASTER RESET

PIN NAMES

\overline{PL}	Parallel Load Input (Active LOW)
P_0 - P_3	Parallel Data Inputs
CP_U	Count Up Clock Pulse Input (L→H Edge-Triggered)
CP_D	Count Down Clock Pulse Input (L→H Edge-Triggered)
MR	Master Reset Input (Asynchronous)
Q_0 - Q_3	Buffered Counter Outputs
$\overline{TC_U}$	Buffered Terminal Count Up (Carry) Output (Active LOW)
$\overline{TC_D}$	Buffered Terminal Count Down (Borrow) Output (Active LOW)

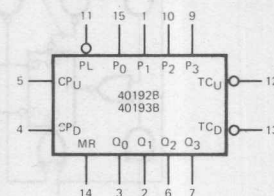
MODE SELECTION

(Both Counters)

MR	\overline{PL}	CP_U	CP_D	MODE
H	X	X	X	Reset (Asyn.)
L	L	X	X	Preset (Asyn.)
L	H	H	H	No Change
L	H	⌋	H	Count Up
L	H	H	⌋	Count Down

L = LOW Level
H = HIGH Level
X = Don't Care
⌋ = Positive-Going Clock Pulse Edge

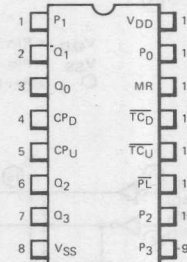
LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

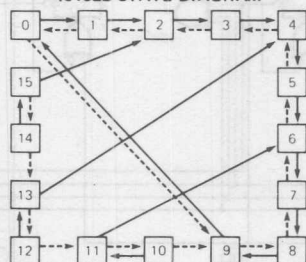
CONNECTION DIAGRAM

DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

40192B STATE DIAGRAM

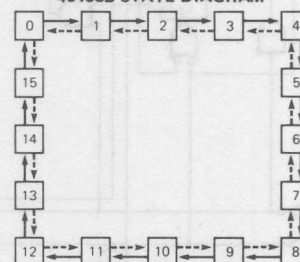


40192B LOGIC EQUATIONS FOR TERMINAL COUNT

$$\overline{TC_U} = Q_0 \cdot Q_3 \cdot \overline{CP_U}$$

$$\overline{TC_D} = \overline{Q_0} \cdot \overline{Q_1} \cdot \overline{Q_2} \cdot \overline{Q_3} \cdot \overline{CP_D}$$

40193B STATE DIAGRAM



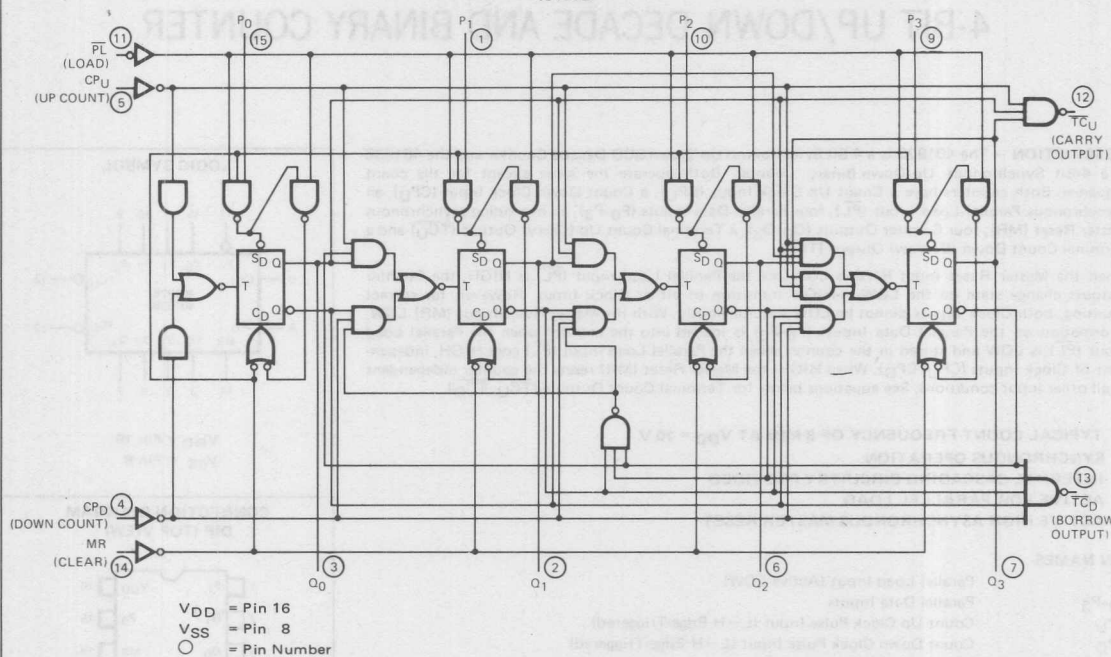
40193B LOGIC EQUATIONS FOR TERMINAL COUNT

$$\overline{TC_U} = Q_0 \cdot Q_1 \cdot Q_2 \cdot Q_3 \cdot \overline{CP_U}$$

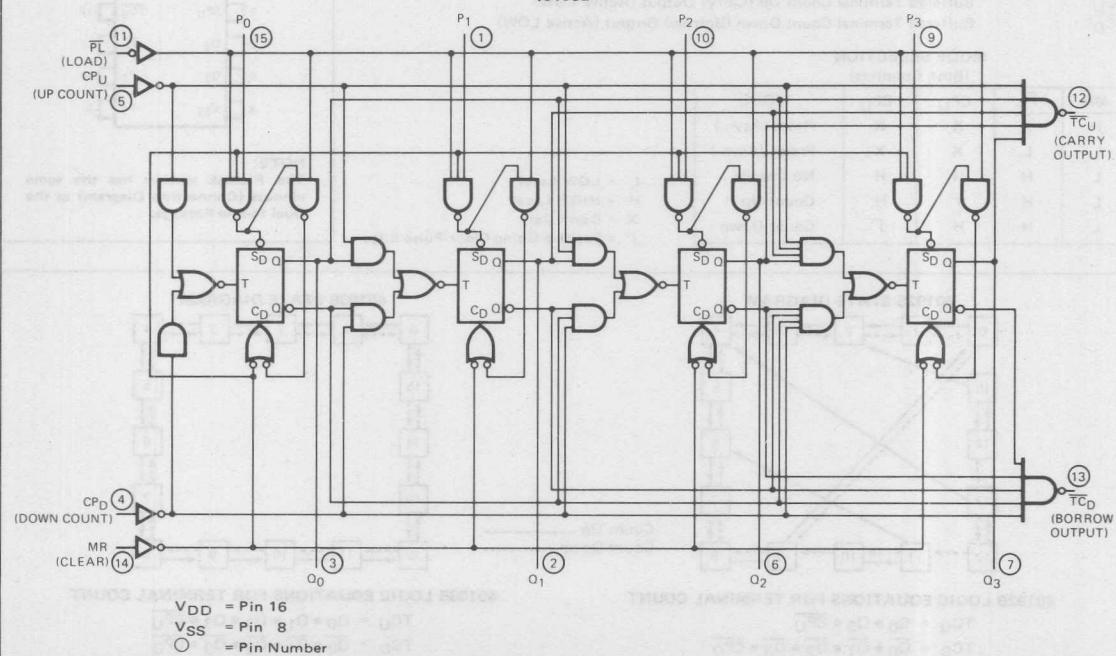
$$\overline{TC_D} = \overline{Q_0} \cdot \overline{Q_1} \cdot \overline{Q_2} \cdot \overline{Q_3} \cdot \overline{CP_D}$$

LOGIC DIAGRAMS

40192B



40193B



DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

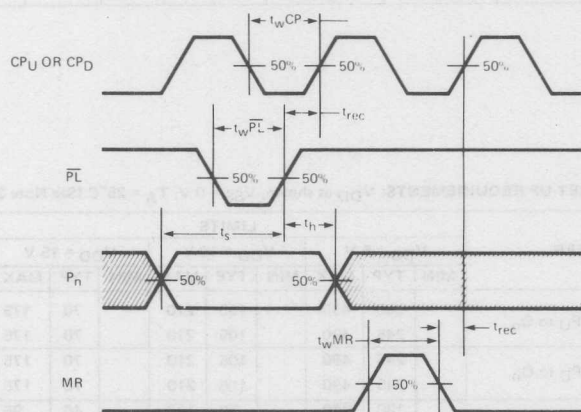
SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP _U to Q _n		245	490		105	210		70	175	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			245	490		105	210		70	175		
t _{PLH}	Propagation Delay, CP _D to Q _n		245	490		105	210		70	175	ns	
t _{PHL}			245	490		105	210		70	175		
t _{PLH}	Propagation Delay, CP _U to $\overline{TC_U}$		130	260		60	120		40	96	ns	
t _{PHL}			130	260		60	120		40	96		
t _{PLH}	Propagation Delay, CP _D to $\overline{TC_D}$		145	290		60	120		40	96	ns	
t _{PHL}			145	290		60	120		40	96		
t _{PHL}	Propagation Delay, MR to Q _n		270	540		120	240		80	192	ns	
PLH	Propagation Delay, MR to $\overline{TC_U}$ or $\overline{TC_D}$		370	740		170	340		105	270	ns	
t _{PLH}	Propagation Delay, \overline{PL} to Q _n		270	540		110	220		70	175	ns	
t _{PHL}			270	540		110	220		70	175		
t _{TLH}	Output Transition Time		55	135		30	75		20	45	ns	
t _{THL}			55	135		30	75		20	45		
t _{wCP}	Min. CP _U or CP _D Pulse Width	170	85		75	30		60	20		ns	
t _{wMR}	Minimum MR Pulse Width	180	60		80	30		64	20		ns	
t _{wPL}	Minimum \overline{PL} Pulse Width	150	75		85	25		52	20		ns	
t _{rec}	MR Recovery Time	150	75		65	30		52	20		ns	
t _{rec}	PL Recovery Time	150	75		65	30		52	20		ns	
t _s	Set-Up Time, P _n to \overline{PL}	170	85		75	30		60	20		ns	
t _h	Hold Time, P _n to \overline{PL}	0	-83		0	-28		0	-19			
f _{MAX}	Input Count Frequency (Note 3)	2	4		4	8		5	12		MHz	

Notes on following page.

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For t_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

SWITCHING WAVEFORMS



RECOVERY TIMES FOR \overline{PL} AND MR,
MINIMUM PULSE WIDTHS FOR CP_U , CP_D ,
 \overline{PL} AND MR AND SET-UP AND HOLD TIMES P_n TO \overline{PL}

NOTE: Set-up and Hold Times are shown as positive values but may be specified as negative values.

40194B

4-BIT BIDIRECTIONAL UNIVERSAL SHIFT REGISTER

DESCRIPTION — The 40194B is a 4-Bit Bidirectional Shift Register with two Mode Control Inputs (S_0, S_1), a Clock Input (CP), a Serial Data Shift Left Input (D_{SL}), a Serial Data Shift Right Input (D_{SR}), four Parallel Data Inputs (P_0-P_3), an overriding asynchronous Master Reset Input (MR) and four Buffered Parallel Outputs (Q_0-Q_3).

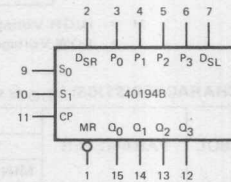
When LOW, the Master Reset Input (\overline{MR}) resets all stages and forces all Outputs (Q_0-Q_3) LOW, overriding all other input conditions. When the Master Reset Input (MR) is HIGH, the operating mode is controlled by the two Mode Control Inputs (S_0, S_1) as shown in the Truth Table. Serial and parallel operation is edge-triggered on the LOW-to-HIGH transition of the Clock Input (CP). The inputs at which the data is to be entered and the Mode Control Inputs (S_0, S_1) must be stable for a set-up time before the LOW-to-HIGH transition of the Clock Input CP).

- TYPICAL SHIFT FREQUENCY OF 14 MHz AT $V_{DD} = 10\text{ V}$
- ASYNCHRONOUS MASTER RESET
- HOLD (DO NOTHING) MODE
- FULLY SYNCHRONOUS SERIAL OR PARALLEL DATA TRANSFERS
- POSITIVE EDGE-TRIGGERED CLOCK

PIN NAMES

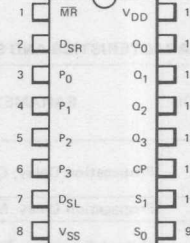
S_0, S_1	Mode Control Inputs
P_0-P_3	Parallel Data Inputs
D_{SR}	Serial (Shift Right) Data Input
D_{SL}	Serial (Shift Left) Data Input
CP	Clock Input (L→H Edge-Triggered)
\overline{MR}	Master Reset Input (Active LOW)
Q_0-Q_3	Parallel Outputs

LOGIC SYMBOL



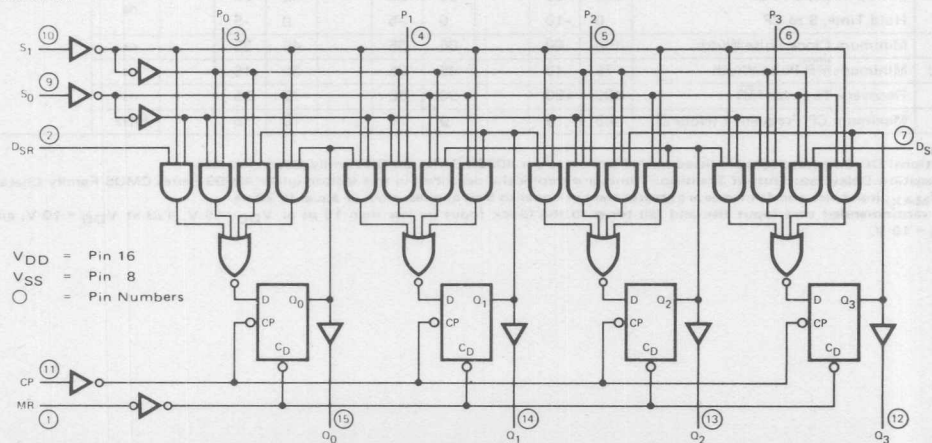
V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

LOGIC DIAGRAM



FAIRCHILD CMOS • 40194B

TRUTH TABLE

OPERATING MODE	INPUTS (MR = H)					OUTPUTS AT t_{n+1}			
	S ₁	S ₀	DSR	DSL	P ₀ ,P ₁ ,P ₂ ,P ₃	Q ₀	Q ₁	Q ₂	Q ₃
Hold	L	L	X	X	X	Q ₀	Q ₁	Q ₂	Q ₃
Shift Left	H	L	X	L	X	Q ₁	Q ₂	Q ₃	L
	H	L	X	H	X	Q ₁	Q ₂	Q ₃	H
Shift Right	L	H	L	X	X	L	Q ₀	Q ₁	Q ₂
	L	H	H	X	X	H	Q ₀	Q ₁	Q ₂
Parallel Load	H	H	X	X	L	L	L	L	L
	H	H	X	X	H	H	H	H	H

H = HIGH Voltage Level
L = LOW Voltage Level

X = Don't Care

(t_{n+1}) = Indicates state after next LOW-to-HIGH clock transition.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (see Note 1)														
SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			$V_{DD} = 5$ V			$V_{DD} = 10$ V			$V_{DD} = 15$ V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I_{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C MAX	All inputs at 0 V or V_{DD}
					150			300			600			
	Supply Current	XM			5			10			20	μA	MIN, 25°C MAX	
					150			300			600			

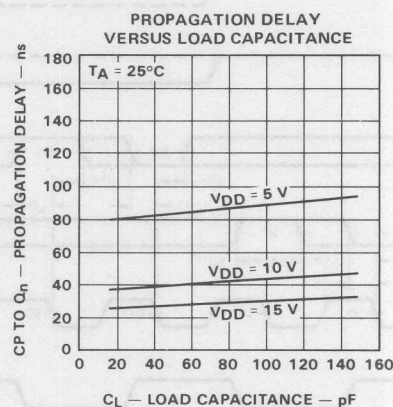
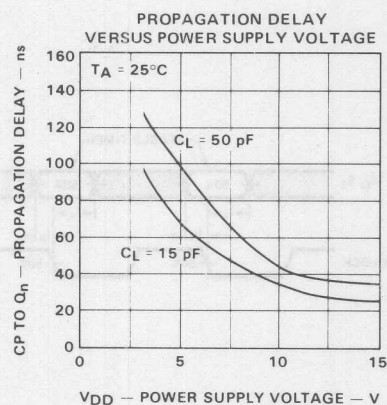
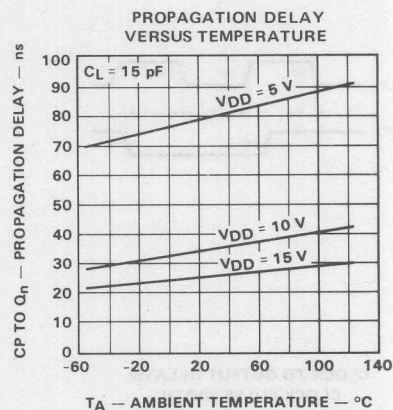
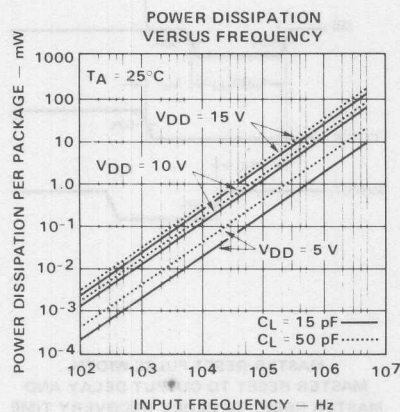
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q		100	180		45	80		35	64	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}	Propagation Delay, \overline{MR} to Q		100	180		45	80		35	64	ns	
t _{THL}	Output Transition Time		75	135		40	70		25	45	ns	
t _{TLH}			75	135		40	70		25	45	ns	
t _s	Set-Up Time, P ₀ -P ₃ , D _{SL} , D _{SR} to CP	80	40		40	20		32	15		ns	
t _h	Hold Time, P ₀ -P ₃ , D _{SL} , D _{SR} to CP	0	-10		0	-5		0	-5		ns	
t _s	Set-Up Time, S to CP	100	60		50	30		40	20		ns	
t _h	Hold Time, S to CP	0	-10		0	-5		0	-5		ns	
t _{wCP(L)}	Minimum Clock Pulse Width	100	60		60	35		48	25		ns	
t _{wMR(L)}	Minimum MR Pulse Width	75	40		45	25		36	15		ns	
t _{rec}	Recovery Time for MR	180	100		90	50		72	35		ns	
f _{MAX}	Maximum CP Frequency (Note 3)	4.5	9		9	14		10	16		MHz	

NOTES:

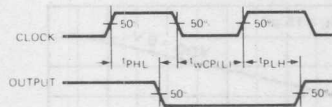
1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For t_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

TYPICAL ELECTRICAL CHARACTERISTICS



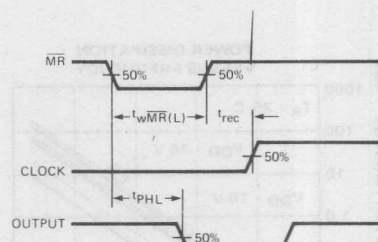
SWITCHING TIME WAVEFORMS

The shaded areas indicate when the input is permitted to change for predictable output performance.



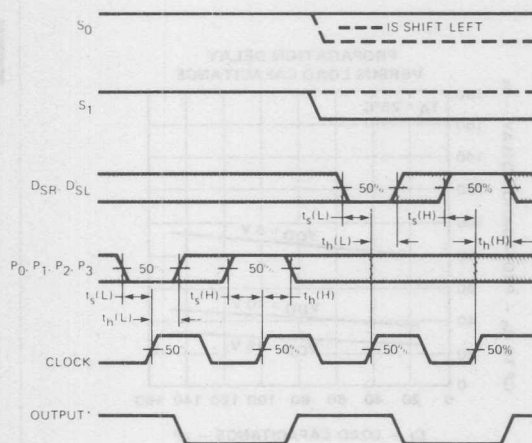
CLOCK TO OUTPUT DELAYS
CLOCK PULSE WIDTH

OTHER CONDITIONS: $S_1 = L, \overline{MR} = H, S_0 = H$



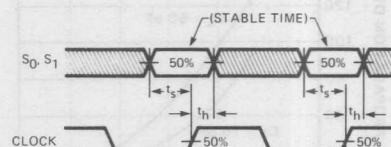
MASTER RESET PULSE WIDTH,
MASTER RESET TO OUTPUT DELAY AND
MASTER RESET TO CLOCK RECOVERY TIME

OTHER CONDITIONS: $S_0, S_1 = H$
 $P_0 = P_1 = P_2 = P_3 = H$



SET-UP (t_s) AND HOLD (t_h) TIME FOR SERIAL
DATA (D_{SR}, D_{SL}) AND PARALLEL DATA (P_0, P_1, P_2, P_3)

OTHER CONDITIONS: $\overline{MR} = H$
* D_{SR} Set up Time Affects Q_0 Only
 D_{SL} Set up Time Affects Q_3 Only



SET-UP (t_s) AND HOLD (t_h) TIME FOR S INPUT

OTHER CONDITIONS: $\overline{MR} = H$

40195B/74C195/54C195

4-BIT UNIVERSAL SHIFT REGISTER

DESCRIPTION — The 40195B is a fully synchronous edge-triggered 4-Bit Shift Register with a Clock Input (CP), four synchronous Parallel Data Inputs (P_0 - P_3), two synchronous Serial Data Inputs (J, K), a synchronous Mode Control Input (PE), Buffered Outputs from all four bit positions (Q_0 - Q_3), a Buffered Inverted Output from the last bit position (\bar{Q}_3) and an overriding asynchronous Master Reset Input (MR).

Operation is synchronous (except for Master Reset) and is edge-triggered on the LOW-to-HIGH transition of the Clock Input (CP). When the Mode Control Input (PE) is LOW, a LOW-to-HIGH clock transition loads data into the register from Parallel Data Inputs (P_0 - P_3). When the Mode Control Input (PE) is HIGH, a LOW-to-HIGH clock transition shifts data into the first register position from the Serial Data Inputs (J, K), and shifts all the data in the register one position to the right. D-type entry is obtained by tying the two Serial Data Inputs (J, K) together. A LOW on the Master Reset Input (MR) resets all four bit positions (Q_0 - Q_3 = LOW, \bar{Q}_3 = HIGH) independent of all other input conditions.

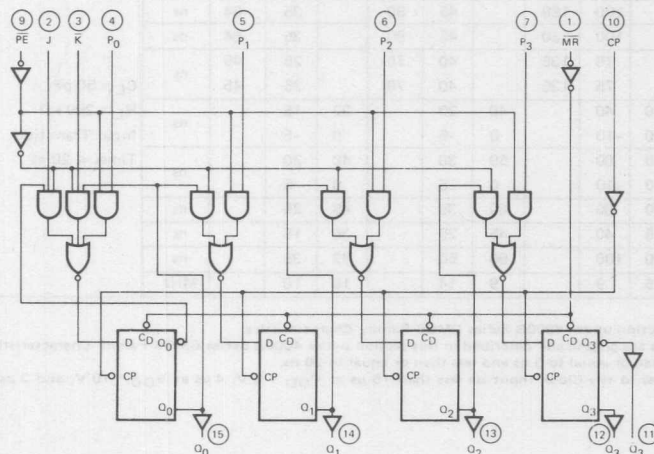
The 40195B is a direct replacement for the 74C195/54C195.

- TYPICAL SHIFT FREQUENCY OF 14 MHz AT V_{DD} = 10 V
- ASYNCHRONOUS MASTER RESET
- J, \bar{K} INPUTS TO THE FIRST STAGE
- FULLY SYNCHRONOUS SERIAL OR PARALLEL DATA TRANSFERS
- COMPLEMENTARY OUTPUT FROM THE LAST STAGE
- POSITIVE EDGE-TRIGGERED CLOCK

PIN NAMES

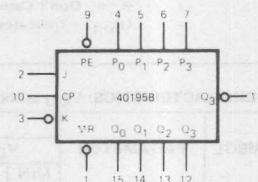
PE	Parallel Enable Input (Active LOW)
P_0 - P_3	Parallel Data Inputs
J	First Stage J Input (Active HIGH)
K	First Stage K Input (Active LOW)
CP	Clock Input (L → H Edge-Triggered)
MR	Master Reset Input (Active LOW)
Q_0 - Q_3	Parallel Outputs
\bar{Q}_3	Complementary Last Stage Output

LOGIC DIAGRAM



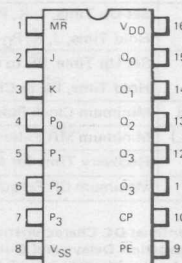
V_{DD} = Pin 16
 V_{SS} = Pin 8
 ○ = Pin Numbers

LOGIC SYMBOL



V_{DD} = Pin 16
 V_{SS} = Pin 8

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
 The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD CMOS • 40195B/74C195/54C195

TRUTH TABLE

OPERATING MODE	INPUTS (MR = H)							OUTPUTS AT t_{n+1}				
	PE	J	K	P ₀	P ₁	P ₂	P ₃	Q ₀	Q ₁	Q ₂	Q ₃	\bar{Q}_3
Shift Mode	H	L	L	X	X	X	X	L	Q ₀	Q ₁	Q ₂	\bar{Q}_2
	H	L	H	X	X	X	X	Q ₀	Q ₀	Q ₁	Q ₂	\bar{Q}_2
	H	H	L	X	X	X	X	\bar{Q}_0	Q ₀	Q ₁	Q ₂	\bar{Q}_2
	H	H	H	X	X	X	X	H	Q ₀	Q ₁	Q ₂	\bar{Q}_2
Parallel Entry Mode	L	X	X	L	L	L	L	L	L	L	L	H
	L	X	X	H	H	H	H	H	H	H	H	L

H = HIGH Voltage Level

L = LOW Voltage Level

X = Don't Care

(t_{n+1}) = Indicates state after next LOW to HIGH clock transition.

DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER		LIMITS									UNITS	TEMP	TEST CONDITIONS
			V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V					
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I _{DD}	Quiescent Power	XC			20			40			80	μA	MIN, 25°C	All inputs at 0 V or V _{DD}
					150			300			600		MAX	
	Supply Current	XM			5			10			20	μA	MIN, 25°C	
					150			300			600		MAX	

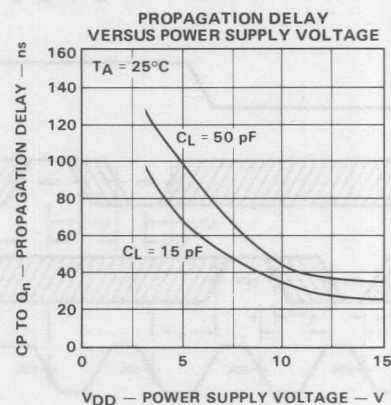
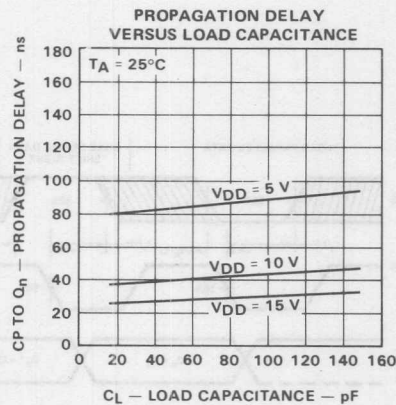
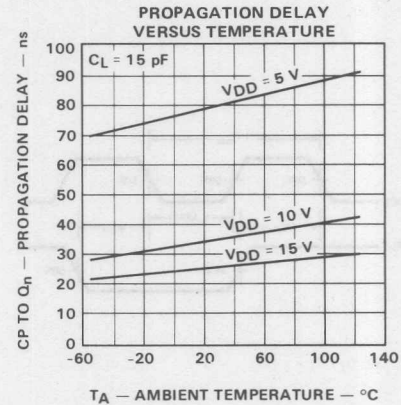
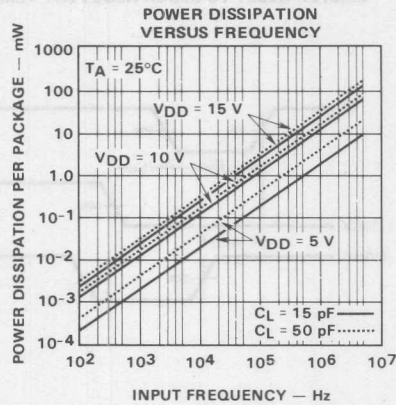
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ\text{C}$ (See Note 2)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		V _{DD} = 5 V			V _{DD} = 10 V			V _{DD} = 15 V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t _{PLH}	Propagation Delay, CP to Q _n or \bar{Q}_3		100	180		45	80		35	64	ns	C _L = 50 pF, R _L = 200 kΩ Input Transition Times ≤ 20 ns
t _{PHL}			100	180		45	80		35	64		
t _{PHL}	Propagation Delay, MR to \bar{Q}_3		100	180		45	80		35	64	ns	
t _{PHL}	Propagation Delay, MR to Q _n		100	180		45	80		35	64	ns	
t _{THL}	Output Transition Time		75	135		40	70		25	45	ns	
t _{TLH}			75	135		40	70		25	45		
t _s	Set-Up Time, J, K, P ₀ -P ₃ to CP	80	40		40	20		32	15		ns	
t _h	Hold Time, J, K, P ₀ -P ₃ to CP	0	-10		0	-5		0	-5			
t _s	Set-Up Time, $\bar{P}E$ to CP	100	60		50	30		40	20		ns	
t _h	Hold Time, $\bar{P}E$ to CP	0	-10		0	-5		0	-5			
t _{wCP(L)}	Minimum Clock Pulse Width	100	60		60	35		48	25		ns	
t _{wMR(L)}	Minimum MR Pulse Width	75	40		45	25		36	15		ns	
t _{rec}	Recovery Time for MR	180	100		90	50		72	35		ns	
f _{MAX}	Maximum CP Frequency (Note 3)	4.5	9		9	14		10	16		MHz	

NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
3. For f_{MAX} , input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

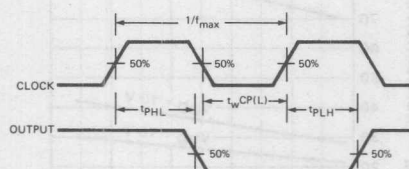
TYPICAL ELECTRICAL CHARACTERISTICS



SWITCHING TIME WAVEFORMS

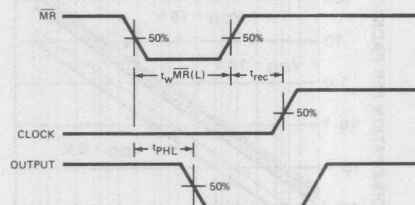
The shaded areas indicate when the input is permitted to change for predictable output performance.

CLOCK TO OUTPUT DELAYS AND CLOCK PULSE WIDTH



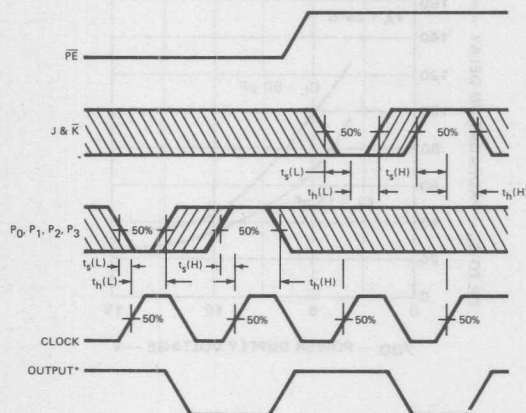
OTHER CONDITIONS: $J = \overline{PE} = \overline{MR} = \text{HIGH}$
 $\overline{K} = L \text{ \& W}$

MASTER RESET PULSE WIDTH, MASTER RESET TO OUTPUT DELAY AND MASTER RESET TO CLOCK RECOVERY TIME



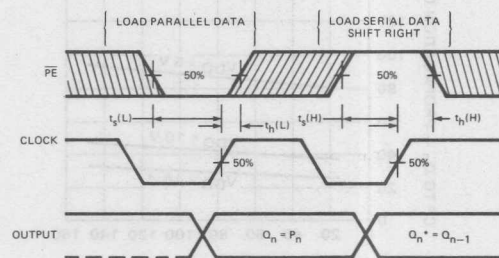
OTHER CONDITIONS: $\overline{PE} = \text{LOW}$
 $P_0 = P_1 = P_2 = P_3 = \text{HIGH}$

SET-UP (t_s) AND HOLD (t_h) TIME FOR SERIAL DATA (J & K) AND PARALLEL DATA (P_0, P_1, P_2, P_3)



OTHER CONDITIONS: $\overline{MR} = \text{HIGH}$
 *J & K Set-up Time Affects Q_0 Only

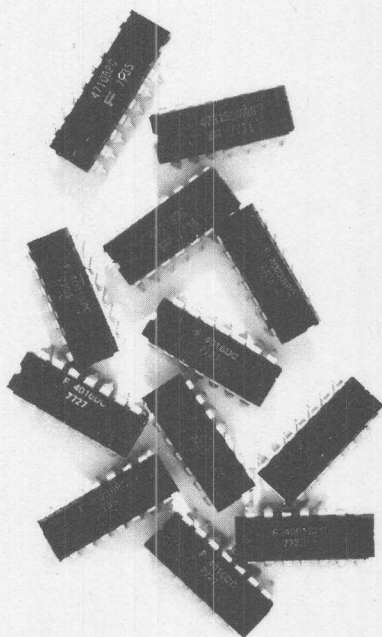
SET-UP (t_s) AND HOLD (t_h) TIME FOR \overline{PE} INPUT



OTHER CONDITIONS: $\overline{MR} = \text{HIGH}$
 * Q_0 State will be Determined by J & K Inputs

NOTE:

Set-up Times (t_s) and Hold Times (t_h) are shown as positive values but may be specified as negative values.



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INTERFACE CIRCUITS FOR CMOS

Fairchild manufactures one of the broadest varieties of Integrated Circuits in the world. In an effort to aid the designer in his search for compatible interface alternatives, listed below are a number of circuits manufactured by different divisions of Fairchild Semiconductor and easily compatible with the Fairchild line of Isoplanar CMOS.

Fairchild F54LSXX/74LSXX LOW POWER SCHOTTKY TTL

(Reference: Fairchild Low Power Schottky Data Book and Fairchild Low Power Schottky Designer's Guide)

When Multi-TTL drive capability is required, the CMOS 4049B and 4050B Hex Buffers can be used to drive two standard TTL Loads with typical delay of 45 ns ($V_{DD} = 5V$). These devices, because of the deletion of the V_{DD} input diode, allow High Voltage CMOS to 5 Volt TTL translation. For higher performance and additional drive capability each of the following Fairchild Low Power Schottky devices may be used as interface/logic translating elements with capability of driving up to five standard TTL Loads. Although the Low Power Schottky devices must be operated from a 5 V TTL supply, they can accept input voltages up to 15 V, allowing direct interface with CMOS operated up to 15 V.

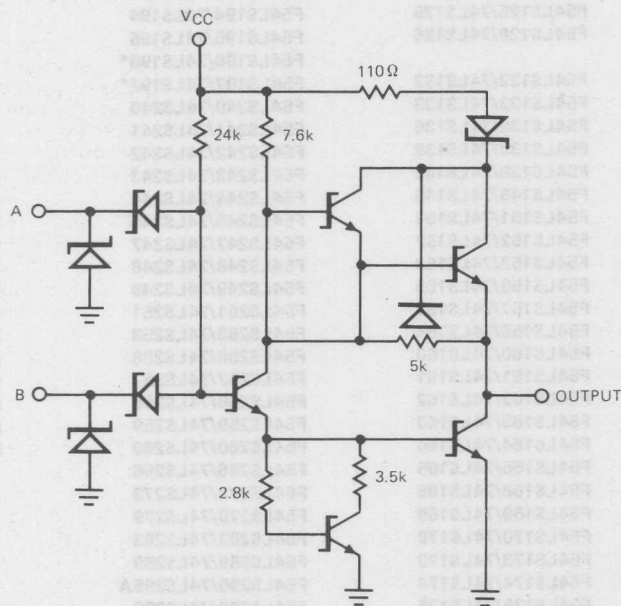
F54LS00/74LS00	F54LS85/74LS85	F54LS189/74LS189	F54LS352/74LS352
F54LS02/74LS02	F54LS86/74LS86	F54LS190/74LS190	F54LS353/74LS353
F54LS04/74LS04	F54LS89/74LS89	F54LS191/74LS191	F54LS365/74LS365
F54LS08/74LS08	F54LS95/74LS95B	F54LS192/74LS192	F54LS366/74LS366
F54LS09/74LS09	F54LS107/74LS107	F54LS193/74LS193	F54LS367/74LS367
F54LS10/74LS10	F54LS125/74LS125	F54LS194/74LS194	F54LS368/74LS368
F54LS11/74LS11	F54LS126/74LS126	F54LS195/74LS195	F54LS373/74LS373
		F54LS196/74LS196*	
F54LS13/74LS13	F54LS132/74LS132	F54LS197/74LS197*	F54LS374/74LS374
F54LS14/74LS14	F54LS133/74LS133	F54LS240/74LS240	F54LS375/74LS375
F54LS15/74LS15	F54LS136/74LS136	F54LS241/74LS241	F54LS377/74LS377
F54LS20/74LS20	F54LS138/74LS138	F54LS242/74LS242	F54LS378/74LS378
F54LS21/74LS21	F54LS139/74LS139	F54LS243/74LS243	F54LS379/74LS379
F54LS27/74LS27	F54LS145/74LS145	F54LS244/74LS244	F54LS386/74LS386
F54LS28/74LS28	F54LS151/74LS151	F54LS245/74LS245	F54LS395/74LS395
F54LS30/74LS30	F54LS152/74LS152	F54LS247/74LS247	F54LS398/74LS398
F54LS32/74LS32	F54LS153/74LS153	F54LS248/74LS248	F54LS399/74LS399
F54LS33/74LS33	F54LS155/74LS155	F54LS249/74LS249	F54LS502/74LS502
F54LS37/74LS37	F54LS157/74LS157	F54LS251/74LS251	F54LS540/74LS540
F54LS38/74LS38	F54LS158/74LS158	F54LS253/74LS253	F54LS541/74LS541
F54LS40/74LS40	F54LS160/74LS160	F54LS256/74LS256	F54LS568/74LS568
F54LS42/74LS42	F54LS161/74LS161	F54LS257/74LS257	F54LS569/74LS569
F54LS47/74LS47	F54LS162/74LS162	F54LS258/74LS258	F54LS573/74LS573
F54LS48/74LS48	F54LS163/74LS163	F54LS259/74LS259	F54LS574/74LS574
F54LS49/74LS49	F54LS164/74LS164	F54LS260/74LS260	F54LS670/74LS670
F54LS51/74LS51	F54LS165/74LS165	F54LS266/74LS266	
F54LS54/74LS54	F54LS168/74LS168	F54LS273/74LS273	
F54LS55/74LS55	F54LS169/74LS169	F54LS279/74LS279	
F54LS73/74LS73	F54LS170/74LS170	F54LS283/74LS283	
F54LS75/74LS75	F54LS173/74LS173	F54LS289/74LS289	
F54LS76/74LS76	F54LS174/74LS174	F54LS295/74LS295A	
F54LS77/74LS77	F54LS175/74LS175	F54LS298/74LS298	
F54LS78/74LS78	F54LS181/74LS181	F54LS299/74LS299	
F54LS83/74LS83A	F54LS182/74LS182	F54LS323/74LS323	

*Except For Clock Inputs.

INTERFACE CIRCUITS FOR CMOS

Fairchild Low Power Schottky devices also incorporate a unique Schottky Diode in series with the collector of the output transistor. This diode allows the output to be pulled substantially higher than V_{CC} . Although the Low Power Schottky devices must be operated from a 5 V TTL supply, a simple external pullup resistor between the LS output and the CMOS V_{DD} power supply will allow direct interface between Low Power Schottky Logic ($V_{CC} = 5$ V) and high voltage CMOS logic, up to $V_{DD} = 10$ V. With the exception of the F74LS00, F74LS02, F74LS04, F74LS10, F74LS11, F74LS20, and the F74LS32, each of the devices listed above will perform the low voltage to high voltage translation.

**FAIRCHILD LOW POWER SCHOTTKY
2-Input NAND Gate**



75491 • 75492

MOS TO LED SEGMENT AND DIGIT DRIVERS

(Reference: Fairchild Linear Integrated Circuits Data Book)

The 75491 and 75491A, LED Quad Segment Digit Drivers interface MOS signals to common cathode LED displays. High output current capability makes the devices ideal in time multiplex systems using segment address or digit scan method of driving LEDs to minimize the number of drivers required.

The 75492 and 75492A Hex LED/Lamp Drivers convert MOS signals to high output currents for LED display digit select or lamp select. The high output current capability makes the devices ideal in time multiplex systems using segment address or digit scan method of driving LEDs to minimize the number of drivers required.

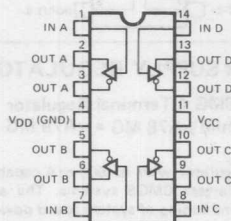
75491 • 75491A

- 50 mA SOURCE OR SINK CAPABILITY
- LOW INPUT CURRENTS FOR CMOS COMPATIBILITY
- LOW STANDBY POWER
- FOUR HIGH GAIN DARLINGTON CIRCUITS
- 10 V and 20 V OPERATION

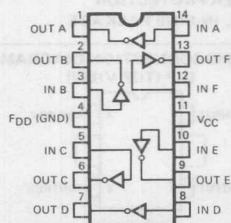
75492 • 75492A

- 250 mA SINK CAPABILITY
- CMOS COMPATIBLE INPUTS
- LOW STANDBY POWER
- SIX HIGH GAIN DARLINGTON CIRCUITS
- 10 V AND 20 V OPERATION

75491 • 75491A
CONNECTION DIAGRAM
(TOP VIEW)



75492 • 75492A
CONNECTION DIAGRAM
(TOP VIEW)



9665 • 9667 • 9668

HIGH VOLTAGE HIGH CURRENT DARLINGTON DRIVERS

(Reference: Fairchild 9665 • 9666 • 9667 • 9668 Data Sheet)

The 9665, 9667 and 9668 are comprised of seven high voltage, high current npn Darlington Transistor pairs. All units feature common emitter, open collector outputs. To maximize their effectiveness, these units contain suppression diodes for inductive loads and appropriate emitter-base resistors for leakage.

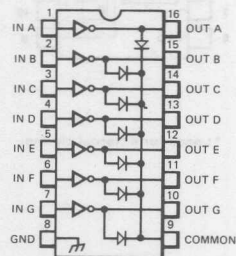
The 9665 is a general purpose array which may be used with DTL, TTL, PMOS, CMOS, etc. Input current limiting is done by connecting an appropriate discrete resistor to each input.

The 9667 has a series base resistor to each Darlington pair, thus allowing operation directly with TTL or CMOS operating at supply voltages of 5 V.

The 9668 has an appropriate input resistor to allow direct operation from CMOS or PMOS outputs operating at supply voltages of 6 to 15 V.

- SEVEN HIGH GAIN DARLINGTON TRANSISTOR PAIRS
- HIGH OUTPUT VOLTAGE ($V_{CE} = 50 \text{ V}$)
- HIGH OUTPUT CURRENT ($I_C \approx 350 \text{ mA}$)
- CMOS COMPATIBLE INPUTS
- SUPPRESSION DIODES FOR INDUCTIVE LOADS
- 2 WATT PLASTIC DIP PACKAGE ON COPPER PIN FRAME

9665 • 9667 • 9668
CONNECTION DIAGRAM
(TOP VIEW)



96L02

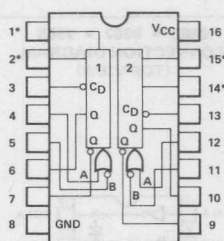
LOW POWER DUAL ONE-SHOT MULTIVIBRATOR

Retriggerable Resettable Monostable Multivibrator
(Reference: Fairchild Low Power TTL Book)

The 96L02 is pin and function compatible with the F4528 Dual Monostable and exhibits improved stability and speed. It is usable in 5 V CMOS systems.

- TYPICAL POWER DISSIPATION OF 25 mW/ONE SHOT
- 50 ns TYPICAL PROPAGATION DELAY
- RETRIGGERABLE 0 TO 100% DUTY CYCLE
- FAIRCHILD 4000B COMPATIBLE INPUTS
- OPTIONAL RETRIGGER LOCK-OUT CAPABILITY
- PULSE WIDTH COMPENSATED FOR V_{CC} AND TEMPERATURE VARIATIONS
- RESETTABLE

96L02 LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



* Leads for external timing

μ A775

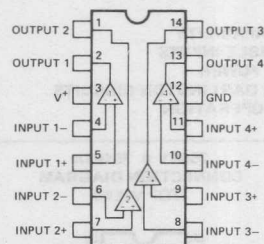
QUAD COMPARATOR VOLTAGE COMPARATOR

(Reference: Fairchild μ A775 Data Sheet)

In a CMOS system it may be necessary to detect differences between two voltage levels and convert to logic levels. The μ A775 Quad Comparator is capable of operating over the CMOS power supply range. These comparators have a unique characteristic in that the input common mode voltage range includes ground, even though operated from a single power supply voltage. Applications include limit comparators, simple analog to digital converters; pulse, squarewave and time delay generators and wide range V_{CO} .

- SINGLE SUPPLY OPERATION—+2.0 V TO +36 V
- COMPARES VOLTAGES NEAR GROUND POTENTIAL
- LOW CURRENT DRAIN—700 μ A TYPICAL
- COMPATIBLE WITH ALL FORMS OF CMOS
- LOW INPUT BIAS CURRENT—25 nA TYPICAL
- LOW INPUT OFFSET CURRENT—25 nA
- LOW OFFSET VOLTAGE—5 mV MAX

LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



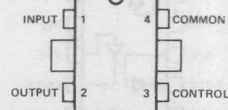
POWER SUPPLY REGULATOR

μ A78MG 4-Terminal Regulator
(Reference: Fairchild μ A78 MG • μ A79 MG Data Sheet)

This single compact regulator with its 500 mA capability is sufficient for all but the very largest CMOS systems. The adjustable output voltage feature allows fine tuning of system speed power product.

- OUTPUT CURRENT IN EXCESS OF 0.5 A
- POSITIVE OUTPUT VOLTAGE 5 TO 30 V
- INTERNAL THERMAL OVERLOAD PROTECTION
- INTERNAL SHORT CIRCUIT CURRENT PROTECTION
- OUTPUT SAFE AREA PROTECTION
- POWER MINI DUAL IN-LINE PACKAGE

μ A78 MG CONNECTION DIAGRAM
DIP (TOP VIEW)



NOTE: Heat sink tabs connected to common

9664

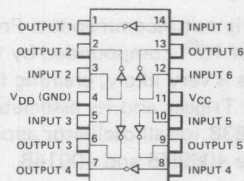
MOS TO LED DIGIT DRIVER

(Reference: Fairchild 9664 Data Sheet)

This driver is ideal for driving high current devices such as LEDs, relays and lamps. High input impedance allows direct drive from Fairchild 4000B CMOS devices; however, there is some degradation in logic level at the CMOS output. The 9664 is specified to 10 V operation, the 9664A to 20 V.

- 150 mA SINK CAPABILITY
- CMOS COMPATIBLE INPUTS
- VERY LOW STANDBY POWER
- SIX HIGH GAIN DARLINGTON CIRCUITS
- 10 AND 20 V OPERATION

9664/9664A LOGIC AND CONNECTION DIAGRAM
DIP (TOP VIEW)



9374

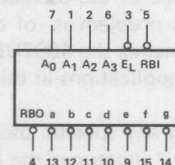
DECODER/DRIVER/LATCH CMOS TO 7-SEGMENT LED DISPLAY

(Reference: Fairchild 9374 Data Sheet)

This bipolar device contains latches for storage, a 7-segment decoder and 15 mA constant current drivers. The 9374 must operate at 5 V; its inputs are also limited to 5 V.

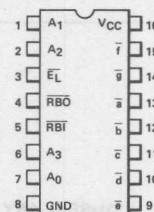
- FAIRCHILD 4000B SERIES COMPATIBLE INPUTS
- HIGH-SPEED INPUT LATCHES FOR DATA STORAGE
- 15 mA CONSTANT CURRENT SINK CAPABILITY TO DIRECTLY DRIVE COMMON ANODE LED DISPLAYS
- INCREASES INCANDESCENT DISPLAY LIFE
- DATA INPUT LOADING ESSENTIALLY ZERO WHEN LATCH DISABLED
- AUTOMATIC RIPPLE BLANKING FOR SUPPRESSION OF LEADING EDGE ZEROS AND/OR TRAILING EDGE ZEROS

9374
LOGIC SYMBOL



V_{CC} = Pin 16
GND = Pin 8

9374
CONNECTION DIAGRAM
DIP (TOP VIEW)



CMOS OSCILLATORS

This application note describes several square-wave oscillator circuits implemented with standard CMOS gates. In each case, appropriate timing equations, simplifying assumptions, and advantages and disadvantages are listed.

In general, because of the characteristically high input impedance of CMOS logic elements, more cost effective oscillators can be constructed offering relatively large timing constants without large capacitors. In addition, the CMOS oscillator offers:

- Very low power dissipation
- Operation over a wide power supply voltage range of 3 to 15 volts
- Operation over a frequency range of less than 1 Hz to over 23 MHz
- Easy interface to other logic families
- Relatively good stability with respect to variations in power supply voltage and operating temperature range

Generally, the use of buffered CMOS gates in oscillator applications is not recommended. Problems occur because of excessive gain through the buffered element (in excess of 10^6) compounded by the slow edge rates, characteristic of the oscillator circuit. Ringing at the thresholds is very likely, creating false clocks in the system. This problem is, of course, overcome with the Schmitt Trigger and its associated hysteresis. Fairchild recommends the 4007UB, 4069UB, 40014B, 4093B and 4583B for all oscillator applications. For simplification, all applications in this note will be implemented using the 4069UB and 40014B.

Before describing any specific oscillator circuits and in an effort to clear some confusion and a few misconceptions, *Figure 1* illustrates the basic logical oscillator. Any odd number of inverting logic elements will oscillate naturally when connected in a ring as shown in *Figure 1*. This is easily seen by treating the inverters as ideal switches or inverters exhibiting finite propagation delays and ideal switching characteristics. The basic result is that a HIGH logic level chases itself around the ring. In this case the frequency of oscillation is dependent upon the total propagation delay through the ring and is given by:

$$f = \frac{1}{2nT_p} \quad \text{where:}$$

- f = frequency of oscillation (Hz)
 n = number of inverting gates in the ring
 T_p = propagation delay per gate (seconds)

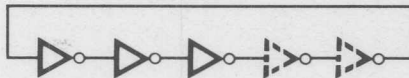
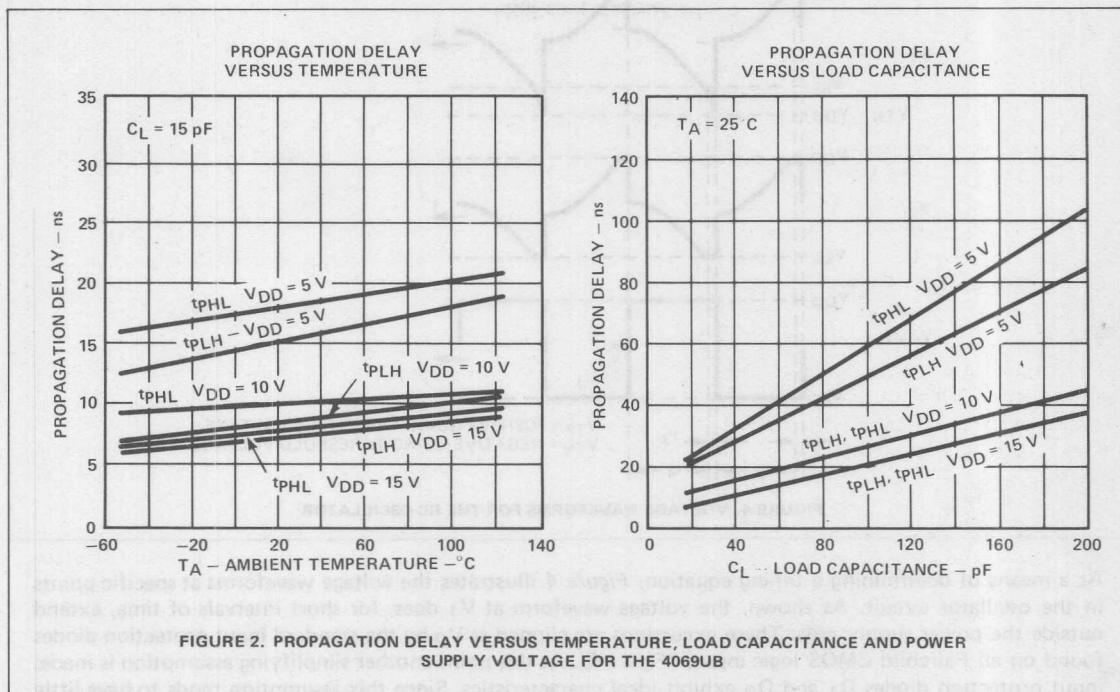


FIGURE 1. ANY ODD NUMBER OF INVERTING GATES WILL ALWAYS OSCILLATE

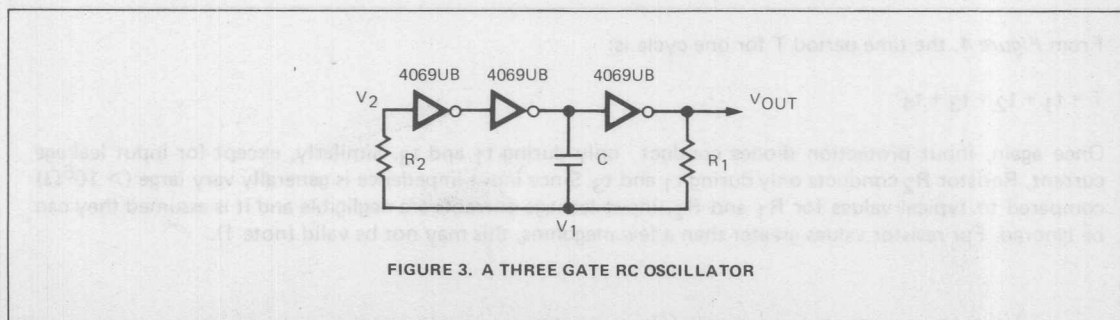
The practicality of such a circuit is limited by the fact that the frequency of oscillation is dependent upon T_P and therefore limited to a few specific values determined by T_P . Furthermore, stability of such a circuit is heavily dependent upon T_P 's variation with temperature, power supply voltage and output loading. Figure 2 illustrates expected variations in propagation delay for the 4069UB.

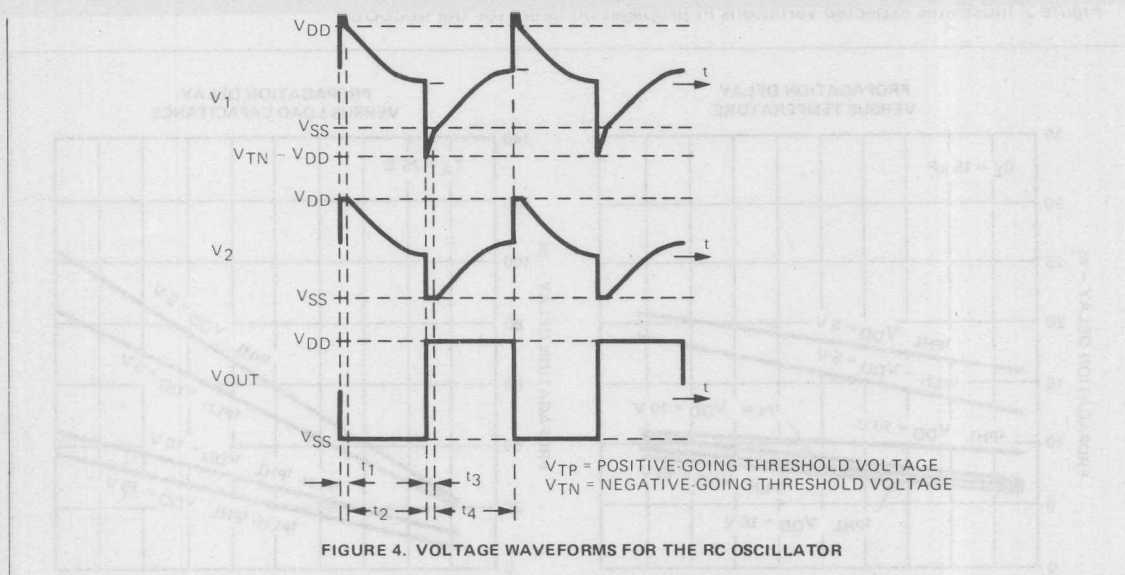


The Logical RC Oscillator

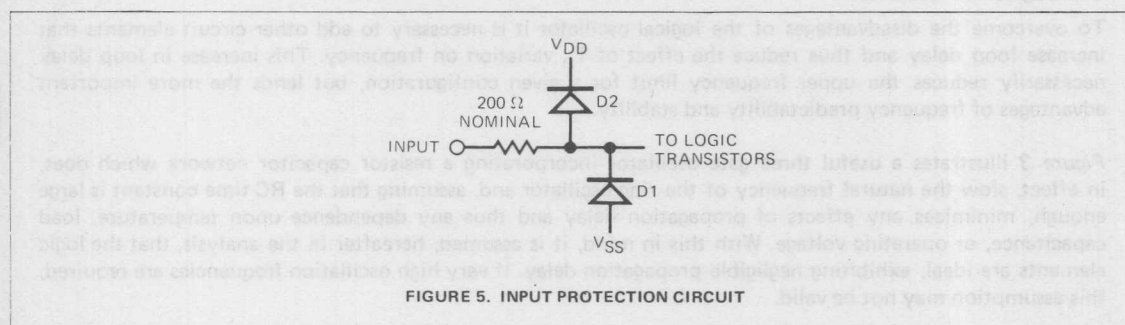
To overcome the disadvantages of the logical oscillator it is necessary to add other circuit elements that increase loop delay and thus reduce the effect of T_P variation on frequency. This increase in loop delay necessarily reduces the upper frequency limit for a given configuration, but lends the more important advantages of frequency predictability and stability.

Figure 3 illustrates a useful three gate oscillator incorporating a resistor capacitor network which does, in effect, slow the natural frequency of the ring oscillator and, assuming that the RC time constant is large enough, minimizes any effects of propagation delay and thus any dependence upon temperature, load capacitance, or operating voltage. With this in mind, it is assumed, hereafter in the analysis, that the logic elements are ideal, exhibiting negligible propagation delay. If very high oscillation frequencies are required, this assumption may not be valid.





As a means of determining a timing equation, *Figure 4* illustrates the voltage waveforms at specific points in the oscillator circuit. As shown, the voltage waveform at V_1 does, for short intervals of time, extend outside the power supply rails. These excursions are clipped at V_2 by the standard input protection diodes found on all Fairchild CMOS logic inputs (*Figure 5*). At this point another simplifying assumption is made; input protection diodes D_1 and D_2 exhibit ideal characteristics. Since this assumption tends to have little overall effect on the voltage waveforms, the error is acceptably small.



From *Figure 4*, the time period T for one cycle is:

$$T = t_1 + t_2 + t_3 + t_4$$

Once again, input protection diodes conduct only during t_1 and t_3 . Similarly, except for input leakage current, Resistor R_2 conducts only during t_1 and t_3 . Since input impedance is generally very large ($> 10^6 \Omega$) compared to typical values for R_1 and R_2 , input leakage currents are negligible and it is assumed they can be ignored. For resistor values greater than a few megohms, this may not be valid (note 1).

From basic electronics, the timing equation for exponential decay of an RC network (Figure 6) is.

$$t = -RC \ln (v/V_O)$$

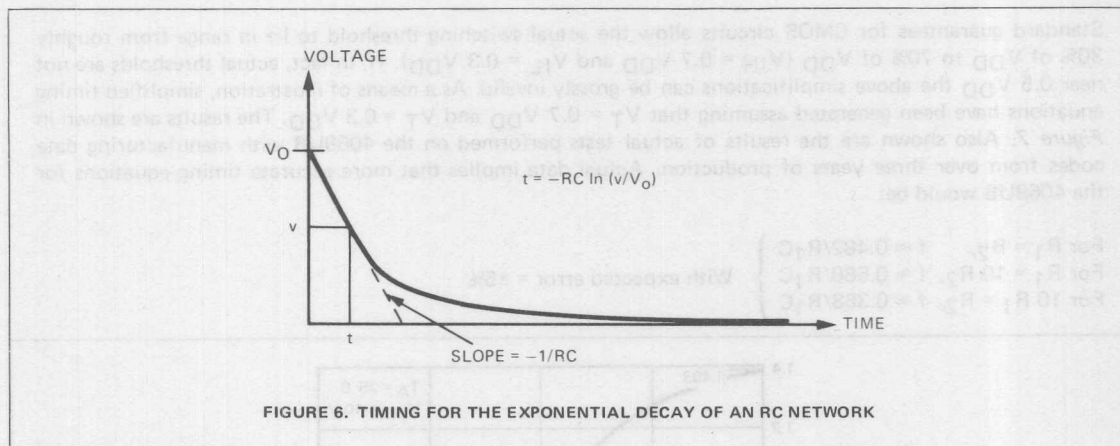
$$\text{Thus: } t_1 \approx -R_1 C \left[\frac{R_2}{R_1 + R_2} \right] \left[\ln \left(\frac{V_{DD}}{V_{DD} + V_{TP}} \right) \right]$$

$$t_2 \approx -R_1 C \ln \left(\frac{V_{TN}}{V_{DD}} \right)$$

$$t_3 \approx -R_1 C \left[\frac{R_2}{R_1 + R_2} \right] \left[\ln \left(\frac{V_{DD}}{2V_{DD} - V_{TN}} \right) \right]$$

$$t_4 \approx -R_1 C \ln \left(\frac{V_{TP}}{V_{DD}} \right)$$

$$\text{and: } T \approx -R_1 C \left\{ \left[\frac{R_2}{R_1 + R_2} \right] \left[\ln \left(\frac{V_{DD}}{V_{DD} + V_{TP}} \right) + \ln \left(\frac{V_{DD}}{2V_{DD} - V_{TN}} \right) \right] + \ln \left(\frac{V_{TN}}{V_{DD}} \right) + \ln \left(\frac{V_{TP}}{V_{DD}} \right) \right\}$$



For those who prefer their timing equations not to be cluttered with details, several simplifying assumptions can be made. First, it is assumed that negative and positive threshold voltages are equal ($V_{TN} = V_{TP}$). This is a fairly safe assumption since standard gates will generally exhibit very little hysteresis (< 200 mV). Of course, this assumption is not valid for Schmitt Triggers.

The timing equation simplifies to:

$$T \approx -R_1 C \left\{ \left[\frac{R_2}{R_1 + R_2} \right] \left[\ln \left(\frac{V_{DD}}{V_{DD} + V_T} \right) + \ln \left(\frac{V_{DD}}{2V_{DD} - V_T} \right) \right] + 2 \ln \left(\frac{V_T}{V_{DD}} \right) \right\}$$

Next, it is assumed that CMOS is the ideal logic family with ideal transfer characteristics and thus, $V_T = V_{DD}/2$. As will be shown later, this can be a very misleading assumption. Nevertheless:

$$T \approx 2R_1C \left[\frac{0.405 R_2}{R_1 + R_2} + 0.693 \right]$$

and:

$$f \approx \frac{1}{2R_1C \left[\frac{0.405 R_2}{R_1 + R_2} + 0.693 \right]}$$

Furthermore:

If $R_1 = R_2$, $f \approx 0.559/R_1C$

If $R_1 \gg R_2$, $f \approx 0.722/R_1C$

If $R_1 \ll R_2$, $f \approx 0.455/R_1C$

The last assumption is a very attractive one, greatly simplifying the timing equations, but can create correlation problems between paper calculations and actual results. CMOS is not, generally, an ideal logic family exhibiting ideal transfer characteristics and, in fact, guaranteed threshold limits allow variations in the timing equation constants which are much greater than those created by variations in R_2/R_1 as implied above.

Standard guarantees for CMOS circuits allow the actual switching threshold to lie in range from roughly 30% of V_{DD} to 70% of V_{DD} ($V_{IH} = 0.7 V_{DD}$ and $V_{IL} = 0.3 V_{DD}$). If, in fact, actual thresholds are not near $0.5 V_{DD}$ the above simplifications can be grossly invalid. As a means of illustration, simplified timing equations have been generated assuming that $V_T = 0.7 V_{DD}$ and $V_T = 0.3 V_{DD}$. The results are shown in Figure 7. Also shown are the results of actual tests performed on the 4069UB with manufacturing date codes from over three years of production. Actual data implies that more accurate timing equations for the 4069UB would be:

For $R_1 = R_2$, $f \approx 0.482/R_1C$
 For $R_1 = 10 R_2$, $f \approx 0.580/R_1C$
 For $10 R_1 = R_2$, $f \approx 0.368/R_1C$ } With expected error = $\pm 5\%$

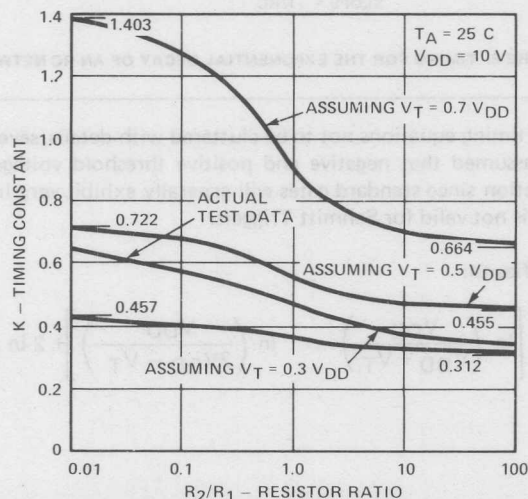


FIGURE 7. TIMING CONSTANT VERSUS RESISTOR RATIO FOR THE RC OSCILLATOR ASSUMING VARIOUS THRESHOLD VOLTAGES

Furthermore, it should be noted that the duty cycle of V_{OUT} will depend directly upon the actual threshold voltage. When $V_T = 0.5 V_{DD}$, a 50% duty cycle results.

In summary, for better comparison between software and hardware, it may be necessary for the designer to more accurately determine actual threshold voltages.

The Two Gate Oscillator

A popular two gate RC Oscillator circuit is shown in *Figure 8*. Coincidentally, all of the RC oscillator timing equations, RC waveforms, assumptions and arguments thus far also apply to the circuit in *Figure 8*. The only real problem with this circuit is that it may not oscillate for certain values of capacitance. Unlike the logical oscillator circuit of *Figure 1* which oscillates naturally and the frequency of oscillation is only slowed and stabilized by an RC network, the two gate circuit is forced to oscillate by the RC network. To illustrate this point, allow C to go to zero. The result is a circuit as shown in *Figure 9* which obviously will not oscillate in an acceptable manner. However, gate count may be a critical factor in a design and the two gate oscillator circuit is often employed.

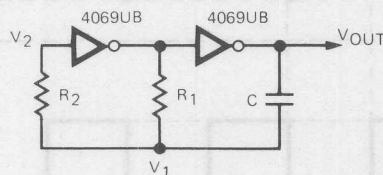


FIGURE 8. A TWO GATE RC OSCILLATOR

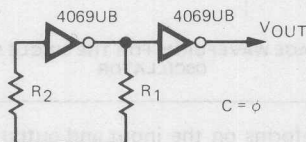


FIGURE 9. A TWO GATE RC OSCILLATOR MAY NOT OSCILLATE FOR SOME VALUES OF CAPACITANCE

The Schmitt Trigger Oscillator

Where gate count is a critical factor, *Figure 10* shows an Oscillator constructed from a single Inverting Schmitt Trigger. This circuit consumes only 1/6 of a package allowing the other five inverters to be utilized elsewhere in the system. It should be noted that the single stage oscillator is only practical where substantial hysteresis is provided by the logic element (i.e., Schmitt Triggers). It should, also, be noted that switching thresholds of the Schmitt Trigger are not as insensitive to variations in the power supply voltage. This circuit is best in those applications with relaxed requirements on frequency stability or where power supply voltages are well regulated.

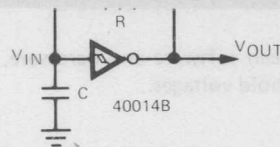


FIGURE 10. A SIMPLE SCHMITT TRIGGER OSCILLATOR

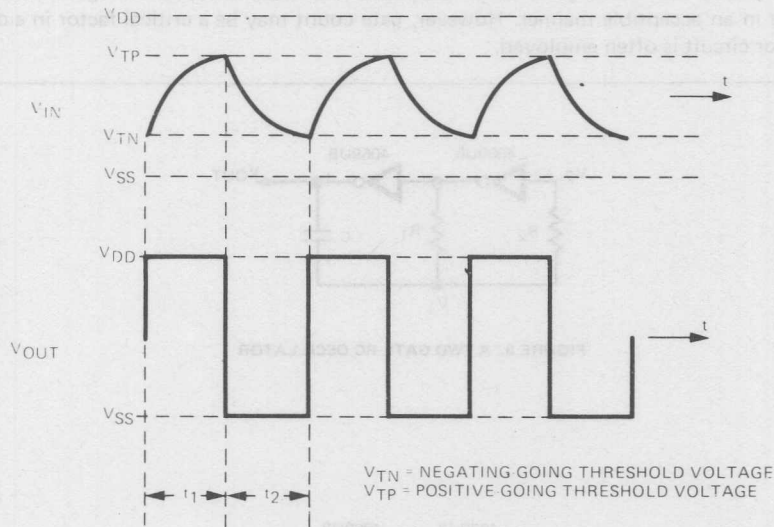


FIGURE 11. VOLTAGE WAVEFORMS FOR THE SINGLE SCHMITT TRIGGER OSCILLATOR

Figure 11 illustrates the voltage waveforms on the input and output pins of the Schmitt Trigger. Assuming that $t_1 + t_2 \gg t_{PLH} + t_{PHL}$ the time period T for one cycle is:

$$T \approx t_1 + t_2$$

$$\text{Where: } t_1 \approx -RC \ln \left(\frac{V_{DD} - V_{TP}}{V_{DD} - V_{TN}} \right)$$

$$t_2 \approx -RC \ln \left(\frac{V_{TN}}{V_{TP}} \right)$$

$$\text{or: } T \approx -RC \left[\ln \left(\frac{V_{TN}}{V_{TP}} \right) + \ln \left(\frac{V_{DD} - V_{TP}}{V_{DD} - V_{TN}} \right) \right]$$

$$\text{or: } T \approx RC \left[\ln \left(\frac{V_{TP}}{V_{TN}} \right) + \ln \left(\frac{V_{DD} - V_{TN}}{V_{DD} - V_{TP}} \right) \right]$$

To simplify the equation, we can assume from the 40014B data sheet that at $V_{DD} = 10\text{ V}$, $V_{TN} = 6.8\text{ V}$ and $V_{TP} = 3.2\text{ V}$, typically.

Thus: $T \approx 1.5\text{ RC}$

or: $f \approx 0.667/\text{RC}$

Once again, from *Figure 12*, it can be determined that the simplification above may not be valid because of possible variations in actual thresholds within the guaranteed worst case limits versus the typical thresholds assumed above.

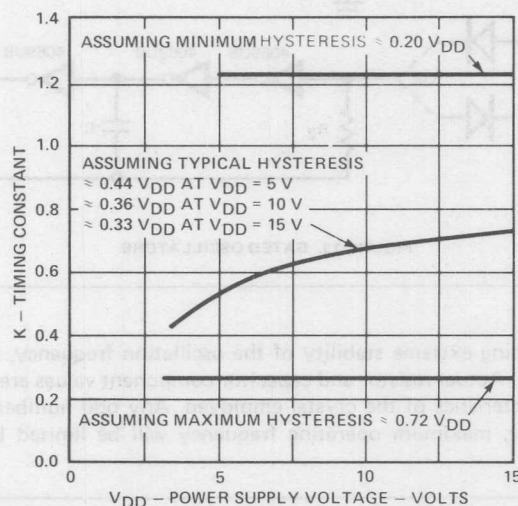


FIGURE 12. TIMING CONSTANT VERSUS POWER SUPPLY VOLTAGE ASSUMING VARIOUS HYSTERESIS LEVELS FOR THE 40014B

Based on actual test data performed on 40014B devices with a variety of manufacturing date codes, the following equation was determined:

$$f \approx 0.631/\text{RC} \quad \text{For } R = 1\text{ K}\Omega \text{ to } 1\text{ M}\Omega$$

and: $C = 10\text{ }\mu\text{F to } 100\text{ pF}$

with expected error $\approx \pm 10\%$

The Gated Oscillator

Often the designer will have a need to enable or disable the free running oscillator at will. This is easily accomplished by adding a diode to the RC Oscillator circuit as shown in *Figure 13*. In one direction the diode provides an active HIGH Enable input and in the other an active LOW Enable input. With proper selection of the RC components, power dissipation in the disabled state can be minimized.

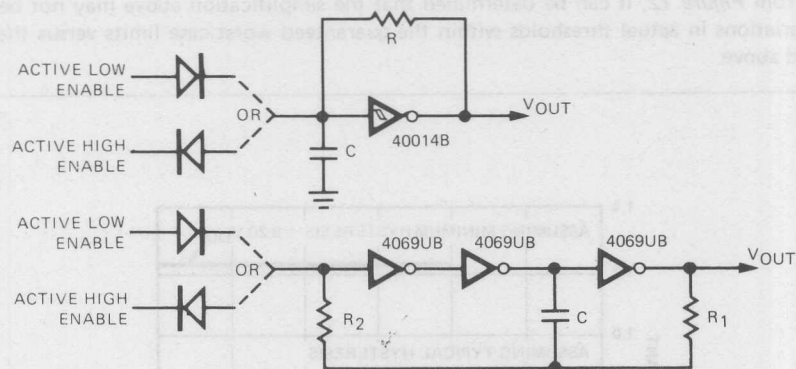


FIGURE 13. GATED OSCILLATORS

A CMOS Crystal Oscillator

For those applications requiring extreme stability of the oscillation frequency, a CMOS Crystal Oscillator circuit is shown in *Figure 14*. Actual resistor and capacitor component values are determined by the desired output frequency and characteristics of the crystal employed. Any odd number of inverting gates may be used in the circuit. However, maximum operating frequency will be limited by total propagation delay through the oscillator ring.

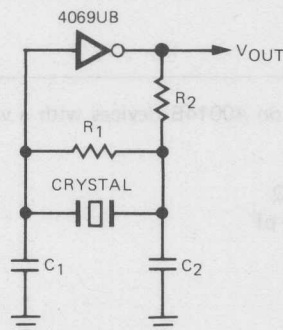


FIGURE 14. A CMOS CRYSTAL OSCILLATOR

Finally, in applications demanding such stringent stability, it is not uncommon for the designer, for reasons of both accuracy and cost, to select highest possible operating frequency. The result is an often critical tradeoff between tolerable power dissipation and acceptable accuracy. For the circuit of *Figure 14*, as operating frequency is increased by a factor of ten, power dissipation will also approximately increase by a factor of ten. Only the designer can acceptably resolve this tradeoff.

Summary

Simple CMOS inverting gates provide an attractive solution to oscillator applications providing better stability (especially at low frequency), very low power dissipation, wide operating power supply voltage range and relatively easy interface to other logic families.

This note has offered several alternative designs for CMOS oscillators each with its own advantages, disadvantages and simplifying assumptions. From the information presented herein, the designer has the capability of selecting the circuit and the characteristic tradeoffs best suited to his specific application.

Note 1. As a general rule, assuming worst case data sheet limits, input leakage current will have approximately a 10% affect upon the timing equation when $R_1 = 1.5 \text{ M}\Omega$ at $V_{DD} = 15 \text{ V}$, $10 \text{ M}\Omega$ at $V_{DD} = 10 \text{ V}$ and $5 \text{ M}\Omega$ at $V_{DD} = 5 \text{ V}$.

APPLICATION OF THE 4702B, PROGRAMMABLE BIT-RATE GENERATOR

The industry standard Universal Asynchronous Receiver/Transmitter (UART), an MOS/LSI subsystem, has had a considerable impact on data-communication system design. Not only has the UART dramatically reduced chip counts and increased reliability, etc., but it has also provided an incentive to integrate the remaining support functions.

One such subsystem is the 4702B programmable bit-rate generator, designed to provide the necessary clocking signals to operate asynchronous transmitter and receiver circuits. Several standardized signaling rates are used for start-stop communication depending on the transmission medium and other system requirements. The equipment must be capable of generating all the necessary frequencies and provide a way to select the desired one. In the past, this required several SSI/MSI circuits. Now, the 4702B can perform the task more easily and economically.

The 4702B provides any one of the 13 common bit rates on a selectable basis using an on-board oscillator and an external crystal; it also is expandable for multichannel applications. In its most general form, multichannel clocking requires that any of the possible frequencies must be available on any channel. Expansion up to eight channels is accomplished without device duplication. In multiple-device systems, there is no need to use a crystal with every device. *Figure 1* shows the block diagram of the 4702B which consists of the following major parts:

- Oscillator and associated gating
- Scan counter
- Count chains
- Initialization circuit
- Multiplexer and output storage

Oscillator and Associated Gating

The oscillator circuit together with an external crystal generates the master timing. A 2.4576 MHz crystal provides 16 times the frequency of the baud values marked; for example, 9600 baud corresponds to 153.6 kHz. If the External Clock Enable ($\overline{E_{CP}}$) is HIGH, the oscillator output signal drives the count chain. On the other hand, if it is LOW, the External Clock (CP) signal is enabled and is then the timing source. The External Clock input also participates in the device initialization scheme. The master timing signal, either from the external source or the local oscillator, is available on the Clock Output pin (CO). This signal can be used to drive other 4702B's in a multiple device system, thus eliminating the need to provide more than one crystal.

Scan Counter

The master timing drives a 3-bit binary scan counter which, in turn, drives the remaining counter chains on the chip. The scan counter allows expansion to eight channels as described later. The prescaling feature of this counter provides another benefit, i.e., it moves the input frequency to 2.4576 MHz which is ideal for low-cost crystals. If it were not for the scan counter, the 4702B would require a more expensive crystal of about 300 kHz.

Count Chains

The scan counter output drives an 8-bit binary counter which provides the frequencies corresponding to 9600, 4800, 2400, 1200, 600, 300, 150 and 75 baud. The 1800-baud signal is generated by dividing 9600 by 16/3. The 110 and 134.5 baud signals are approximated by dividing 2400 by 22 and 18 respectively. Dividing 1200 by 6 gives the 200 baud signal, while 50 baud is generated by dividing 200 baud by 4. All division factors except 16/3 are even; thus, all outputs except 1800 baud have a 50% duty cycle.

The actual division by 16/3 is achieved by using a sequence of integers 5 and 6 such that cumulative error after every three cycles is zero. This scheme, in conjunction with the divide by 16 performed in the UART, achieves good timing accuracy demanded by high speed communication equipment. Calculations indicate that the maximum distortion introduced does not exceed 0.78% regardless of the number of elements in a character.

Initialization Circuit

This circuit generates a Master Reset signal to initialize the flip-flops on the 4702B to a known state. If the External Clock Enable (ECP) is LOW, the local oscillator output is inhibited and timing is derived from the External Clock (CP). The first positive half cycle of the External Clock is used to generate the Master Reset and all succeeding clock signals are used for timing. This initialization scheme allows software-controlled diagnosis for fault isolation.

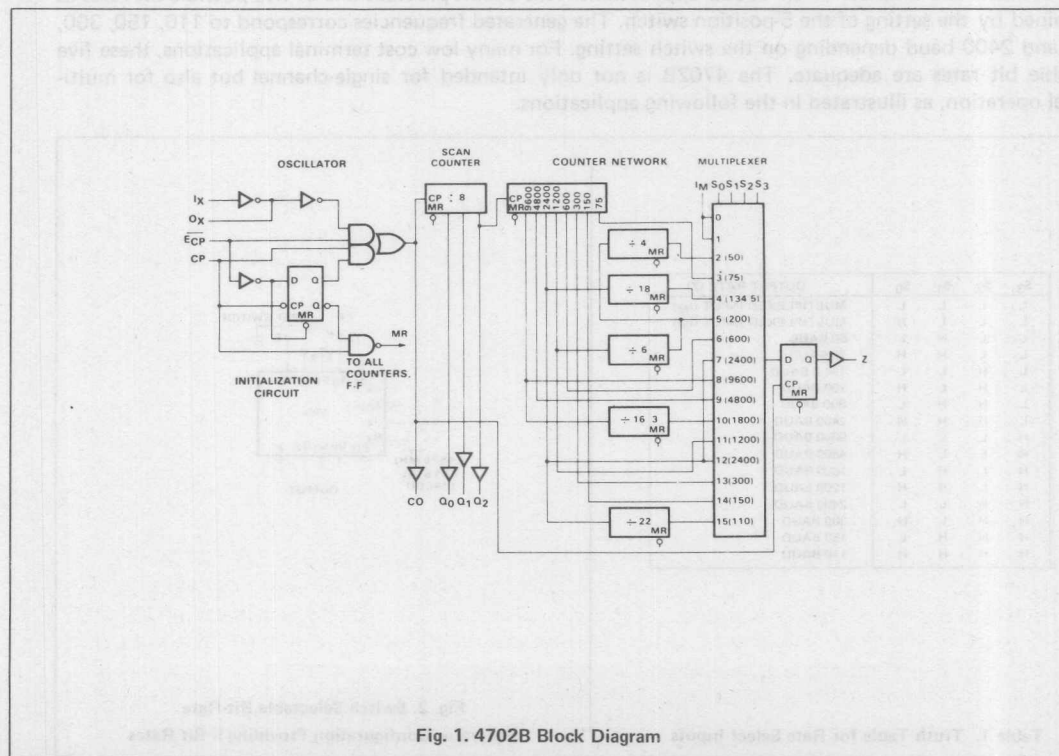


Fig. 1. 4702B Block Diagram

Multiplexer and Output Storage

All the desired outputs from the count chains are fed as data inputs to a multiplexer. The select inputs for this multiplexer are brought out as Rate Select input ($S_0 - S_3$). Table 1 shows the correspondence between this code and the resulting frequency. The multiplexer output is fed as data input to a resynchronizing flip-flop that is clocked by the leading edge of the master timing.

If only single-channel applications of the 4702B were considered, the output flip-flop would be unnecessary. In multichannel applications, however, the Rate Select inputs change as a function of the Scan Counter output ($Q_0 - Q_2$). The resynchronizing flip-flop assures a fixed timing relationship between $Q_0 - Q_2$ and the Bit Rate output (Z).

Three important features should be noted from Table 1. First, two of the select codes specify Multiplexed Input (I_M) signal as the data source to the multiplexer. The user can feed a signal into this input, however, the primary intent was to feed a static logic level to achieve a "zero baud" situation. Secondly, the codes corresponding to 110, 150, 300, 1200 and 2400 baud each have a maximum of only one LOW level. These are the most commonly used rates in contemporary data terminals. Thus the rate select mechanism on these terminals need only be a single-pole 5-position switch with the common terminal grounded. Thirdly, 2400 baud is select by two different codes so that the whole spectrum of modern communication rates will have a HIGH code in the most significant bit position.

Typical Applications

In those applications where the Rate Select inputs are static levels, operation of the 4702B is rather straightforward. The multiplexer connects the specified counter output to the data input of the output flip-flop. Because the flip-flop is clocked by the master timing, its output reflects the selected frequency.

Single-Channel Bit-Rate Generator

Figure 2 shows the simplest of all 4702B applications. This circuit provides one of five possible bit rates as determined by the setting of the 5-position switch. The generated frequencies correspond to 110, 150, 300, 1200, and 2400 baud depending on the switch setting. For many low cost terminal applications, these five selectable bit rates are adequate. The 4702B is not only intended for single-channel but also for multi-channel operation, as illustrated in the following applications.

S_3	S_2	S_1	S_0	OUTPUT RATE (Z)
L	L	L	L	MULTIPLEXED INPUT (I_M)
L	L	L	H	MULTIPLEXED INPUT (I_M)
L	L	H	L	50 BAUD
L	L	H	H	75 BAUD
L	H	L	L	134.5 BAUD
L	H	L	H	200 BAUD
L	H	H	L	600 BAUD
L	H	H	H	2400 BAUD
H	L	L	L	9600 BAUD
H	L	L	H	4800 BAUD
H	L	H	L	1800 BAUD
H	L	H	H	1200 BAUD
H	H	L	L	2400 BAUD
H	H	L	H	300 BAUD
H	H	H	L	150 BAUD
H	H	H	H	110 BAUD

Table 1. Truth Table for Rate Select Inputs

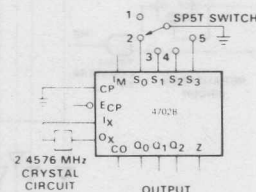


Fig. 2. Switch Selectable Bit-Rate Generator Configuration Providing 5 Bit Rates

Multichannel Bit-Rate Generation

Figure 3 illustrates a fully programmable 8-channel bit-rate generator system. Two 4 x 4 register file devices (9LS170) can be loaded with information (rate select codes from Table 1) relating to the desired frequency on a per-channel basis. For clarity, circuits for writing into the files are not shown.

The least significant Scan Counter outputs (Q_0, Q_1) control the Read Address of the 9LS170s while the most significant output (Q_2) controls the Read Enable (RE) inputs. Thus, as the counter advances, file locations are read out sequentially. The Scan Counter outputs are also the Address inputs for the 93L34 addressable latch. The Bit Rate output (Z) of the 4702B is the Data input to the 93L34 while the Clock Output is the Enable input.

To understand the operation, consider the instant when the Scan Counter outputs become Zero ($Q_0 - Q_2 = \text{LOW}$). The same clock that incremented this counter to Zero also clocked the counter output, corresponding to the selected frequency for channel 7 into the output flip-flop, and disabled the 93L34 latch via the Clock Output (CO), thus preventing any change in the latch outputs while the Scan Counter outputs and the Bit Rate output (Z) are changing.

During the second half of the clock cycle, when the Clock Output (CO) is LOW, the counter output representing the selected frequency for channel 7 is loaded into the 93L34 latch and is locked up on the Q_0 output.

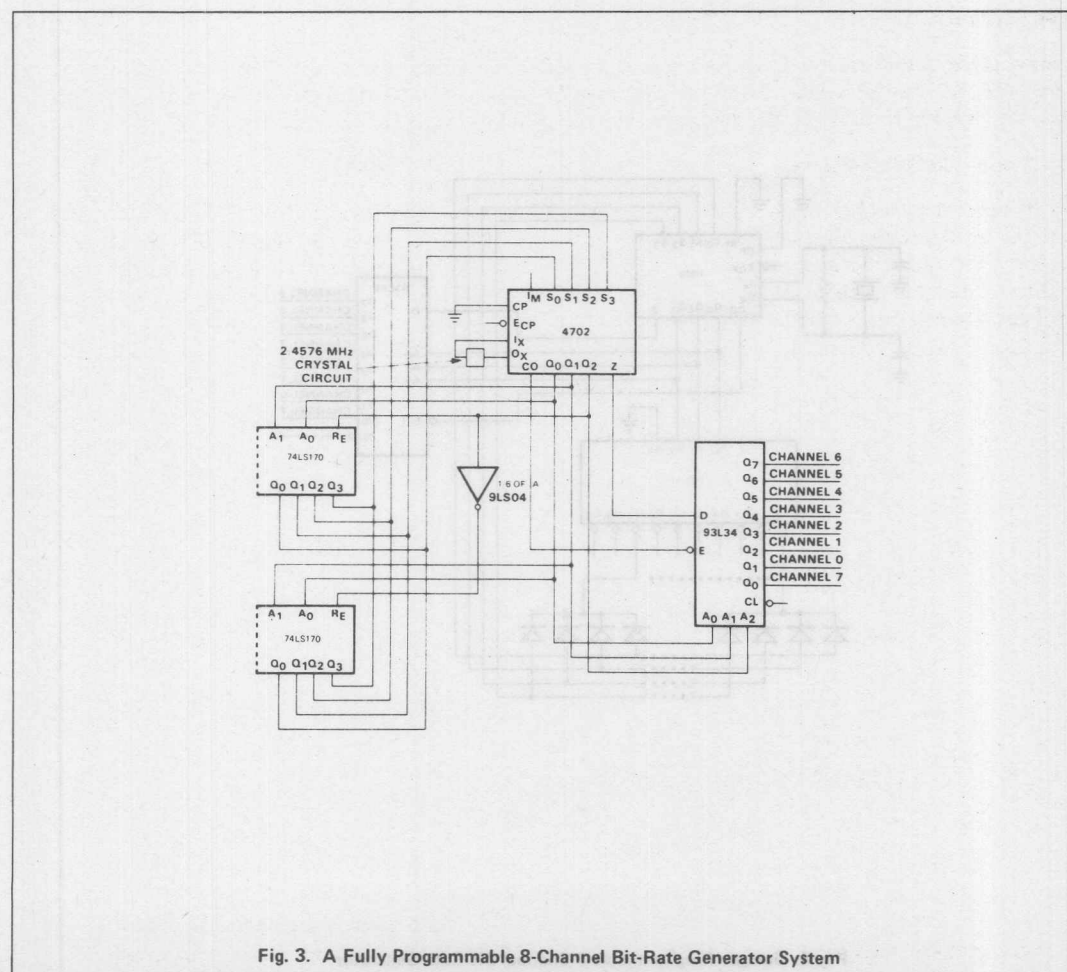


Fig. 3. A Fully Programmable 8-Channel Bit-Rate Generator System

Register file to determine the assigned bit rate for channel 0. The stored value for channel 0 is loaded into the 93L34 latch, so that during the next LOW-to-HIGH clock transition, the state of this internal signal is clocked into the output flip-flop. Thus, each channel is sequentially interrogated and the 93L34 latch is updated at least once during each half cycle of the highest output frequency (9600 baud).

By connecting the Scan Counter output Q2 to the Multiplexed input (IM) a similar technique can be used to implement a system with a maximum output frequency of 19,200 baud, however, the number of channels must be limited to four. This ensures that the output will be interrogated and updated at least once during each half cycle of the highest output frequency (19,200 baud).

Jumper Programmable 8-Channel Bit-Rate Generator

In systems where channel-speed assignments remain relatively fixed, software-controlled channel assignment is not necessary or practical. It may be simpler to program with "jumpers" at appropriate places in the system. See Figure 4.

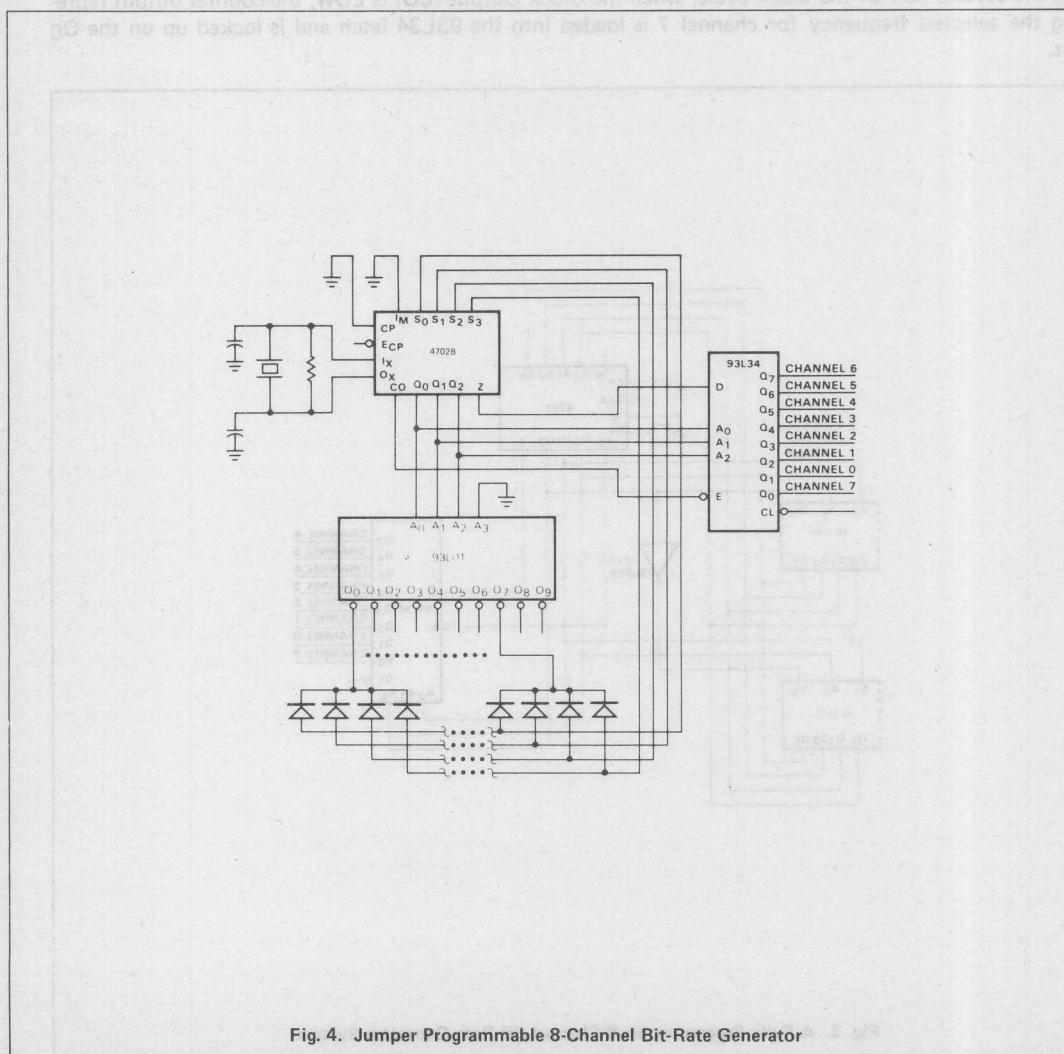


Fig. 4. Jumper Programmable 8-Channel Bit-Rate Generator

In the jumper programmable 8-channel bit-rate generator, the scan counter outputs ($Q_0 - Q_2$) are fed as Address inputs to a 93L01 decoder and a 93L34 addressable latch. The decoder outputs drive the diode clusters which contain four diodes for each channel. All four diode cathodes in a cluster are connected together to a decoder output; the anodes of corresponding diodes in every cluster are connected together to the appropriate Rate Select inputs of the 4702B. Presence of a diode results in a LOW on the particular 4702B input; when a diode is absent, a HIGH results. As the scan counter advances, the decoder outputs activate the desired bit-rate code for that channel. The 93L34 synchronously demultiplexes the 4702B output (Z) and reconstructs the specified bit rates at its output.

32 Times Frequency Bit Rates

The 4702B is designed to generate all the common communication bit rates at actual frequencies of 16 times the selected bit rate. The 16 times frequency is sufficient to operate UARTs. However, some recent LSI devices intended as UART replacements require 32 times frequency on their clock inputs. This note describes an elegant scheme to achieve this without a corresponding increase of the crystal frequency.

Figure 5 illustrates a fully programmable 8-channel system. Two 9LS170 devices are used to store the channel frequency selection information. These devices can be loaded with information on a per channel basis. For clarity, circuitry for writing into these devices is not drawn. The least significant SCAN counter outputs (Q_0 and Q_1) of the 4702B are used as the read address inputs of the 9LS170s. The most significant bit (Q_2) is used to control the read enable (RE) inputs of the 9LS170s. The $Q_0 - Q_2$ outputs of the 4702B are also the inputs to a 9LS138 decoder. The clock output (CO) of the 4702B is used to control one enable input (\overline{E}_1) of the 9LS138. The CO output is also the clock input (CP) for the 9LS164 shift register. The Z output of the 4702B is the data input (A) to the 9LS164. The Z output of the 4702B is also tied into an exclusive NOR gate (4077B) as one input. The second input to the exclusive NOR gate is the Q_7 output of the 9LS164. The output of the exclusive NOR gate controls the second enable input (\overline{E}_2) of the 9LS138. The outputs ($\overline{O}_0 - \overline{O}_7$) of the 9LS138 are the desired output clock signals.

To understand the operation of this circuit, consider the LOW-to-HIGH transition of the CO output of the 4702B when the SCAN counter outputs change from "7" (HHH) to "0" (LLL). From this transition to the next LOW-to-HIGH transition of the CO, the Z output of the 4702B reflects the state of the channel 7 counter output. The $Q_0 - Q_2$ outputs of the 4702B are LOW and hence information for channel 0 will be available on the 9LS170 outputs. The $S_0 - S_3$ inputs of the 4702B are connected to the 9LS170 outputs. On the LOW-to-HIGH transition of the CO output channel 0 counter will be clocked to the Z output. This transition also clocks the 9LS164. The SCAN counter also increments on this transition and will point to channel 1. As the clocking continues, 9LS170 locations will be read out sequentially and information will be shifted into the 9LS164. After eight clock transitions the previous channel 7 output will be at the Q_7 output of the 9LS164, and the current channel 7 output will be on the Z output of the 4702B. The output of the exclusive NOR gate will be LOW if the inputs differ; i.e. whenever the channel 7 output is to make a transition the output of the exclusive NOR gate will be LOW. The CO output is connected to the \overline{E}_2 input of the 9LS138 and during the negative half cycle of the clock the \overline{O}_0 output of the 9LS138 will be LOW. The 4702B internal counters generate 16 times the selected bit rate. The exclusive NOR gate is generating a signal whenever the selected counter is making a transition. This scheme will result in 32 times the selected bit rate. As the clocking continues each channel is serially appearing on the Q_7 output of the 9LS164 and will be compared with the corresponding current channel output. The 9LS138 will then represent the appropriate frequency at its output as shown in Figure 5.

Clock Expansion

The basic 4702B can be expanded to a maximum of eight channels. In applications where more than eight channels are needed, the 4702B must be duplicated. The device is designed with a clock-expansion feature; therefore only one crystal is required to operate all the channels.

The most economical expansion scheme provides one 4702B with a crystal and all other devices derive their timing from this master. The device wiring is such that the External Clock Enable input and I_X input of all but the master device feeds into the External Clock input of all the other devices. The Clock output of each device is connected to its associated 93L34 Enable input as before. An alternative scheme is shown in Figure 6.

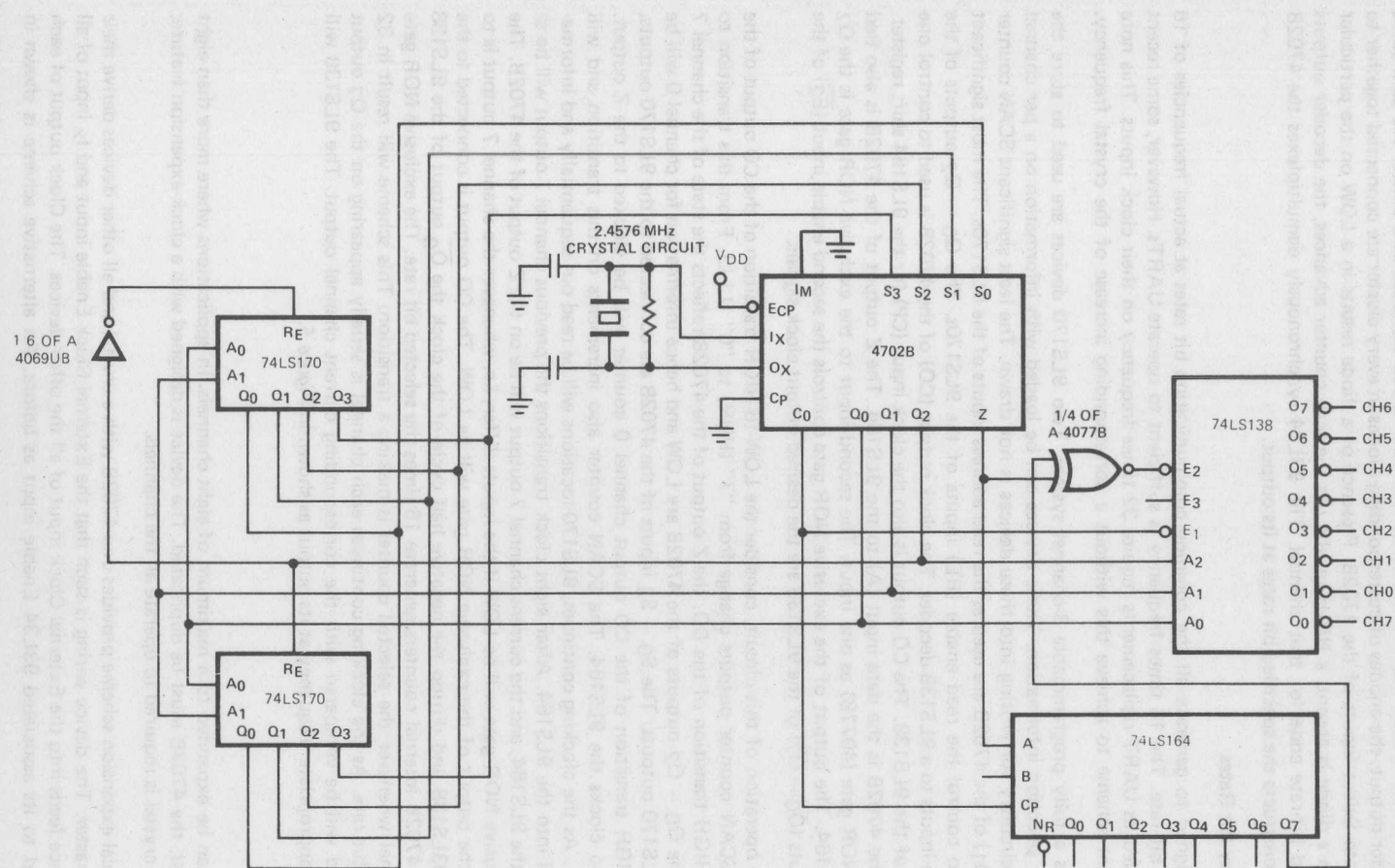


Fig. 5. A Fully Programmable 32 Times Frequency Bit Rate Generator System

The advantage of this scheme is that it can be conveniently used to implement the software external clock feature mentioned previously. Imagine that the External Clock Enable (\overline{ECP}) inputs of all the 4702B's in the system are controlled by the output of a flip-flop (mode) and the External Clock inputs (CP) of all the devices are tied together and software driven, possibly by operating another flip-flop. During normal operation, the mode control is HIGH, thus selecting the crystal oscillator for timing. Also, the external Clock input of each device is held LOW. When the External Clock Enable goes LOW, in preparation for the diagnostic mode, all devices receive their timing from the External Clock input. When this input goes HIGH for the first time, all devices generate an internal Master Reset signal clearing their counter chains. The next HIGH-to-LOW transition sets the internal control flip-flop and thus terminates the Reset; all counters are free to start counting in response to the External Clock signal.

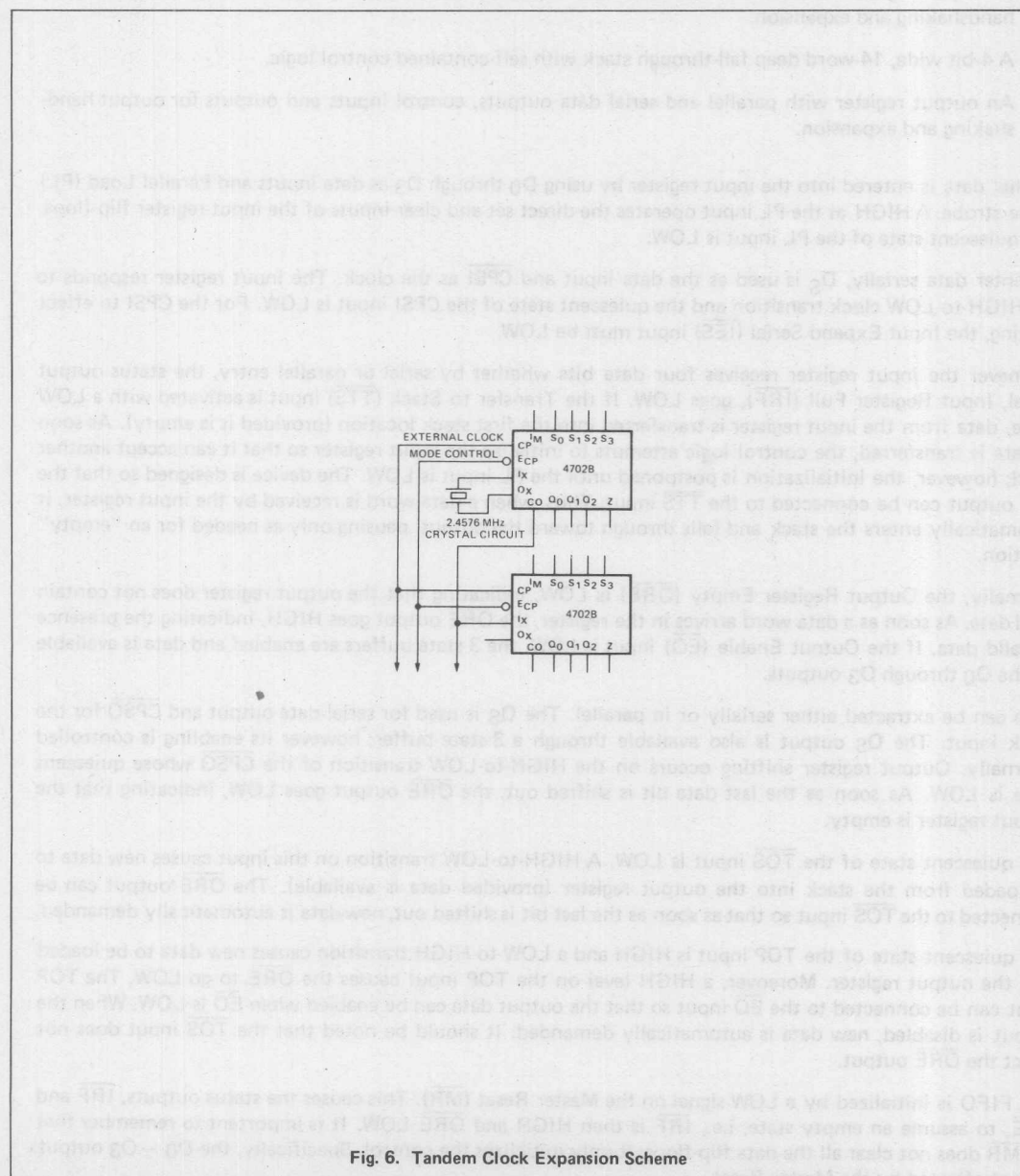


Fig. 6. Tandem Clock Expansion Scheme

USING THE 4703B FIFO

The First-In First-Out (FIFO) memory is read/write memory which automatically stacks the words in the same order as they were entered and makes them available at the output in the same sequence, thus its name first-in first-out.

Description

The 4703B FIFO is a 16 x 4 parallel/serial memory consisting of the following (*Figure 1*).

- An input register with parallel and serial data inputs as well as control inputs and outputs for input handshaking and expansion.
- A 4-bit wide, 14-word deep fall-through stack with self-contained control logic.
- An output register with parallel and serial data outputs, control inputs and outputs for output handshaking and expansion.

Parallel data is entered into the input register by using D0 through D3 as data inputs and Parallel Load (PL) as the strobe. A HIGH at the PL input operates the direct set and clear inputs of the input-register flip-flops. The quiescent state of the PL input is LOW.

To enter data serially, D_S is used as the data input and $\overline{\text{CPSI}}$ as the clock. The input register responds to the HIGH-to-LOW clock transition and the quiescent state of the CPSI input is LOW. For the CPSI to effect shifting, the Input Expand Serial ($\overline{\text{IES}}$) input must be LOW.

Whenever the input register receives four data bits whether by serial or parallel entry, the status output signal, Input Register Full ($\overline{\text{IRF}}$), goes LOW. If the Transfer to Stack (TTS) input is activated with a LOW pulse, data from the input register is transferred into the first stack location (provided it is empty). As soon as data is transferred, the control logic attempts to initialize the input register so that it can accept another word; however, the initialization is postponed until the PL input is LOW. The device is designed so that the $\overline{\text{IRF}}$ output can be connected to the TTS input. Thus, when a data word is received by the input register, it automatically enters the stack and falls through toward the output, pausing only as needed for an "empty" location.

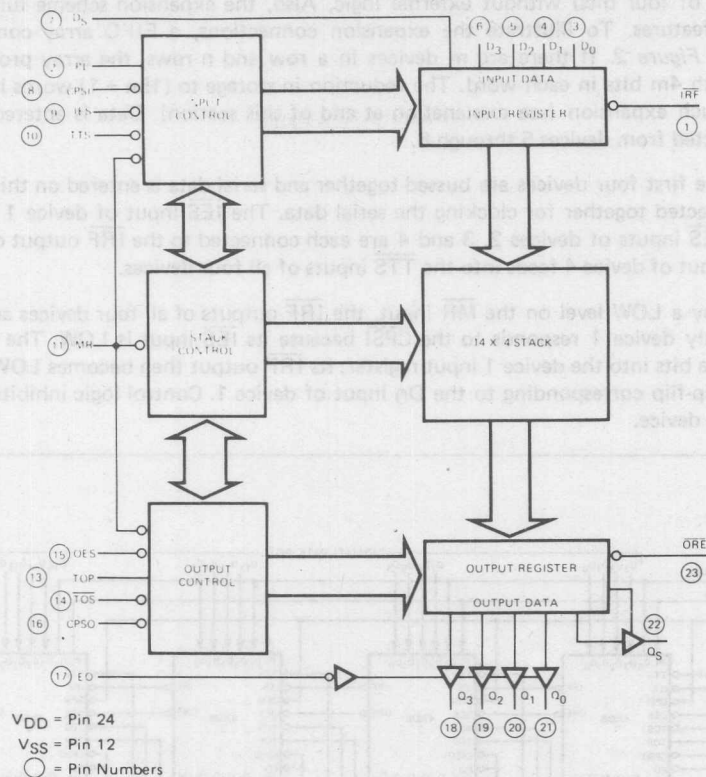
Normally, the Output Register Empty ($\overline{\text{ORE}}$) is LOW, indicating that the output register does not contain valid data. As soon as a data word arrives in the register, the $\overline{\text{ORE}}$ output goes HIGH, indicating the presence of valid data. If the Output Enable ($\overline{\text{EO}}$) input is LOW, the 3-state buffers are enabled and data is available on the O0 through O3 outputs.

Data can be extracted either serially or in parallel. The Q_S is used for serial data output and $\overline{\text{CPSO}}$ for the clock input. The Q_S output is also available through a 3-state buffer; however its enabling is controlled internally. Output register shifting occurs on the HIGH-to-LOW transition of the CPSO whose quiescent state is LOW. As soon as the last data bit is shifted out, the $\overline{\text{ORE}}$ output goes LOW, indicating that the output register is empty.

The quiescent state of the $\overline{\text{TOS}}$ input is LOW. A HIGH-to-LOW transition on this input causes new data to be loaded from the stack into the output register (provided data is available). The $\overline{\text{ORE}}$ output can be connected to the $\overline{\text{TOS}}$ input so that as soon as the last bit is shifted out, new data is automatically demanded.

The quiescent state of the TOP input is HIGH and a LOW-to-HIGH transition causes new data to be loaded into the output register. Moreover, a HIGH level on the TOP input causes the $\overline{\text{ORE}}$ to go LOW. The TOP input can be connected to the $\overline{\text{EO}}$ input so that the output data can be enabled when $\overline{\text{EO}}$ is LOW. When the output is disabled, new data is automatically demanded. It should be noted that the $\overline{\text{TOS}}$ input does not affect the $\overline{\text{ORE}}$ output.

The FIFO is initialized by a LOW signal on the Master Reset ($\overline{\text{MR}}$). This causes the status outputs, $\overline{\text{IRF}}$ and $\overline{\text{ORE}}$, to assume an empty state; i.e., $\overline{\text{IRF}}$ is then HIGH and $\overline{\text{ORE}}$ LOW. It is important to remember that the $\overline{\text{MR}}$ does not clear all the data flip-flops; it only initializes the control. Specifically, the O0 – O3 outputs are not affected by the Master Reset.

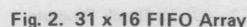


$D_0 - D_3$	Parallel Data Inputs
D_S	Serial Data Input
PL	Parallel Load Input
\overline{CPSI}	Serial Input Clock Input (HIGH-to-LOW Triggered)
\overline{CPSO}	Serial Output Clock Input (HIGH-to-LOW Triggered)
\overline{IES}	Serial Input Enable (Active LOW)
\overline{TTS}	Transfer to Stack Input (Active LOW)
\overline{TOS}	Transfer Out Serial Input (Active LOW)
TOP	Transfer Out Parallel Input
\overline{OES}	Serial Output Enable Input (Active LOW)
\overline{EO}	Output Enable Input (Active LOW)
\overline{MR}	Master Reset Input (Active LOW)
\overline{IRF}	Input Register Full Output (Active LOW)
\overline{ORE}	Output Register Empty Output (Active LOW)
$Q_0 - Q_3$	Parallel Data Outputs
Q_S	Serial Data Output

Fig. 1. 4703B Block Diagram

The 4703B can be vertically expanded to store more words or horizontally expanded to store longer words (in multiples of four bits) without external logic. Also, the expansion scheme fully preserves the parallel/serial data features. To illustrate the expansion connections, a FIFO array consisting of eight devices is shown in *Figure 2*. If there are m devices in a row and n rows, the array provides $(15n + 1)$ words of storage with $4m$ bits in each word. The reduction in storage to $(15n + 1)$ words instead of $16n$ is quite common in such expansion (see explanation at end of this section). Data is entered into devices 1 through 4 and extracted from devices 5 through 8.

After initialization by a LOW level on the $\overline{\text{MR}}$ input, the $\overline{\text{IRF}}$ outputs of all four devices are HIGH. Under these conditions, only device 1 responds to the $\overline{\text{CPSI}}$ because its $\overline{\text{IES}}$ input is LOW. The first four clock pulses shift four data bits into the device 1 input register; its $\overline{\text{IRF}}$ output then becomes LOW. The first data bit is located in a flip-flop corresponding to the D_0 input of device 1. Control logic inhibits the $\overline{\text{CPSI}}$ from further affecting this device.



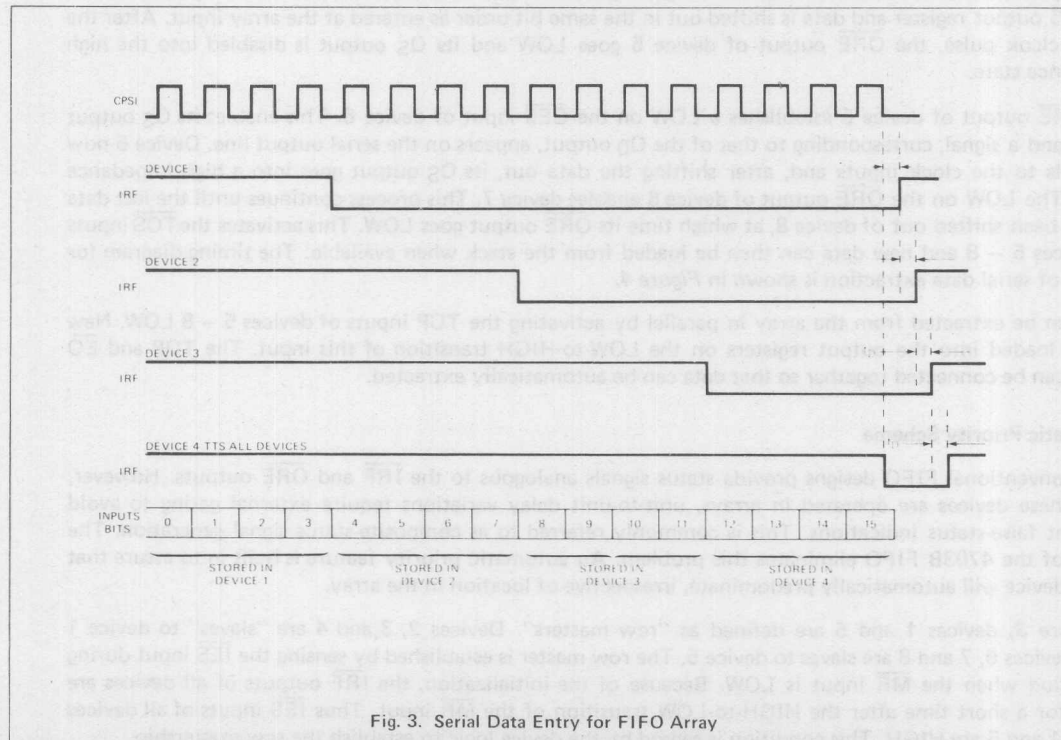
Because the $\overline{\text{IES}}$ input of device 2 is now LOW, the clock starts shifting data into the input register of device 2. On the eighth clock pulse, the $\overline{\text{IRF}}$ output of device 2 goes LOW and disables shifting of device 2. This process continues on devices 3 and 4. Therefore, on the 16th clock pulse, the $\overline{\text{IRF}}$ output of device 4 becomes LOW and activates the $\overline{\text{TTS}}$ inputs of all devices. The stack control logic in each device responds by transferring data into each stack from the respective input register, and the input registers are initialized. Thus the $\overline{\text{IRF}}$ outputs of all devices become HIGH once again. An automatic priority scheme assures that if the $\overline{\text{IRF}}$ output of device 4 is HIGH, the input registers of all four devices have been initialized. The timing diagram for 16 bits of serial entry into the array is shown in Figure 3.

Parallel entry into the array is made with a HIGH level on the PL inputs. The same conditions prevail in the input section that exist after the 16th clock pulse in the serial entry mode. The stack controls do not initialize the input registers until the PL inputs are LOW to assure proper device operation.

Data loaded into the stacks eventually arrives at the output registers of the first four devices. Normally, the $\overline{\text{ORE}}$ outputs are LOW due to initialization; however, as soon as data is loaded into each output register, the $\overline{\text{ORE}}$ goes HIGH. An automatic priority scheme, similar to the one for data entry, also exists at the output. Thus a HIGH level on the $\overline{\text{ORE}}$ output of device 4 guarantees that valid data is present in all the output registers.

The $\overline{\text{ORE}}$ output of device 4 is connected to the PL inputs of devices 5 through 8, as well as to the $\overline{\text{TOS}}$ inputs of the first four devices. It should be noted that if serial extraction from the output is not desired, the $\overline{\text{TOS}}$ inputs can be connected to ground instead. The $\overline{\text{EO}}$ inputs of the first four devices are connected to ground; thus the contents of an output register are available on the appropriate outputs.

The HIGH level on the $\overline{\text{ORE}}$ outputs of device 4 activates the PL inputs of devices 5 – 8, thus forcing the data outputs from each device in the first row into the input register of the corresponding device in the second row. The $\overline{\text{IRF}}$ output of device 8 is connected to the TOP inputs of devices 1 – 4 and to the $\overline{\text{TTS}}$ inputs of devices 5 – 8. Because the PL inputs are HIGH, the $\overline{\text{IRF}}$ outputs of devices 5 – 8 are LOW, therefore establishing a LOW on the TOP inputs of devices 1 – 4. This causes the $\overline{\text{ORE}}$ of devices 1 – 4 to



devices 5 — 8 initialize their respective registers and the $\overline{\text{IRF}}$ outputs go HIGH. An automatic priority scheme is also present at the inputs of devices 5 — 8. The HIGH on the $\overline{\text{IRF}}$ output of device 8 restores the TOP inputs of devices 1 — 4 to the quiescent state.

If the stacks of devices 5 — 8 are full, activating the $\overline{\text{TTS}}$ inputs by the LOW $\overline{\text{IRF}}$ output of device 8 would not initiate a data transfer from the input registers. The $\overline{\text{IRF}}$ output of device 8 would remain LOW until the data can be successfully transferred into the stacks. Thus, as long as devices 5 — 8 are holding 16 words, the $\overline{\text{IRF}}$ output of device 8 remains LOW. This also holds the TOP inputs of devices 1 — 4 LOW. As long as they remain LOW, data cannot be loaded into the output registers from the stacks because a LOW-to-HIGH transition at the TOP inputs is needed to demand new data. Under these circumstances, devices 1 — 4 temporarily lose the ability to use their output registers and hence can hold only 15 words. As a result, the two rows have a storage capacity of 31 words instead of 32; and, for the general case, the storage capacity of an n -row array is $(15n + 1)$ instead of $16n$.

The data loaded into the stacks eventually arrives at the output registers of devices 5 — 8, at which time the $\overline{\text{ORE}}$ outputs go HIGH from the LOW state originally initialized by the $\overline{\text{MR}}$ input. The automatic priority scheme is still in effect, and the data from the output can be extracted either in serial or parallel format.

The QS outputs of devices 5 — 8, each available through a 3-state buffer, are connected together and the serial data output from the array appears on this line. The $\overline{\text{CPSO}}$ inputs are also connected together and the line driven by the output clock. When there is no valid data in the output register, QS is disabled and is therefore in a high impedance state.

The $\overline{\text{OES}}$ input of device 5 is connected to ground and device 6, 7 and 8 each receive its $\overline{\text{OES}}$ input from the preceding device. As soon as data arrives in the output registers of devices 5 — 8, the $\overline{\text{ORE}}$ outputs go HIGH and the 3-state buffer of device 5 is enabled so that its QS output becomes identical to its QO output. The QS outputs of devices 5 — 8 are in a high impedance state. The clock on the $\overline{\text{CPSO}}$ input shifts the device 5 output register and data is shifted out in the same bit order as entered at the array input. After the fourth clock pulse, the $\overline{\text{ORE}}$ output of device 5 goes LOW and its QS output is disabled into the high impedance state.

The $\overline{\text{ORE}}$ output of device 5 establishes a LOW on the $\overline{\text{OES}}$ input of device 6. This enables its QS output buffer and a signal, corresponding to that of the QO output, appears on the serial output line. Device 6 now responds to the clock inputs and, after shifting the data out, its QS output goes into a high impedance mode. The LOW on the $\overline{\text{ORE}}$ output of device 6 enables device 7. This process continues until the last data bit has been shifted out of device 8, at which time its $\overline{\text{ORE}}$ output goes LOW. This activates the $\overline{\text{TOS}}$ inputs of devices 5 — 8 and new data can then be loaded from the stack when available. The timing diagram for 16 bits of serial data extraction is shown in *Figure 4*.

Data can be extracted from the array in parallel by activating the TOP inputs of devices 5 — 8 LOW. New data is loaded into the output registers on the LOW-to-HIGH transition of this input. The TOP and $\overline{\text{EO}}$ inputs can be connected together so that data can be automatically extracted.

Automatic Priority Scheme

Most conventional FIFO designs provide status signals analogous to the $\overline{\text{IRF}}$ and $\overline{\text{ORE}}$ outputs. However, when these devices are operated in arrays, unit-to-unit delay variations require external gating to avoid transient false-status indications. This is commonly referred to as composite-status signal generation. The design of the 4703B FIFO eliminates this problem. An automatic priority feature is built in to assure that a slow device will automatically predominate, irrespective of location in the array.

In *Figure 3*, devices 1 and 5 are defined as "row masters". Devices 2, 3 and 4 are "slaves" to device 1 while devices 6, 7 and 8 are slaves to device 5. The row master is established by sensing the $\overline{\text{IES}}$ input during the period when the $\overline{\text{MR}}$ input is LOW. Because of the initialization, the $\overline{\text{IRF}}$ outputs of all devices are HIGH for a short time after the HIGH-to-LOW transition of the $\overline{\text{MR}}$ input. Thus $\overline{\text{IES}}$ inputs of all devices except 1 and 5 are HIGH. This condition is sensed by the device logic to establish the row mastership.

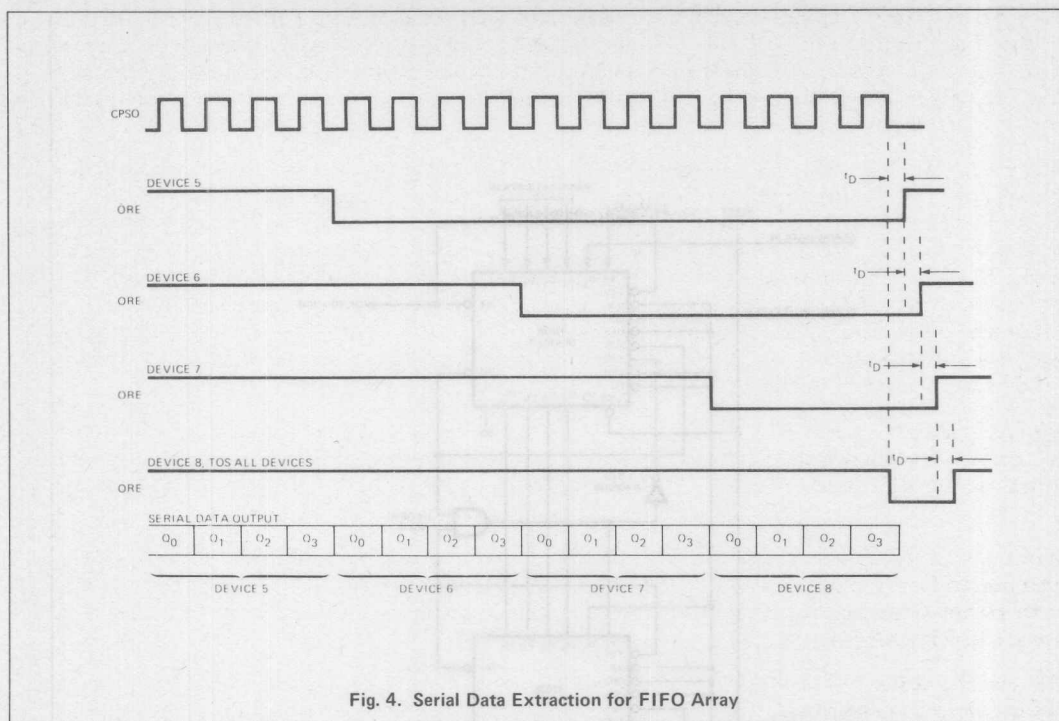


Fig. 4. Serial Data Extraction for FIFO Array

All devices in any given row transfer data from their input registers into the corresponding stacks simultaneously. However, no slave can initialize its input register until its \overline{IES} input goes HIGH. Thus initialization starts with the row master and eventually ends at the last slave in the row.

A similar situation occurs at the output registers of all devices in a row. They are loaded simultaneously from corresponding stacks; however, the \overline{ORE} output of a slave cannot go HIGH until its \overline{OES} input is HIGH. Thus the row master is the first to indicate a HIGH on its \overline{ORE} and eventually the slaves will follow. It should be pointed out that this automatic priority scheme reduces the maximum operation speed of the array. If speed is essential, the master-slave hierarchy can be replaced by the traditional composite-status signal-generation scheme, which requires external gating.

Other Expansion Schemes

The expansion scheme illustrated in *Figure 3* is quite simple and straightforward. It does not require any external support logic to achieve the desired expansion and retains all the serial/parallel features. However, these advantages are not without sacrifice—one storage location is eliminated at the interface between rows—and the n -row array has a storage capacity of $15n + 1$ instead of $16n$ words. Moreover, the automatic priority scheme results in a ripple action from row master to the last slave in that row for the status signaling. This reduces the maximum operation frequency of an array and the inherent speed of the individual devices is not fully utilized.

The 4703B FIFO, because of its versatility, can be used to overcome both above disadvantages with minimum external logic. A vertically expended array, consisting of three FIFOs, yields $16n$ words of storage for an n -row array (*Figure 5*). After initialization by a LOW level on the \overline{MR} inputs, the \overline{IRF} outputs of all three devices are HIGH and the \overline{ORE} outputs LOW. The AND gates (4081B) at the row interface are thus disabled. The PL inputs of devices 2 and 3 are LOW. Now, if the input register of device 1 receives four bits of data, then \overline{IRF} output goes LOW. This activates the \overline{TTS} input and the data falls through into the output register of device 1 and the \overline{ORE} output becomes HIGH. Since the \overline{IRF} output of device 2 is HIGH from initialization, the AND gate between devices 1 and 2 is enabled and the PL input of device 2 becomes HIGH. Data from device 1 is loaded into the input register of device 2 causing the \overline{IRF} output of device 2

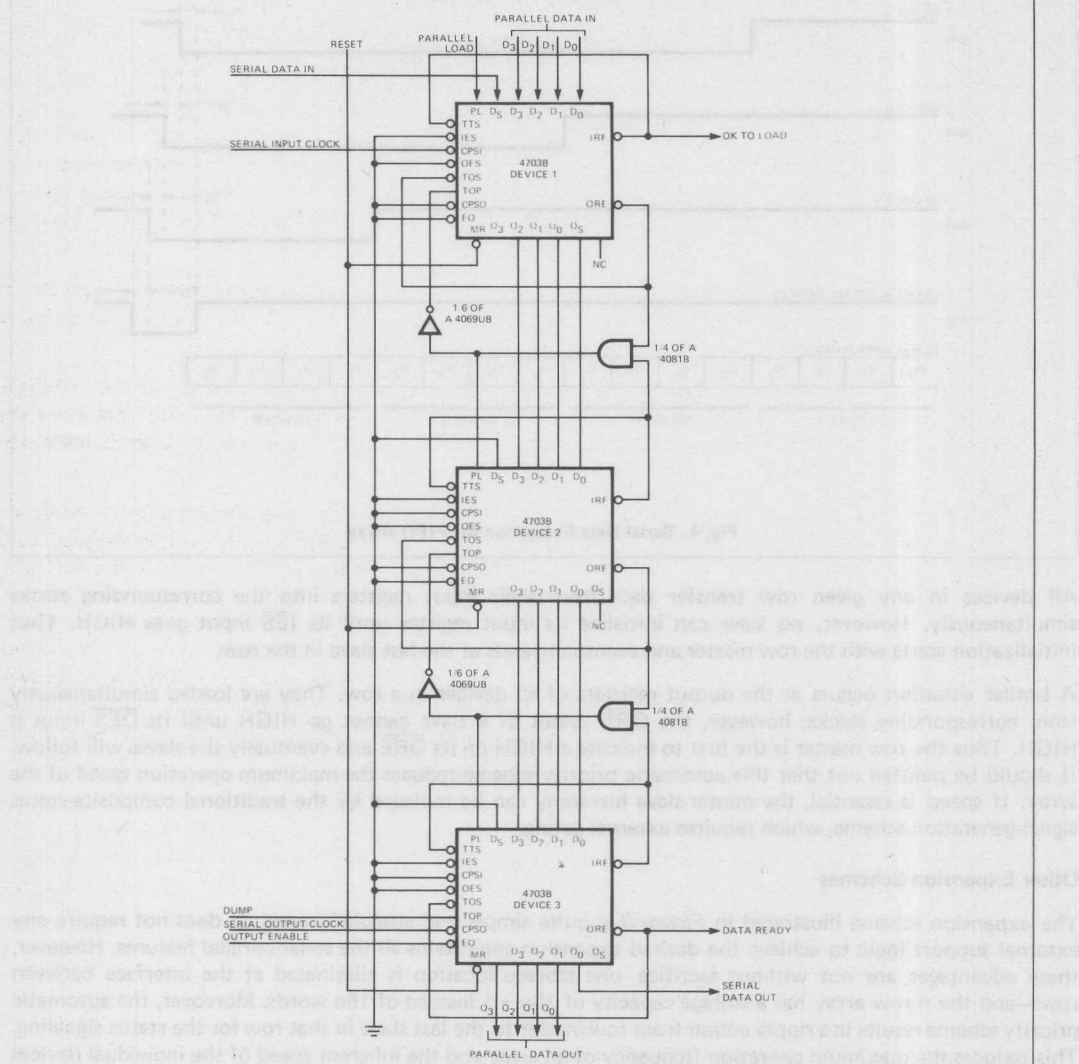


Fig. 5. Expansion without Sacrificing a Storage Location at the Interface

to go LOW. Moreover, a HIGH level on the PL input of device 2 results in a LOW level on the TOP input of device 1. As a result, the \overline{ORE} output of device 1 also becomes LOW. Either way, the AND gate is disabled and the PL input of device 2 goes LOW and the TOP input of device 1 becomes HIGH.

The LOW level on the \overline{IRF} output of device 2 activates its \overline{TTS} input and initiates a fall-through action; the data appears at the output register. Because the TOP input of device 1 is HIGH, new data arrives at the device 2 output register. When data appears at the output of device 2, the AND gate at the interface of devices 2 and 3 is enabled. By a similar action described above, device 3 takes the data word into its input register and passes it on to the output. Thus, if 16 words are loaded at the input to the array, the 1st word is located in the output and the 16th word is in the input register of device 3. Device 3 is full now and its \overline{IRF} output remains LOW until data is extracted. This LOW level disables the AND gate between devices 2 and 3 and hence any arrival of new data into the output register of device 2 does not activate the PL input of device 3. As new data is received, it is arranged in devices 1 and 2 so that the 17th data word falls into the device 2 output register and the 48th word remains in the input register of device 1. Forty-eight data words fill all devices in the array. Under these conditions, the status output is as follows: the \overline{IRF} outputs of devices 1, 2 and 3 are LOW and the \overline{ORE} outputs of devices 1, 2 and 3 HIGH.

The data extraction takes place when the TOP input of device 3 is activated; normally it is HIGH. To extract data, TOP is made LOW and then HIGH. When the TOP input is LOW, the \overline{ORE} of device 3 goes LOW. When TOP is returned HIGH, data is demanded from the stack.

The internal control in device 3 loads the second data word into the output register and the \overline{ORE} goes HIGH. The internal control also initiates a fall-through action in device 3. Thus, the 16th data word that was located in the input register is transferred into the device 3 stack and the input register is initialized. Thus, the \overline{IRF} output of device 3 becomes HIGH.

The 17th data word is located in the output register of device 2, hence the \overline{ORE} output is HIGH. When the \overline{IRF} output of device 3 becomes HIGH, the AND gate at the interface causes the PL input of device 3 to go HIGH and the TOP input of device 2 LOW. The 17th data word then goes into the input register of device 3. The internal control of device 2 initiates fall-through action so that the 18th word falls into the output and the 32nd word is transferred into the stack. This results in a HIGH at the \overline{IRF} output of device 2. Similar action takes place between devices 1 and 2 with the net result that all data has fallen one location creating a vacancy in the input register of device 1. It is now clear that this FIFO array has a 48-word capacity without affecting the serial/parallel data feature at the input or the output. It can then be concluded that if an array of n rows is constructed using the proposed scheme, the effective storage capacity of the FIFO is $16n$ words.

The array of *Figure 6* has all the features and yet operates at a higher speed than the array shown in *Figure 2*. Whenever the \overline{IRF} output of device 1 is HIGH, the \overline{IES} inputs of devices 2, 3 and 4 are also HIGH. Therefore, when the array is initialized by a LOW level on the \overline{MR} inputs, device 1 is the row master and devices 2, 3 and 4 are the slaves. In the second row of devices, the \overline{IRFs} and \overline{IESs} are interconnected so that device 5 is also a row master and devices 6, 7 and 8 are slaves.

When serial data is entered into the array, device 1 receives the first four bits of data. Devices 2, 3 and 4 do not respond to the clock since all three \overline{IES} inputs are HIGH. After the 4th bit, the \overline{IRF} output of device 1 is LOW. This disables device 1 from responding to the clock and enables device 1 so that the next four bits are entered into device 2. Devices 3 and 4 remain disabled by a HIGH level on the \overline{IES} inputs. After the 8th bit, the \overline{IRF} of device 2 becomes LOW, thus disabling device 2 and enabling device 3. After the 12th bit, the \overline{IRF} output of device 3 is LOW and thus device 4 is enabled. After the 16th bit, the \overline{IRF} output of device 4 is LOW. So far, the serial data entry into this array is identical to that for the array in *Figure 2*.

The LOW level on the \overline{IRF} output of device 4 activates the \overline{TTS} inputs of all 4 devices, causing the transfer of data into the stacks. Although all devices transfer data into the stack simultaneously, device 1 (row master) is the first to initialize its input register. Since devices 2, 3 and 4 are slaves, they need a HIGH on their \overline{IES} inputs for input-register initialization. As soon as the \overline{IRF} output of device 1 goes HIGH due to initialization, the \overline{IES} inputs of devices 2, 3 and 4 become HIGH and their input registers are initialized simultaneously. This is in contrast to *Figure 2* where device 3 has to wait for device 2 to initialize, etc. The ripple action of input initialization has been overcome by simple gating. The \overline{IRF} outputs of devices 1,

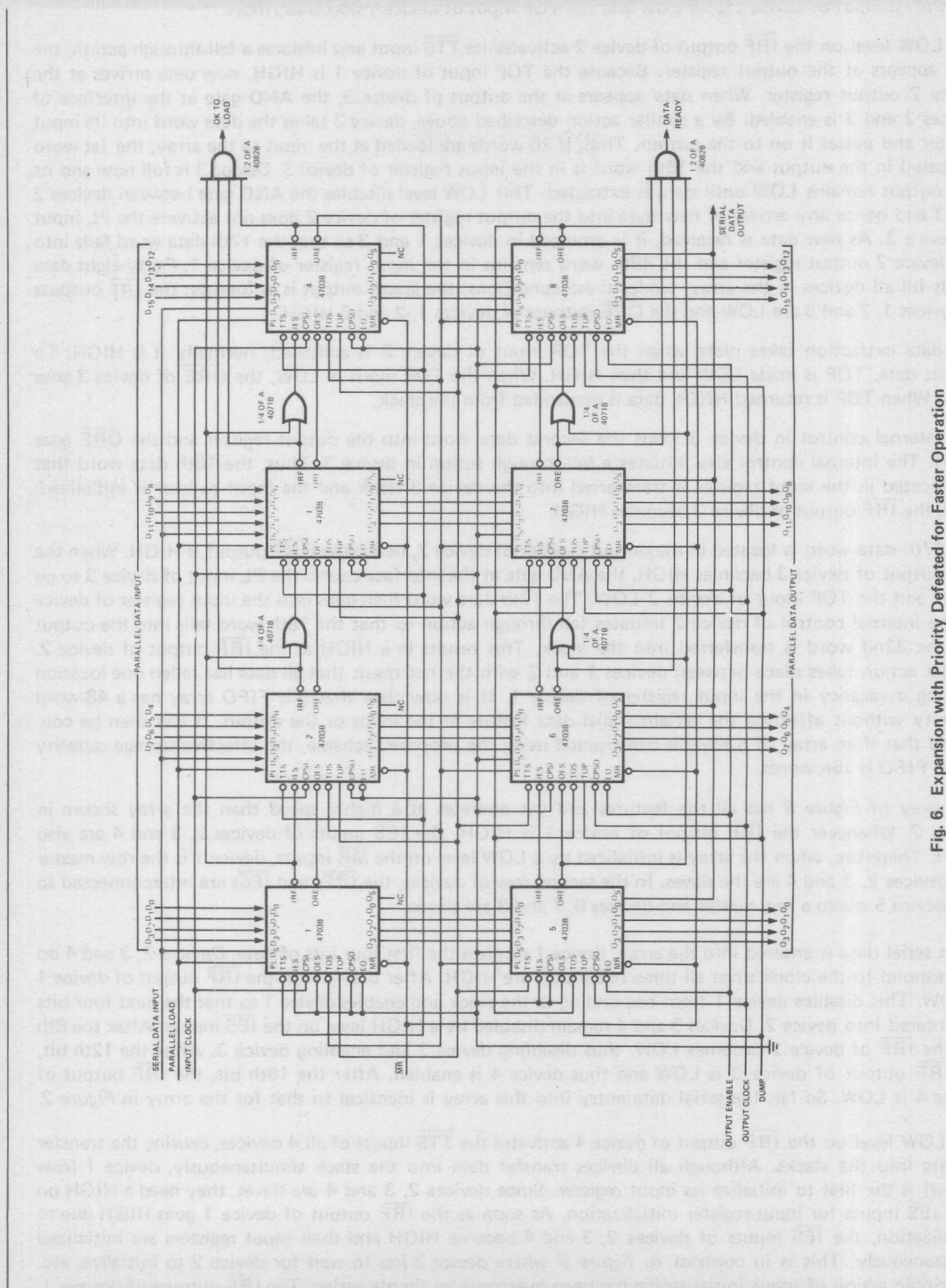


Fig. 6. Expansion with Priority Defeated for Faster Operation

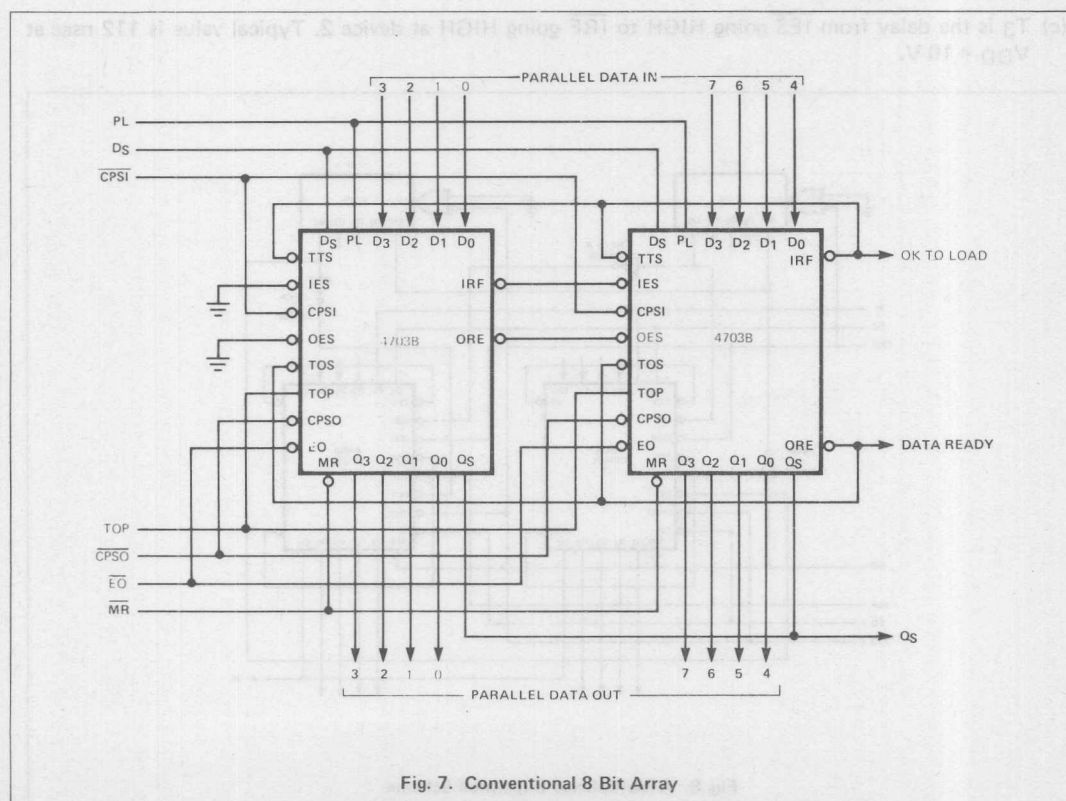
2, 3 and 4 are fed into 4-input AND gates (4082B) to generate the composite input status. To obtain an indication that the input register of the array is empty, the input register of each device in the first row should be empty.

The \overline{ORE} and \overline{OES} interconnections for the second row are essentially similar to the input section. This gating at the output section eliminates the rippling effect of the output status indication. If the gating arrangement used in Figure 5 is incorporated into the array of Figure 6, the result is a 32 word x 16-bit FIFO network.

As shown in Figure 8, higher FIFO speeds may also be attained by adding one 4518B and implementing a multiplexed expansion scheme. Figure 7 shows the conventional horizontally expanded 8-bit array with 16 words of storage.

Serial data is entered using the D_S as the data input and $CPSI$ as the clock input. Shifting takes place on the HIGH-to-LOW transition of the $CPSI$ input. When the first four bits of data are entered into device 1, its \overline{IRF} output goes LOW indicating that its input register is full. The LOW on the \overline{IRF} output of device 1 enables device 2 and disables device 1. Device 2 will shift the next four data bits into its input register. When the input register of device 2 is full, its \overline{IRF} output goes LOW. The LOW on the \overline{IRF} output of device 2 activates the \overline{TTS} inputs of both devices. Thus, data from the input registers of both devices is loaded into their respective stacks simultaneously. The control logic in each device then initializes its input register in preparation to accept more incoming data.

In Figure 7, device 1 is called the row master and is privileged to initialize its input register first. This results in a HIGH on its \overline{IRF} output. Device 2 (slave) senses this and allows its \overline{IRF} to go HIGH. This master/slave scheme is built into the 4703B so that device to device speed variations do not cause transient false status indications. However, this is effectively a ripple action and limits the ultimate operating speed of the array. A multiplexing scheme is proposed that achieves much higher operating speeds.



A similar scheme is used at the output. The other half of a 4518B counter is used to control the $\overline{\text{OES}}$ inputs. A HIGH-to-LOW transition of the $\overline{\text{CPSO}}$ input shifts data out on the QS output. A connection between the $\overline{\text{ORE}}$ output and the $\overline{\text{TOS}}$ input provides automatic data extraction after shifting out four bits of data from a device.

(a) T_1 is the delay from the HIGH-to-LOW transition of $\overline{\text{CPSI}}$ to $\overline{\text{IRF}}$ going LOW at device 2. Typical value is 81 nsec at $V_{DD} = 10 \text{ V}$.

(b) T_2 is the delay from $\overline{\text{TTS}}$ going LOW to $\overline{\text{IRF}}$ going HIGH at device 1. Typical value is 131 nsec at $V_{DD} = 10 \text{ V}$.

(c) T_3 is the delay from $\overline{\text{IES}}$ going HIGH to $\overline{\text{IRF}}$ going HIGH at device 2. Typical value is 112 nsec at $V_{DD} = 10 \text{ V}$.



A new data word cannot begin shifting into device 1 until the $\overline{\text{IRF}}$ output of device 2 is HIGH. Thus, the $\overline{\text{CPSI}}$ clock period is $T_1 + T_2 + T_3$ or 324 nsec typical at $V_{DD} = 10 \text{ V}$.

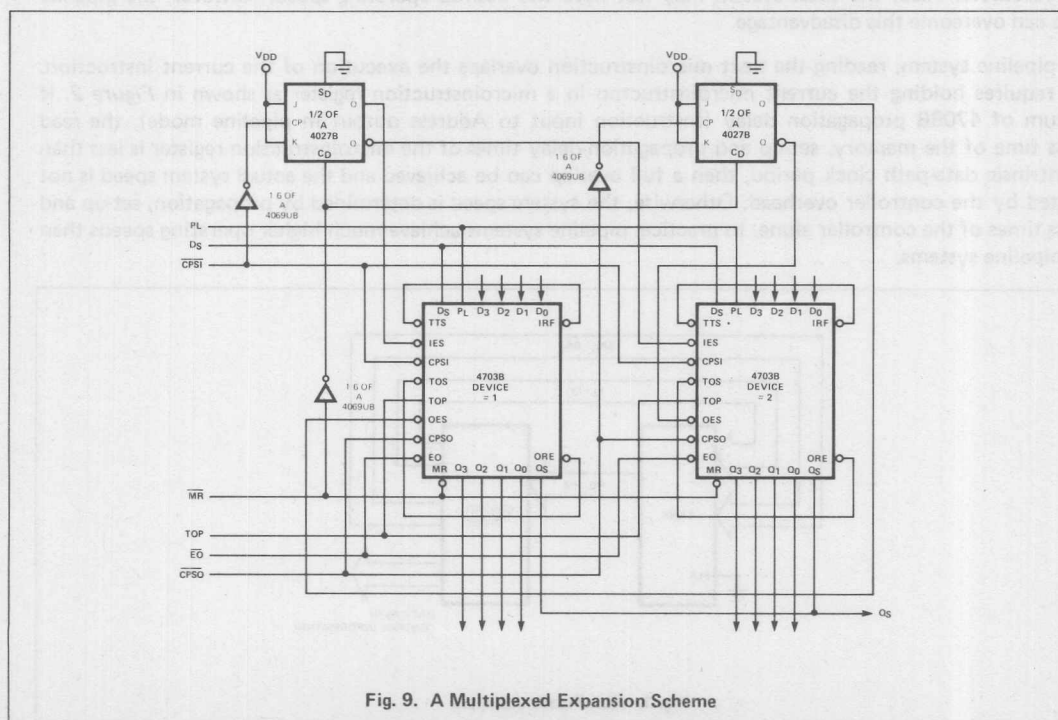
Figure 9 shows another 8-bit network using multiplexed $\overline{\text{IES}}$ inputs. When the array is reset by a LOW pulse on the Master Reset input (MR), the $\overline{\text{IES}}$ input of device 1 is LOW and the $\overline{\text{IES}}$ input of device 2 is HIGH. This establishes device 1 as the row master and device 2 as the slave. The first HIGH-to-LOW $\overline{\text{CPSI}}$ transition shifts the first data bit into device 1. This transition complements the flip-flop also. The $\overline{\text{IES}}$ of device 1 goes HIGH and the $\overline{\text{IES}}$ of device 2 goes LOW. The second data bit will shift into device 2 and the flip-flop toggles again. The third data bit will shift into device 1 and so on. When the seventh data bit is shifted into device 1, its input register becomes full. The $\overline{\text{IRF}}$ output becomes LOW; thus, the $\overline{\text{TTS}}$ input of device 1 is activated. This causes the device 1 to transfer its data into its stack and initialize its input register. In the meantime device 2 can receive the eighth data bit. In Figure 9 the propagation delays are as follows:

- (a) T_1 is the delay from the HIGH-to-LOW $\overline{\text{CPSI}}$ transition to $\overline{\text{IRF}}$ going LOW at both devices 1 and 2. Typical value is 81 nsec at $V_{DD} = 10 \text{ V}$.
- (b) T_2 is the delay from $\overline{\text{TTS}}$ going LOW to $\overline{\text{IRF}}$ going HIGH for both devices 1 and 2. Typical value is 131 nsec at $V_{DD} = 10 \text{ V}$.

The $\overline{\text{CPSI}}$ clock period in Figure 9 is then $T_1 + T_2$ or 212 nsec typical at $V_{DD} = 10 \text{ V}$. This is a significant improvement over that calculated for Figure 7.

A similar flip-flop scheme is used at the output to control the $\overline{\text{OES}}$ inputs. The HIGH-to-LOW transition of the $\overline{\text{CPSO}}$ shifts out the data on the Q_S output. Note that serial data bits come out in the same order as they are entered at the input. The connection between the $\overline{\text{ORE}}$ and $\overline{\text{TOS}}$ of the devices is to accomplish automatic data extraction after shifting their four bits of data.

It should be noted that if any attempt is made to clock data at the input when both $\overline{\text{IRF}}$ outputs are LOW, a data overrun condition exists. A LOW on the $\overline{\text{IRF}}$ input indicates that the input register is full. Similarly, if the $\overline{\text{ORE}}$ outputs are LOW and an attempt is made to shift out data, then an overrun condition exists, also. A LOW on the $\overline{\text{ORE}}$ indicates that no valid information is present in the output register.



MICROPROGRAMMING WITH PROCESSOR ORIENTED MACROLOGIC

Microprogram Execution Modes

Any microprogrammed system, in effect, consists of two major elements—a controller and controllee (data path). The data path usually consists of ALUs, general registers, stacks etc., and can readily be implemented with Macrologic devices (ALRS, DPS etc.). The controller for operating the data path can be designed to perform in either pipeline or non-pipeline mode. The non-pipeline controller is simply a 4708B and a control store that usually consists of a PROM (ROM) or RAM (*Figure 1*). In a pipeline system, an edge-triggered microinstruction register is needed in addition to the memory and the 4708B (*Figure 2*).

In a non-pipeline system, a microinstruction is read from the control store and executed in the same clock cycle. No attempt is made to read the control store for the next microinstruction until the execution of the current instruction is complete.

Most microprogrammed systems are designed as synchronous machines. The actual data-path logic dictates the maximum frequency at which the data path will operate properly. However, a non-pipeline system cannot be run at this speed because of the overhead imposed by the controller. Reading a microinstruction involves setting up the address and accessing the memory. Because of the synchronous nature of the system, setting up the address is in sympathy with the clock. The sum of the 4708B propagation delay (CP to Address outputs) and the read access time of the memory should be added to the allowable clock cycle time of the data path to arrive at the actual system speed. The overhead imposed by the microprogram controller could be a significant percentage of the data-path speed. This is an inefficient use of the data-path resources. Also, the total system may not have the desired operating speed. However, the pipeline mode can overcome this disadvantage.

In a pipeline system, reading the next microinstruction overlaps the execution of the current instruction. This requires holding the current microinstruction in a microinstruction register as shown in *Figure 2*. If the sum of 4708B propagation delay (Instruction input to Address output in pipeline mode), the read access time of the memory, set-up and propagation-delay times of the microinstruction register is less than the intrinsic data-path clock period, then a full overlap can be achieved and the actual system speed is not affected by the controller overhead. Otherwise, the system speed is determined by propagation, set-up and access times of the controller alone. In practice, pipeline systems achieve much higher operating speeds than non-pipeline systems.

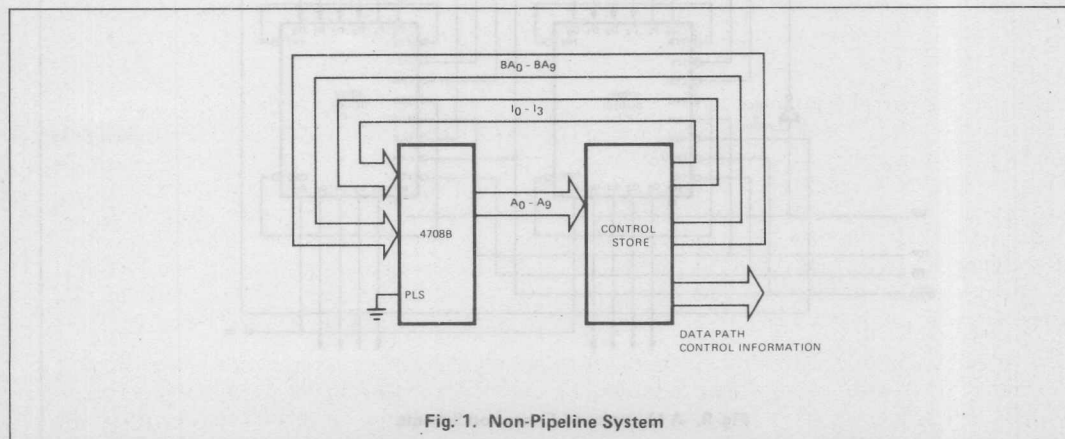


Fig. 1. Non-Pipeline System

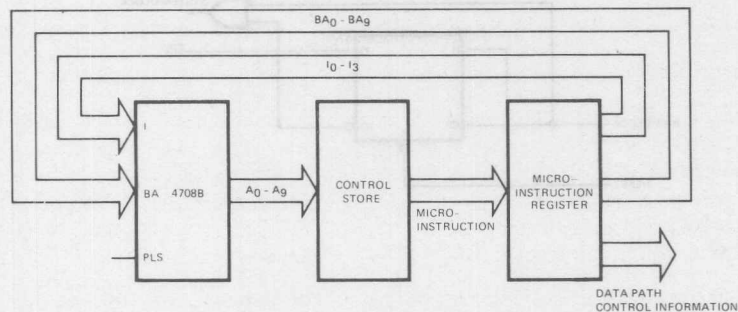


Fig. 2. Pipeline System

In many instances, a microprogram written for non-pipeline system cannot be executed in pipeline mode. However, 4708B architecture is designed so that the same microprogram can be executed in pipeline or non-pipeline mode without any modification. This feature gives the user a distinct advantage since he can design his high end product with pipeline execution and lower end product with non-pipeline. No micro-program changes are required thus significant cost advantages can be realized.

Initializing The Microprogram

In microprogrammed systems, the current control-memory address identifies the current control state, while the contents of the addressed location, i.e. microinstruction, provides the information required to establish proper control-signal combinations for the data path and to choose the next address. A micro-programmed system is inherently a sequential machine and initialization of the controller is necessary for proper system operation.

Initialization of the non-pipeline systems is rather straightforward. Whenever the 4708B \overline{MR} input is LOW, the program counter (PC) is cleared and hence all the Address outputs of the 4708B will be LOW. This address then defines the starting location for the microprogram execution. The PC is held clear as long as the \overline{MR} input is LOW. A simple initialization scheme is shown in Figure 3. The flip-flop is held clear by a low-level Reset input. The Q output of this flip-flop is connected to the \overline{MR} input of the 4708B. As long as the reset signal is LOW, the Raw Clock signal is blocked by the OR gate, due to the HIGH level from the \overline{Q} output, thus the System Clock output will be HIGH. When the Reset input goes HIGH, the following LOW-to-HIGH transition of the Raw Clock sets the flip-flop. The OR gate passes the Raw Clock input as the System Clock which then can be used to drive the data path and the CP input of the 4708B.

In a pipeline system, merely addressing the starting location is not enough. The first microinstruction must be loaded into the microinstruction register to prime the pipe. The Raw Clock can be used for this purpose—a LOW-to-HIGH transition loads the microinstruction register. As before, the System Clock operates on the data path and the 4708B.

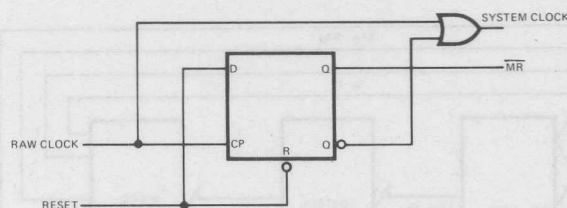


Fig. 3. Initialization Circuit

Sharing The Control Fields For Next Address

A straightforward microinstruction consists of fields for specifying data-path control and an explicit specification of the next address. An explicit next-address specification is mandatory in many microprogram sequencer architectures. However, in the 4708B, a Fetch instruction is provided to facilitate writing a microprogram where a large number of instructions fit naturally into sequential memory locations. The next address for a Fetch instruction need not be explicit; it is always implied to be $PC + 1$. In general, the total number of bits required for the data-path control (total control-field width) is more than the number of bits needed to explicitly specify the next address. Thus, if there is an easy way to use the control fields, or part of them, to specify the address, significant reduction of the microinstruction width can be achieved. The Inhibit output of the 4708B is provided to facilitate sharing of microinstruction fields.

There are two 4708B instructions that do not require next-address specification, FTCH and RTS. The remaining 14 instructions fall into a branch class requiring an external next address. The Inhibit output is LOW for FTCH and RTS only and HIGH for all other instructions. Thus, if the system clock can be inhibited from operating the data path whenever the Inhibit output is HIGH, then the microinstruction field that normally operates on the data path can be fed into the 4708B as the next address. Inhibiting the data path operation is extremely simple with the Macrologic processor elements. In some Macrologic systems, the devices are connected as a bussed system; an example is shown in *Figure 4*. Although the 4705B and 4706B devices derive their instructions from the same microinstruction field, either the 4705B or the 4706B can be individually selected to respond to an instruction by controlling the $\bar{E}X$ inputs. Macrologic systems can employ an encoded field in the microinstruction, called destination field, for this purpose. A decoder is commonly used to drive the individual $\bar{E}X$ inputs. Now, if the Inhibit output of the 4708B is connected to the Enable input of the decoder, all $\bar{E}X$ inputs are HIGH for branch-class instructions. Thus clocking would not affect the devices. This technique of sharing fields is beneficial only if a large percentage of the operations is from sequential memory locations with an occasional random branch. If a microprogram has many branch instructions, the extra clock cycle needed for branch operation may affect the system speed.

Handling The Test Inputs

In microprogrammed systems, it is often necessary to test the status of external conditions. Often, these inputs are derived from the ALU of the data path as condition codes. For example, the ALRS (4705B) provides four status signals—Carry (\bar{W}), Negative (\bar{X}), Overflow (\bar{Y}), and Zero (Z). These signals can be connected to the $T_0 - T_3$ inputs of 4708B so that a LOW-to-HIGH transistion of the STRB will load them

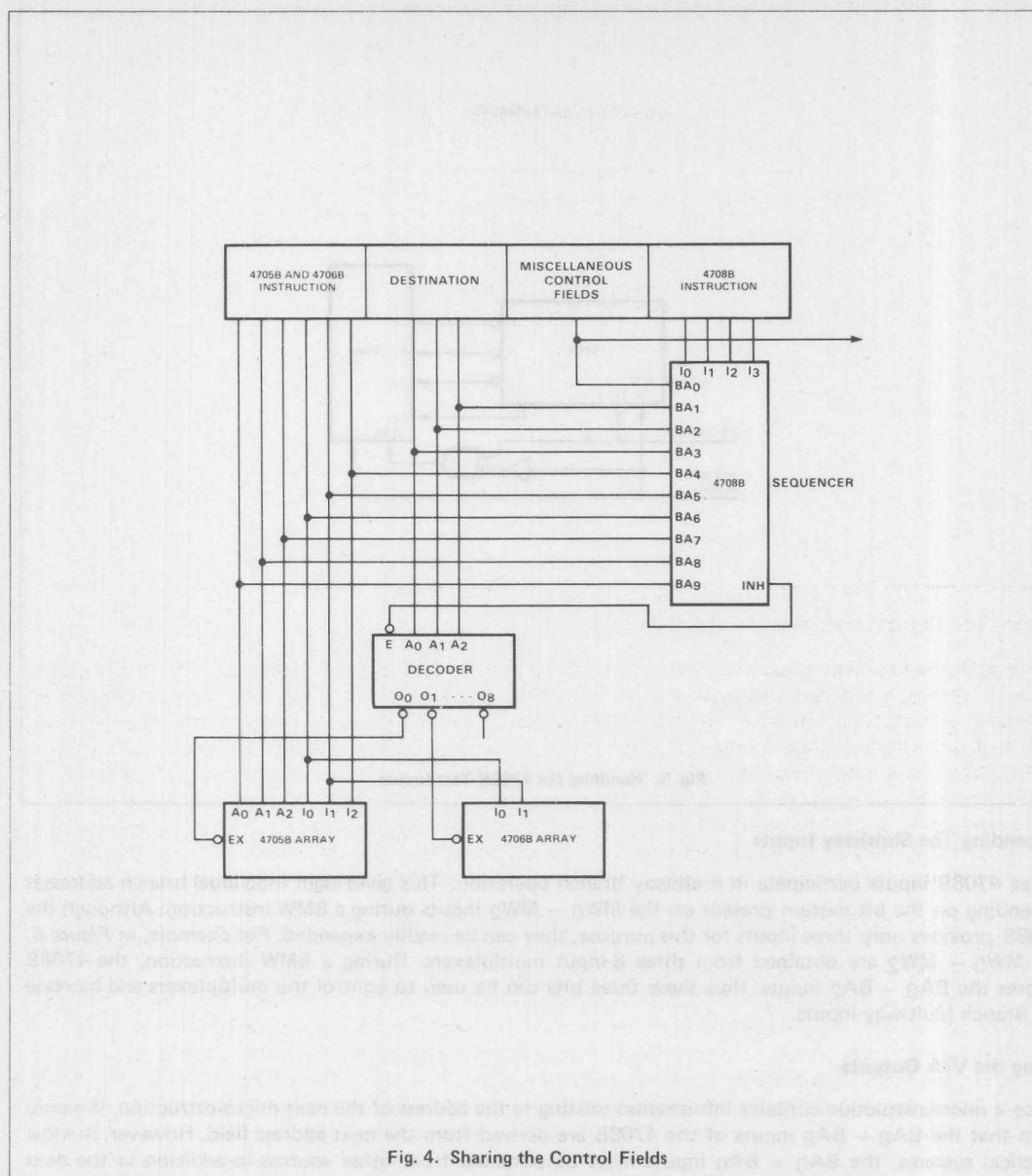


Fig. 4. Sharing the Control Fields

into the 4-bit test register. Although the STRB and CP inputs of the 4708B can be connected together, in most systems, the STRB input is derived from the system clock by appropriate gating. This is done so that the test register is only affected during those microinstructions that involve an ALU operation. *Figure 5* illustrates test-input handling. In both modes of operation, the ALRS status can be stored in the 4708B during a microcycle and tested during subsequent microcycles using appropriate conditional branch instructions.

It should be noted that the 4705B provides the status signals towards the end of the microcycle and the system clock should be chosen so that the 4708B set up (test-to-strobe) time is satisfied. In *Figure 5* gating the system clock with \bar{EX} inputs of the 4705B assures that the test register operates only for those microcycles that affect the 4705B.

The single microprocessor example shown in Figure 7 and Table 7 is an assembly of a 1-bit word from a set of data words (SER DATA) using the associated clock (SER CLK). Figure 8 illustrates the assumed timing relationship between SER DATA and SER CLK signals. Consider an 8-bit word data path using two 4708B and two 4704B devices as shown in Figure 9. A 6-bit instruction bus is obtained (4708B field) by the microprocessor bit 4 through bit 9 of the serial stream (see Figure 7a). The 6-bit 4708B field is obtained by connecting 1 through 6 of 4708B devices and using 1 through 6 of each device separately. These six bits are also controlled by an output bit 10 through bit 15 of the control bus. The 4708B provides the 10-bit branch address for the microprocessor instruction bus.

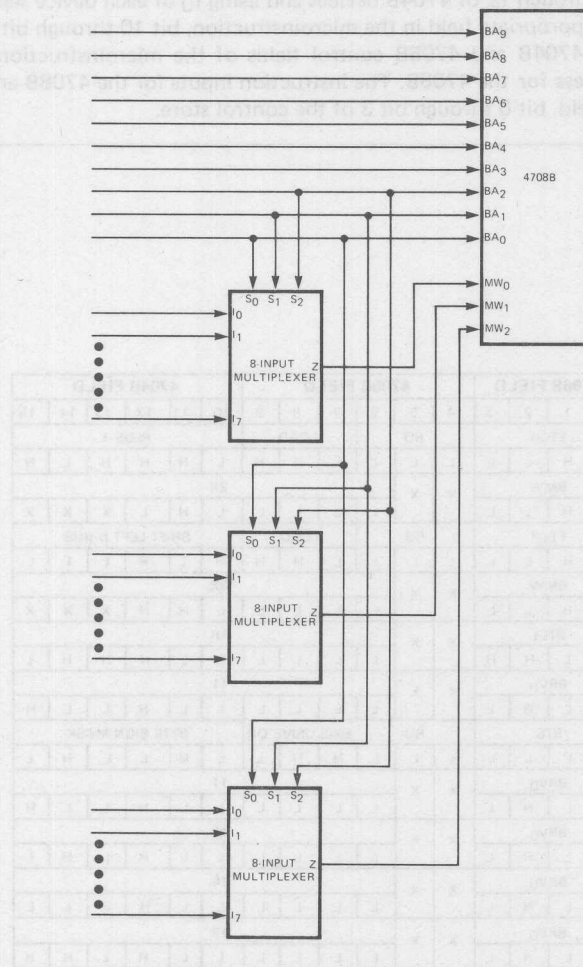


Fig. 6. Expanding Multiway Inputs

A Microprogram Example

The simple microprogram example, shown in *Figure 7* and *Table 1*, is an assembly of a 7-bit word from a serial data stream (SER DATA) using the associated clock (SER CLK). *Figure 8* illustrates the assumed timing relationship between SER DATA and SER CLK signals. Consider an 8-bit wide data path using two 4705B and two 4704B devices as shown in *Figure 7a*. A 6-bit instruction bus is obtained (4705B field) by appropriate connections of the 4705B instruction inputs. These six bits are controlled by an appropriate field in the microinstruction, bit 4 through bit 9 of the control store (see *Figure 7b*). The 6-bit 4704B field is obtained by connecting I₁ through I₄ of 4704B devices and using I₀ of each device separately. These six bits are also controlled by an appropriate field in the microinstruction, bit 10 through bit 15 of the control store. In this illustration, the 4704B and 4705B control fields of the microinstruction are also used to provide the 10-bit branch address for the 4708B. The instruction inputs for the 4708B are provided by the appropriate microinstruction field, bit 0 through bit 3 of the control store.

ADDRESS (Octal)	4708B FIELD				4705B FIELD						4704B FIELD					
	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
10	FTCH				RO			LOAD			PLUS 1					
	L	H	L	L	L	L	L	L	H	H	L	H	H	H	L	H
11	BMW				X	X	2X									
	H	H	L	L			L	L	L	L	L	H	L	X	X	X
12	FTCH				RO			LOAD			SHIFT LEFT D-BUS					
	L	H	L	L	L	L	L	L	H	H	H	L	H	L	L	L
13	BMW				X	X	3X									
	H	H	L	L			L	L	L	L	L	H	H	X	X	X
16	BTL ₁				X	X	16									
	H	L	H	H			L	L	L	L	L	L	L	H	H	H
15	BRV ₀				X	X	11									
	L	L	H	L			L	L	L	L	L	L	L	H	L	L
16	RTS				RO		EXCLUSIVE-OR			BYTE SIGN MASK						
	L	L	L	L	L	L	L	H	H	L	L	H	L	L	H	L
20	BRV ₀				X	X	11									
	L	L	H	L			L	L	L	L	L	L	H	L	L	H
21	BRV ₀				X	X	12									
	L	L	H	L			L	L	L	L	L	L	L	H	L	H
30	BRV ₀				X	X	14									
	L	L	H	L			L	L	L	L	L	L	L	H	H	L
31	BRV ₀				X	X	13									
	L	L	H	L			L	L	L	L	L	L	L	H	L	H

L = LOW Level
H = HIGH Level
X = Don't Care

Table 1. Control Store Listing

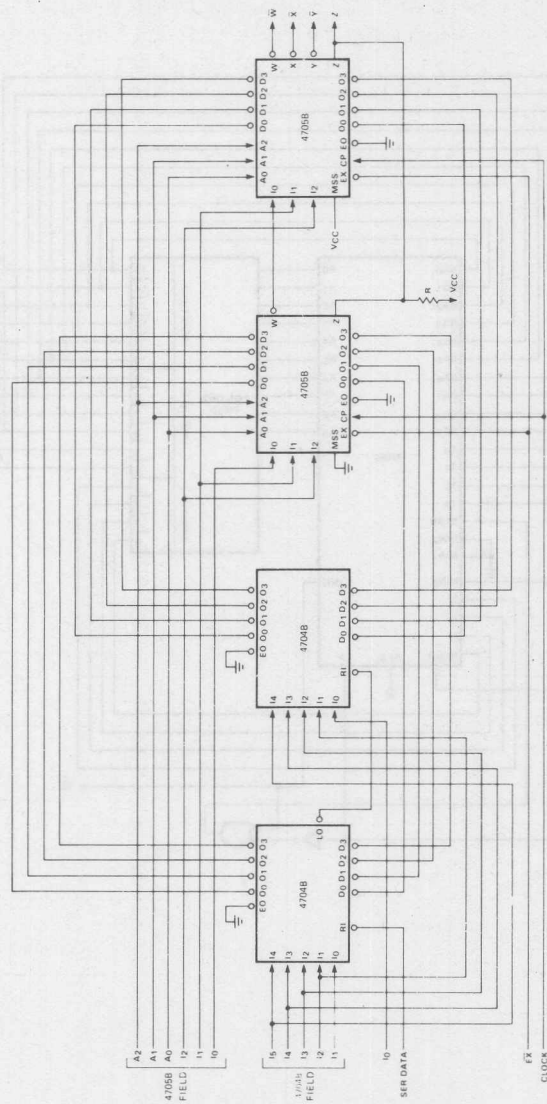


Fig. 7a. Data Path Example

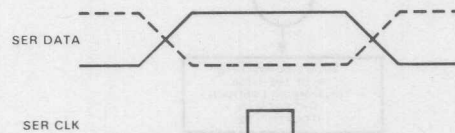


Fig. 8. Timing Relationship between SER DATA and SER CLK

The status outputs from the most significant 4705B, \overline{W} , \overline{X} , \overline{Y} and Z , are connected to the $T_0 - T_3$ inputs of the 4708B although only the \overline{X} output is used in this example. The \overline{EX} inputs of both 4705B's are connected to the INH output of the 4708B. The Clock signal operates the 4705B's and the 4708B. In addition, the Clock is gated with the INH output to operate the STRB input of the 4708B.

The SER CLK input is synchronized to the Clock input by using a synchronizing flip-flop with the Q output connected to the MW₀ input of the 4708B while MW₁ and MW₂ inputs are grounded. The A₀ - A₉ outputs of the 4708B are used to address the control store. The SER DATA is fed into the right shift input of the least significant 4704B.

The flow chart in *Figure 9* shows the sequence of operations assuming the sequence is a subroutine starting at location (10)g in the control store. The program for implementing this flow chart is shown in *Table 1*. Note that register R₀, the first of the eight general purpose registers of the 4705B, is used for the serial-to-parallel conversion. Thus bit 4 through bit 6 (address bits of the 4705B field) are L L L. To indicate that a load operation into R₀ is desired, bit 7 through bit 9 (4705B instruction field) are L H H.

Bit 10 through bit 15 of the microinstruction (4704B instruction field) is L H H H L H so that bit pattern 0 0 0 0 0 0 1 is present at the inputs of the 4705B. This becomes apparent when the 4704B truth table in the data sheet is consulted. (The 4705B treats a LOW level data input as logic "1".) Bit 0 through bit 3 (4708B instruction field) require the 4708B to perform a Fetch for the next instruction.

Location (11)g contains a Branch Multiway, BMW, instruction to determine whether or not the synchronization flip-flop is set. Bit 6 through bit 15 of the microinstruction is specified as L L L L H L X X X where X indicates "don't care". Thus, if the synchronization flip-flop is not set, the 4708B generates L L L L L H L L L as the next address (20)g. At location (20)g, there is a Branch VIA, BRV₀, to location (11)g instruction. Thus, the microprogram loops between location (11)g and (20)g testing for a HIGH on the SER CLK input. When the synchronization flip-flop is set, the BMW instruction at location (11)g results in (21)g as the next address instead of (20)g. Location (21)g contains the instruction "BRV₀ to location (12)g".

The instruction in (12)g shifts the contents of the 4705B to the left and loads the shifted value back into R₀. Because the SER DATA input is connected to the shift input of the 4704B, the information present as the SER DATA input is loaded into R₀. Thus after taking the first data bit, R₀ reads 0 0 0 0 0 0 1 B₁,

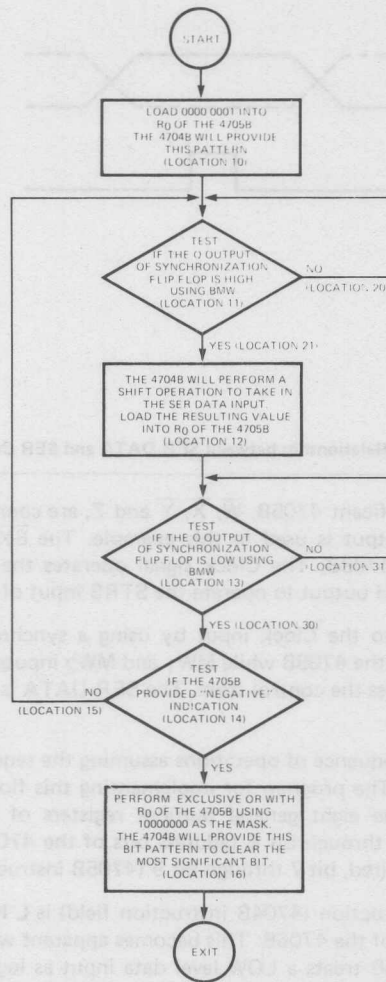


Fig. 9. Sequence of Operation

where B₁ is the first bit assembled. The instruction in location (12)g, specifies a Fetch for the 4708B, thus the INH output is LOW. This activates the EX inputs of the 4705B's. Moreover, the LOW level also enables the gate; thus, the Clock activates the STRB input of the 4708B so that the 4705B status outputs can be loaded into the 4708B test register. As long as the result of an ALU operation is positive, i.e., most significant bit HIGH, the negative status (\bar{X} output of the 4705B) is HIGH.

Location (13)g contains BMW with (3X)g as the next address. Thus if MW₀ input is HIGH, the next address is (31)g; if MW₀ is LOW, the next address is (30)g. Location (30)g contains "BRV₀ to location (13)g" and locations (13)g contains "BRV₀ to (14)g". Thus, as long as SER CLK input is HIGH, the program loops between location (13)g and (31)g. When the synchronizing flip-flop is cleared, the program goes to location (14)g due to the instruction in location (30)g.

At location (14)g, the "Branch Test LOW, BTL₁, to location (16)g" is used to determine when the T₁ input of the 4708B is LOW. It will not be LOW until seven SER DATA bits have been shifted. Instead of branching to (16)g, the program goes to location (15)g, which contains "BRV₀ to location (11)g". The program loops around until seven data bits have been shifted in. At this time, the 4705B has indicated a LOW on its \bar{X} output and the BTL results in a branch to location (16)g.

At location (16)g, the 4704B provides 1 0 0 0 0 0 0 0 as a mask and an exclusive OR is performed in R₀ or the 4705B to eliminate the marker bit that was previously loaded into R₀. R₀ then contains seven data bits assembled from the SER DATA bit stream. It has been assumed that this small program is a subroutine. Therefore, by specifying RTS to the 4708B in location (16)g, a return to the main program is effected.

IMPELMENTING DATA PATHS WITH MACROLOGIC

Individual Macrologic data sheets indicate how each 4-bit slice may be expanded into arrays to handle larger work lengths; these different arrays (*Figure 10*) can be configured to develop the data paths. Since Macrologic elements are designed to be used in bus-organized systems, all devices are provided with 3-state data outputs and an Output Enable (EO) input to control them. Therefore, the data outputs from the arrays can be bussed together to obtain the output bus (*Figure 11*). With a LOW level on the appropriate EO input, an array can be made to source data on to the output bus. For example, in *Figure 11*, a LOW on the EO₁ input selects the ALRS array as the source. The data inputs can also be bussed together to obtain the input bus.

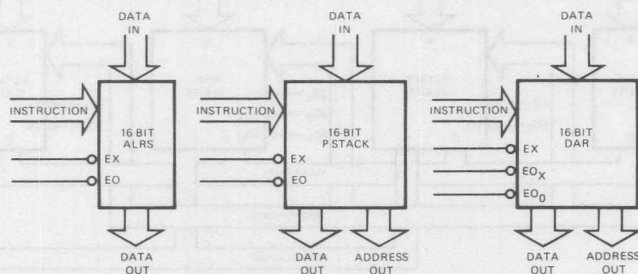


Fig. 10. Typical Macrologic Arrays

needed.

The Macrologic elements are provided with individual \overline{EX} inputs. A device does not respond to the clock unless its \overline{EX} input is LOW. Thus, the instruction inputs can be bussed together to obtain an instruction bus (Figure 12). The individual \overline{EX} inputs are used to control the array chosen to perform the current microinstruction, i.e., the destination. Thus, in Figure 12, a 6-bit field is sufficient for the instruction inputs.

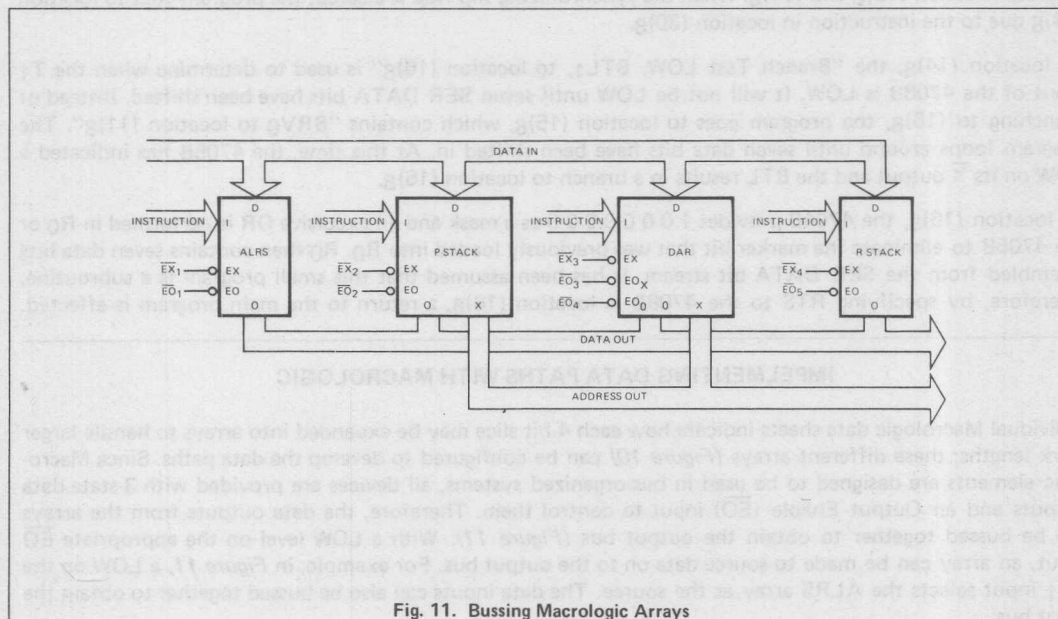


Fig. 11. Bussing Macrologic Arrays

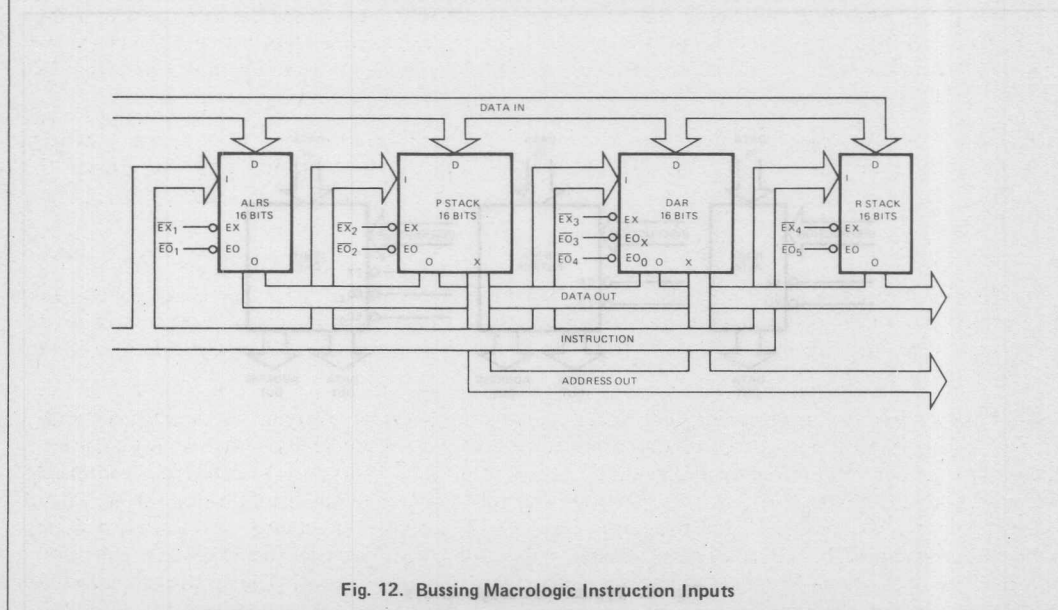


Fig. 12. Bussing Macrologic Instruction Inputs

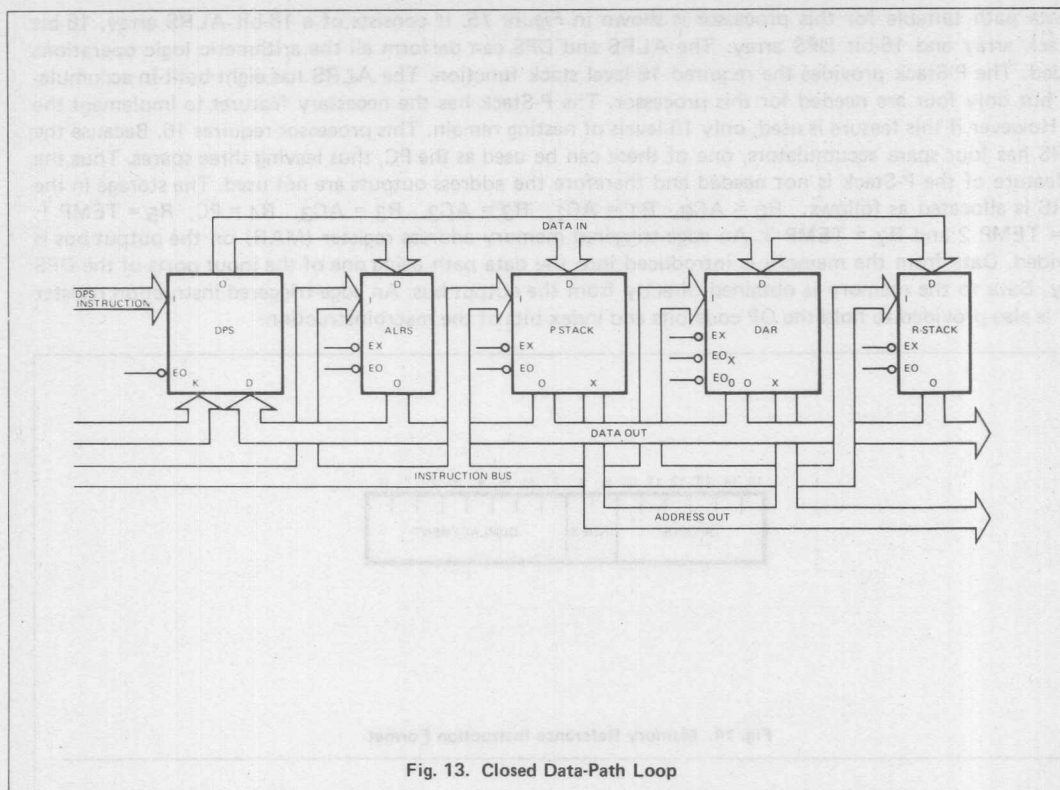


Fig. 13. Closed Data-Path Loop

Experience indicates that data paths in microprogrammed systems are closed loop, therefore, a means should be provided for the output bus to communicate with the input bus. The Macrologic DPS element is ideally suited for this purpose (*Figure 13*) since it has two identical input ports. One port can be used to close the data-path loop while the other is used to introduce data from external sources into the data paths. The DPS is a combinatorial device and hence will always operate on the data; in many cases the operation may be just to pass the input to the output. Thus it will always require an instruction input and cannot be bussed with the instruction bus.

It can be concluded that the basic steps involved in data path configuration are, first, choose arrays of desired word lengths and desired functions, then arrange them into a bus organization similar to *Figure 13*.

A SIMPLE PROCESSOR EXAMPLE

One of the many possible Macrologic applications is to implement emulators for existing instruction sets. These complex functional LSIs offer improved cost and performance while retaining software compatibility with the target machine. A simple 16-bit processor is a good example to demonstrate the ease of use and versatility of Macrologic.

The 16-bit fixed word-length processor, with four accumulators ($AC_0 - AC_3$) and 2s complement arithmetic, has a 16-word push/pop stack for subroutine nesting, as well as general use. The memory reference instruction format is shown in *Figure 14*. The 2-bit index field in the instruction specifies four addressing modes—base page, PC relative, AC_2 and AC_3 relative. For the base-page mode, the 8-bit displacement field of the instruction is taken as the absolute address i.e., first 256 memory locations. For the relative mode, the 8-bit displacement is treated as a signed number in 2s complement notation and added to the Program Counter (PC relative) or one of the specified accumulators (AC_2 or AC_3 relative). The result then is used as the effective address for the operand.

A data path suitable for this processor is shown in *Figure 15*. It consists of a 16-bit ALRS array, 16-bit P-Stack array and 16-bit DPS array. The ALRS and DPS can perform all the arithmetic logic operations needed. The P-Stack provides the required 16-level stack function. The ALRS has eight built-in accumulators but only four are needed for this processor. The P-Stack has the necessary features to implement the PC. However, if this feature is used, only 15 levels of nesting remain. This processor requires 16. Because the ALRS has four spare accumulators, one of these can be used as the PC, thus leaving three spares. Thus the PC feature of the P-Stack is not needed and therefore the address outputs are not used. The storage in the ALRS is allocated as follows: $R_0 = AC_0$, $R_1 = AC_1$, $R_2 = AC_2$, $R_3 = AC_3$, $R_4 = PC$, $R_5 = TEMP\ 1$, $R_6 = TEMP\ 2$ and $R_7 = TEMP\ 3$. An edge-triggered memory address register (MAR) on the output bus is provided. Data from the memory is introduced into the data path using one of the input ports of the DPS array. Data to the memory is obtained directly from the output bus. An edge-triggered instruction register (IR) is also provided to hold the OP code bits and index bits of the macroinstruction.



Fig. 14. Memory Reference Instruction Format

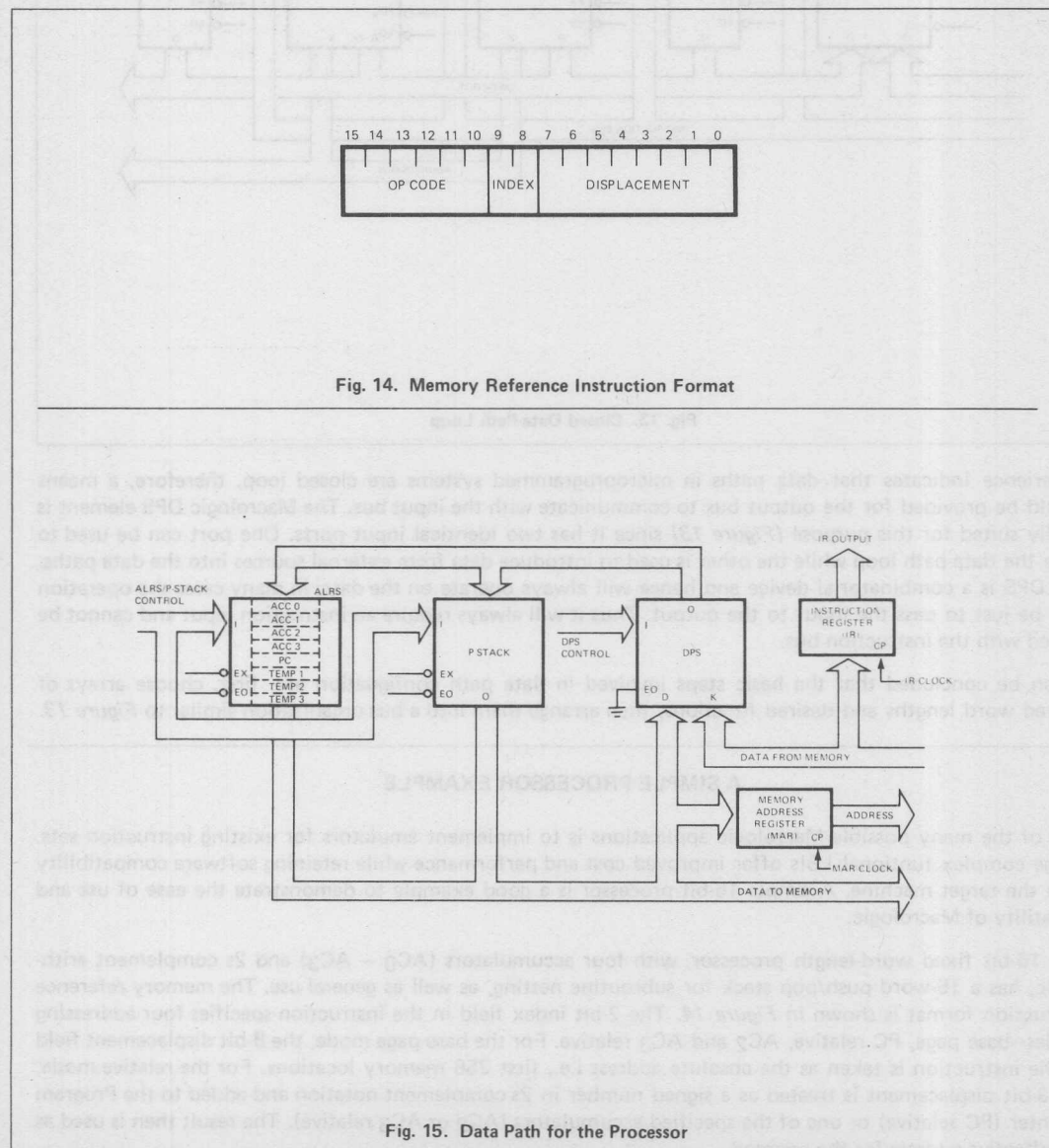


Fig. 15. Data Path for the Processor

Figure 16 illustrates the microprogram control section for the data path. This control is centered around the 4708B sequencer operating in the pipeline mode. The INH output of the 4708B is used to share the control fields. Thus, the source, destination, and ALRS/P-stack control fields provide the 10-bit address for branching when needed. A 6-bit DPS control field provides the instruction inputs for the DPS array while the 4-bit SEQ field provides the instruction inputs for the 4708B. Other fields lumped as miscellaneous are used to control the memory etc.

The Source and Destination fields are decoded to activate the \overline{EO} and \overline{EX} inputs (see Figure 16). Note that the IR Clock and MAR Clock signals are generated by gating the system clock with the appropriate destination decoder outputs. The branch address inputs (BA₀ — BA₉) are obtained from a 4-way input multiplexer which, in turn, is controlled by the VIA₀ and VIA₁ outputs of the 4708B. One of the inputs to this multiplexer consists of the address inputs for branching from the microinstruction register. The second port is fed by a mapper that may be a PROM or FPLA. It receives the IR outputs and translates them into a starting address in the control memory for emulation. Figure 17 is a flow chart for the sequence of operations to accomplish macroinstruction fetch while Table 2 lists the operations performed by various data path elements and the 4708B.

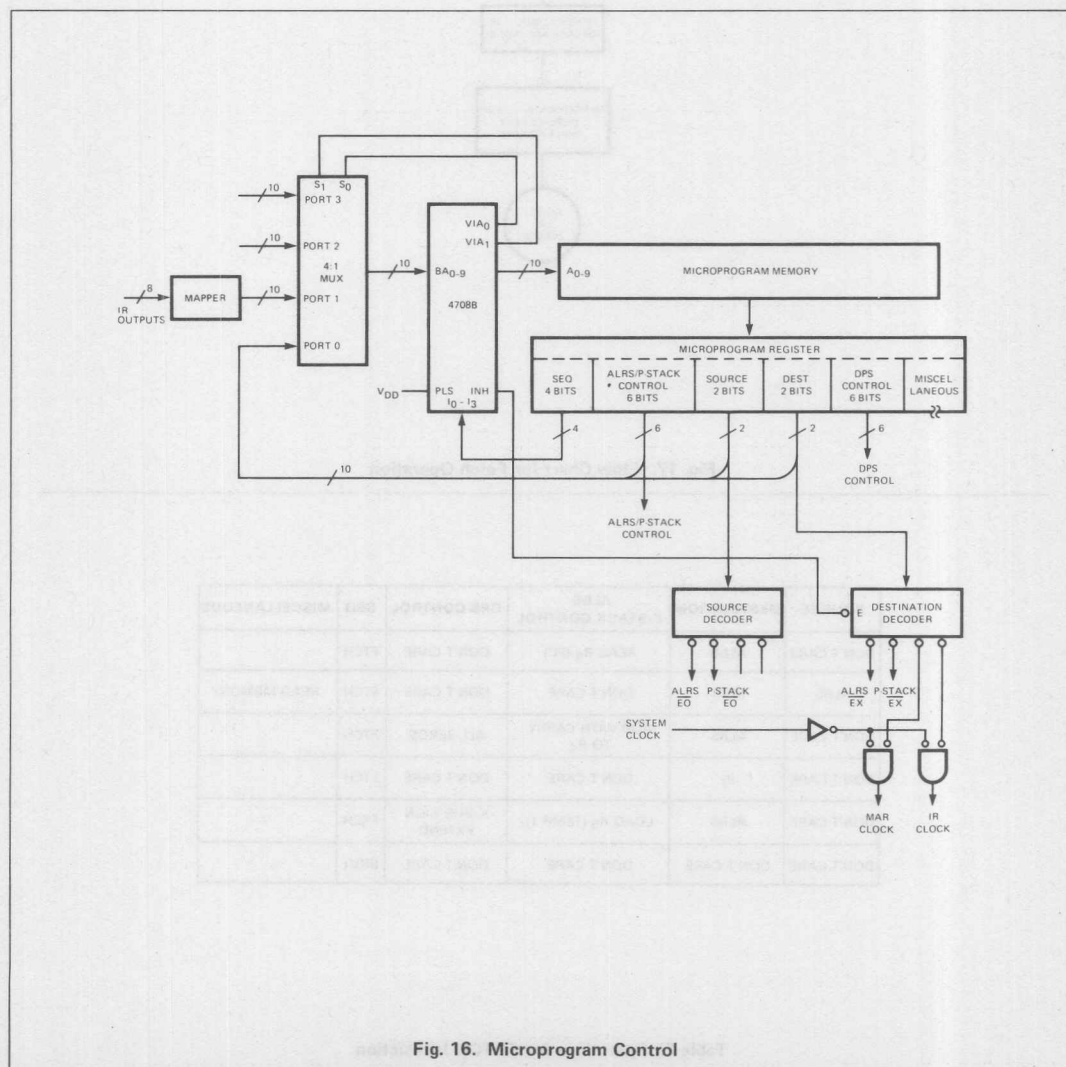


Fig. 16. Microprogram Control

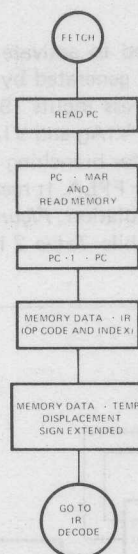


Fig. 17. Flow Chart for Fetch Operation

SOURCE	DESTINATION	ALRS/ P-STACK CONTROL	DPS CONTROL	SEQ	MISCELLANEOUS
DON'T CARE	ALRS	READ R ₄ (PC)	DON'T CARE	FTCH	...
ALRS	MAR	DON'T CARE	DON'T CARE	FTCH	READ MEMORY
DON'T CARE	ALRS	ADD WITH CARRY TO R ₄	ALL ZEROS	FTCH	...
DON'T CARE	IR	DON'T CARE	DON'T CARE	FTCH	...
DON'T CARE	ALRS	LOAD R ₅ (TEMP 1)	K-BUS SIGN EXTEND	FTCH	...
DON'T CARE	DON'T CARE	DON'T CARE	DON'T CARE	BRV ₁	...

Table 2. Operations for FETCH Instruction

The first operation is to read the PC. Thus, the destination field specifies the ALRS and the destination decoder drives the $\overline{\text{EX}}$ input of the ALRS LOW. The ALRS/P-stack control field specifies "read R4". At the end of the microcycle, the contents of R4, i.e., the PC, are in the output register of the ALRS. The SEQ field of the first microinstruction is FTCH, therefore, the 4708B generates the address of the second microinstruction.

Here, the ALRS is specified as the source and the MAR as the destination. The source decoder activates the $\overline{\text{EO}}$ input of the ALRS, the destination decoder enables the gating for the MAR Clock, and the microinstruction loads the PC into the MAR. In the miscellaneous field, a memory Read is initiated. The third microinstruction is made to increment R4 by selecting ALRS as the destination specifying Add with Carry. The DPS outputs (ALRS inputs) are forced HIGH. This incrementation is in preparation for the next macroinstruction fetch. The result from the memory read operation, initiated during the second microinstruction, is now available on the K-bus of the DPS. The fourth microinstruction activates the IR clock so that the eight most significant bits of the memory data are loaded into the IR. Assuming the data is still on the bus, the sign extended displacement is loaded into R5 (TEMP 1) of the ALRS in the fifth microcycle by selecting "Load R5" as the ALRS operation and selecting the "K-bus sign extend" for the DPS. It should be recalled that the data path has a 16-bit fixed word length and the displacement must be treated as a 2s complement number. By using the sign extension capabilities of the DPS, the sign bits, i.e., most significant bits, can be aligned. At this point, the instruction is in the IR and the sign extended displacement is in TEMP 1. The sign of the least significant eight bits of the macroinstruction is extended in anticipation of a memory reference instruction. The sixth microcycle is intended to decode the IR. By specifying a BRV1 in the SEQ field, the VIA outputs of the 4708B select the mapper output as the source for next address. The mapper is designed to provide the starting address of the routine to emulate the instruction currently residing in the IR.

The total microprogram really consists of several simple routines. These easy steps can be converted into binary patterns to be loaded into the control store. Once a data path architecture and microinstruction format has been chosen for a given system design, the microprogram can be written to realize the desired function. It can then be assembled, using the microprogram assembler, to get the binary listing that specifies the control store address and contents. Using this information, the control store can be loaded with the program and the system is ready for operation.

MACROLOGIC ASSEMBLERS

Macrologic users, designing programmed logic systems, find a need for a microprogram assembler to aid in software development. To fill that need, Fairchild offers a choice of assembler software, the microprogram assembler and DAPL, available through two different worldwide time share networks.

Microprogram Assembler

The microprogram assembler is an aid in the preparation of a microcode. The user defines his own mnemonics to represent meaningful binary bit patterns and using the symbolic language thus created, writes the program. The microprogram assembler translates the symbolic language into binary code and produces punched card, disk or tape output for each program step. The same information is also printed along with indications of errors that were present in the input statements. Access to the microprogram assembler is easily arranged from anywhere in the world.

The microprogram assembler is available at the Computer Usage Company, Data Center, Sunnyvale, California. (408-738-4300).

DAPL

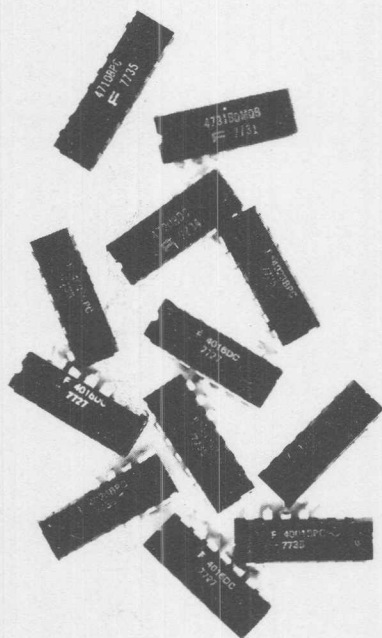
DAPL is a highly modular microprogramming language for the Fairchild Macrologic series. Constructed in four concentric and compatible levels, the microprogrammer selects the DAPL feature that provides a convenient symbolic representation of a particular microprogram. Macros and symbolic values may be used at all DAPL levels. Level 0 essentially permits the microinstructions to be formed by sequences of symbolic names and binary, octal, decimal, and hexadecimal numbers. In Level 1, microinstructions are defined as

a series of fields with each field sequentially assigned a value as in Level 0. Additionally, label tables can be incorporated for mapping ROMs and PLAs. Level 2 extends the microinstruction field definition to include symbolic names and default values. Finally, Level 3 allows the expression of microprograms in register transfer notation.

Other DAPL features include:

- Microprogram accommodation up to 8192 words by 256 bits.
- Free form input with comments arbitrarily interspersed for documentation.
- An interlist command that lists the generated microcode directly beneath the associated microinstruction.
- A complete variable cross-reference listing.
- Extensive error detection and debugging aids.
- Optional hexadecimal or binary object format.
- A use map showing those locations actually used.

DAPL is available under a one-time license from Zeno Systems Inc., 2210 3rd Street, Santa Monica CA., (213) 396-6020 or on a timesharing basis from Remote Computing Corporation, One Wilshire, Los Angeles, CA 90015, (213) 629-2532.



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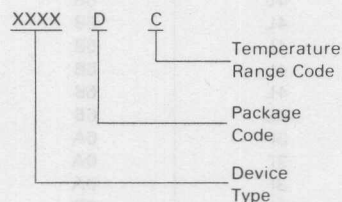


ORDER AND PACKAGE INFORMATION

Fairchild integrated circuits may be ordered using a simplified purchasing code where the package style and temperature range are defined as follows:

PACKAGE STYLE

D = Dual In-line — Ceramic (hermetic)
P = Dual In-line — Plastic
F = Flatpak



In order to accommodate varying die sizes and numbers of pins (14, 16, 24, etc.), a number of different package forms are required. The Package Information list on the following pages indicates the specific package codes currently used for each device type. The detailed package outline corresponding to each package code is shown at the end of this section.

Temperature Range

Two basic temperature grades are in common use: C = Commercial-Industrial, -40°C to $+85^{\circ}\text{C}$; M = Military, -55°C to $+125^{\circ}\text{C}$. Exact values and conditions are indicated on the data sheets.

Examples

- (a) 4014BFM
This number code indicates a 4014B Register in a Flatpak with military temperature rating.
- (b) 4720BDC
This number code indicates a 4720B 256 x 1 RAM in a ceramic Dual In-line Package with commercial temperature rating.
- (d) 40014BPC
This number code indicates a 40014B Hex Schmitt Trigger in a plastic package with a commercial temperature rating.

Device Identification/Marking

All Fairchild standard catalog integrated circuits will be marked as follows:



ORDER AND PACKAGE INFORMATION

CMOS PACKAGE INFORMATION

DEVICE	MILITARY (M) -55°C to +125°C		COMMERCIAL (C)/INDUSTRIAL -40°C to +85°C		
	CERAMIC DIP (D)	FLATPAK (F)	CERAMIC DIP (D)	PLASTIC DIP (P)	FLATPAK (F)
4001B	6A	3I	6A	9A	3I
4002B	6A	3I	6A	9A	3I
4006B	6A	3I	6A	9A	3I
4007UB	6A	3I	6A	9A	3I
4008B	6B	4L	6B	9B	4L
4011B	6A	3I	6A	9A	3I
4012B	6A	3I	6A	9A	3I
4013B	6A	3I	6A	9A	3I
4014B	6B	4L	6B	9B	4L
4015B	6B	4L	6B	9B	4L
4016B	6A	3I	6A	9A	3I
4017B	6B	4L	6B	9B	4L
4018B	6B	4L	6B	9B	4L
4019B	6B	4L	6B	9B	4L
4020B	6B	4L	6B	9B	4L
4021B	6B	4L	6B	9B	4L
4022B	6B	4L	6B	9B	4L
4023B	6A	3I	6A	9A	3I
4024B	6A	3I	6A	9A	3I
4025B	6A	3I	6A	9A	3I
4027B	6B	4L	6B	9B	4L
4028B	6B	4L	6B	9B	4L
4029B	6B	4L	6B	9B	4L
4030B	6A	3I	6A	9A	3I
4031B	6B	4L	6B	9B	4L
4034B	6N	4M	6N	9N	4M
4035B	6B	4L	6B	9B	4L
4040B	6B	4L	6B	9B	4L
4041B	6A	3I	6A	9A	3I
4042B	6B	4L	6B	9B	4L
4043B	6B	4L	6B	9B	4L
4044B	6B	4L	6B	9B	4L
4045B	6B	4L	6B	9B	4L
4046B	6B	4L	6B	9B	4L
4047B	6A	3I	6A	9A	3I
4049B	6B	4L	6B	9B	4L
4050B	6B	4L	6B	9B	4L
4051B	6B	4L	6B	9B	4L
4052B	6B	4L	6B	9B	4L
4053B	6B	4L	6B	9B	4L
4066B	6A	3I	6A	9A	3I
4067B	6N	4M	6N	9N	4M
4068B	6A	3I	6A	9A	3I
4069UB	6A	3I	6A	9A	3I
4070B	6A	3I	6A	9A	3I
4071B	6A	3I	6A	9A	3I
4072B	6A	3I	6A	9A	3I
4073B	6A	3I	6A	9A	3I
4075B	6A	3I	6A	9A	3I
4076B	6B	4L	6B	9B	4L
4077B	6A	3I	6A	9A	3I
4078B	6A	3I	6A	9A	3I
4081B	6A	3I	6A	9A	3I
4082B	6A	3I	6A	9A	3I
4085B	6A	3I	6A	9A	3I
4086B	6A	3I	6A	9A	3I
4093B	6A	3I	6A	9A	3I

ORDER AND PACKAGE INFORMATION

CMOS PACKAGE INFORMATION (Cont'd)

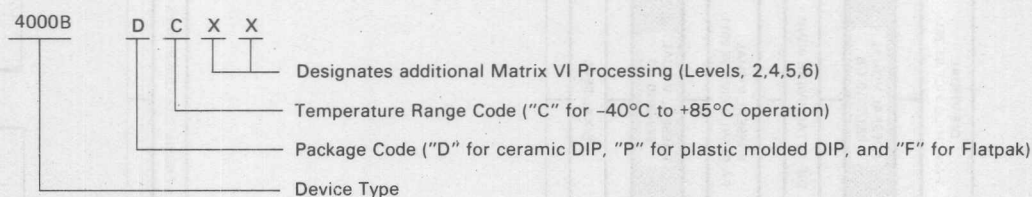
DEVICE	MILITARY (M) -55°C to +125°C		COMMERCIAL (C)/INDUSTRIAL -40°C to +85°C		
	CERAMIC DIP (D)	FLATPAK (F)	CERAMIC DIP (D)	PLASTIC DIP (P)	FLATPAK (F)
4104B	6B	4L	6B	9B	4L
4510B	6B	4L	6B	9B	4L
4511B	6B	4L	6B	9B	4L
4512B	6B	4L	6B	9B	4L
4514B	6N	4M	6N	9N	4M
4515B	6N	4M	6N	9N	4M
4516B	6B	4L	6B	9B	4L
4518B	6B	4L	6B	9B	4L
4519B	6B	4L	6B	9B	4L
4520B	6B	4L	6B	9B	4L
4521B	6B	4L	6B	9B	4L
4522B	6B	4L	6B	9B	4L
4526B	6B	4L	6B	9B	4L
4527B	6B	4L	6B	9B	4L
4528B	6B	4L	6B	9B	4L
4531B	6B	4L	6B	9B	4L
4532B	6B	4L	6B	9B	4L
4534B	6N	4M	6N	9N	4M
4538B	6B	4L	6B	9B	4L
4539B	6B	4L	6B	9B	4L
4543B	6B	4L	6B	9B	4L
4553B	6B	4L	6B	9B	4L
4555B	6B	4L	6B	9B	4L
4556B	6B	4L	6B	9B	4L
4557B	6B	4L	6B	9B	4L
4560B	6B	4L	6B	9B	4L
4561B	6A	3I	6A	9A	3I
4566B	6B	4L	6B	9B	4L
4581B	6N	4M	6N	9N	4M
4582B	6B	4L	6B	9B	4L
4583B	6B	4L	6B	9B	4L
4702B	6B	4L	6B	9B	4L
4703B	6Q	4M	6Q	9U	4M
4704B	6Q	4M	6Q	9U	4M
4705B	6Q	4M	6Q	9U	4M
4706B	6Q	4M	6Q	9U	4M
4707B	6Q	4M	6Q	9U	4M
4708B	6I		6I	8P	
4710B	7D		7D	9M	
4720B	7B	4L	7B	9B	4L
4721B	6V, 7I	4M	6V, 7I	4K	4M
4722B	6B	4L	6B	9B	4L
4723B	6B	4L	6B	9B	4L
4724B	6B	4L	6B	9B	4L
4725B	6B	4L	6B	9B	4L
4727B	6A	3I	6A	9A	3I
4731B	6A	4L	6A	9A	4L
4734B	7D		7D	9M	
4735B	6N, 6Q	4M	6N, 6Q	9N, 9U	4M
4736B	6B	4L	6B	9B	4L
4737B	6A	3I	6A	9A	3I
4741B	6B	4L	6B	9B	4L

DEVICE	MILITARY (M) -55°C to +125°C		COMMERCIAL (C)/INDUSTRIAL -40°C to +85°C		
	CERAMIC DIP (D)	FLATPAK (F)	CERAMIC DIP (D)	PLASTIC DIP (P)	FLATPAK (F)
40014B	6A	3I	6A	9A	3I
40085B	6B	4L	6B	9B	4L
40097B	6B	4L	6B	9B	4L
40098B	6B	4L	6B	9B	4L
40160B	6B	4L	6B	9B	4L
40161B	6B	4L	6B	9B	4L
40162B	6B	4L	6B	9B	4L
40163B	6B	4L	6B	9B	4L
40174B	6B	4L	6B	9B	4L
40175B	6B	4L	6B	9B	4L
40192B	6B	4L	6B	9B	4L
40193B	6B	4L	6B	9B	4L
40194B	6B	4L	6B	9B	4L
40195B	6B	4L	6B	9B	4L

MATRIX VI PROGRAM ORDERING INFORMATION

Matrix VI is a full spectrum/cost effective reliability and quality program for commercial/industrial ICs only. It features six levels of screening/package flows, each tailored to a user's field application/environment and his incoming quality/equipment reliability requirements.

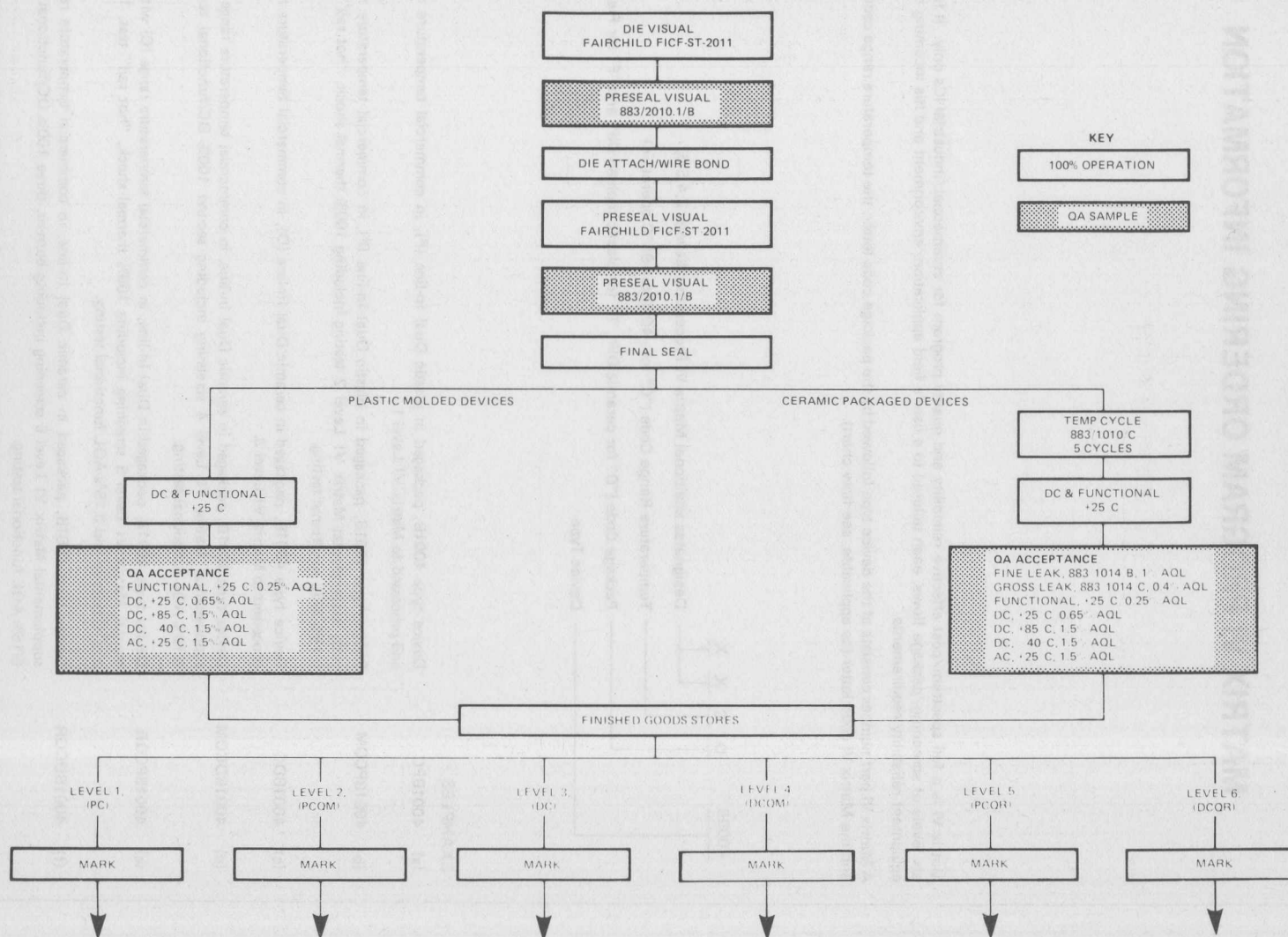
A Matrix VI part number consists of the device type followed by the package code letter, the temperature range code letter, and the Matrix VI code letter (as applicable, see flow chart).

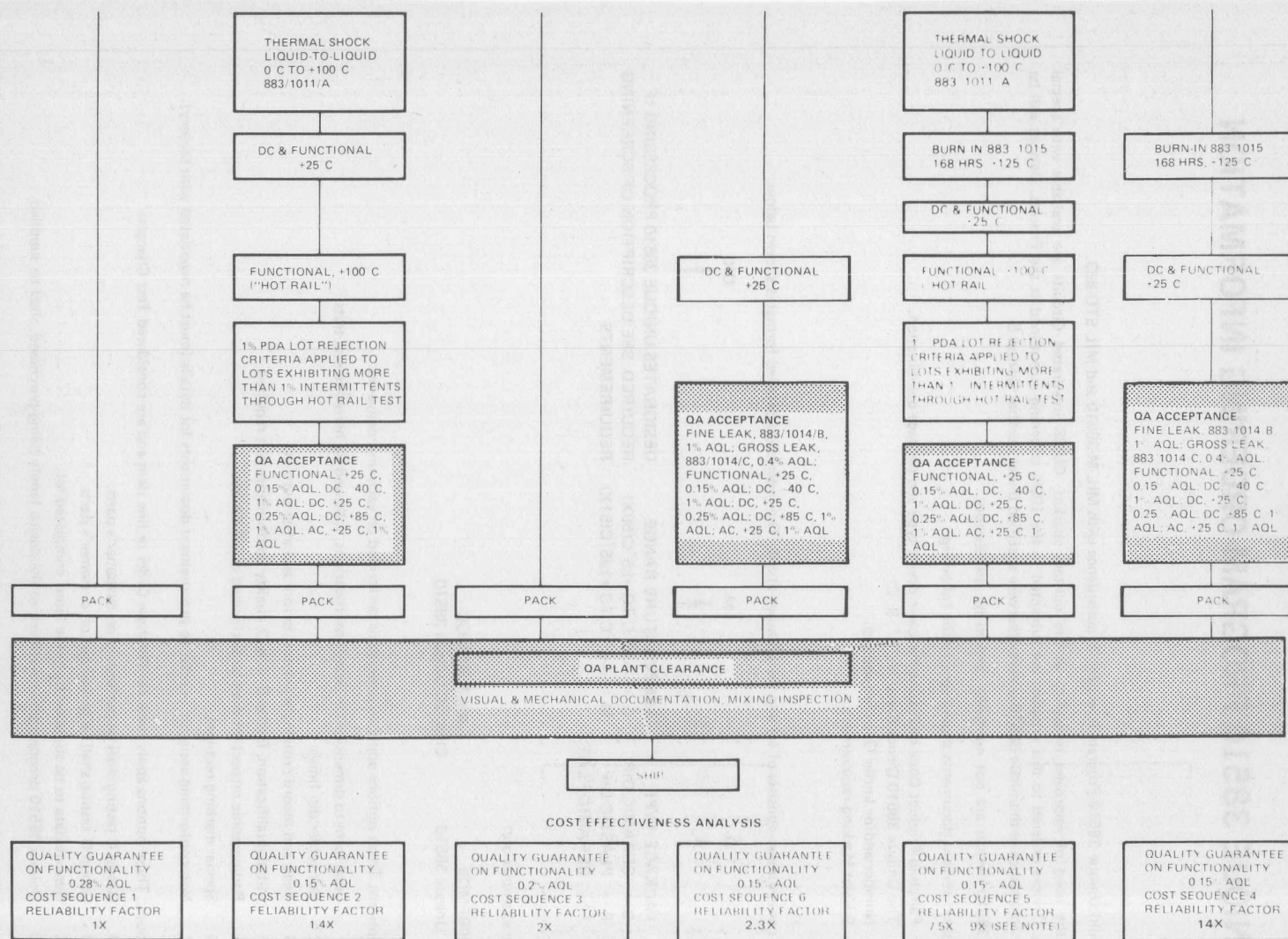


EXAMPLES

- | | |
|---------------|---|
| (a) 4001BPC | Device type 4001B, packaged in plastic Dual In-line (P), in commercial temperature range (C) and processed to Matrix VI Level 1. |
| (b) 4001BPCOM | Device type 4001B, packaged in plastic Dual In-line (P), in commercial temperature range (C) with supplemental Matrix VI Level 2 testing including 100% thermal shock, "hot rail" test and 0.15% AQL functional testing. |
| (c) 4001BDC | Device type 4001B, packaged in ceramic Dual In-line (D), in commercial temperature range and processed to Matrix VI Level 3. |
| (d) 4001BDCQM | Device type 4001B, packaged in ceramic Dual In-line, in commercial temperature range (C) with supplemental Matrix VI Level 4 screening including second 100% DC/functional testing and 0.15% AQL functional testing. |
| (e) 4001BPCQR | Device type 4001B, packaged in Dual In-line, in commercial temperature range (C) with supplemental Matrix VI Level 5 screening including 100% thermal shock, "hot rail" test, 168 hours 125°C burn-in and 0.15% AQL functional testing. |
| (f) 4001BDCQR | Device type 4001B, packaged in ceramic Dual In-line, in commercial temperature range with supplemental Matrix VI Level 6 screening including burn-in, three 100% DC/functional tests and 0.15% AQL functional testing. |

MATRIX VI PROCESS FLOW OPTIONS & COST EFFECTIVENESS





Note: Burn-In has the same relative effectiveness for plastic molded devices as for ceramic/hermetic packaged devices. Assuming a controlled (air conditioned and constant power) field application/environment, the reliability factor would be approximately 9X. But should the field application be in a less controlled and power ON/OFF application, the reliability factor would be approximately 7.5X.

UNIQUE 38510 PROGRAM ORDERING INFORMATION

The Fairchild Unique 38510 Program is written in accordance with MIL-M-38510 and MIL-STD-883

To meet the need of improved reliability in the military market, CMOS Integrated Circuits are available with special processing. Devices ordered to this program are subjected to the 100% screening as outlined in the Process. Devices will be marked in accordance with unique 38510 unless otherwise specified under number Option 6.

UNIQUE 38510 devices are not normally stocked by distributors.

Customer procurement documents should specify the following:

- (a) Fairchild Product Code indicating the basic device type and package combination.
- (b) The Unique 38510 Device Class. (A, B*, B, C)
- (c) Number and/or Letter Options required.
- (d) Special Marking requirements.

The order code number consists of (a) and (b) as shown above. The order code detailed format is shown below.

4001B	D	M	QX
↑	↑	↑	↑
DEVICE TYPE	PACKAGE TYPE	TEMPERATURE RANGE	DESIGNATES UNIQUE 38510 PROCESSING IF REQUIRED. SEE DESCRIPTION OF SCREENING REQUIREMENTS
	D = CERAMIC DIP	C = -40°C TO +85°C (59X)	
	P = PLASTIC DIP	M = -55°C TO +125°C (51X)	
	F = CERAMIC FLAT		

Order code examples are:

4029BFMQB
Class QB Unique 38510

4007UBDMQC
Class QC Unique 38510

Number Options: These options apply to operations performed on each unit delivered:

- OPTION 1 Lead form to dimensions in detail specifications, followed by hermetic seal tests.
- OPTION 2 Hot solder dip finish.
- OPTION 3 Read and record critical parameters before and after burn-in.
- OPTION 4 Initial qualification, Group B, C & D quality conformance not required.
- OPTION 5 Radiographic inspection shall be performed on all devices.
- OPTION 6 Special marking required.
- OPTION 7 Non-conforming variation – refer to procurement documents for details (must be negotiated with factory).

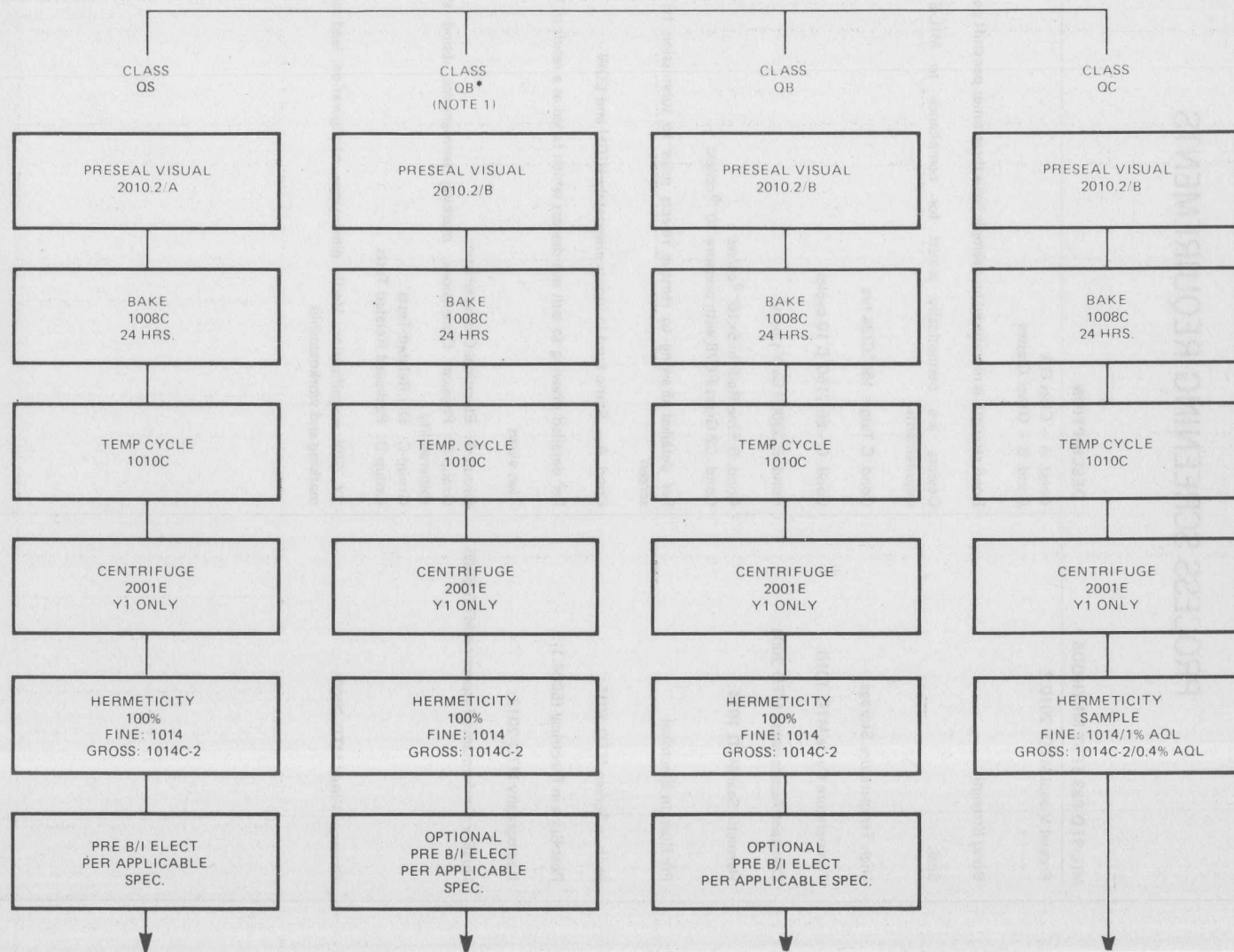
Letter Options: These options apply once per Purchase Order or line item and are considered Test Charges:

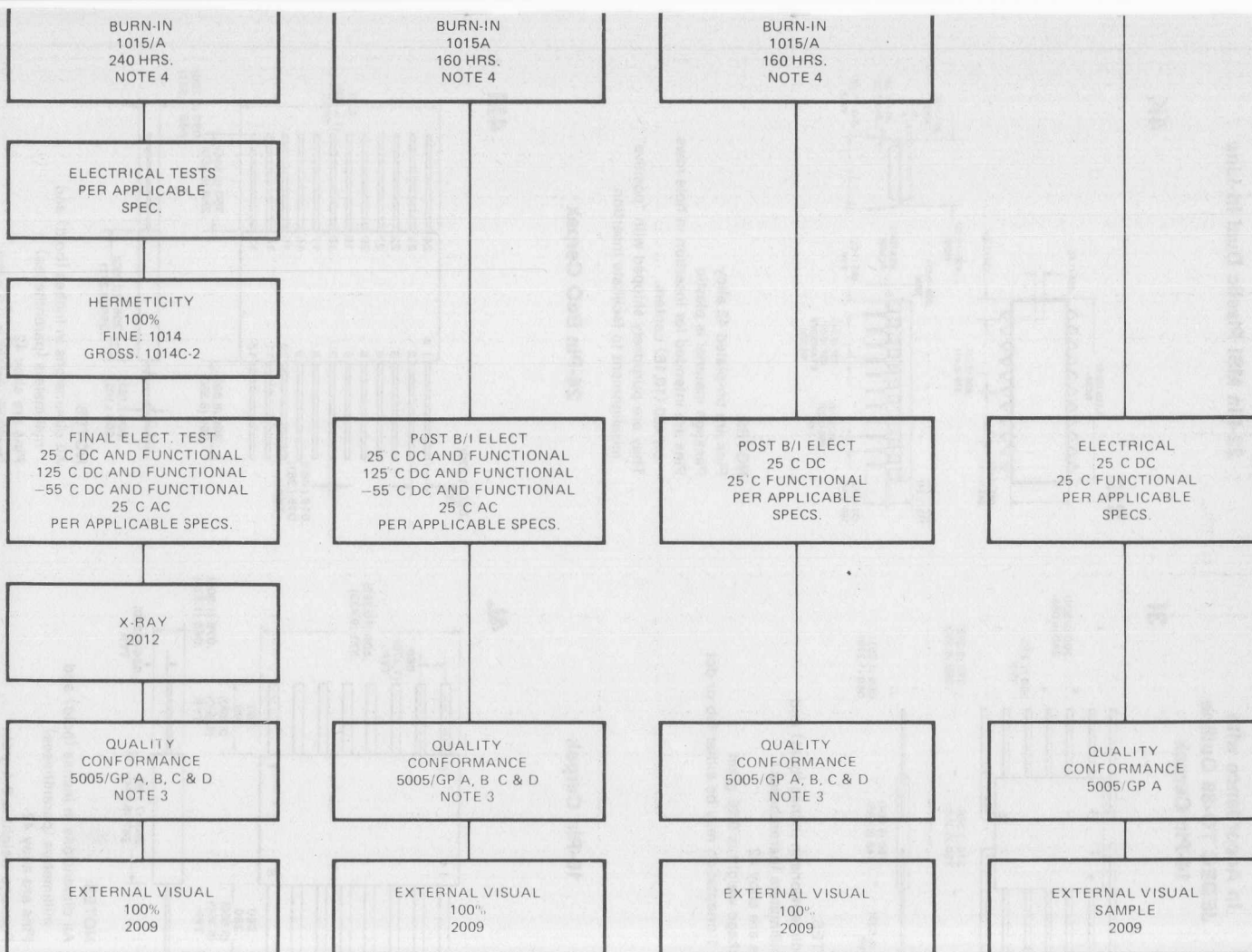
- OPTION A Group C testing shall be performed on customer's parts.
- OPTION B Group D testing shall be performed on customer's parts.
- OPTION C Generic data to be supplied from the latest completed lot.
- OPTION D Unique 38510 program plan, pertinent to the device family being purchased, shall be supplied.

PROCESS SCREENING REQUIREMENTS

MIL-STD-883 TEST METHODS	DESCRIPTION
Preseal Visual MTD. 2010.2	Cond. A — Class QA Cond. B — Other Classes
Bond Strength:	Bond strength is monitored on a sample basis three times per shift per mach.
Seal:	Devices are hermetically sealed for compliance to MIL-STD-883 requirements
High Temperature Storage:	Cond. C Tstg = 150°C/24 hrs
Temperature Cycle MTD 1010:	Cond. C -65°/150°C 10 cycles
Constant Acceleration MTD 2001:	Cond. E 30000 Gs Y ₁ only
Hermetic Seal MTD 1014:	Cond. B Fine-Radiflo 5x10 ⁻⁸ cc/sec Cond. C2 Gross-FC78 with pressure 10 ⁻⁵ cc/sec
Pre Burn-In Electrical	Per detailed drawing to remove rejects prior to submission to burn-in screen
Burn-in Screen MTD 1015:	Cond. A — Static burn-in inputs alternately HIGH and LOW.
Post Burn-in Electrical (5004.1):	Per detailed drawing to cull out devices which failed as a result of burn-in.
Radiography MTD 2012:	Two views
Quality Conformance Inspection MTD 5005	Group A: Electrical Characteristics Group B: Physical Dimensions, marking permanence, bond strength, solderability Group C: Die Related Tests Group D: Packaged Related Tests
External Visual MTD 2009:	3X, 20X magnification: Verify dimensions, configuration, lead structure, marking and workmanship

UNIQUE 38510
NOTE 2



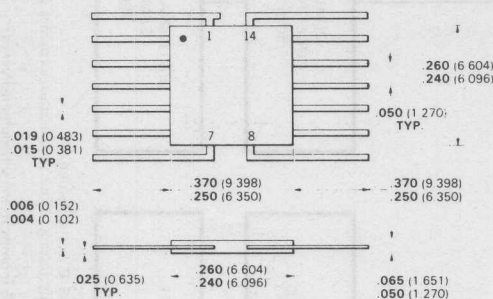


Notes:

1. Upon customer request only. Class B processing in this case includes adding post burn-in testing: dc testing at +125 C and -55 C and ac testing.
2. Unique 38510 is written around the MIL-M-38510 requirements with a few modifications to Method 5005 in that 100% dc testing at the temperature extremes and 100% ac testing at 25 C is not done and Unique 38510 QS has some burn-in logistics differences.
3. Qualification testing per groups B, C and D on a customer's parts require additional lot charges and an added minimum of two months to the schedules deliveries.
4. Any burn-in condition other than MTD 1015 Condition A is at customer request only.

IN ACCORDANCE WITH
JEDEC TO-86 Outline
14-Pin Cerpak

3I

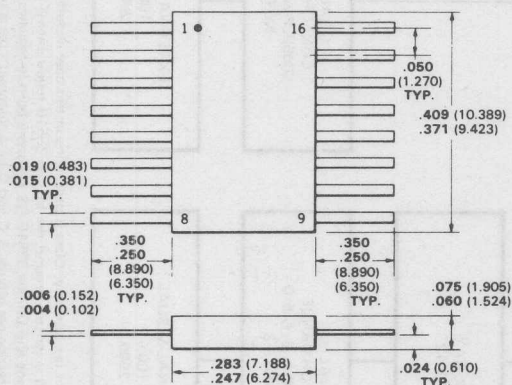


NOTES:

All dimensions in inches (bold) and millimeters (parentheses)
Pins are alloy 42
Package weight is 0.26 gram
Pin 1 orientation may be either tab or dot

16-Pin Cerpak

4L

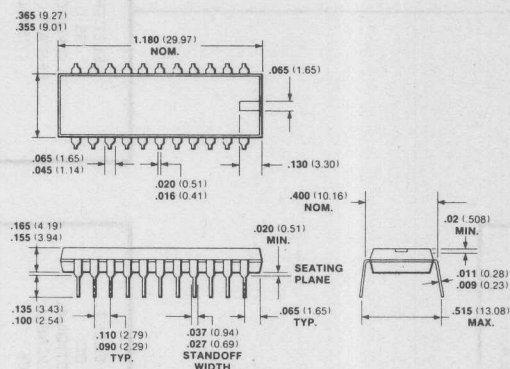


NOTES:

All dimensions in inches (bold) and millimeters (parentheses)
Pins are alloy 42
Package weight is 0.4 gram
Hermetically sealed beryllia package

JEDEC TO-86 Outline 24-Pin Cerpak

4K

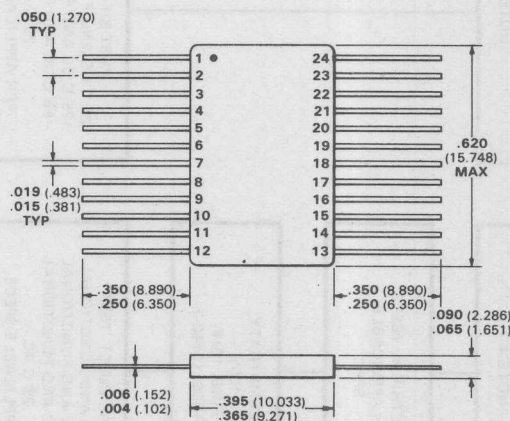


NOTES:

Pins are tin-plated 42 alloy
Package material is plastic
Pins are intended for insertion in hole rows on 400 (10.16) centers.
They are purposely shipped with "positive" misalignment to facilitate insertion.

24-Pin BeO Cerpak

4M



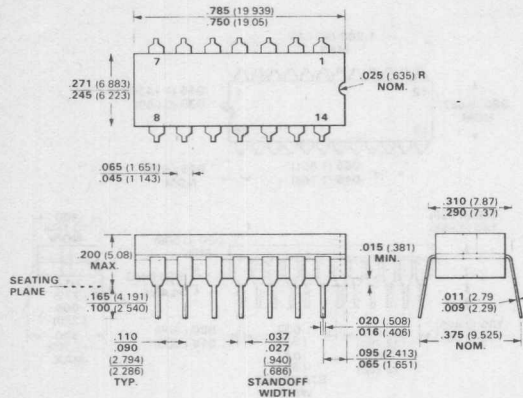
NOTES:

All dimensions in inches (bold) and millimeters (parentheses)
Pins are alloy 42
Package weight is 0.8 gram
Hermetically sealed beryllia package

PACKAGE OUTLINES

in accordance with JEDEC (TO-116) outline 14-Pin Ceramic Dual In-Line

6A

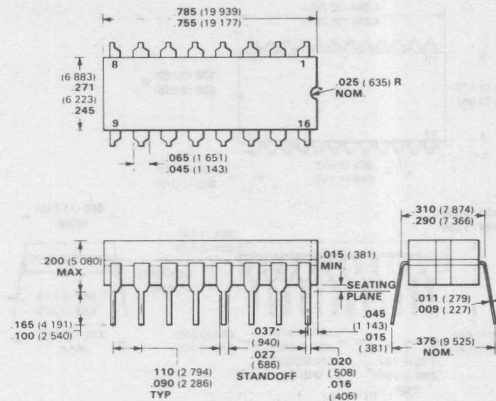


NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are intended for insertion in hole rows on .300" (7.620) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion
- Board-drilling dimensions should equal your practice for .020" (0.508) diameter pin
- Pins are alloy 42
- Package weight is 2.0 grams

16-Pin Ceramic Dual In-Line

6B

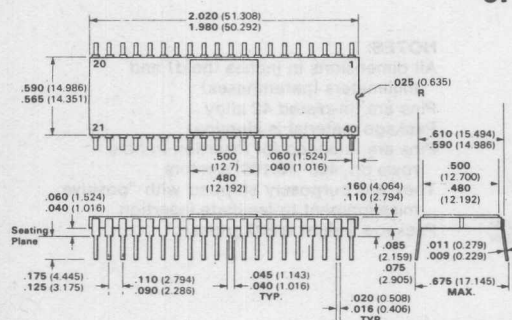


NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are intended for insertion in hole rows on .300" (7.620) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion
- Board-drilling dimensions should equal your practice for .020 inch (0.508) diameter pin
- Pins are alloy 42
- Package weight is 2.0 grams
- *The .037/.027 (.940/.686) dimensions does not apply to the corner pins

40-Pin Dual In-Line Side Brazed, Large Cavity

6I



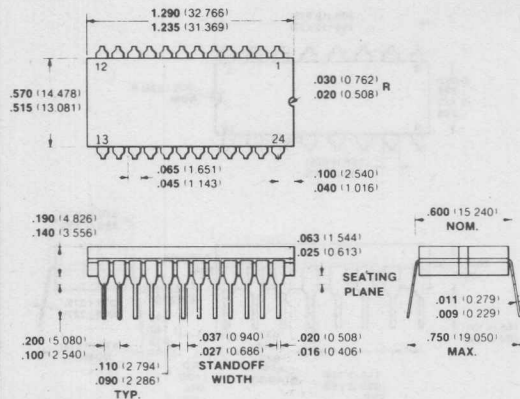
NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pin material nickel gold-plated kovar
- Cap is kovar
- Base is ceramic
- Package weight is 6.5 grams

PACKAGE OUTLINES

24-Pin Ceramic Dual In-Line

6N

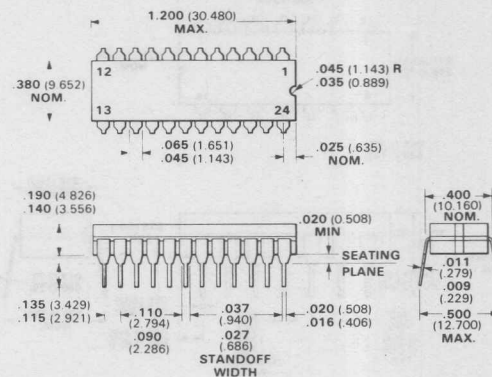


NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are intended for insertion in hole rows on .600" (15.24) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion
- Pins are alloy 42
- Package weight is 6.5 grams
- Package material is alumina

24-Pin Ceramic Dual In-Line

6Q

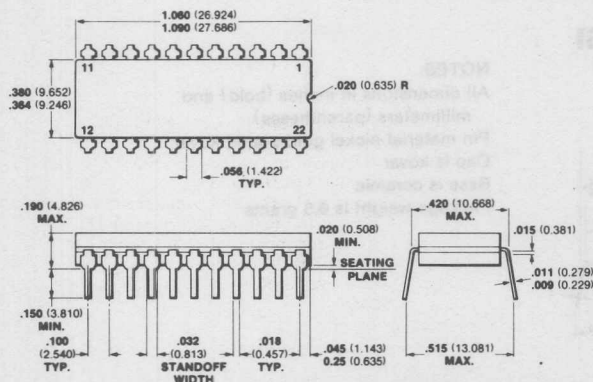


NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are intended for insertion in hole rows on .400" (10.16) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion
- Board-drilling dimensions should equal your practice for .020 inch (0.508) diameter pin
- Pins are alloy 42

22-Pin Ceramic Dual In-Line

6V



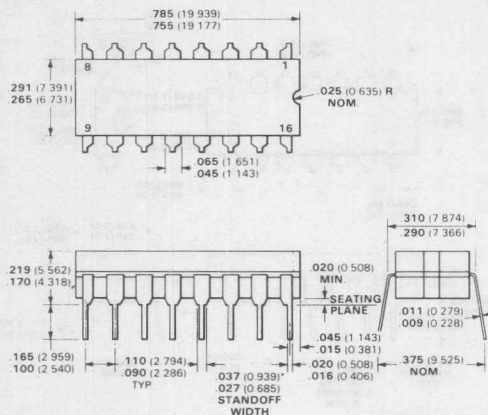
NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are tin-plated 42 alloy
- Package material is alumina
- Pins are intended for insertion in hole rows on .400 (10.16) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion.
- Package weight is 6.0 grams

PACKAGE OUTLINES

16-Pin Dual In-Line

7B

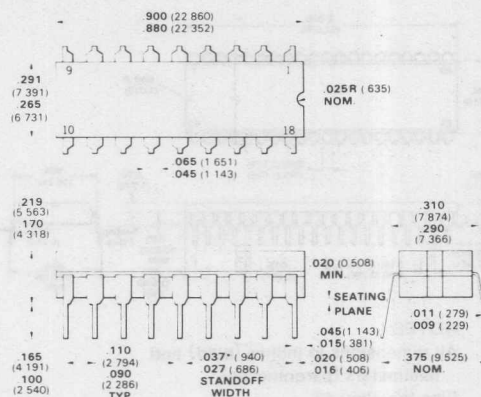


NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are intended for insertion in hole rows on .300" (7.620) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion
- Board-drilling dimensions should equal your practice for .020 inch (0.508) diameter pin
- Pins are alloy 42
- Package weight is 2.2 grams
- *The .037/.027 (.940/.686) dimension does not apply to the corner pins

18-Pin Ceramic Dual In-Line

7D

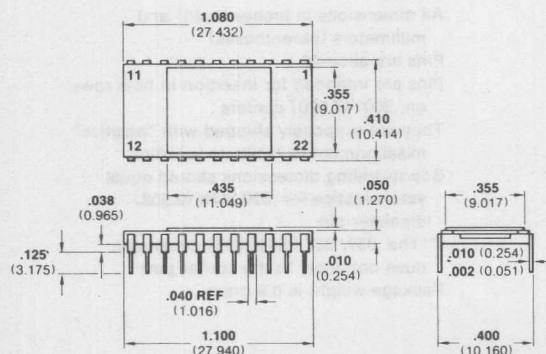


NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are intended for insertion in hole rows on .300" (7.620) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion
- Board-drilling dimensions should equal your practice for .020 inch (0.508) diameter pin
- Pins are alloy 42

22-Pin Dual In-Line (Metal Cap)

7I

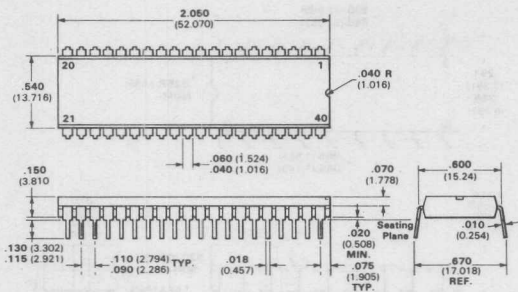


NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are intended for insertion in hole rows on .400" (10.16) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion
- Board-drilling dimensions should equal your practice for .020" (0.51) diameter pin
- Pins are gold-plated Kovar
- Cap is Kovar
- Base is ceramic
- Package weight is 4 grams

(Production Mold)

8P



NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

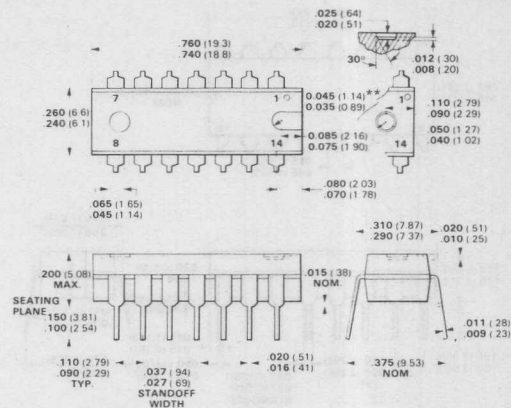
Pins are alloy 42

Package material is plastic

Pins are intended for insertion in hole rows on .600" (15.24) centers

They are purposely shipped with "positive" misalignment to facilitate insertion

9A



NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

Pins are intended for insertion in hole rows on .300" (7.620) centers

They are purposely shipped with "positive" misalignment to facilitate insertion

Board-drilling dimensions should equal your practice for .020 inch (0.508) diameter pin

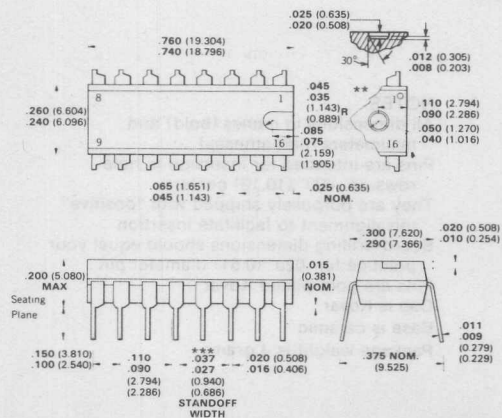
Pins are alloy 42

Package weight is 0.9 gram

Package material is silicone

16-Pin Plastic Dual In-Line

9B



NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

Pins are alloy 42

Pins are intended for insertion in hole rows on .300" (7.620) centers

They are purposely shipped with "positive" misalignment to facilitate insertion

Board-drilling dimensions should equal your practice for .020 inch (0.508) diameter pin

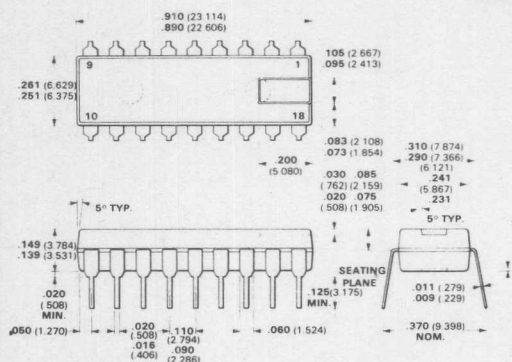
***The .037/.027 (.940/.686) dimension does not apply to the corner pins

Package weight is 0.9 gram

PACKAGE OUTLINES

18-Pin Plastic Dual In-Line

9M

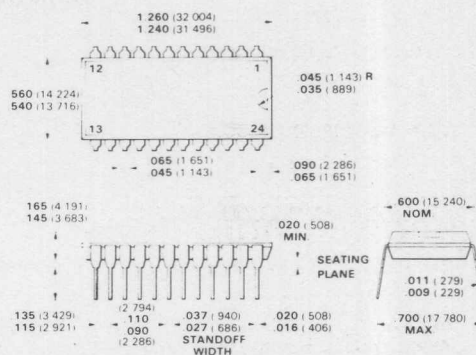


NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are intended for insertion in hole rows on .300" (7.620) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion
- Board-drilling dimensions should equal your practice for .020 inch (0.508) diameter pin
- Pins are alloy 42

24-Pin Plastic Dual In-Line

9N

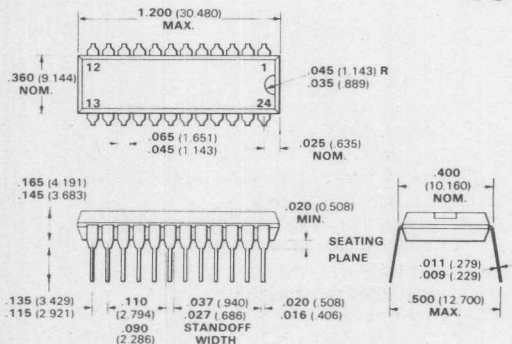


NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are intended for insertion in hole rows on .600" (15.24) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion
- Board-drilling dimensions should equal your practice for .020 inch (0.508) diameter pin
- Pins are alloy 42

24-Pin Plastic Dual In-Line

9U



NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- Pins are intended for insertion in hole rows on .400" (10.16) centers
- They are purposely shipped with "positive" misalignment to facilitate insertion
- Board-drilling dimensions should equal your practice for .020 inch (0.508) diameter pin
- Pins are alloy 42

PACKAGE OUTLINES

24-Pin Plastic Dual In-Line

BM



NOTE:
All dimensions are in inches (bold) and millimeters (parentheses).
Pin 1 is indicated by a dot in this view.
Pin 12 is 0.015 (0.381) from Pin 1.
The package is shipped with the lead wires bent at a 90-degree angle.
Lead wire dimensions should equal your supplier's for 28 gauge wire.
Standard pin
Pin 1 is only 0.5

24-Pin Plastic Dual In-Line

3W



NOTE:
All dimensions are in inches (bold) and millimeters (parentheses).
Pin 1 is indicated by a dot in this view.
Pin 12 is 0.015 (0.381) from Pin 1.
The package is shipped with the lead wires bent at a 90-degree angle.
Lead wire dimensions should equal your supplier's for 28 gauge wire.
Standard pin
Pin 1 is only 0.5

24-Pin Plastic Dual In-Line

9U



NOTE:
All dimensions are in inches (bold) and millimeters (parentheses).
Pin 1 is indicated by a dot in this view.
Pin 12 is 0.015 (0.381) from Pin 1.
The package is shipped with the lead wires bent at a 90-degree angle.
Lead wire dimensions should equal your supplier's for 28 gauge wire.
Standard pin
Pin 1 is only 0.5